

38/10-30-95JS (2)

CONF-9402160--

ANL/APS/TM-15

Detectors for Third-Generation Synchrotron Sources: Workshop Report

Co-Chairs: B. Rodricks, E. M. Westbrook,
P.A. Montano, and S. H. Barr

Advanced Photon Source



Argonne National Laboratory
operated by The University of Chicago for the U.S. Department of Energy under Contract W-31-109-Eng-38

Argonne National Laboratory, with facilities in the states of Illinois and Idaho, is owned by the United States government, and operated by The University of Chicago under the provisions of a contract with the Department of Energy.

DISCLAIMER

This report was prepared as an account of work sponsored by an agency of the United States Government. Neither the United States Government nor any agency thereof, nor any of their employees, makes any warranty, express or implied, or assumes any legal liability or responsibility for the accuracy, completeness, or usefulness of any information, apparatus, product, or process disclosed, or represents that its use would not infringe privately owned rights. Reference herein to any specific commercial product, process, or service by trade name, trademark, manufacturer, or otherwise, does not necessarily constitute or imply its endorsement, recommendation, or favoring by the United States Government or any agency thereof. The views and opinions of authors expressed herein do not necessarily state or reflect those of the United States Government or any agency thereof.

Reproduced from the best available copy.

Available to DOE and DOE contractors from the
Office of Scientific and Technical Information
P.O. Box 62
Oak Ridge, TN 37831
Prices available from (615) 576-8401

Available to the public from the
National Technical Information Service
U.S. Department of Commerce
5285 Port Royal Road
Springfield, VA 22161

ARGONNE NATIONAL LABORATORY
9700 South Cass Avenue
Argonne, Illinois 60439

ANL/APS/TM-15

WORKSHOP ON DETECTORS FOR
THIRD-GENERATION SYNCHROTRON SOURCES

Proceedings of a workshop held at
Argonne National Laboratory
February 14-15, 1994

Workshop Organizing Committee

Brian Rodricks
Edwin M. Westbrook
Pedro A. Montano
Susan H. Barr

December 1994

work sponsored by
U.S. DEPARTMENT OF ENERGY
Office of Energy Research

MASTER

DISTRIBUTION OF THIS DOCUMENT IS UNLIMITED

f

DISCLAIMER

**Portions of this document may be illegible
electronic image products. Images are
produced from the best available original
document.**

FOREWORD

The Workshop on Detectors for Third-Generation Synchrotron Sources was hosted by the APS February 14-15, 1994. The aims of the workshop were (1) to acquaint APS users with current R&D being carried out on detectors, (2) to identify new detector systems possible during the next five years, (3) to identify new detectors theoretically possible in the future, (4) to stimulate interactions between user groups and detector developers, and (5) to obtain recommendations from expert panels on technical issues needing resolution. The two day workshop was attended by more than 100 scientists, with invited speakers from the ESRF, SPring-8, CERN, LBL, and BNL.

The organizing committee would like to thank Roy Clarke, Alain Fontaine, Sol Gruner, and Keith Moffat for chairing the discussion sessions; Dennis Mills and Gopal Shenoy for advice and suggestions; the APS User Office: (Linda Carlson, and Diane Sandberg) for local arrangements; Susan Picologlou for editing this Workshop Report; and finally, the speakers. Special thanks go to David Moncton for opening the workshop with a status report of the Advanced Photon Source. Support for the workshop was provided by the U.S. Department of Energy BES-Material Science, under grant No. W-31-109-ENG-38.

CONTENTS

Progress in Detector Development at the ESRF John Morse, ESRF	1
Detector Development at SPring-8 Masayo Suzuki and Tatzuo Ueki, RIKEN	53
Development of Gas and Silicon X-ray Detectors at BNL Hobart Kraner and Graham Smith, Brookhaven National Laboratory	89
The Advanced Photon Source High Power Density X-ray Beam Position Monitor Deming Shu and Tuncer M. Kuzay, Advanced Photon Source	113
Physical and Technological Aspects of Storage Phosphor Plates Made of BaFBr:Eu ²⁺ Andrew Harrison, Edinburgh University	153
Time-Resolved Experiments on Muscle Using Synchrotron Radiation A. R. Faruqi, MRC Laboratory of Molecular Biology	187
CCD Area X-ray Detectors: Experiments and Possibilities Sol M. Gruner, Princeton University	210
Amorphous Silicon-Based Imaging Detectors for Protein Crystallography Istevan Naday, Argonne National Laboratory, and Robert Sweet, Xerox	252
Crystallographic Data Handling and Reduction in Experiments with Extremely High Data-Acquisition Rates Wladek Minor, Purdue University	279
Silicon Pixel Detector Development at CERN Michael Campbell, CERN	297
APDs - Large Dynamic Range Detectors for Hard X-rays Wolfgang Sturhahn, Advanced Photon Source	327
Application of Bulk-Grown Cd _{1-x} Zn _x Te Alloys to Single-Photon X-ray Imaging Richard C. Schirato, Raulf M. Polichar and John H. Reed, Science Applications International Corporation	345
MBE CdTe Photoconductive Position Sensitive X-ray Detectors Sung Shik Yoo, University of Illinois	371

Contents continued

Recent Work at Lawrence Berkeley Laboratory on Semiconductor Detectors for Synchrotron Applications C. Rossington, B. Ludewigt, P. Luke, N. Derhacobian and J. Walton, Lawrence Berkeley Laboratory	398
The Multi-Element Mercuric Iodide Detector Array with Computer Controlled Miniaturized Electronics for EXAFS B. E. Patt, J. S. Iwanctyk, R. Szczebiot and M. Wang, Xsirius Corporation, B. Hedman, K. O. Hodgson and T. Cox, Stanford Synchrotron Radiation Laboratory	420
Large Area Photodiodes Marek Szawlowski and Ernesto Gramsch, Advanced Photonix	440
Agenda	461
Final List of Participants	465

John Morse

ESRF

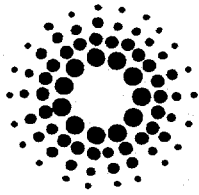
Progress in Detector Development at the ESRF

In 1990, the ESRF Detector Group began work on scintillation detector schemes based upon i) medical X-ray Image Intensifiers (XIIs) for large sensitive areas ($\approx 300 \text{ cm}^2$) and ii) scintillant screens $< \varnothing 100 \text{ mm}$ for higher spatial resolution applications ($\leq 50 \mu\text{m}$ FWHM). Both these approaches use the coupling of a visible light image to a CCD camera readout system. A development with Thomson Tubes Électroniques was funded to produce XIIs with beryllium input windows to extend their sensitive energy range down to 5 keV. The first XIIs with beryllium window and scintillator substrate have now been extensively tested at the ESRF: the absence of tails in the measured point spread function ($\approx 150 \mu\text{m}$ FWHM, $\approx 1 \text{ mm}$ FW0.1% M over a $\varnothing 200 \text{ mm}$ input field) gives these an excellent capability to separate closely spaced diffraction peaks. An area detector of $\varnothing 110 \text{ mm}$ input field has also been built and tested and is based upon a high resolution (PSF $\approx 50 \mu\text{m}$ FWHM) mammography x-ray screen directly coupled by a large aperture ($f/0.87$) relay lens to a CCD camera. A similar development is in progress to provide a time resolved ($\approx 50 \mu\text{sec}$) detector for the energy dispersive EXAFS beamline; this will be read out using a masked area-array CCD as a one-dimensional detector with fast internal-analogue buffering of data. Detailed measurements have been made on the problem of phosphor-screen-output decay times and afterglow over a dynamic range $\geq 10^4$, and this has resulted in the choice for this application of a novel low-lag ceramic phosphor. Work is in progress on evaluating new materials for high density and structured phosphor screens.

A 1Mpixel CCD camera to operate at up to 10 frames per second with a single-frame dynamic range ≥ 5000 is at an advanced stage of construction. The VXI electronic standard has been adopted for detector data acquisition and by March 1994, a camera interface and 256 Mbyte memory buffer will be completed. By using the VXI local bus feature, a continuous 40 Mbyte/sec update rate is available. The memory buffer will support several access modes including successive CCD frame integration and a histogramming function for other types of area detectors that are photon counters.

Photon-counting detectors under development for the ESRF include a two-dimensional microstrip gas detector, based on charge division readout in

one dimension, and on a strip-by-strip basis in the second dimension at a pitch of 300 μm . The position interpolation scheme for this detector has been proven to a resolution of 1/500 over the microstrip length with readout rate >100 kcps/strip. For low-count-rate Compton scattering studies, monolithic, multielement germanium detectors are being developed, offering both good spatial resolution and energy resolution (≈ 1 keV) for background noise suppression for x-ray energies to >100 keV. A 30-strip test detector at 200- μm pitch is being studied to evaluate the consequences of interstrip dead zones and crosstalk; this will be followed by a 300-strip design.



ESRF

APS Detectors for 3rd Gen. Sources Workshop 14 - 15 February 1994

Developments within the ESRF Detector Group

1. X-ray Image Intensifiers: Ø215mm beryllium window device
2. Scintillant screen systems: 1-D detector for energy dispersive EXAFS
Ø110mm camera for Microfocus beamline
3. Fast CCD camera head: 10 frames/sec 1024² pixels at 14 bits
4. Germanium multi-strip (200µm) high energy (30 - 100 keV) detector
5. Rutherford Appleton Lab' - ESRF Area Gas Microstrip Detector
6. VXI-bus fast data acquisition: CCD interface; Histogramming Memory

J Morse, Detector Group, Experiments Division

ESRF Detector Group: *Personnel*

-Detector physics/engineering:

M Diot
S Gibney
A Koch
J Morse
J-P Moy

- Electronics & software:

J Clément
P Habraken
J-C Labiche
T Mary
J Segura
R Stephens
D VanBrussel

(ILL, until 5/94)
(RAL, Peak Load)

DETECTOR REQUIREMENTS: ESRF BEAMLINES

Detector types	BL 1	BL 2	BL 3	BL 4	BL 5	BL 6	BL 7	BL 8	BL 9	BL 10	BL 11	BL 12	BL 13	BL 14	BL 15	BL 16	BL 17	BL 18	BL 19	BL 20	BL 21	BL 22	BL 23	BL 24
scintillator-PMT (counting mode)	*	*	*	*	*		*		*		*	*	*	*	*	*	*	*				*	*	
Photodiodes† (current mode)	*	*				*			*				*	*		*		*				*		
Scintillant screen - CCD	*						*	*					*			*								
X-Ray Intensifier- CCD		*	*	*													*		*					
1D-and-2D Gas MWPC or strip	*		*	*			*		*						*		*	*						
2D Image Plate	*	*	*	*	*									*	*	*	*	*	*	*	*	*	*	*
Silicon-energy†† dispersive						*			*			*			*			*				*	*	*
Germanium†† energy dispersive	*	*		*	*	*	*		*				*	*	*			*	*	*	*	*	*	*

† Photodiodes operating in current mode will also be used on many beamlines for beam intensity and/or position monitoring

†† Includes single channel and multi-element systems (for higher counting rate or spatial resolution)

BL 11 alternative detectors are: i) avalanche diodes ii) scintillator/pulsed MCP

ESRF Detector Group Developments

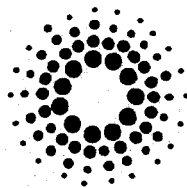
Application Areas	X-ray Image Intensifier-CCD	Phosphor screen - CCD lens coupled camera	1D Phosphor screen- 'analog buffer' CCD camera	Multi-strip Germanium	RAL/ESRF Gas Microstrip charge division readout/strip
Active Size mm	Diffraction and other 2D area imaging Al: to Ø400, Be: Ø200	Diffraction and other 2D high spatial resolution imaging Ø110	Energy Dispersive EXAFS, high intensity, fast 1D framing 40 x (0.02 to > 0.1)	Compton and high energy studies: spatial (1D) and energy resolution 20 x 6 (30 element) 20 x 60 (300 element)	Diffuse scattering: 2D, low noise, fast counting ~ 150 x 150
Number of elements	1024 x 1024 ('F3') 512 x 512 ('F4')	1000 x 1000	512	30 & 300	'y' axis: ~300 strips 'x' axis: ~500 lw/hms
Optimum DOE %	~90 at 15keV	~30 for 10 to 20 keV	> 60 for 10 to 25keV	>90 for 8 to 80keV	>90 at 8keV
Spatial resolution input referred lw/hm	Be XII: 180 µm, CCD: Nyquist	Screen/lens: 80 µm, CCD: Nyquist	Screen/lens: <40 µm, CCD: Nyquist	~Nyquist (150µm active elements)	'y' axis: Nyquist-strip number 'x' axis: ~500µm
Energy range keV, >10% DOE	Be: 6-60; Al: 20-200	6 - 30 keV	5 - 60 keV	6 to 150keV	6 - 20 (at 1 bar Xenon)
Energy resolution keV/lw/hm	none (integrating detector)	none (integrating detector)	none (integrating detector)	< 1	= 2
Exposure/sampling time minimum, maximum seconds	shutter limit to ~20 ('F3')† shutter limit to ~20 ('F4')†	shutter limit to >1000†	~3E-6 to >1000*	<5E-8 (signal/preamp' risetime) to hours	<1E-6 to hours
Readout/dead time seconds	0.1 ('F3' frame readout) ~2E-3 ('F4' frame transfer)	10 (CCD frame readout)	~1E-5 (CCD line transfer)* 10 (CCD full frame readout)*	~1E-6 (signal shaping time)	~1E-5 (signal processing time)
Noise	XII NEP: <0.1keV/mm2/sec >5000 ('F3') & ~1000 ('F4')	CCD readout ~25keV/pixel ~50 000	CCD readout ~30keV/pixel ~100 000	<1cpm/element 'counting statistics'	<1cpm/element 'counting statistics'
Dynamic range	No limit††	No limit††	No limit††	~10kcps (shaping time ~µsec) ~300kcps (for 30 elements) ~3Mcps (for 300 elements)	~100kcps per 'x' strip 30Mcps (for 300 'x' strips)
Max. count rate per element	No limit††	No limit††	No limit††		
Max. count rate 'global'					
Radiation tolerance	XII >>1E7 rads	phosphor screen to >1E11 rads	phosphor screen >1E7 rads	germanium crystal > 1E6 rads (?)	µstrip substrate >10Mrads (?)

Notes:

† minimum when used with µsec beam chopper, maximum is set by CCD dark current for F4 CCD (pellet cooled). F3, F4 refer to CCD camera systems under development in Detector Group.

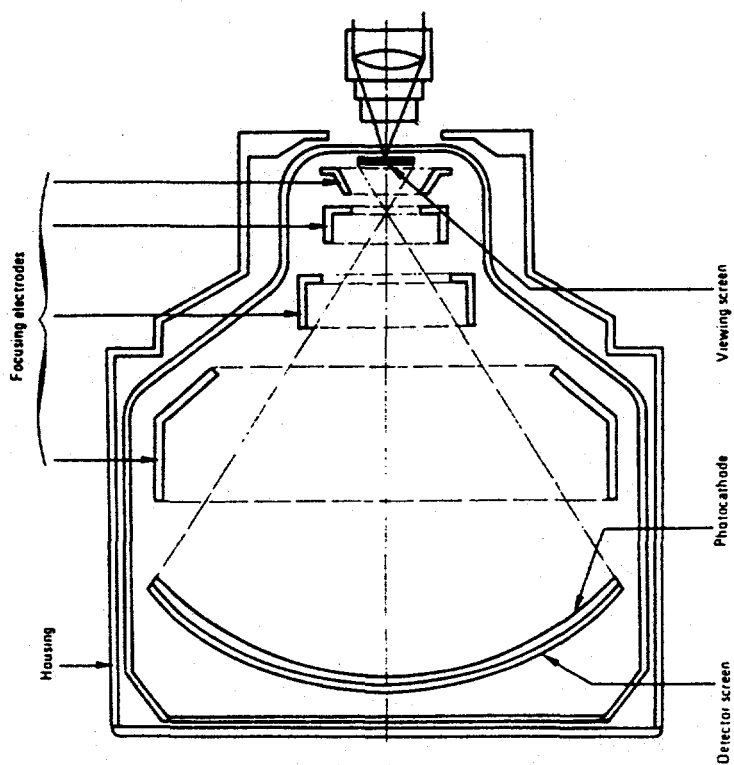
†† typical coupling to CCD adjustable by lens aperture and/or attenuating filters. Effective maximum count rate is set by dynamic range and readout time.

* area CCD operates as 1D sensor with 1 to 10 lines exposed, and fast analog signal buffer. Deadreadout time is limited by phosphor lag (1ms to 1E-3 of initial response), line transfer time and/or frame readout time. Last revision 3 Feb/94



EUROPEAN SYNCHROTRON RADIATION FACILITY
BP 220
F - 38043 GRENOBLE CEDEX
FRANCE

X RAY IMAGE INTENSIFIER





ESRF

COLUMNAR GROWTH OF SCINTILLATORS

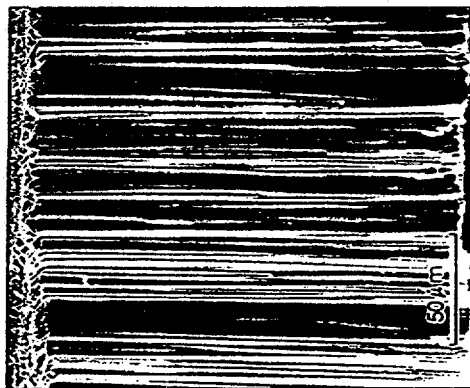


PHOTO: Electron Microscope
Photograph (x 320) of CsI
Input Phosphor Screen

	Be XR11, P20	Be XR11, P46	Standard 9"	Standard 9"	Standard 12"	Standard 12"
Energy range	5-25 keV	5-25 keV	20-80 keV	20-80 keV	20-80 keV	20-80 keV
useful input size	Ø200 mm	Ø200 mm	Ø200 mm	Ø200 mm	Ø270 mm	Ø270 mm
MTF @ 1.5 lp/mm	0.58	0.50 **	0.50	0.45 **	0.37 *	
MTF @ 4 lp/mm	0.10	0.08 **	0.06	0.04 **	0.02 *	
Ø of PSF @ 0.1%	1 mm	1 mm **	1.2 mm	1.4 mm **	1.5 mm **	
sensitivity (F/2 lens, CCD)	25 eV/el.	100 eV/el.	25 eV/el.	100 eV/el.	25 eV/el.	100 eV/el.
DQE	65% @ 10 keV	65% @ 10 keV	65% @ 40 keV*	65% @ 40 keV*	65% @ 40 keV*	65% @ 40 keV*
equiv. input dark signal	< 40 keV/s.cm ²	< 40 keV/s.cm ²	< 100 keV/s.cm ²	< 100 keV/s.cm ²	< 100 keV/s.cm ²	< 100 keV/s.cm ²
decay time to 10 %	< 1ms	< 10 µs	< 1ms	< 10 µs	< 1ms	< 10 µs
decay time to 0.1 %	500 ms	10 ms	500 ms	10 ms	500 ms	10 ms
integral distortion	< 4% *	< 4% *	< 4% *	< 4% *	< 8% *	< 8% *
recommended CCD camera	slow scan hi res fast moderate res	fast/ultra-fast	slow scan hi res fast moderate res	fast/ultra-fast	slow scan hi res fast moderate res	fast/ultra-fast
availability	mid 93	mid 93	off the shelf	custom	off the shelf	custom

All data result from measurements on real devices, except

* from THOMSON data sheet

** inferred from other measurements in different conditions; to be confirmed.

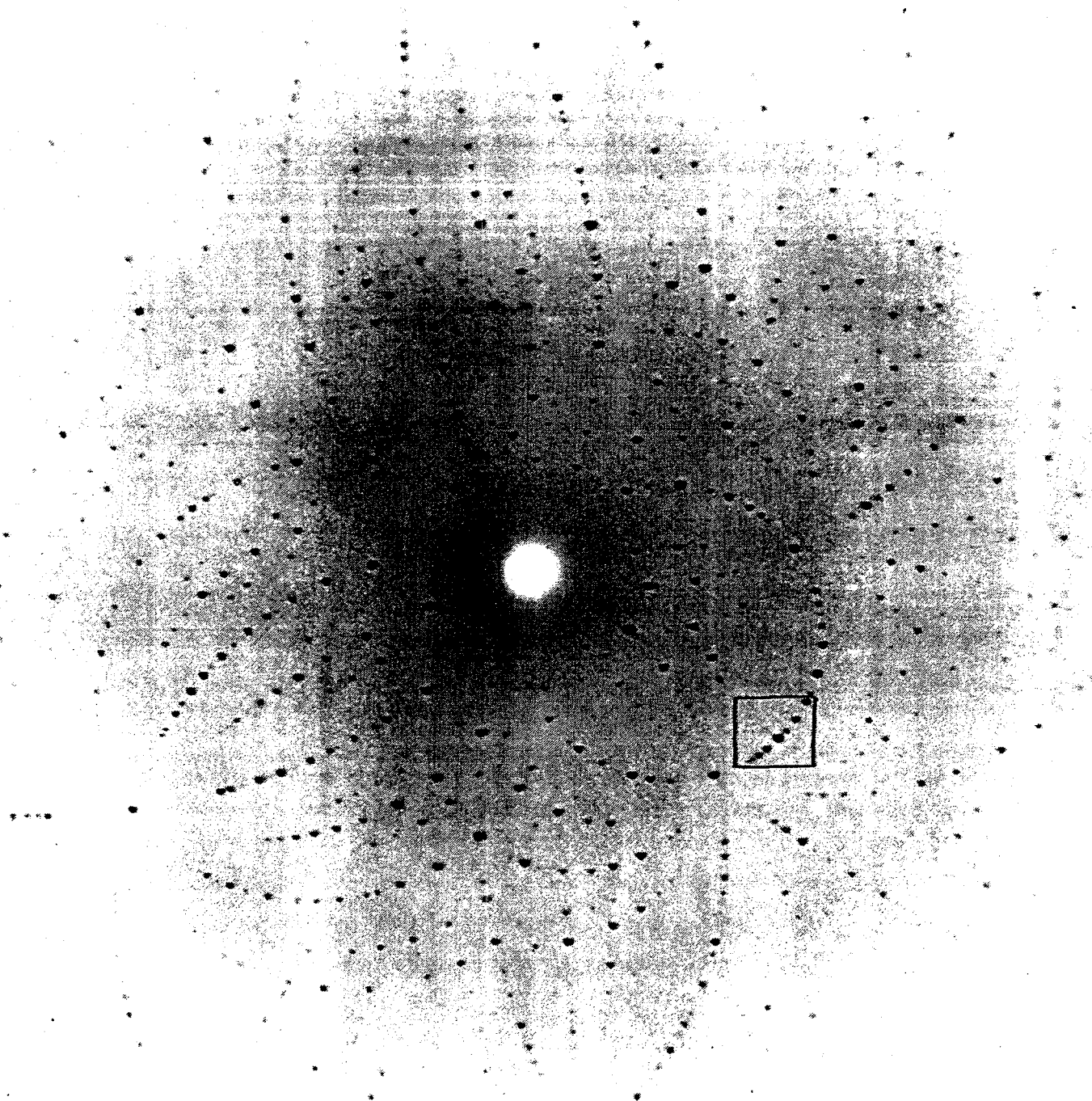
Table 1. Main characteristics of X-ray Image intensifiers to be used in the modular detectors

LAUE DIFFRACTION PATTERN OF A LYSOSYME CRYSTAL

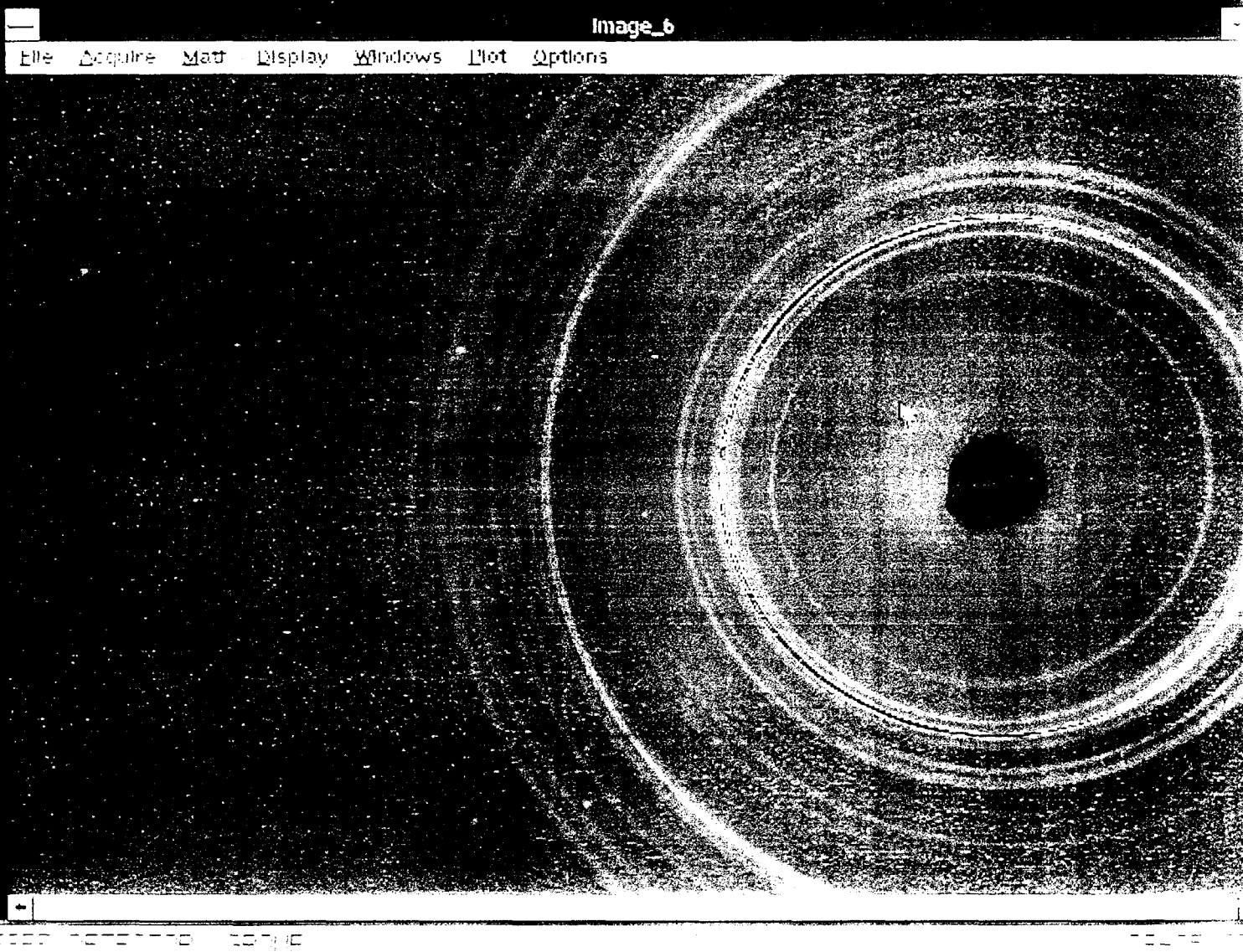
5x5 μm Beam from UNDULATOR, gap 50 mm

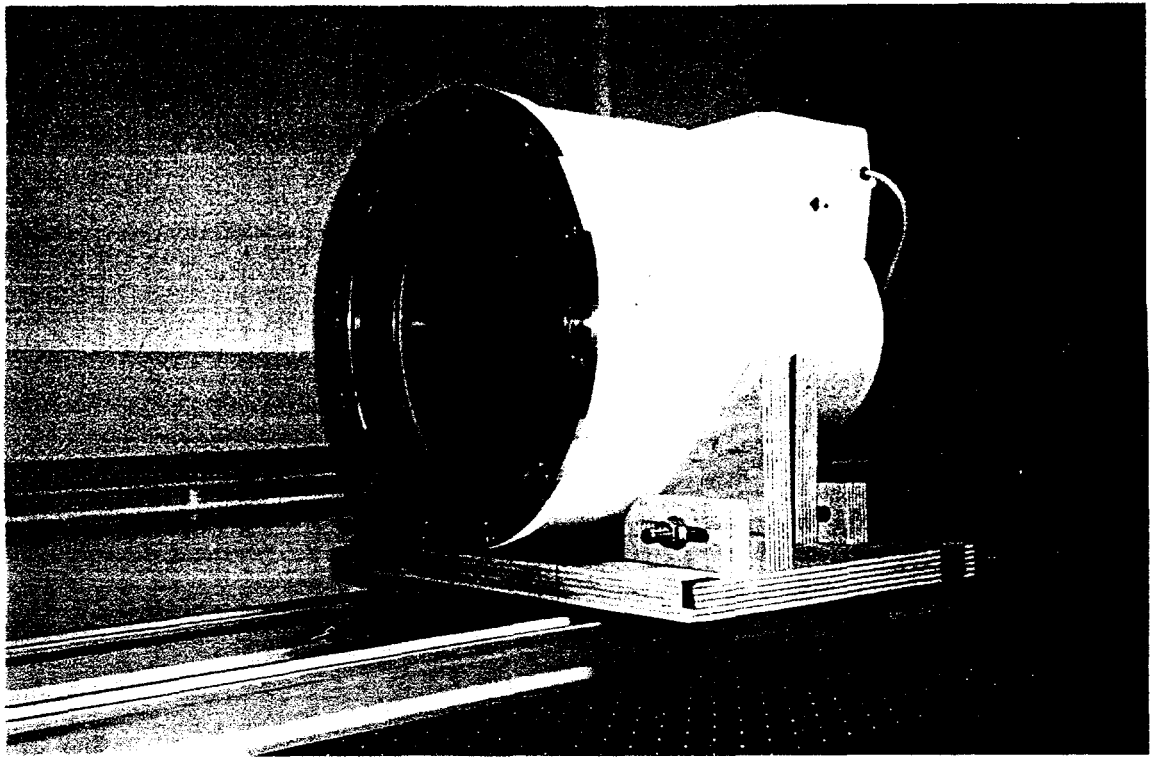
4 seconds exposure, Be XR11, full field, 1024^2 CCD

log scale, 16000:1 dynamic range

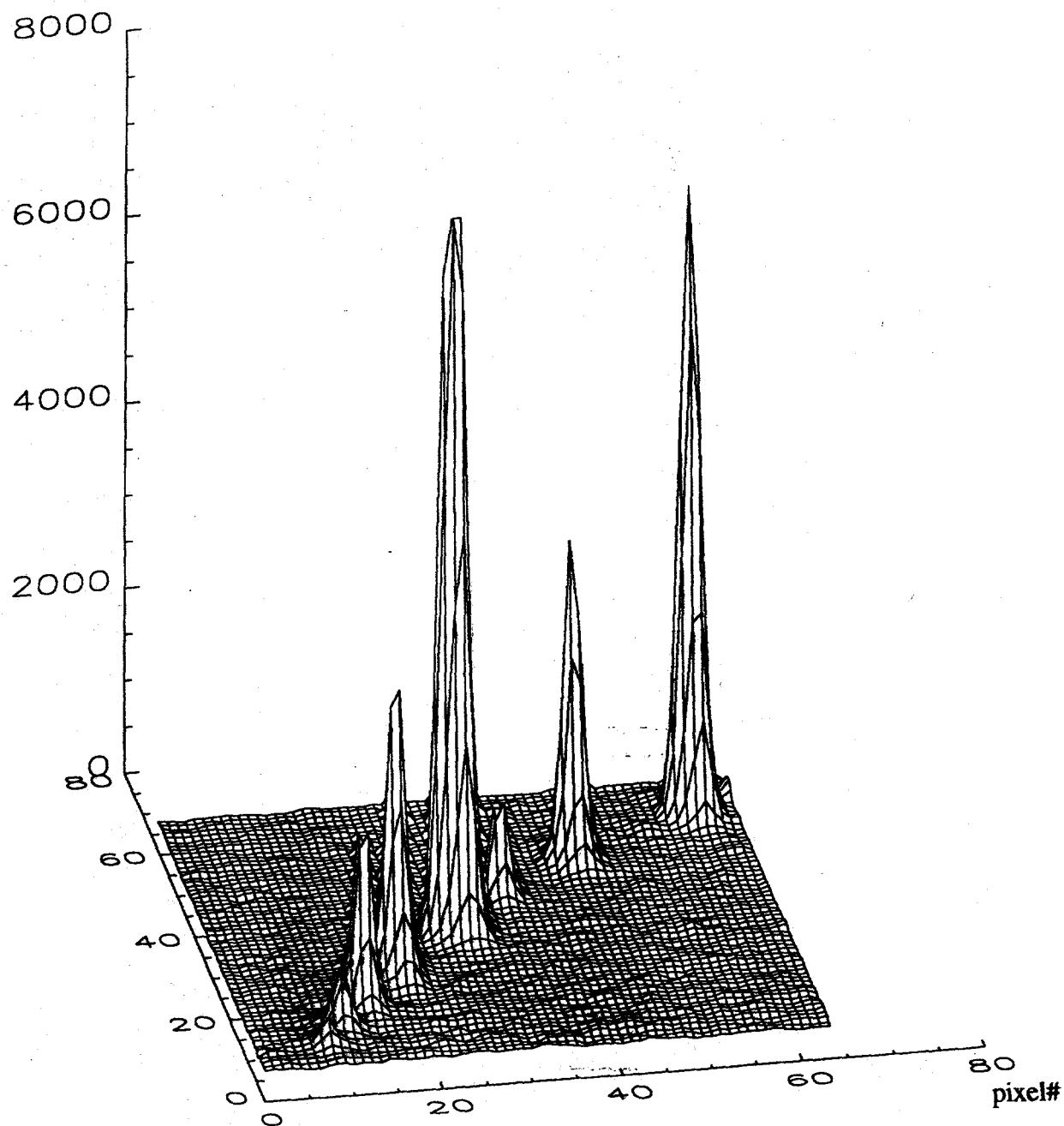


High Pressure 2002 18 keV Al Be tube 1024² CCD
5 min exp time





AD units (1count $\approx$ 100keV)



3-D plot of a 64 x 64 pixels region of the Laue diffraction pattern of a lysosyme crystal.

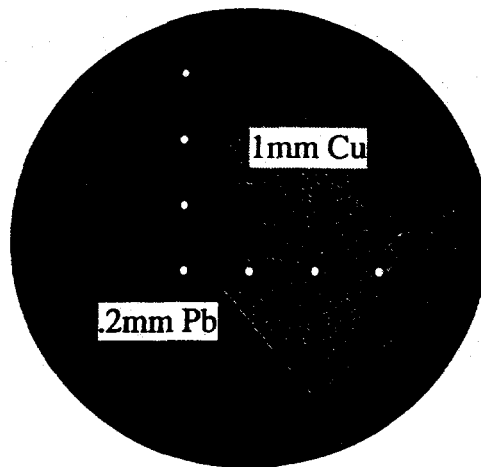
X-ray beam 5 x 5 μm , undulator gap 50 mm, exposure time 4 seconds.

detector: $\varnothing$ 220 mm Be XRII optically coupled to a 1024² cooled CCD camera (14 bit, 200 kpel/s).

BL3, dec 94

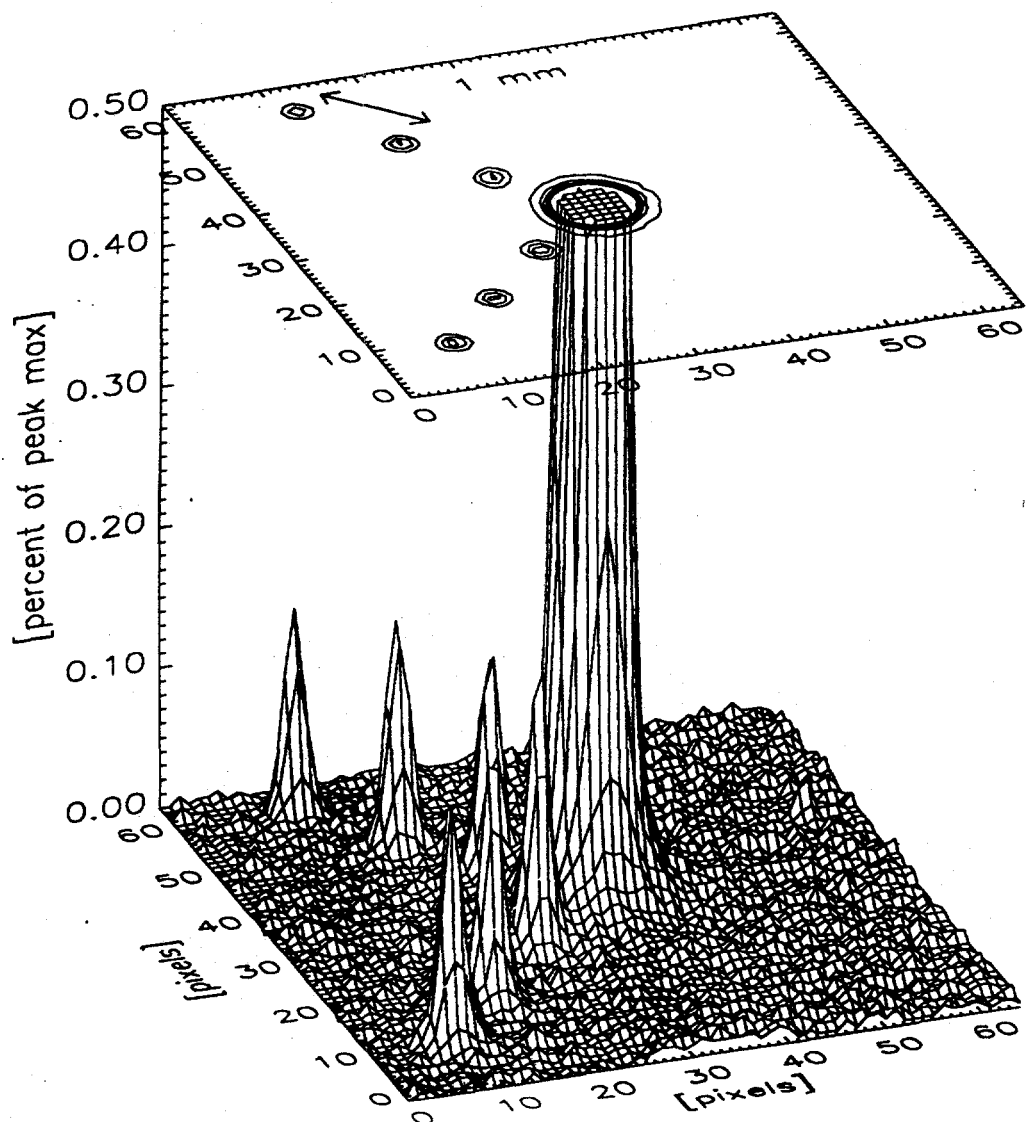
RESOLUTION / DYNAMIC RANGE TEST

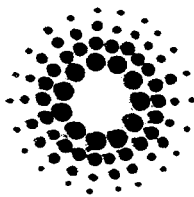
test pattern:



7 $\varnothing$ 150 μ m pinholes
in 200 μ m Pb foil,
pitch: 1mm

Expanded 3D view from 0 to 0.5% of full scale.
central spot close to saturation, satellite spots $\approx$ 1/1000 of saturation
contours at 0.15%, 0.10%, 0.05 %



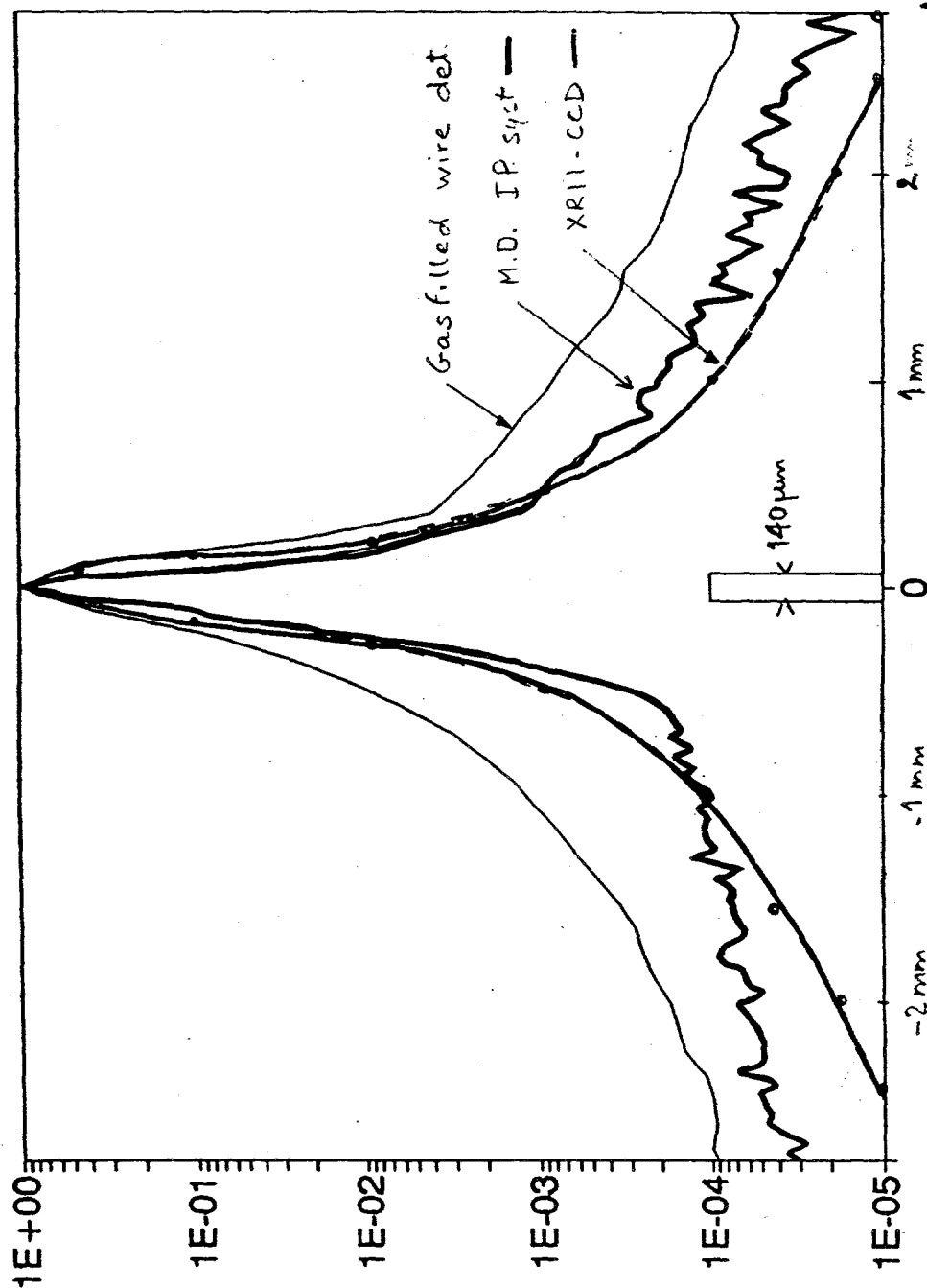


EUROPEAN SYNCHROTRON RADIATION FACILITY

BP 220

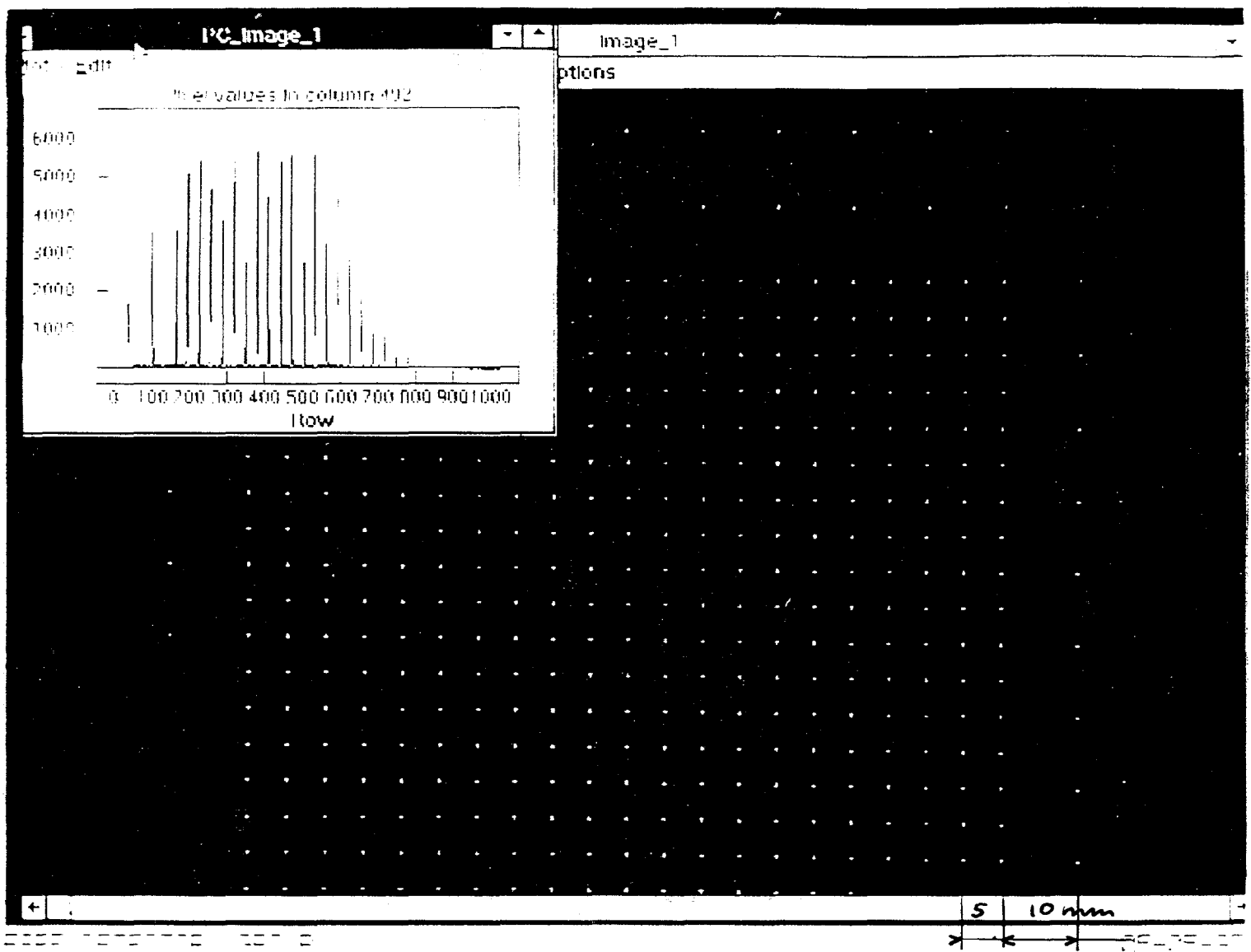
F - 38043 GRENOBLE CEDEX

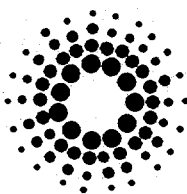
COMPARED PSFs



After Ne^+ zomb...

DISTORTION FIELD





EUROPEAN SYNCHROTRON RADIATION FACILITY

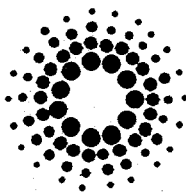
BP 220

F - 38043 GRENOBLE CEDEX

FRANCE

MAIN DRAWBACKS OF THE XRII

- Convex input surface $\Rightarrow$ limited diffraction angle, $< \pm 15^\circ$,
distortion depending on sample position
- Sensitivity to magnetic field $\Rightarrow$ careful shielding required
- Non-uniformity of response $\Rightarrow$ flat field correction mandatory
(depending on sample position)
- CsI input $\Rightarrow$ 33 and 36 keV edges.
Gd based input available, but dramatic loss in resolution



EUROPEAN SYNCHROTRON RADIATION FACILITY
BP 220
F - 38043 GRENOBLE CEDEX
FRANCE

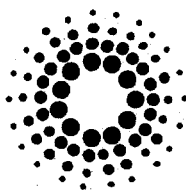
TIME RESPONSE

Governed by the CsI:Na input phosphor,
the P20 (slow, high resolution)
or P46 (fast, lower resolution) output phosphor

Typically, after a steplike excitation, fall time down to :

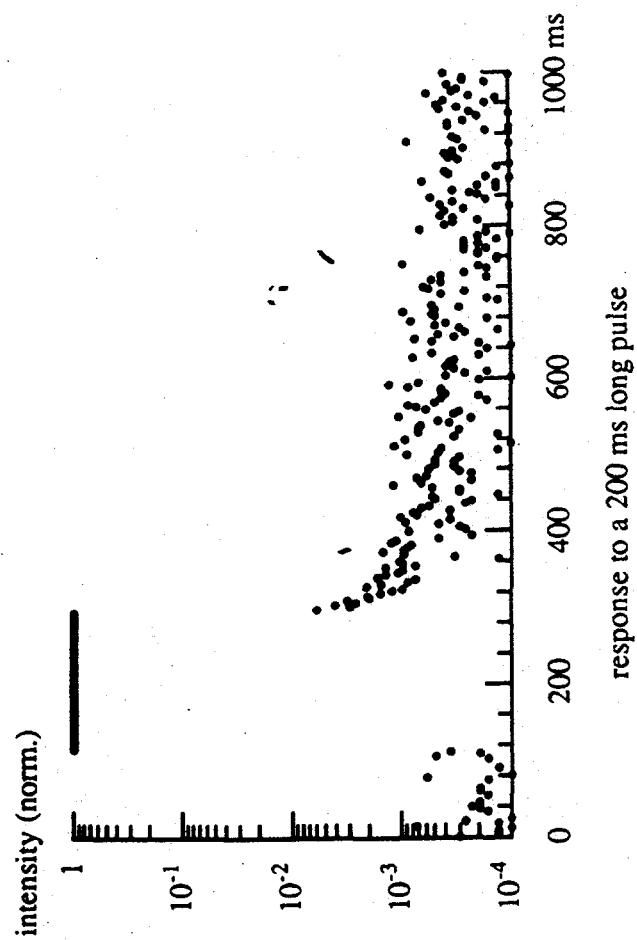
	10 %	0.1 %
with P20	< 1 ms	500 ms
with P46	< 10 μ s	10 ms

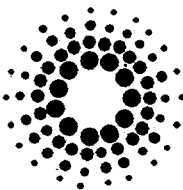
The P46 phosphor allows virtually lag free imaging even up to several thousand frames per second.



EUROPEAN SYNCHROTRON RADIATION FACILITY
BP 220
F - 38043 GRENOBLE CEDEX
FRANCE

FAST XRII TIME RESPONSE





EUROPEAN SYNCHROTRON RADIATION FACILITY
BP 220
F - 38043 GRENOBLE CEDEX
FRANCE

SENSITIVITY , NOISE

Sensitivity is best expressed in number of electrons created in the CCD per input X-ray energy. It is essentially dependent on the optical coupling between the output screen and the CCD.

measured value : 170 electrons / keV
for $F/D = 1$
DQE $\approx 65\%$ @ 10keV

The noise consists of a strongly non gaussian but very weak background and hot spots mainly due to cosmic rays and natural radioactivity:

background: 20-40 keV / s.cm² (input)

for short exposures ($\approx$ seconds), the CCD readout noise is dominant.

Scintillant Screen-CCD cameras (A Koch)

Advantages:

Flexibility of the system, scintillant screen may be easily exchanged:

- efficiency vs. time response
- efficiency vs. spatial resolution
- absorption edges

No image intensifier gain stage:

- source of additional noise removed
- simple absorption corrections (flat detection surface)
- rigorous image stability and simple geometric corrections, insensitive to B fields

21

High radiation tolerance possible

- tests on ID11 wiggler white beam to $>100\text{Mrads}$

Disadvantages:

Limited size of detector

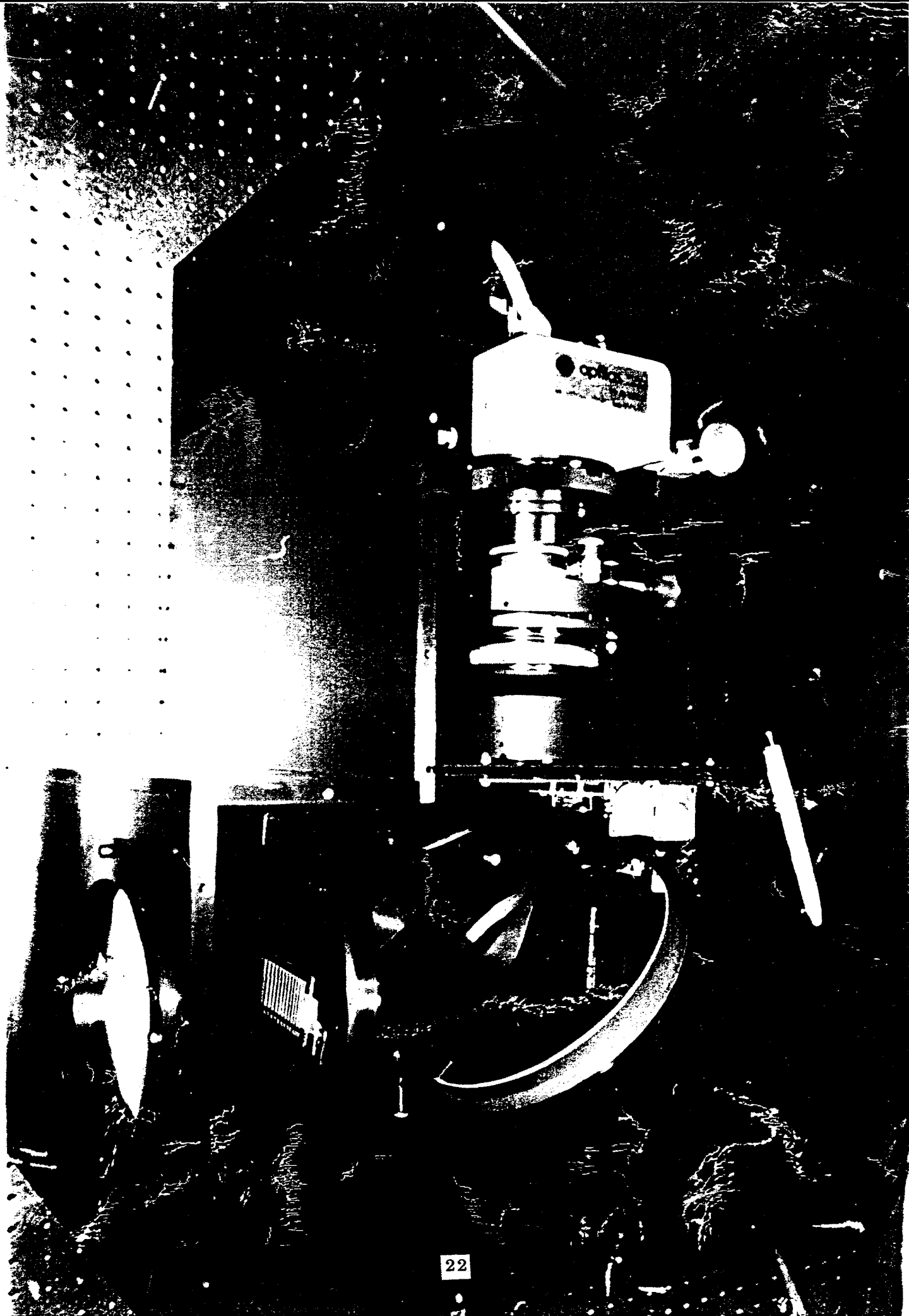
- light collection efficiency $\sim (\text{demagnification})^{-2} \Rightarrow$ practical size limit $\sim 100\text{cm}^2$
e.g. for 10% efficient scintillator, CCD sensor at demagnification of 4,
sensitivity $\approx 10\text{keV/electron}$, field of view 80mm

Readout time ≈ 10 seconds for 1000×1000 pixels at low noise ($\approx 5\text{electron/pixel}$)

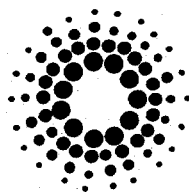
Prospects:

Applications: μ focus beamline, DEXAFS, topography & microtomography (to $1\mu\text{m}$)
radiation hard, online beam-profile monitors

structured (non isotropic) fabrication methods, low temperature scintillators

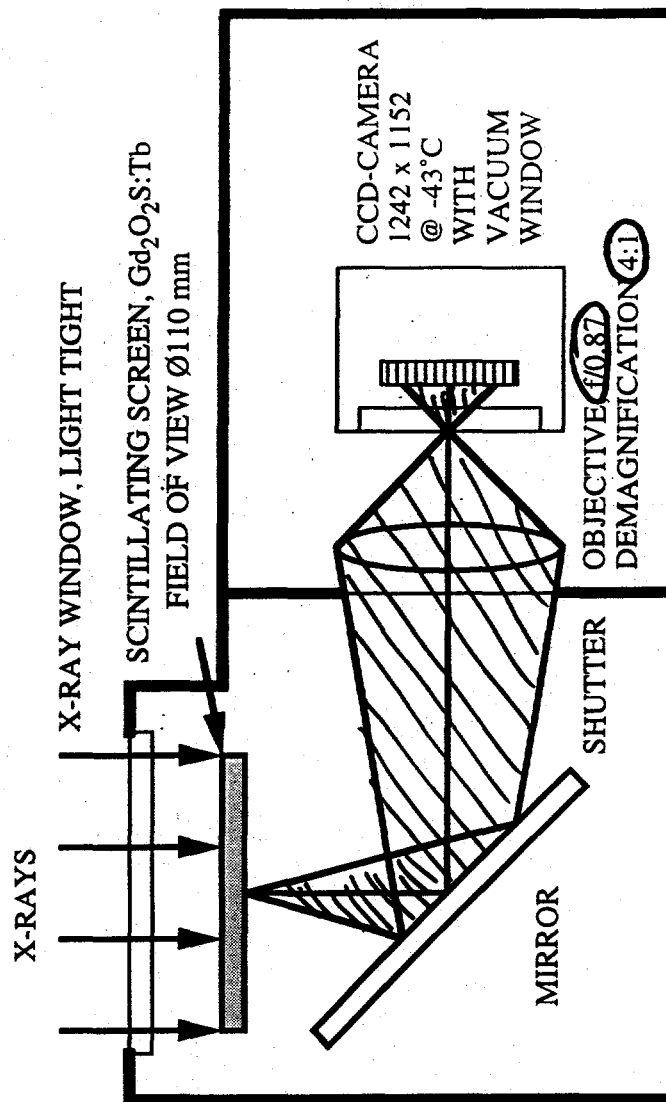


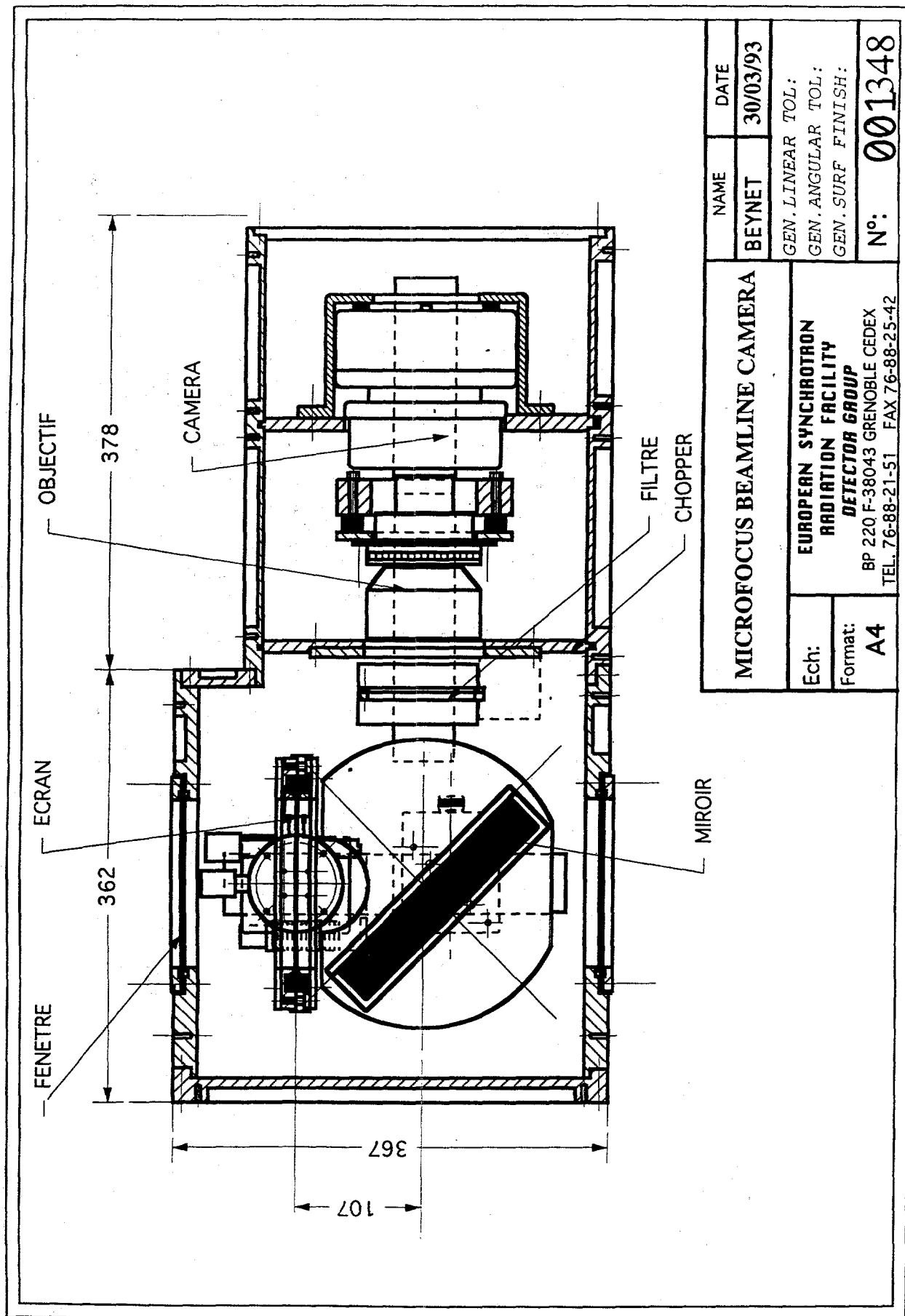
For Microfocus Beamline



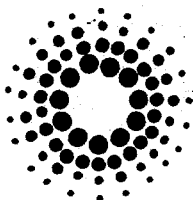
ESRF

DETECTOR DESIGN



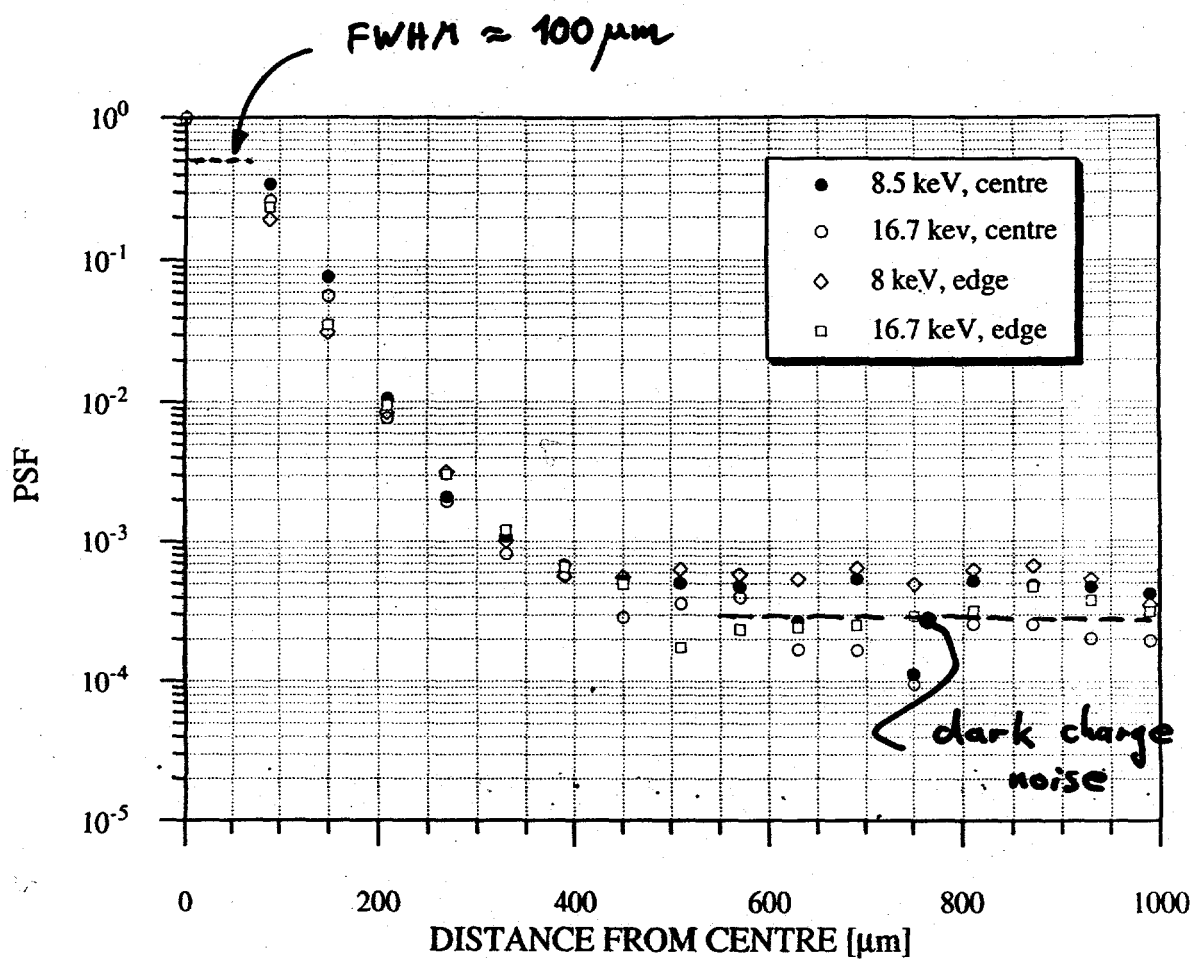


MICROFOCUS BEAMLINE CAMERA		NAME		DATE
		BEYNET		30/03/93
Ech:	GEN. LINEAR TOL:			
	GEN. ANGULAR TOL:			
	GEN. SURF FINISH:			
Format:	EUROPEAN SYNCHROTRON RADIATION FACILITY DETECTOR GROUP		N°: 001348	
A4	BP 220 F-38043 GRENOBLE CEDEX TEL. 76-88-21-51 FAX 76-88-25-42			

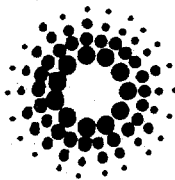


ESRF

POINT SPREAD FUNCTION OF THE DETECTOR



- no difference for tangential and sagittal PSF & MTF



ESRF

PERFORMANCE OF THE DETECTOR

(*pin focus camera*)

energy range, optimized:

10 keV - 20 keV

DQE:

≈ 30% (10 keV - 20 keV) @ integrated intensity > 1×10^5 eV/mm²/readout

equivalent input dark signal:

9×10^4 eV/mm²/s

dynamic range:

10^4

sensitivity:

15 keV/e⁻

field of view:

Ø 110 mm

spatial resolution:

PSF @ FWHM: 100 µm, @ FW1%: 400 µm, @ FW0.1%: 650 µm

distortion-integral:

MTF @ 3 lp/mm: 50%

- differential:

0.4%

pixel response non-uniformity:

1.5%, corrected by flatfielding

vignetting:

30%

readout time:

1 image/8s

further potential improvements:

- red emitting phosphor
- structured screens
- lower temperature at CCD
- other deposition technique

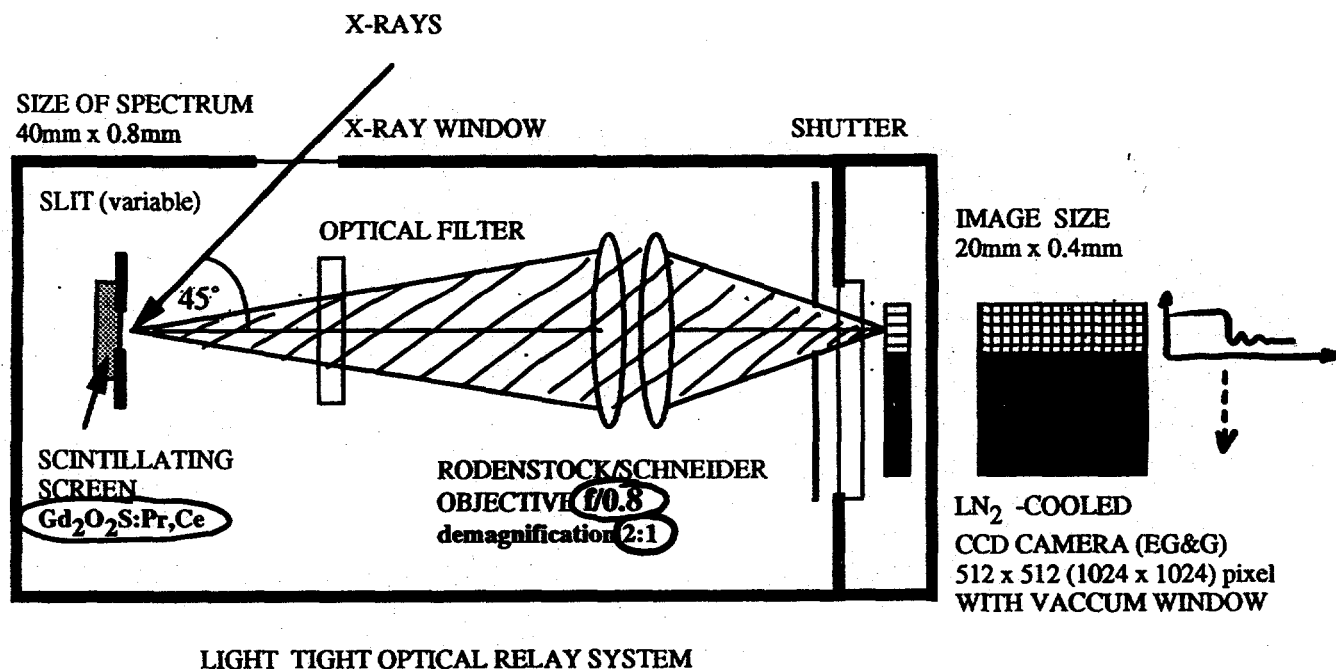
-----> better matched to quantum efficiency of CCD, higher DQE

-----> better spatial resolution at higher energies

-----> lower dark charge, longer exposure times

-----> higher density, better spatial resolution

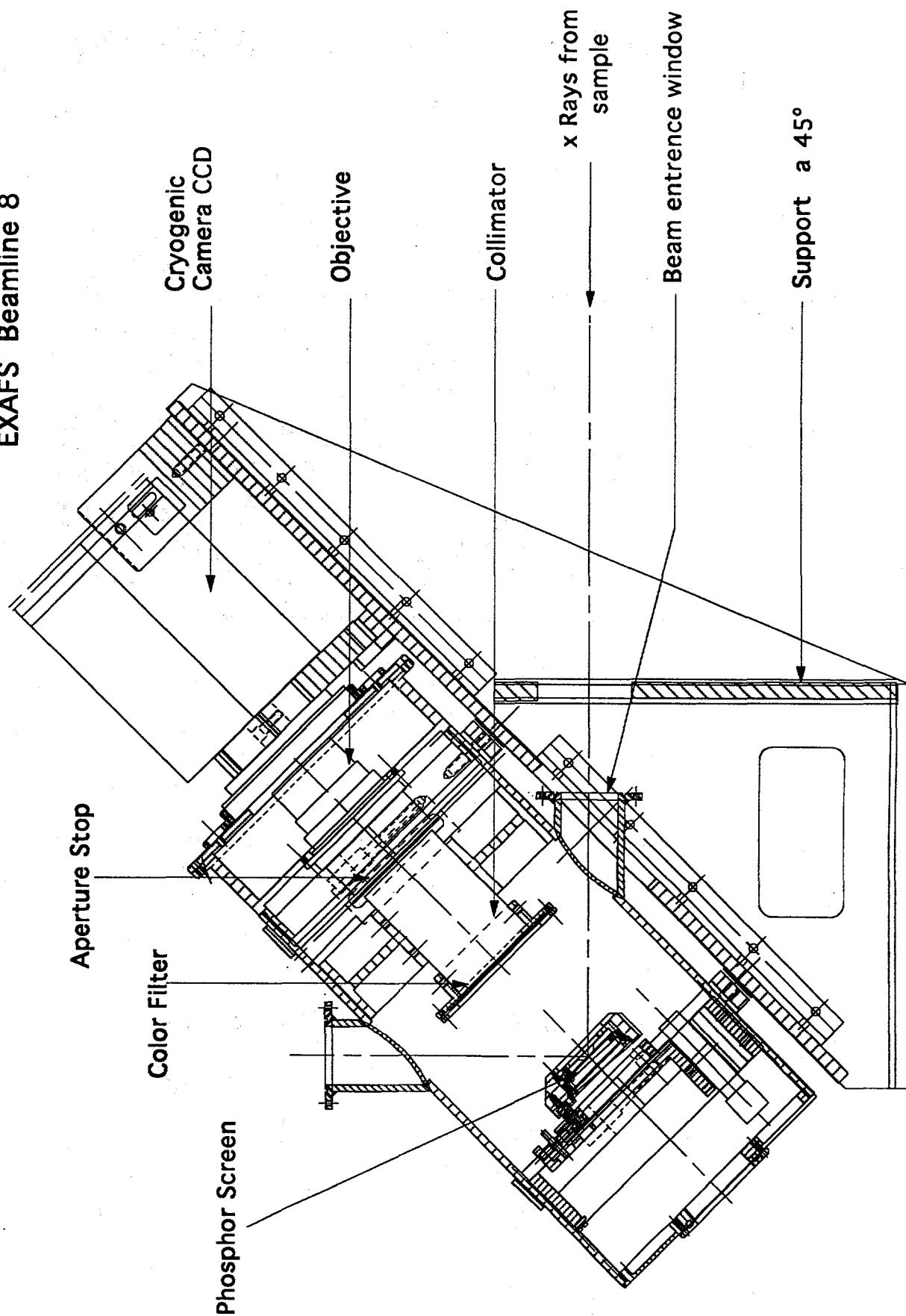
CAMERA FOR DISPERSIVE EXAFS BEAMLINE



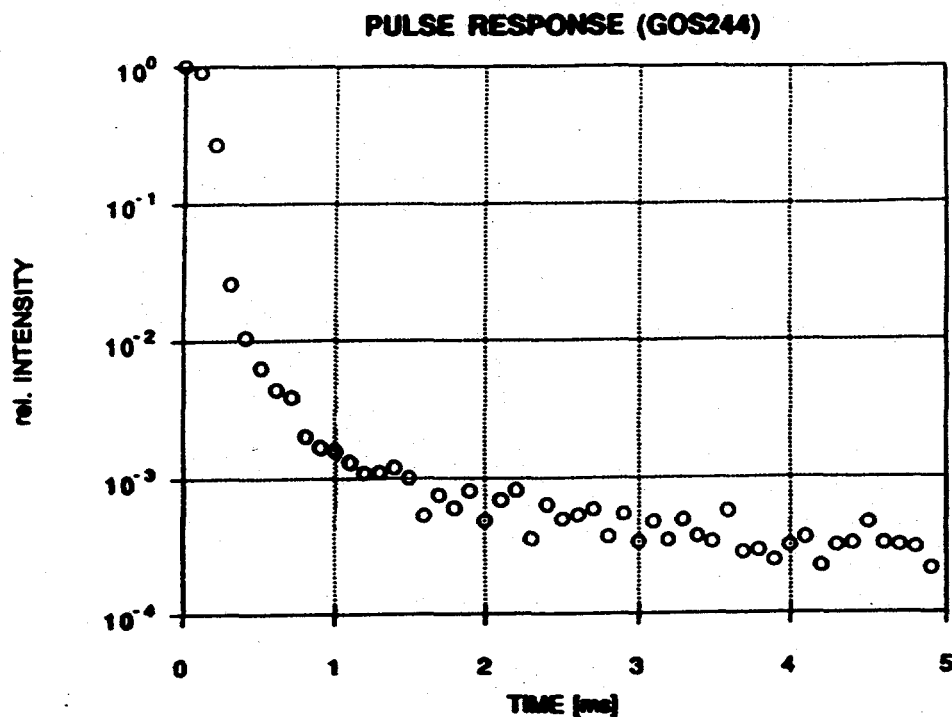
essential characteristics:

- fast relay optics
- efficient phosphor
- fast luminescent decay of phosphor (--> high dynamic range)
- high spatial resolution of phosphor (--> high dynamic range)

Detector for Energy Dispersive EXAFS Beamline 8



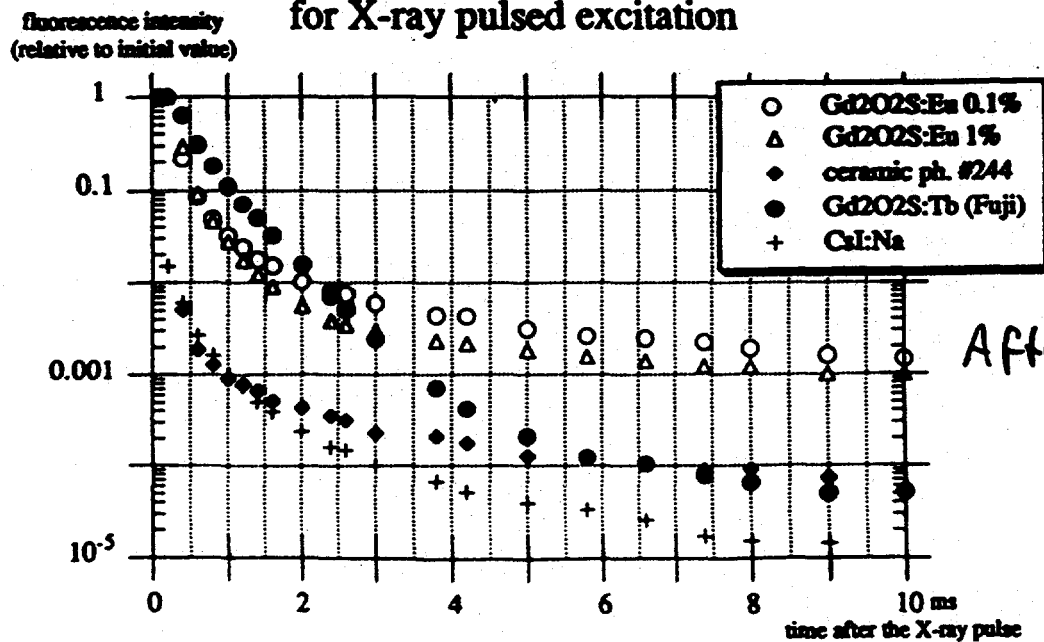
TIME RESPONSE OF PHOSPHOR



$\Delta t = 100 \mu s$

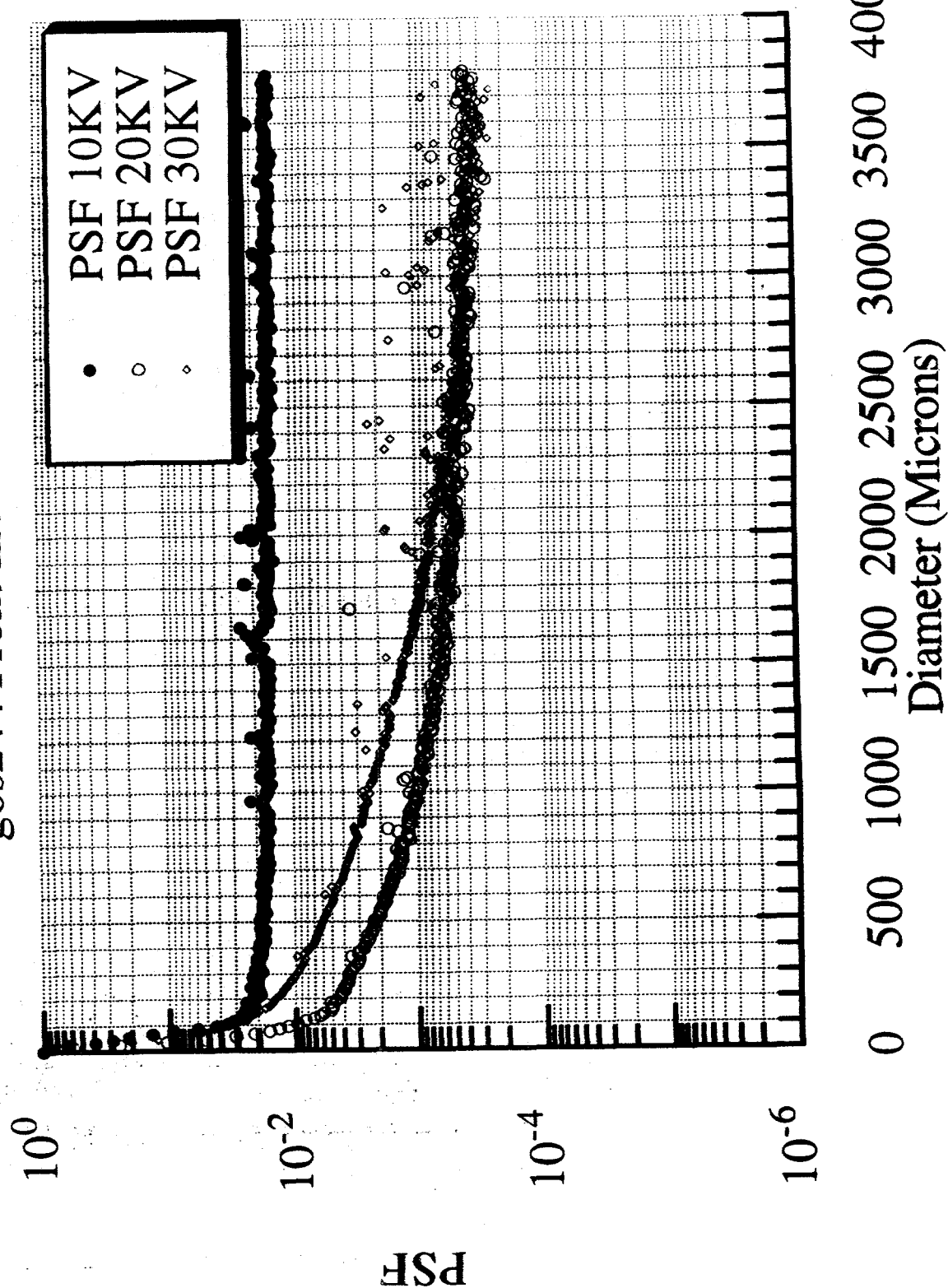
$FWHM < 100 \mu s$

**Fluorescence decay of some fast phosphors
for X-ray pulsed excitation**



After glow

gos244 Front Illumination PSF

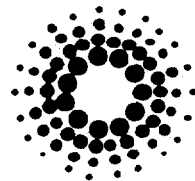


EXPECTED PERFORMANCE OF THE DETECTOR

- SUMMARY

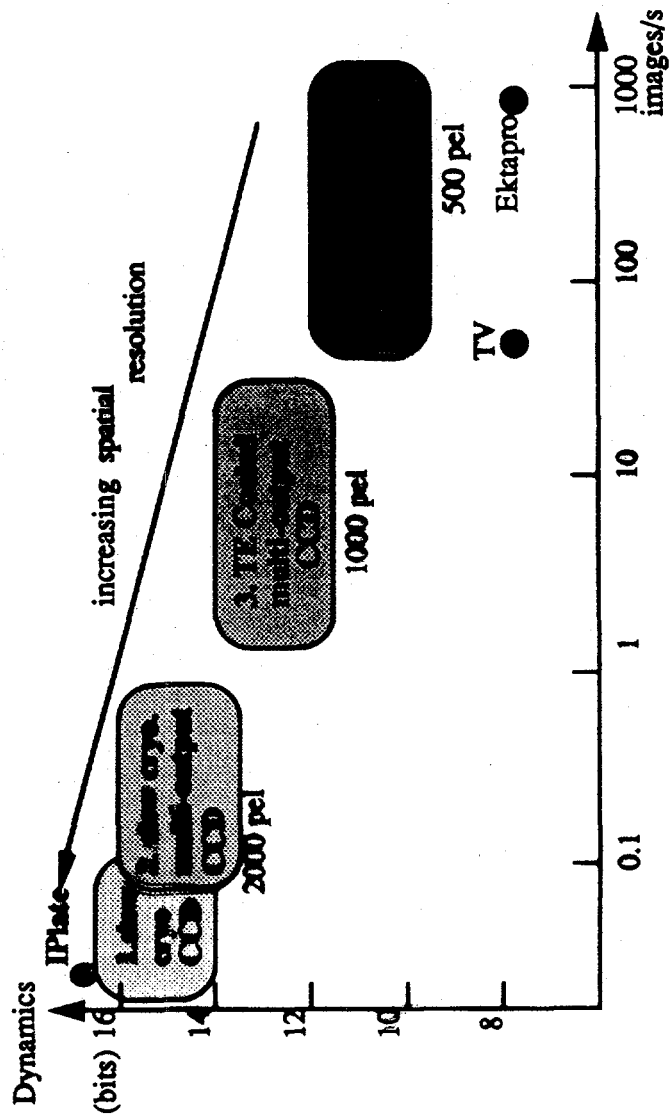
energy range, optimized:	5 keV -30 keV
DQE:	$\approx 50\%$ (10 keV - 30 keV) @ integrated intensity $> 6 \times 10^5$ eV/pixel/readout
equivalent input dark signal:	20 eV/pixel/s
dynamic range:	10^4
sensitivity:	6 keV/e ⁻
field of view:	Ø40 mm
spatial resolution:	PSF @ FWHM: 40-50 μm MTF @ 12 lp/mm: 50%
distortion-integral:	0.2%
pixel response non-uniformity:	2%, to be corrected by flatfielding
vignetting:	30%
readout time:	1 image/5s

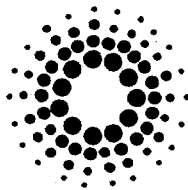
(1 pixel = 40 μm x 40 μm)



ESRF

CCD CAMERAS FOR X-RAY IMAGING





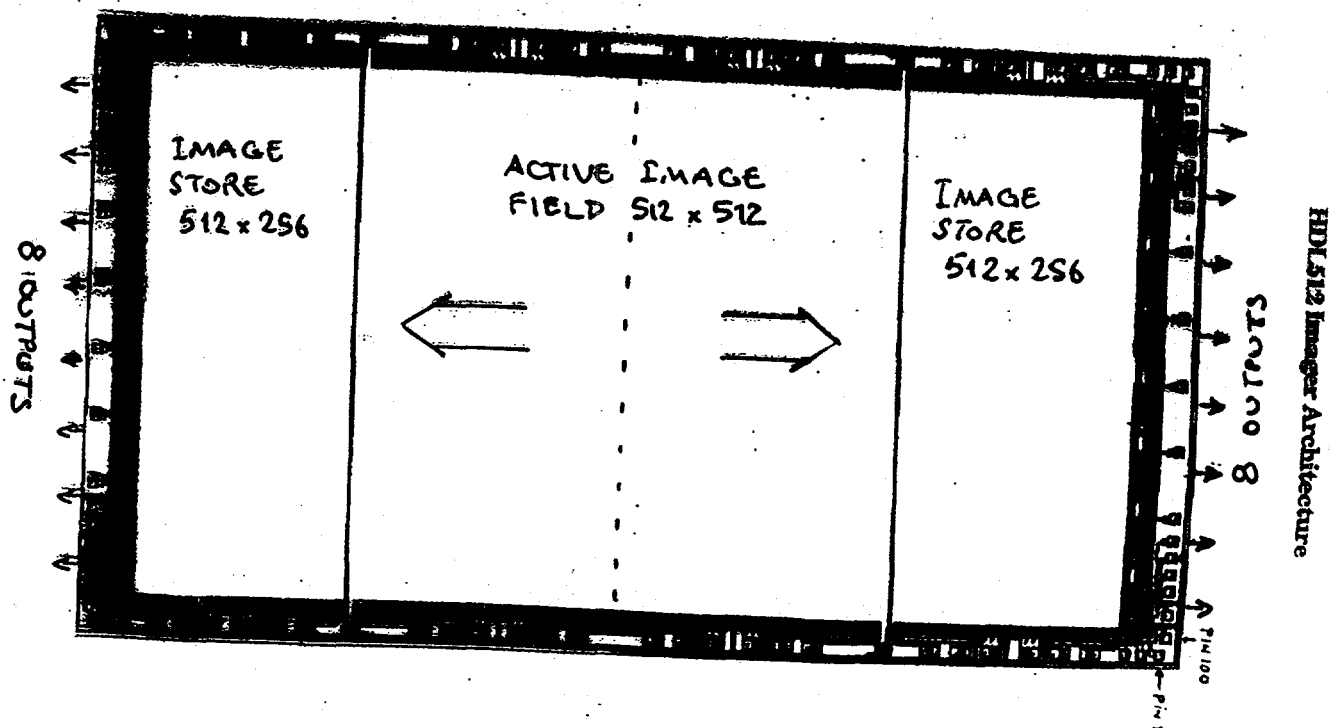
ESRF

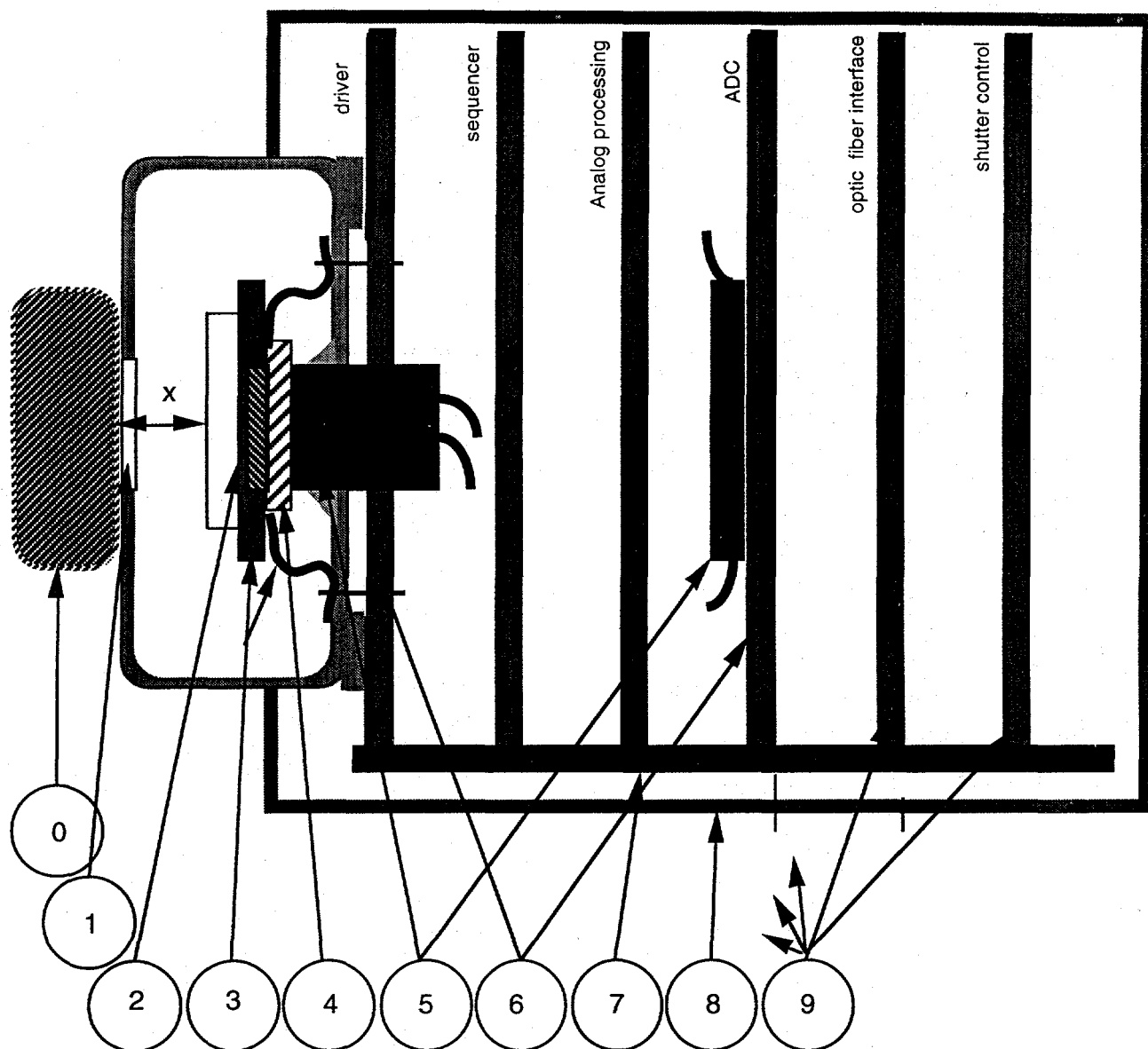
Fast CCD Readout Projects

- 'Family 3' Thomson TH7896A
 - 4 output channels, 1024^2 full frame
 - 14 bit encoding/ $0.4\mu\text{s}/\text{pixel}$ --> 10 frames/sec
- 'Family 4' Sarnoff VCCD512H
 - 16 output channels, 512^2 frame transfer
 - 10 bit encoding/ $0.1\mu\text{s}/\text{pixel}$ --> 500 frames/sec
- Peltier-water cooled camera head, fibre-optic data transfer
- VXI : camera interface/controller and real-time monitor display
 - memory buffer 40 (400) Mbyte/sec update,
 - 256 (1024) Mbyte storage (32 bit address/data)

Sarnoff 512 x 512 16-Port CCD Imager Typical Specifications

Architecture:	512 x 512 Vertical frame transfer Back-side illumination	→ 1024 x 1024
Pixel Size:	18 x 18 μm	
Optical Fill Factor:	100%	
Quantum Efficiency:	400 nm, QE = 50% 600 nm, QE = 70% 700 nm, QE = 75% 800 nm, QE = 85%	
Output Ports:	16 output ports. Each port reads a subarray of 64(h) x 256(v) pixels	→ 32
Gamma:	1.0	
Frame Rate:	> 500 fps	
Dark Readout Noise:	30 rms electrons per pixel	} DYNAMIC RANGE ~ 8000 AT 2 msec readout
Full Well Signal:	140,000 electrons	
Dark Current:	250 pe/cm^2 at 28 °C	
On-chip Amplifier:	Floating diffusion with correlated double sampling	
Output Impedance:	500 Ω	
Sensitivity:	3 $\mu\text{V/electron}$ (C = 70 fF)	
Vertical Clock Rate:	2.5 MHz	
Horizontal Clock Rate:	> 10 MHz	

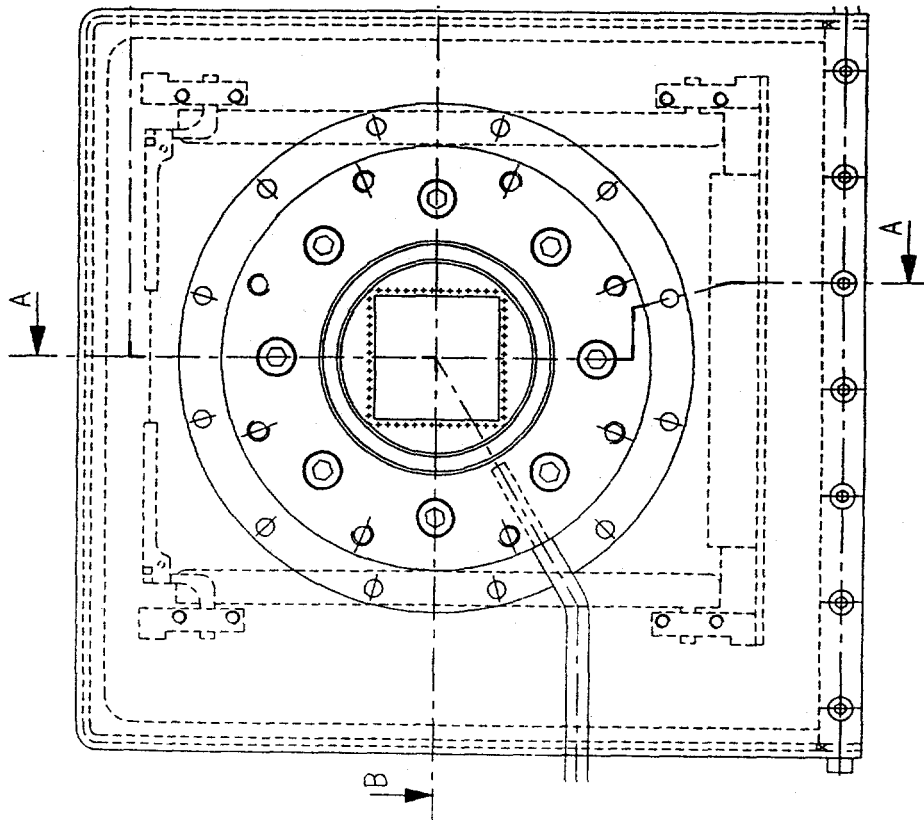
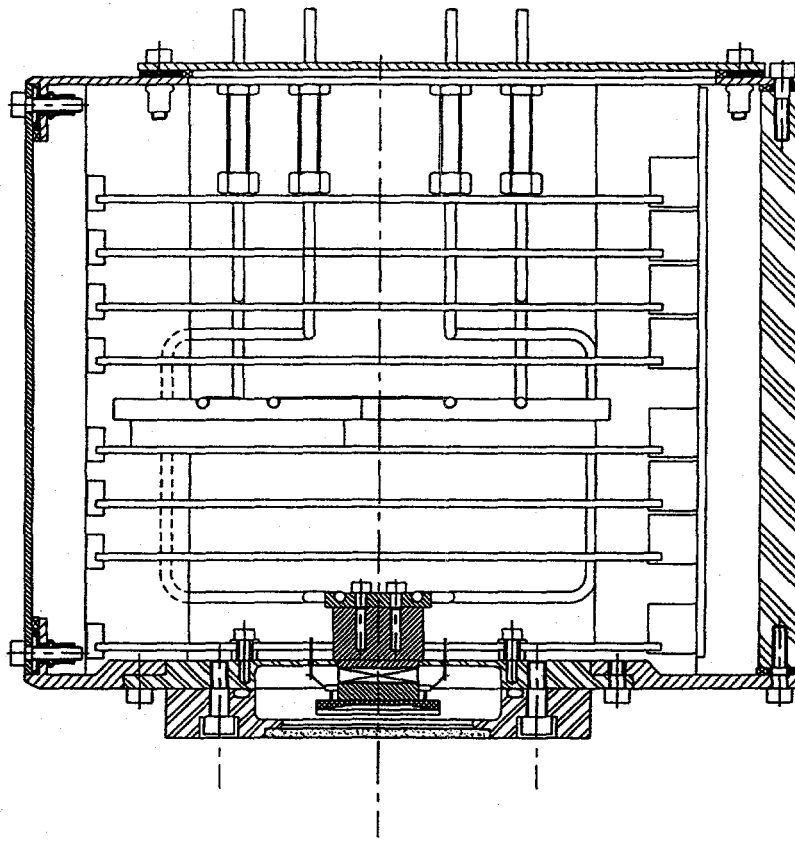




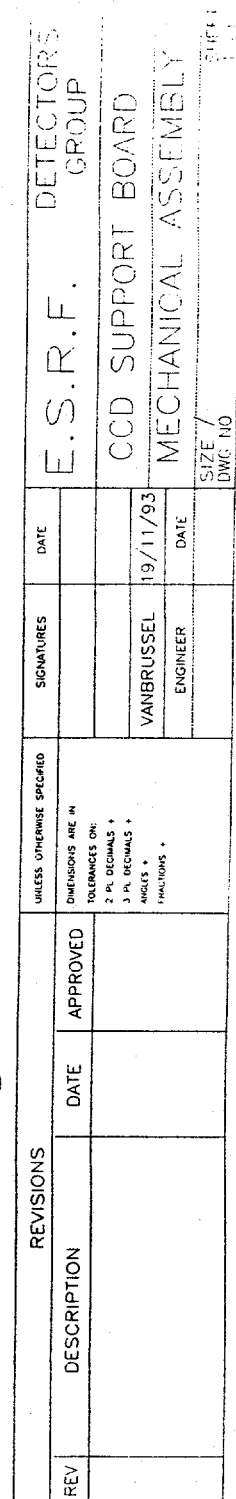
- 0 Ensemble optique. Fixé et alignable par rapport à la pièce 1
- 1 Chambre à vide ou à gaz inerte avec fenetre optique adaptable.
- 2 Plan du Capteur CCD. Pependicolarité à l'axe $< 10 \mu\text{radians}$
- 3 Circuit imprimé en capton. Distance $x < 10\text{mm}$ (à préciser)
- 4 Etage refroidisseur peltier
- 5 Echangeurs de chaleur à eau
- 6 2 circuits imprimés avec drain thermique
- 7 Circuit imprimé de fond de panier
- 8 Chassis-boitier démontable. Protection électromagnétique
- 9 6 cartes circuits imprimés

ARCHITECTURE DE LA TETE DE CAMERA F3

SECTION AA



- 1 = CCD INTERFACE BOARD
- 2 = LOWER FLANGE CD 307
- 3 = ALCATEL PIRANI SENSOR
- 4 = TH7896A CCD SENSOR
- 5 = WARM SUPPORT PIECE CD202
- 6 = AB31-1818 PELTIER COOLER
- 7 = COLD SUPPORT PIECE CD201
- 8 = BM12A RTD SENSOR
- 9 = CCD SOCKET BOARD



Germanium Multi-element Semiconductor Detectors

Advantages:

- reliable fabrication of 1 sided *monolithic* detectors (2 sided?)
- established readout electronics and software for development work
- energy resolution (1% at 25keV)
- high density, high Z (≈ 32 , Silicon Z = 14)
 - > wide energy range (300eV - 100 keV)
 - > high spatial resolution $\approx 100\mu\text{m}$ at 30keV

33

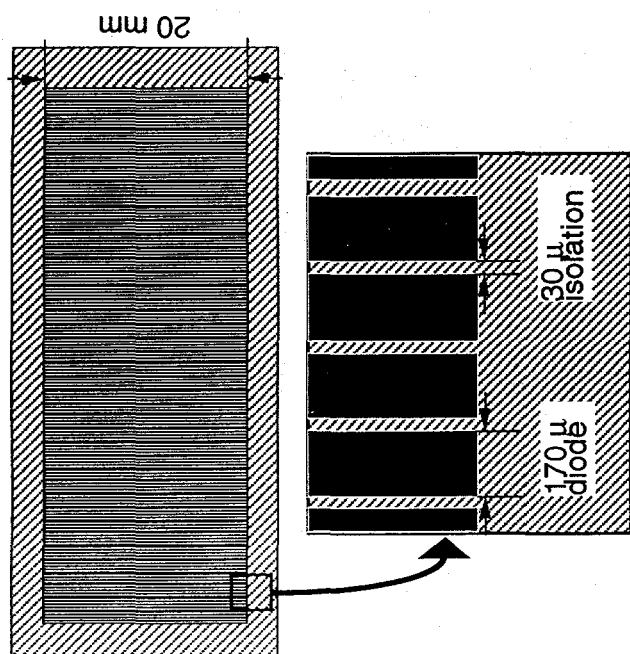
Disadvantages:

- per channel count rate limit imposed by signal shaping ($\sim \mu\text{sec}$)
- crosstalk between channels --> spatial & energy resolution degradation
- need to develop integrated readout electronics and software for multi-channel ($n > 30$) devices
- operation at $\approx 80^\circ \text{K}$ ($\Rightarrow$ liquid nitrogen cryostat)

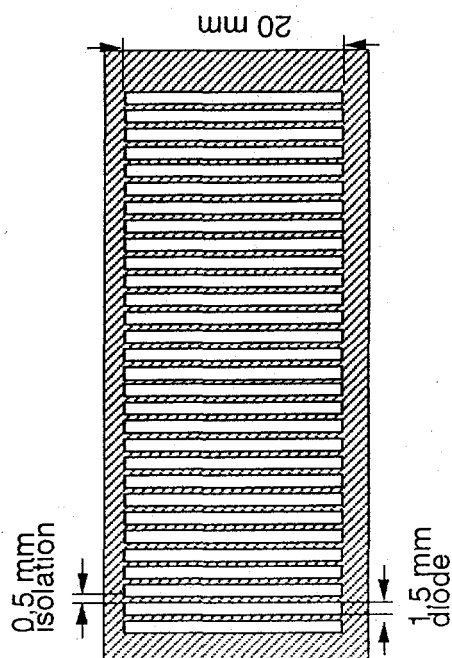
Prospects:

- large arrays ($\rightarrow 150\text{mm}$) using lithographic techniques and axially sliced boules
- integrated electronics within cryostat (eg preamplifiers, scalars, MUX...)
- alternative materials (CdZnTe for high energies, 'thick' Si $\rightarrow 2\text{mm}$)

Germanium Detectors: High energy Beamline 5



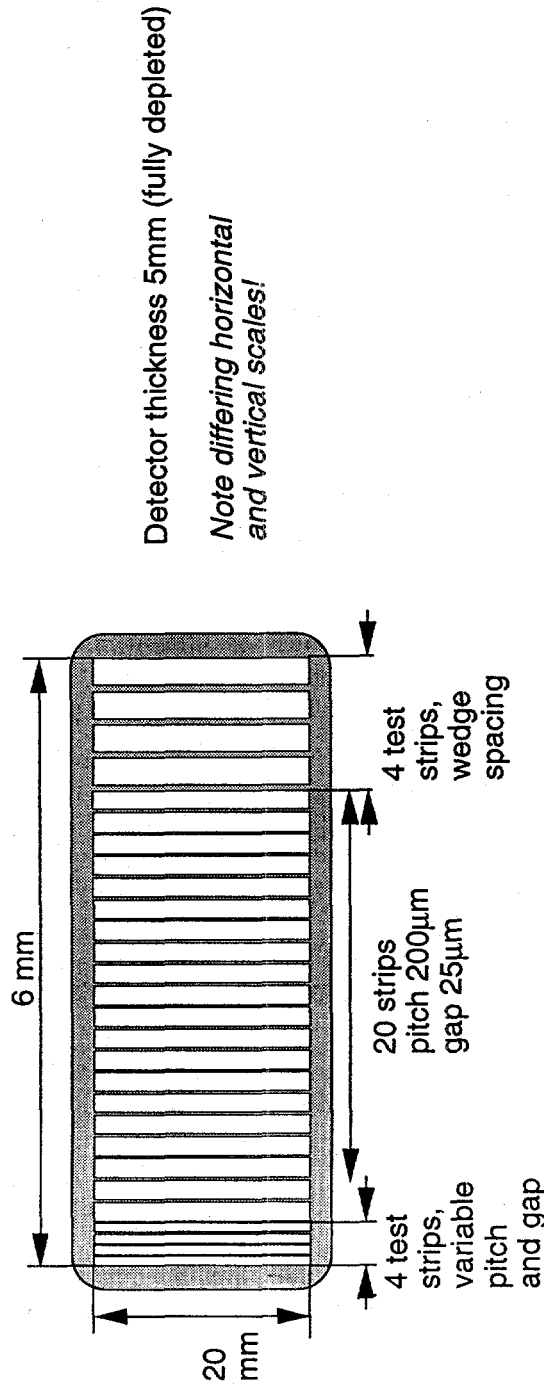
300 strip array,
 ≈ 1 keV @ 30keV,
 1kcps/element
 30 - 100 keV



30 element array,
 < 600 eV @ 150keV,
 50kcps/element
 30 - 150keV

Multi-element Test Detector Program

- 28 strip Germanium test detector and cryostat (Intertechnique)
- preliminary measurements of resolution, spectral tailing/crosstalk using standard NIM etc. electronics (from 1/94)

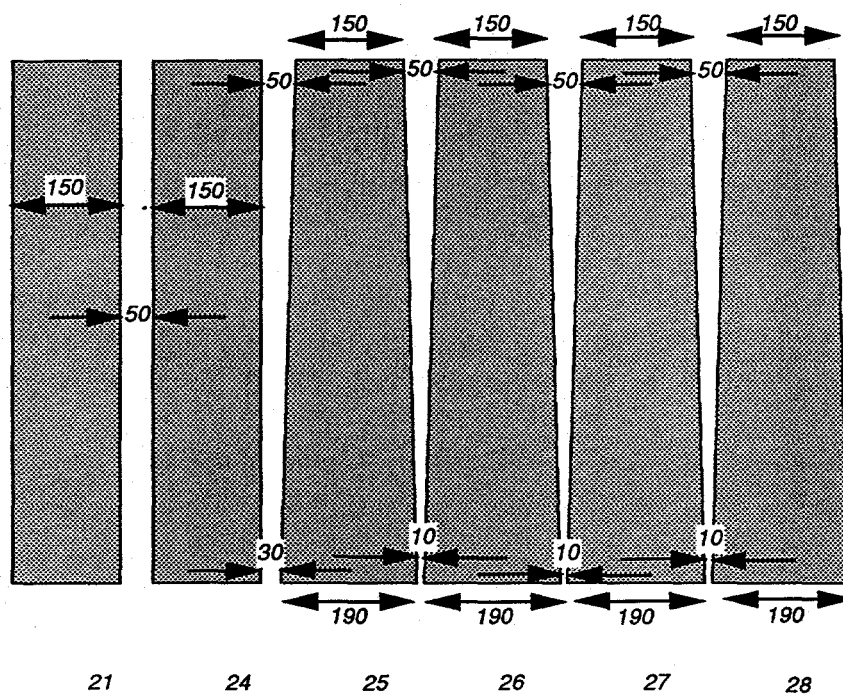
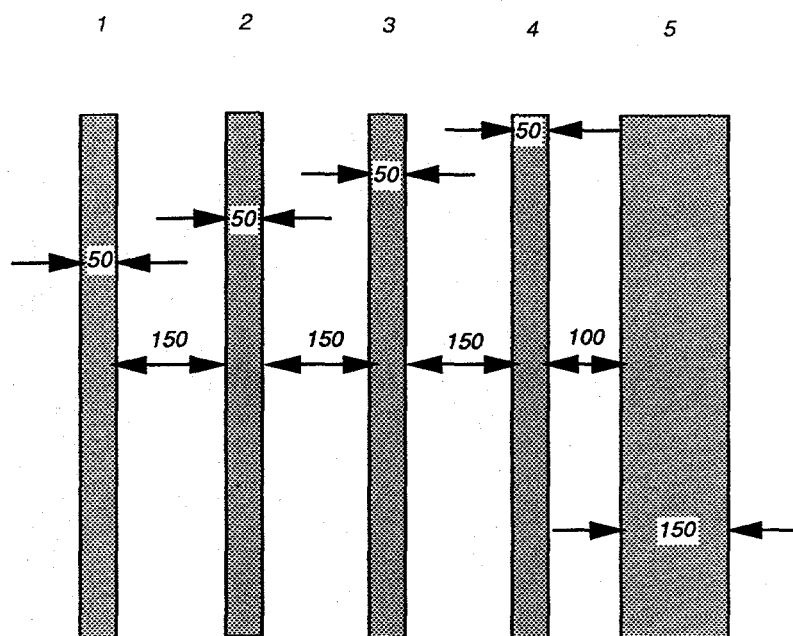


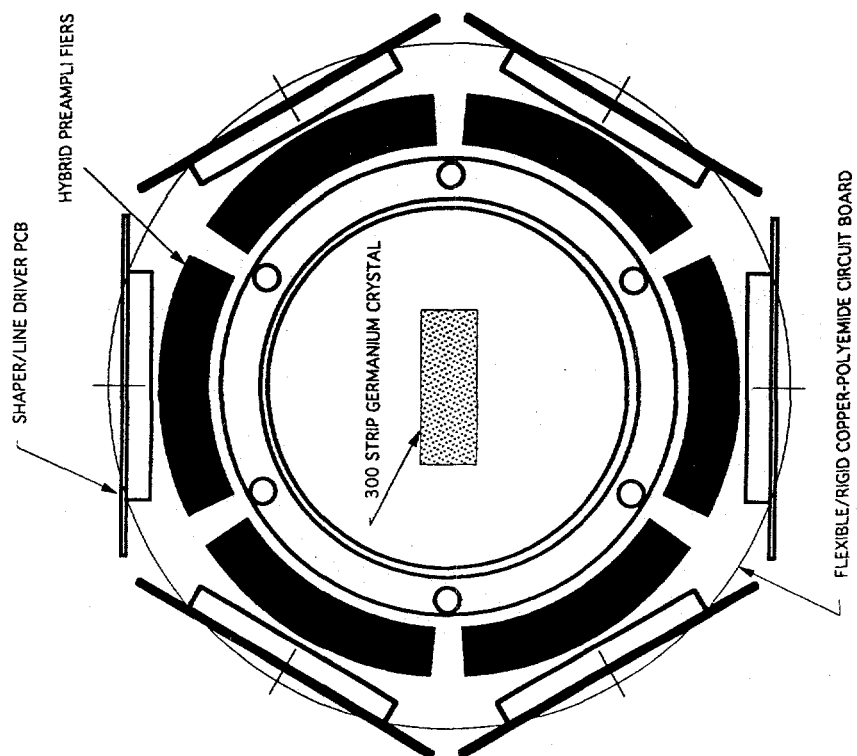
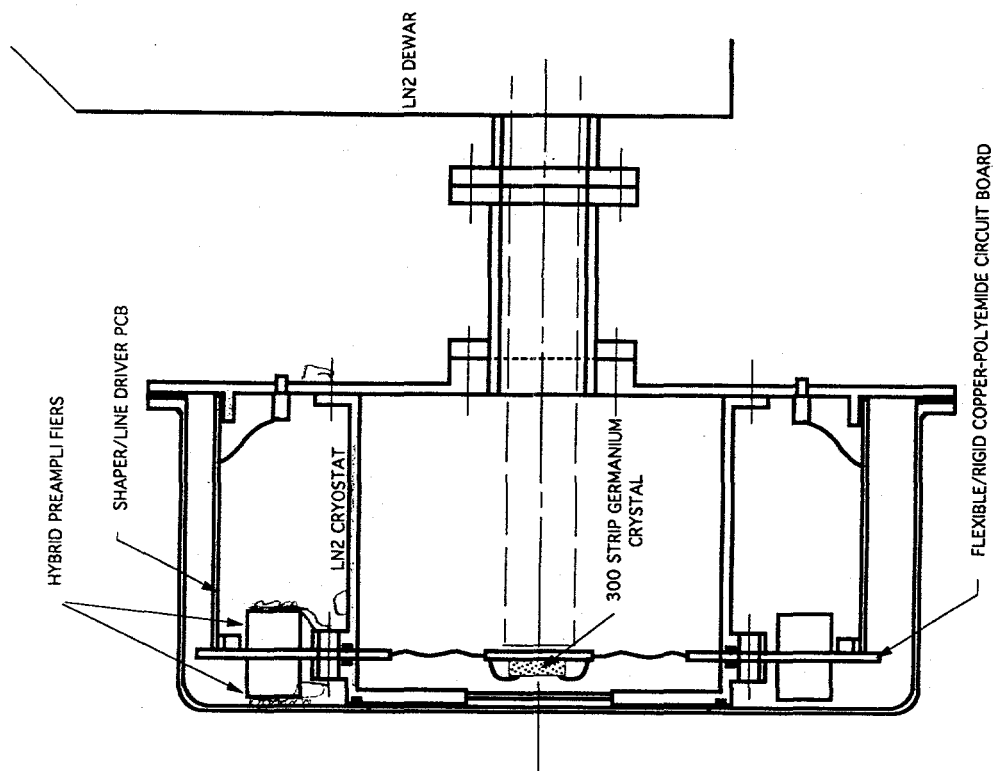
40

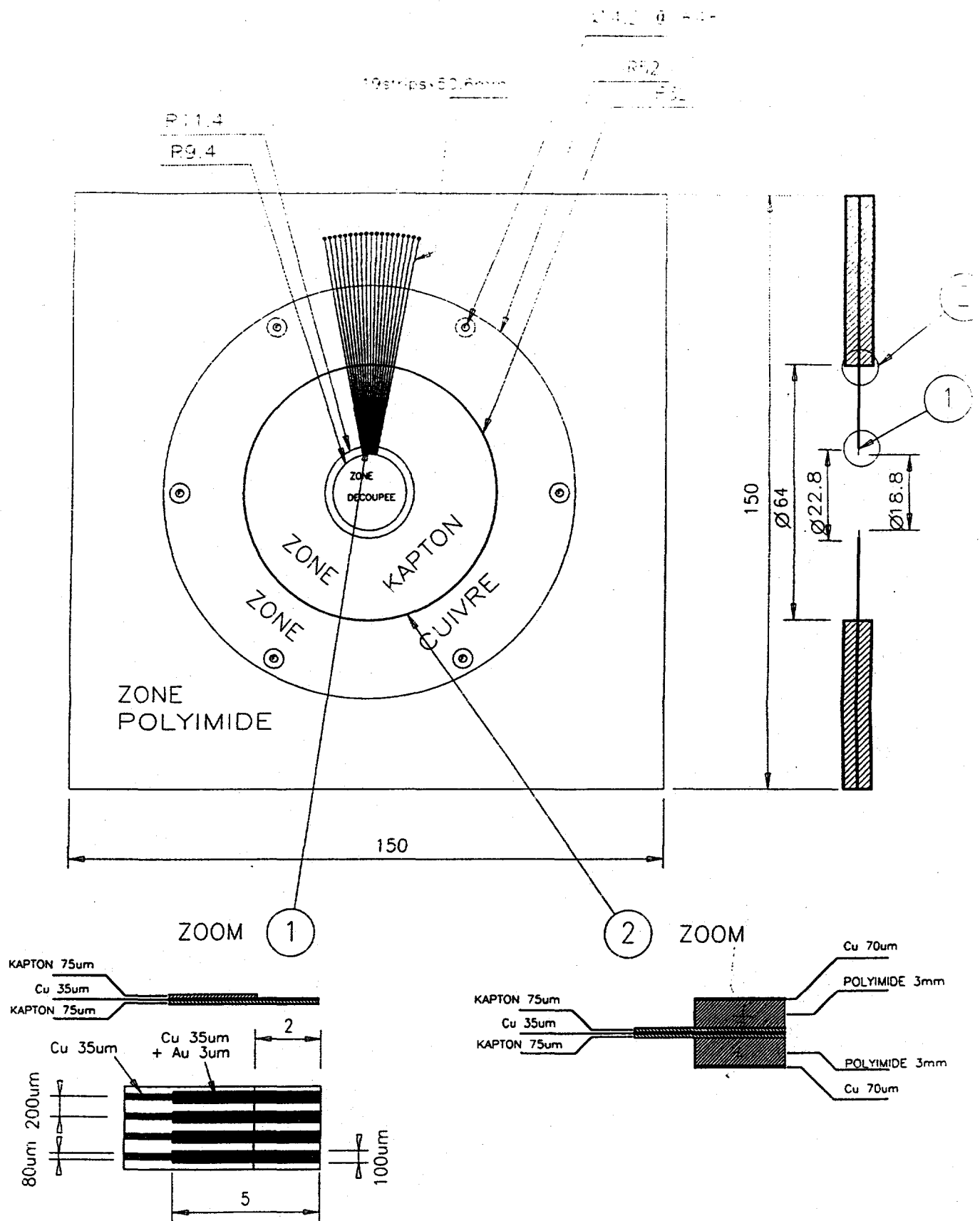
- optimisation of front-end electronics to minimize noise and suppress crosstalk (eg 3-channel sensing...)
- design for 300 channel system: cryostat/preamplifiers/data acquisition

Details of end strips (strips 5...24 are identical)

Not to scale!
dimensions in μm

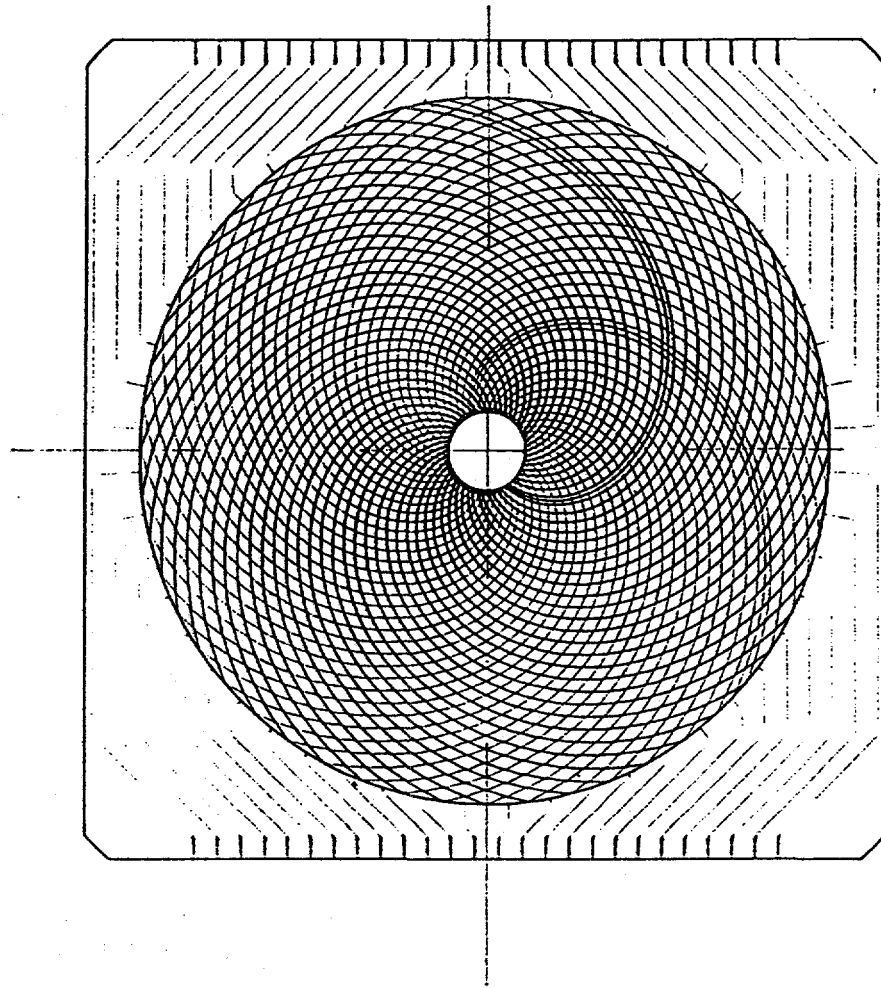






Low noise preamplifier mounting-cryostat feedthrough test assembly

40 000 pixel germanium detector for
'Cosy' at K.F.A. Jülich.



position structure of detector 1
only 52 elements (instead of 200) are shown

Riepe, KFA Jülich

Gas Microstrip Detectors

Advantages:

- lithographic production methods:
 - > close spacing of anode lines ($\approx 300\mu\text{m}$)
 - > non-rectilinear motifs possible
- fast ion transit => higher count rates (--> Mcps/cm)
- good intrinsic energy resolution (12% fwhm at 6keV)

4th Disadvantages:

- rate dependent gain drift effects (?)
 - 'radiation' damage lifetime question: local effects
 - gas absorption phase: parallax, photoelectron range and diffusion
 - gain limit (eg 1000) --> analogue position encoding difficulties
 - immature technology (semiconducting glasses, 'microgap'...) with expensive development cycle (materials R+D, mask designs...)
-
- very fast 1 and 2-dimensional counters (--> 100Mcps) with 'per strip' high density readout electronics

Prospects:

Rutherford-Appleton Laboratory - ESRF Gas μ strip Detector

Contract begun 1/91 for feasibility and design study for a ~ 300 strip detector with charge division readout on each strip at a rate > 100 kcps, to give a 'global' count rate ~ 100 Mcps.

Objectives:

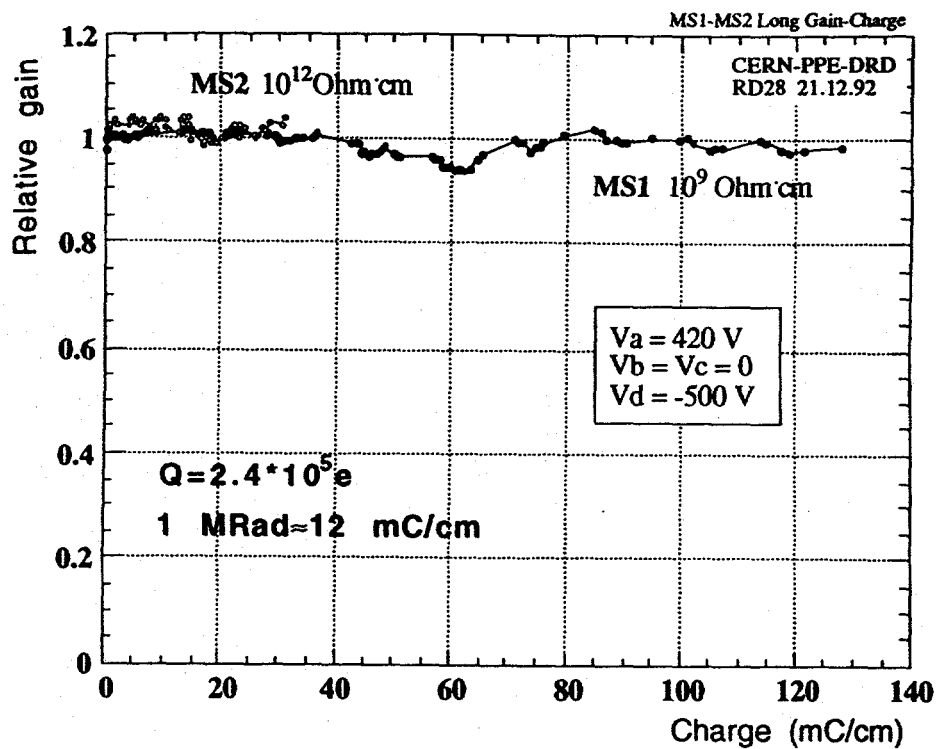
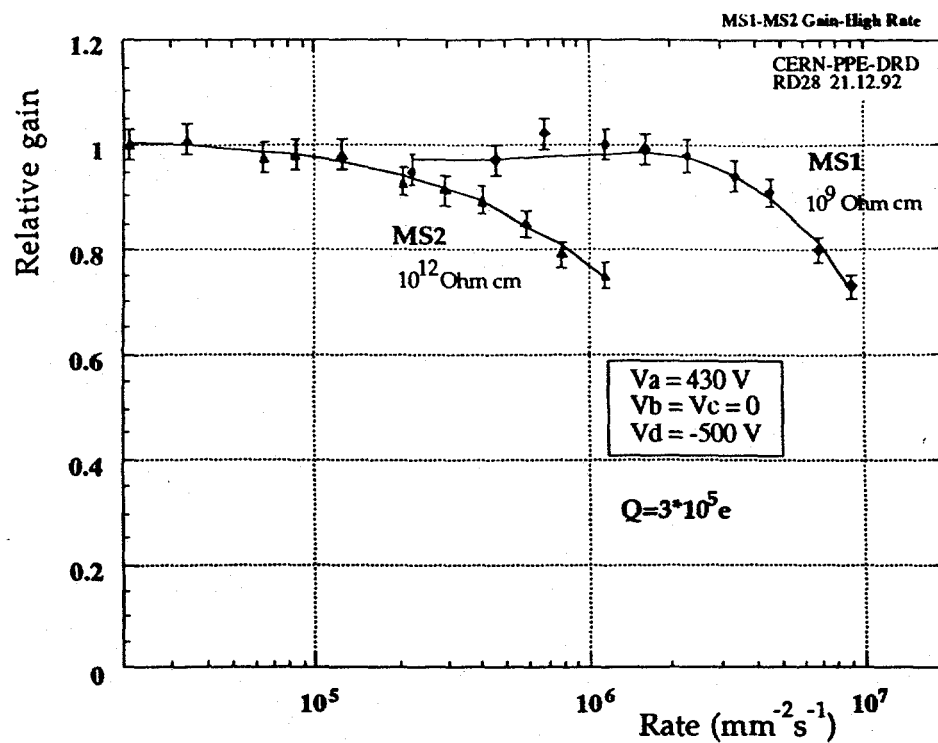
- substrate testing/manufacture to produce a gain stable μ strip detector of size $\geq 100\text{cm}^2$
- design and test of charge division electronics for 16 strip prototype which can scale to a full size system of ≥ 300 channels at $300\mu\text{m}$ pitch.

Results:

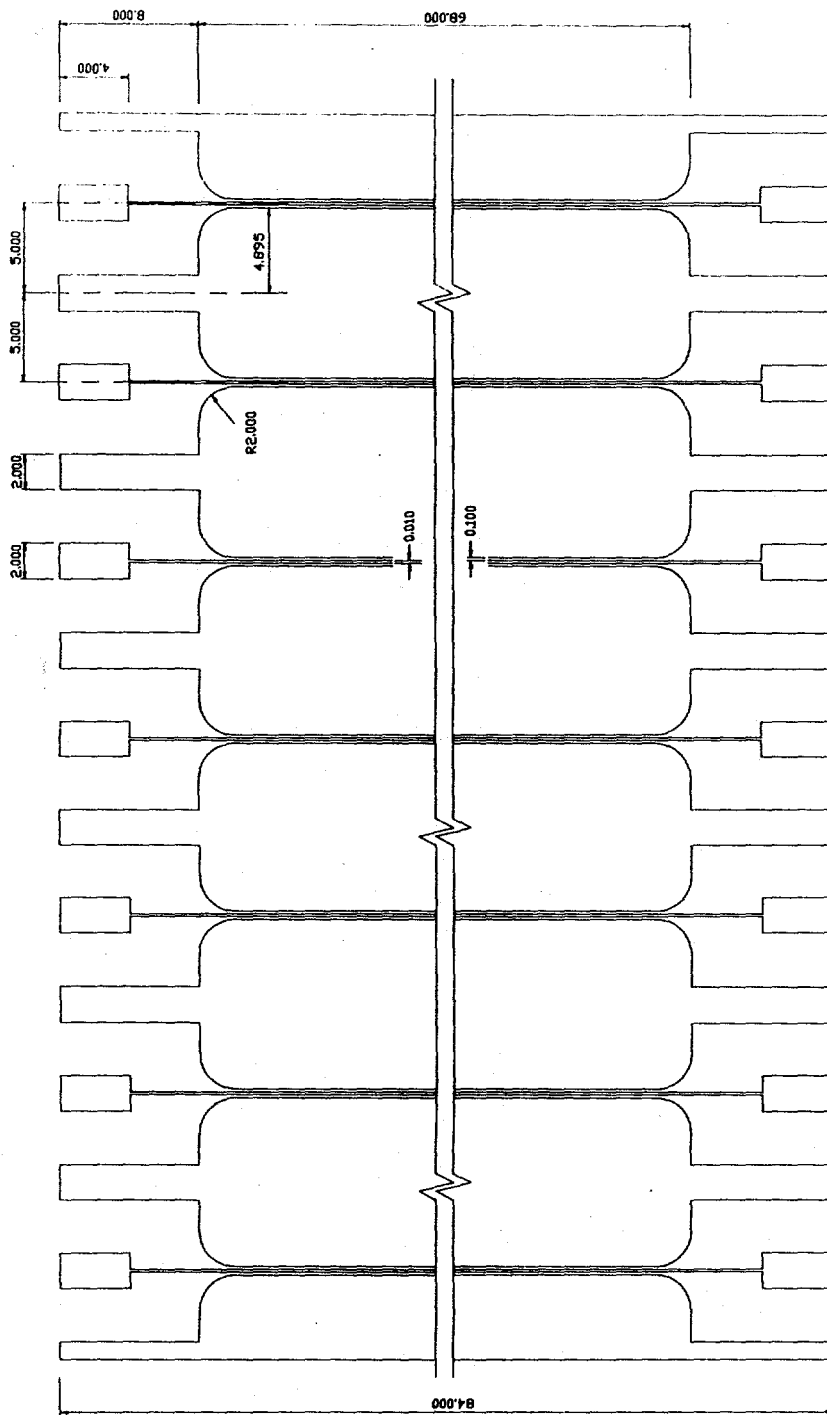
- gain stability problems (with count rate, 'radiation' damage) preclude use of 'standard' glass substrates. Work now done on semiconducting glasses (Schott S-8900, 10^{11} ohm-cm) giving good rate stability; ageing tests in progress.
- hybrid/surface mount 16 channel preamplifiers suitable for $300\mu\text{m}$ pitch detector mounting.
- Double delay line NIM shaping modules designed which give position resolution (fwhm) $< 500\mu\text{m}$ on 80mm strips at $> 10^5$ cps.

Current status:

- studies of long term ageing effects
- measurements of neighbouring channel crosstalk effects on position resolution
- study of $300\mu\text{m}$ pitch E-field stress relieved bonding techniques

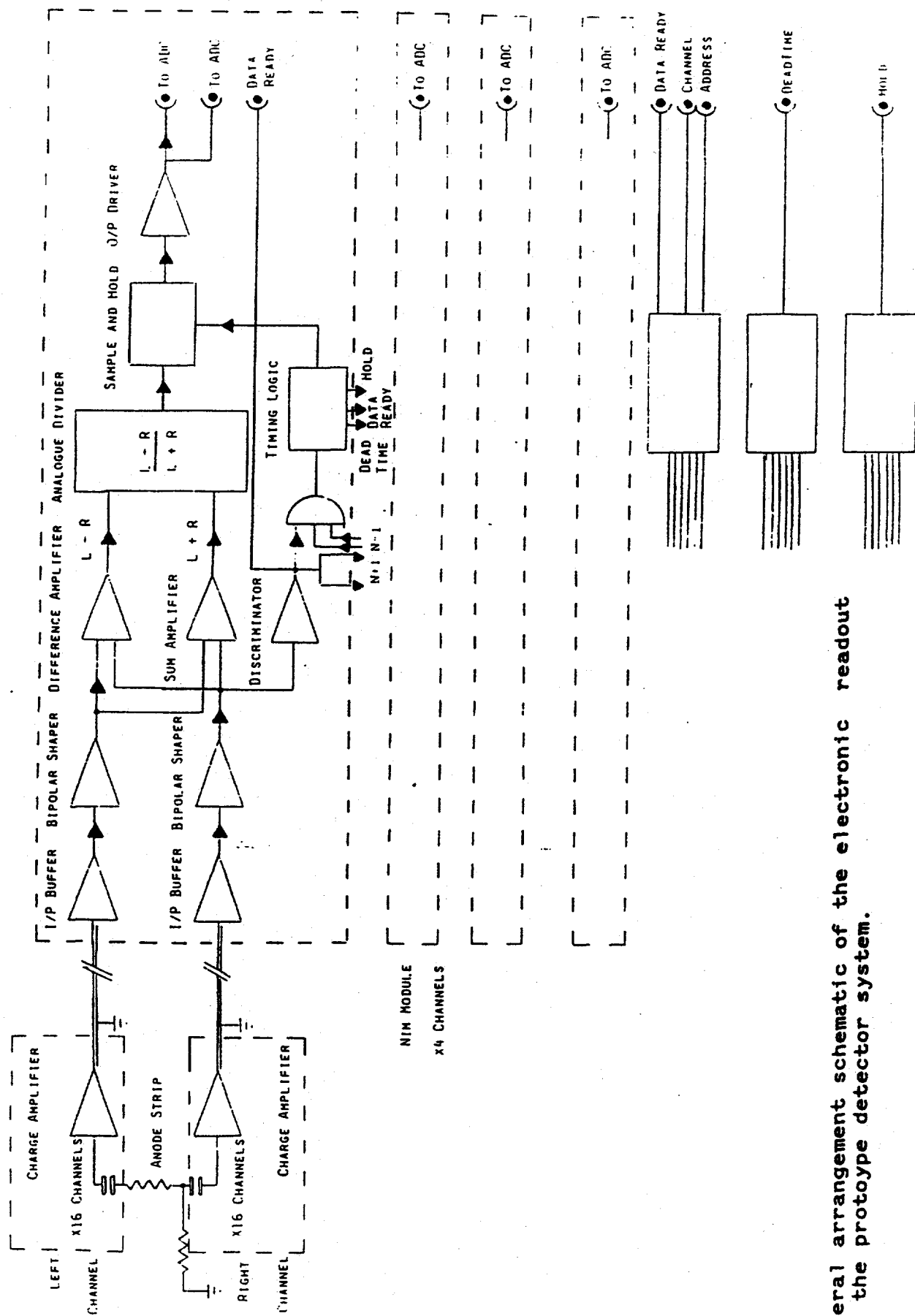


A3

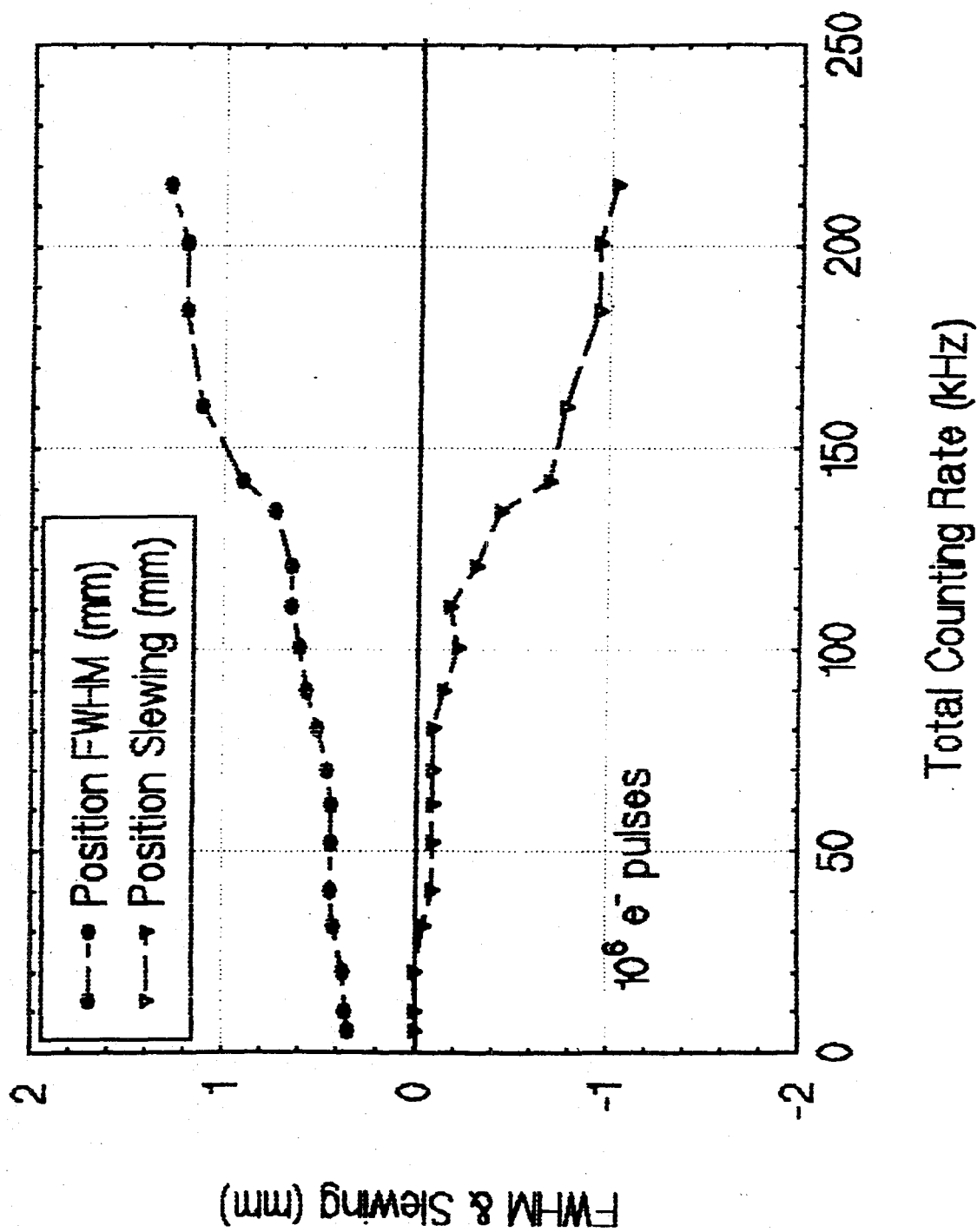


48

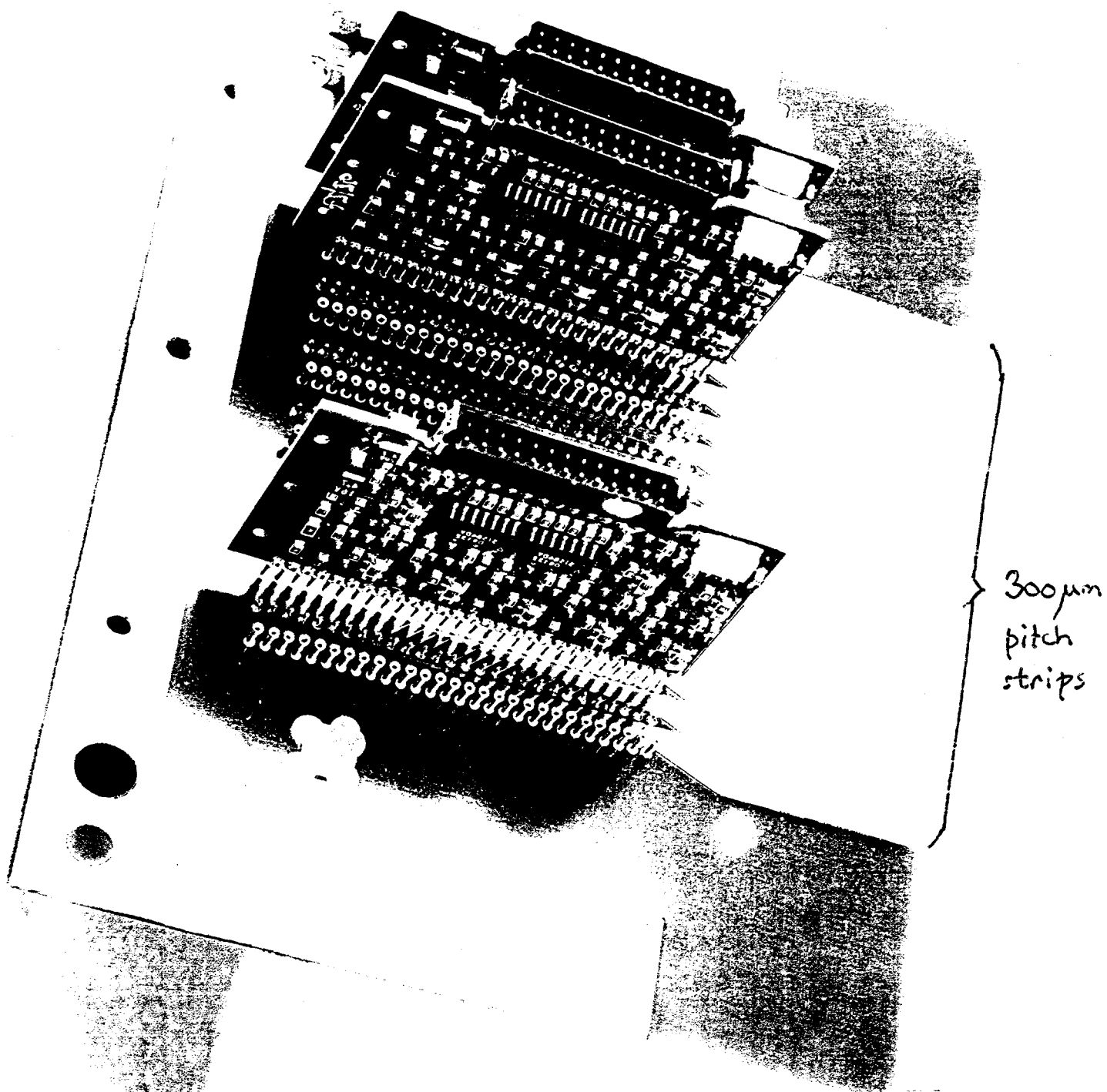
[illegible]



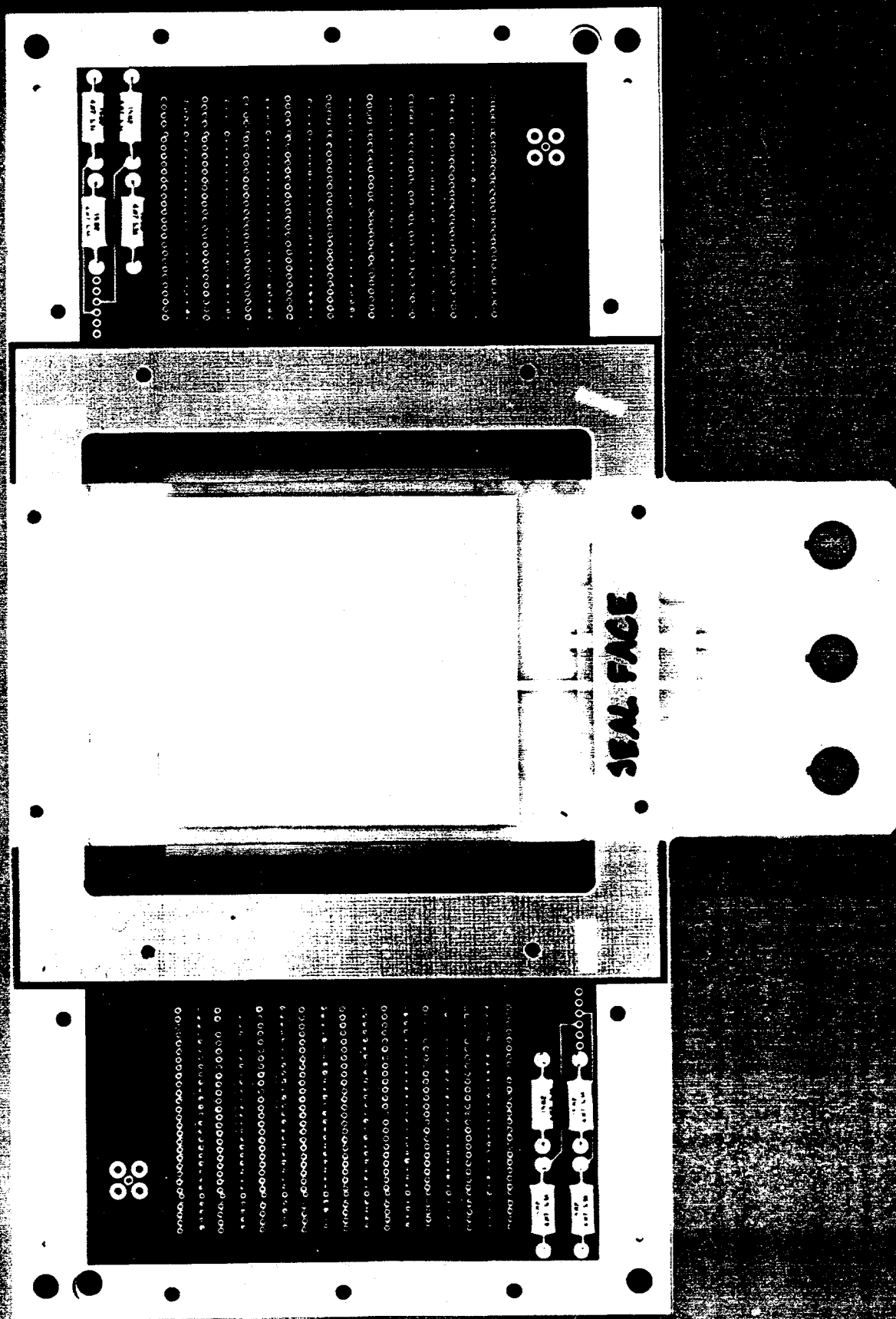
General arrangement schematic of the electronic readout for the prototype detector system.



Rate performance of the basic analogue processing system for finding the coordinate of an event along an anode strip.



MOUNTING OF PREAMPLIFIERS (16 CHANNEL) AT 300µm PITCH



Masayo Suzuki

RIKEN

Detector Development at SPring-8

Masayo Suzuki and Tatzuo Ueki

The SPring-8 Project Team initiated a feasibility study of x-ray detectors in 1990. Having completed the study covering various types of detectors and evaluating the capability that each detector could attain, the SPring-8 Project Team decided to conduct R&D programs on the following detectors in 1992: [1] CdTe Solid State Detectors, [2] Ring-Cathode Proportional Detectors, [3] Image Plate Systems, [4] X-ray Image Intensifiers, [5] MicroStrip Gas Chambers, and [6] Proportional Scintillation X-ray Imaging Chambers. All of these R&D programs have successfully progressed, becoming one of the major ongoing efforts at the SPring-8 Project.

The R&D group for CdTe Detectors has developed a full-scale model, of a size 64 mm x 128 mm, having 512 independent channels, each composed of eight linearly arranged CdTe unit sensors (0.25 mm in width, 8 mm in length, and 0.8 mm in thickness). The unit sensor is associated with its own electronics consisting of a preamplifier, a lower-level discriminator, and a counter. The prototype has been tested with fluorescent x-rays (43 keV to 59 keV) from rare earth samples irradiated by hard synchrotron radiation at KEK/PF. The latest experimental data suggest that further optimization in terms of the wiring configuration and of the temperature regulation will result in improving its performance significantly.

The R&D group for Ring-Cathode Proportional Detectors has constructed a prototype with a newly designed delay-line having a delay time of 2.6 nsec/mm. The prototype has been installed in BL-10C at KEK/PF and attained a spatial resolution better than 800 μm . By carefully distributing the applied electric field over the ring-cathode, the prototype successfully operated at a counting rate of 2×10^5 without any discharge, above which distortion in scattering patterns began to be observed. The uniformity of response was found to be better than 10% with a scattering angle smaller than 30 degrees. The group will continue its effort in the direction of improving the high counting capability and the uniformity over the entire region of the detection area.

The R&D group for Image Plate Systems has introduced a new type of image plate Blue IP (Fuji film BAS-UR), originally designed for electron microscopy, to improve the spatial resolution. The preliminary test showed that the spatial resolution of Blue IP is twice as high as that of conventional image plates, such as White IP (Fuji film BAS-HR III). The group has also intensively studied a scanning mechanism associated with line-shaped laser light in order to shorten the readout time for large area image plates (400 mm x 600 mm). In this readout system, the photostimulated luminescence induced by the line-shaped laser light will be focused on a CCD through an optical lens system of large numerical aperture and will be read out one-dimensionally with a readout cycle of 500 kHz. Having completed the basic design, the group is currently constructing a prototype based upon this new readout mechanism.

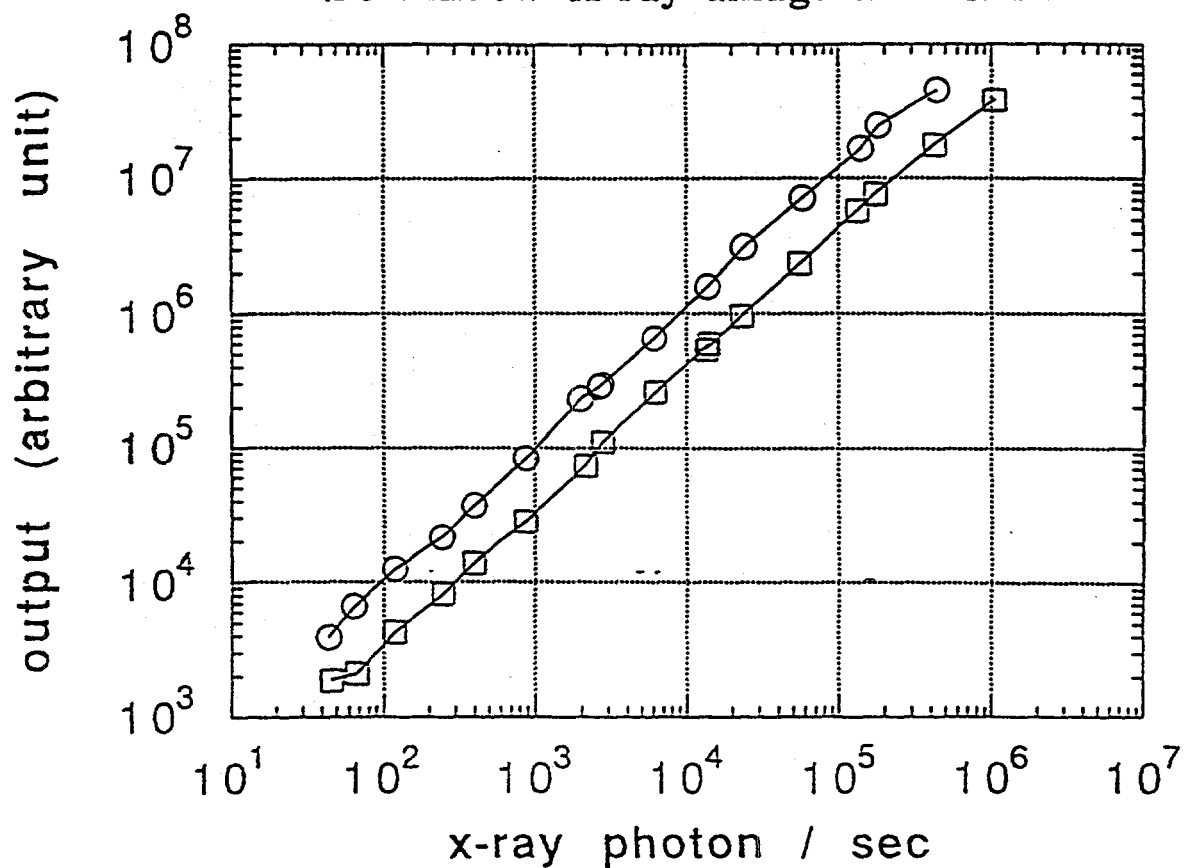
The R&D group for X-ray Image Intensifiers has been successfully enlarging the detection area of the device. An x-ray image intensifier with a beryllium window having 150 mm ϕ entrance field has been developed by the group on the basis of a technology for aluminum window medical x-ray image intensifiers. With the Be-window x-ray image intensifier, the photon gain is also improved by more than 10 times compared with the visible-light image intensifier. This improvement has enabled them to use standard CCDs to perform time-resolved measurements at a rate of 30 frames per second. Confirming that the x-ray image intensifier has a dynamic range wider than four orders of magnitude and a point spread function with a FWHM of 280 μ m, the group has succeeded in observing time-resolved diffraction patterns from frog skeletal muscle during contraction under stretch.

The R&D group for MicroStrip Gas Chambers has developed a two-dimensional prototype chamber having an effective area of 50 mm x 50 mm with a very thin substrate by employing multi-chip module technology. It has 250 anode strips and 250 backplane strips orthogonal to each other with an expected spatial resolution of 60 μ m. It is mounted on a large ceramic package with 600 connected pins, realizing easy and high-density connections. The x-ray images so far obtained are encouraging, although preamplifiers with a higher gain are required for better performance. The design of a full-scale model with an effective area of 100 mm x 100 mm is currently in progress, with which the group expects to extend the effective detection area up to 200 mm x 200 mm by combining four of these.

The R&D program on Proportional Scintillation X-ray Imaging Chambers has been the most challenging project among the programs, since it is based upon a new chamber technique. The detector system consists of a

rare gas proportional scintillation chamber and an image-intensifier-associated CCD camera. The prototype constructed has demonstrated that this novel detector is capable of imaging single x-ray photons. The spatial resolutions attained in analogue mode and in digital mode were around 1 mm and better than 170 μm , respectively. The design of a full-scale detector is currently in progress.

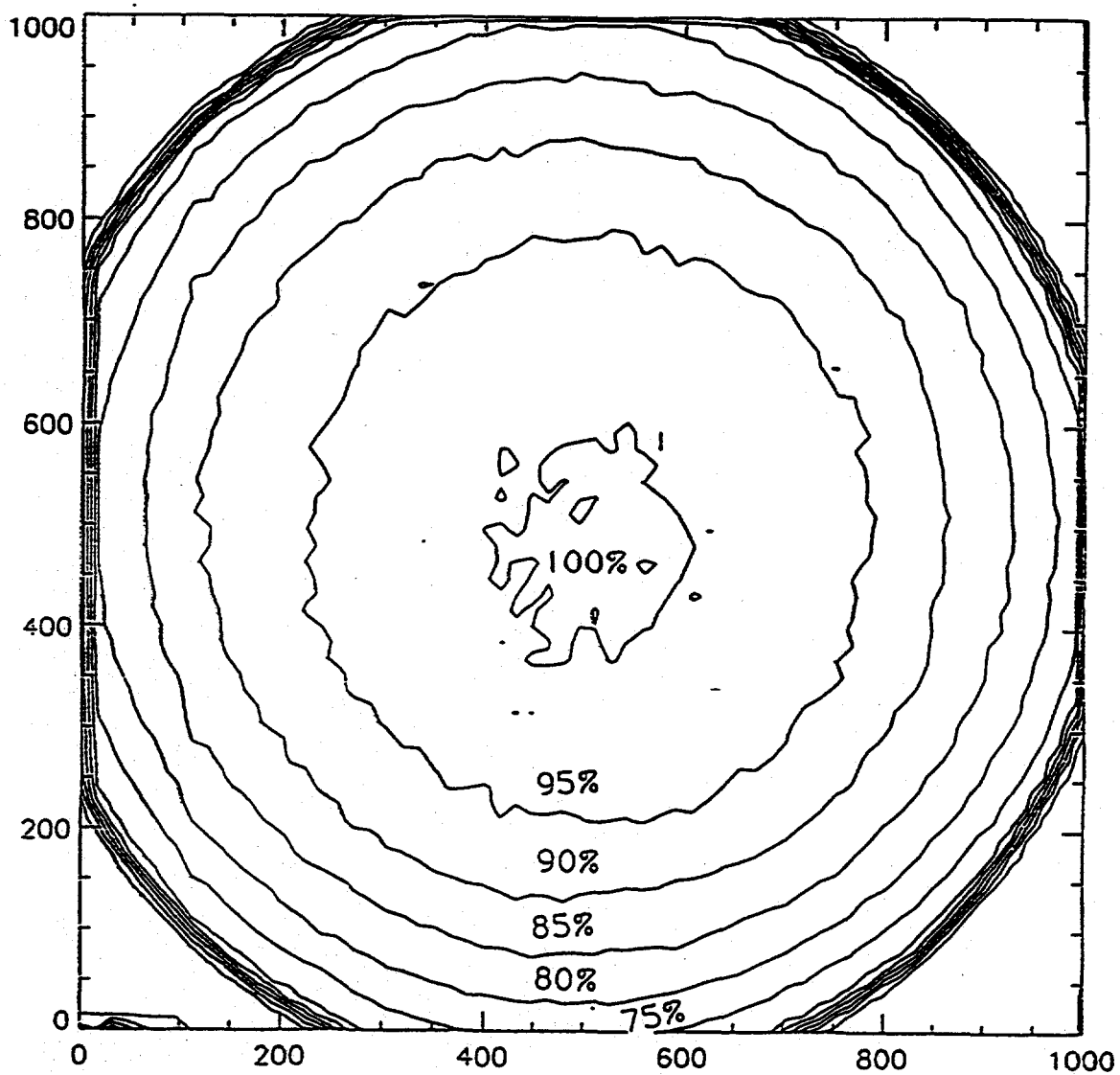
Dynamic range of Be-window X-ray Image Intensifier



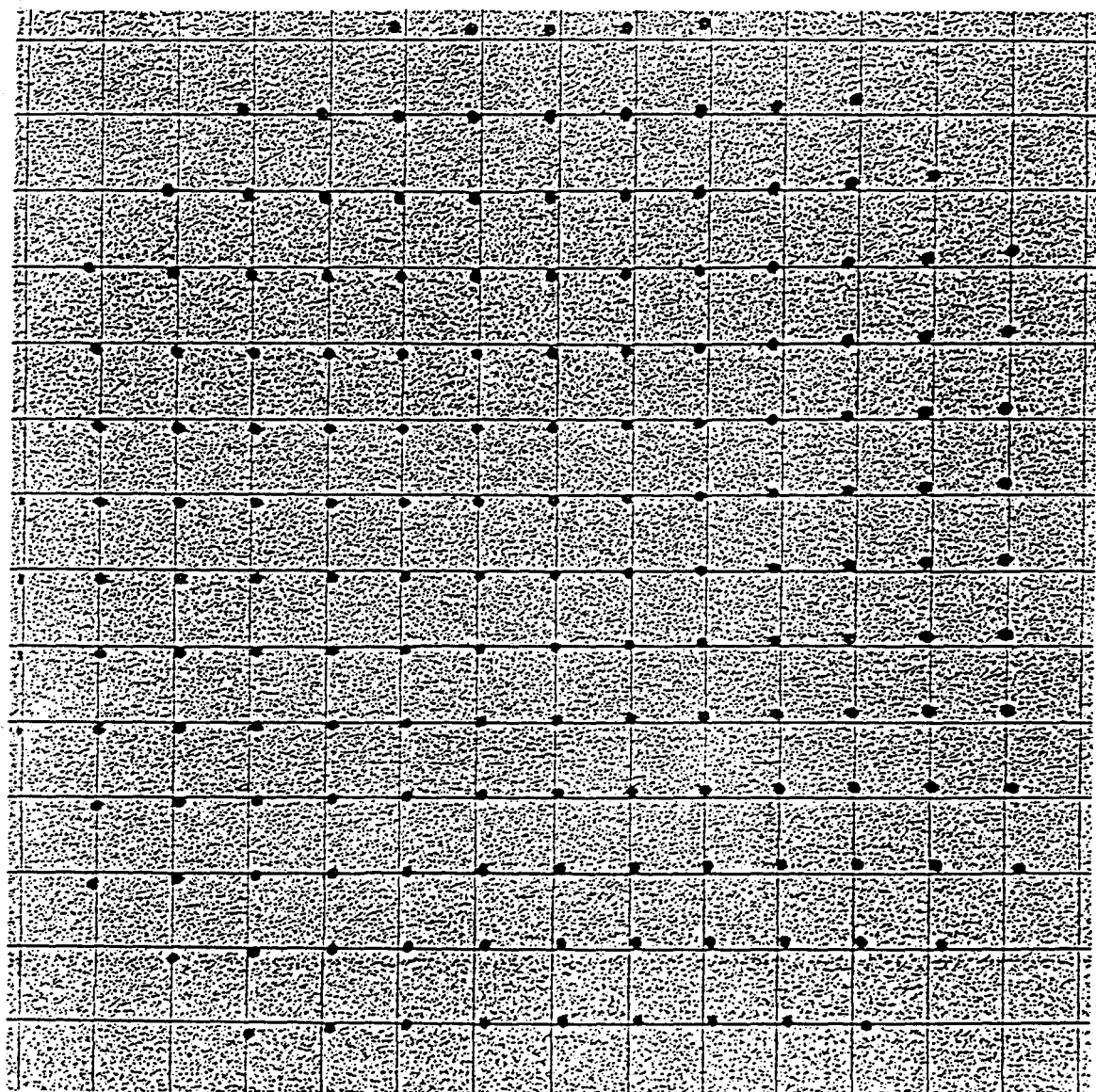
D3

$\frac{n}{t_{\text{from}}}$

D1 & D2

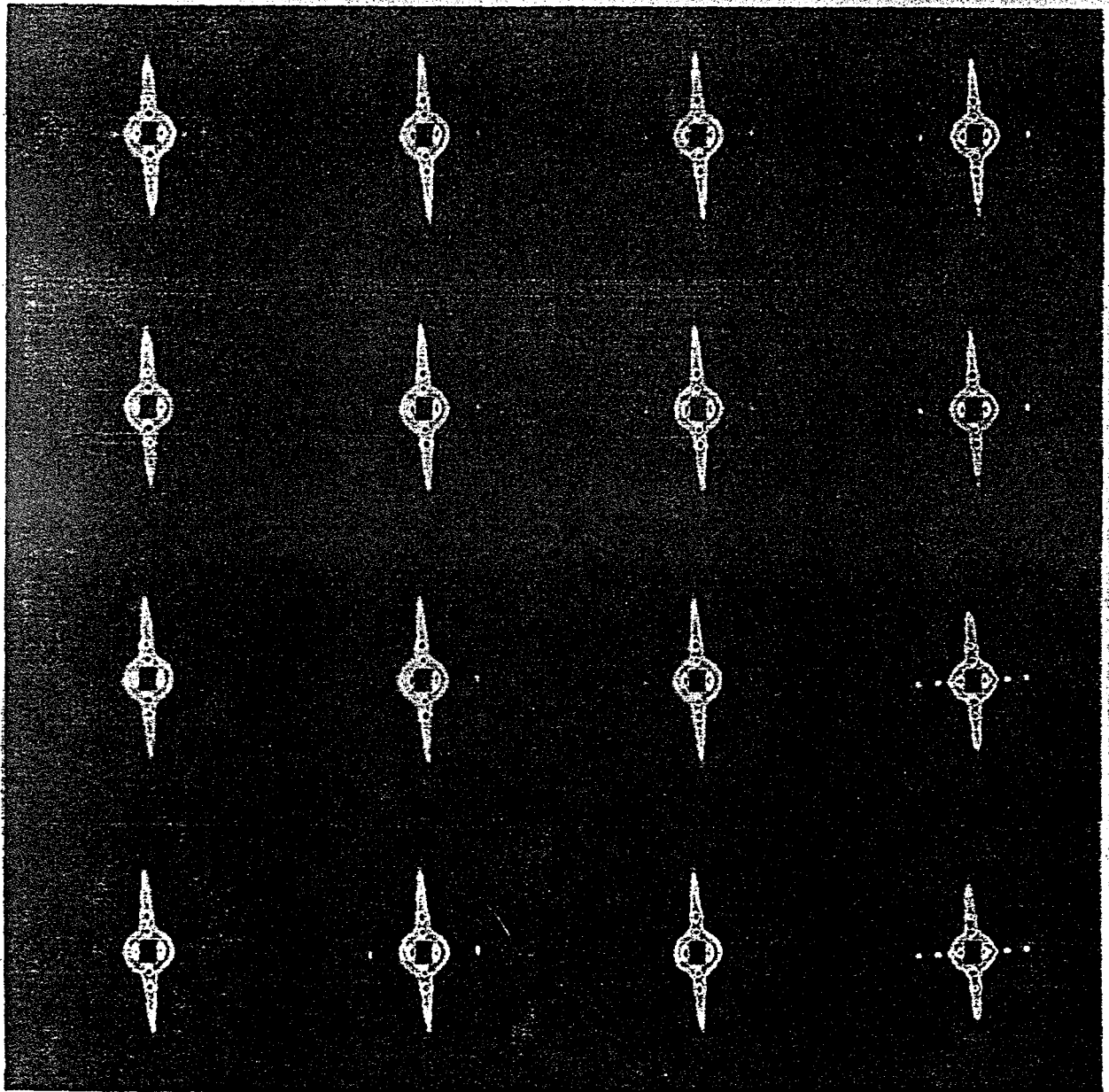


X-11 ²⁴ 214 A

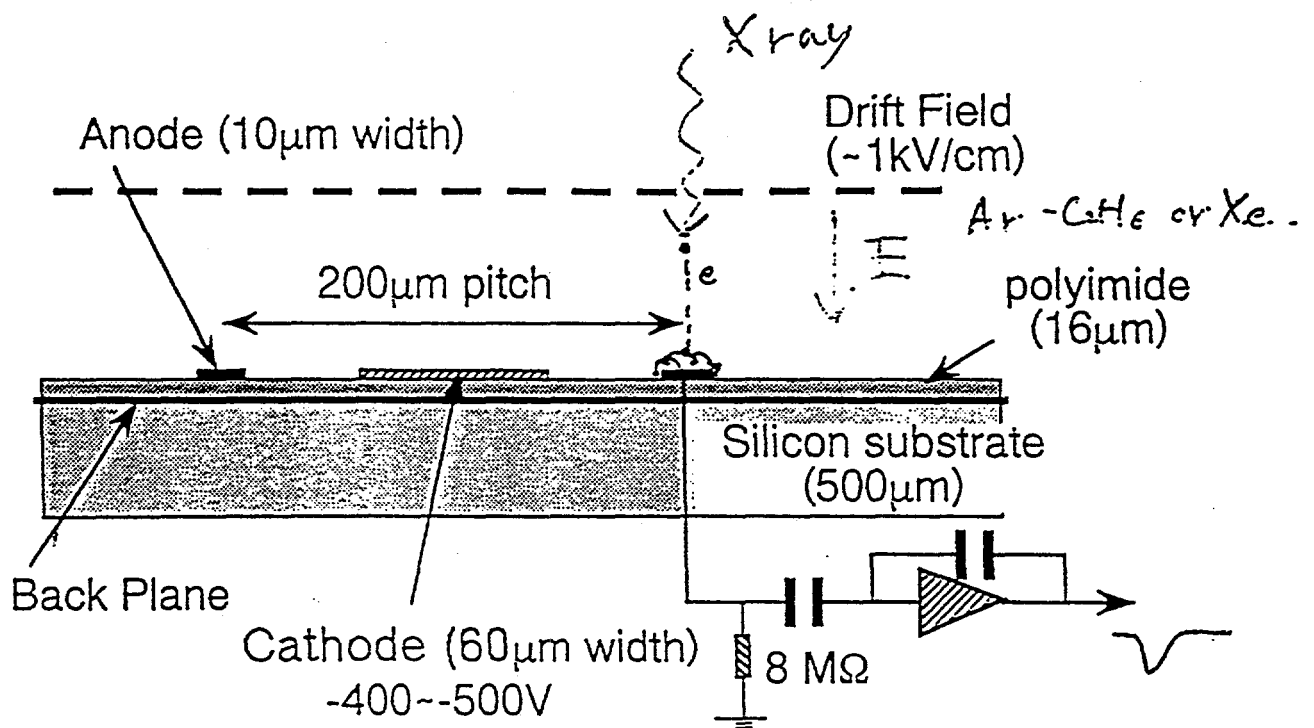


130 mm

130 mm



Feature of MicroStrip Gas Chamber (MSGC)



Schematic View of MicroStrip Gas Chamber (MSGC)

• Photon Counting Detector

Rigid Substrate &
Fine Precision Structure ($< 0.1 \mu\text{m}$)



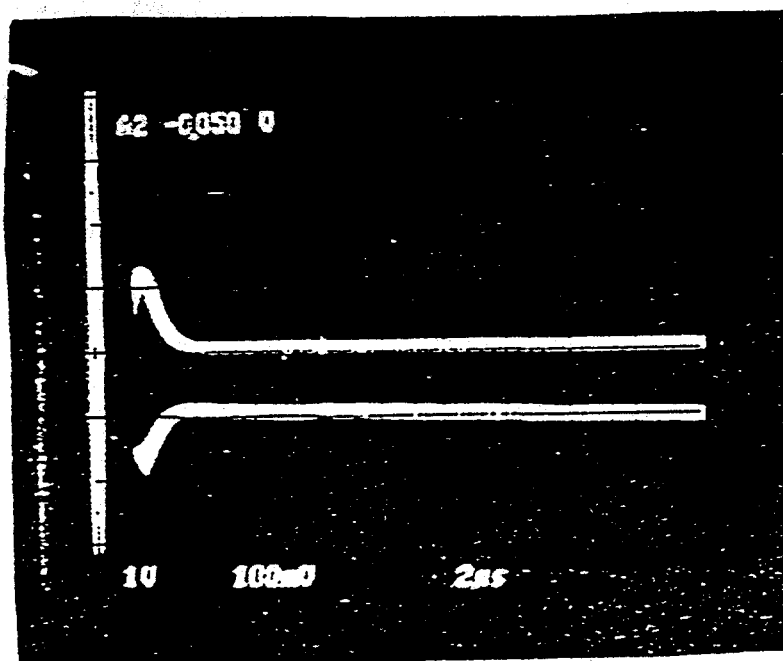
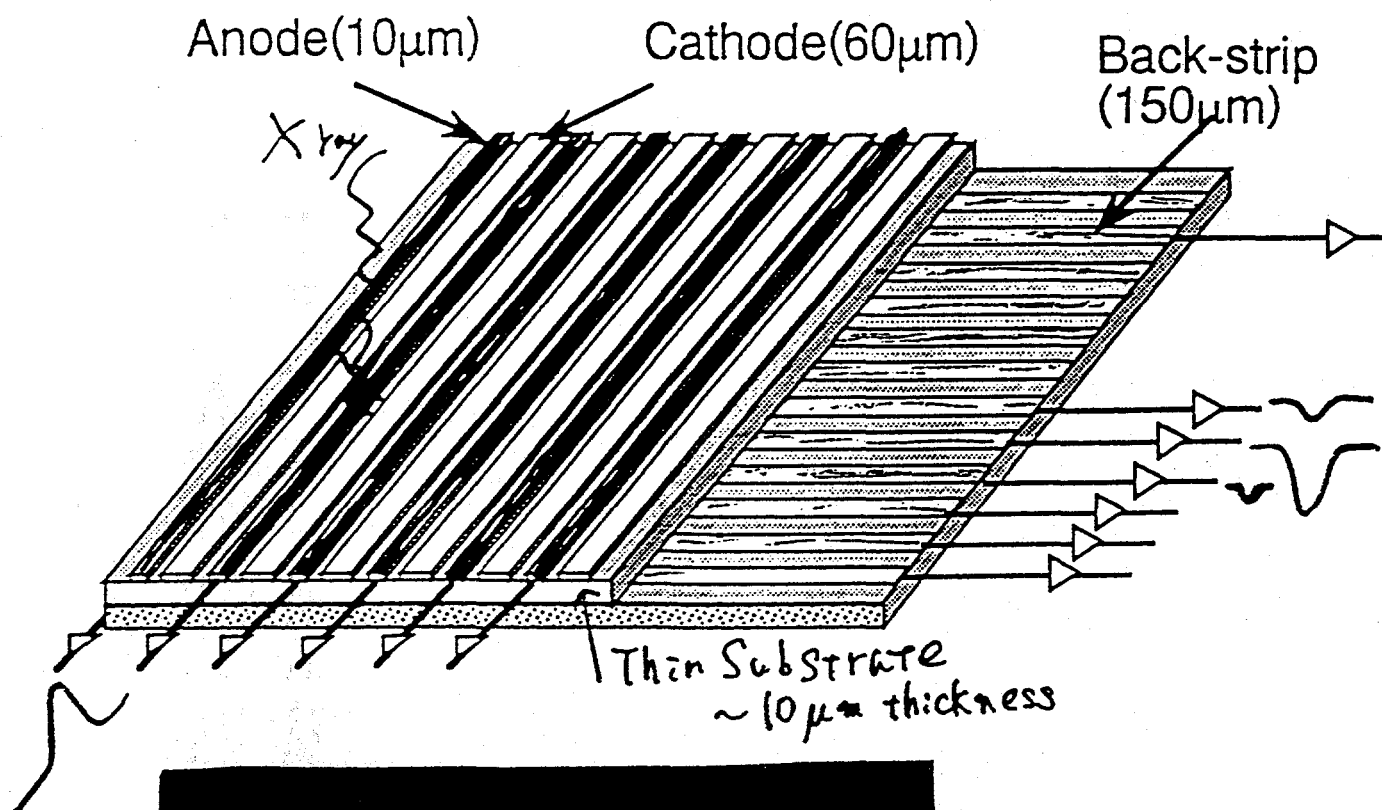
Fine Position Resolution ($\sim 60 \mu\text{m}$)

Fast Signal Processing ($\sim 10 \text{ ns}$)

High Counting Rate ($\sim 10^7 \text{ Hz/mm}^2 \text{ s}^{-1}$)

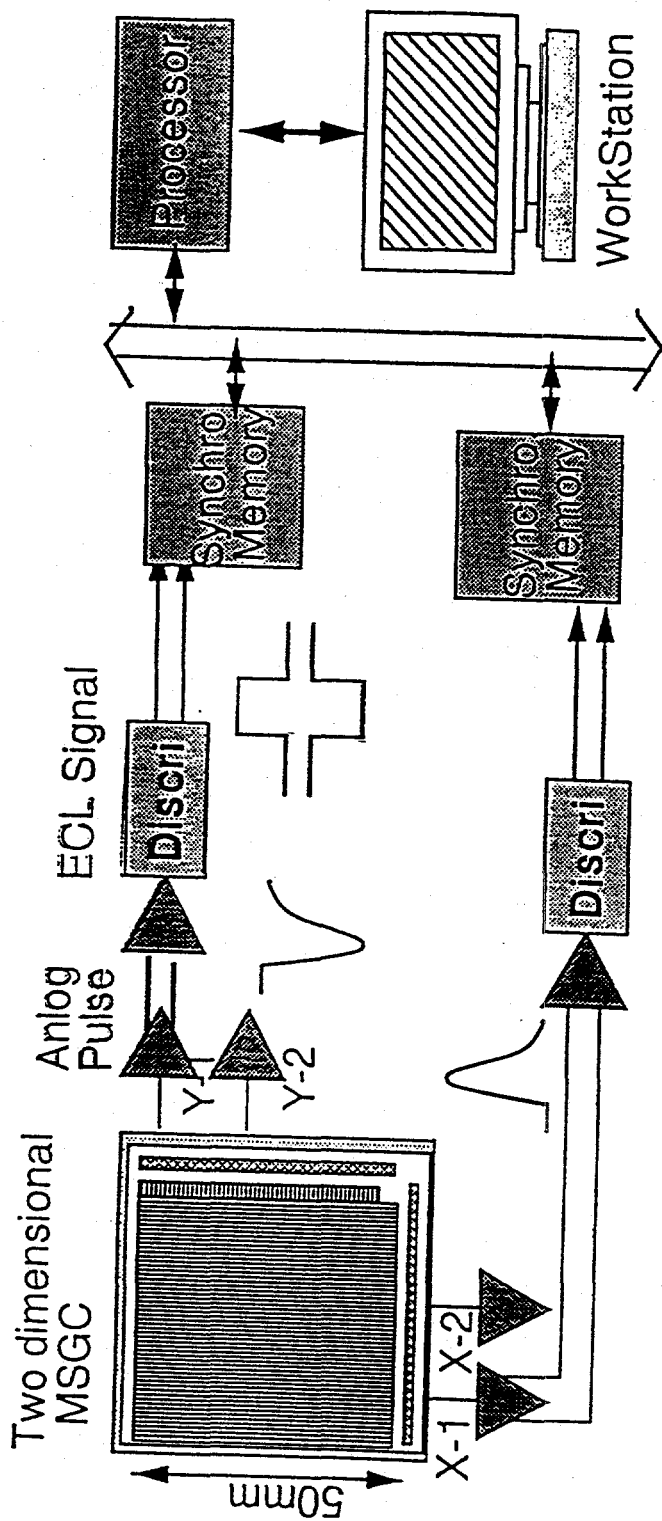
Simple Fabrication

Structure of Two dimensional MSGC

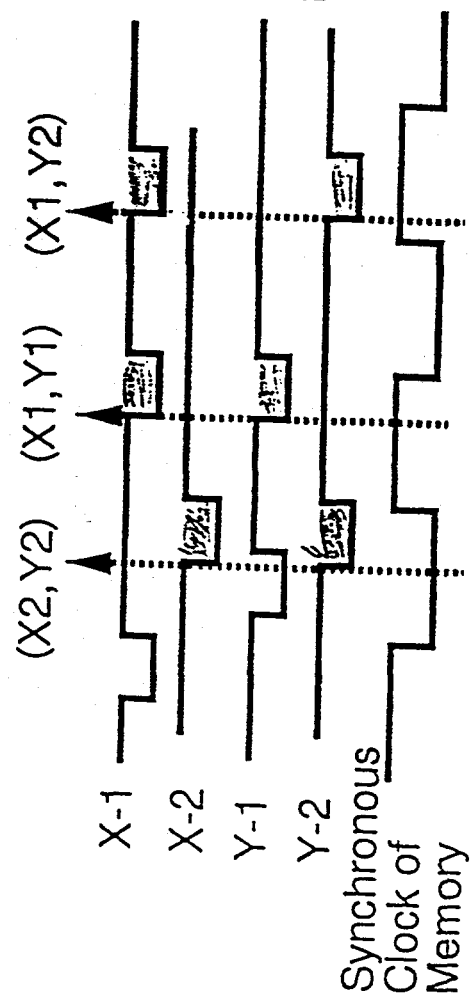


Photograph of an anode signal (up) and a back-strip signal (down) of 50mm x 50mm two dimensional MSGC for 5.9 KeV Fe X-ray

MSGC Imaging System



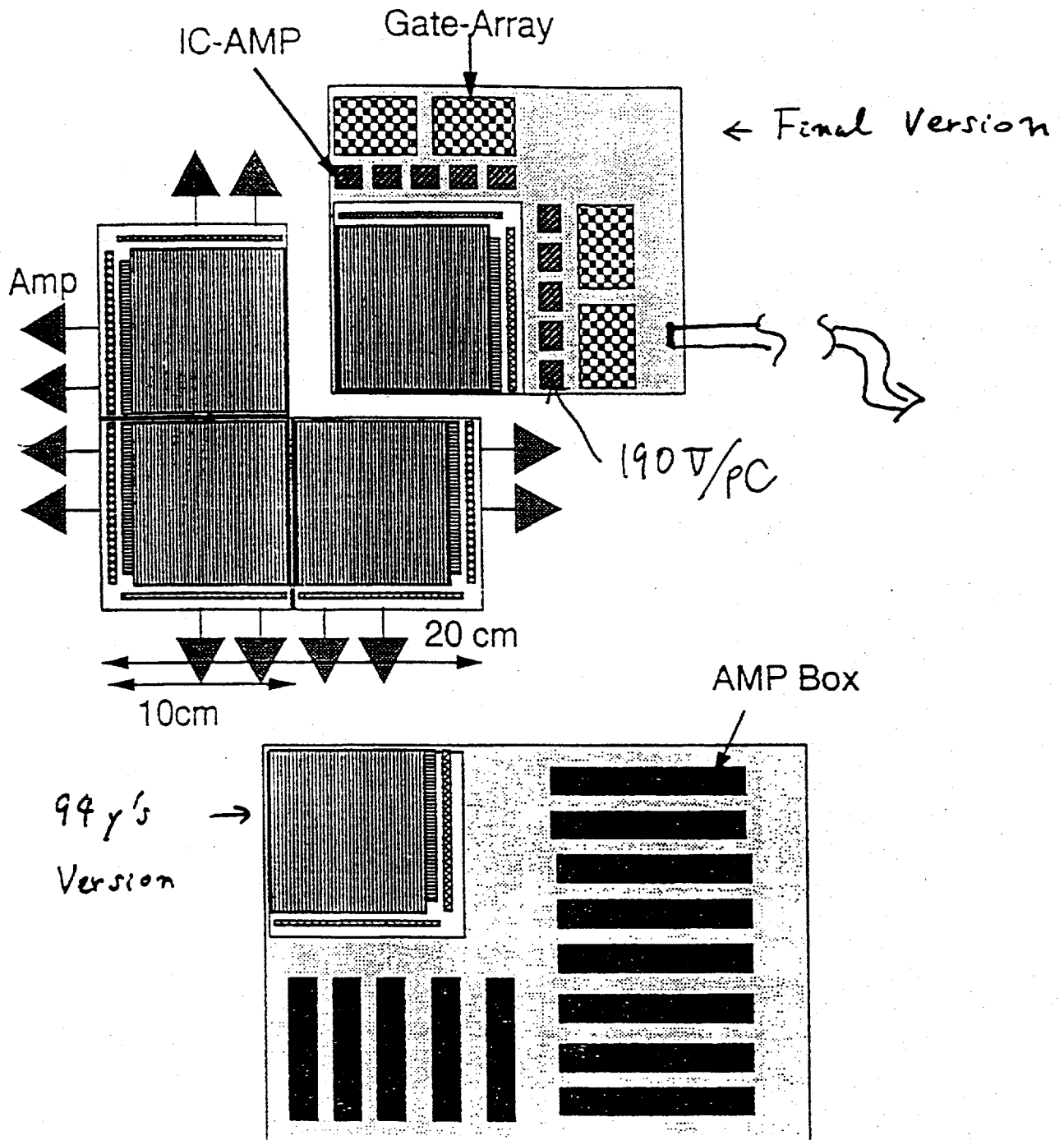
(X2,Y2) (X1,Y1) (X1,Y2)



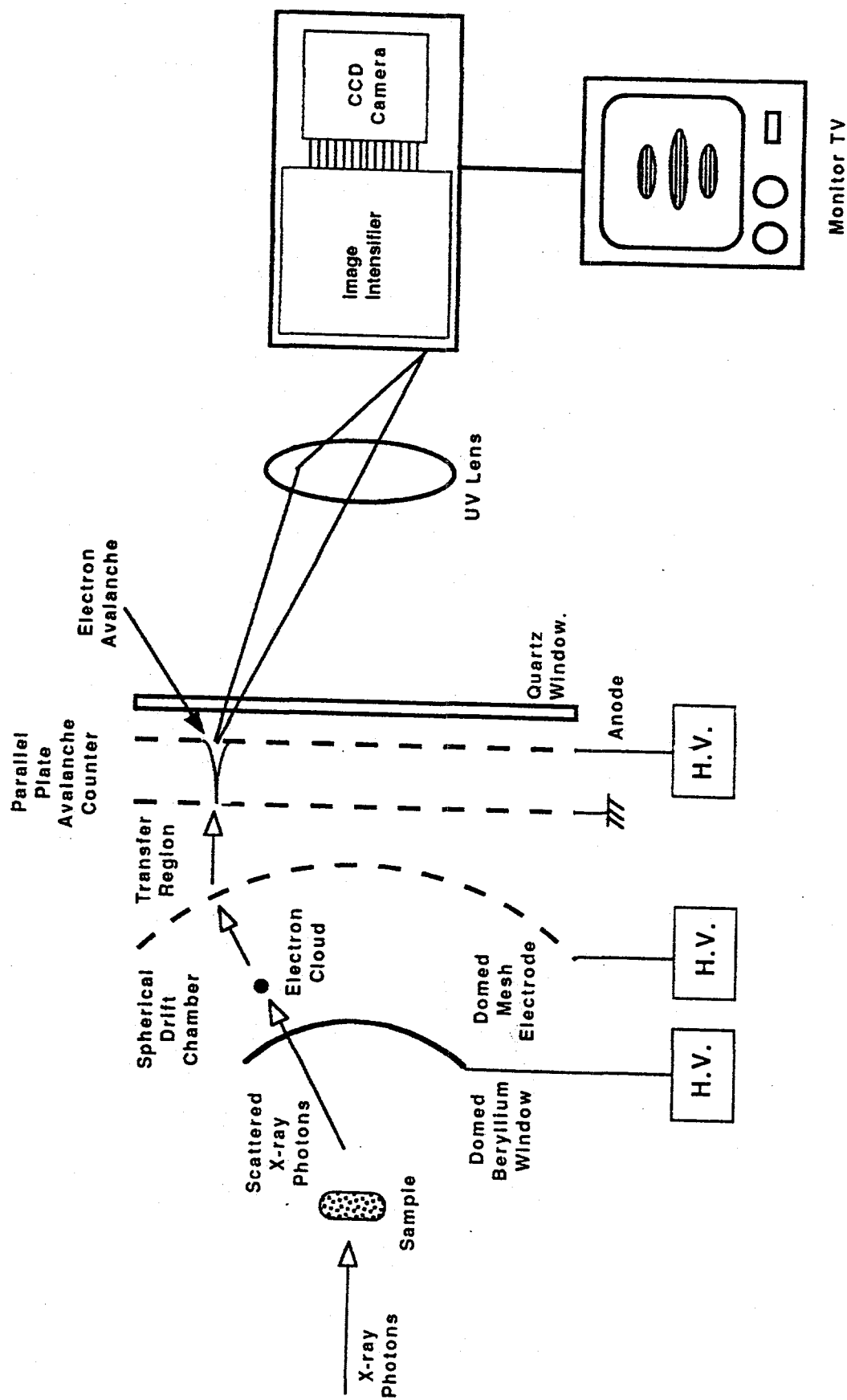
Schematic diagram of signal processing from MSGC.

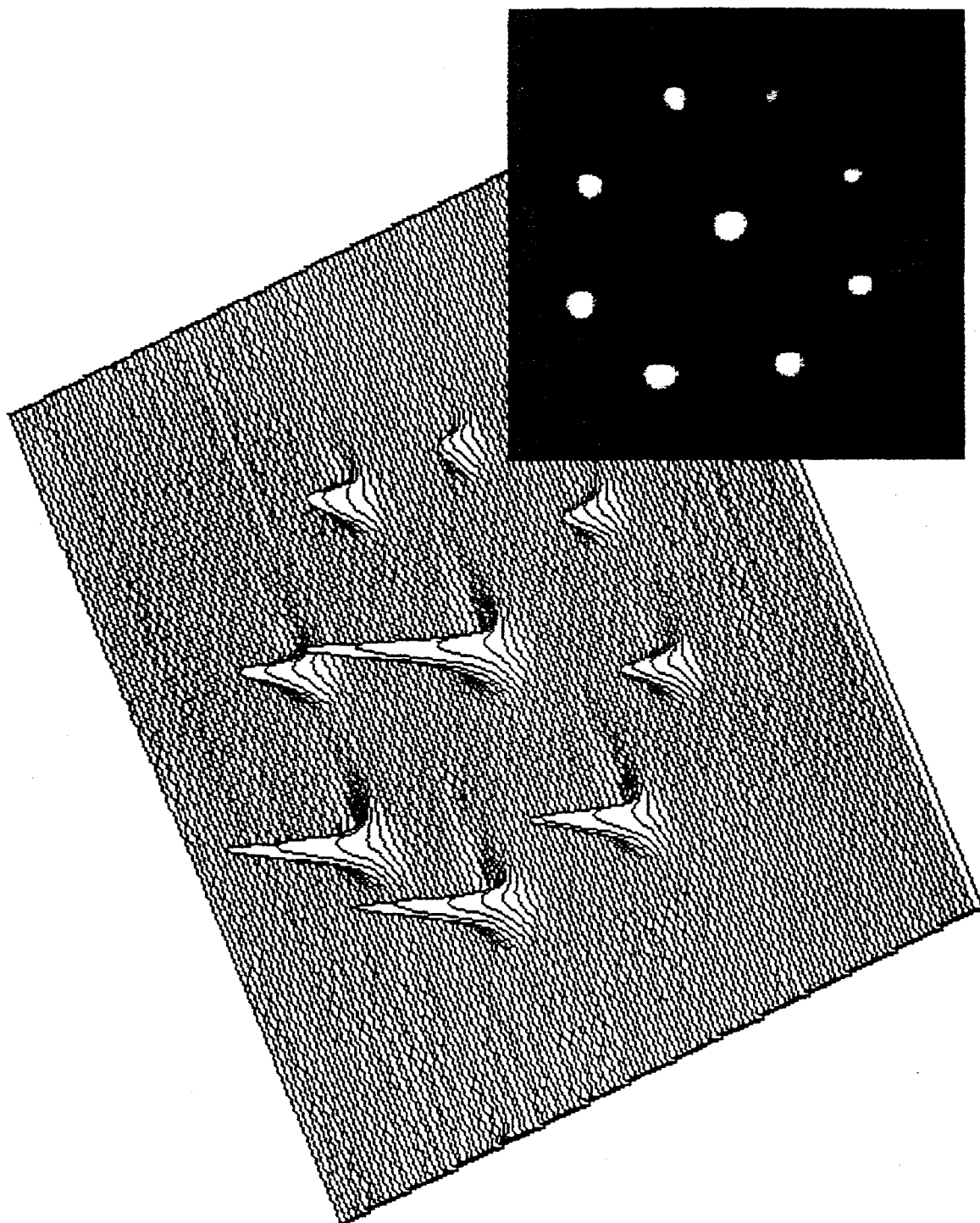
Signal of MSGC is at first amplified and discriminated for every channel, and then pulse from discriminator is latched in VME memory module synchronously with ~ 10 MHz clock.

Large area Two dimensional MSGC

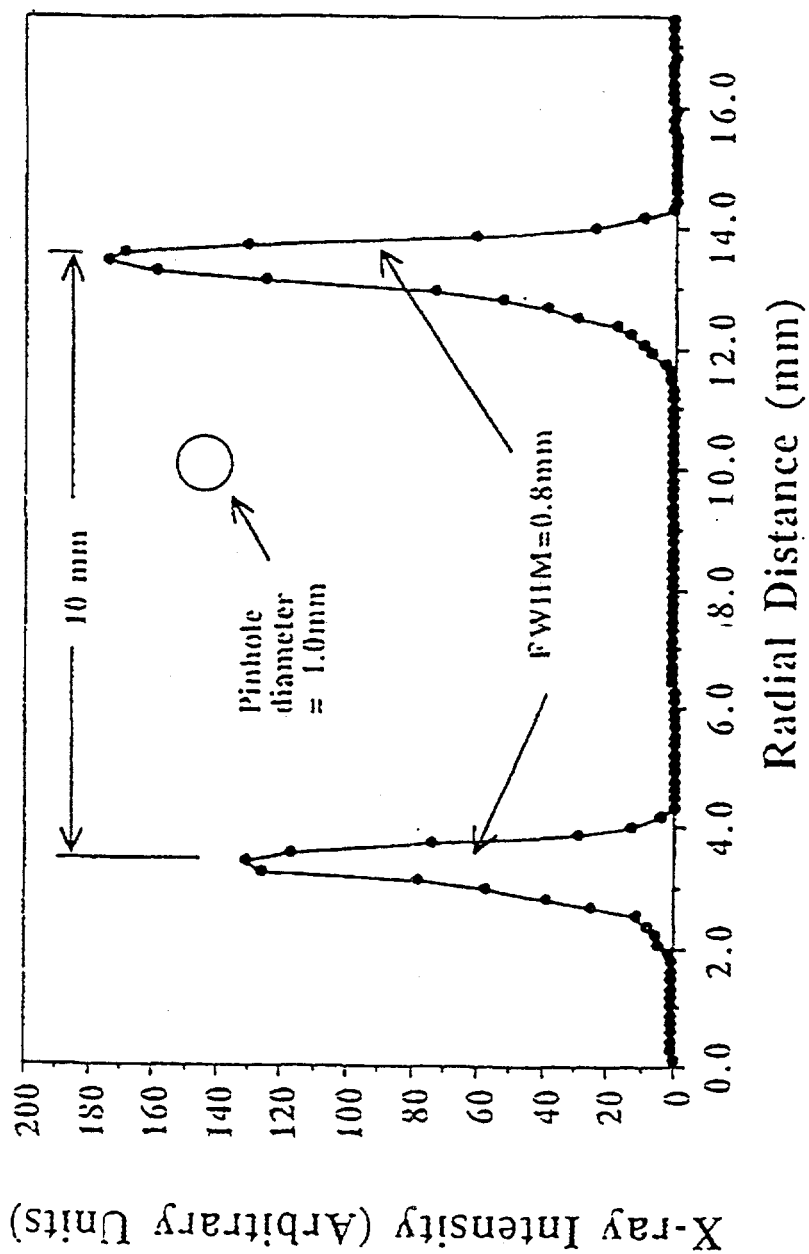


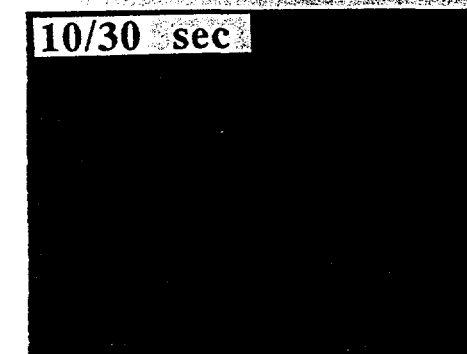
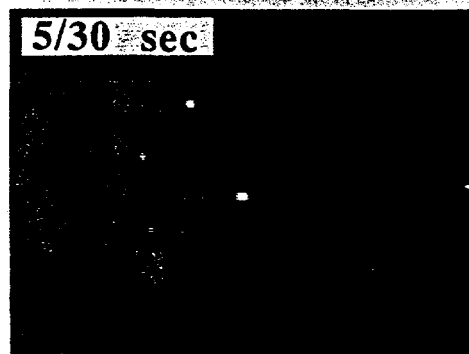
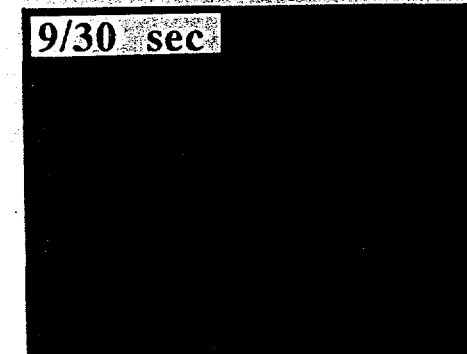
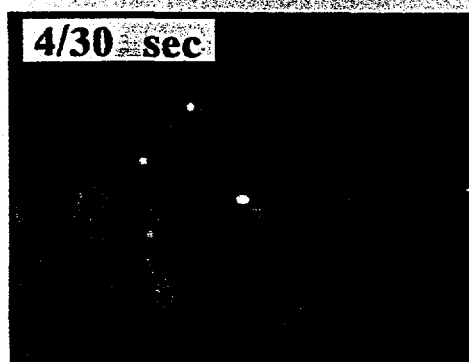
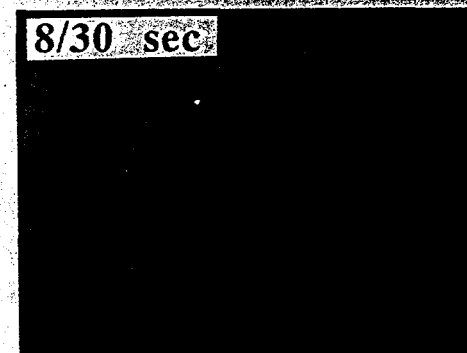
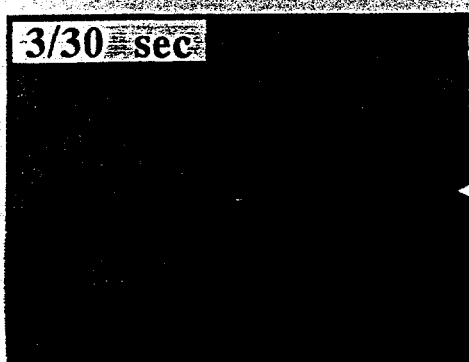
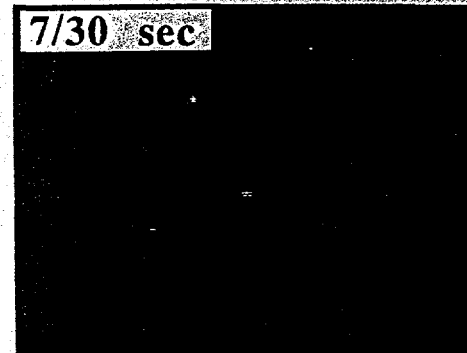
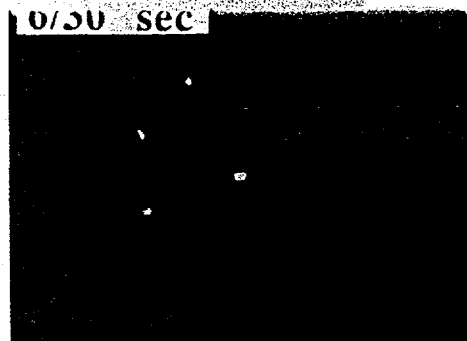
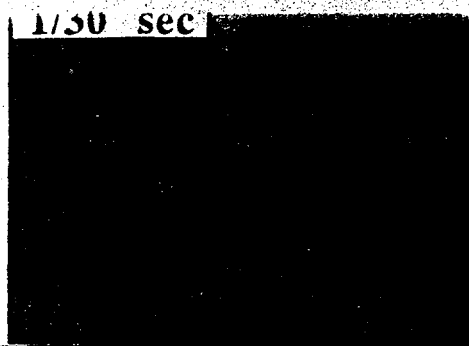
Large Imaging MSGC with 20cm x 20cm effective area, which consists of four MSGCs with 10cm x 10cm effective area

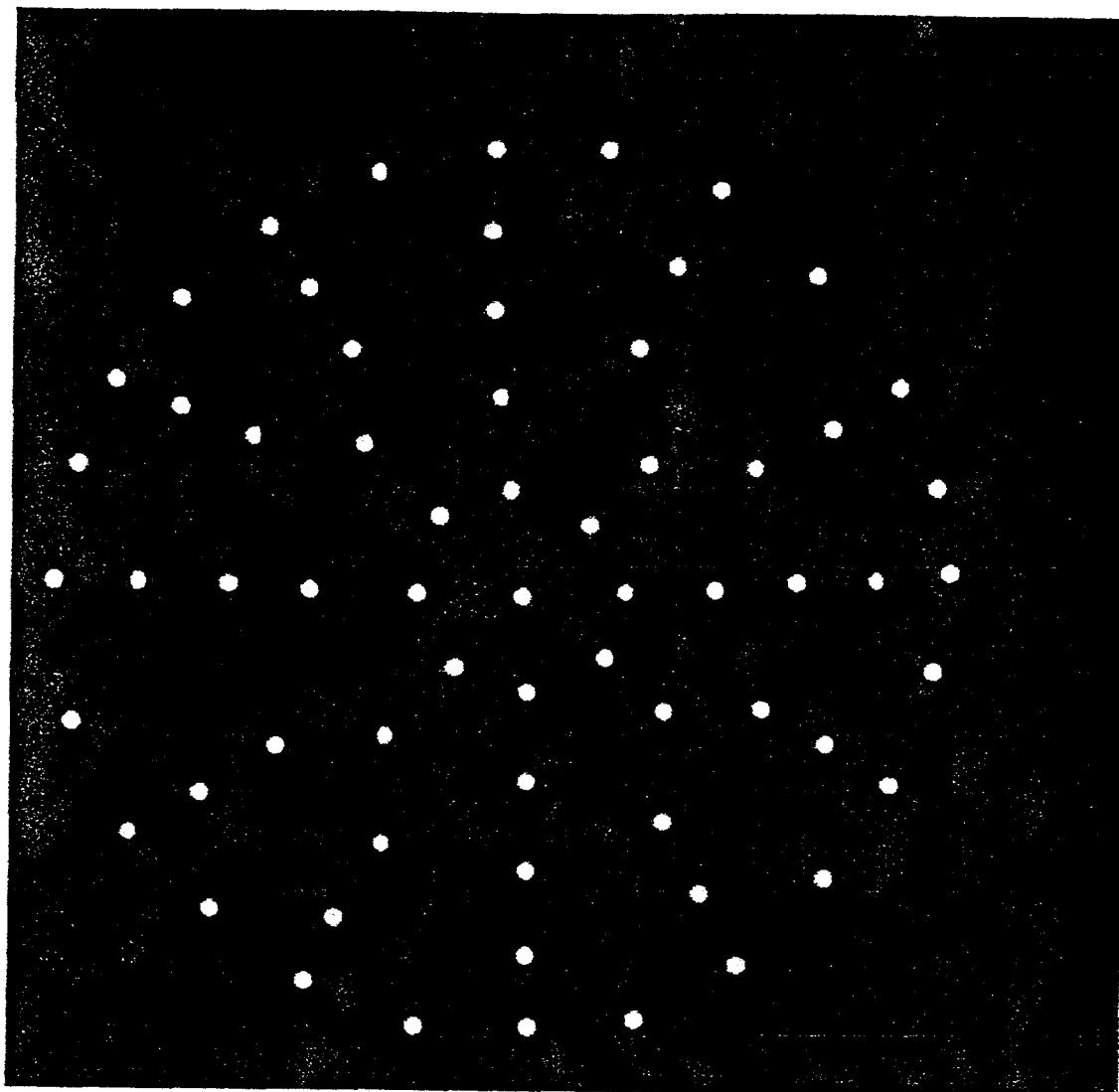




Data from "2Peak/data;2"







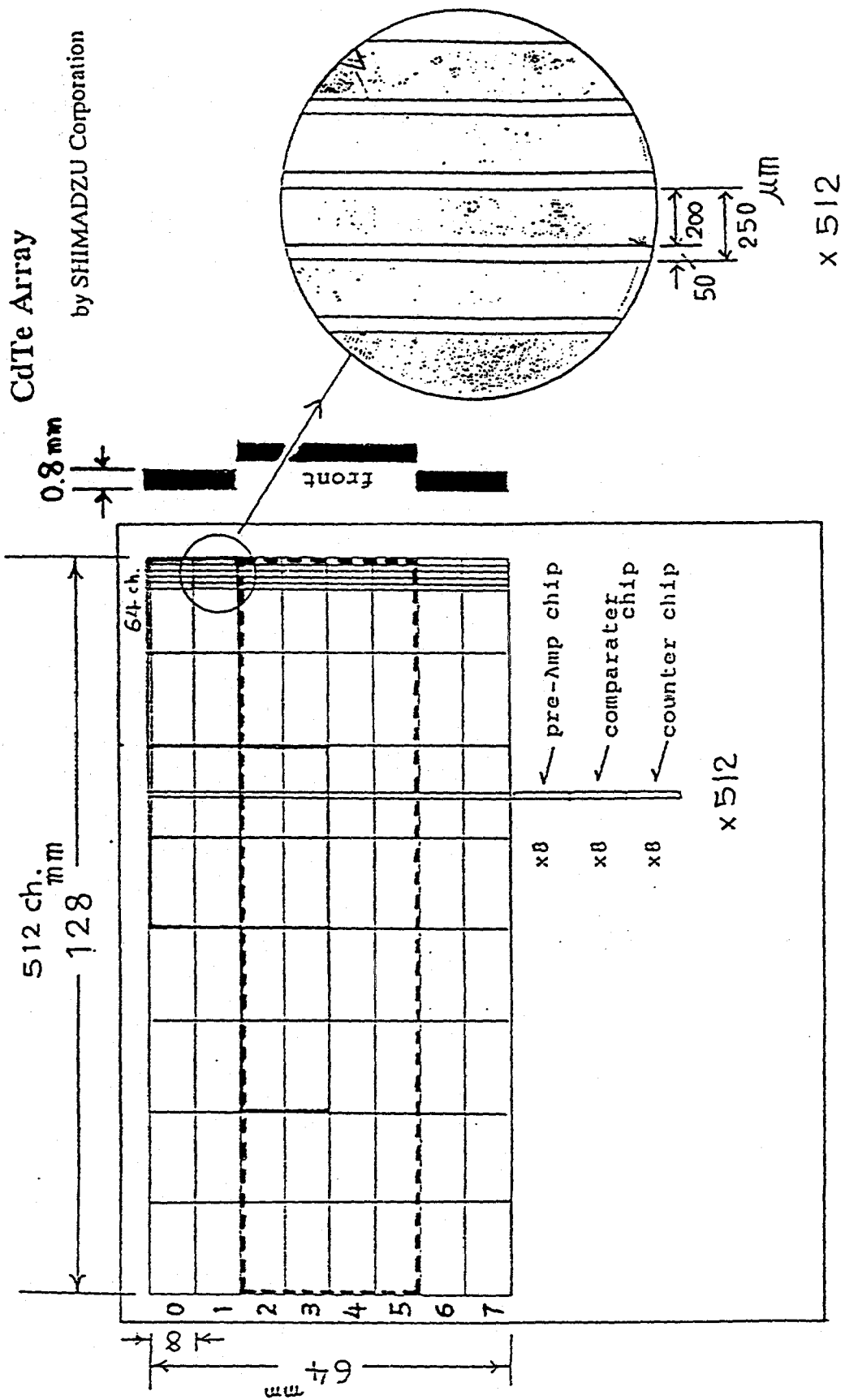
$$\sigma_{\theta} < 170 \mu\text{m}$$
$$\sigma_{\phi} < 100 \mu\text{m}$$

Detector Development at SPring-8

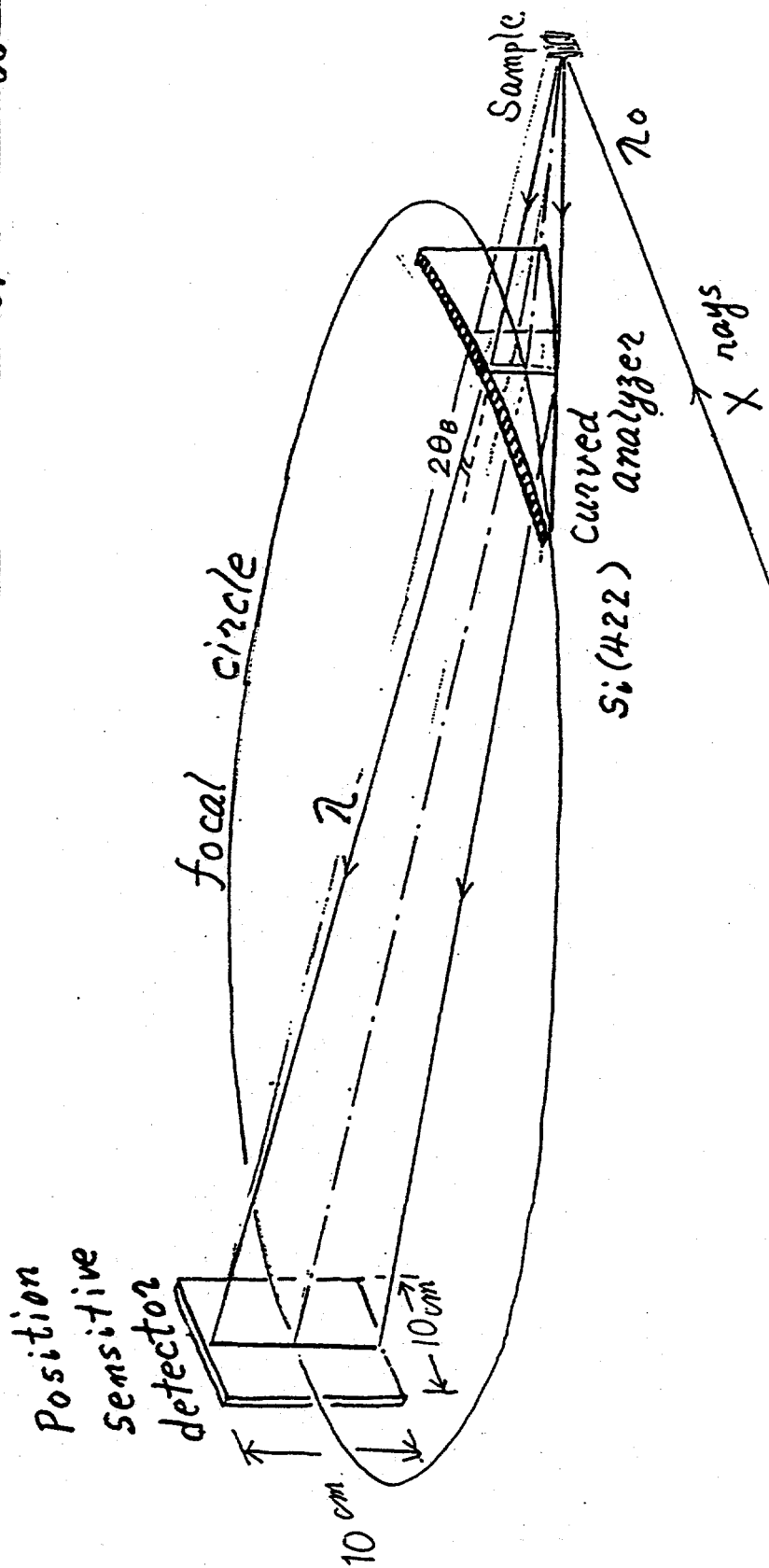
Masayo SUZUKI and Tatzuo UEKI

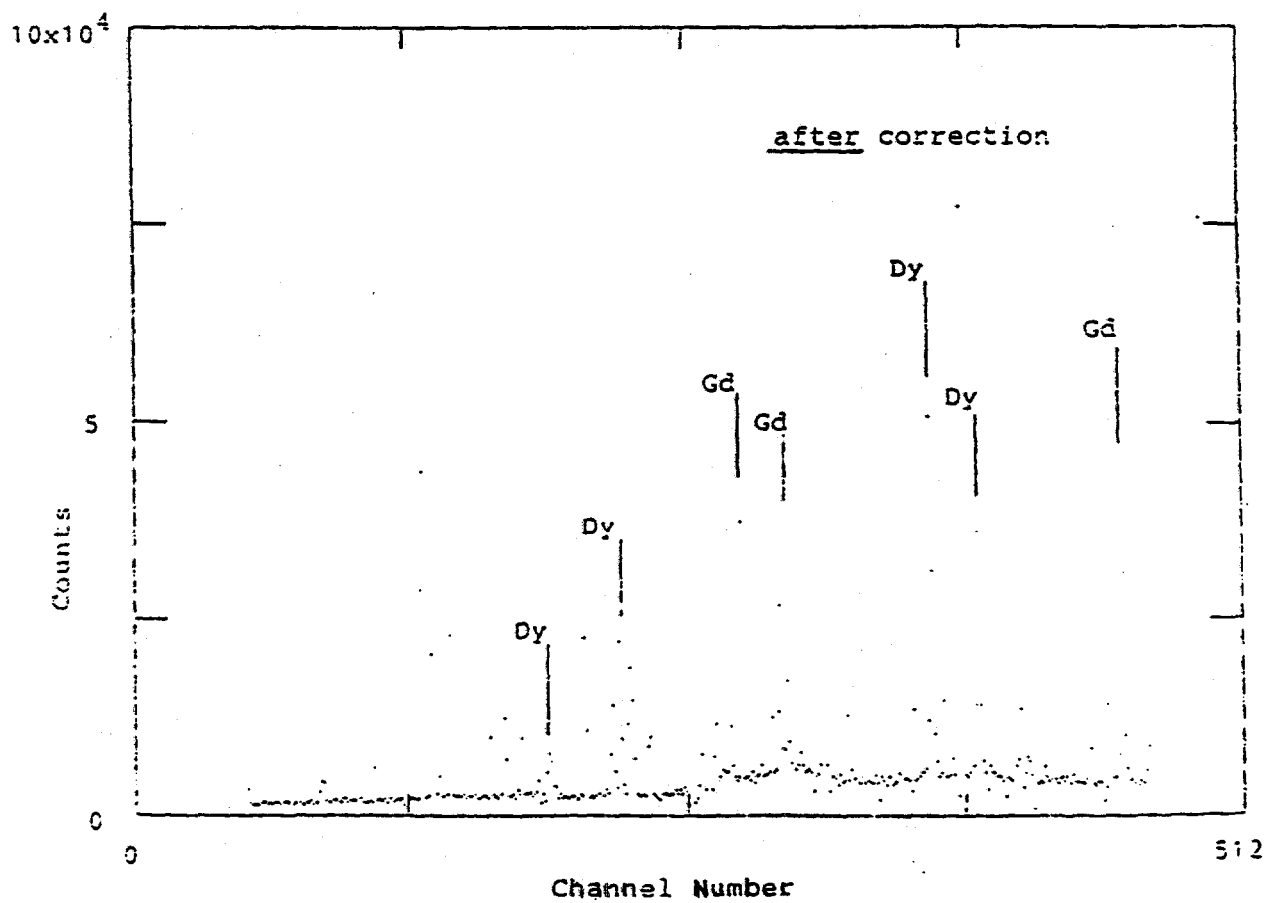
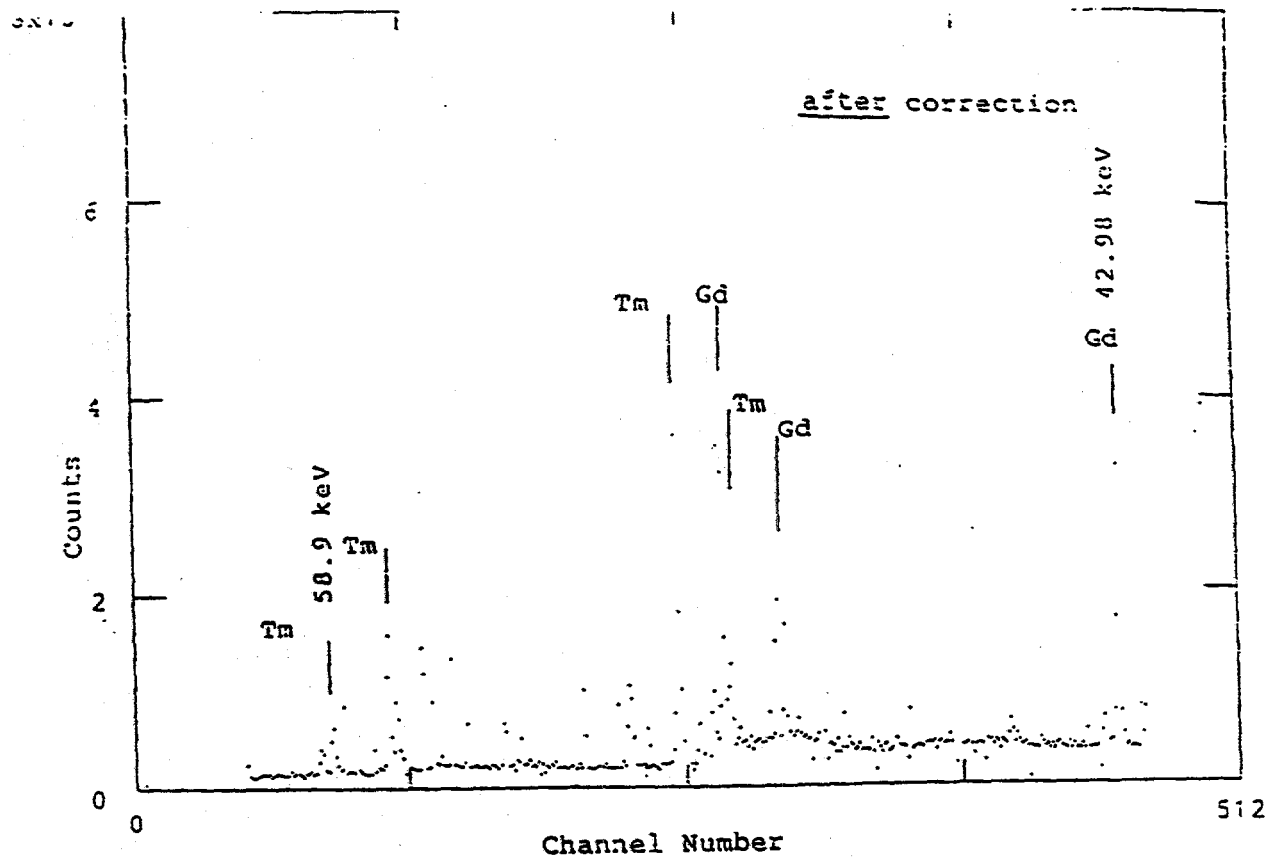
RIKEN, SPring-8 Project Team

- [1] CdTe Solid State Detector**
- [2] Ring-Cathode Proportional Detector**
- [3] Image Plate System**
- [4] X-ray Image Intensifier**
- [5] MicroStrip Gas Chamber**
- [6] Proportional Scintillation X-ray Imaging Chamber**

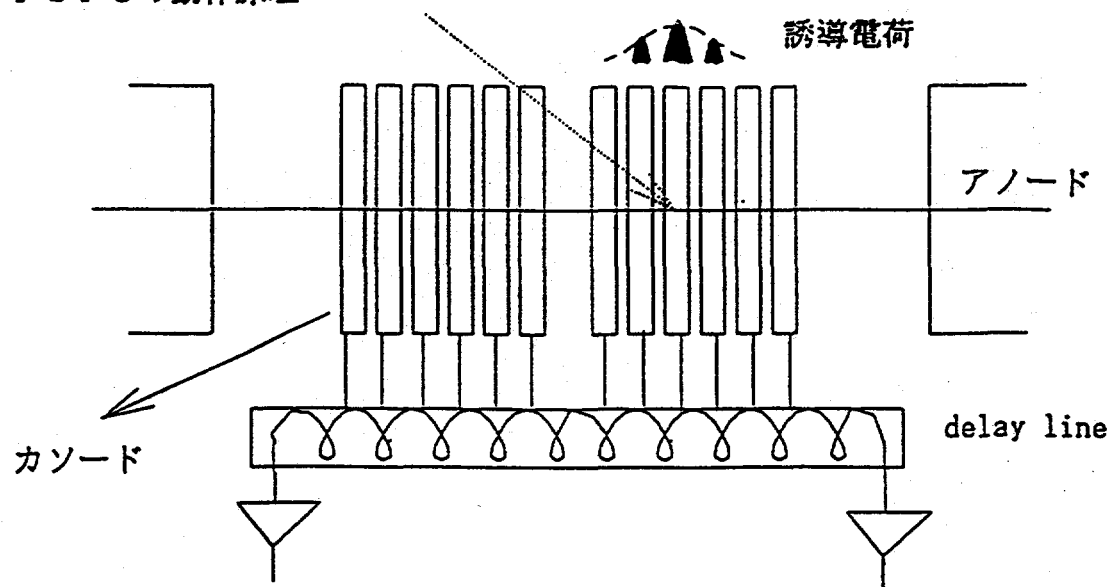


Cauchy's Type Analyzer

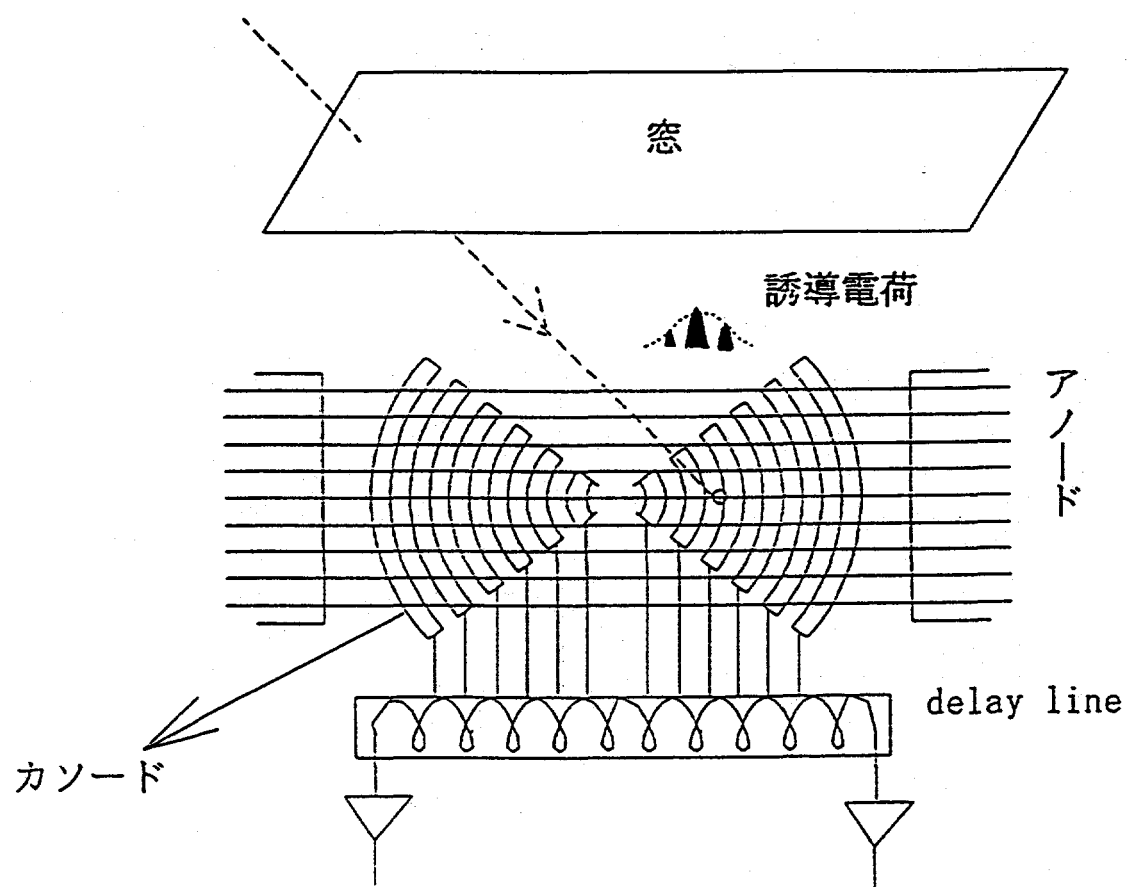




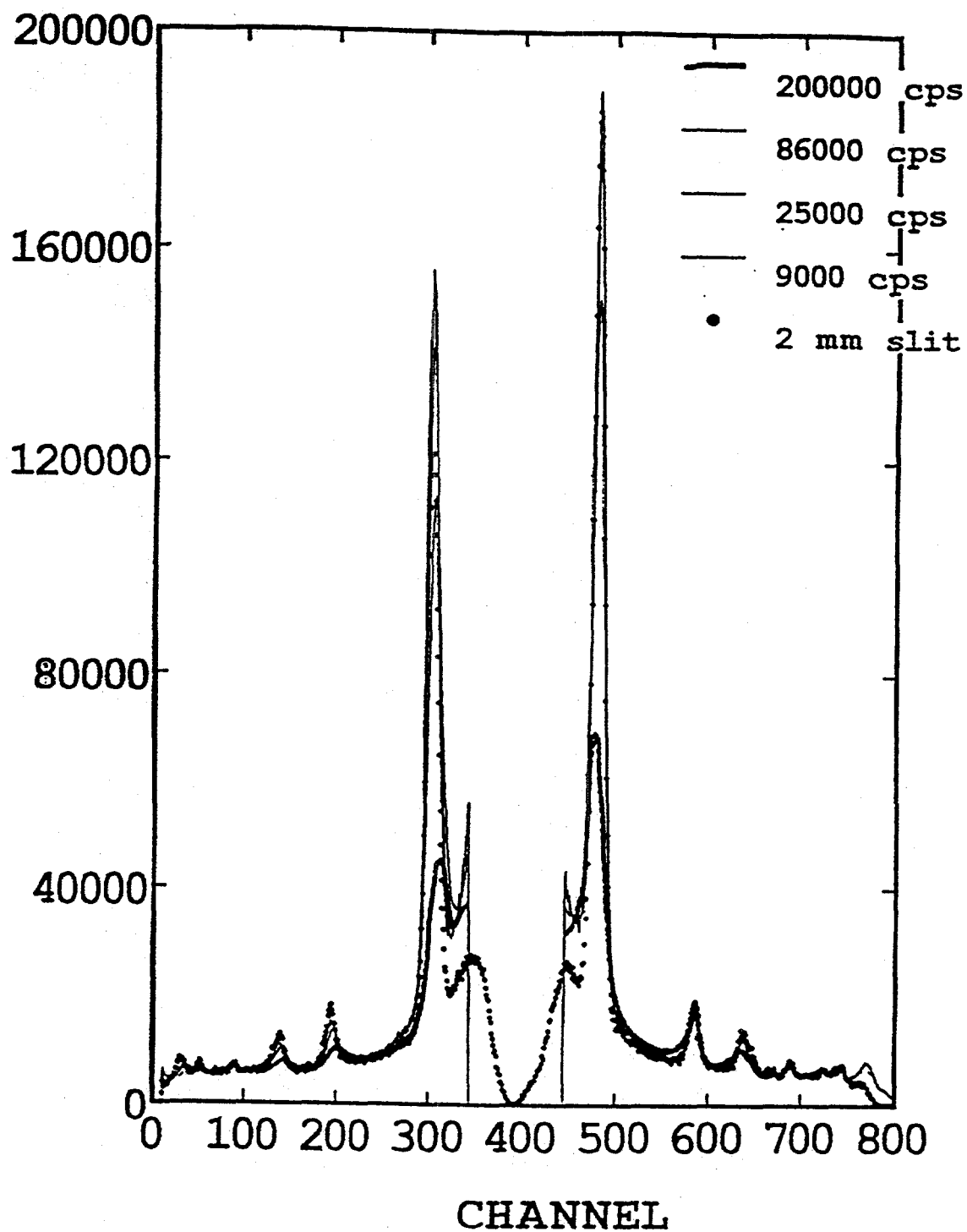
PSPCの動作原理



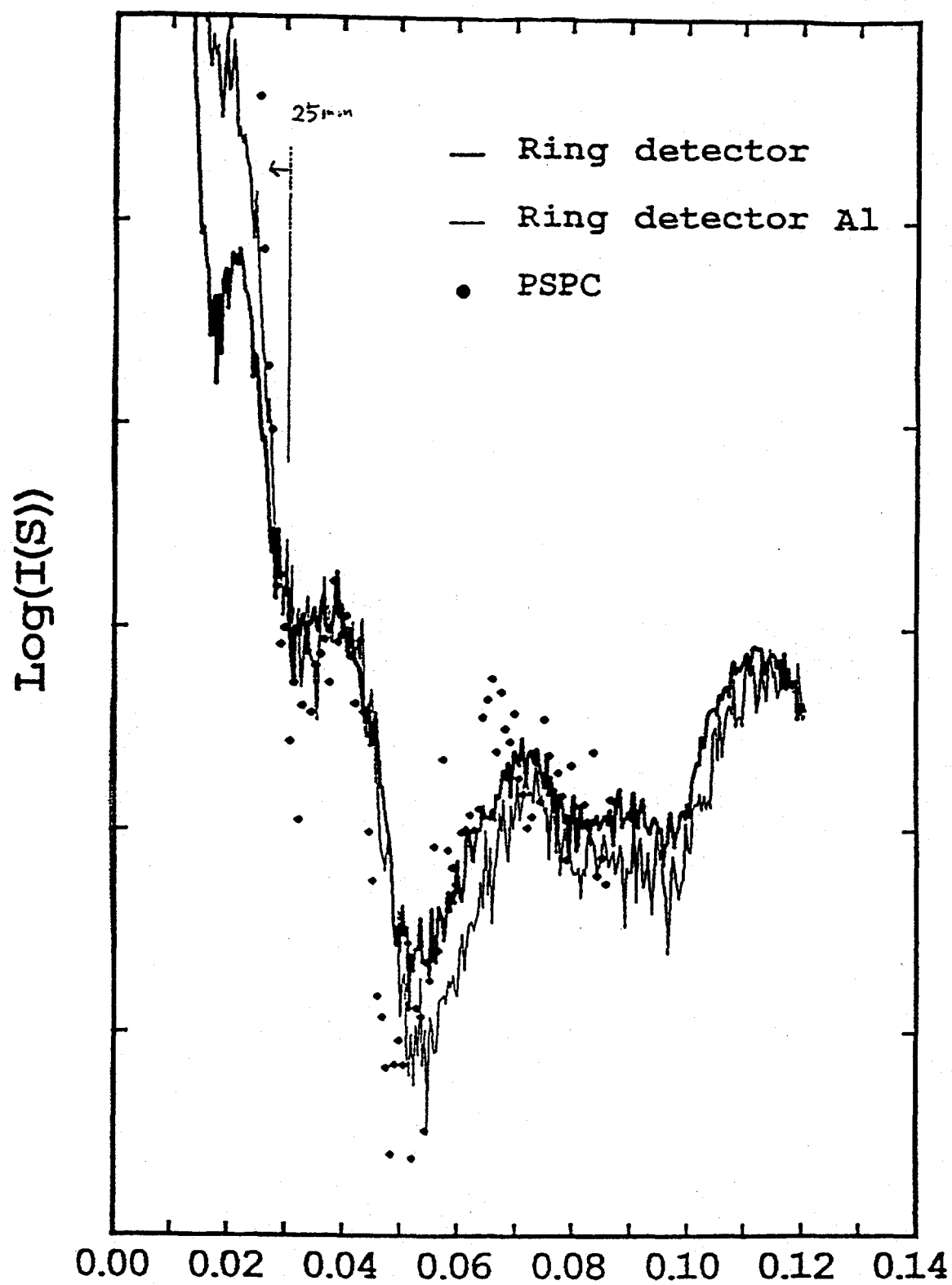
Ring detector



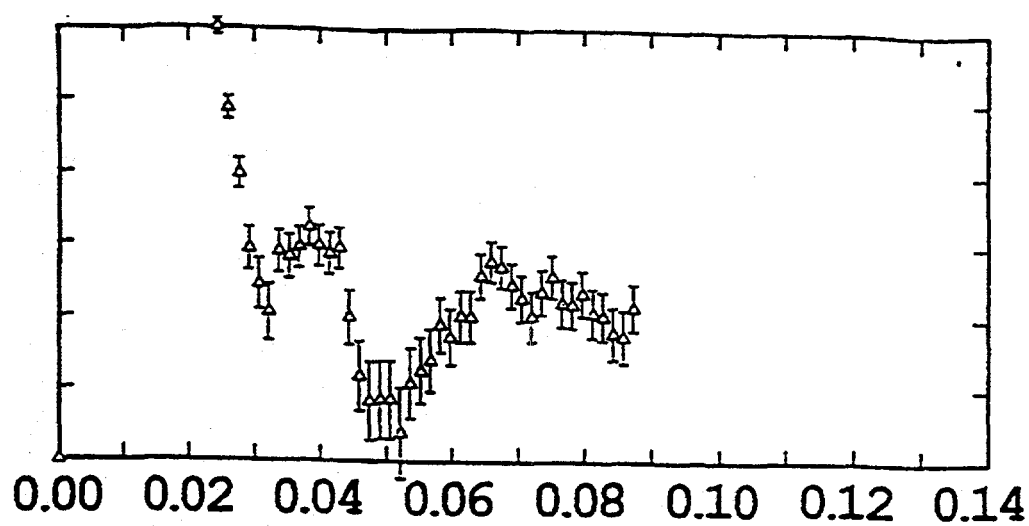
Ring-detectorの強度に対する感応性 (補正後)



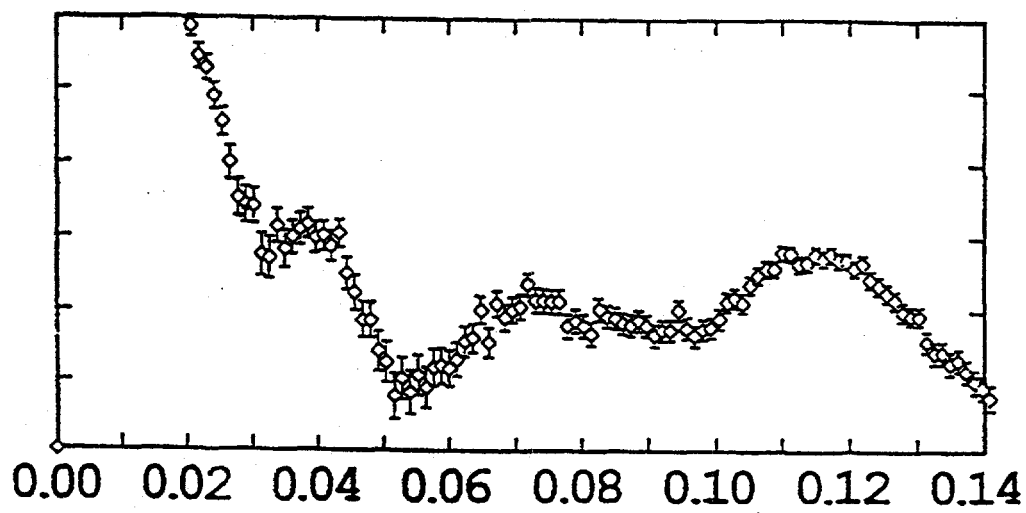
LDHの中広角散乱パターン



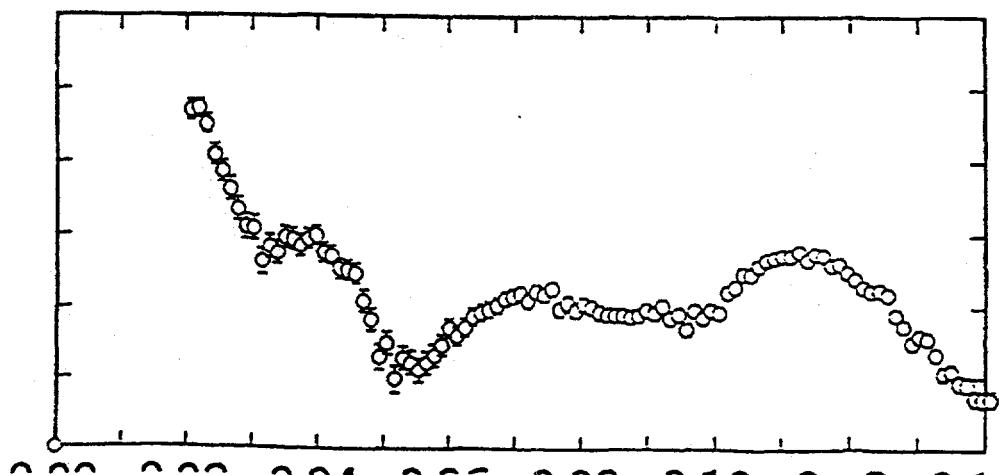
PSPC



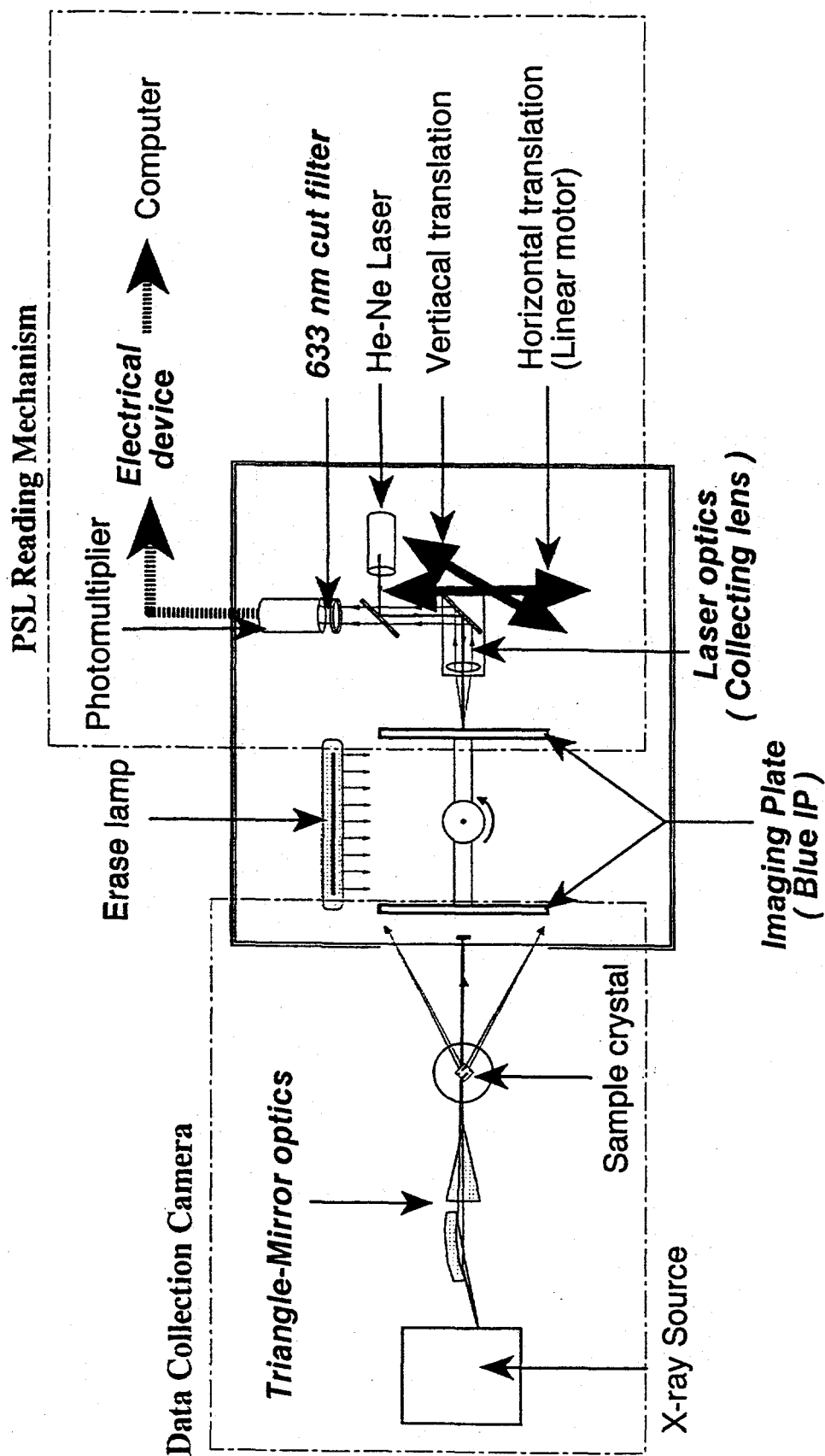
Ring detector with Al



Ring detector



Imaging Plate Detector System Design



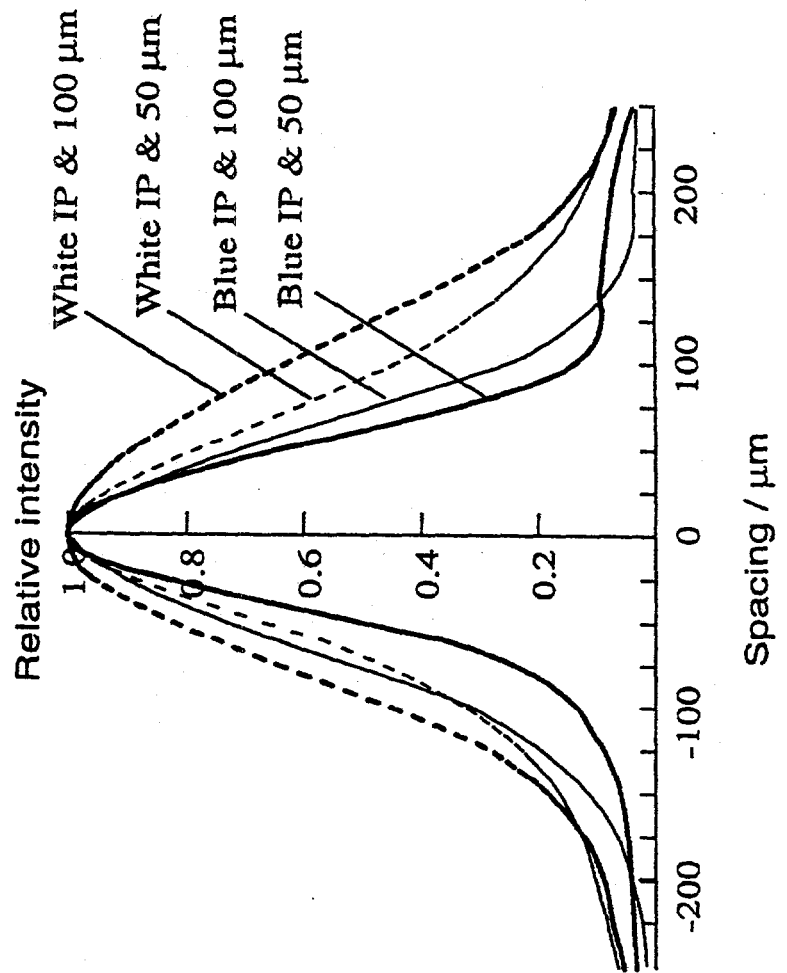
Preliminary Spatial Resolution TEST Influence of Changing Imaging Plate and Readout Resolution

White IP (conventional type)
Fuji film BAS-HR III

Pixel Size	FWHM
100 μm	190 μm
50 μm	140 μm

Blue IP (high resolution type)
Fuji film BAS-UR

Pixel Size	FWHM
100 μm	170 μm
50 μm	100 μm



Performance of The Imaging Plate Detector system

Spatial Resolution

Horizontal

53 μm (FWHM)

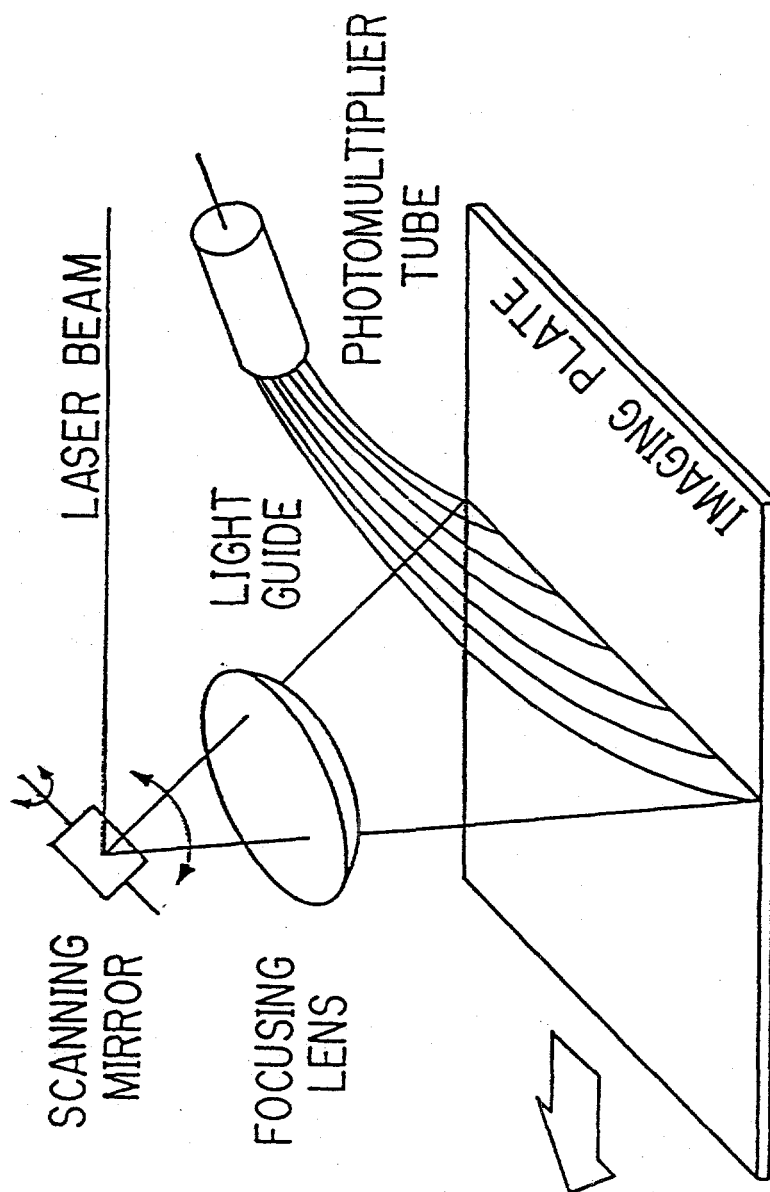
Vertical

73 μm (FWHM)

Sensitivity

The sensitivity of Blue IP is equal to that of White IP
reading at 50 μm pixel size.

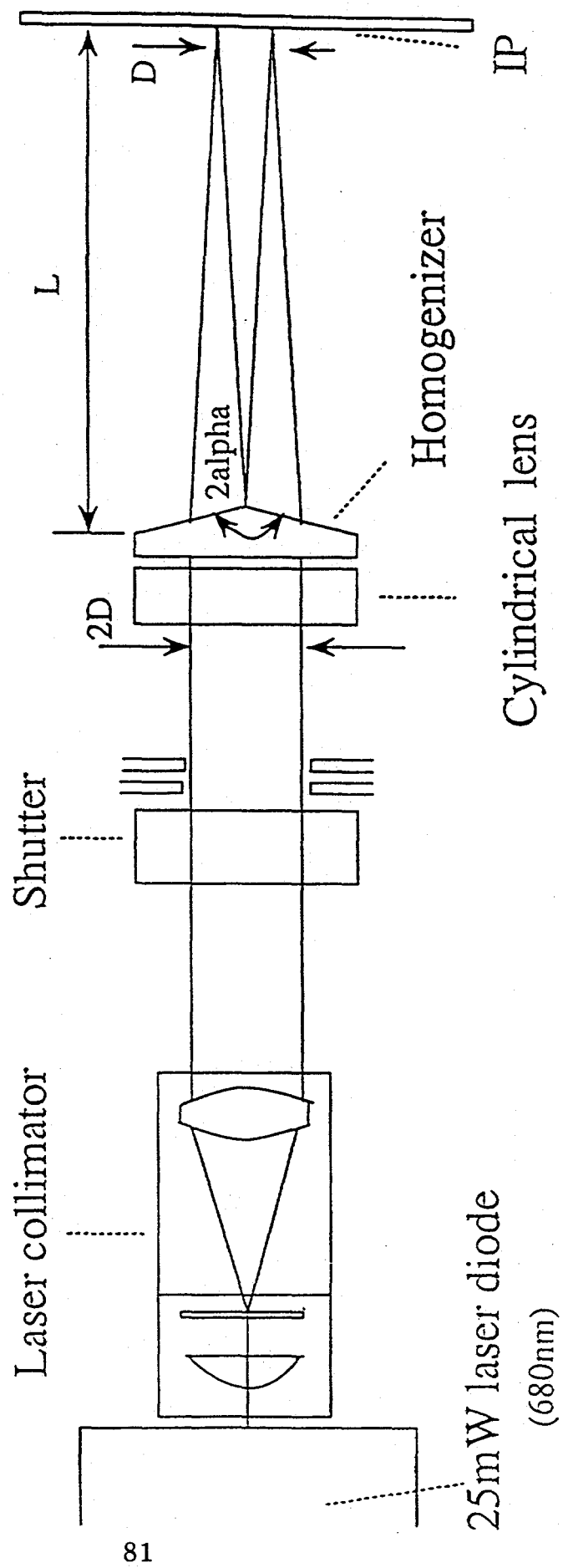
How to shorten the readout time



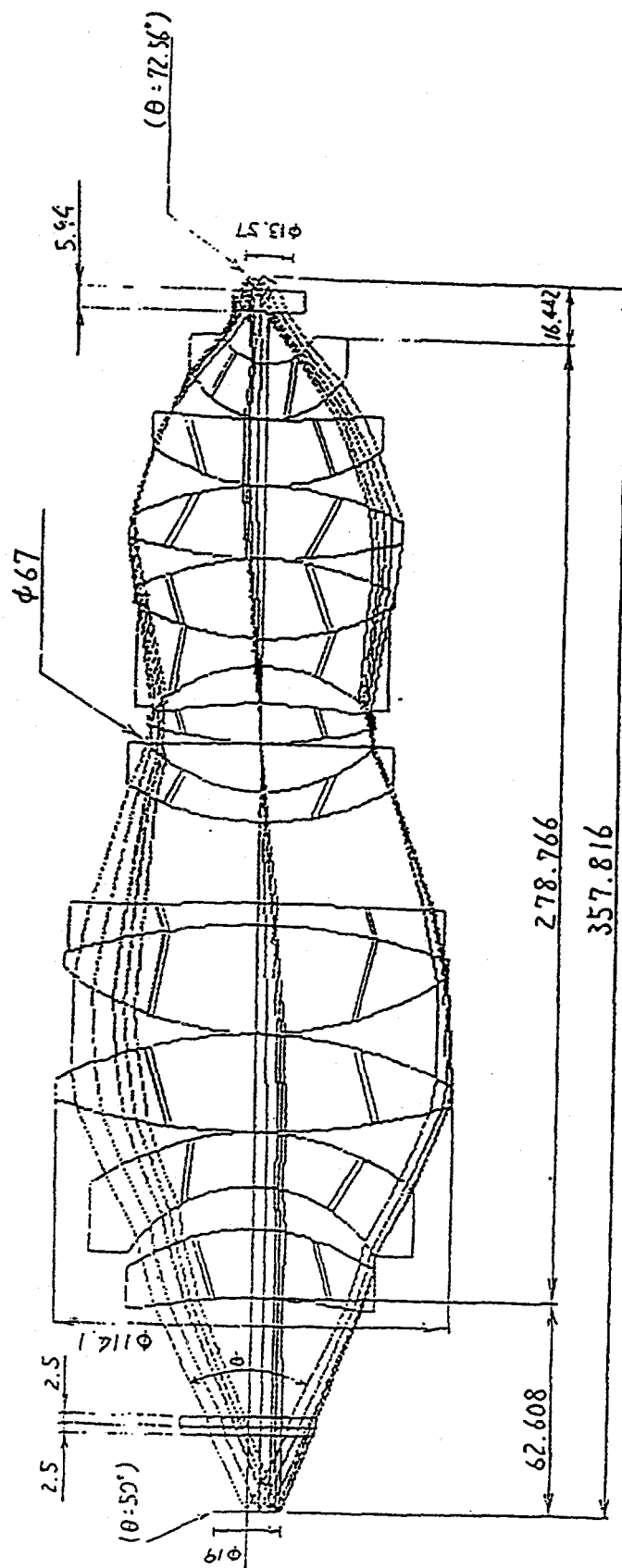
Lifetime of photostimulated luminescence (PSL) = $0.7 \mu\text{sec}$

Readout time = $5 \mu\text{sec/pixel}$ (point by point mechanism)

How to make the line shaped laser light

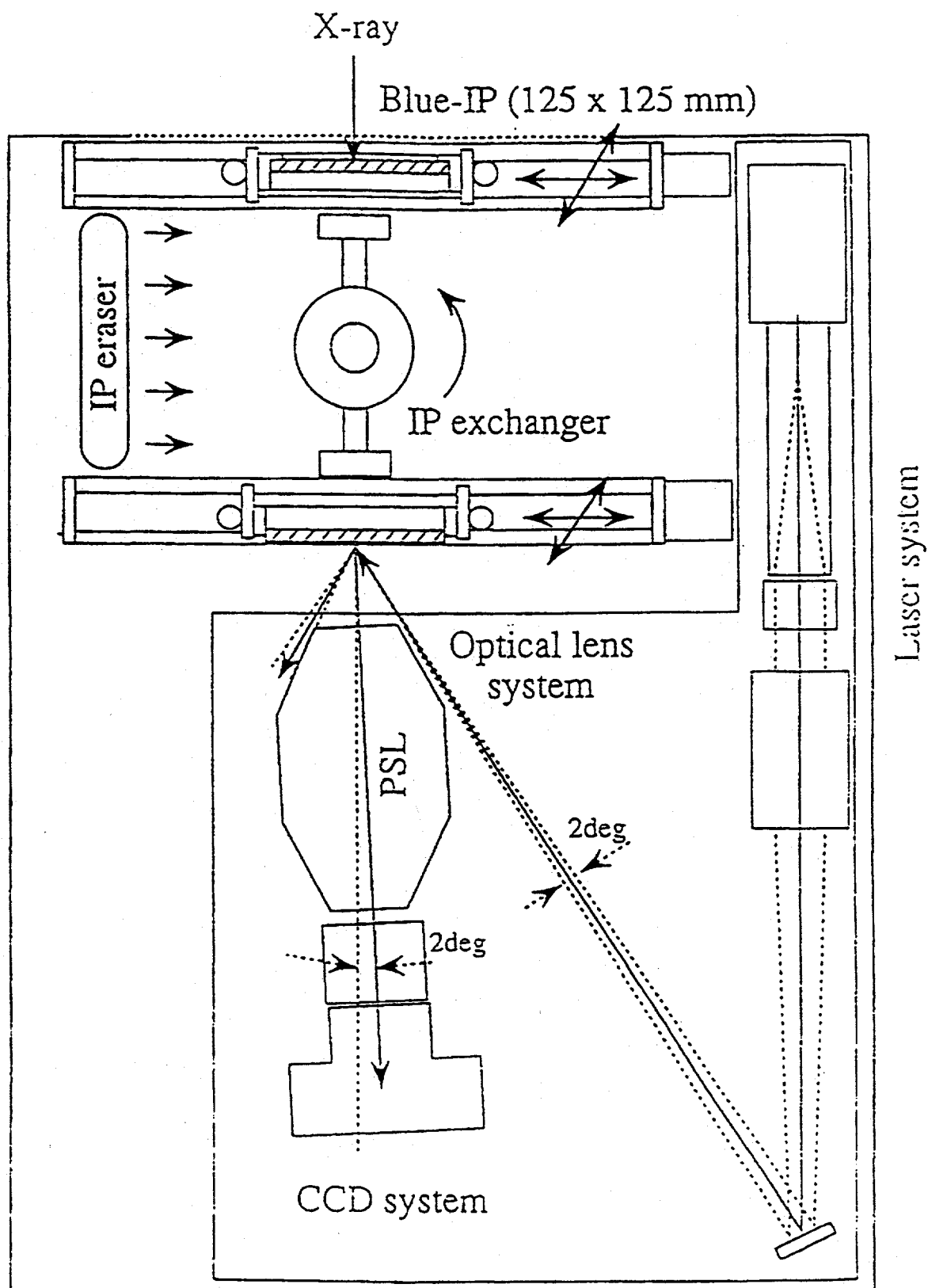


Specifications for optical lens system



Wavelength : 380 ~ 410 nm Magnification : 1/1.4
 Numerical aperture : 0.65 ($\theta=50\text{deg.}$) Aberration : 10 lp/mm (MTF50%)
 Transmittance : > 70%

Schematical drawing of prototype reader



FEB-11-'94 FRI 00:52

 TERM ID: XFD BLDG 362
 TEL NO.: (708) 252-3222

P-9999

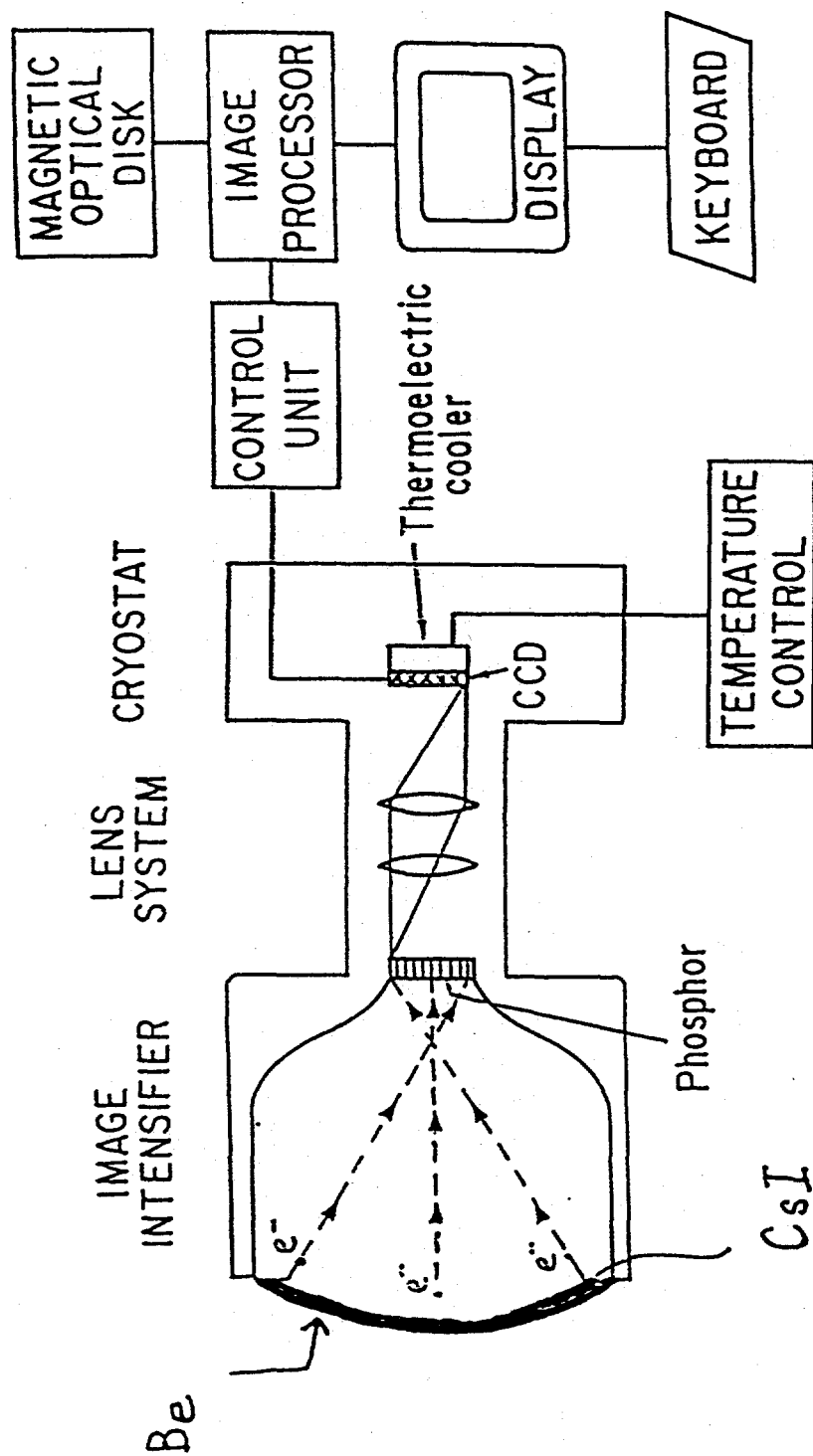
TRANSMIT RECORD

NO.	DATE	ST. TIME	TOTAL TIME	ABBR	ID	STATUS	#PGS	DEPT CODE	COMM. CODE
283	02-09	15:36	00° 00' 47		708 252 5753	OK	1		0688008000008800
284	02-09	16:13	00° 00' 42		TRA-CON INC	OK	1		0088008000009600
285	02-09	16:20	00° 00' 44		214 680 3331	OK	1		0688008000008400
286	02-09	16:25	00° 00' 53		712064851911	-	0		4680081000008000
287	02-09	16:27	00° 00' 52		712064851911	OK	1		0680008000008000
288	02-09	17:05	00° 05' 21		708 252 4500	OK	5		0688008000008810
289	02-10	08:47	00° 01' 44		715162823238	OK	3		0688008000008410
290	02-10	09:21	00° 05' 05		312 996 9016	OK	7		0688008000008810
291	02-10	09:26	00° 01' 23		1 708 252 5274	OK	2		0688008000009E13
292	02-10	10:00	00° 00' 48		708 252 5753	OK	1		0688008000008800
293	02-10	10:17	00° 01' 15		APS ASD DCC	OK	2		0088008000009611
294	02-10	10:29	00° 01' 25		312 996 9016	OK	2		0688008000008810
295	02-10	12:45	00° 01' 01		CTD TEL SUC	OK	1		0088008000009600
296	02-10	13:27	00° 01' 01		7082527305	OK	1		0688008000008800
297	02-10	14:18	00° 00' 53		25948	OK	1		0688008000009E00
298	02-10	14:23	00° 00' 45		048 462 4641	OK	1		0688008000008800
299	02-10	15:13	00° 00' 56		73497156	-	0		4680080200008816
300	02-10	15:21	00° 01' 02		7082527305	OK	1		0688008000008800
301	02-10	15:40	00° 02' 20		914 945 4407	OK	4		0688008000009011
302	02-10	15:59	00° 01' 01		7082527305	OK	1		0688008000008800
303	02-10	16:04	00° 02' 05		22948	OK	3		0688008000008810
304	02-10	16:24	00° 00' 48		7166343957	OK	1		0688008000003100
305	02-10	16:41	00° 08' 41		510 422 1370	OK	17		0688008000006610
306	02-10	16:52	00° 01' 43		7085623075	OK	3		068800800000A416
307	02-10	17:36	00° 01' 01		7082527305	OK	1		0688008000008800
TOTAL #PGS 61									

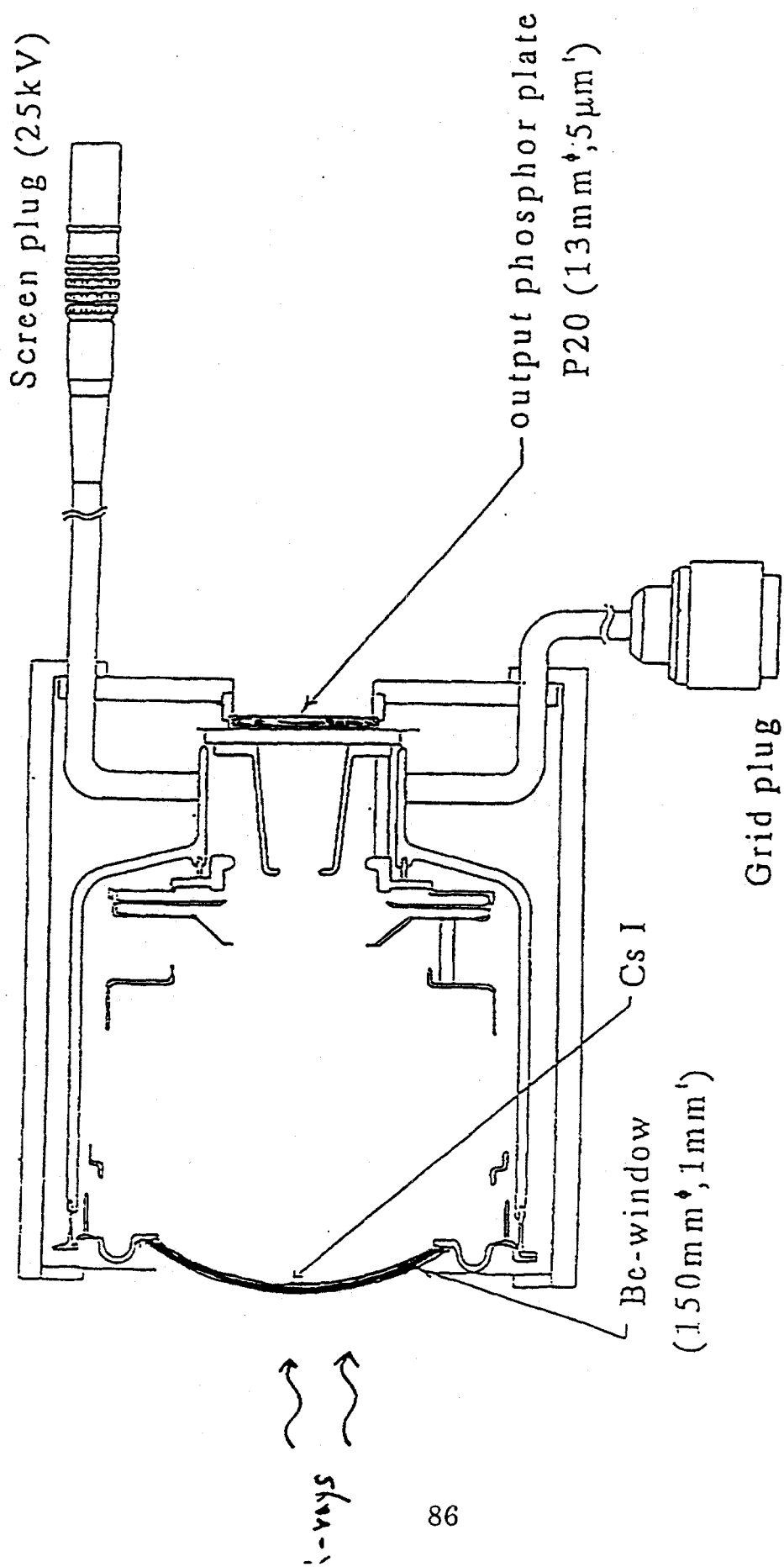
RECEIVE RECORD

NO.	DATE	ST. TIME	TOTAL TIME	ABBR	ID	STATUS	#PGS	DEPT CODE	COMM. CODE
268	02-09	15:30	00° 01' 13		ARGONNE MSD-223	OK	2		0088008000009600
---	02-09	16:07	00° 02' 04		516 282 5773	OK	4		0788008000000000
---	02-09	16:22	00° 01' 00		815 753 8565	OK	1		0688008000000000
---	02-09	16:34	00° 01' 15		7082527305	OK	1		0788008000000000
---	02-09	17:22	00° 00' 58			OK	1		0640080000000000
---	02-09	22:23	00° 04' 35		708 972 9647	OK	6		0680080000000000
---	02-10	04:49	00° 01' 45		7087786615	OK	2		0680080000000000
---	02-10	07:04	00° 00' 57		031 650 4743	OK	1		0688008000000000
---	02-10	08:31	00° 00' 49		1 317 453 0460	OK	1		0688008000000000
---	02-10	09:29	00° 00' 33		-63-	OK	1		0788008000000000
---	02-10	10:24	00° 03' 16		515 294 0689	OK	3		06E8008010000060
217	02-10	10:39	00° 00' 48		APS ASD DCC	OK	1		0088008000009600
---	02-10	11:15	00° 01' 08		615+483+2177	OK	2		0788008000000000
---	02-10	12:13	00° 00' 38		3137642193	OK	1		0788008000000000
---	02-10	12:19	00° 01' 06		619 562 3728	OK	1		0680080000000000
---	02-10	12:25	00° 03' 38		B E . -B.J.	OK	5		0680080000000070
---	02-10	12:52	00° 03' 35			OK	5		0680080000000000
---	02-10	13:12	00° 00' 56		13125673576	OK	1		0688008000000000
---	02-10	14:40	00° 01' 42			OK	3		0680080000000000
---	02-10	14:56	00° 01' 38		3174940706	-	0		4680081100000F0
---	02-10	15:00	00° 01' 22		5019688645	OK	2		0688008000000000
---	02-10	15:08	00° 00' 54		+708 674 4133	OK	1		0688008000000000
---	02-10	15:23	00° 08' 42		7085623075	OK	7		07F8008010000000
---	02-10	16:21	00° 00' 49			OK	1		0680080000000000
---	02-11	00:45	00° 06' 55		048 462 4641	OK	16		0788008000000000
TOTAL #PGS 69									

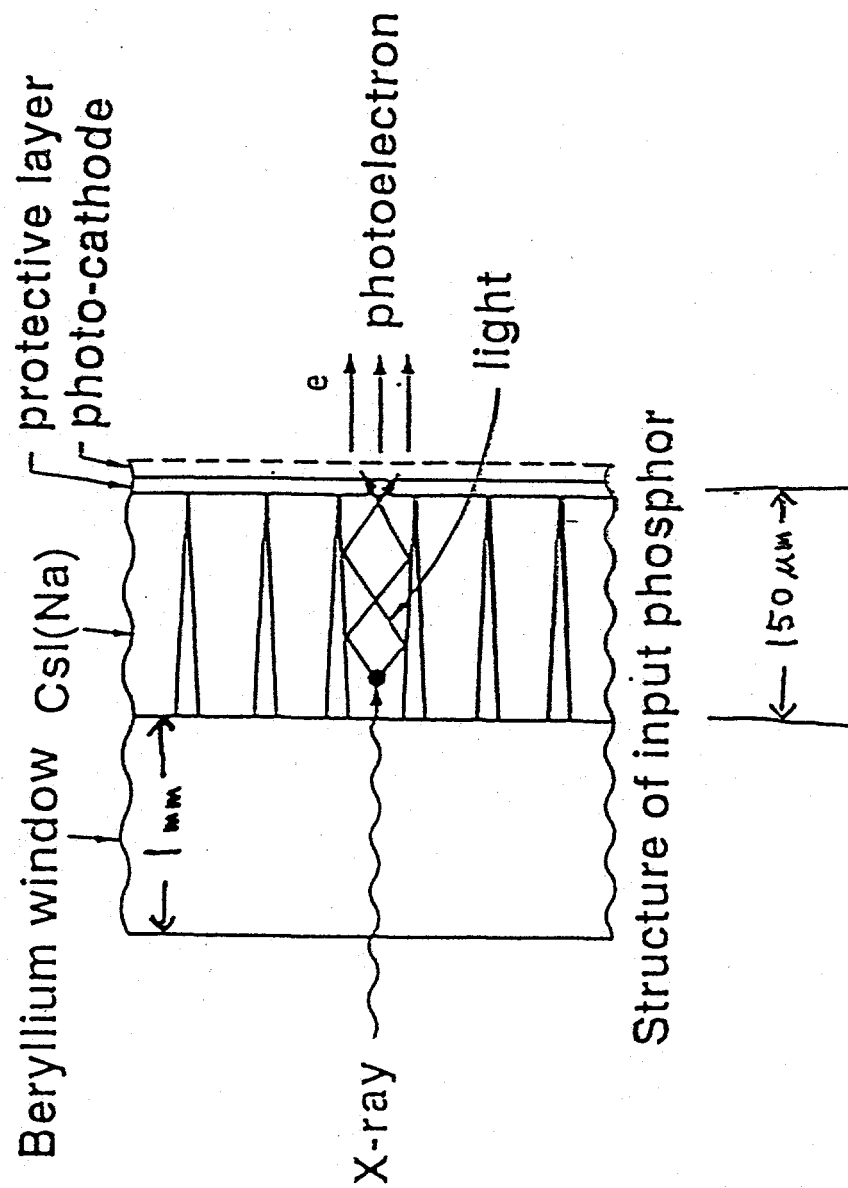
END PAGE

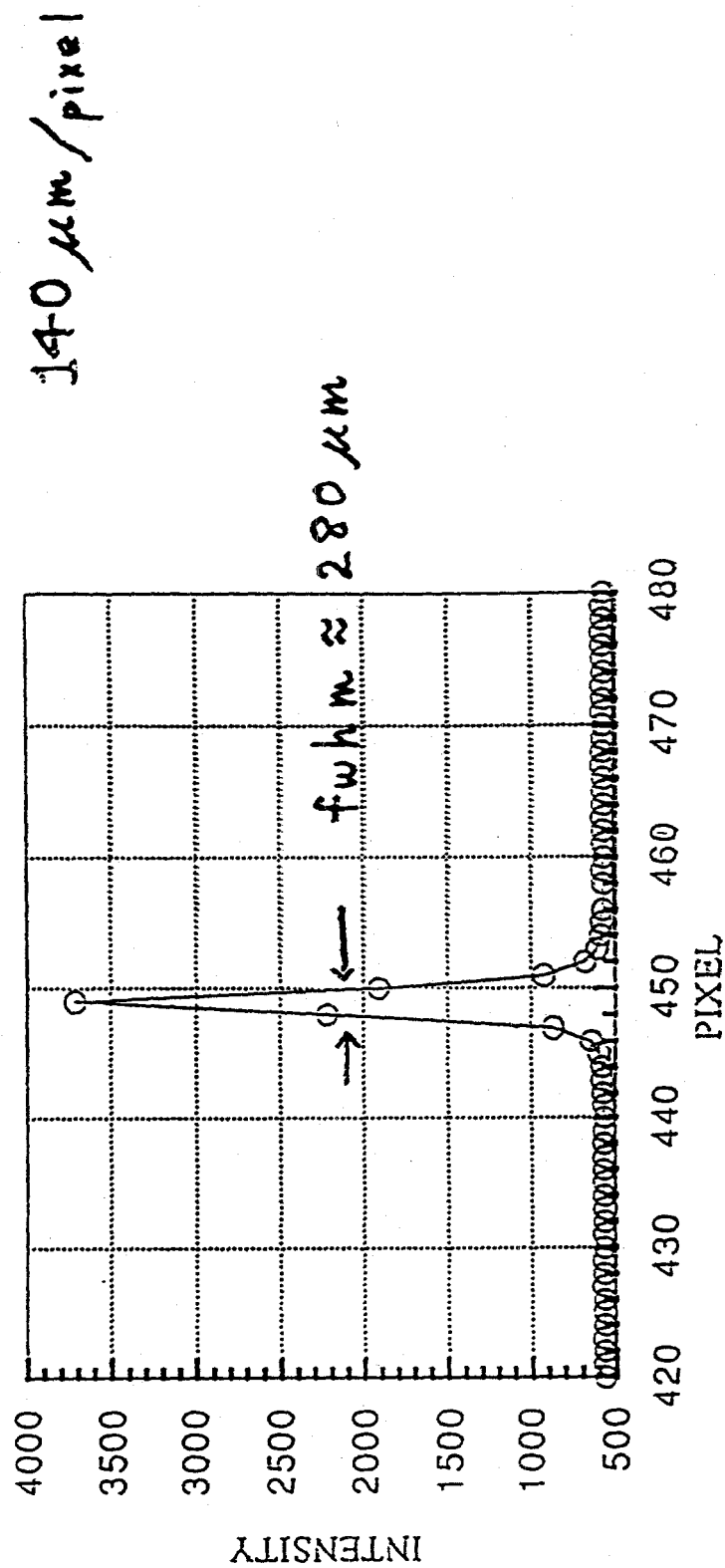


Schematics of the X-ray TV detector which utilizes the Be-window X ray image intensifier together with a cooled or a TV-rate CCD.



Be-windowed X-ray Image Intensifier





Development of Gas and Silicon X-ray Detectors at BNL

Some basic characteristics of two-dimensional detectors based on multiwire proportional chambers, developed at BNL over the last several years, are presented, including position resolution (about 100 μm FWHM for 8 keV in xenon), counting rate capability (a few 10^5 s^{-1}) and differential nonlinearity (of order $\pm 4\%$). The performance of a two-dimensional detector in combination with a purpose-built TDC, at the time-resolved beamline X12B of the NSLS, is described. A new generation of very high rate two-dimensional proportional chambers are now being developed in which the fundamental limit to position resolution will be achieved, but the limitations associated with counting one event at a time will be very much reduced. In this new class of device, based on similar principles to those being developed for multiparticle detection in high energy and nuclear physics experiments, position readout is carried out solely on the rear cathode, which is fabricated as an array of geometrically shaped pads. With close anode-wire spacing of less than one millimeter and compact low-noise preamplifiers fabricated in monolithic form, a detector of area 20 cm x 20 cm is being designed with over 10^8 s^{-1} rate capability.

Silicon drift chambers have been under development for about ten years; however, their main application so far has been as position-sensitive devices for high-energy physics. X-ray detection has, nevertheless, been demonstrated and several very attractive features of this concept should be noted. The potential for this structure in the synchrotron environment will be reviewed and results to date will be summarized.

SILICON DRIFT DETECTORS

H. W. Kraner, BNL

2/14/94

INTRODUCTION

Operation, principles

Fabrication considerations

Survey of types, geometries

linear, cylindrical, spiral, CCD

SPECIFIC EXPERIENCE

3" cylindrical drift chamber

4x4cm STAR1 prototype linear

PHOTON DETECTORS

cylindrical, 241Am

windows

INVENTORS: P. Rehak and E. Gatti

MAJOR CONTRIBUTORS: MPI group, L. Struder, P. Holl
J. Kemmer, also J. Walton LBL

PRINCIPLES OF SILICON DRIFT DETECTOR

(Rehak et al)

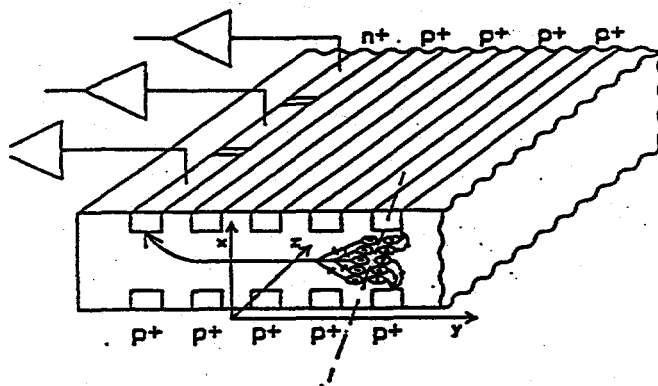


Figure 1: Perspective view (not to scale) of a semiconductor drift detector. Electrons created by an ionising particle are transported long distances parallel to the detector surface. The anode is divided into short segments to measure the coordinate perpendicular to the drift direction.

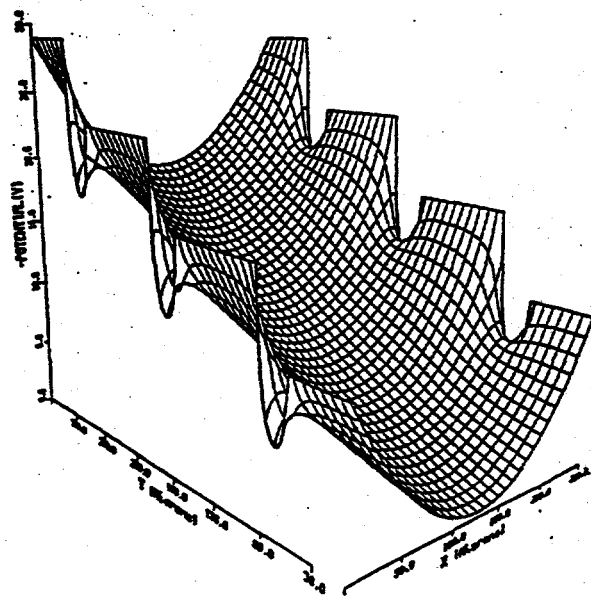


Figure 7: Negative potential in a radial cross section (called "Y") of the detector. Equipotentials imposed at both surfaces of the detector are the rectifying junctions. Surface between rectifying junctions is covered by SiO_2 . Potential at this surface depends on the global design of the detector.

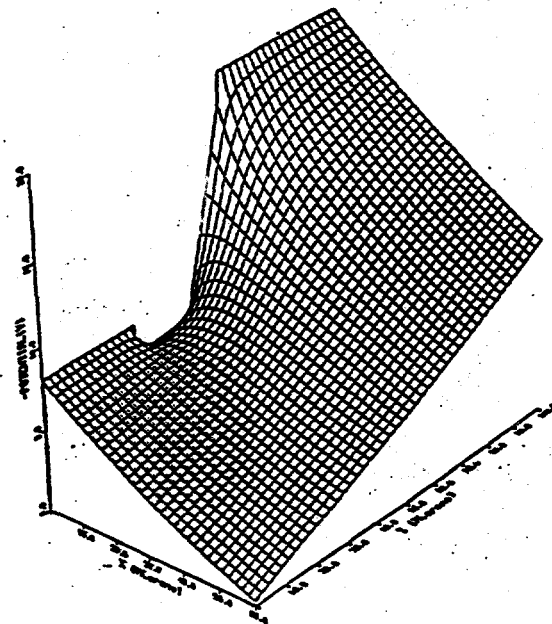


Figure 8: Detail of negative potential in a cross section of the detector close to the surface. The potential is defined in the p^+ implants of two rings at both sides of the $\text{Si} - \text{SiO}_2$ interface. The secondary valley contains some electrons which form a conductive channel. There is still a barrier which prevents electrons generated on the $\text{Si} - \text{SiO}_2$ interface to reach the main valley of the detector.

FABRICATION CONSIDERATIONS

Silicon: usually n-type, controllable surfaces
must be uniformly doped---NTD doped
Process should retain lifetime
Wacker cooperation

Complicated device structure (8-10 mask levels)
many process steps, continual inspection
considerable chance for fatal errors
(defects/wafer, not per die)
two-sided device, backside alignment
required, backside integrity to be
maintained

Limited interest by commercial firms
no US commercial fab

Design requires serious simulation including Poisson

"Progress in Semiconductor Drift Detectors", Rehak et al
NIM A248, 367 (1986).

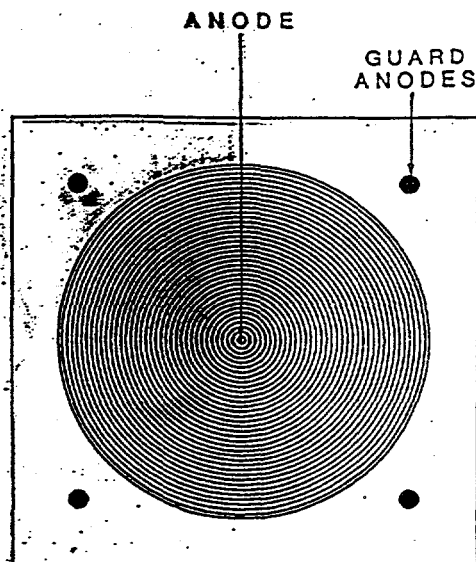


Fig. 6. Top view of the N-side of the circular SDC. The signal anode is the 200 m diameter circle in the center.

1 cm diam. Anode C ≈ 0.06 pf

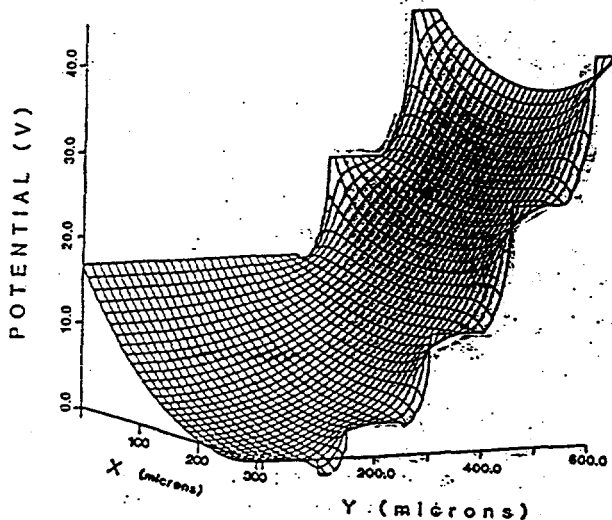
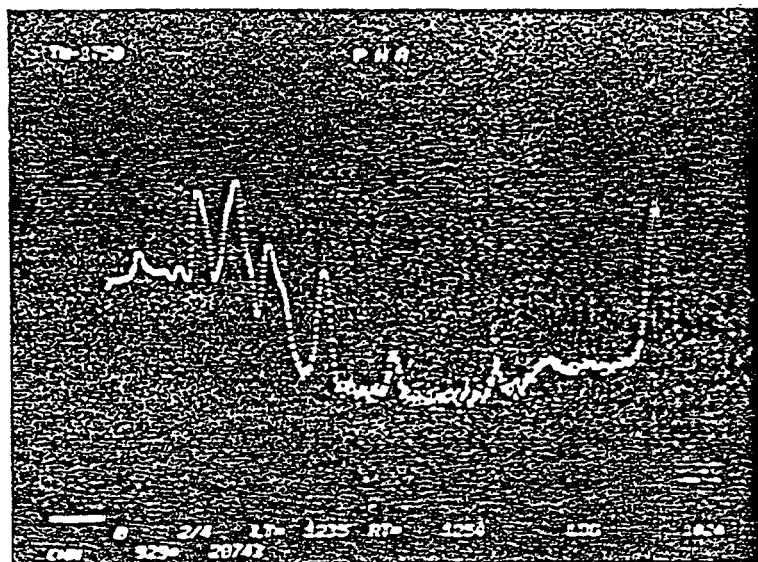


Fig. 9. Potential energy of electrons for the circular drift chamber.

LOG COUNTS



Total Input C
(2N4416) ≈ 5 pf

Noise 170 e rm
(930 eV FWHM)
@ 250 nsec
shaping
 $I_e \sim 3$ mA

Various 10-20 keV
L x-rays

60 keV
241 Am γ

SPIRAL CYLINDRICAL DRIFT DETECTOR

Gatti et al IEEE TNS 36, 203 (1989)

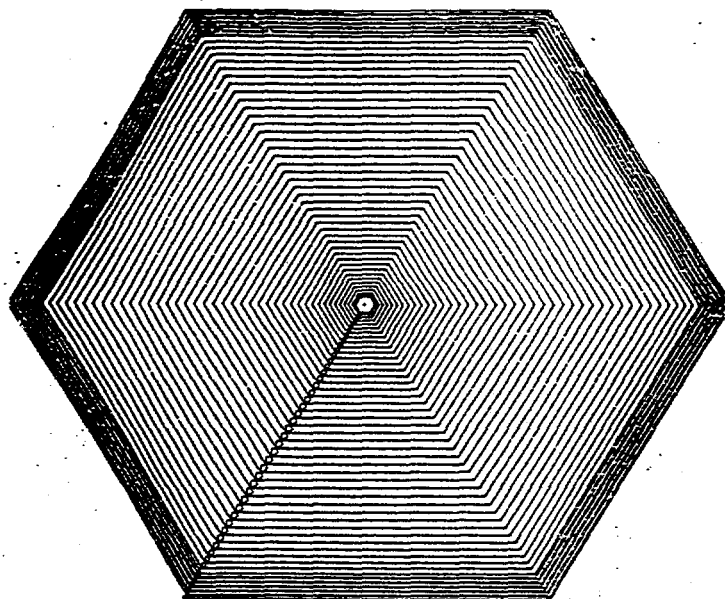


Fig. 2.2: n -side of the spiral detector. Two intertwined hexagonal spirals are visible. The wider spiral is a rectifying p^+ implant; the narrower spiral is the thermally grown SiO_2 . Both spirals are running from the outer radius to the center of the detector where the signal anode is located.

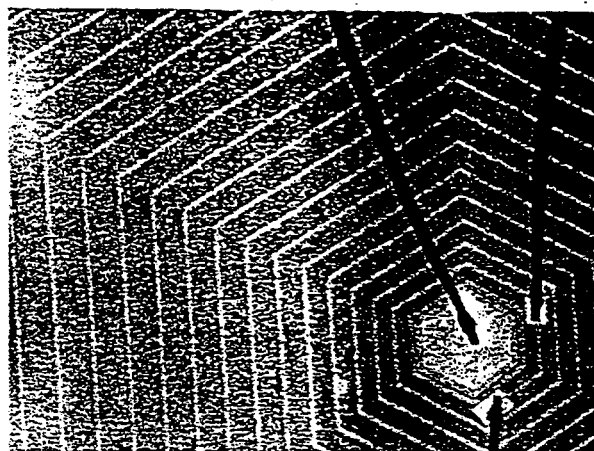


Fig. 2.4: Microphotograph of the central part of the detector. The large central hexagon is the anode. The lower bond is the connection to the final closed turn of the p^+ spiral. The bond at the right hand side is the connection to the guard sink.

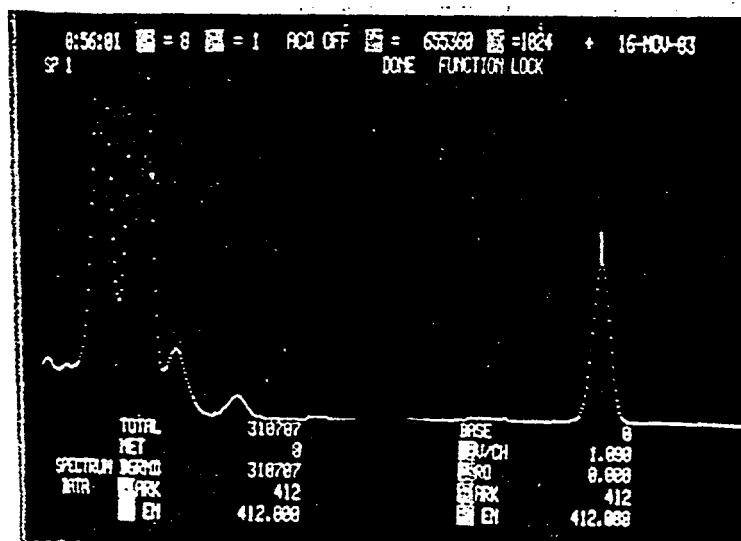


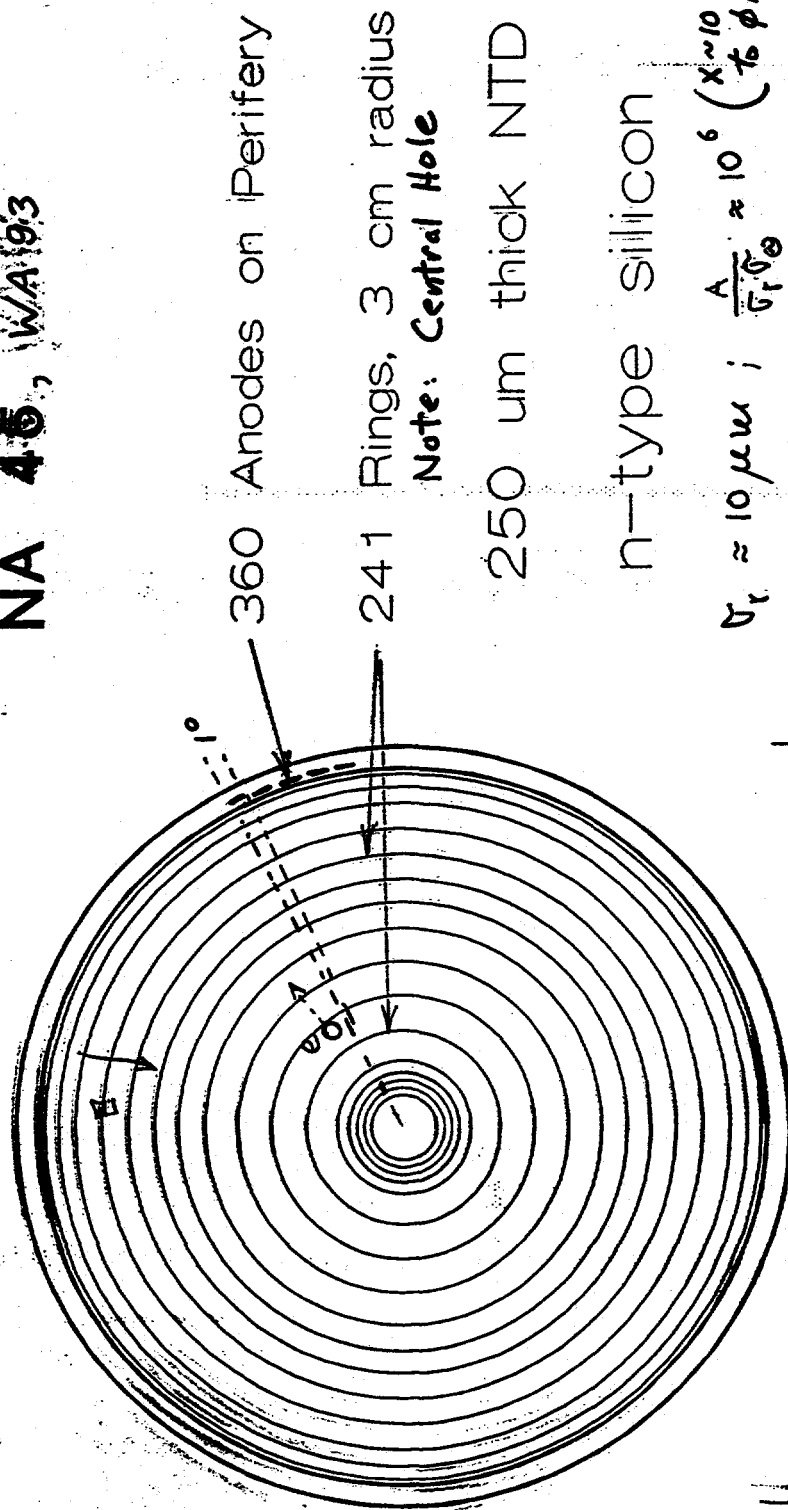
Fig. 4.3: Am^{241} X-ray spectrum obtained with a Silicon Spiral Detector and a commercially available preamplifier RL-791/1 (linear scale).

Gatti, Rehak

Chev, Krauer, Li

Silicon Drift Chamber

NA 45, W/A 93



$$V_r \approx 10 \mu\text{m} ; \frac{A}{V_r \phi} \approx 10^6 \left(\frac{X \sim 10 \text{ dx}}{t_0 \phi_{\text{NTD}}}\right)$$

{ Number of independent pixels $\approx$ }
 $\approx 5 \times 10^6$

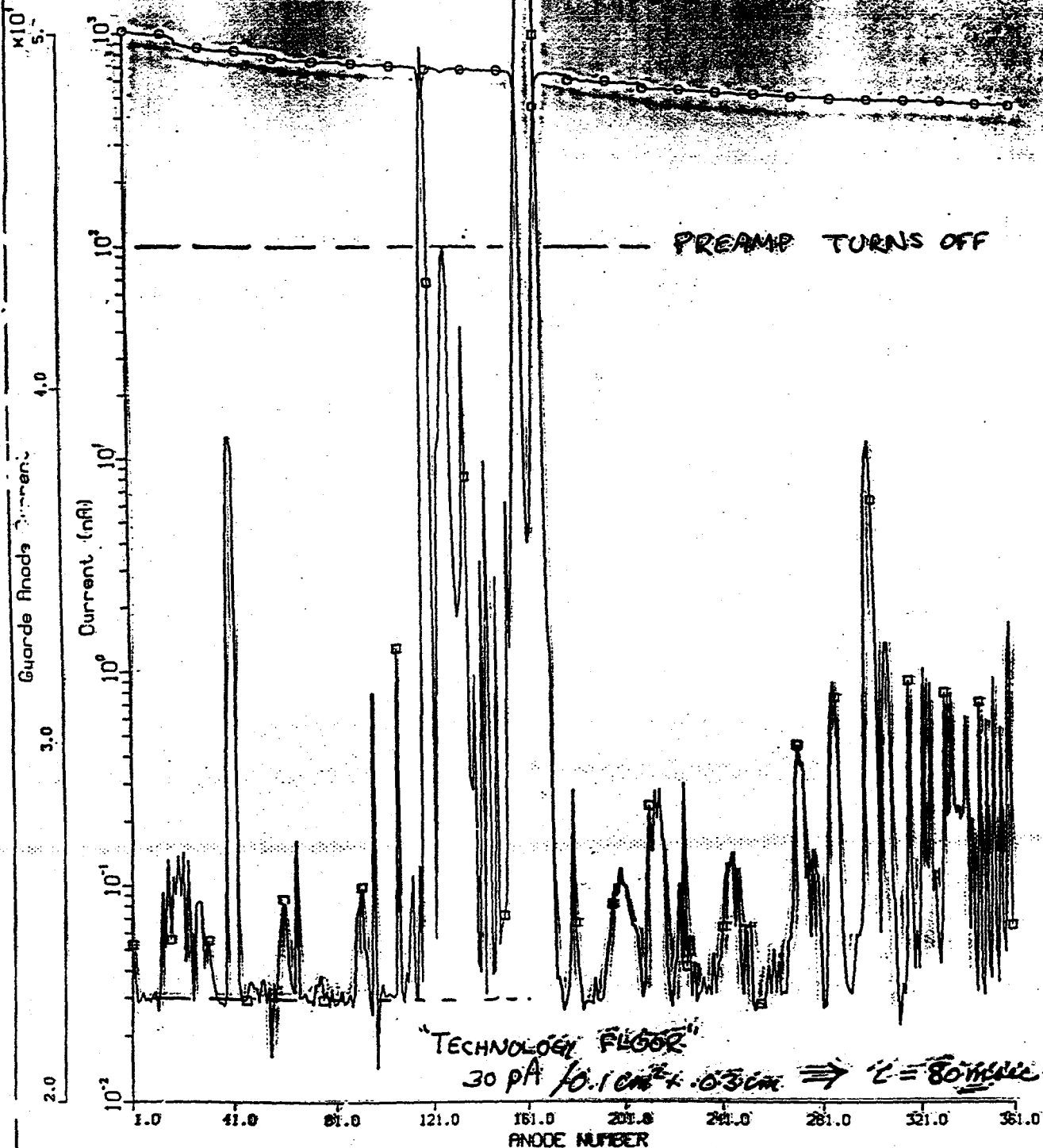
~120 processing steps, inspections
8 Level Mask set. Double Sided

NA 45

B25. Rg. 229 at -1392V.

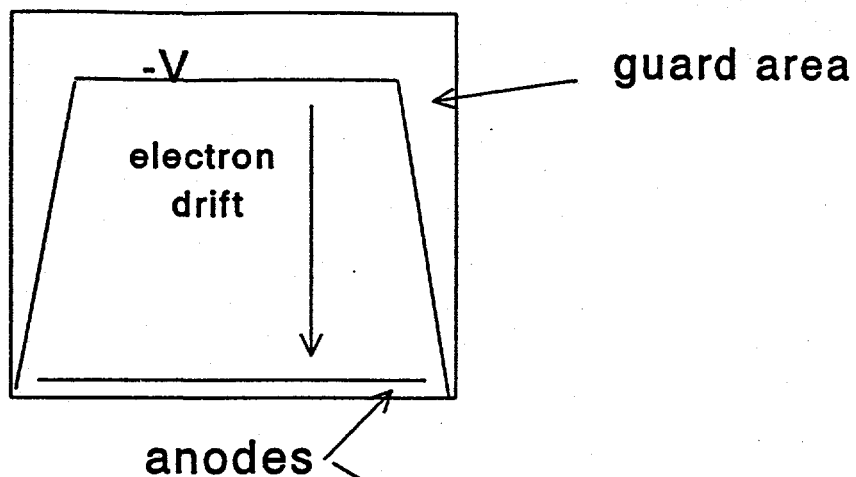
03-26-1992

Sum anode 1s 0.6405E+05 nA. Avg. grd 0.4859E+05 nA

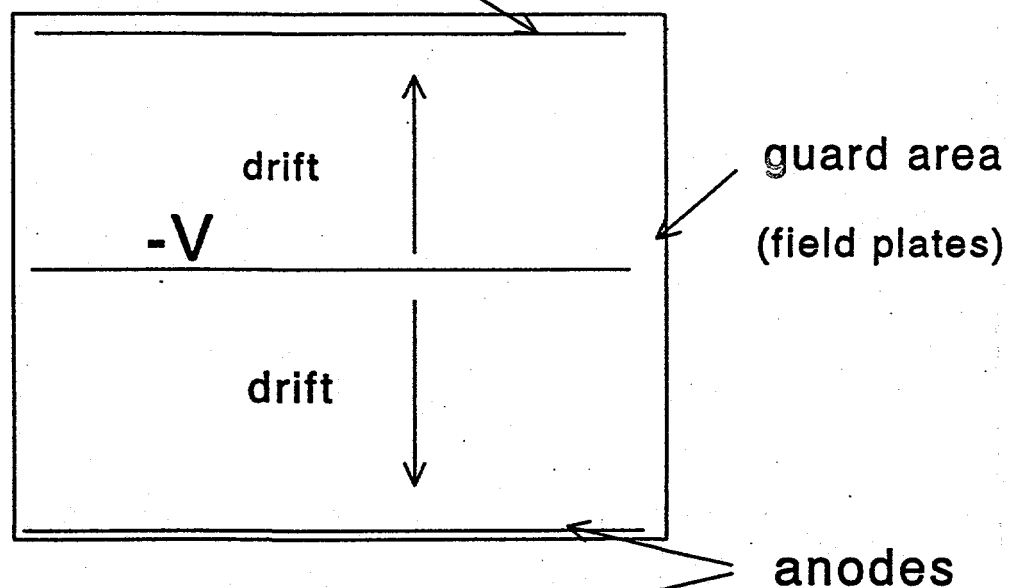


STAR PROTOTYPE DRIFT DETECTORS

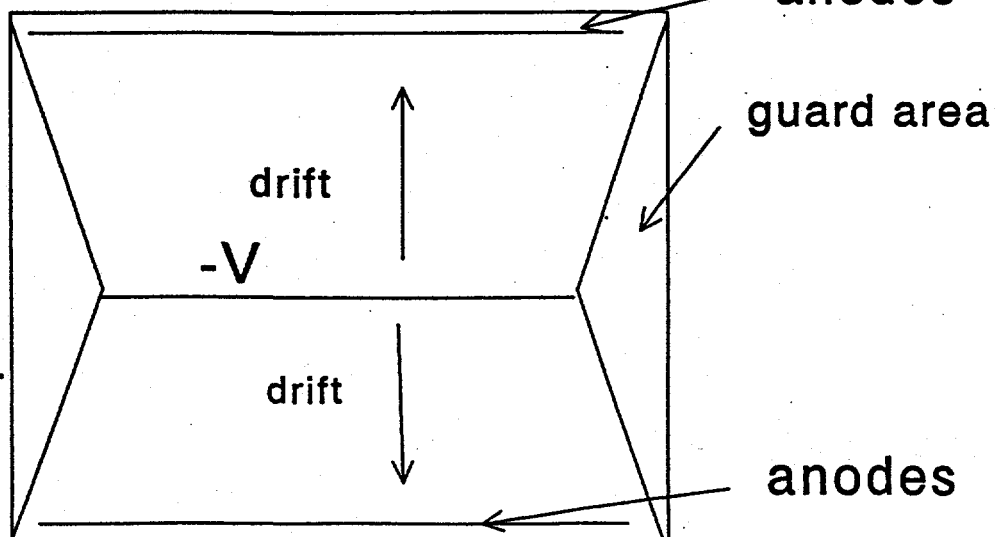
STAR 1
4 x 4 cm
July 93
OK



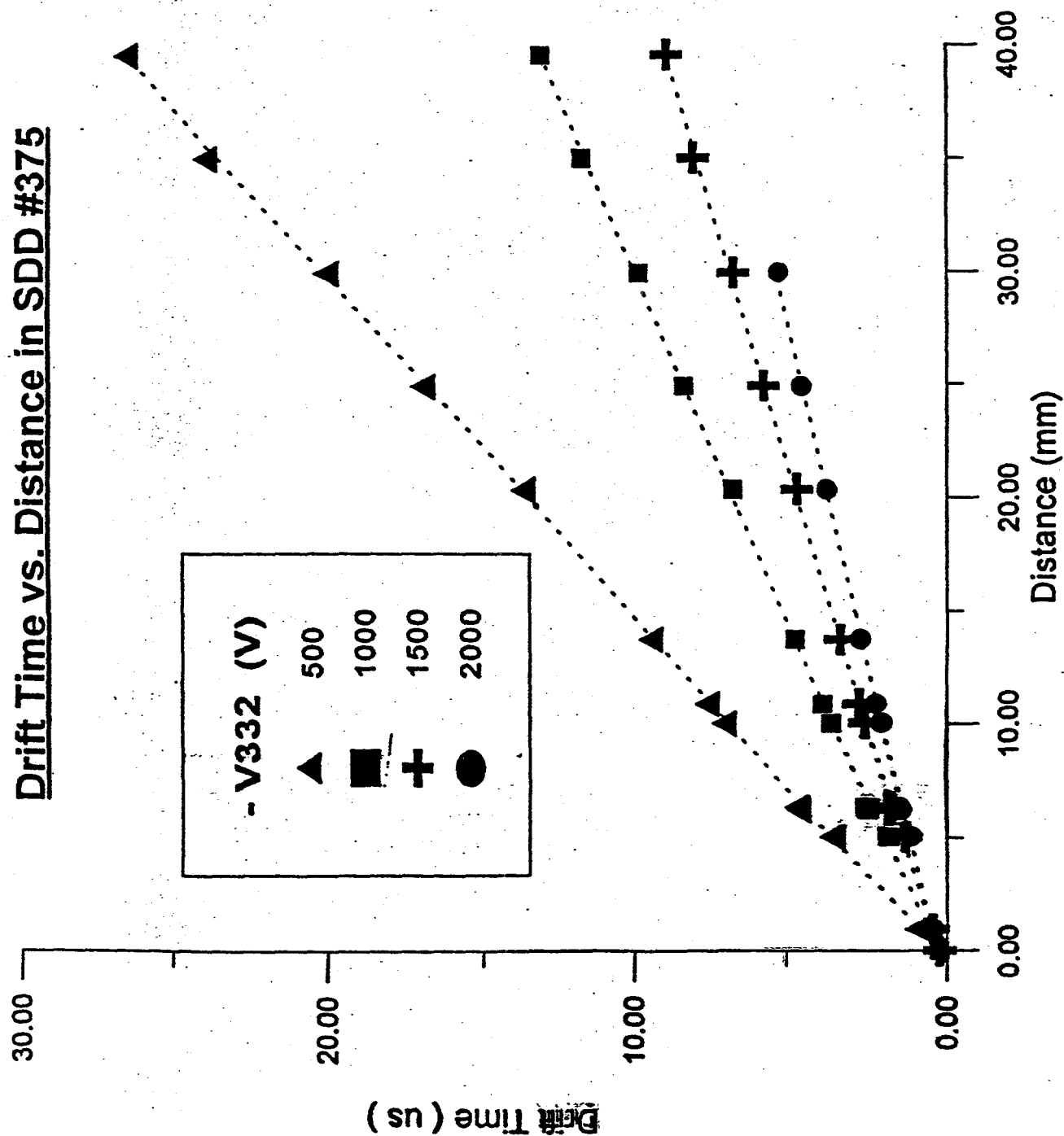
STAR 2
6 x 6 cm
April 94



STAR 3
6 x 6 cm
October 94

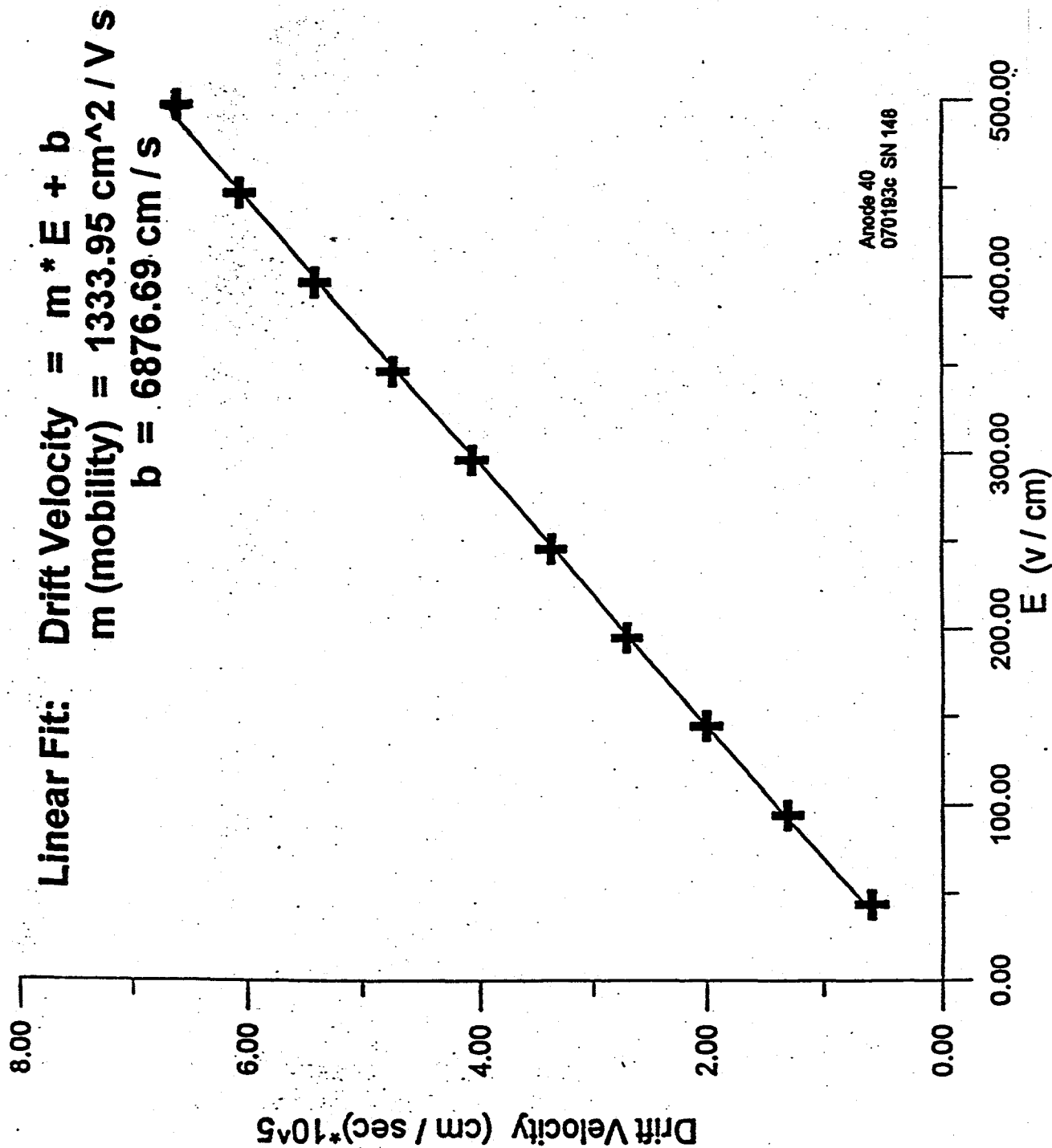


Drift Time vs. Distance in SDD #375

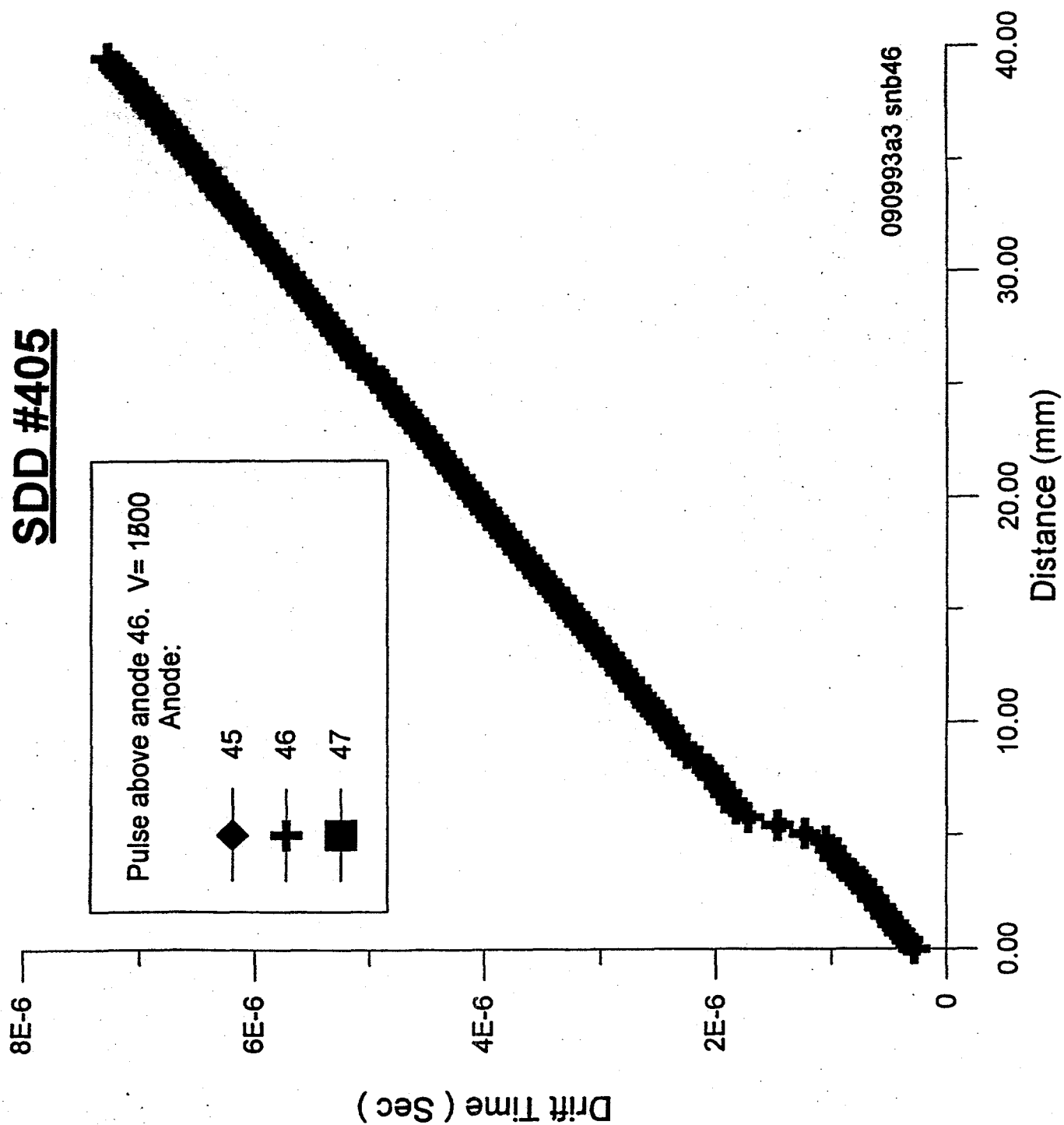


070783d snb29

Drift Velocity vs. Electric Field SDD #395



SDD #405



X-RAY GAS PROPORTIONAL DETECTOR DEVELOPMENT AT BNL

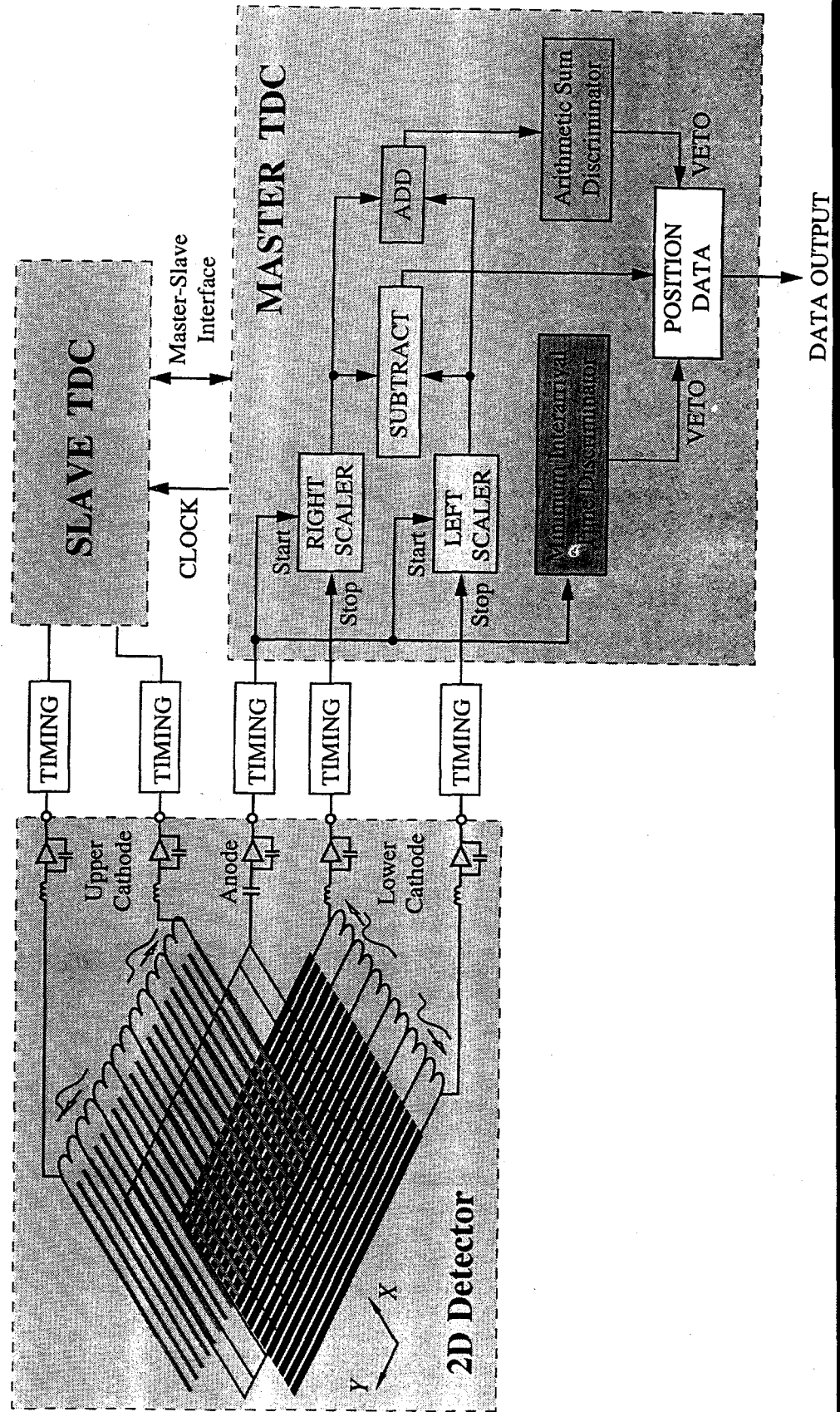
G.C. Smith
Brookhaven National Laboratory
Upton, NY 11973

1. Basic characteristics of two-dimensional, gas proportional chambers with delay line readout:
 - 100 μ m FWHM position resolution
 - $\pm 4\%$ differential non-linearity
 - few times 10^5 s^{-1} count rate
 - high throughput TDC
 - results from X12B, NSLS
 - new, 0.5 mm wire pitch detector
2. Some measurements illustrating fundamental limit to position resolution in Ar, Kr, Xe
3. Development of next generation proportional chamber, using interpolating cathode pads. Design for count rate capability of 10^8 s^{-1}

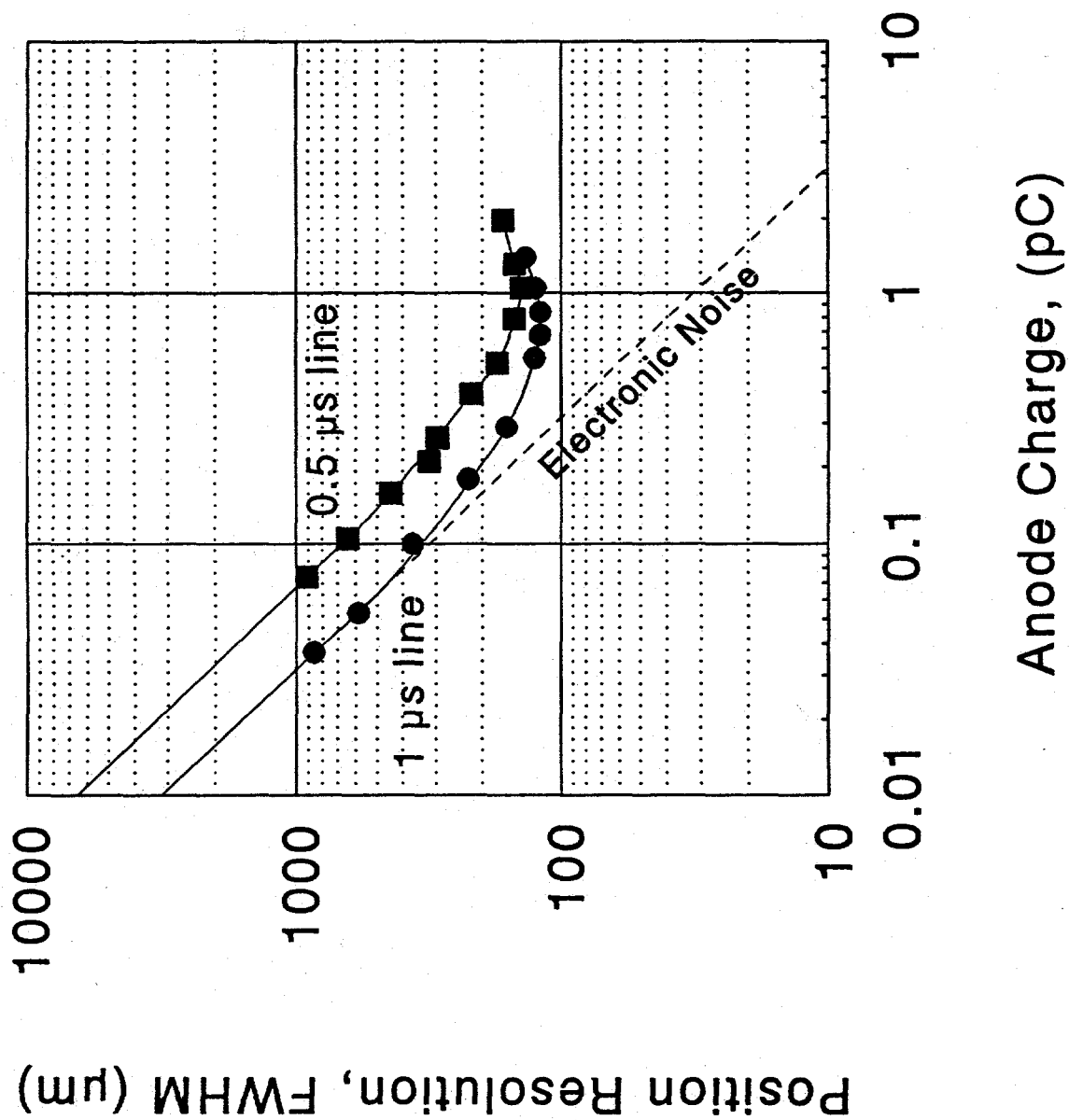
Co-workers:

J. Fischer, J. A. Harder, V. Radeka, L.C. Rogers, B. Yu

2D Gas Proportional Detector Data Flow



5.4 keV X-rays in Ar/20%CO₂



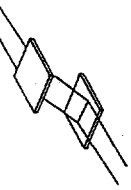
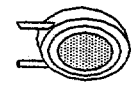
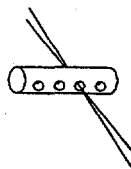
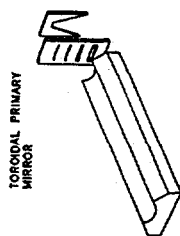
BEAM LINE X12B, NSLS (Time resolved studies)

CYLINDRICAL SECONDARY MIRROR

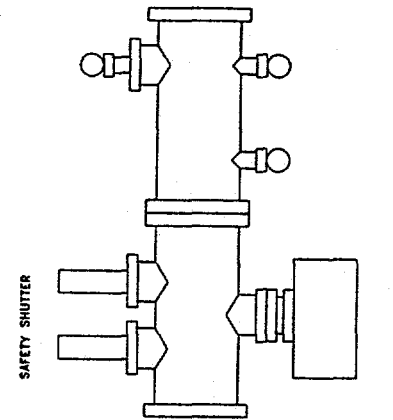
SI 111 FIXED-EXIT MONOCHROMATOR

WATER-COOLED BERYLLIUM WINDOW

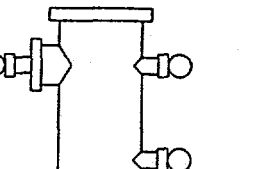
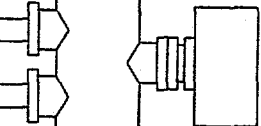
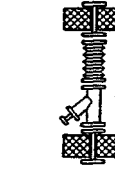
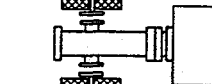
WATER-COOLED APERTURE (FOCAL POINT OF PRIMARY)



SHIELD WALL



B_e WINDOW



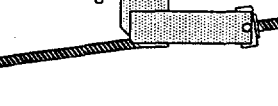
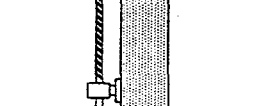
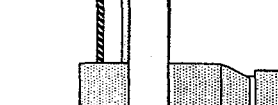
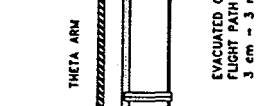
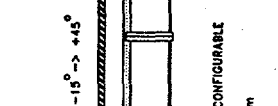
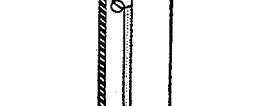
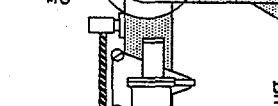
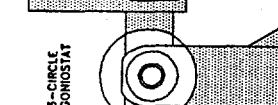
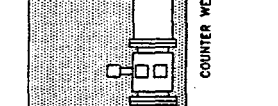
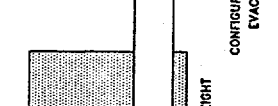
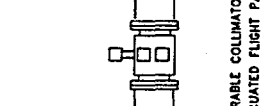
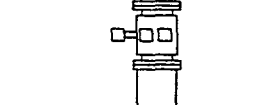
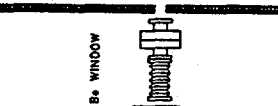
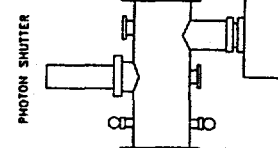
2D HIGH RATE GAS DETECTOR SYSTEM



MOTORIZED X-Y SLIT SCREENS

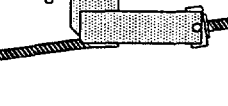
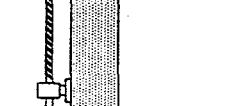
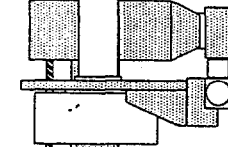


DEFINING SLITS



3-CIRCLE GONIOMETER

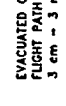
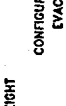
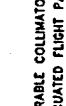
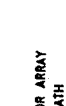
THETA ARM $-15^{\circ} \rightarrow +45^{\circ}$



EVACUATED CONFIGURABLE FLIGHT PATH 3 cm - 3 m



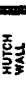
COUNTER WEIGHT



DIFFRACTOMETER

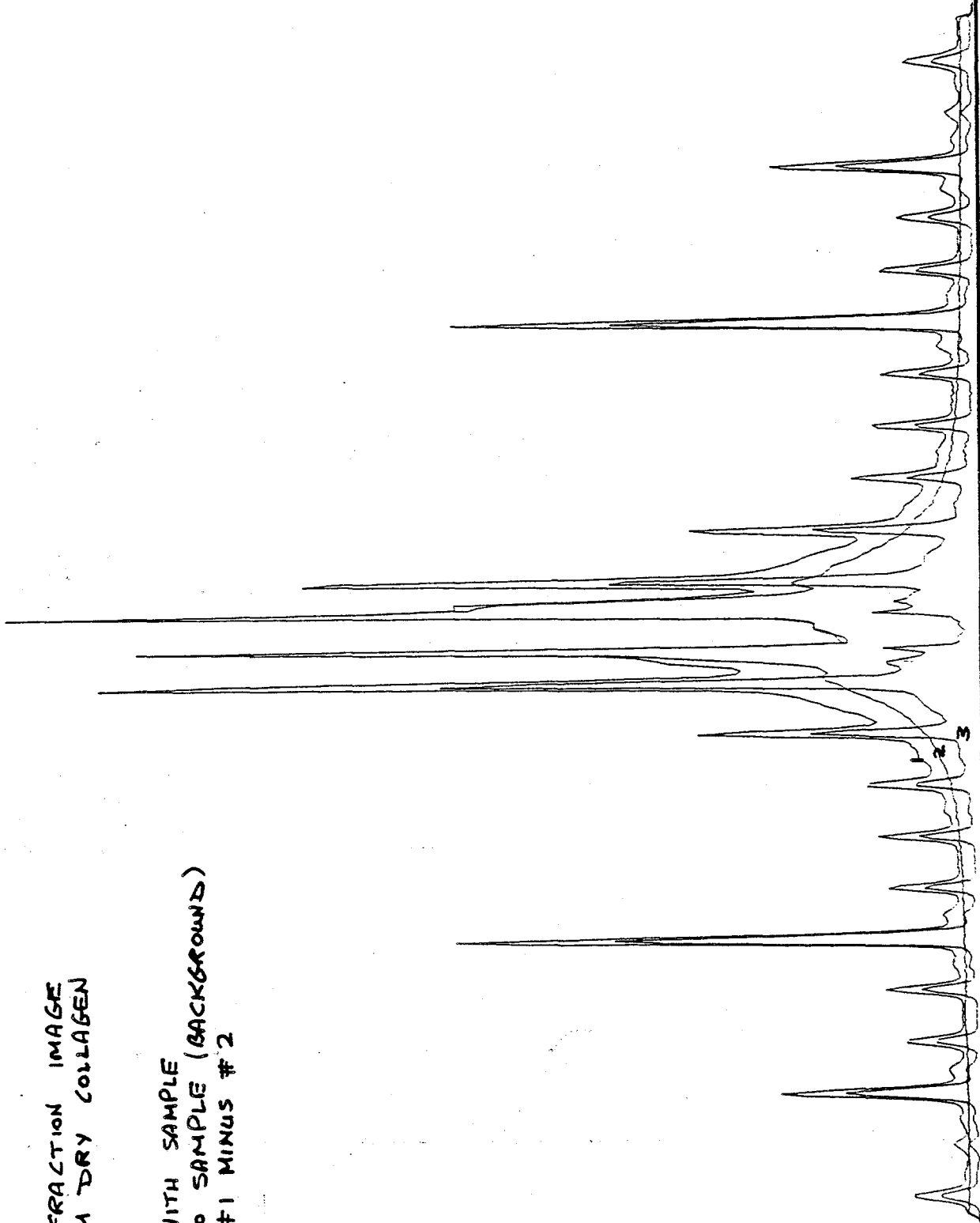


MUTCH WALL



DIFFRACTION IMAGE
FROM DRY COLLAGEN

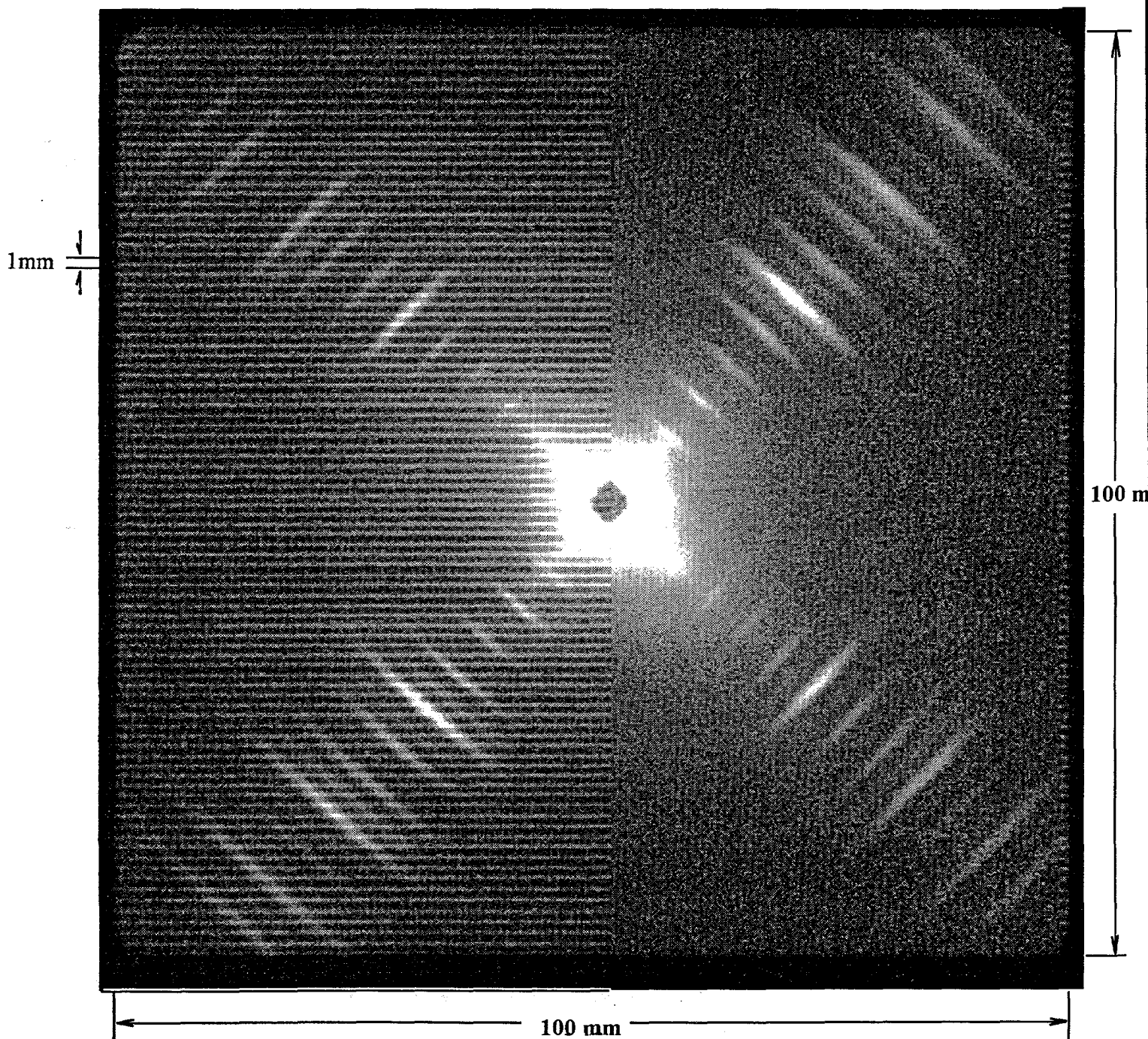
- 1 WITH SAMPLE
- 2 NO SAMPLE (BACKGROUND)
- 3 #1 MINUS #2



2D Gas Proportional Detector with Delay Line Encoding

Anode Wire Pitch = 1 mm

Meridional diffraction pattern from two dried collagen fibers
at right angles to each other (9keV, Ar/20%CO₂)

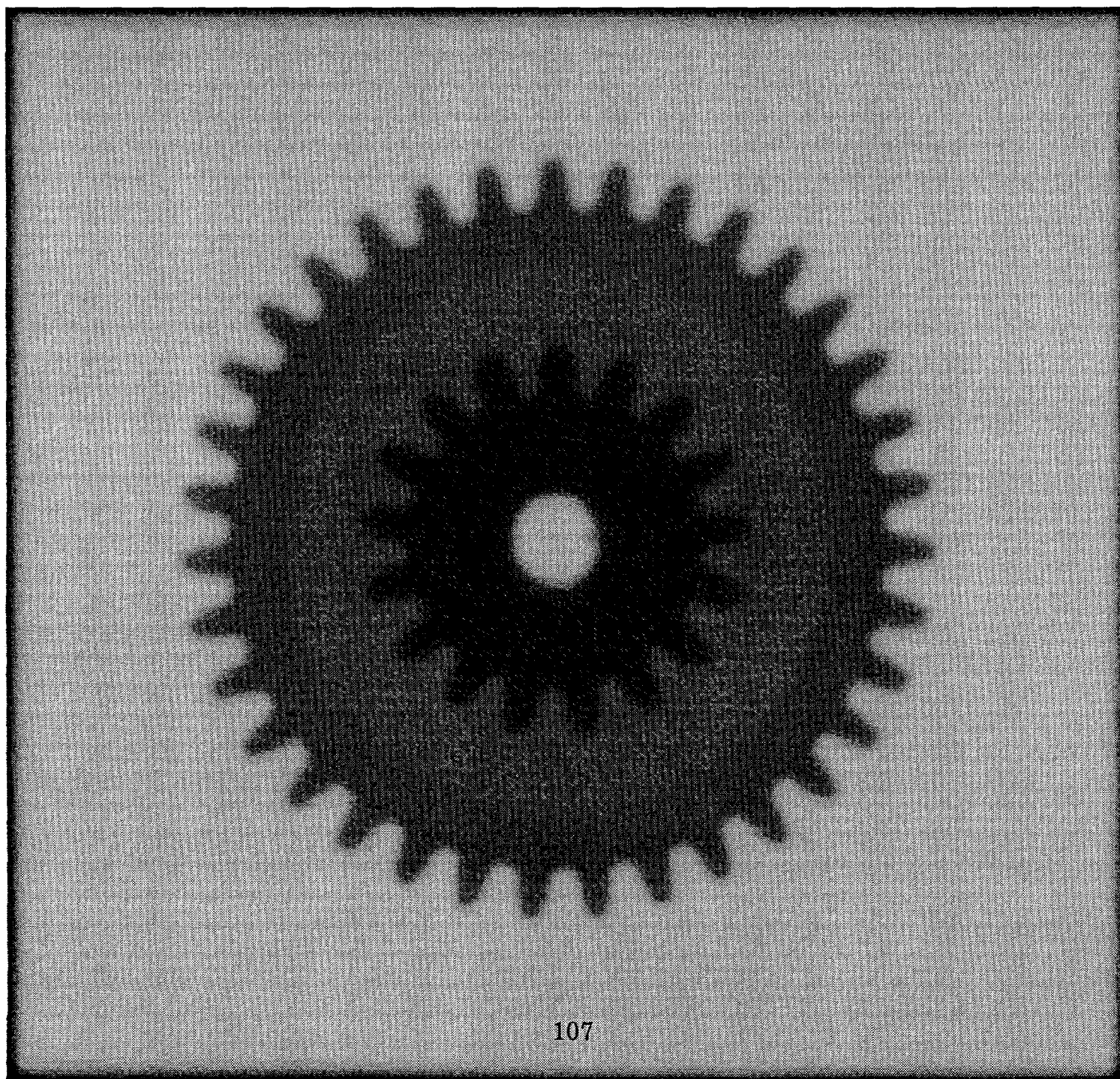


2D Gas Proportional Detector with Delay Line Encoding

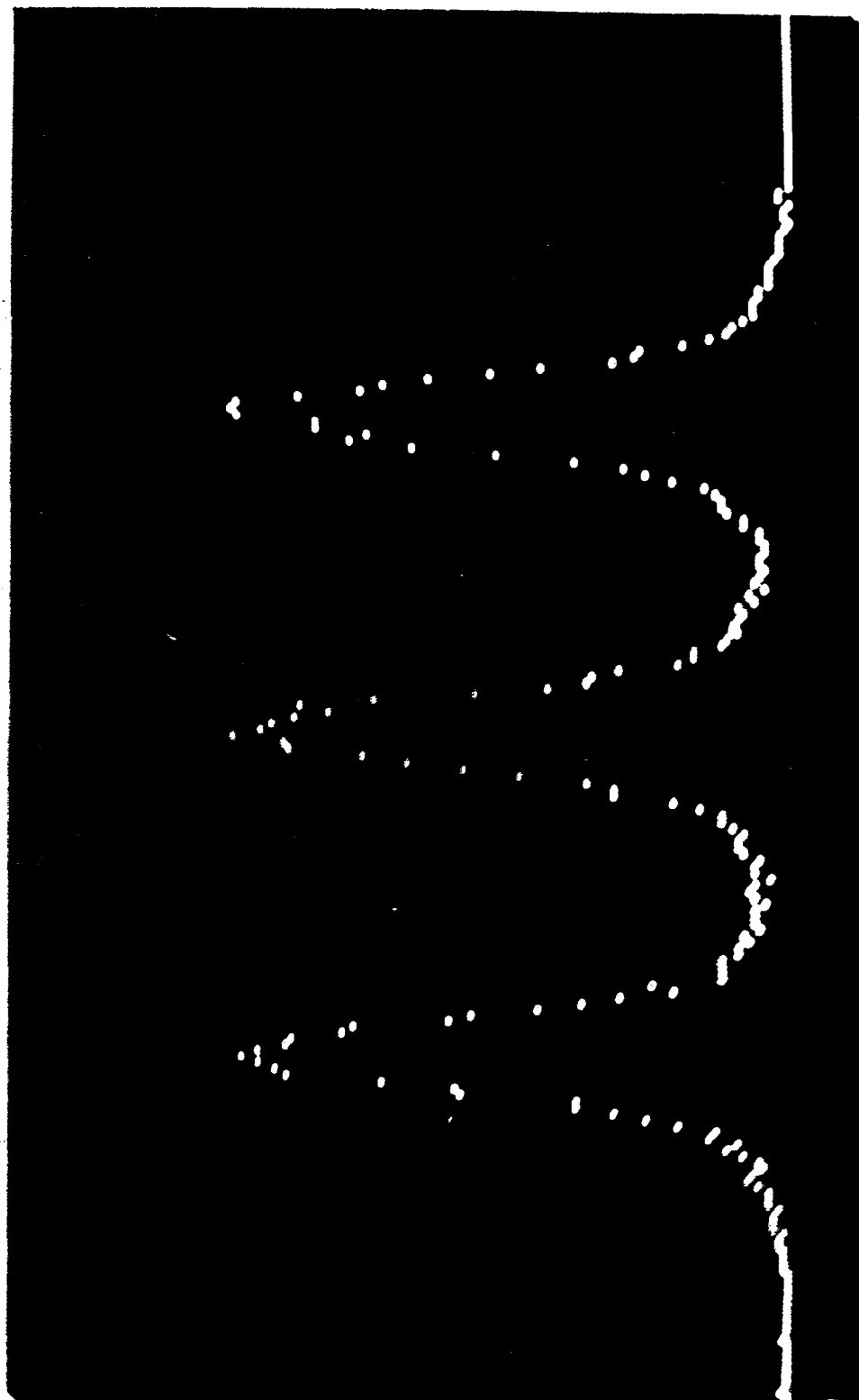
Anode Wire Pitch = 0.5mm

Image of a plastic gear wheel, 15 mm diameter (5.4 keV, Ar/20%CO₂)

RAW DATA

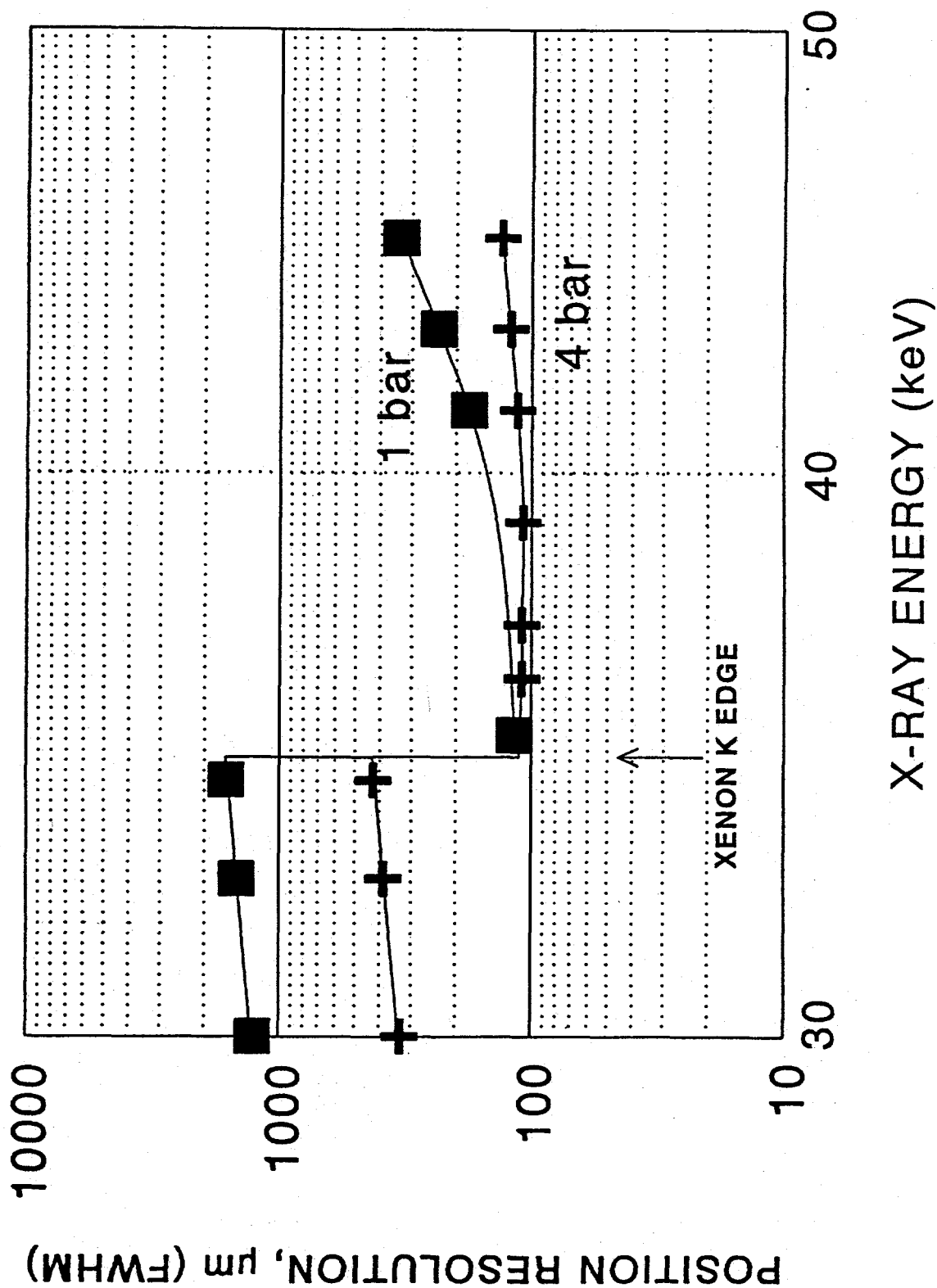


8 keV X-RAYS, Xe/10%CO₂ @ 10 bar



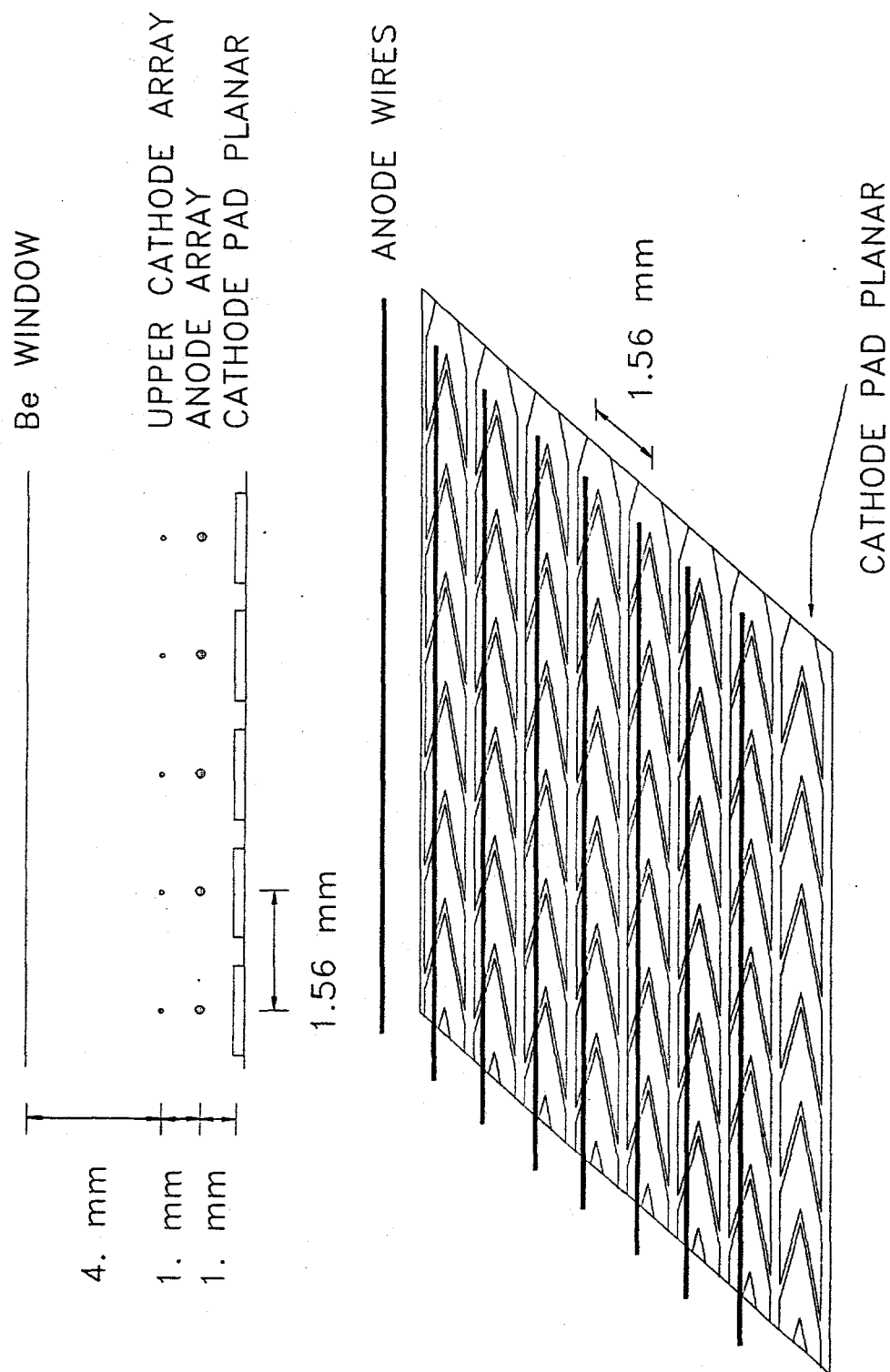
50 μ m 50 μ m

X-ray Position Resolution, Xe/10%CO₂



2D DETECTOR, 10^8 ph s^{-1}

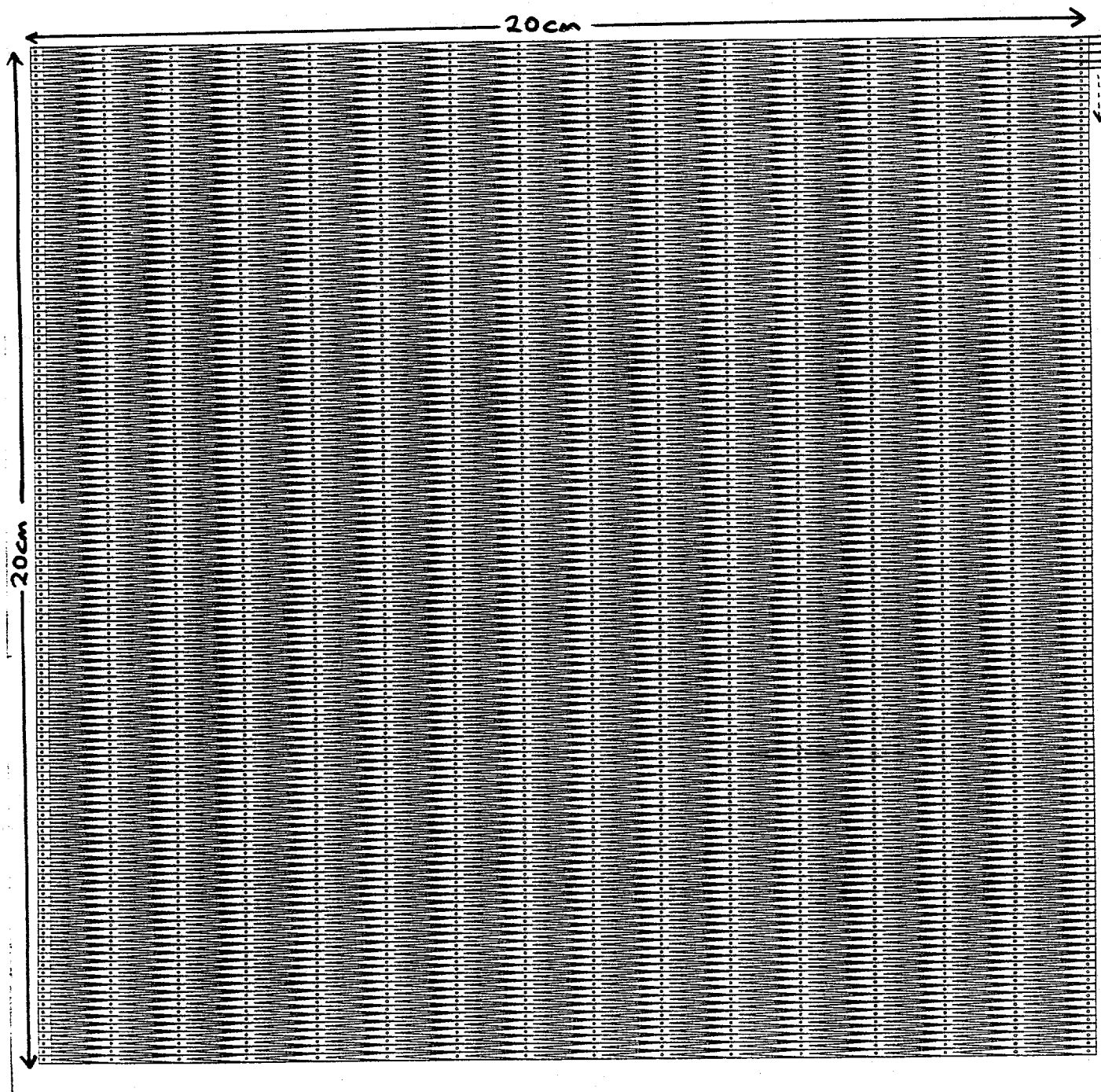
PROPORTIONAL CHAMBER CROSS-SECTION

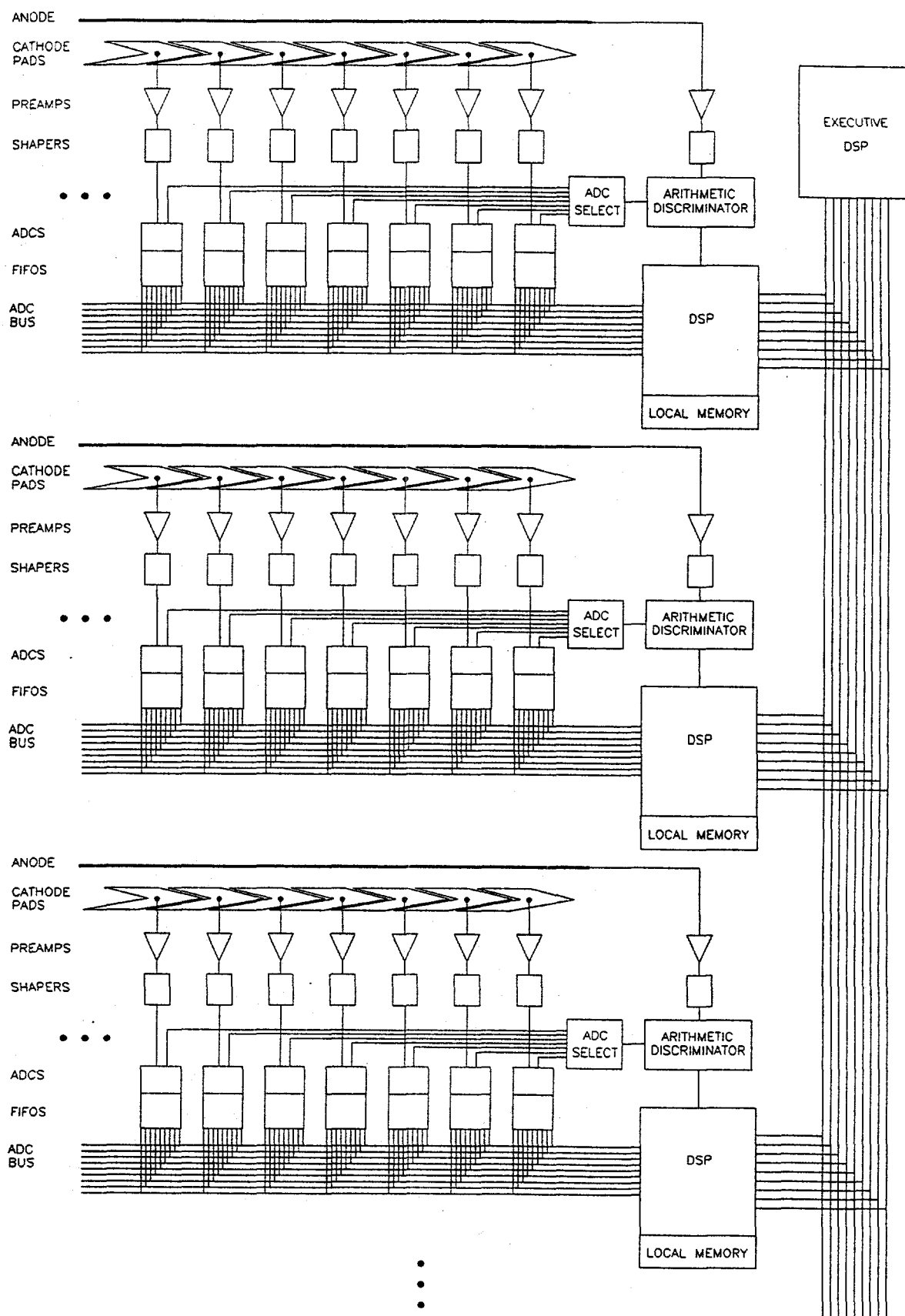


PERSPECTIVE VIEW

CATHODE PAD ARRAY FOR PROTOTYPE ULTRA-HIGH
RATE 2D DETECTOR

16 pads x 128 pads = 2048 channels





Deming Shu and Tuncer M. Kuzay

Advanced Photon Source

**The Advanced Photon Source High Power Density
X-ray Beam Position Monitor***

Synthetic diamond is being used for the s-ray beam position monitor blades subject to very high heat flux at the Advanced Photon Source at Argonne National Laboratory. The design and preliminary test results for the monitor are discussed in this presentation.

* This work supported by U.S. DOE BES Materials Science, under contract no. W-31-109-Eng-38.

- 1. Introduction**
- 2. APS Insertion Devices X-ray Beam Parameters**
- 3. X-ray Beam Position Monitor Design for APS Front End**
- 4. Pre-prototype Beam Position Monitor Test at CHESS
(Cornell Univ.) and NSLS (Brookhaven National Lab.)**
- 5. X-ray Transmitting Beam Position Monitor Tests at NSLS**
- 6. Discussion and Conclusions**

ADVANCED PHOTON SOURCE

Photon Beam Position Monitors

Design Goal:

Sensing 10% of undulator beam opening angle and beam spatial size.

For β_x and β_y of 10 m,

$$\partial\sigma_y < 8 - 30 \mu\text{m}$$

$$\partial\sigma_{y'} < 1 - 2 \mu\text{rad}$$

The detection of such changes is achieved by using two photon BPMs with a spatial resolution of $\pm 1\mu$ and separated by 3 - 4 m.

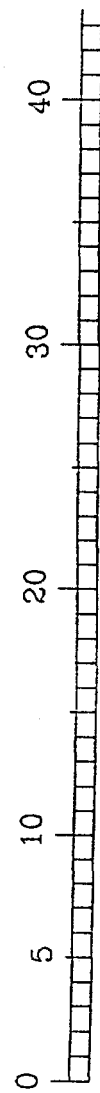
DESIGN CRITERIA

1. USING PHOTON - ELECTRON EMISSION TYPE

- UHV COMPATIBILITY
- HIGH SENSITIVITY
- EASY MAINTANENCE

2. USING CVD DIAMOND AS A BLADE BASE MATERIAL FOR SUPERIOR PERFORMANCE IN BLADE MATERIAL STRENGTH, THERMAL CONDUCTIVITY THERMAL EXPANSION AND STIFFNESS UNDER HEAT

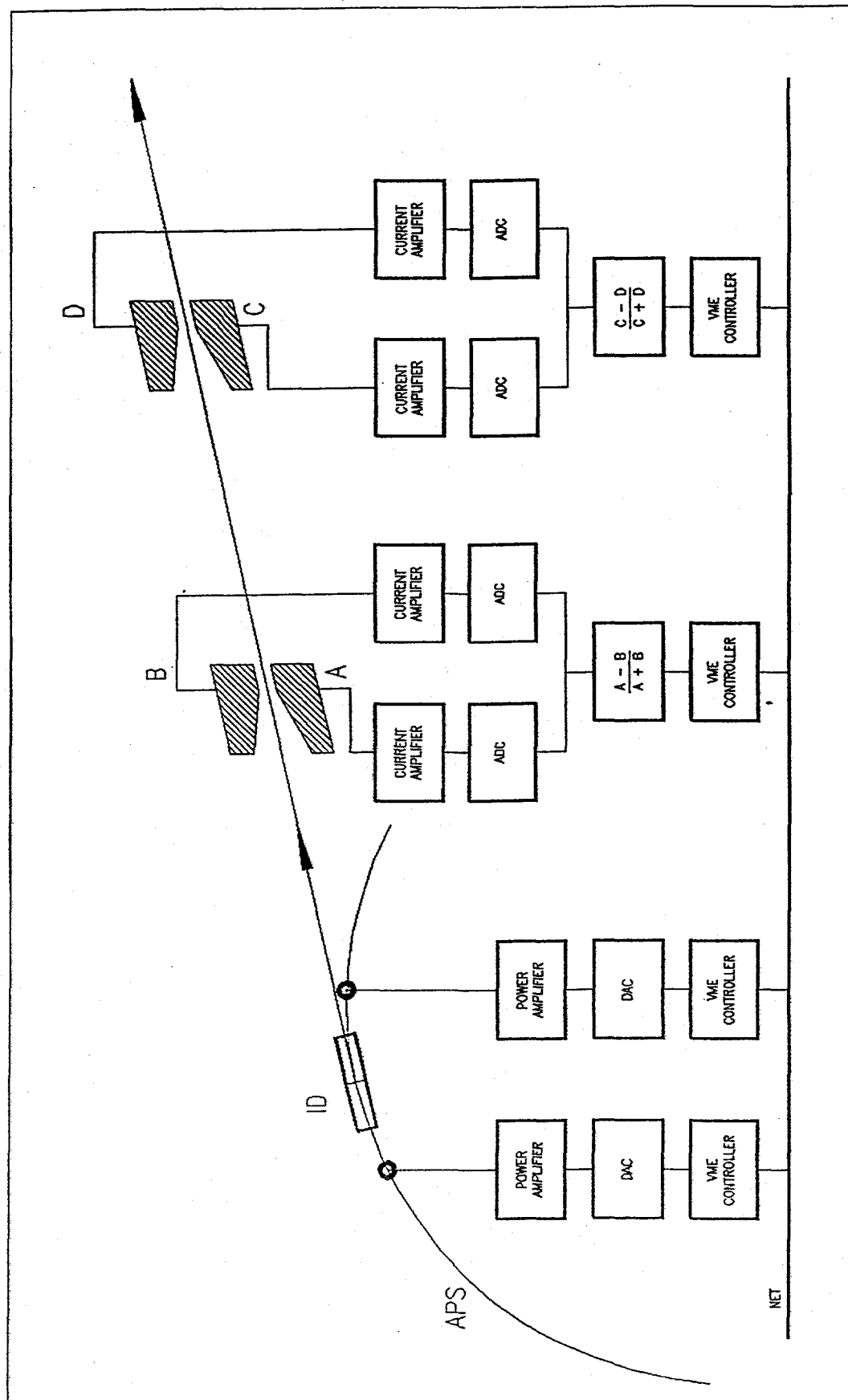
3. USING METAL COATING MATERIAL,
WHICH IS COMPATIBLE WITH
DIAMOND FOR A GOOD BOND AND
ALSO TO PROVIDE A GOOD PHOTO
EMISSION SIGNAL
4. USING ROLLING WEDGE STRUCTURE
TO PROVIDE HORIZONTAL BLADE
ADJUSTMENT TO SUIT UNDULATOR
OR WIGGLER OPERATION
5. USE OF A THREE PAIR GEOMETRIC
ARRANGEMENT TO SOLVE THE
"SHADOWING" PROBLEM

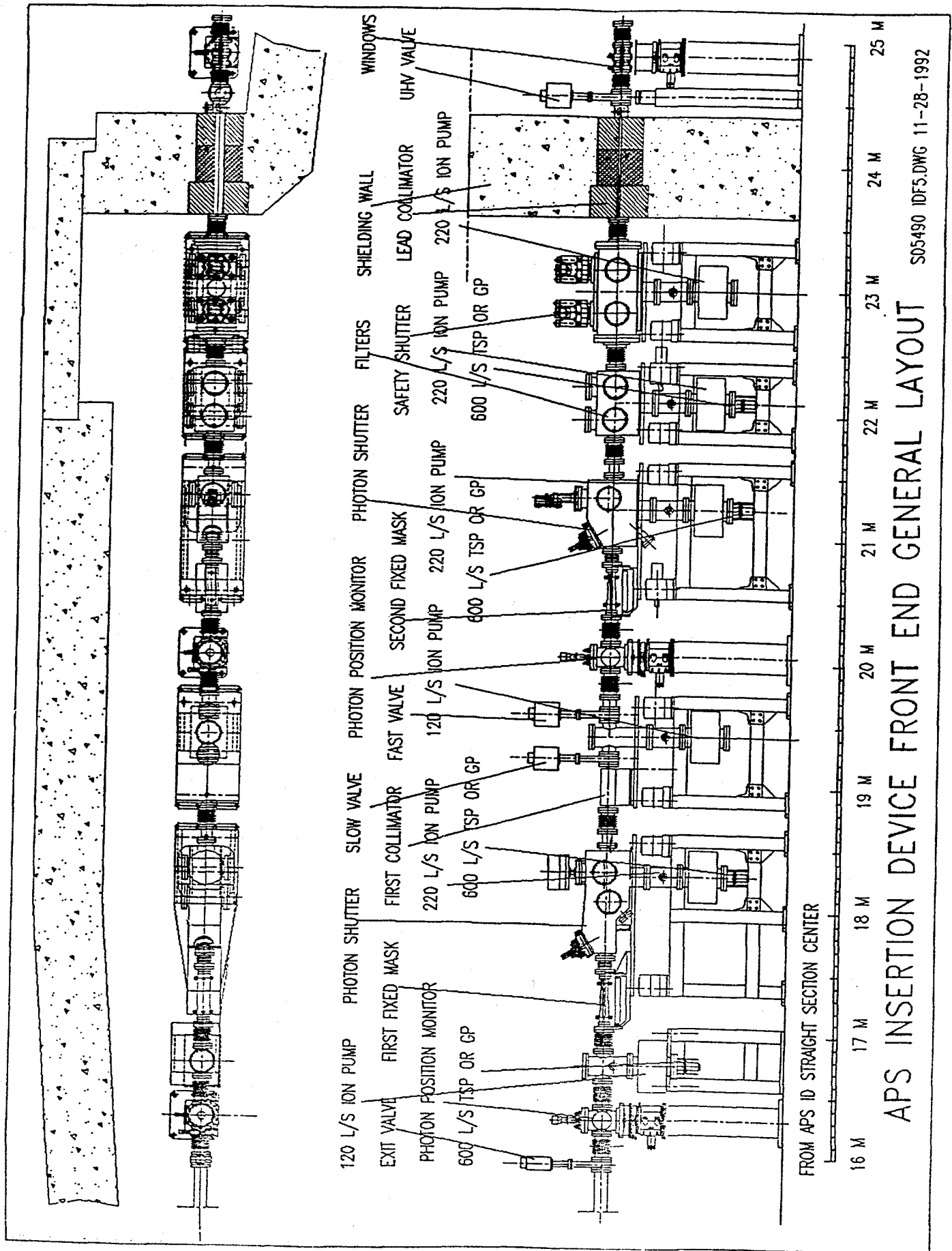


08-15-1993

S04919 SRICAT5.DWG

[illegible]





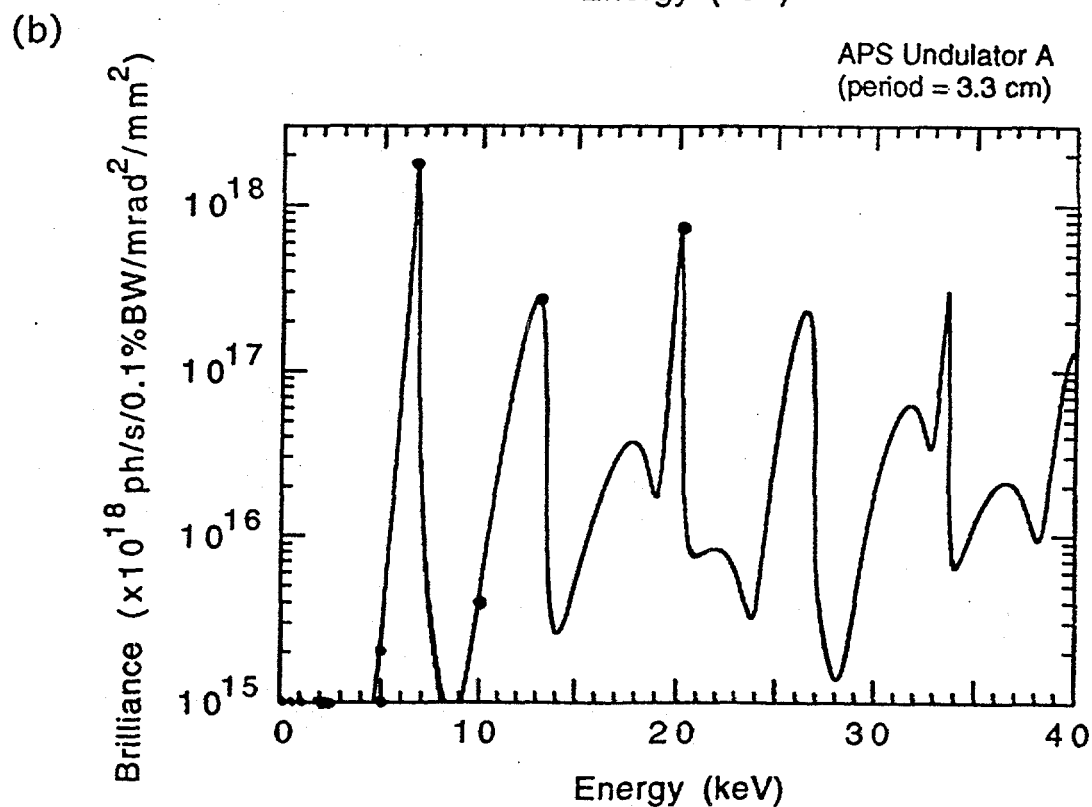
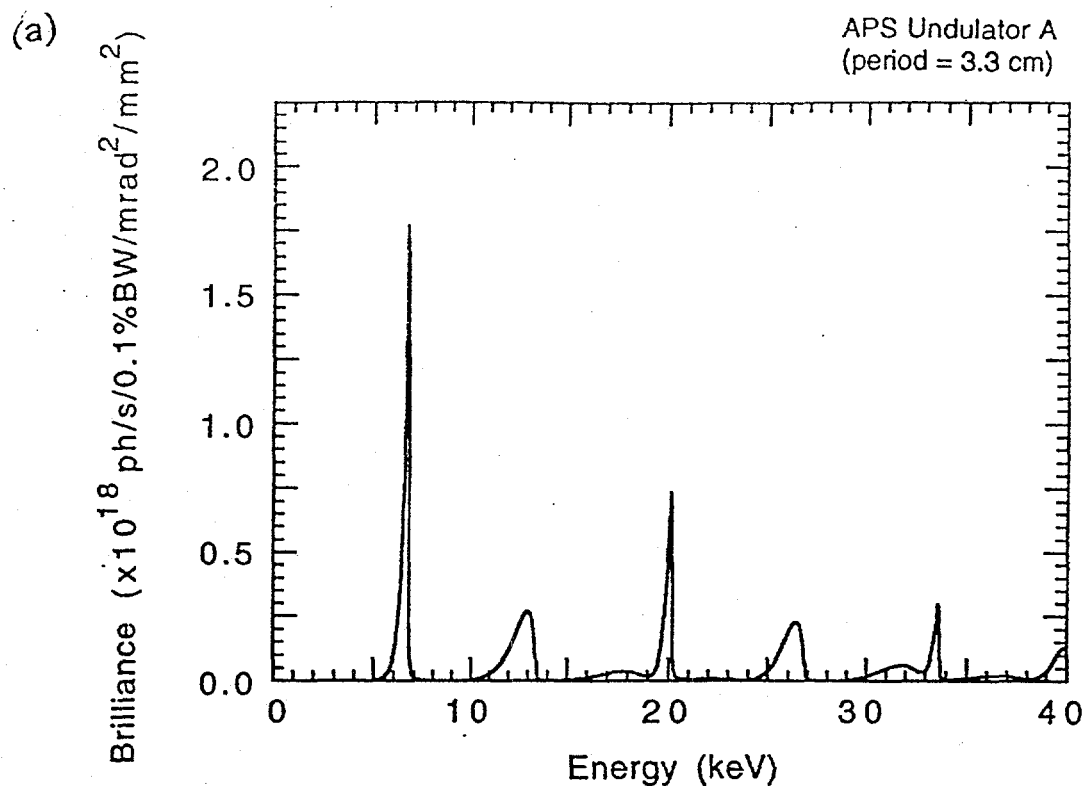
ADVANCED PHOTON SOURCE

TABLE 1

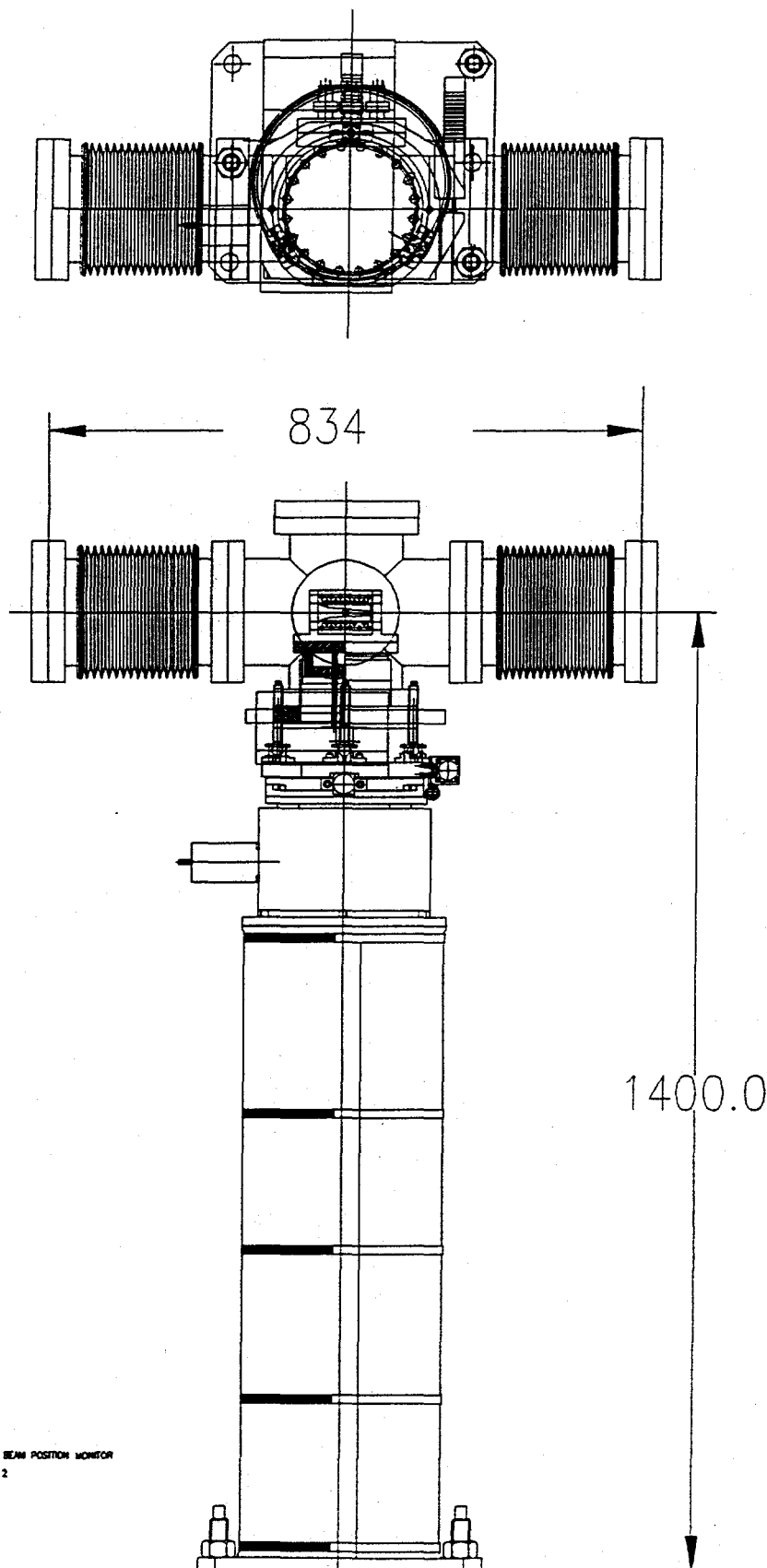
Design Parameters for Various APS Insertion Devices

($E_r = 7$ GeV; $I = 100$ mA, and $1/\gamma = 73$ μ rad. Quantities at the indicated gap position.)

Parameters	Undulator A (at closed gap of 11.5 mm)	Wiggler A (at 21 mm gap)
Period length [cm]	3.3	8.5
Device length [m]	2.40	2.40
Number of periods	72	28
Max. magnetic field B_0 [T]	0.72	1.0
Critical energy E_c [keV]	23.6	32.6
Max. deflection parameter, K	2.23	7.9
K/γ [μ rad]	163	577
Total power [kW]	3.8	7.4
Peak power [kW/mrad ²]	134	73
ID-photon shutter distance (m)	16.9	18.1
Peak heat flux @ photon shutter (W/mm ²)	469	223



(a) Linear and (b) logarithmic plot of the on-axis brilliance spectrum for Undulator A at the initial gap of 1.55 cm ($K=1.48$). Note the presence of even and higher harmonics. (Operation at 7 GeV, 100 mA).



APS 5M FE PHOTON BEAM POSITION MONITOR
PBPW7.DWG 2 OF 2
04-1993

ADVANCED PHOTON SOURCE

W.B.S. 1.4.1.2.1.1.4

ID Front End Photon Beam Position Monitor

Technical Specifications

1.4.1.2.1.1.4 - 200000

ID Front End First Photon Beam Position Monitor

1. Location : 16.3 m from ID Straight Section Center
2. Aperture Size : 70 mm (H) x 27 mm (V)
3. Vertical Maximum Acceptance : 1.6 mrad
4. Horizontal Maximum Acceptance : 4.29 mrad
5. Input Flange O.D. : 150 mm (6 inch)
6. Output Flange O.D. : 150 mm (6 inch)
7. Monitor Type : Six Blade Photoelectron Emission
7. Monitor Blades Material : CVD Diamond
with Thermal Conductivity > 1200 W/mk
8. Monitor Blade Thermal Limit : < 600 °C
9. Monitor Cooling Base Material : OFHC
10. Cooling Method: Water Cooling
11. Cooling Water Supply : < 0.5 GPM and 5 PSI Total Pressure Drop
12. Monitor Position Sensitivity : < 0.5 micron
16. Flange to Flange Device Length : 660 mm
17. Vacuum : UHV Compatible
18. Maximum Heat Load : Planned APS 2.4 m Undulator or Wiggler with
7 GeV and 100 mA

ADVANCED PHOTON SOURCE

W.B.S. 1.4.1.2.1.1.4

ID Front-End Photon Beam Position Monitor

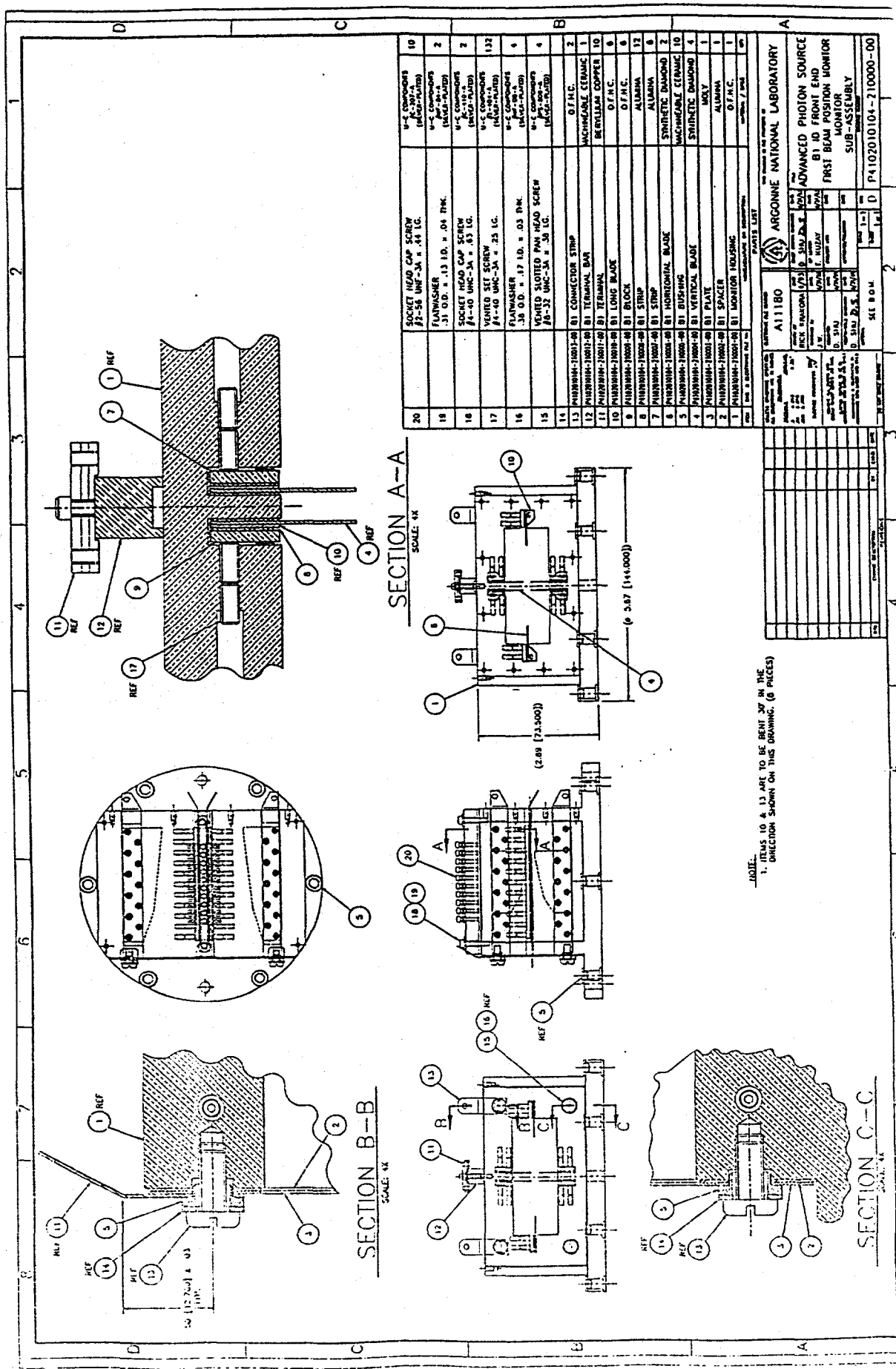
Technical Specifications

1.4.1.2.1.1.4 - 300000

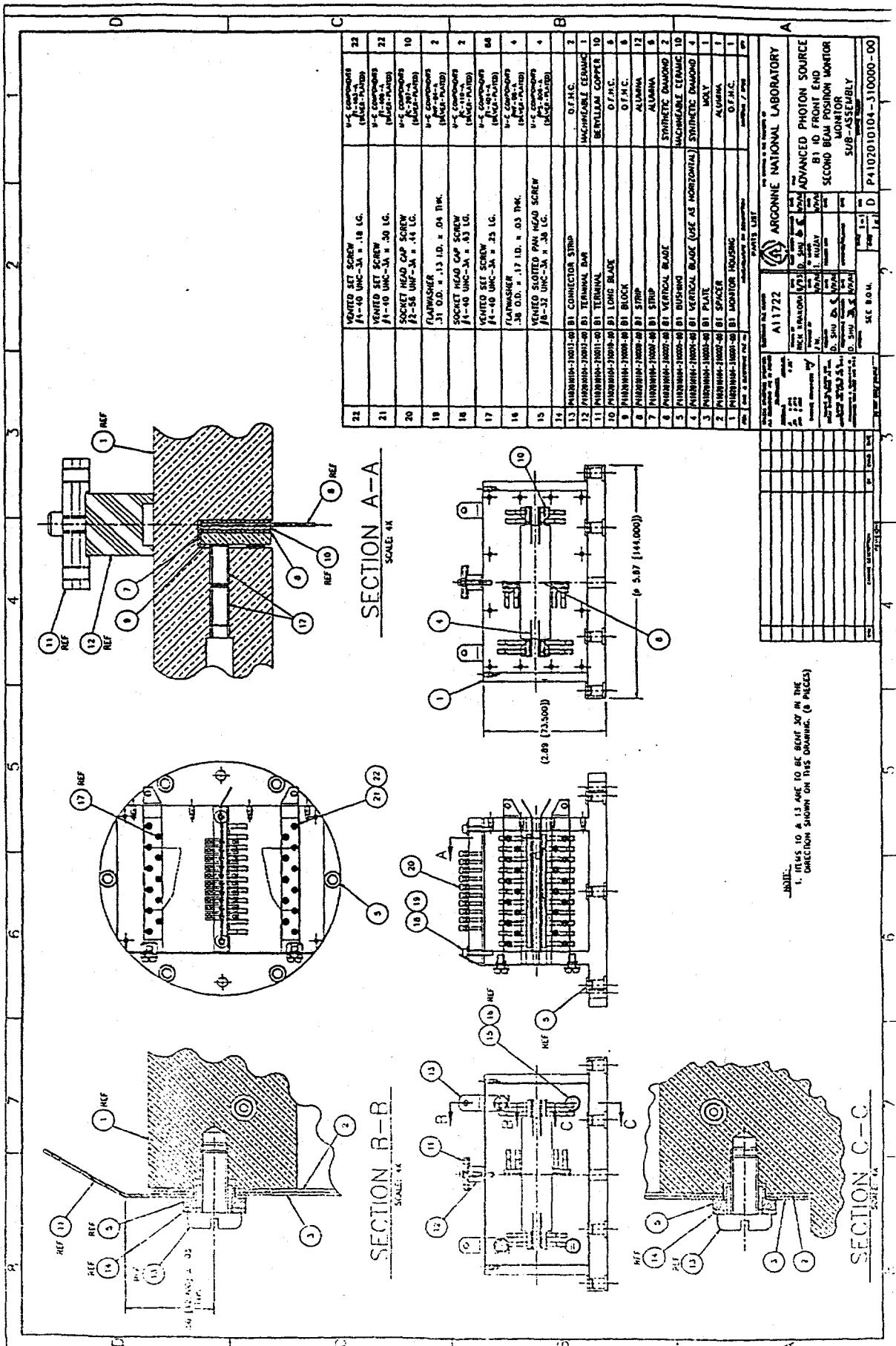
ID Front-End Second Photon Beam Position Monitor

1. Location : 20.1 m from ID Straight Section Center
2. Aperture Size : 70 mm (H) x 18 mm (V)
3. Vertical Maximum Acceptance : 0.9 mrad
4. Horizontal Maximum Acceptance : 3.48 mrad
5. Input Flange O.D. : 150 mm (6 inch)
6. Output Flange O.D. : 150 mm (6 inch)
7. Monitor Type : Six Blade Photoelectron Emission
7. Monitor Blades Material : CVD Diamond
with Thermal Conductivity > 1200 W/mk
8. Monitor Blade Thermal Limit : < 600 °C
9. Monitor Cooling Base Material : OFHC
10. Cooling Method: Water Cooling
11. Cooling Water Supply : < 0.5 GPM and 5 PSI Total Pressure Drop
12. Monitor Position Sensitivity : < 0.5 micron
16. Flange to Flange Device Length : 660 mm
17. Vacuum : UHV Compatible
18. Maximum Heat Load : Planned APS 2.4 m Undulator or Wiggler with
7 GeV and 100 mA

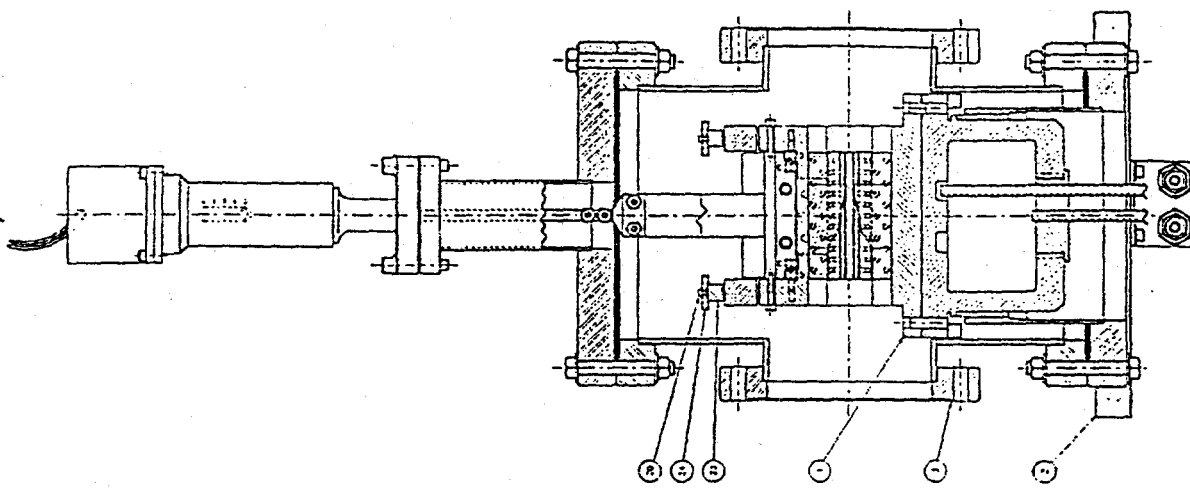




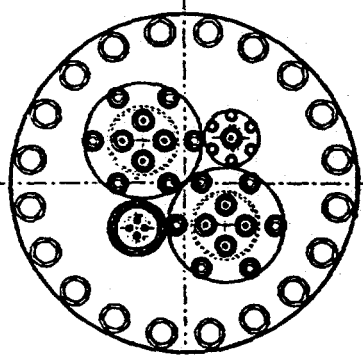




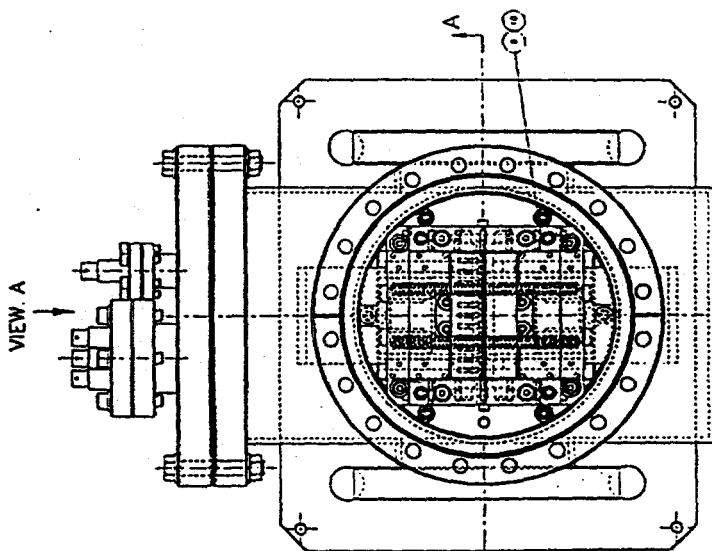
NOTE:
1. THIS IS A 1:1 SCALE TO BE USED FOR THE
1. DIRECTION SHOWN ON THIS DRAWING. (8 PAGES)



SECTION A-A

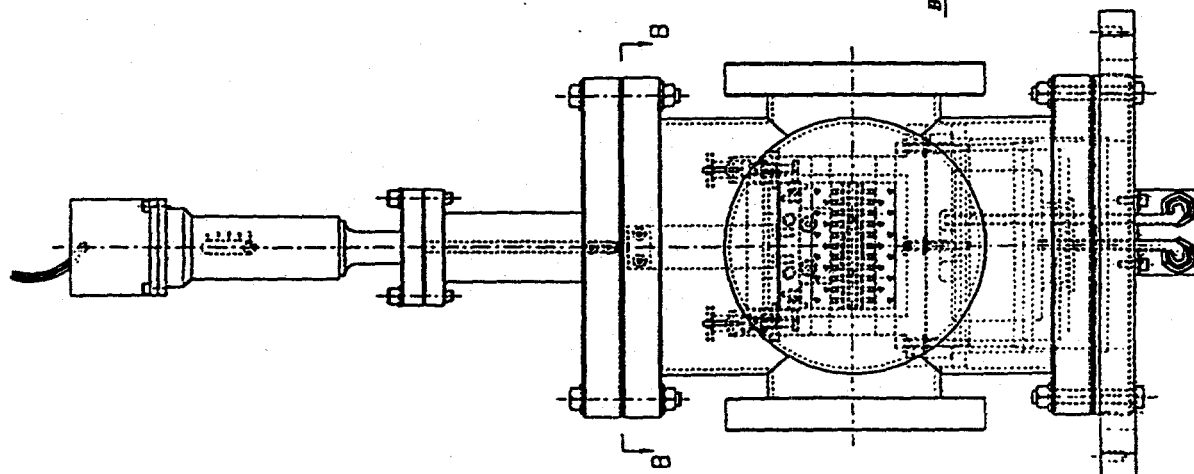


VIEW A



VIEW B-B

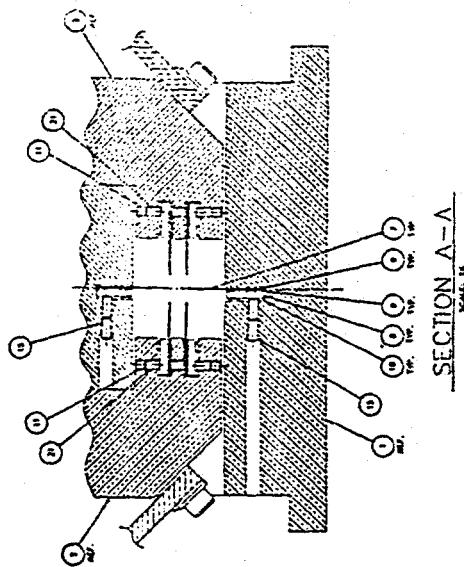
.. FEEDTHROUGH FLANGE REMOVED FOR CLARIFICATION ..



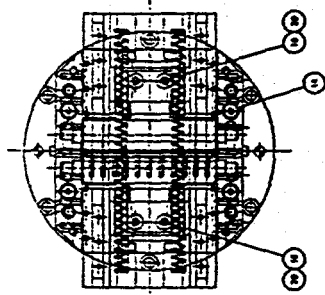
SIDE VIEW

SHOWN WITHOUT SPRING SHEET WELDMENT

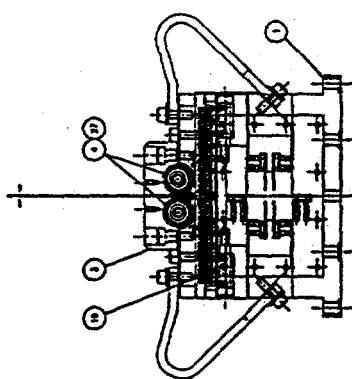
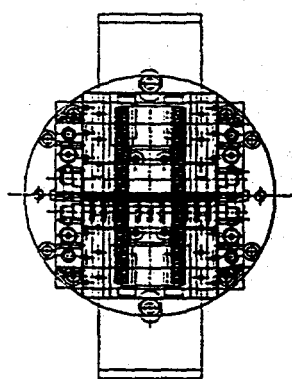
APPROVED FOR RELEASE DATE 10-10-2010 BY 60322 AUTHORITY 1045-010-0000-10	
ARGONNE NATIONAL LABORATORY 4045 E. CALIFORNIA STREET URBANA, ILLINOIS 61824-6308 TEL: 618/244-3100 FAX: 618/244-3101 WWW.ANL.GOV	
PROJECT: 1045-010-0000-10 DRAWING: 1045-010-0000-10 REVISION: 1045-010-0000-10 DATE: 10-10-2010 BY: 60322 CHECKED: 60322 APPROVED: 60322	



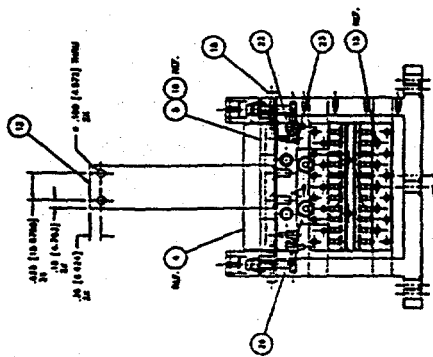
SECTION A-A
SCALE 1:1



SHOWN WITHOUT SPRING SHEET MECHANISM



IN OPEN POSITION



SHOWN WITHOUT SPRING SHEET

ITEM	DESCRIPTION	QTY	UNIT	REMARKS
1	WASHER	1	PC	
2	WASHER	1	PC	
3	WASHER	1	PC	
4	WASHER	1	PC	
5	WASHER	1	PC	
6	WASHER	1	PC	
7	WASHER	1	PC	
8	WASHER	1	PC	
9	WASHER	1	PC	
10	WASHER	1	PC	
11	WASHER	1	PC	
12	WASHER	1	PC	
13	WASHER	1	PC	
14	WASHER	1	PC	

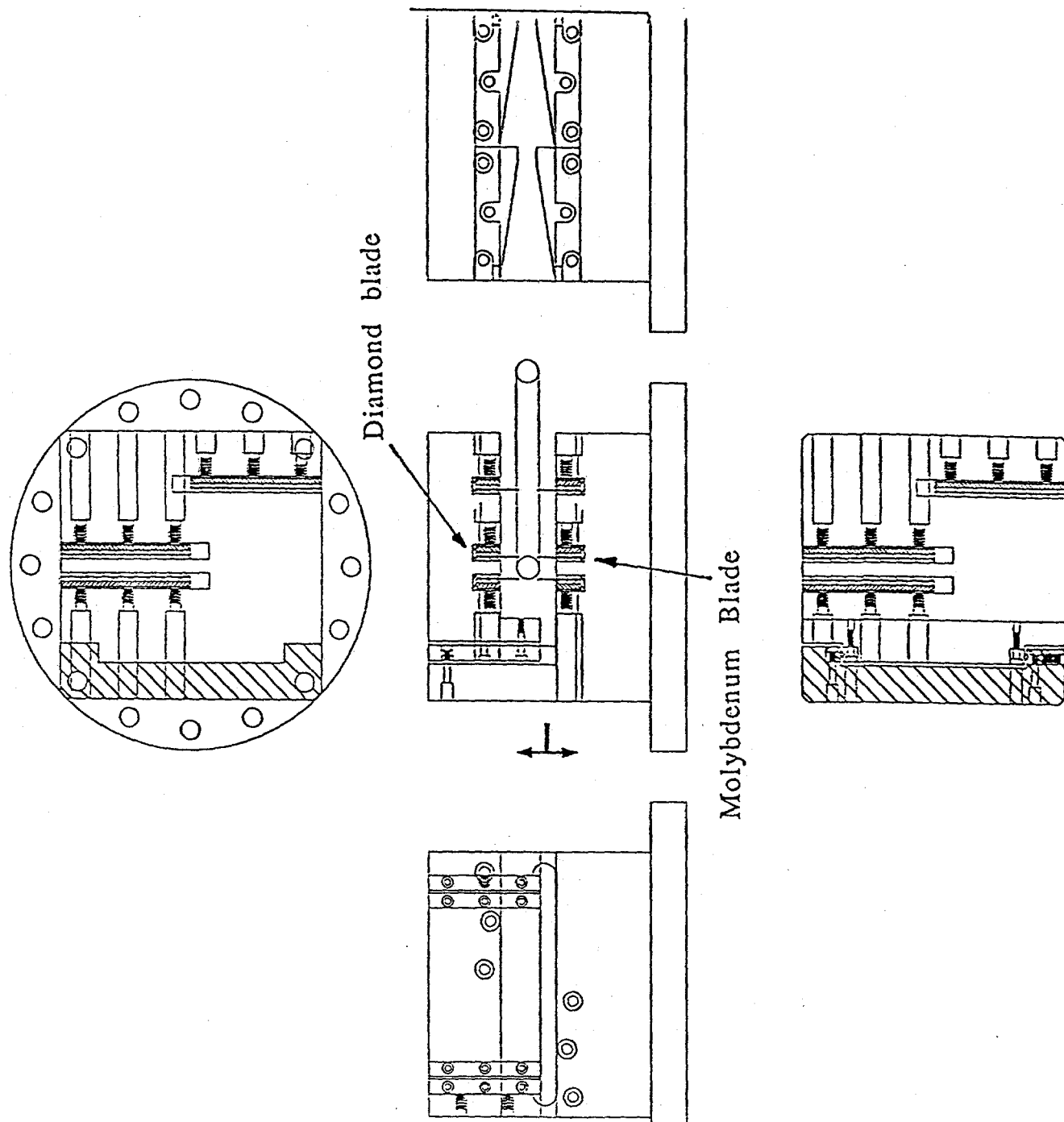
ITEM	DESCRIPTION	QTY	UNIT	REMARKS
15	WASHER	1	PC	
16	WASHER	1	PC	
17	WASHER	1	PC	
18	WASHER	1	PC	
19	WASHER	1	PC	
20	WASHER	1	PC	
21	WASHER	1	PC	
22	WASHER	1	PC	
23	WASHER	1	PC	
24	WASHER	1	PC	
25	WASHER	1	PC	
26	WASHER	1	PC	
27	WASHER	1	PC	
28	WASHER	1	PC	
29	WASHER	1	PC	
30	WASHER	1	PC	
31	WASHER	1	PC	
32	WASHER	1	PC	
33	WASHER	1	PC	
34	WASHER	1	PC	
35	WASHER	1	PC	
36	WASHER	1	PC	
37	WASHER	1	PC	
38	WASHER	1	PC	
39	WASHER	1	PC	
40	WASHER	1	PC	
41	WASHER	1	PC	
42	WASHER	1	PC	
43	WASHER	1	PC	
44	WASHER	1	PC	
45	WASHER	1	PC	
46	WASHER	1	PC	
47	WASHER	1	PC	
48	WASHER	1	PC	
49	WASHER	1	PC	
50	WASHER	1	PC	
51	WASHER	1	PC	
52	WASHER	1	PC	
53	WASHER	1	PC	
54	WASHER	1	PC	
55	WASHER	1	PC	
56	WASHER	1	PC	
57	WASHER	1	PC	
58	WASHER	1	PC	
59	WASHER	1	PC	
60	WASHER	1	PC	
61	WASHER	1	PC	
62	WASHER	1	PC	
63	WASHER	1	PC	
64	WASHER	1	PC	
65	WASHER	1	PC	
66	WASHER	1	PC	
67	WASHER	1	PC	
68	WASHER	1	PC	
69	WASHER	1	PC	
70	WASHER	1	PC	
71	WASHER	1	PC	
72	WASHER	1	PC	
73	WASHER	1	PC	
74	WASHER	1	PC	
75	WASHER	1	PC	
76	WASHER	1	PC	
77	WASHER	1	PC	
78	WASHER	1	PC	
79	WASHER	1	PC	
80	WASHER	1	PC	
81	WASHER	1	PC	
82	WASHER	1	PC	
83	WASHER	1	PC	
84	WASHER	1	PC	
85	WASHER	1	PC	
86	WASHER	1	PC	
87	WASHER	1	PC	
88	WASHER	1	PC	
89	WASHER	1	PC	
90	WASHER	1	PC	
91	WASHER	1	PC	
92	WASHER	1	PC	
93	WASHER	1	PC	
94	WASHER	1	PC	
95	WASHER	1	PC	
96	WASHER	1	PC	
97	WASHER	1	PC	
98	WASHER	1	PC	
99	WASHER	1	PC	
100	WASHER	1	PC	

TABLE 2 BPM Support Stages Specifications

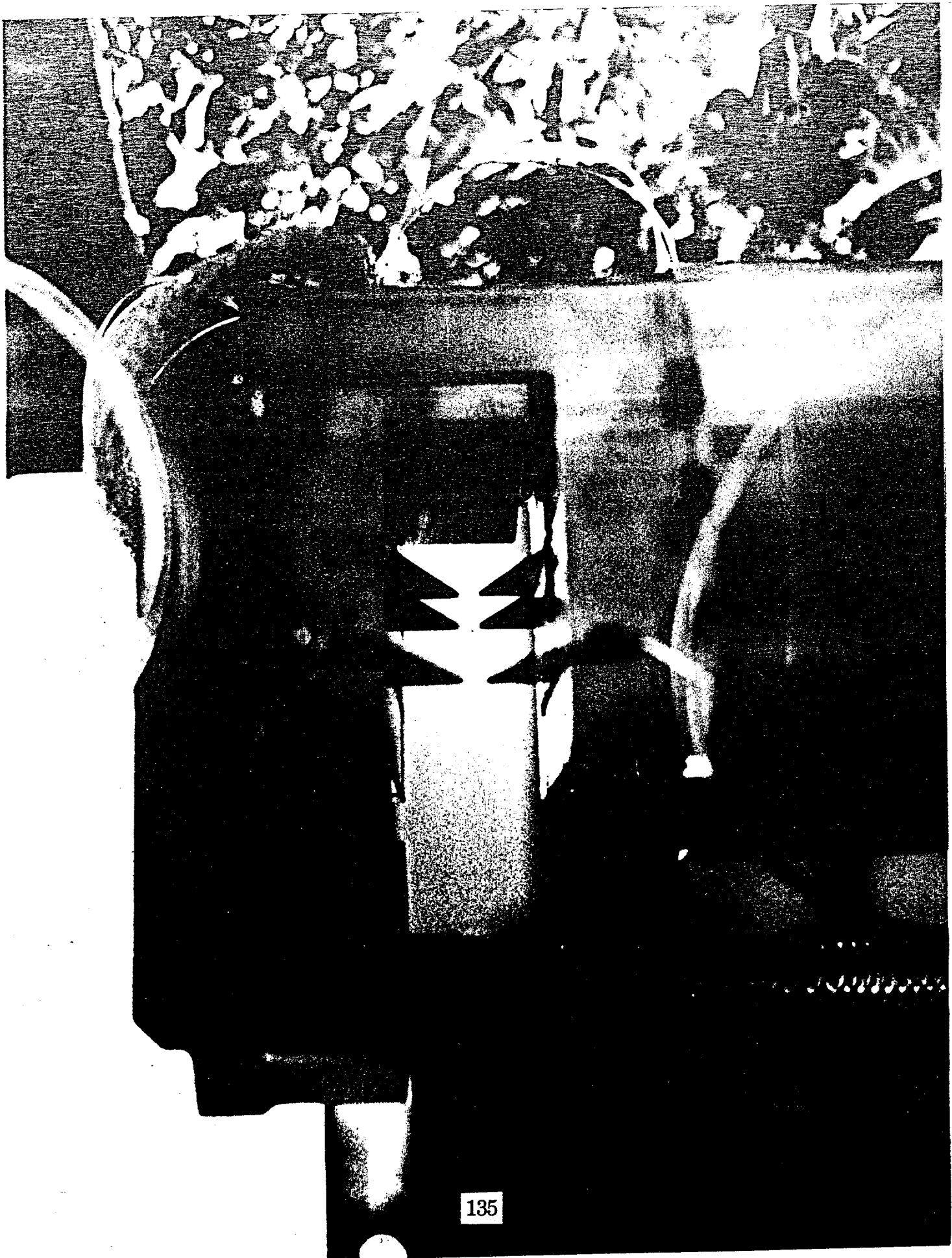
Load Capacity	90 kg
Travel Range	+/- 5mm
Angular Range	+/- 2 deg
Linear Resolution	0.2 μm
Angular Resolution	0.5 arc second
Repeatability:	
Horizontal	+/- 5 μm
Vertical	+/- 2 μm
Angular	5 arc second
Straightness of Trajectory	1×10^{-5} rad/25mm

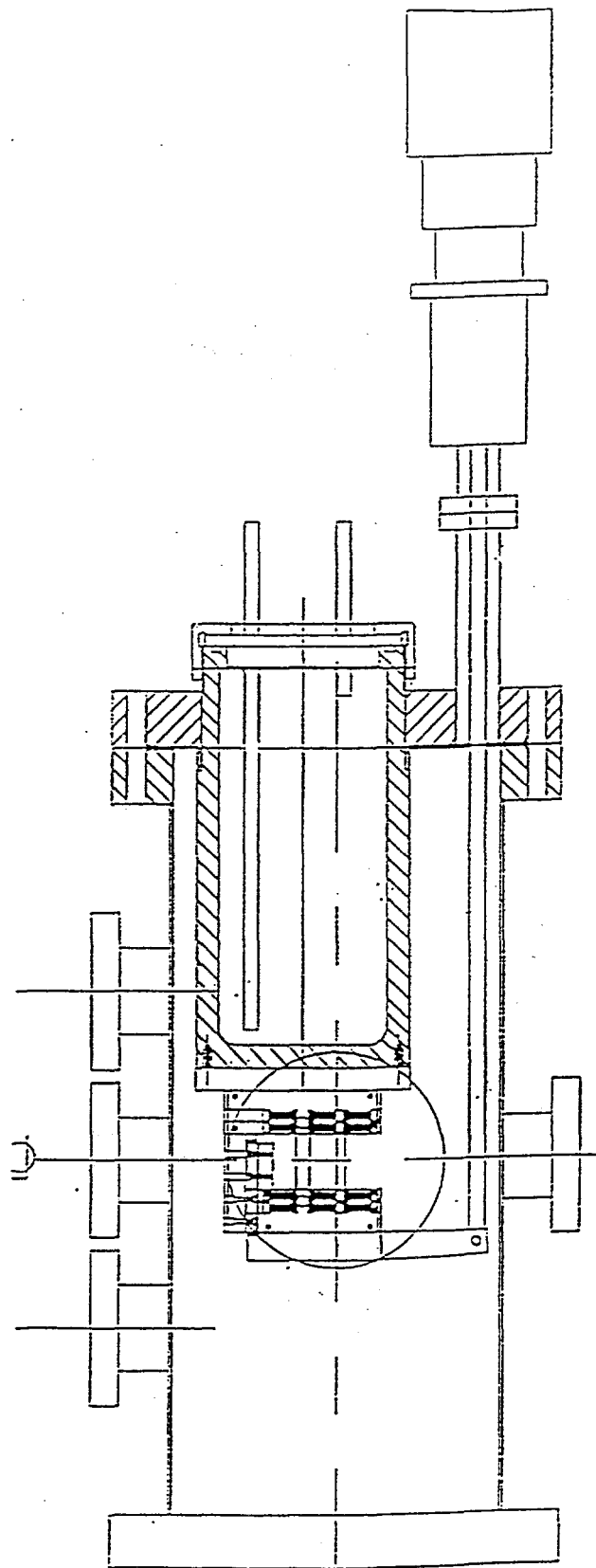
PURPOSE OF THE PRE-PROTOTYPE TEST

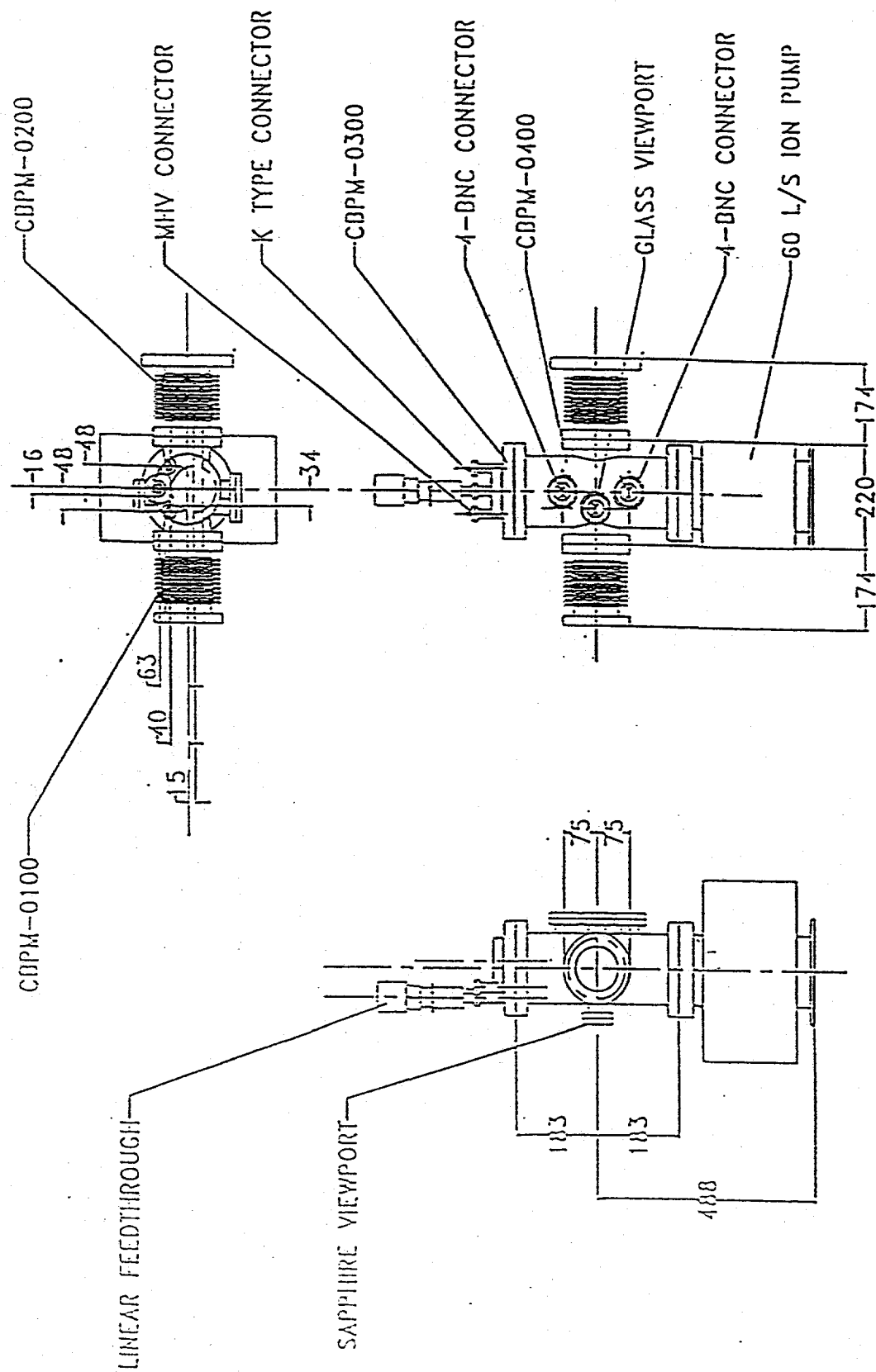
1. EXPERIMENTALLY PROVE THAT
USING THE SOFT X-RAY PART OF THE
HARD X-RAY UNDULATOR BEAM
WILL DETERMINE THE BEAM CENTER
POSITION
2. TEST THE DEVICE SENSITIVITY
3. ASSESS THE BENDING MAGNET
SYNCHROTRON RADIATION
CONTAMINATION
4. CHECKOUT BLADE GAP IN
ADJUSTMENT IN UHV AND
REPRODUCIBILITY
5. ASSESS IF TWO VERTICAL PAIR OF
BLADES WILL PROVIDE A GOOD
HORIZONTAL POSITION
INFORMATION



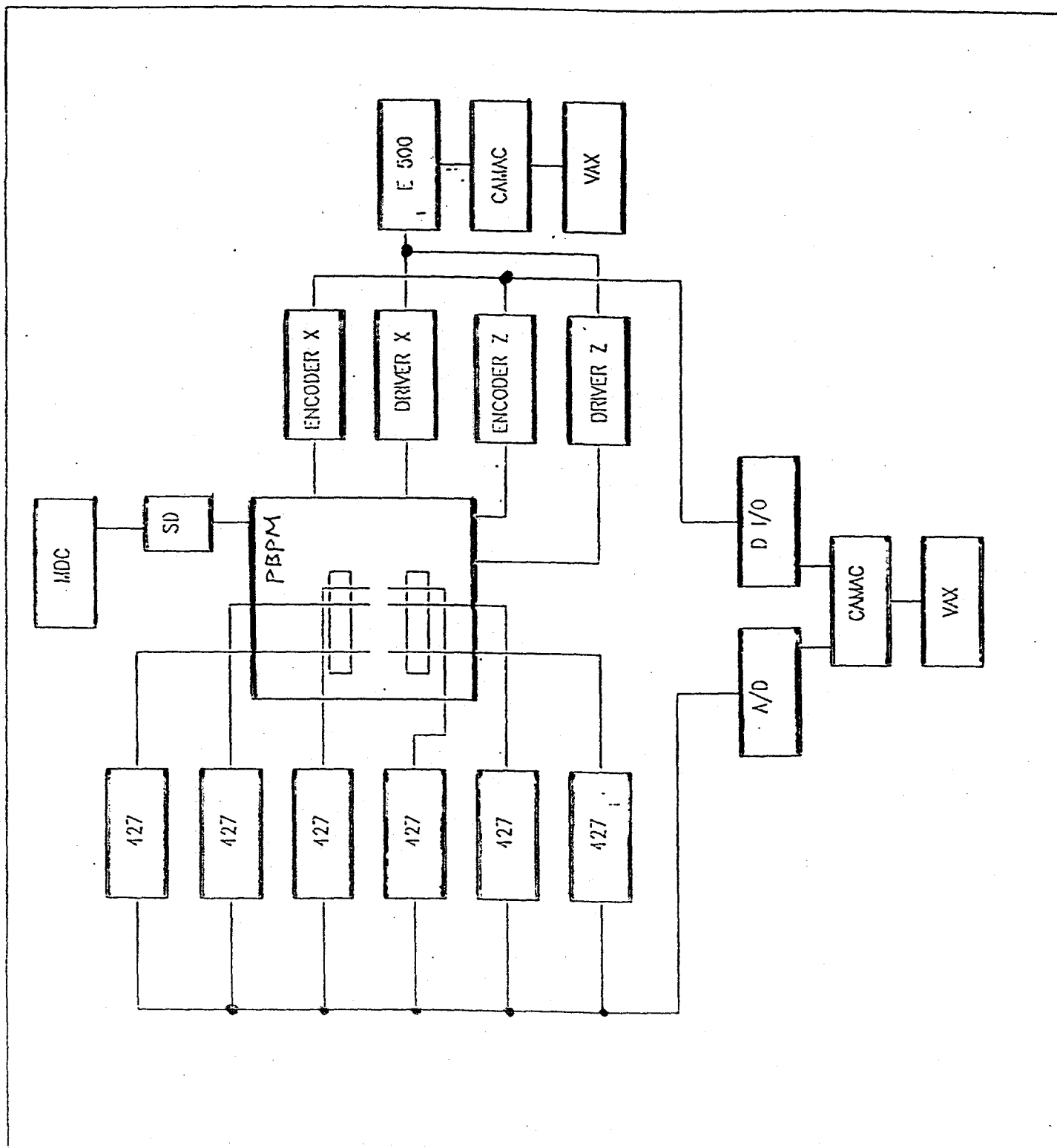
Assembly drawing of the Photon Beam Position Monitor
 Tested at CHESS, Cornell University





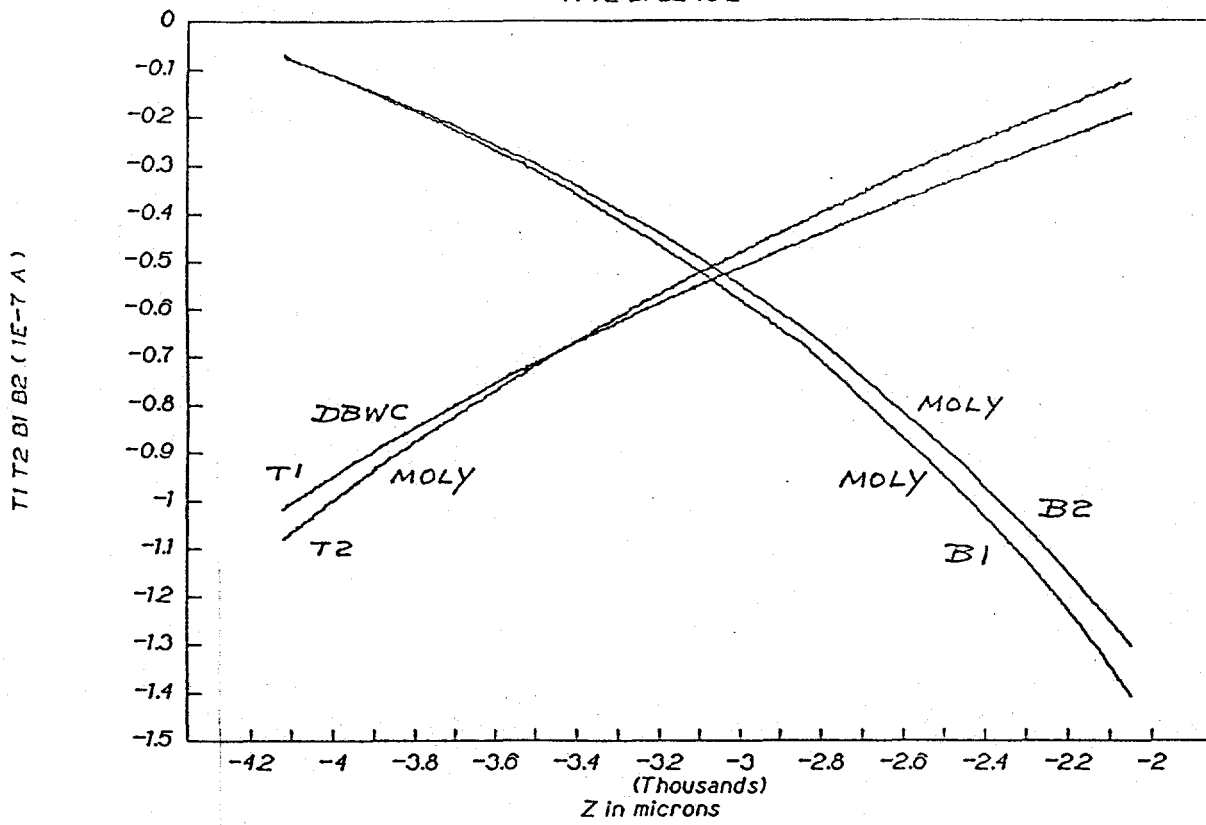


Layout of the APS Photon Beam Position Monitor for the
APS/CHSS Undulator Runs



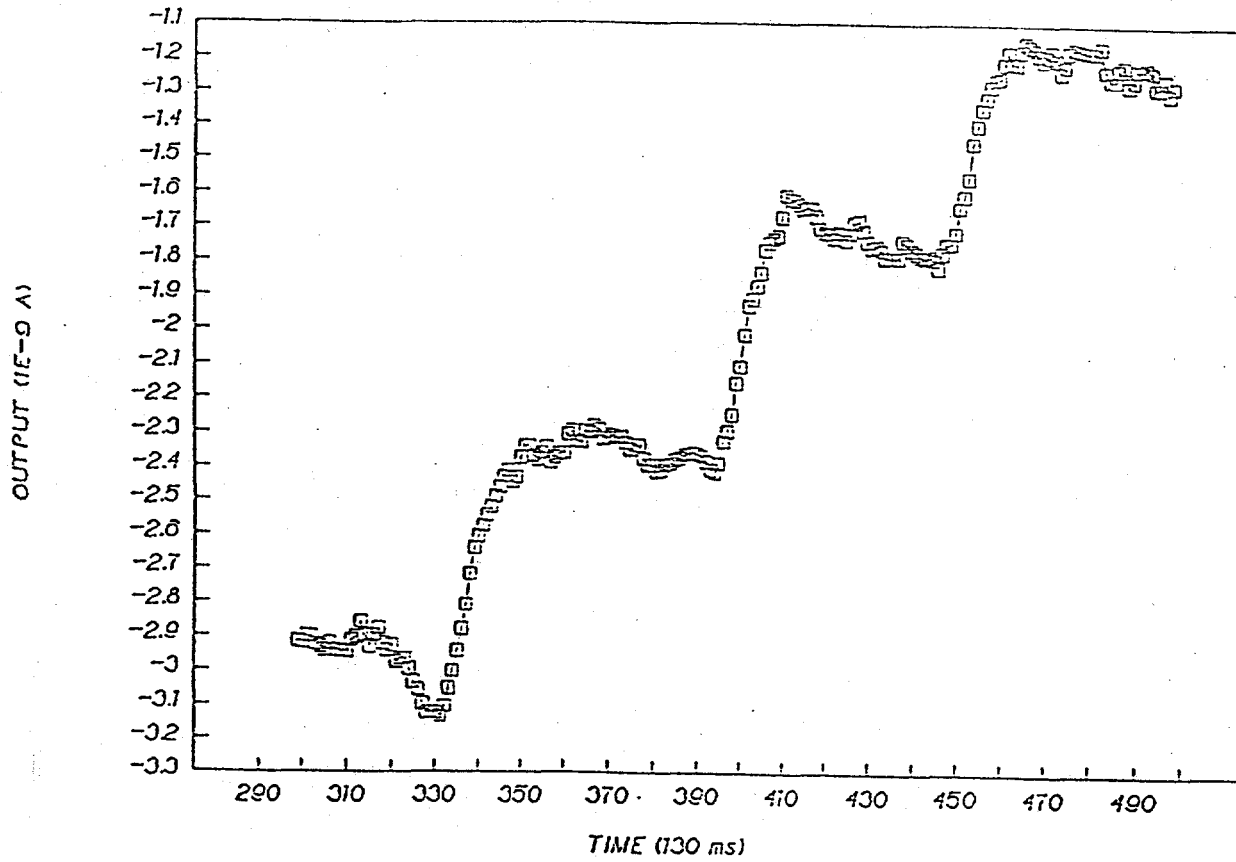
C061714.DAT

T1 T2 B1 B2 vs Z



Diamond Blade and Molybdenum Blade Tests at CHESS

5 μ m JUMPS TEST



Diamond Blade sensitivity tests to 5 μ m step change at
CHESS

"WORST CASE" TEST.

July 15, 1991

ANL / CHESS UNDULATOR (GAP = 15 mm)

5.4 GEV

120 MA

POWER DENSITY AT 8.3 m 280 W/mm^2

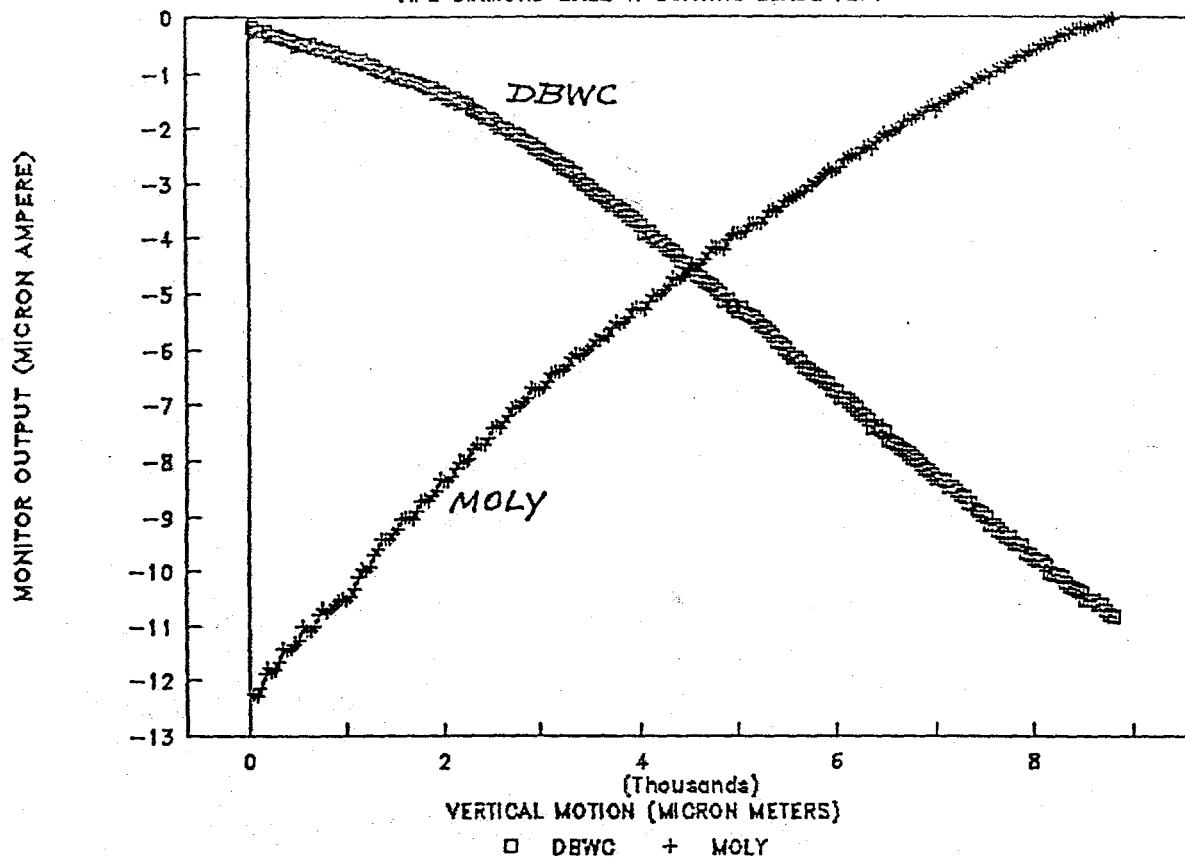
BLADES WERE DIRECTLY IMPINGED BY
THE CENTRAL PART OF THE WHITE BEAM.

THE MONITOR WAS STILL FULLY FUNCTIONAL.

NO VISUAL CHANGES WERE FOUND ON THE
CVD DIAMOND BASE TUNGSTEN COATED BLADE.

052206.DAT (NSLS X13B UNDULATOR BEAM)

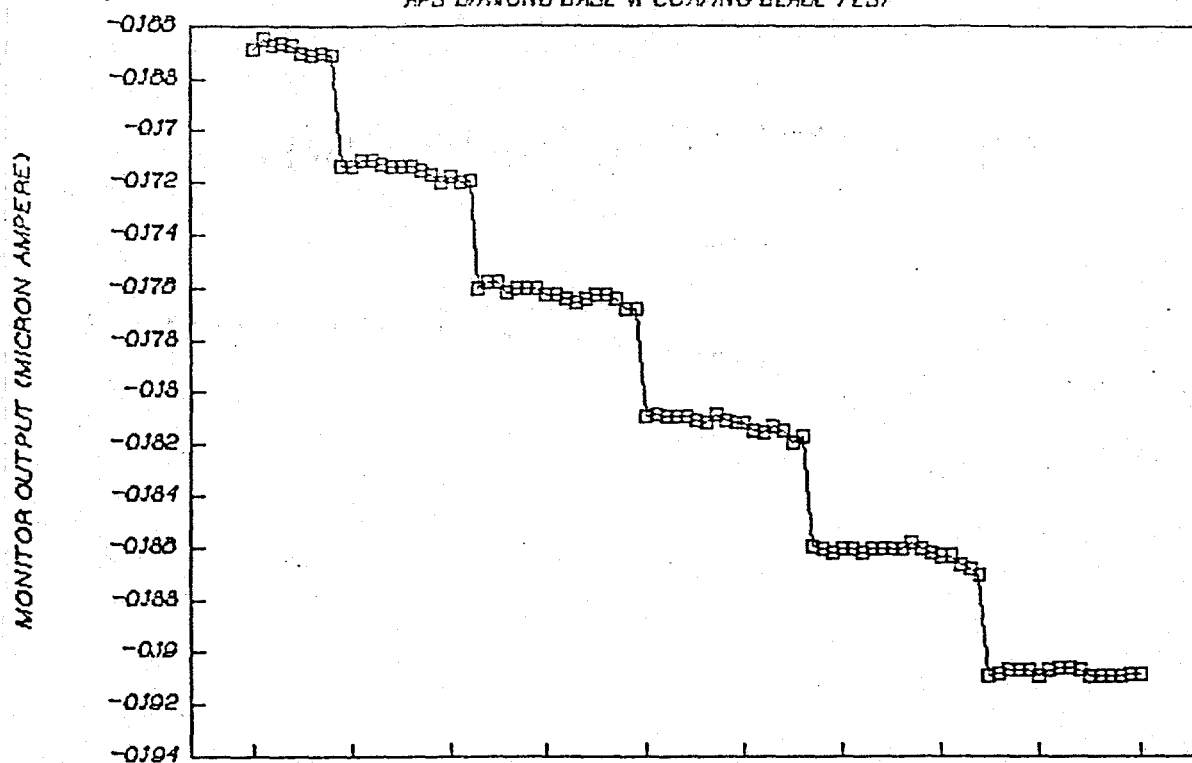
APS DIAMOND BASE W COATING BLADE TEST



Diamond Blade and Molybdenum Blade Tests at NSLS X-13

052214.DAT (NSLS X13B UNDULATOR BEAM)

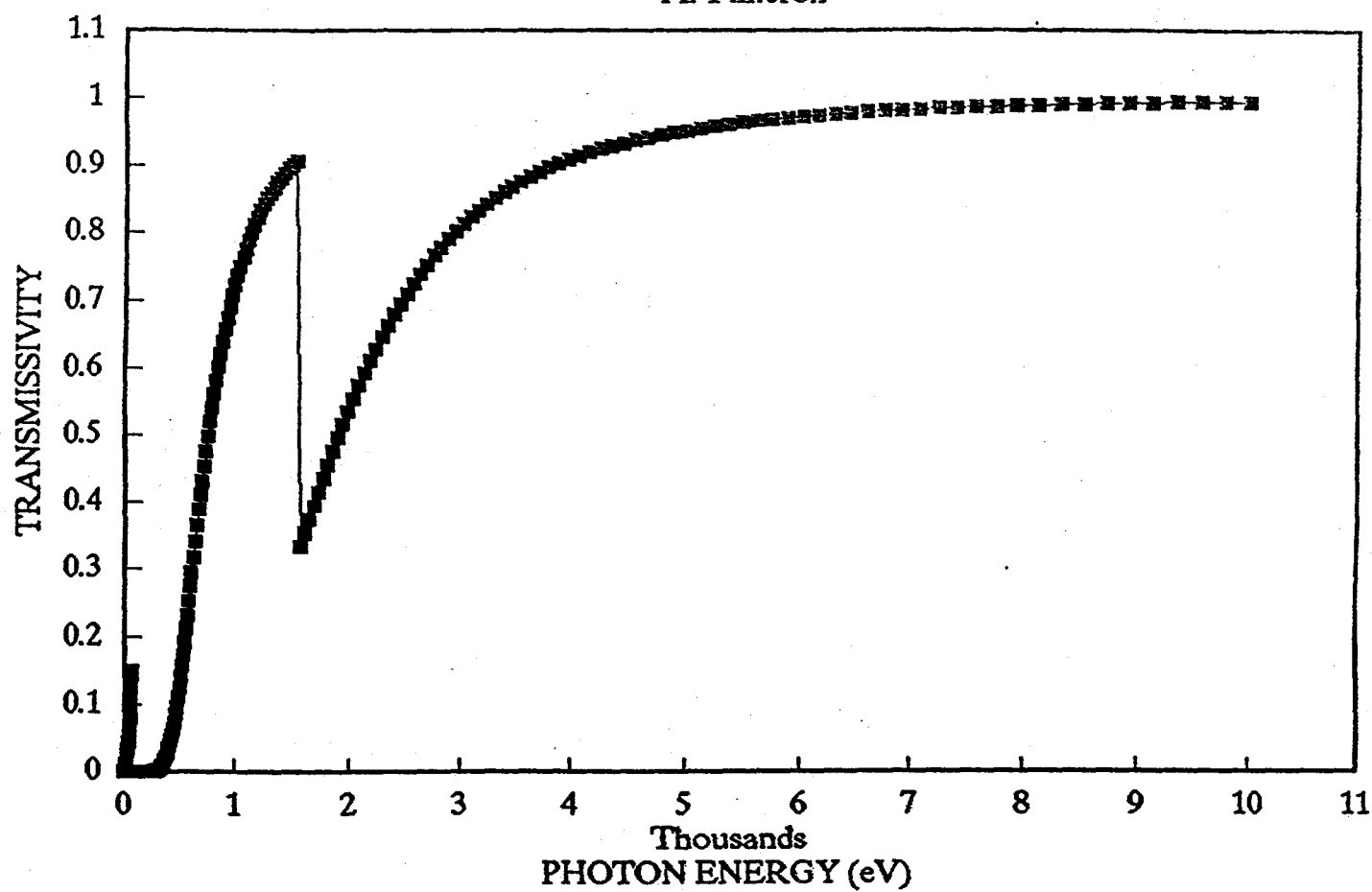
APS DIAMOND BASE W COATING BLADE TEST



Diamond Blade Sensitivity Tests to 5 μm Step Change at NSLS X-13

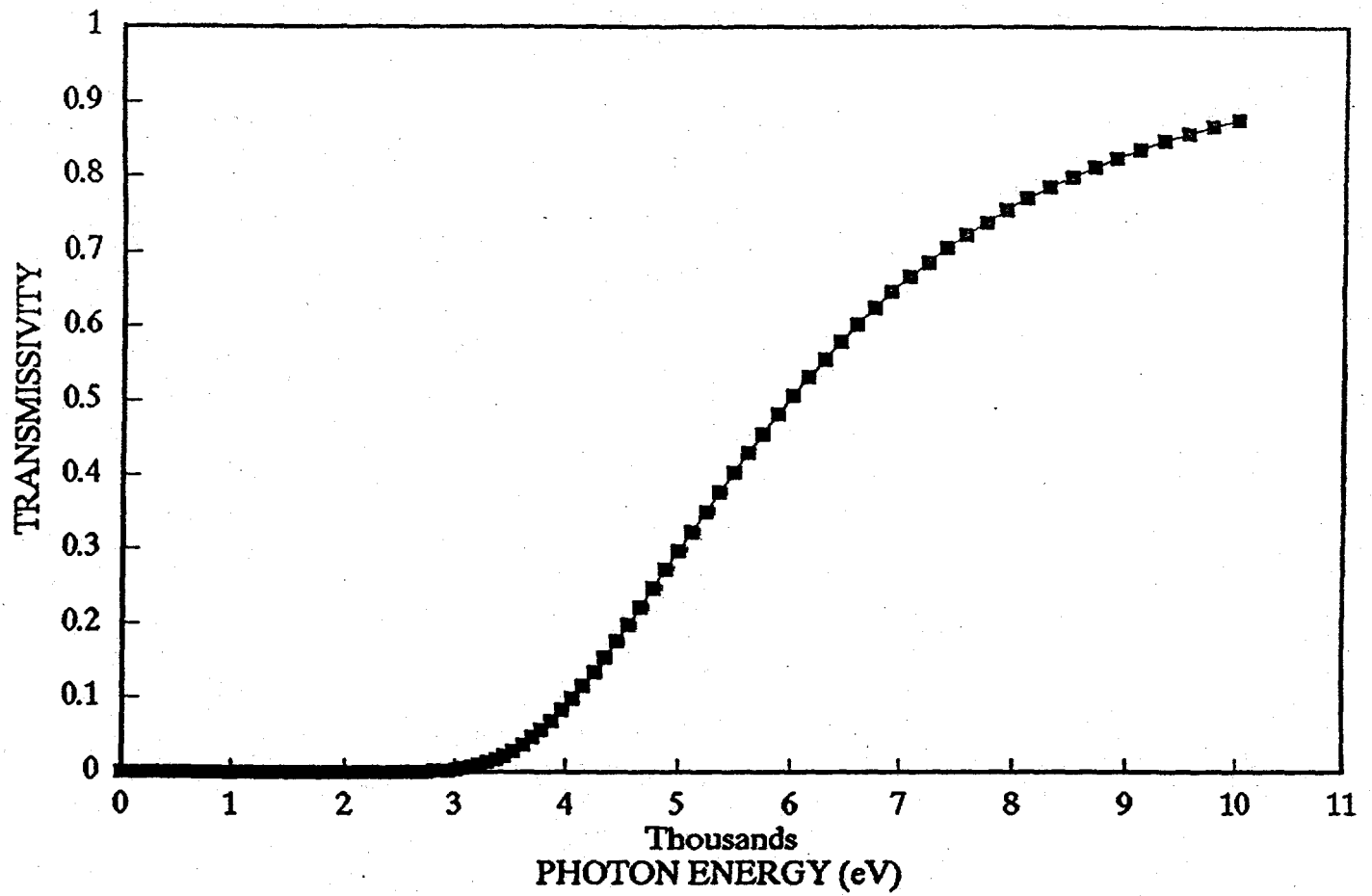
PHOTON TRANSMISSIVITY

Al 1 micron



PHOTON TRANSMISSIVITY

DIAMOND 184 microns



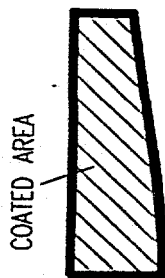


FIG. 1a

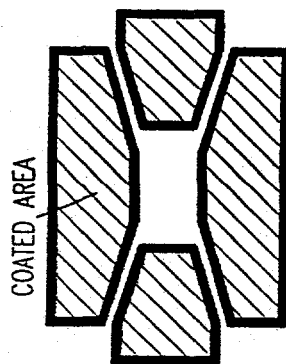


FIG. 1b

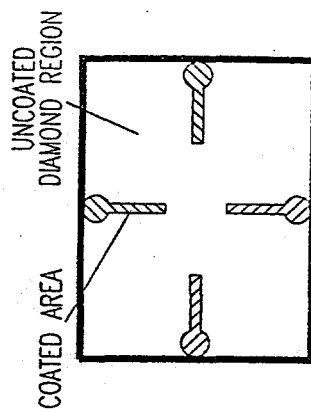


FIG. 1c

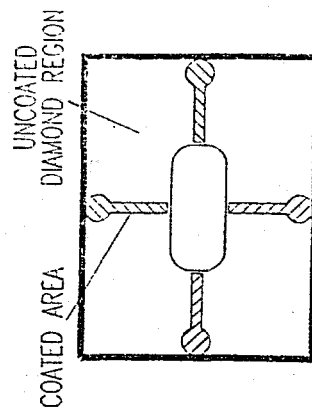
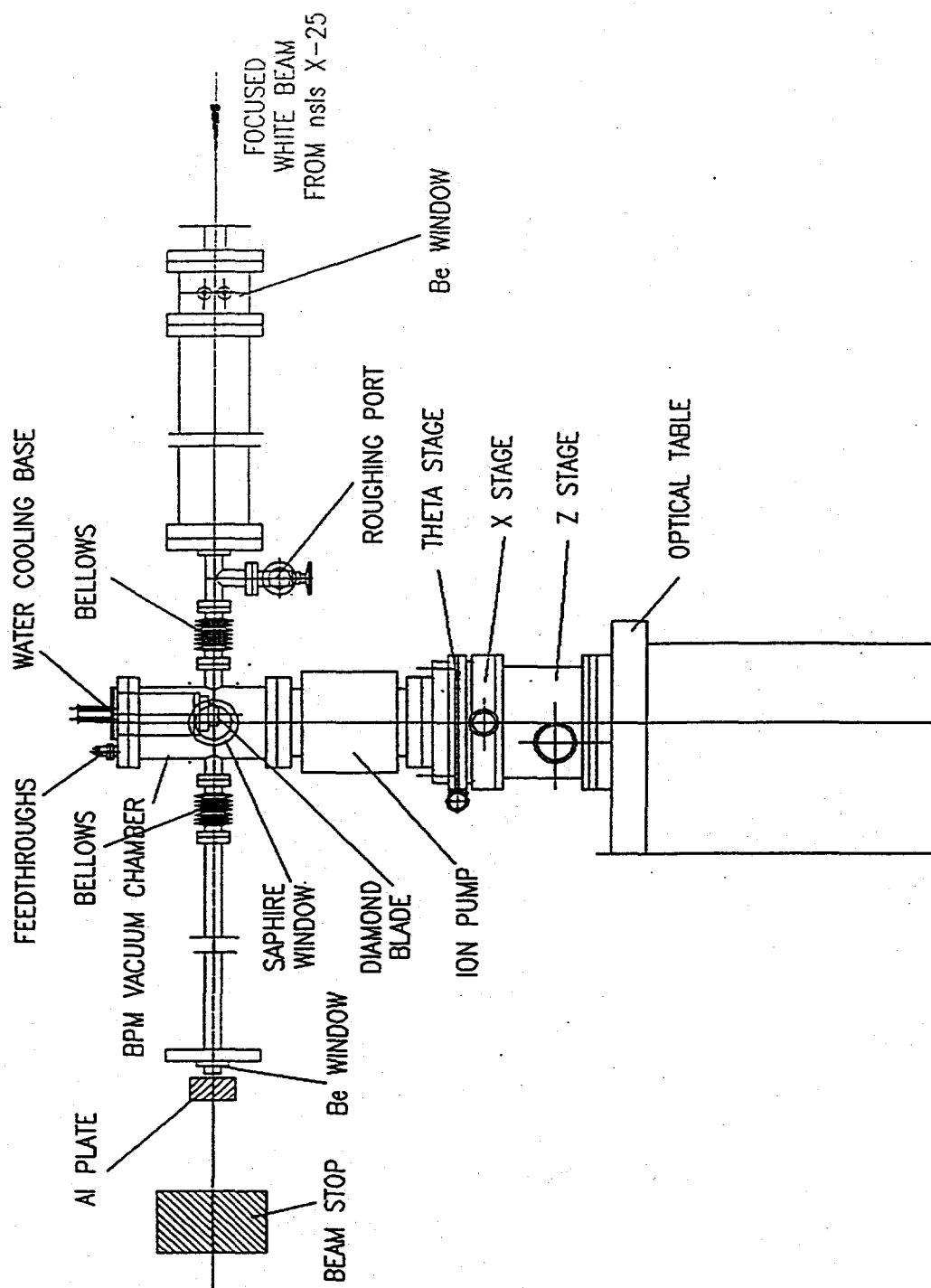


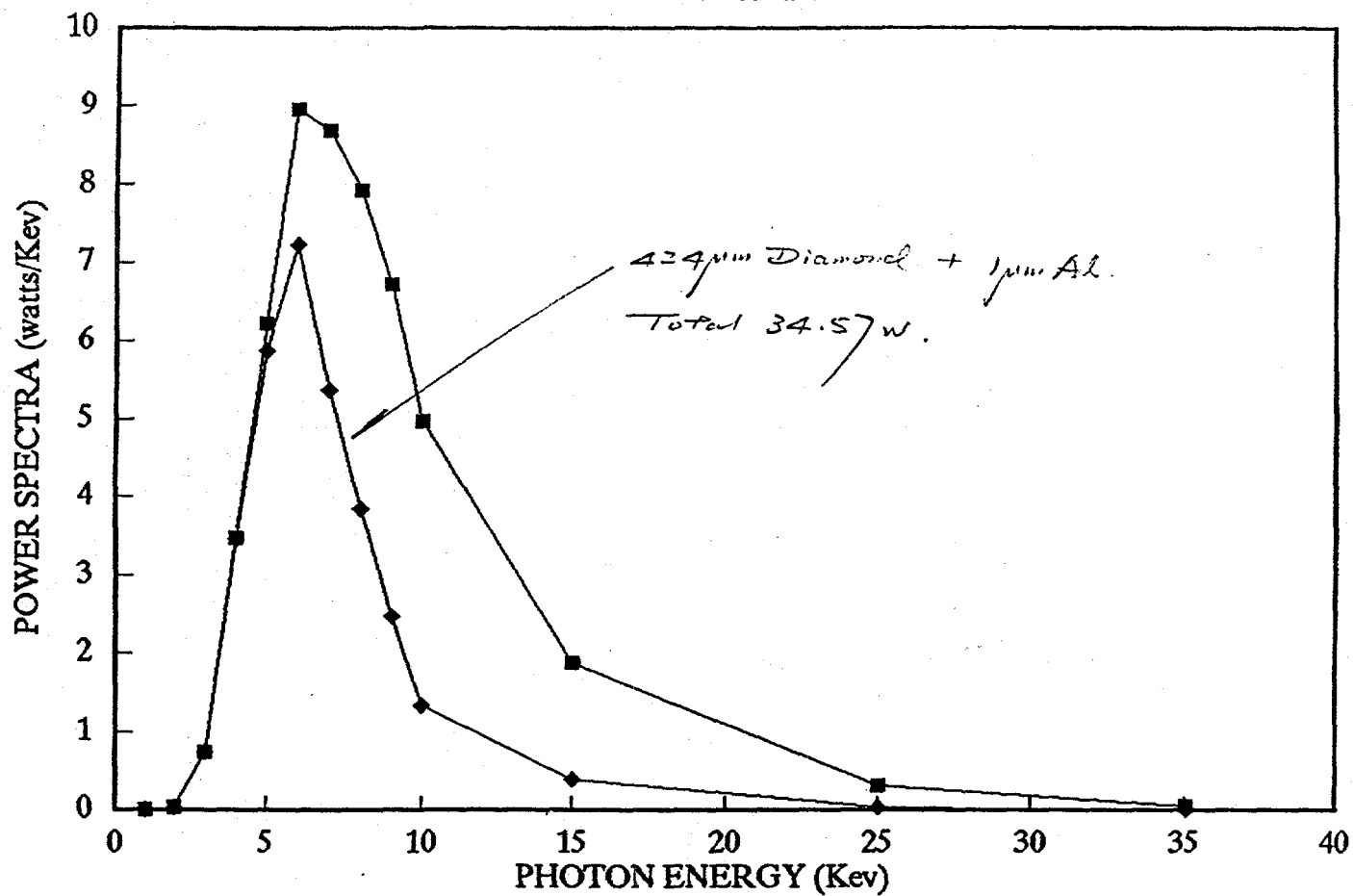
FIG. 1d



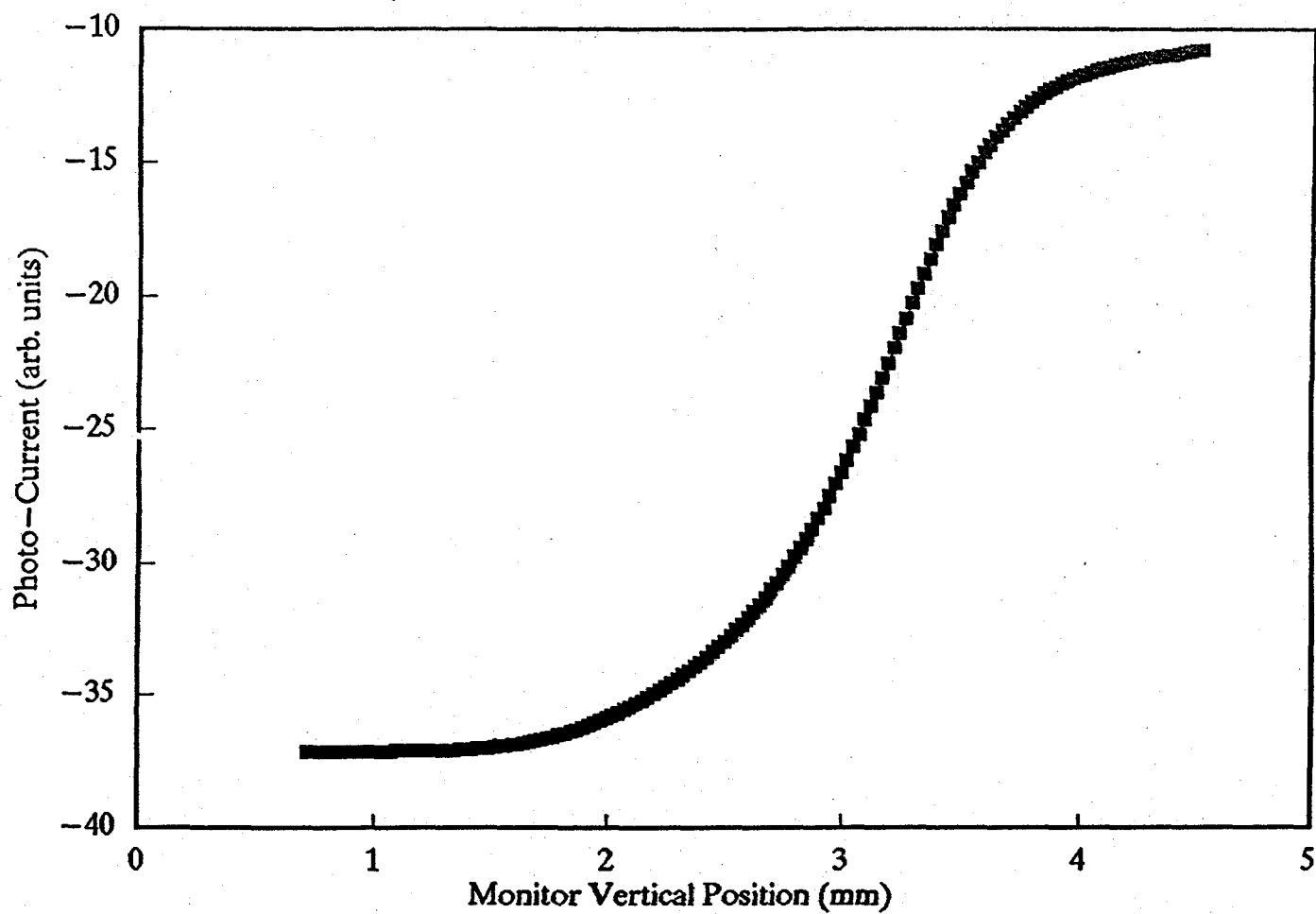
APS PTBPM TEST SET-UP SCHEMATIC AT NSLS X-25

NSLS X-25 POWER SPECTRA

2.5Gev 200ma 70w total AT FOCAL POINT

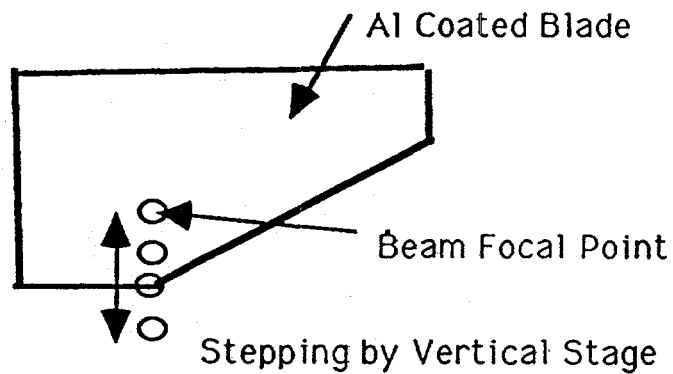


APS/XFD PTBPM TEST AT X-25



ADVANCED PHOTON SOURCE

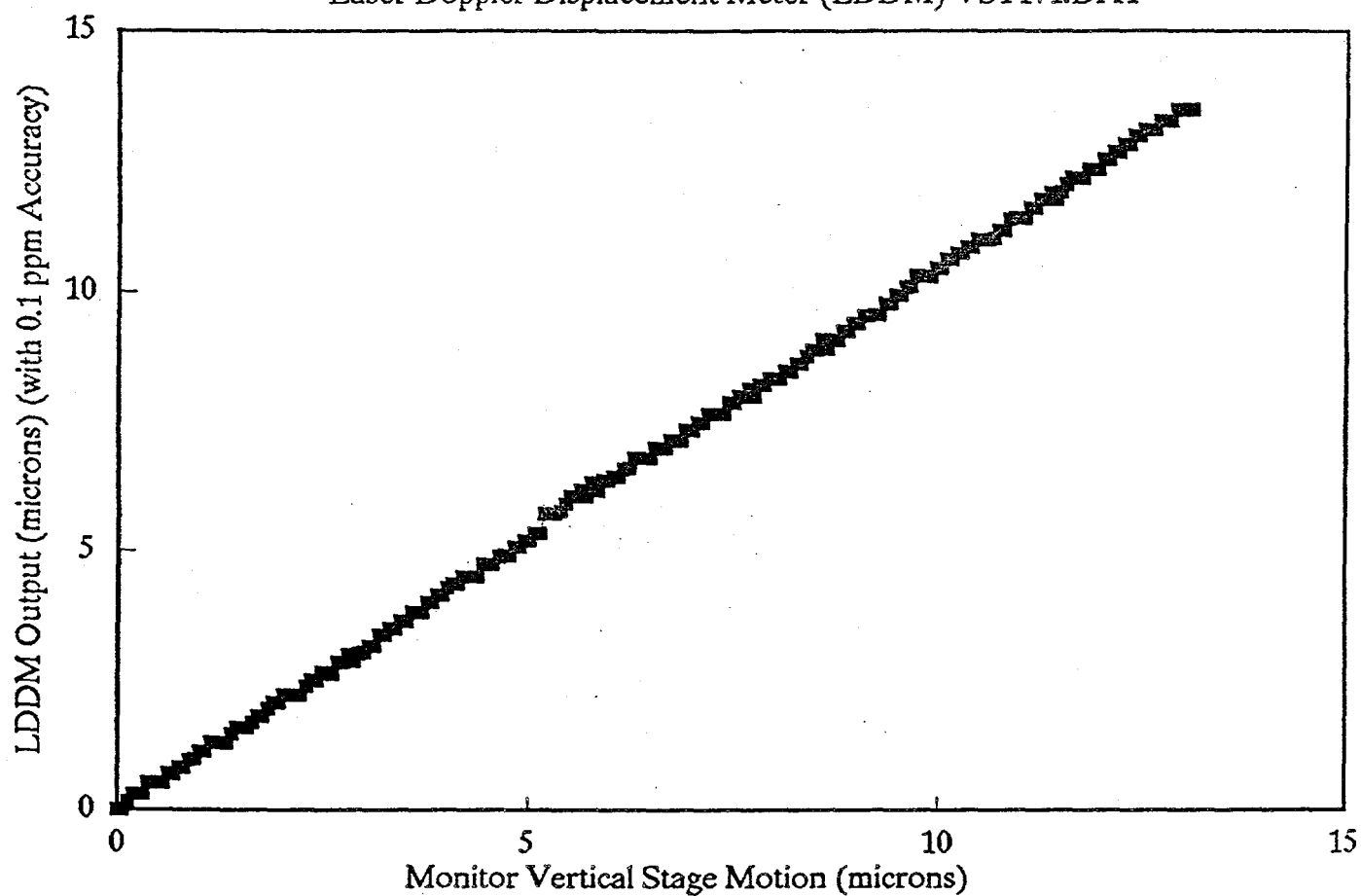
Vertical Stepping Tests at NSLS-X25

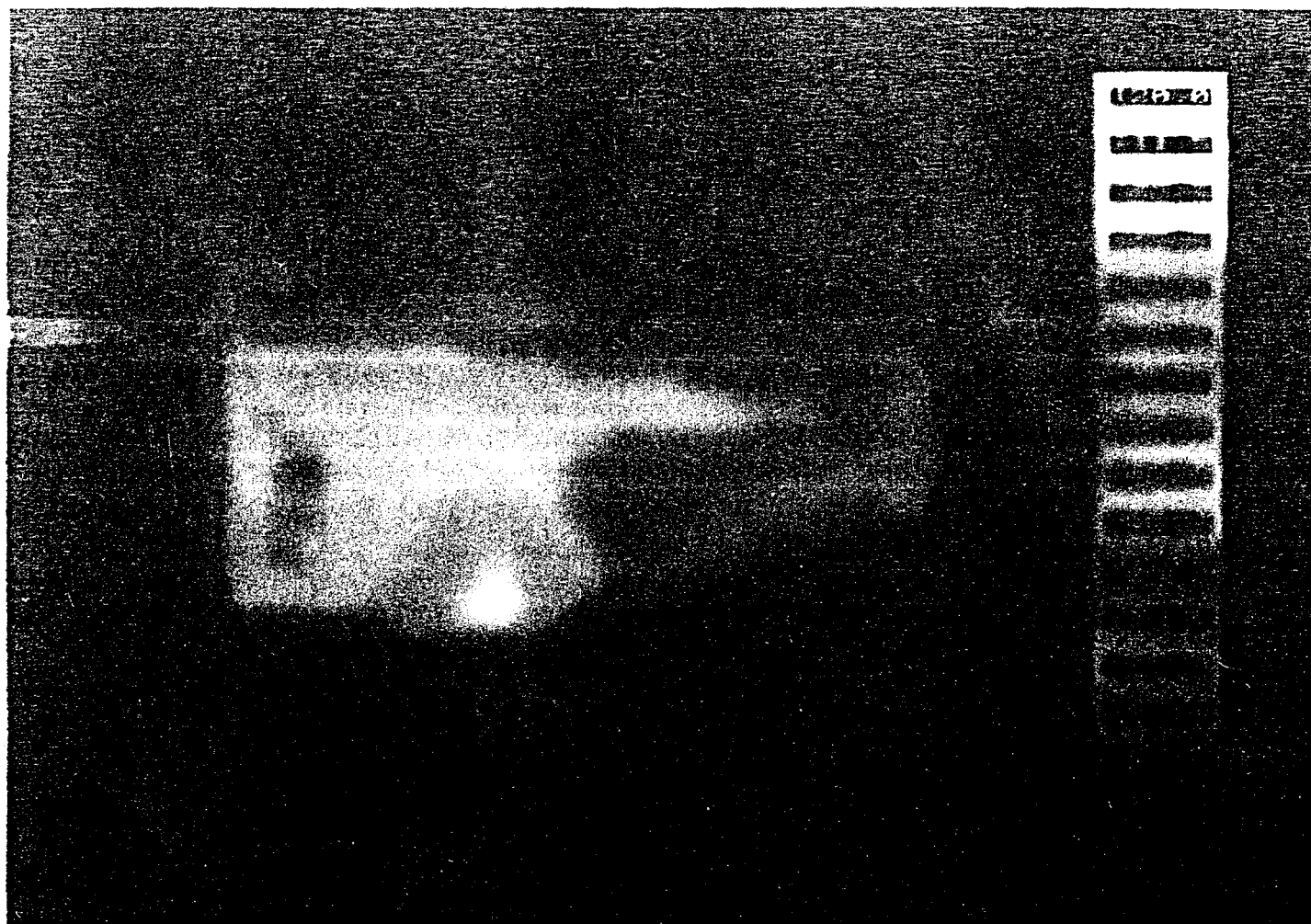


Stepping of the Test Blade 1 with Respect to the Beam with the Vertical Stage

APS/XFD BPM Vertical Stage Test

Laser Doppler Displacement Meter (LDDM) VST171.DAT





Andrew Harrison

Edinburgh University

**Physical and Technological Aspects of
Storage Phosphor Plates Made of BaFBr:Eu²⁺**

In recent years, two-dimensional x-ray detectors have been developed that are based upon the use of BaFBr phosphor. This phosphor stores the x-ray image in the form of trapped charge, the charge having been produced by the x-ray ionization. The image may be read by exposing the plate to red light and observing the stimulated, blue luminescence. In this article, we describe the mechanisms of photostimulated luminescence (PSL) in BaFBr and show how this affects the material's use as a detector of x-ray diffraction images. Our research indicates that all our observations can be rationalized by postulating that one of the trapped species hops randomly in two dimensions until it finds itself in close proximity to a filled recombination center. Once they are in proximity, sub-condition band recombination can occur via photostimulation. This random lattice migration affects the image stability, the effective detector sensitivity, and the ability to zero the image, and it causes the recuperation of partially zeroed PSL signals. These effects will be described, and their implication for high-precision x-ray measurements will be examined. We have also been engaged in making phosphor plates specifically designed for x-ray diffraction applications. We describe the progress we have made towards developing the technology for making fully erasable image plates with improved spatial resolution.

PHYSICAL AND TECHNOLOGICAL ASPECTS OF STORAGE PHOSPHOR PLATES.

ANDREW HARRISON + RICHARD TEMPLE^{*}

Department of Chemistry, Edinburgh

* Department of Chemistry, Imperial College,
London

with -

A. SYRYKH + G. P. KEOGH, IMPERIAL

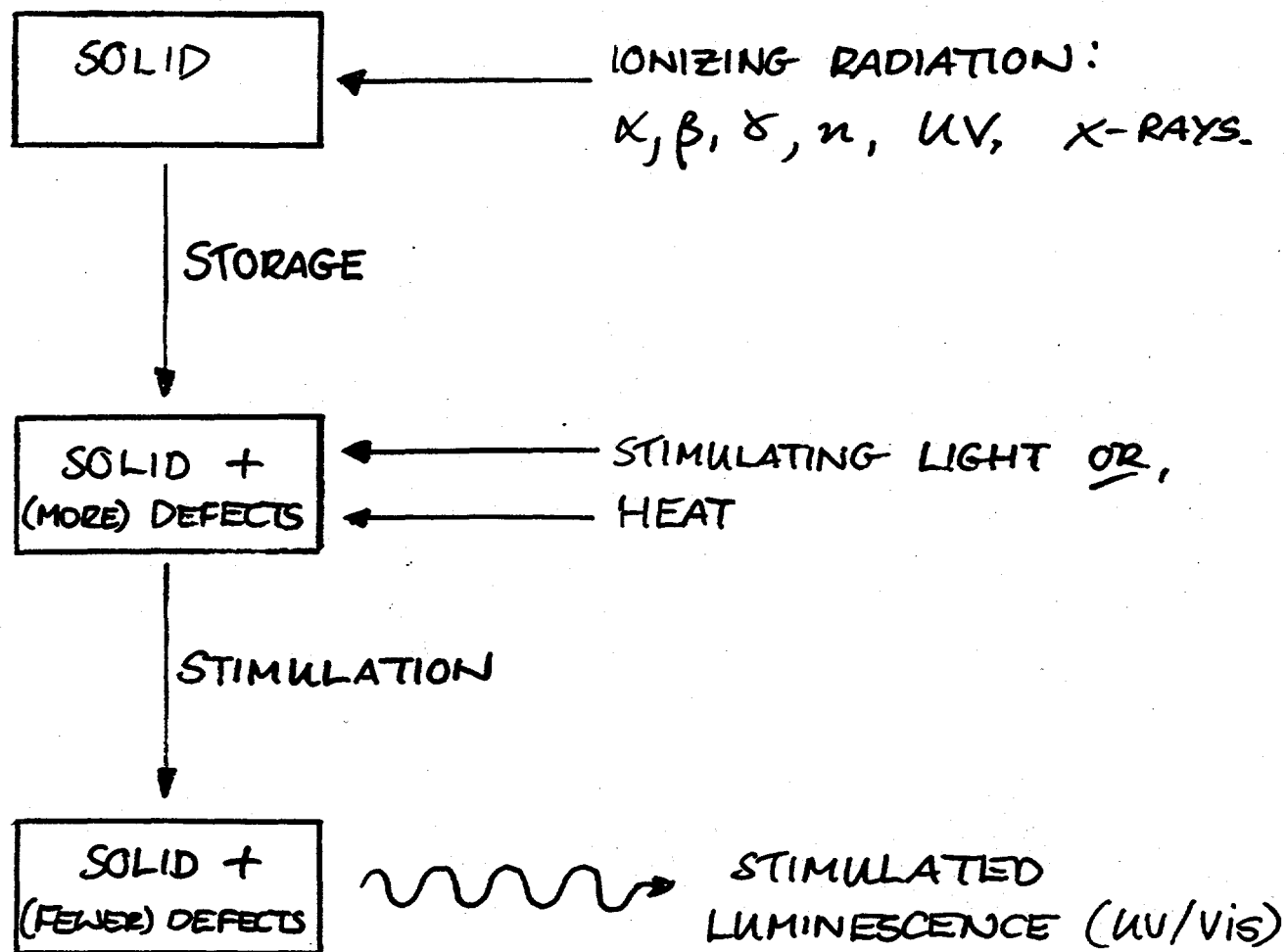
M. T. HARRISON + A. S. WILLS, OXFORD

C. HALL + R. LEWIS DARESBURY

C. WILKINSON EMBL,
GRENOBLE

● STORAGE PHOSPHORS

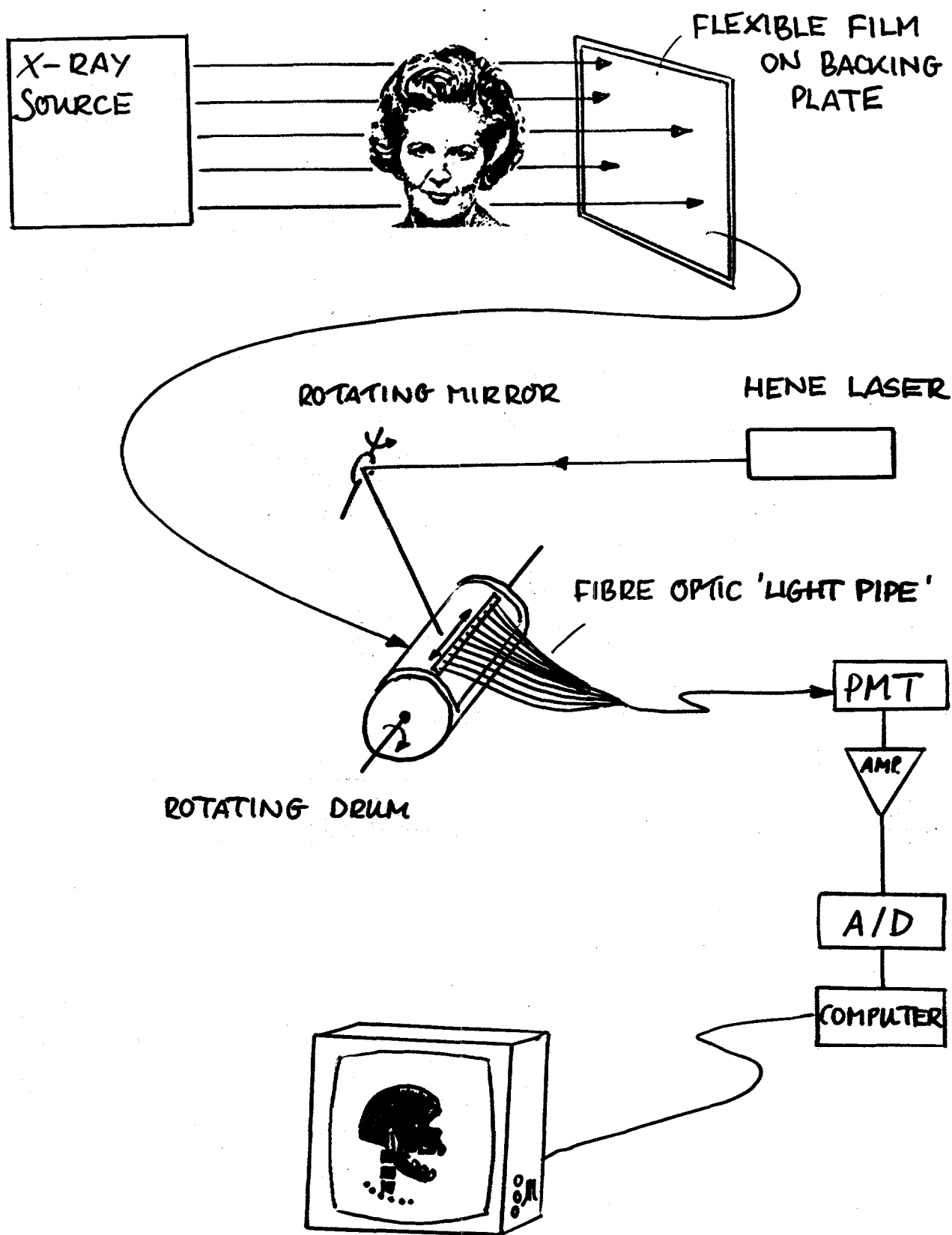
WHAT HAPPENS WHEN IONIZING RADIATION
IMPINGES ON AN INSULATING SOLID ?



IF LUMINESCENCE IS STIMULATED BY LIGHT IT IS
CALLED PHOTOSTIMULATED LUMINESCENCE (PSL).

IF STIMULATED BY HEAT IT IS CALLED
THERMOLUMINESCENCE (TL).

P.S.L. RADIOGRAPHY MACHINE



PREVIOUS WORK

PHILIPS, FUJI, KODAK, SIEMENS,
du PONT

Takahashi et al, J. Lumin 31 832 (1984)
266

Amemiya et al, Nucl. Inst. & Methods
A266 (1988) 645

Von Seggen et al, J. Appl. Phys. 64
(1988) 1405

Crawford et al, J. Appl. Phys. 66 (1989) 3758

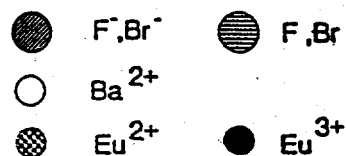
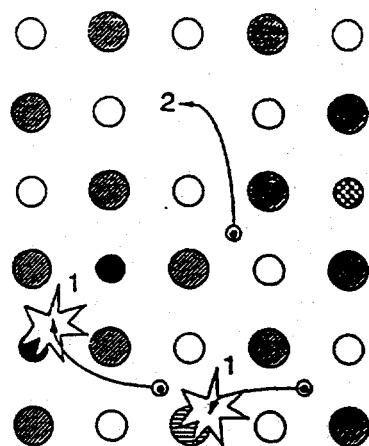
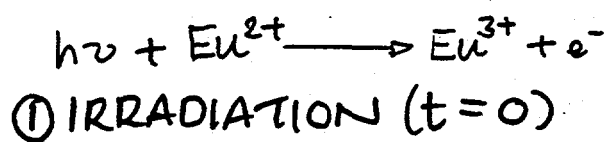
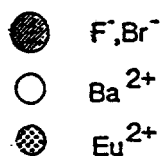
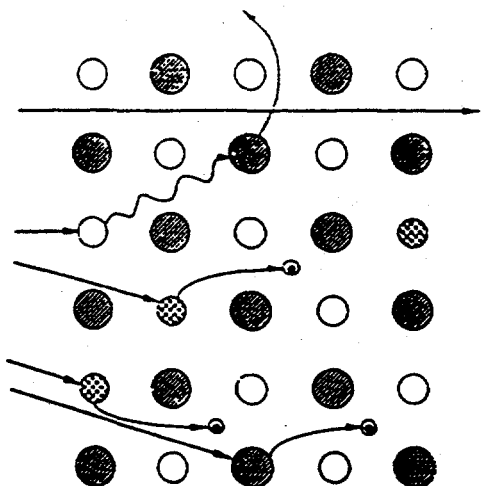
Koschnick et al, Phys. Rev. Lett. 67 (1991)
3571

Templer et al, Acta Cryst (In Press)

Almost exclusively on BaFBr:Eu²⁺

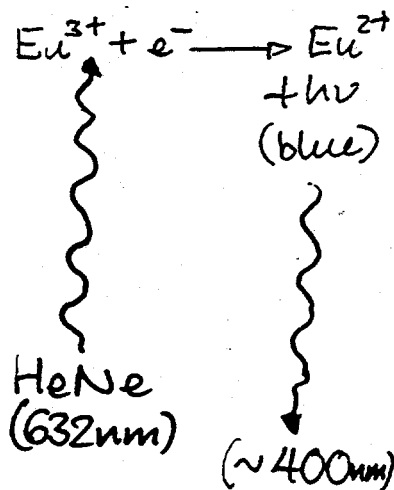
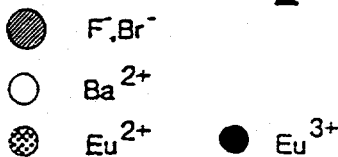
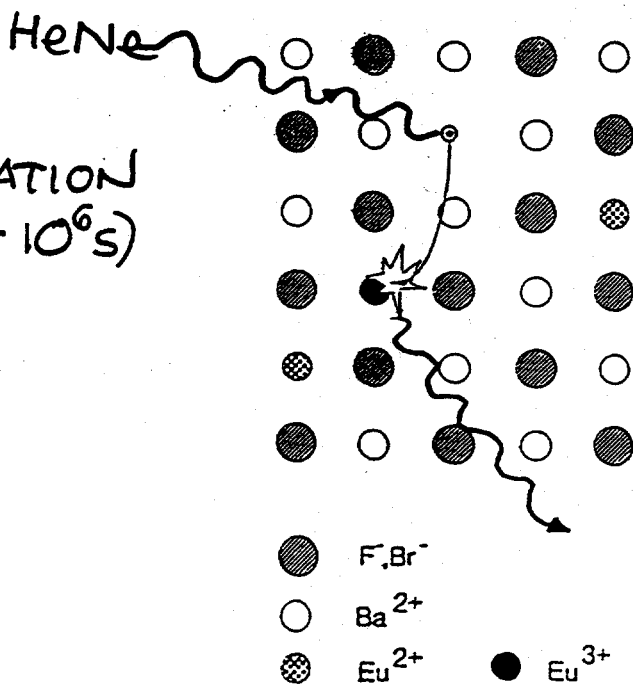
OUTLINE OF THE TALK

- 'CLASSICAL' MODEL FOR STORAGE, STIMULATION + ERASURE
- OUR MEASUREMENTS OF STORAGE AND STIMULATION KINETICS IN BaFBr:Eu^{2+}
- A REFINED MODEL AND ITS TECHNOLOGICAL IMPLICATIONS
 - STORAGE STABILITY
 - SENSITIVITY
 - DYNAMIC RANGE
 - RESOLUTION
 - ERASURE



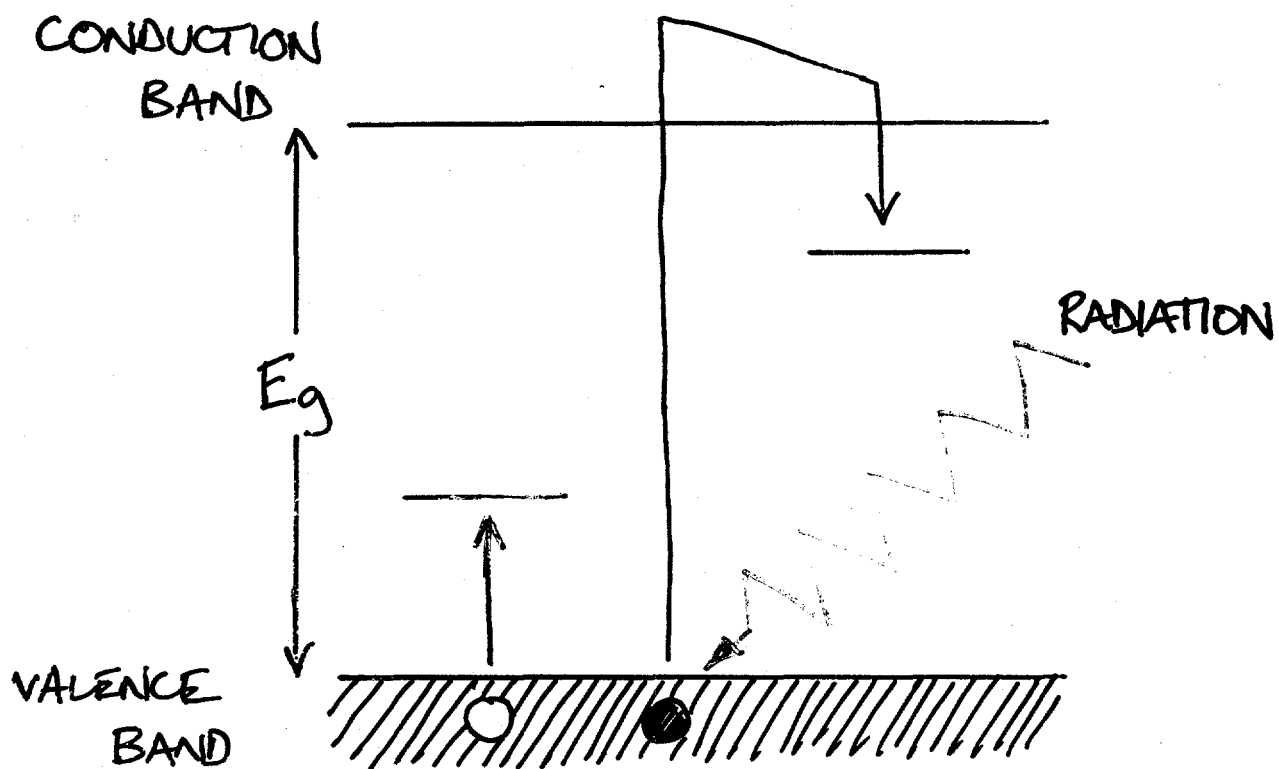
② SOON AFTER IRRADIATION ($t < 10^{-3}$)

③ STIMULATION ($t = 10^2 - 10^6$ s)



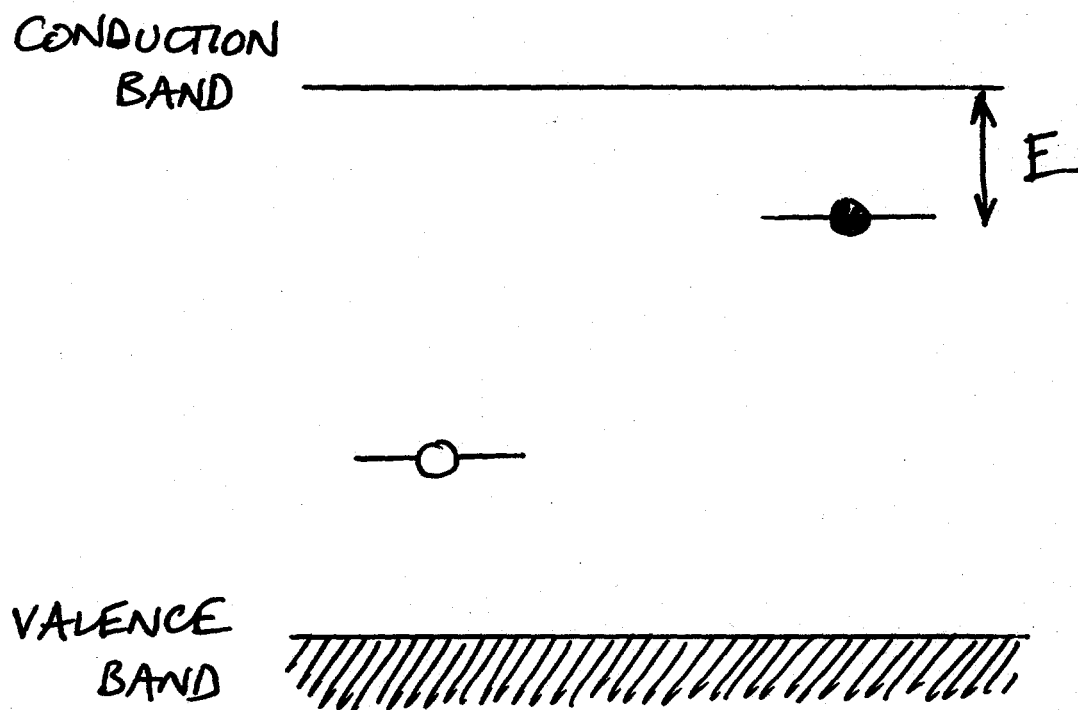
THE CLASSICAL PICTURE

- IRRADIATION



THE CLASSICAL PICTURE

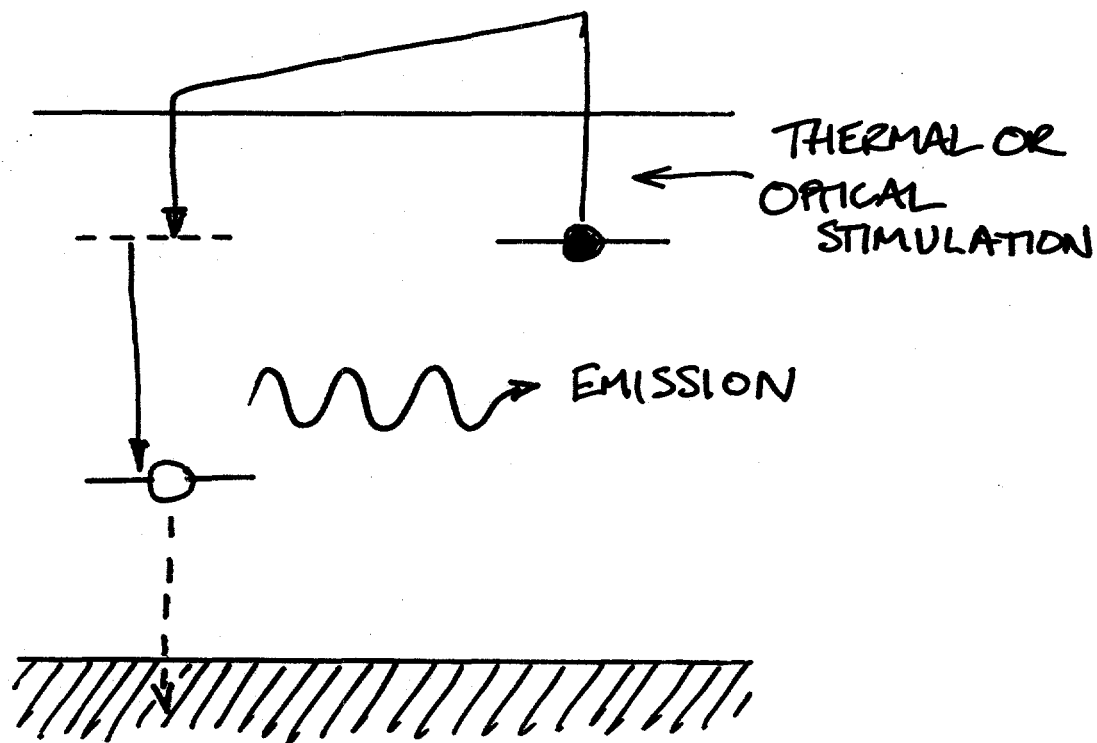
- STORAGE

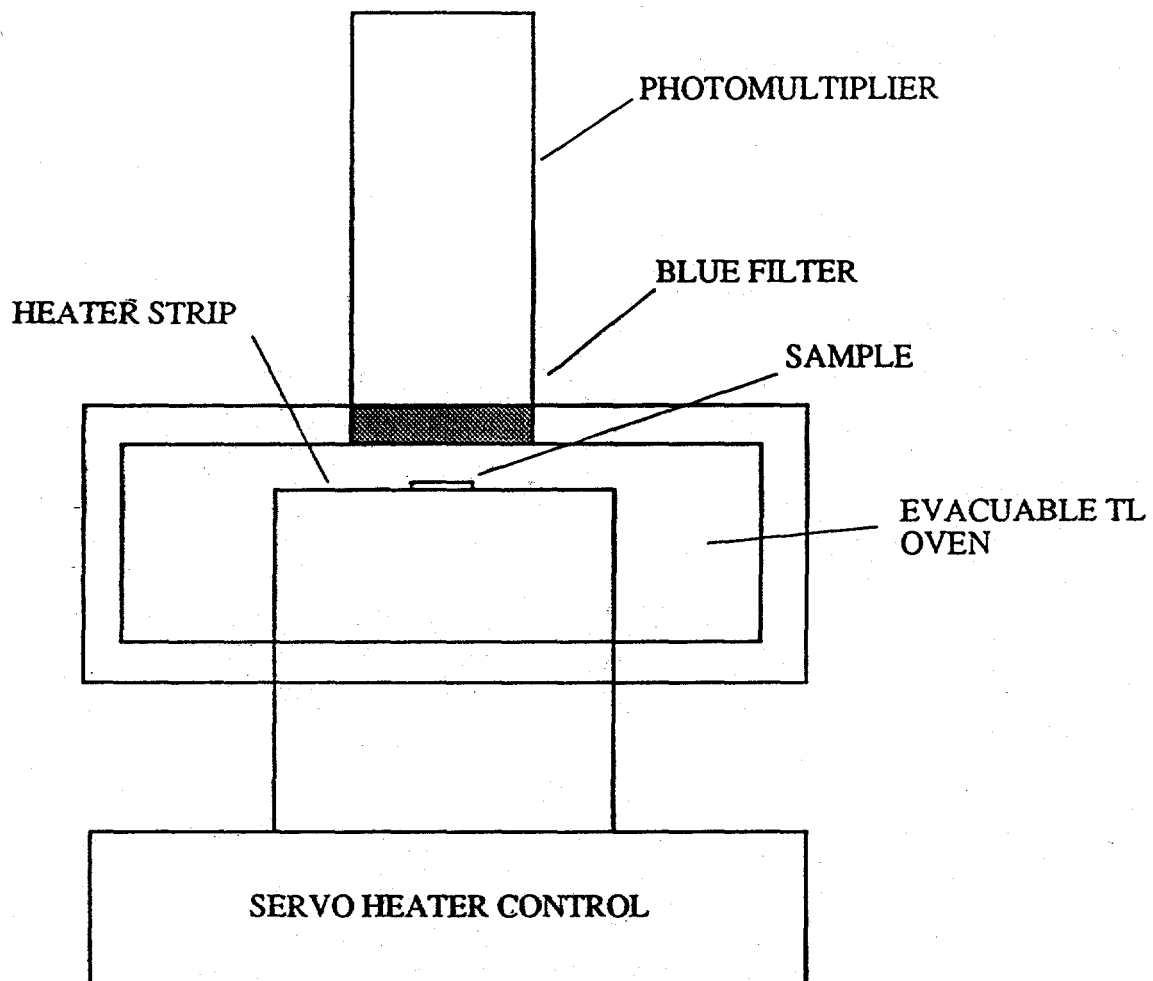


$$\tau = s^{-1} e^{E/kT}$$

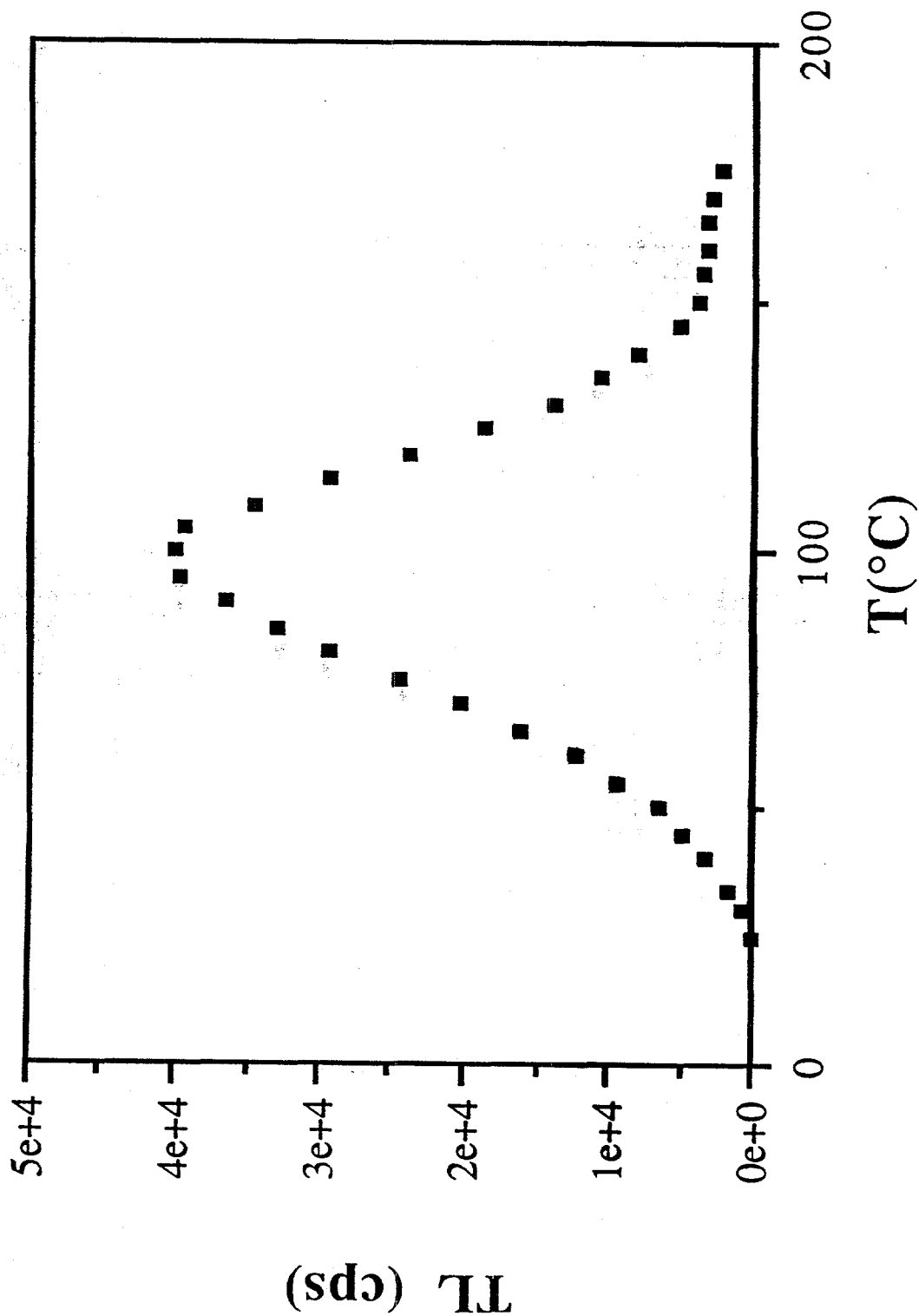
THE CLASSICAL PICTURE

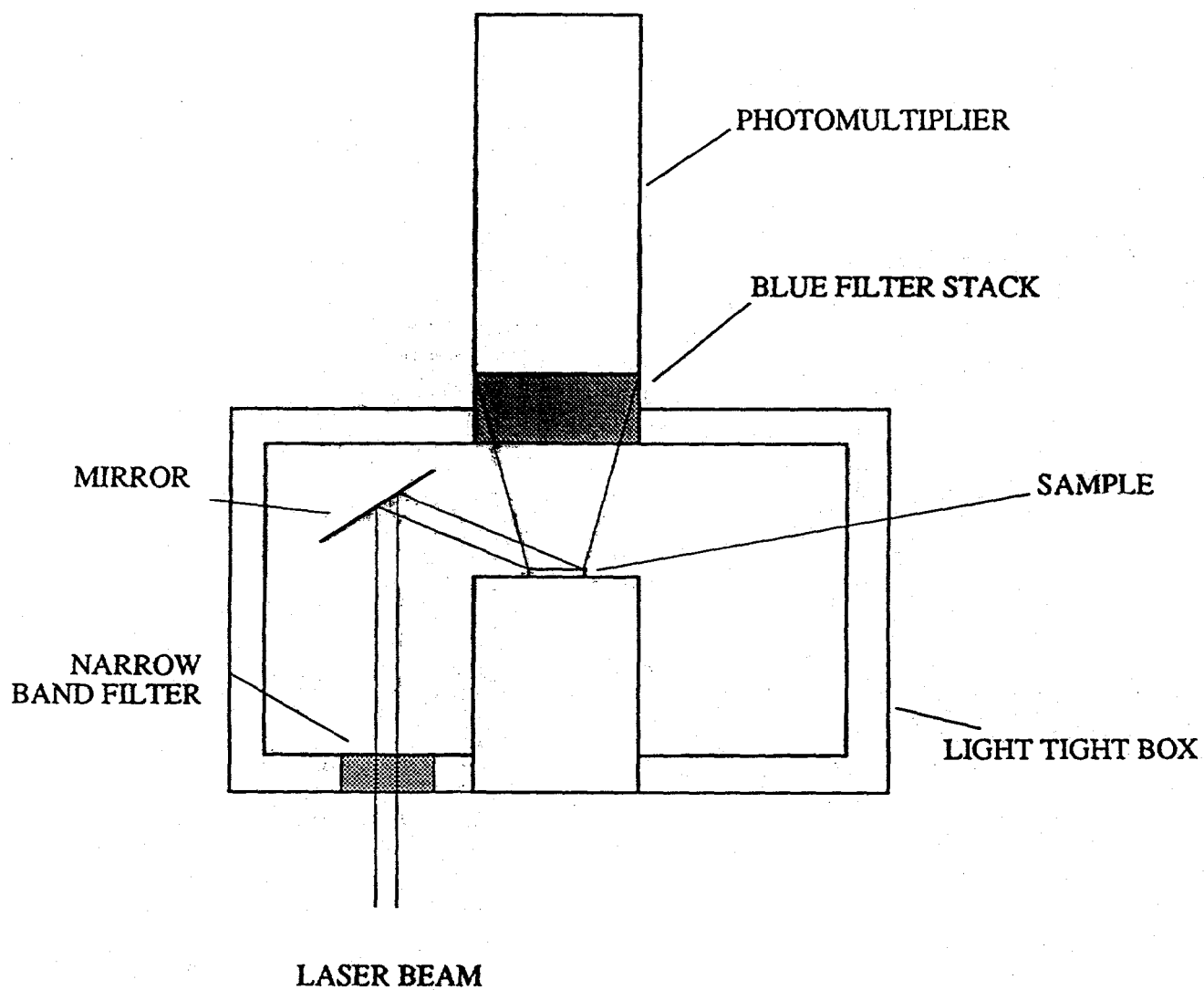
- READOUT



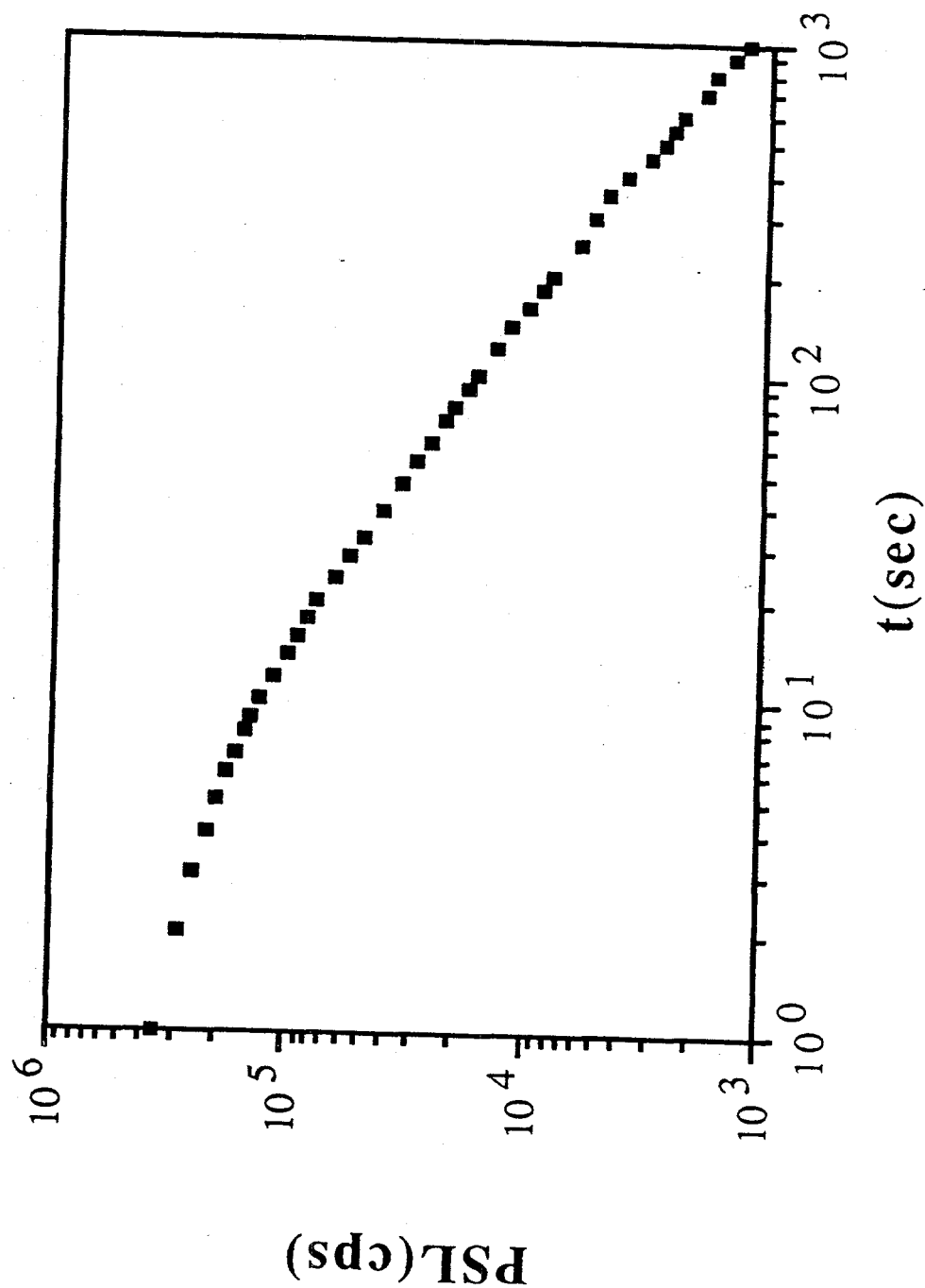


TL FROM BaFBr:Eu²⁺





PSL FROM BaFBr:Eu²⁺



FAILURE OF THE CLASSICAL PICTURE

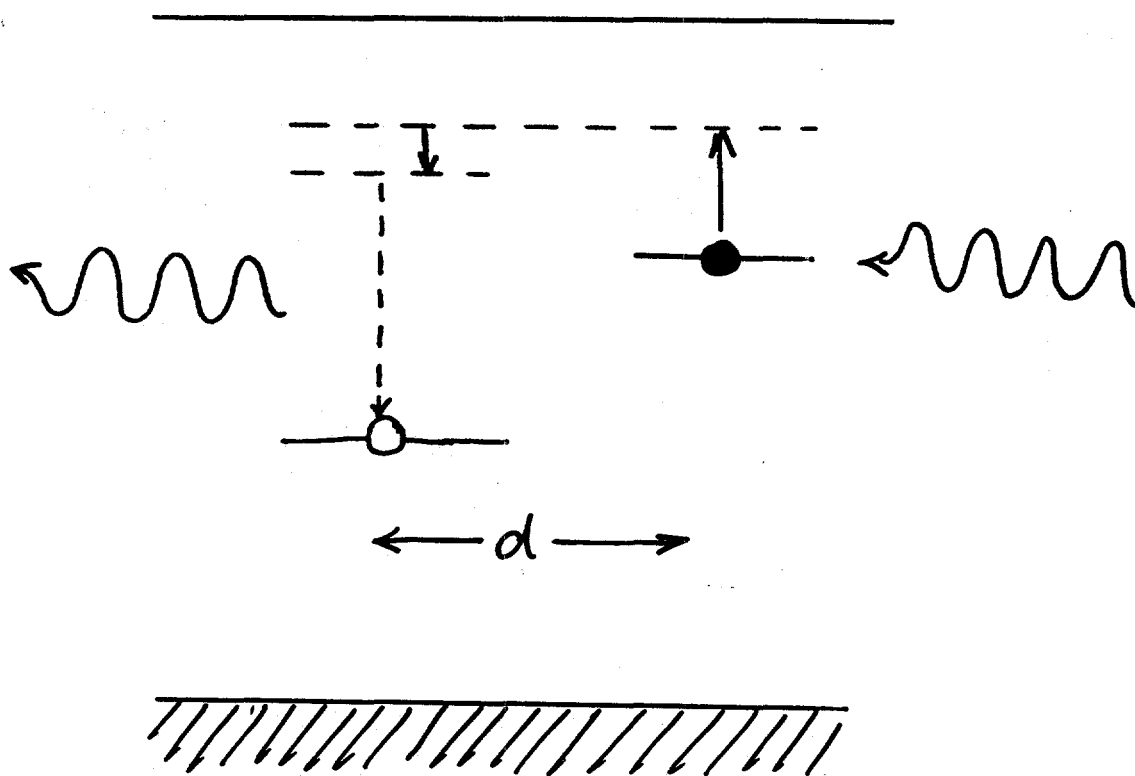
———— 0.9 eV
———— 1.1 eV



$$\boxed{\frac{E_0}{E} = \frac{k_0}{k}}$$

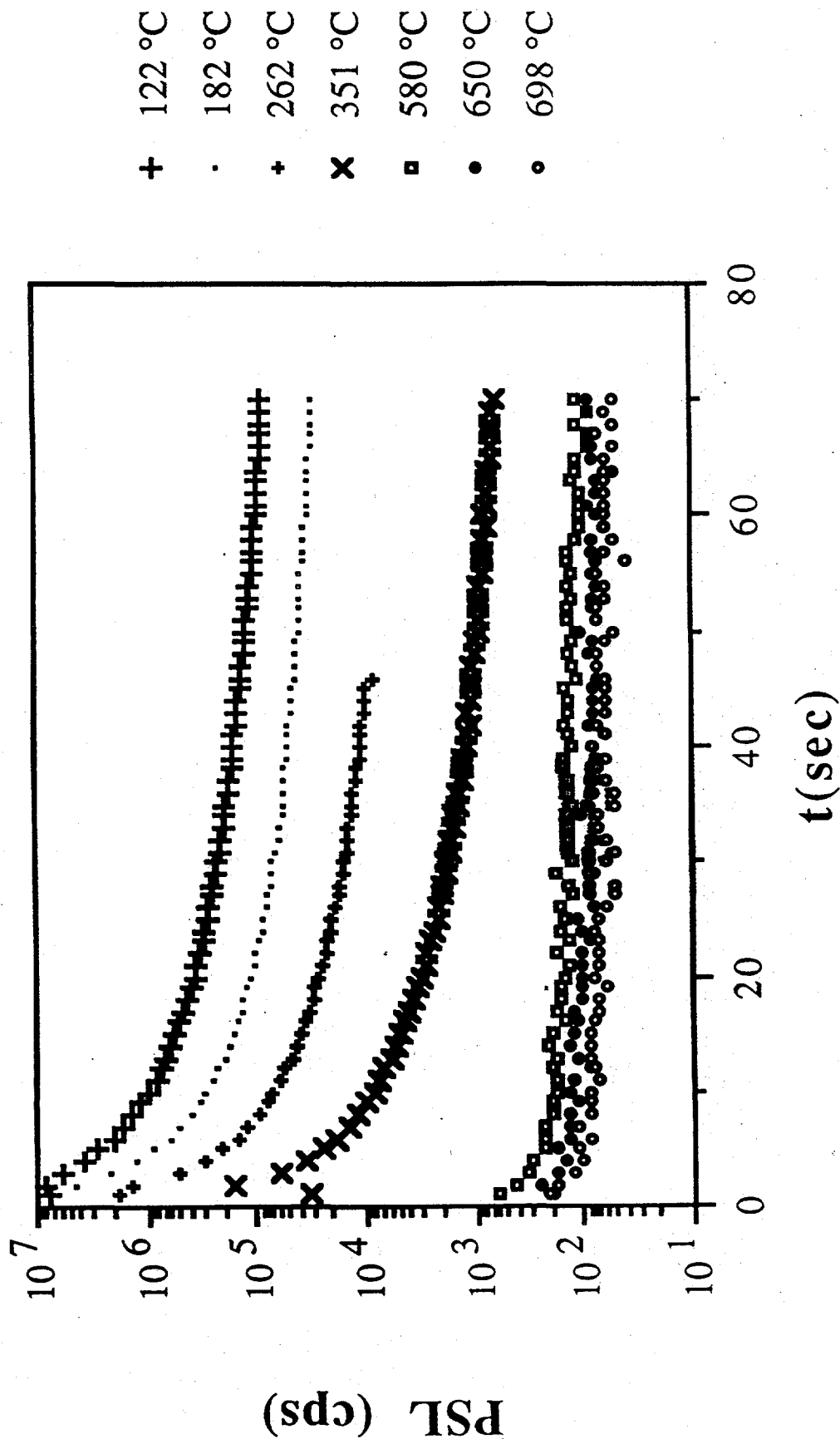
For BaFBr $\frac{k_0}{k} \doteq 3.1 \therefore E_0 = 2.7 \text{ eV}$
for $E = 0.9 \text{ eV}$.

LOCALIZED TRANSITIONS

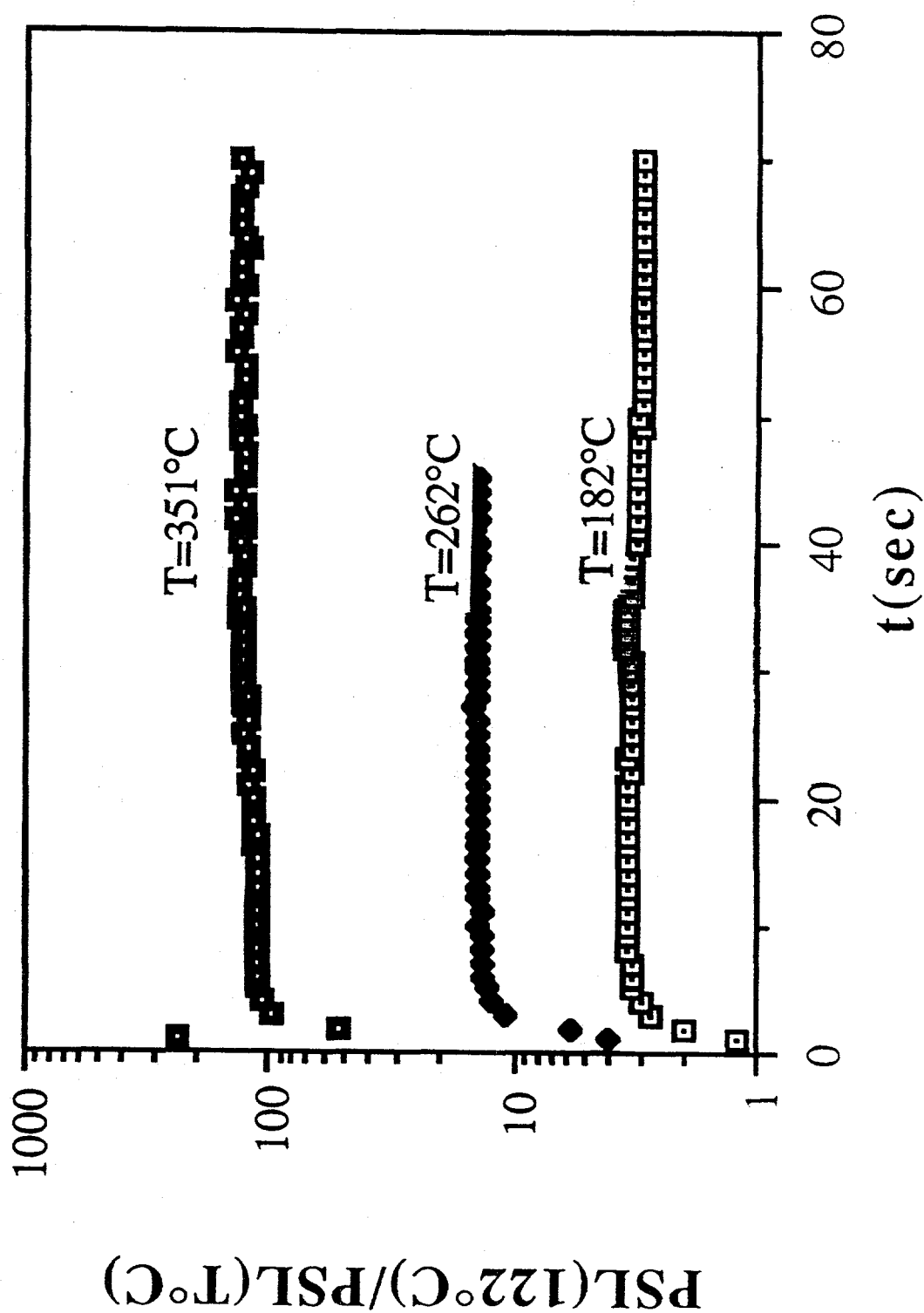


$$d \lesssim 15 \text{ \AA}$$

ANNEALING THE PSL



SELF SIMILARITY AFTER ANNEALS

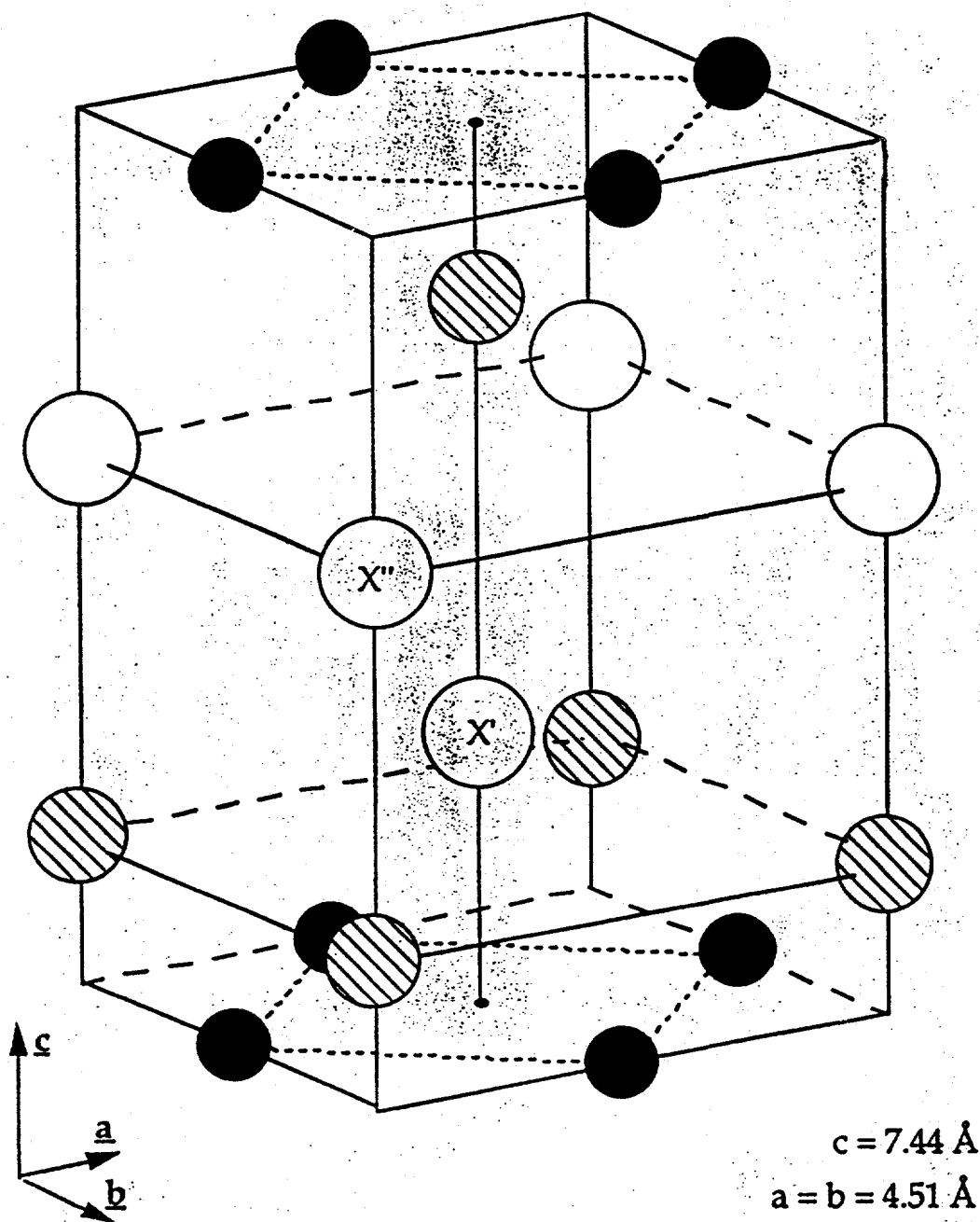


BaFBr STRUCTURE

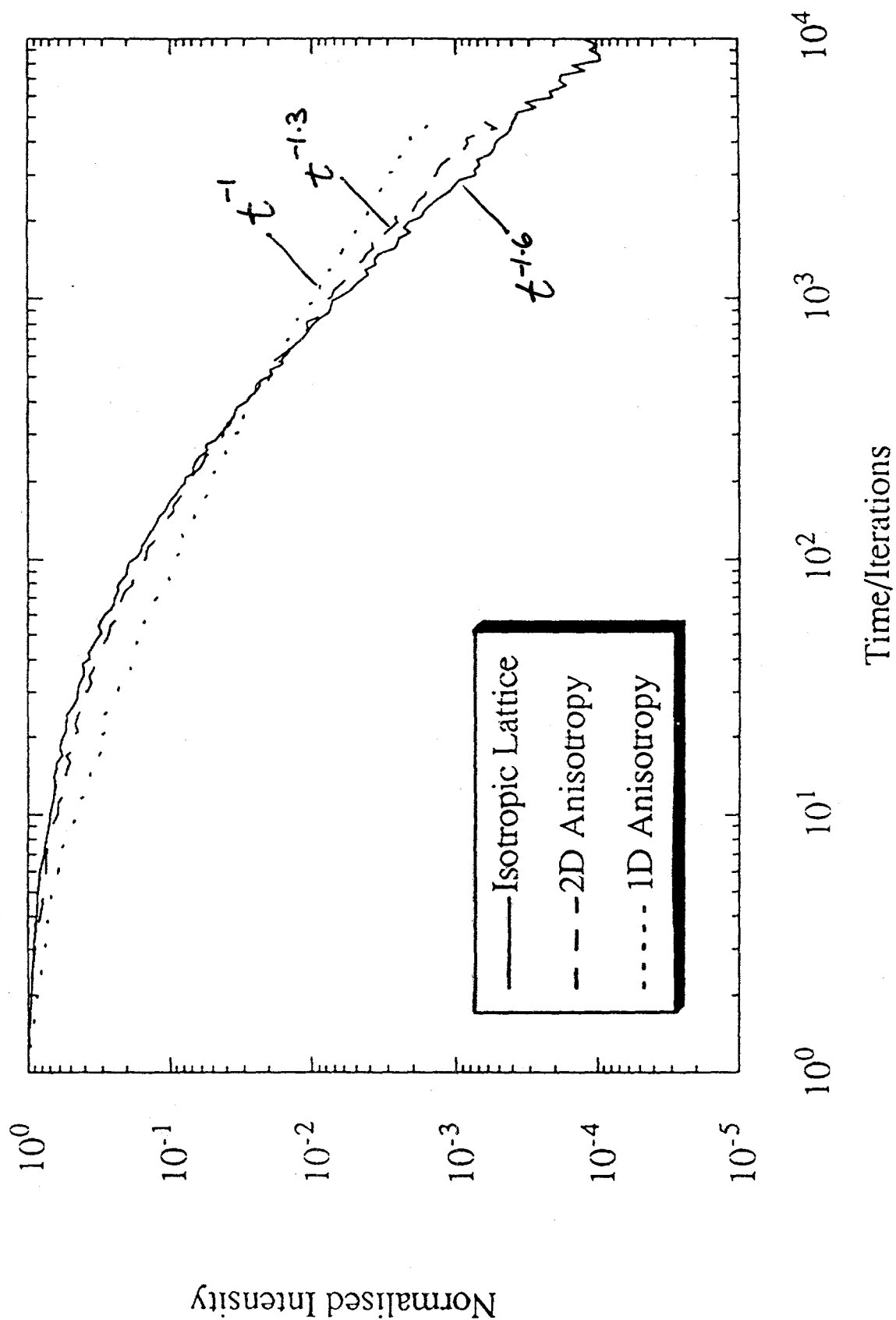
● = F

▨ = Ba

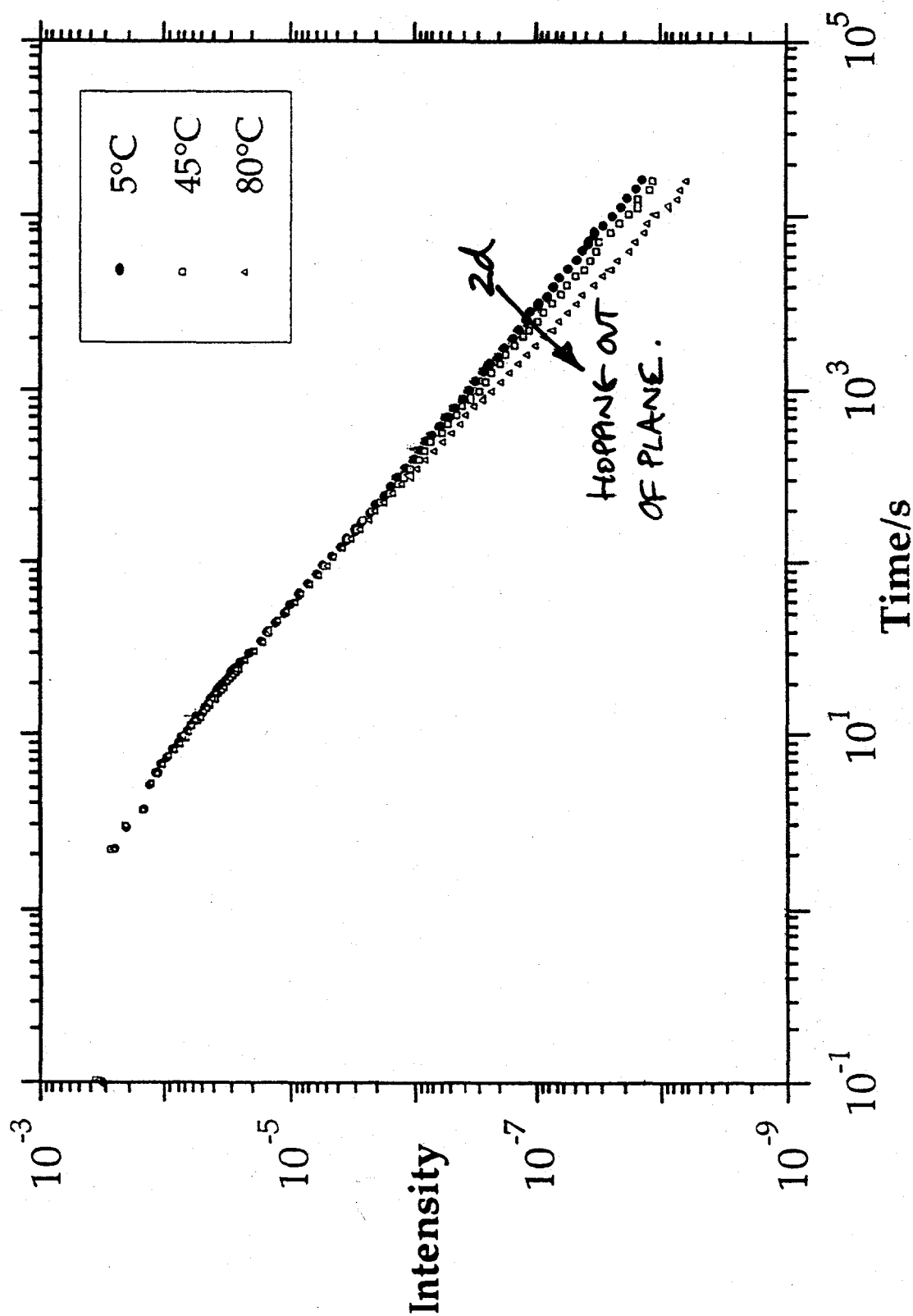
○ = Br/Cl



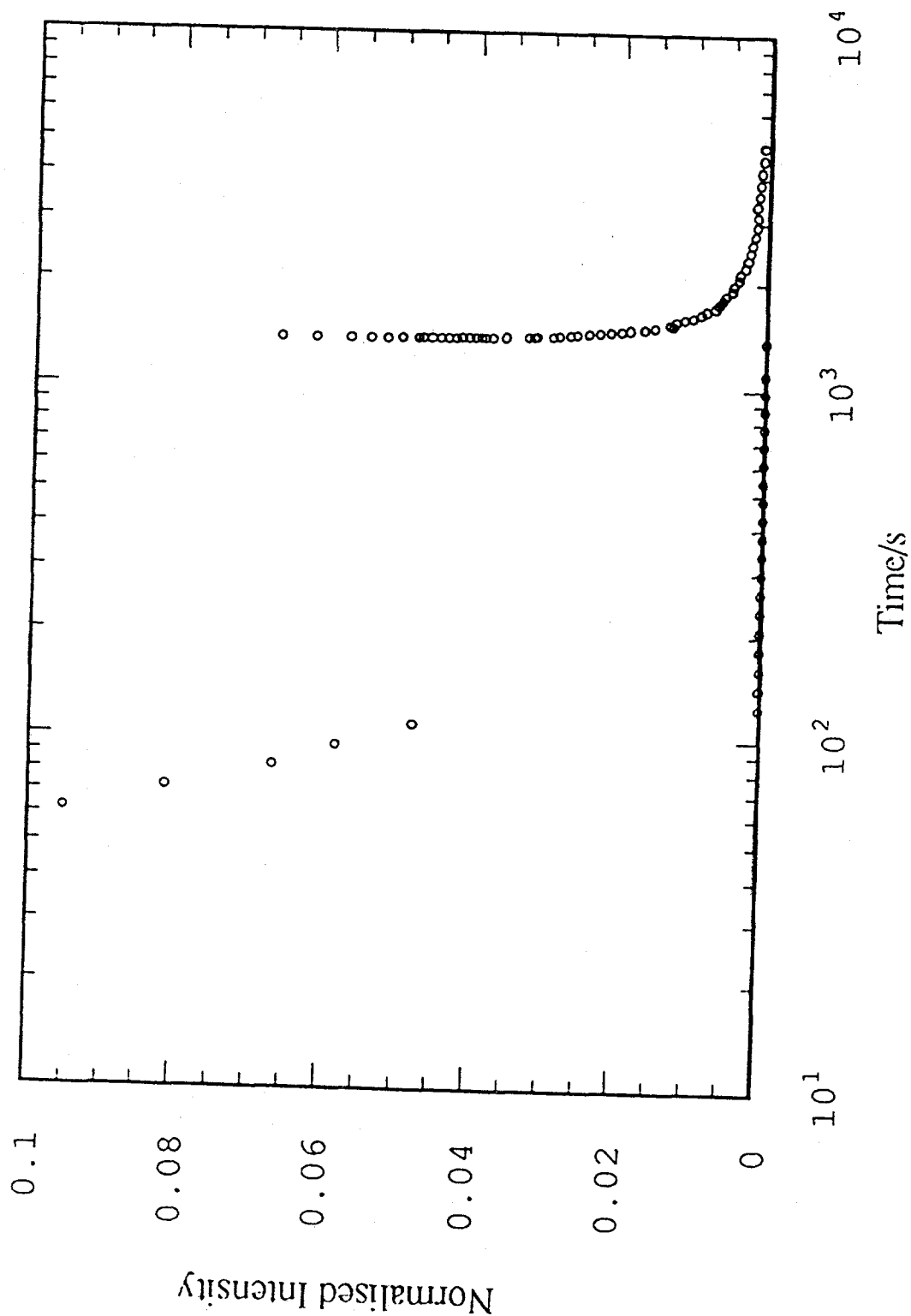
RANDOM WALK MODEL OF RL



PSL AS A FUNCTION OF T

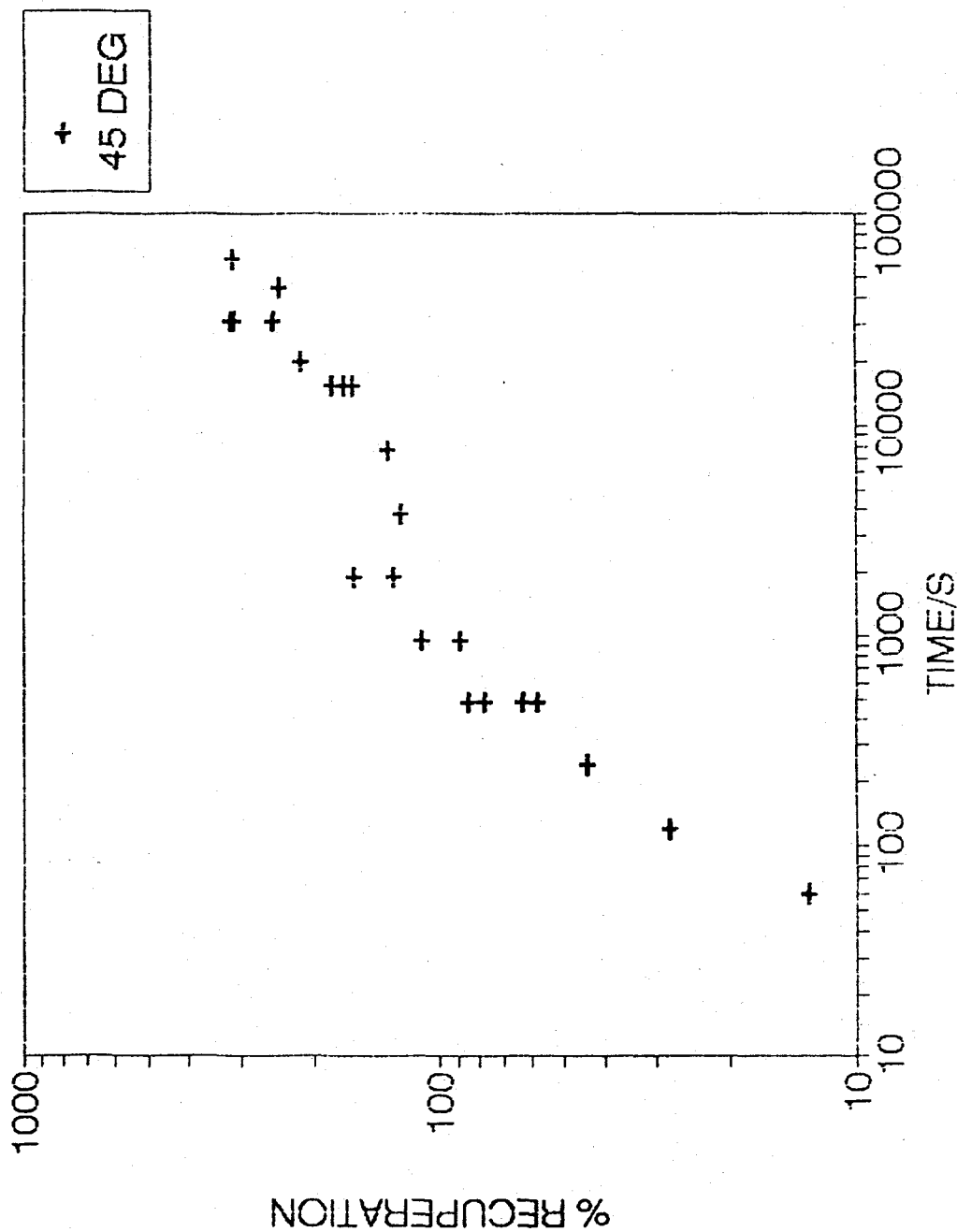


PSL RECUPERATION

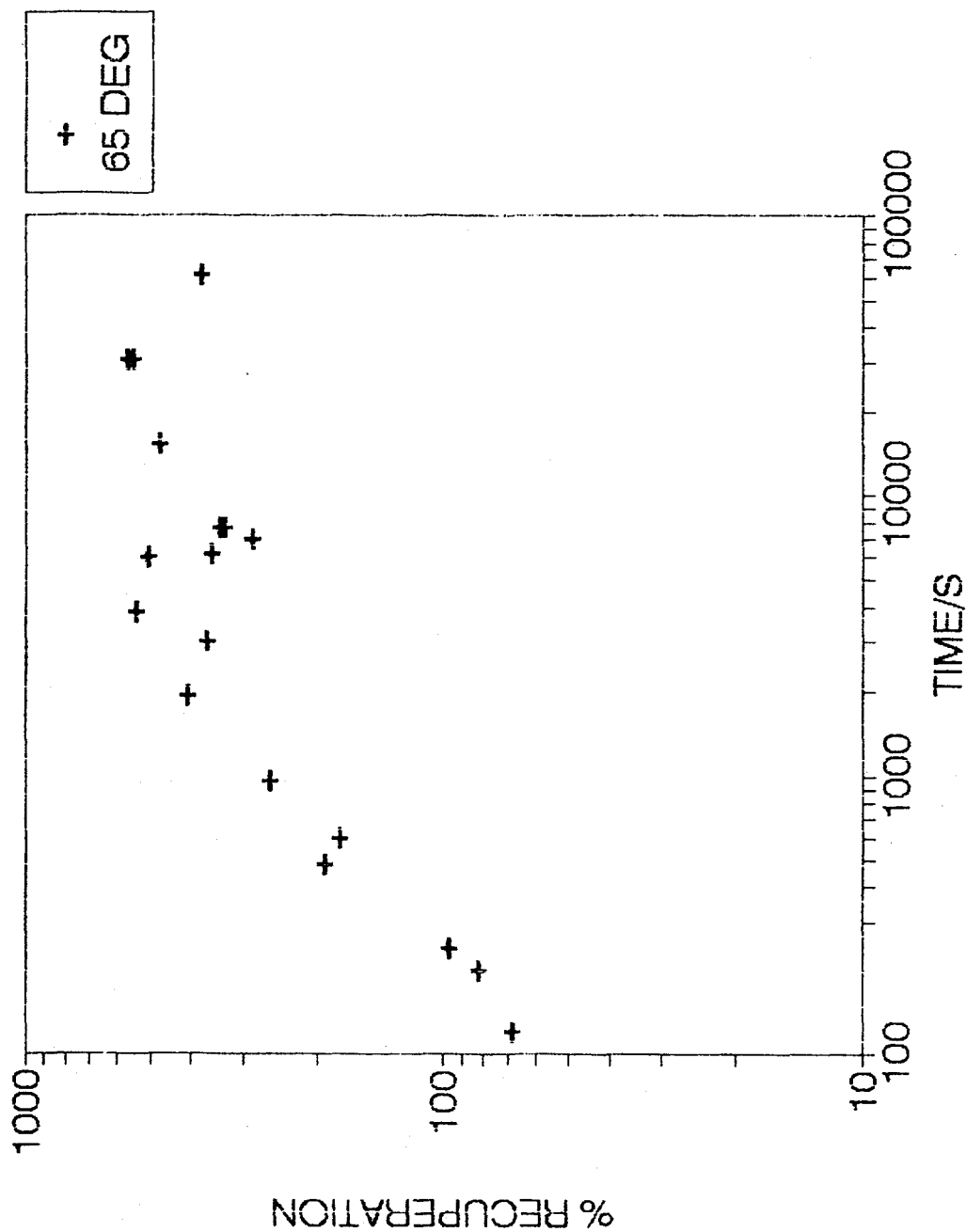


$T = 45^{\circ}\text{C}$

RECUPERATION AT 45°C



RECUPERATION AT 65°C



TECHNOLOGICAL IMPLICATIONS

EVOLUTION OF LUMINESCENCE WITH TIME

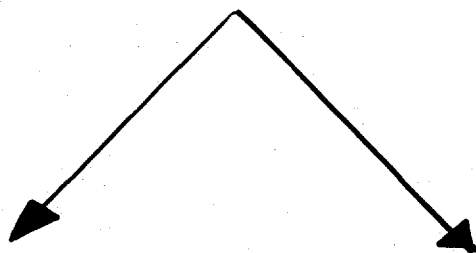


IMAGE STABILITY

10% drop in image intensity in 2-4 mins.

PROBLEM:

Relative intensities wrong

SOLUTION(S):

1. Leave to fade 1st.
2. Calibrate plate
3. Cool
4. New materials

ERASURE

Ghosts may appear overnight after optical bleach

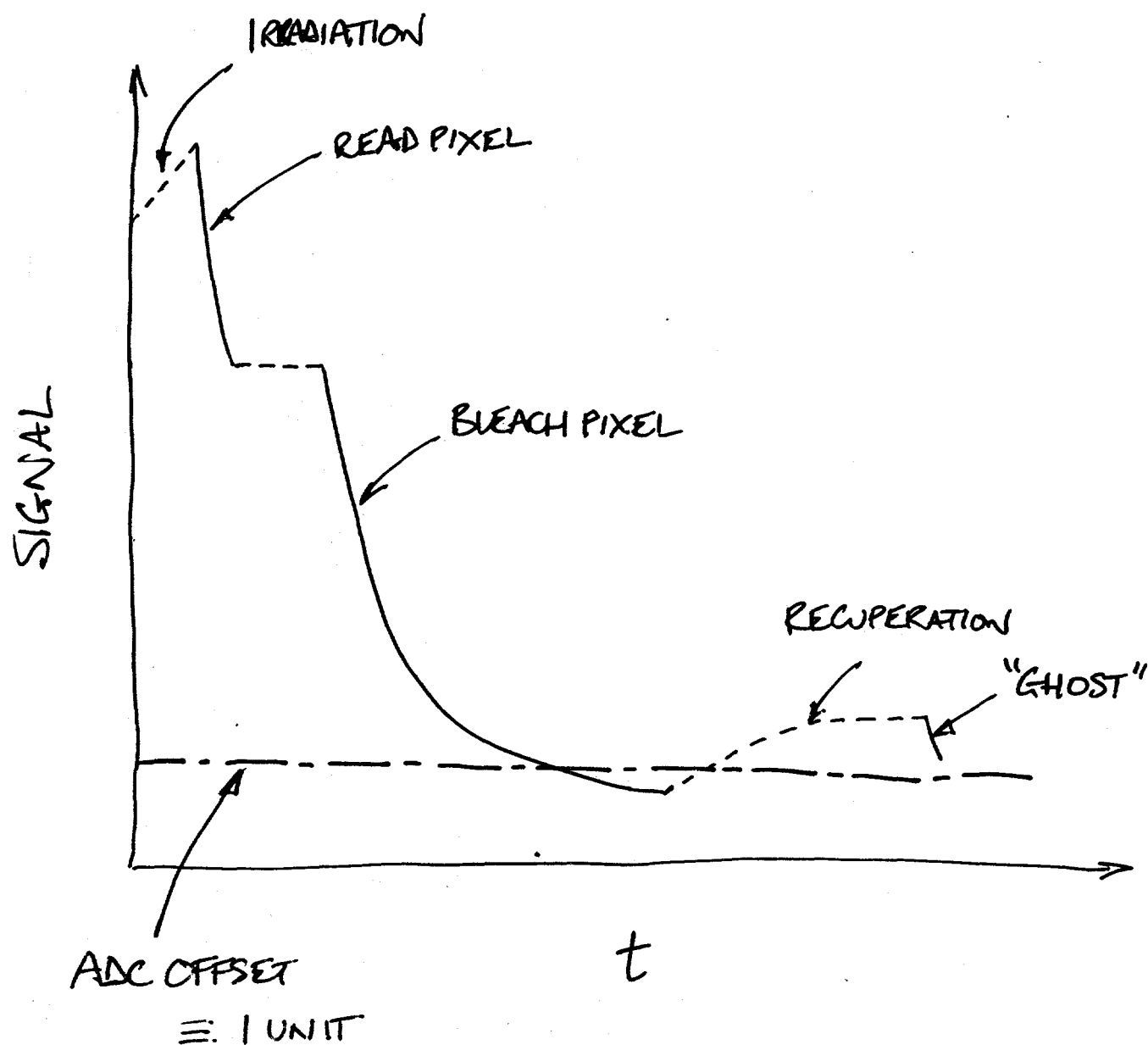
PROBLEM:

Is a weak spot real?

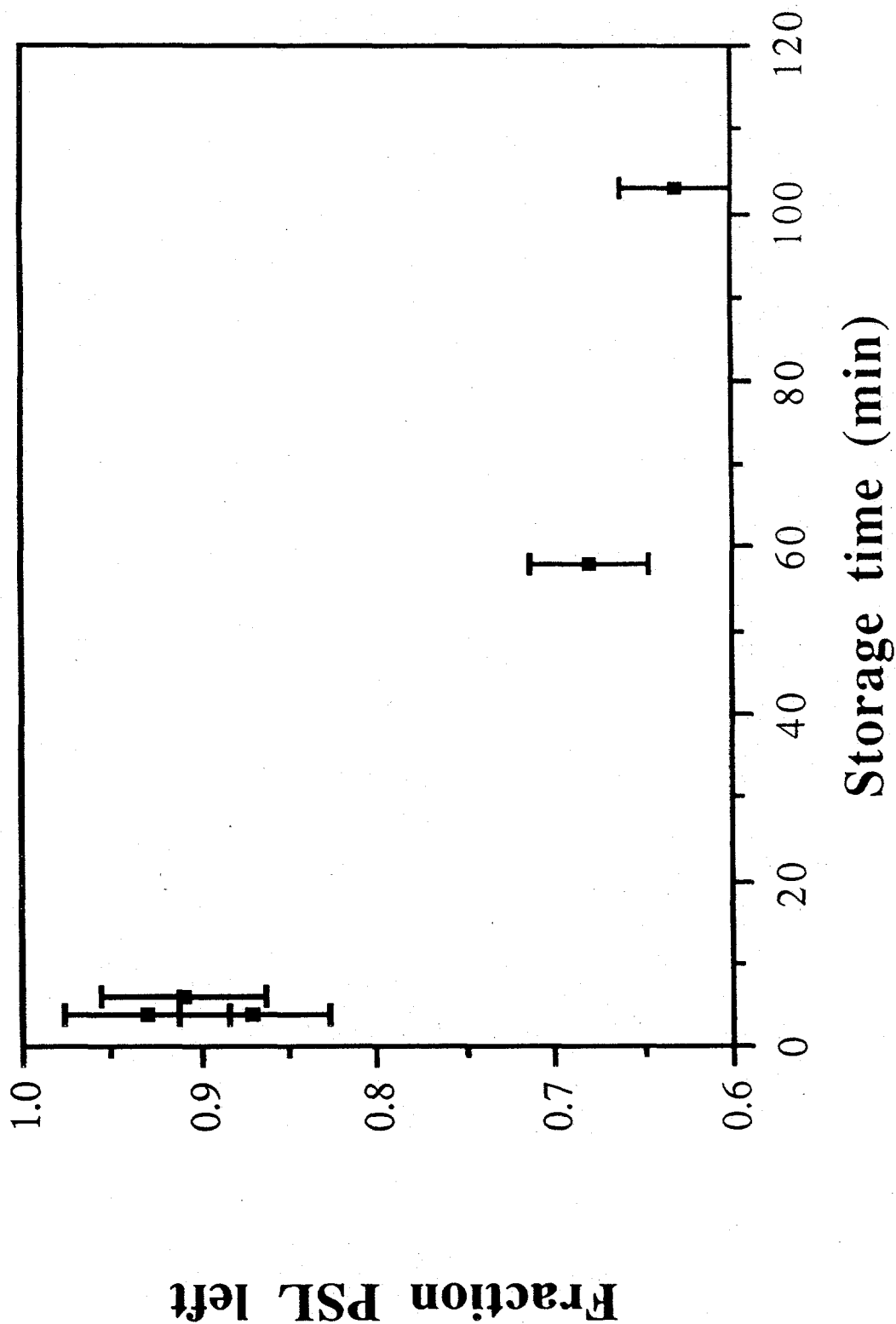
SOLUTION(S):

1. Stronger optical bleach
2. Thermal bleach ($>500^{\circ}\text{C}$)
3. Bleach just before use.

THE EFFECT OF NON-ZERO OPTICAL BLEACHING & SIGNAL RECUPERATION



SIGNAL STORAGE INSTABILITY



SENSITIVITY

Maximum no e^- /CuK α X-Ray < 325
($\sim 33\%$).

Maximum no. rec'd fr $8mJ.cm^{-2}$ < 32.5
($\sim 10\%$)

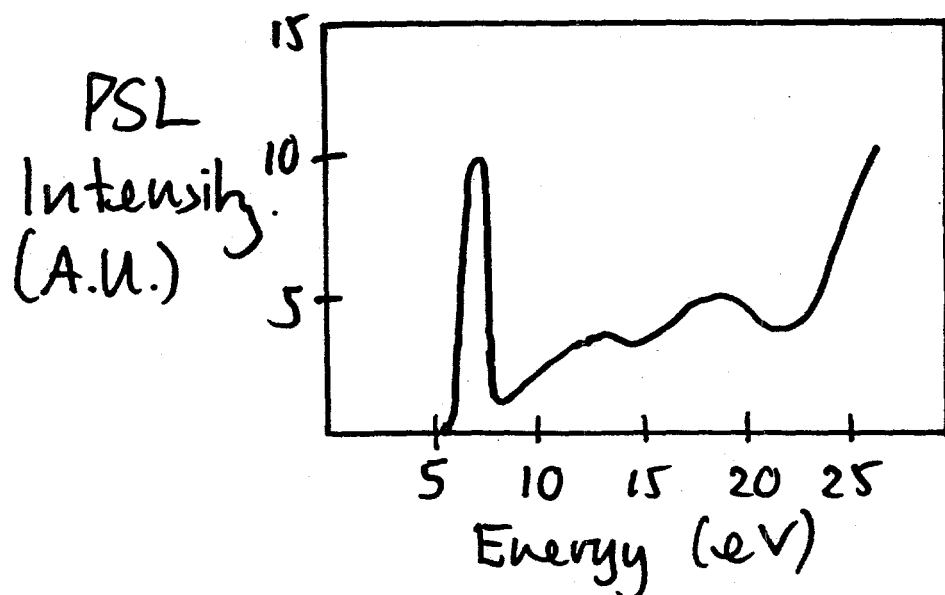
Efficiency of light collection < 13
($\sim 40\%$).

Absorbance of filters. < 10
($\sim 20\%$).

Q.E. of PMT ($\sim 15\%$). < 1.5

Marginal!!

Experience at Daresbury shows problems detecting signals $< 20-50$ photons CuK α .



RESOLUTION

Plate dimensions $\approx 250 \times 200 \text{ mm}$

Pixel size $\approx 100 \times 100 \mu\text{m}$

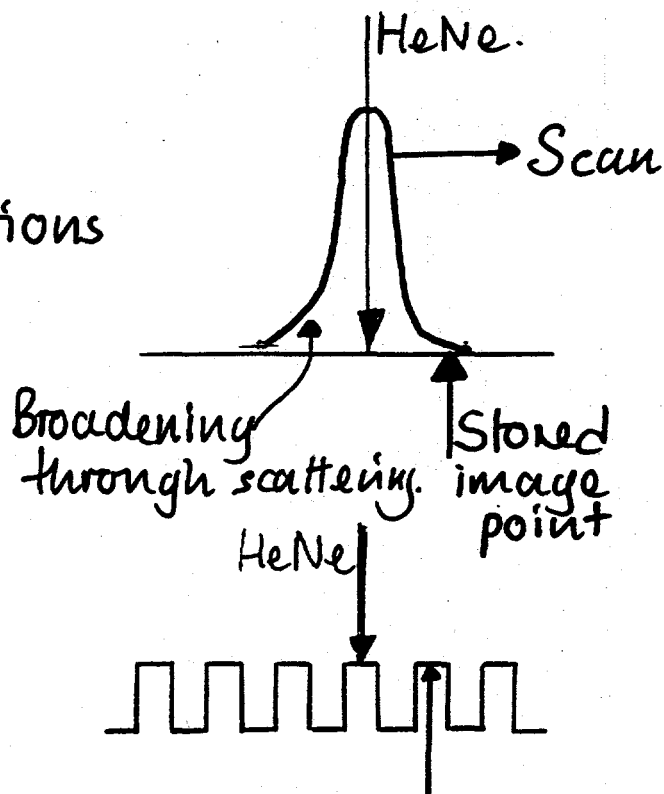
Typical resolution $\approx 180 \mu\text{m FWHM}$.

BUT

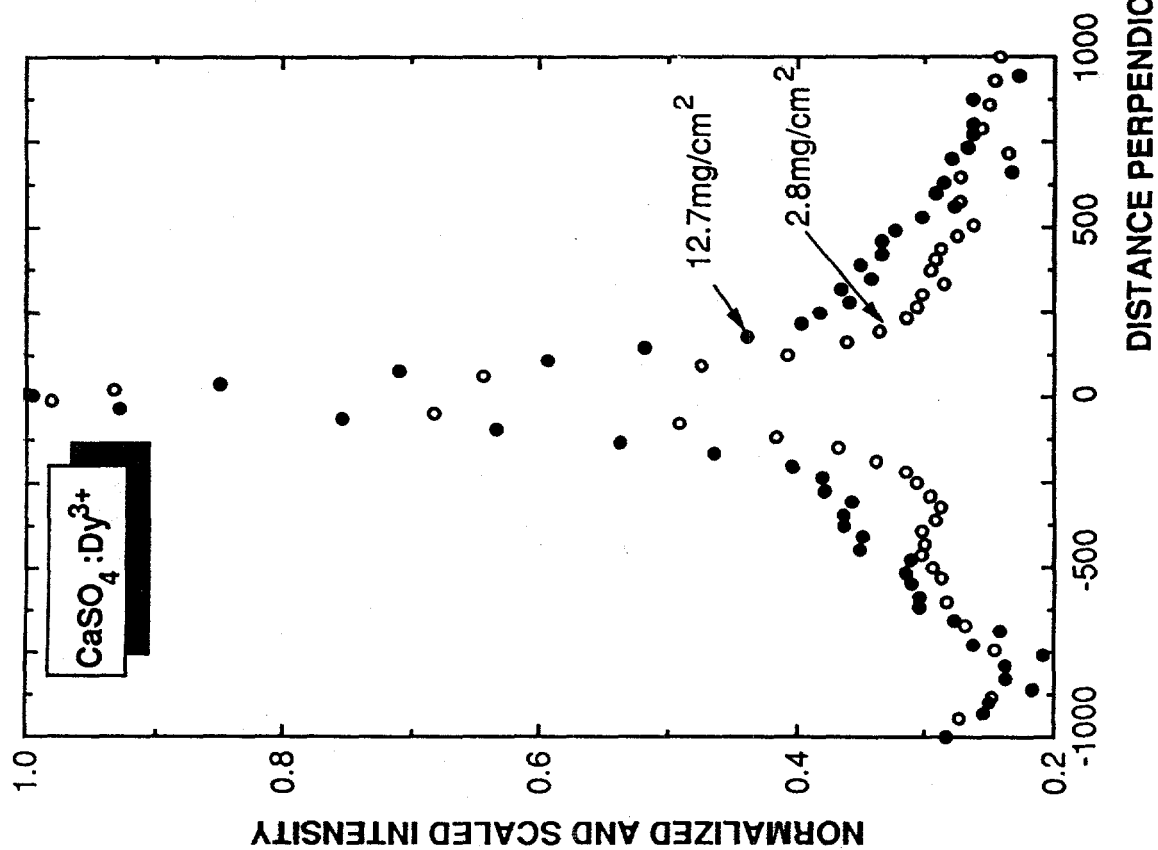
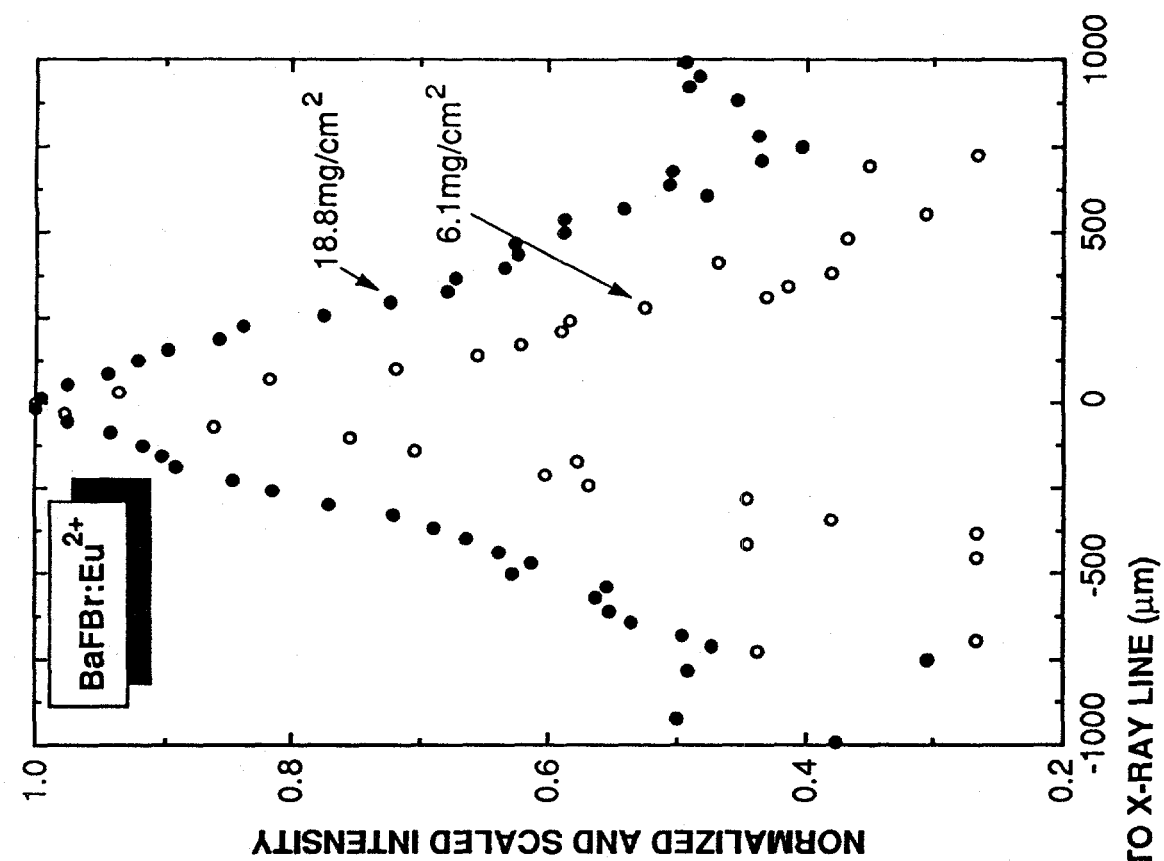
Appreciable spread as far as 1 mm.

PROBLEM

Previous strong reflections



SOLUTION?



DYNAMIC RANGE

We find sublinear response for
doses $> 10^7$ AuK α photons /
 $100 \times 100 \mu\text{m pixel}$

Probably due to signal loss at
longer exposures

$\Rightarrow$ Dynamic range $\simeq 2 \times 10^5$

PERFORMANCE SUMMARY

Sensitivity $\approx 10-50 \text{ CuK}\alpha$.

Resolution $100-200 \mu\text{m}$ FWHM

Dynamic
range $> 10^5$

PROBLEMS

Signal fading

Zeroing/usage
incomplete

SOLUTIONS

Cool plate

Heat plate

Stronger bleach

LOOKING AHEAD

Better plate design

- Thermally stable binder
- Isolated pixels

Better materials

- What makes a good storage phosphor?

ACKNOWLEDGEMENTS

Richard Templar
Gary Keogh
Alexei Syrykh

} Imperial College,
London

Mike Hamison
Andrew Wills

} Oxford University

Chris Hall
Rob Lewis

} Daresbury
Synchrotron

Aine Wilkinson

} EMBL, Grenoble

SERC, Royal Society + Paul
Instrument Fund.

A. R. Faruqi

MRC Laboratory of Molecular Biology

**Time-Resolved Experiments on Muscle
Using Synchrotron Radiation**

A monochromatized and focused high-flux x-ray beam obtained from a synchrotron radiation source provides a unique tool for reducing exposure times sufficiently to make time-resolved measurements with submillisecond time resolution on many biological specimens. One of the major applications of the technique has been in making dynamic studies on vertebrate muscle undergoing different types of mechanical or chemical activity during contraction. The main aim of such studies is to determine the details of structural changes that lead to force generation. The high intensities in the x-ray pattern to be recorded by the detector impose quite difficult and often conflicting requirements, and for these reasons the development of adequate detectors has been a slow process that needs to be continued, perhaps with increased effort, as sources are being developed relatively more rapidly than detectors.

The talk will be divided into two main parts:

1. What have we learned from time-resolved measurements on muscle and what further information can we reasonably hope to acquire given the increased technical specifications of the APS, ESRF, and other new generation of high-brilliance storage rings, and
2. What special requirements are there for detectors for use in time-resolved measurements and which type of detectors are likely to be the most readily applicable.

X-Ray Studies on Muscle

Sliding Filament Model:

Relative sliding movement between actin & myosin filaments

Main Aims of Current Research

- (1) Give explanations of details of muscle contraction at molecular level.
- (2) Control or Regulation of Contraction: A more detailed explanation

For Dynamic processes a useful technique:

'Time Resolved X-ray Diffraction from contracting muscle'

Main Difficulties: Technical. Small physical size of cross-bridges and rapid movement

Time-Resolved X-ray Diffraction from Muscle

Molecular mechanisms involved in muscle contraction & force generation.

sl. Actin - Myosin interactions → Force
Muscle small angle pattern dominated by myosin & actin. Changes in pattern during contraction very informative re- structural changes.

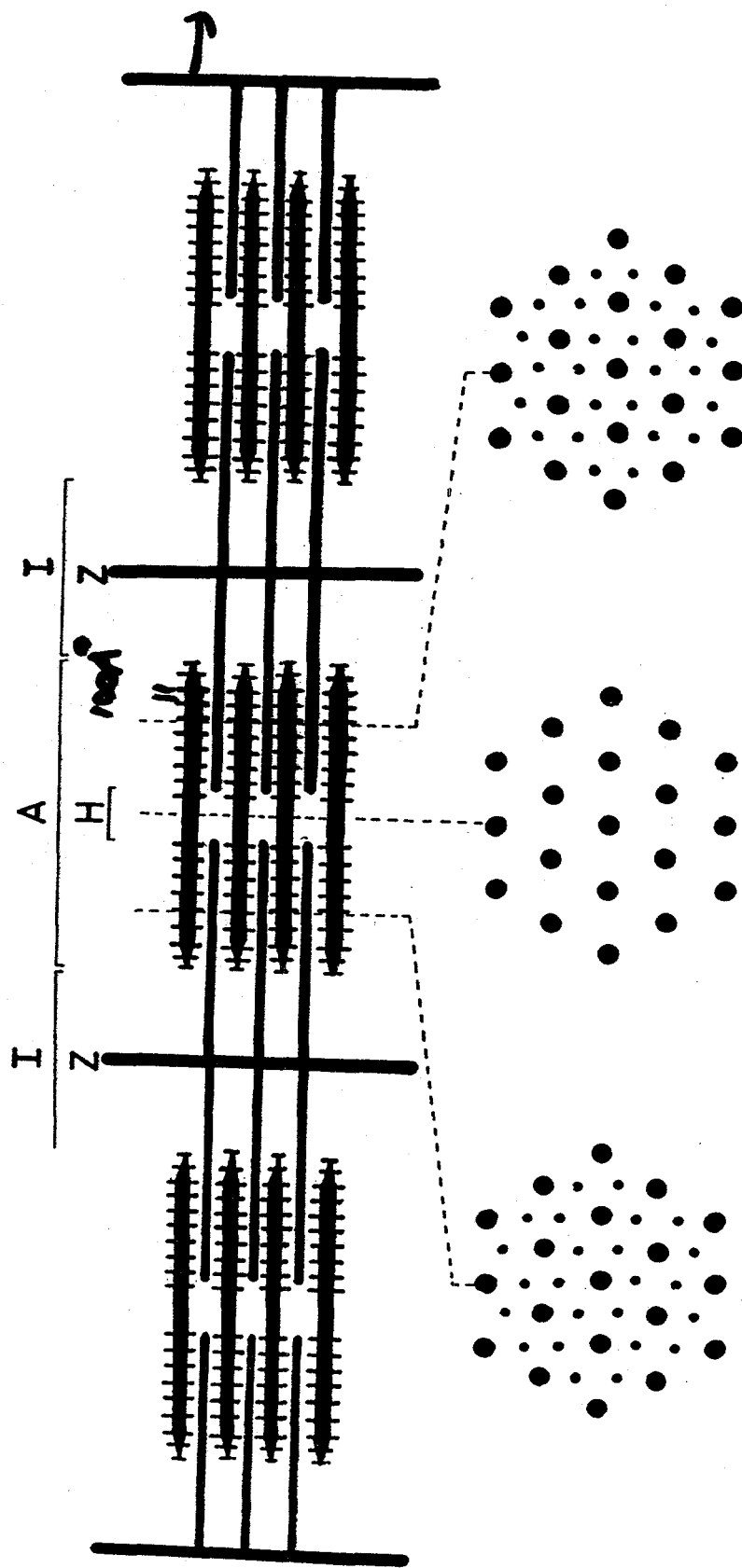
sl. Difference Pattern (from Huxley, et al)
at SRS, Dares.

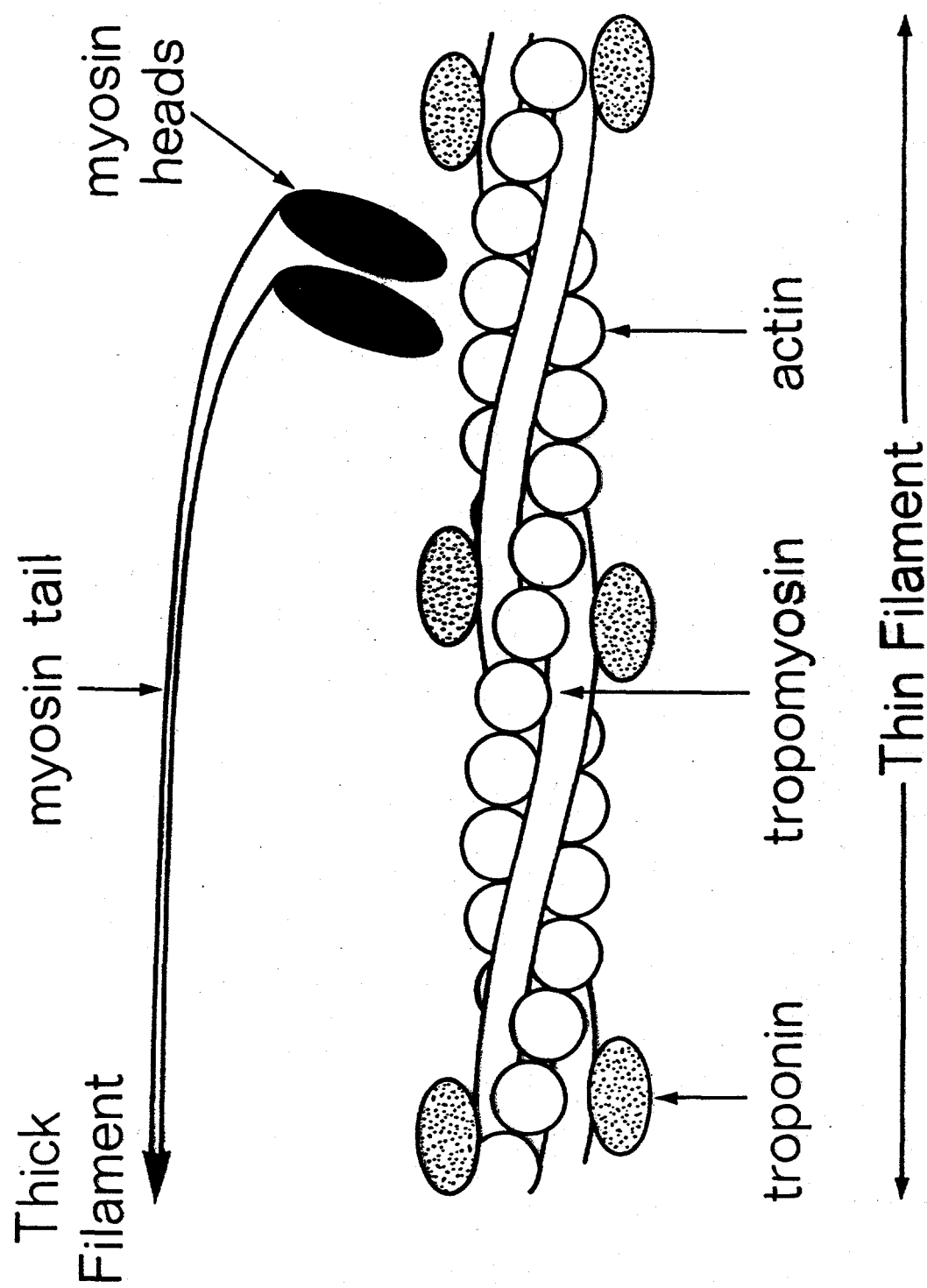
Kinetics of cross-bridge cycling with MWLD shows that at fast

sl. shortening cross-bridges take 15-20ms to diffuse back to myosin. (Poster)

Muscle Sarcomere

2.2 μm





ACTIN Layer Lines

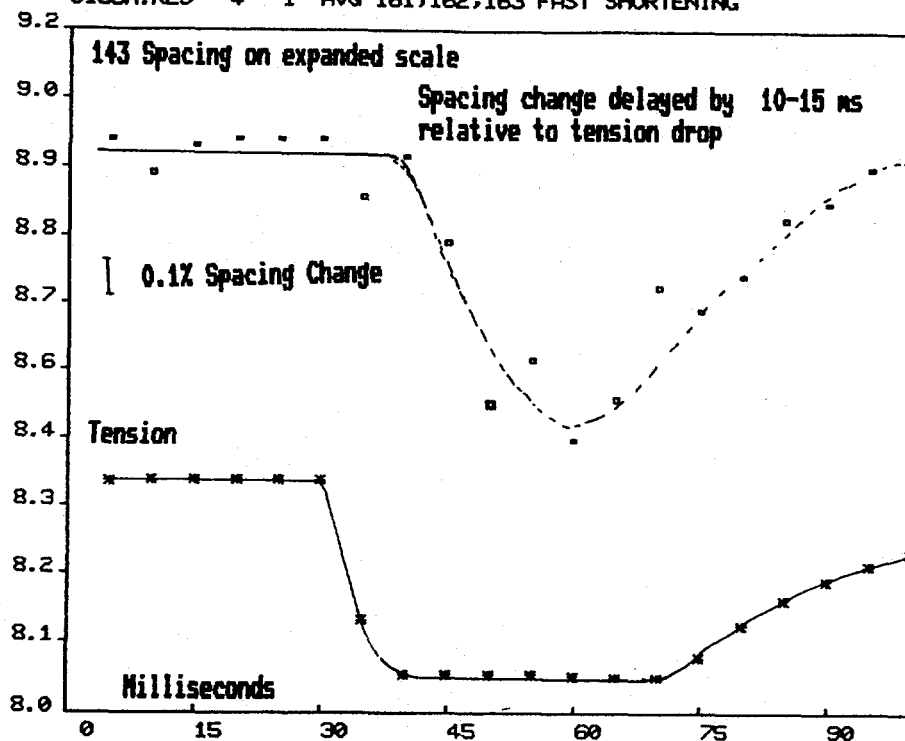
Kress et al J. Mol Biol 188 (1986) 325-342

2nd layer line : axial $179\text{\AA}$
(tropomyosin) radial $0.023\text{\AA}^{-1}$
($43\text{\AA}$)

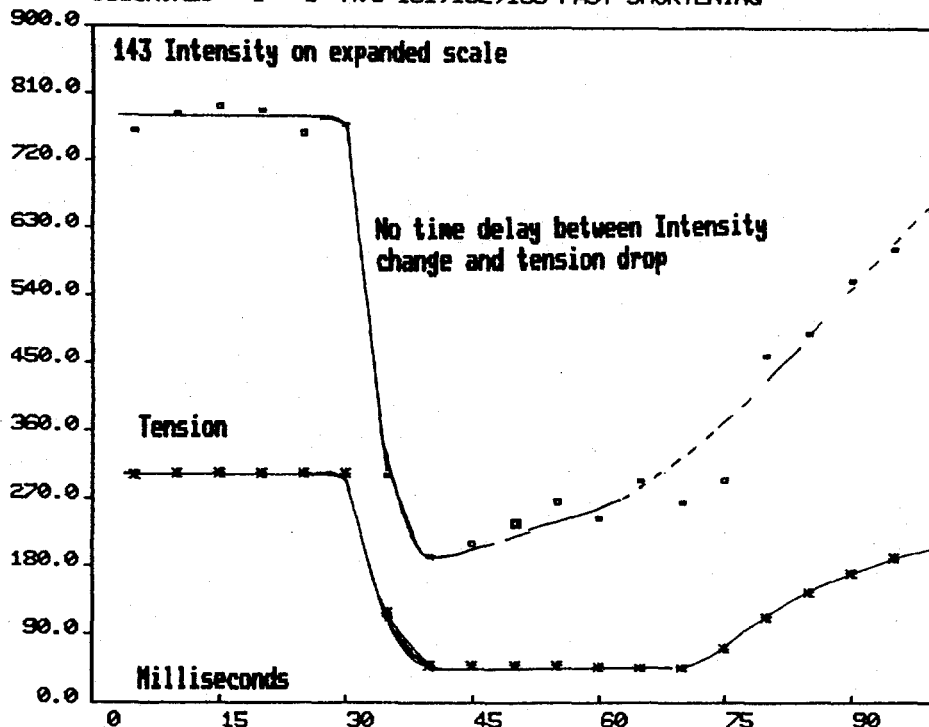
At 6°C , large changes in the intensity of the 2nd LL both in 'normal' & 'overstretched' muscle with no overlap between thick and thin filaments.

Ca^{++} binding to troponin $\rightarrow$ movement (no axial change) of tropomyosin, which is the first step (structurally) in muscle contraction. (See Fig. 2)

S163A.RES 4 1 AVG 161,162,163 FAST SHORTENING



S163A.RES 1 1 AVG 161,162,163 FAST SHORTENING



A. R. Faruqi et al. Nucl Instr & Meth A310 (1991) 359
- 361

X-ray Detectors

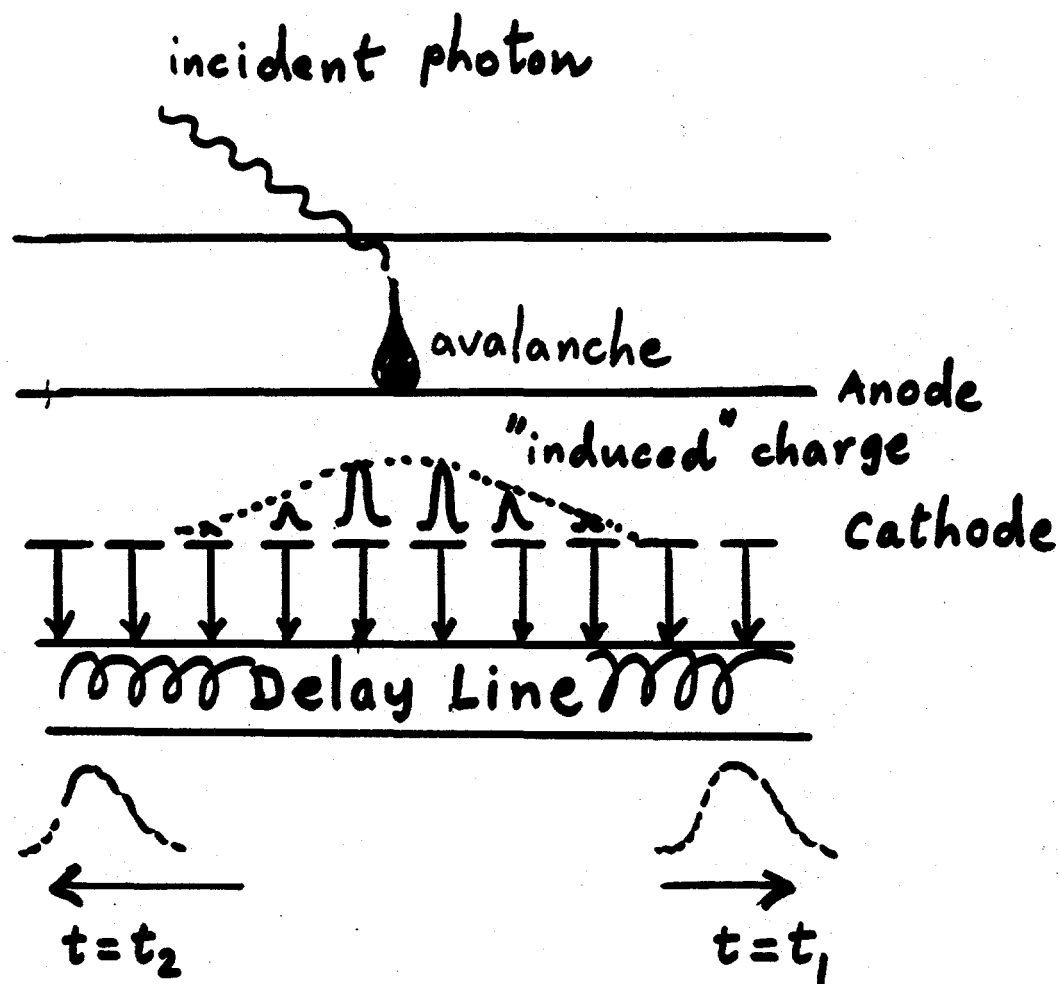
(A) Integrating Detectors

- (i) Film
- (ii) Image Plate
- (iii) TV-based
- (iv) CCD

(B) 'Pulse' Counting Detectors

- (i) Multiwire Chambers
- (ii) Scintillation Detectors

POSITION SENSITIVE DETECTOR



$$\text{Position} \propto |t_1 - t_2| \times \text{velocity}$$

Transmission Velocity 1-10 ns/mm

MULTIWIRE PROPORTIONAL CHAMBERS

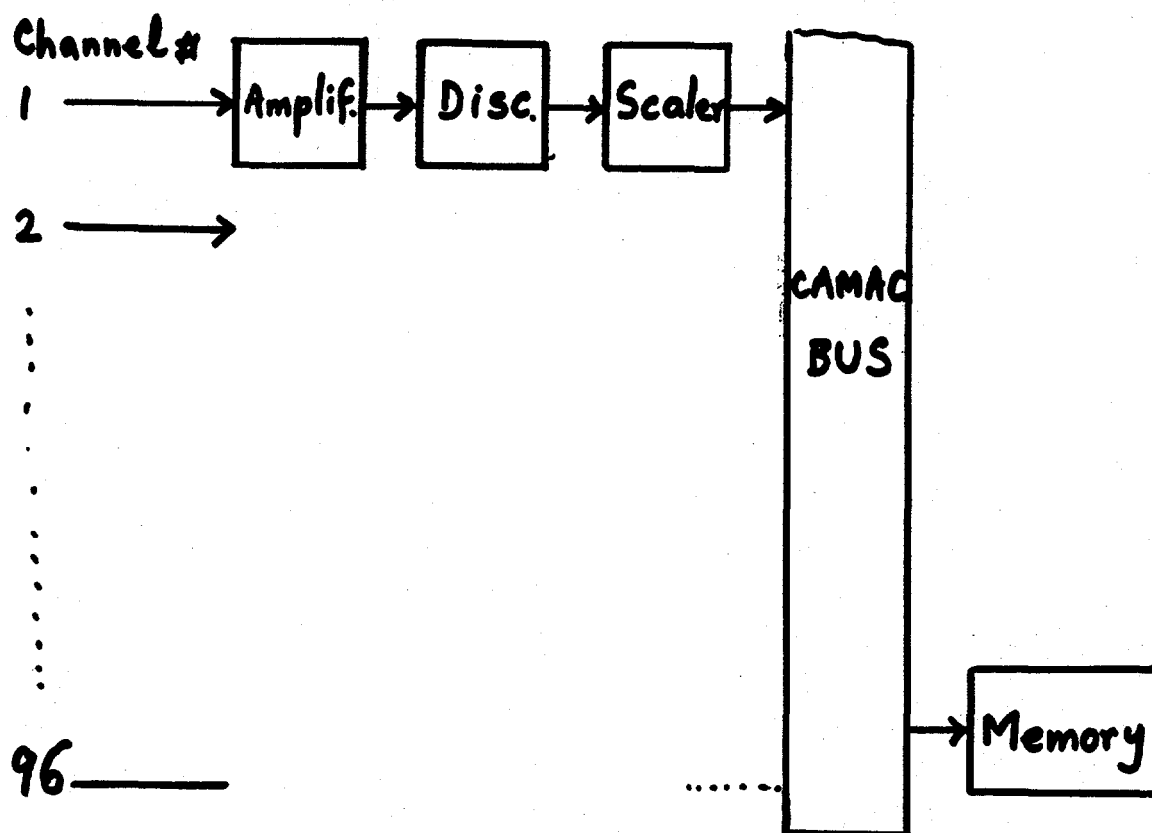
ADVANTAGES

- (1) High Quantum Efficiency for 8 keV x-rays
- (2) Time-Resolved Work possible due to relatively rapid readout
- (3) Good Dynamic Range
- (4) Good Linearity
- (5) Adequate Spatial Resolution
- (6) Geometry (i.e. size) well matched to muscle specimen & synchrotron source size

DISADVANTAGES

- (1) Counting Rates not high enough (SR)
- (2) Radiation Damage limits lifetime (SR)
- (3) High Angles: Parallax

MULTIWIRE LINEAR DETECTOR



Efficiency $\sim 90\%$

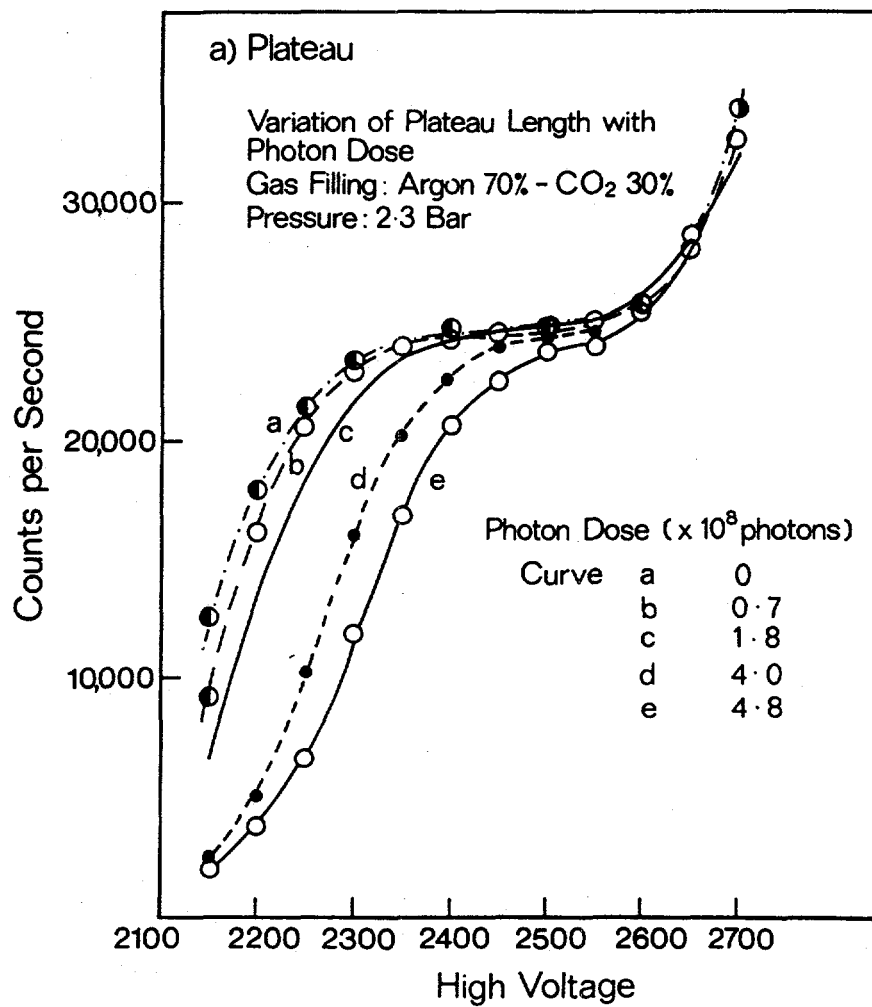
Spatial Resolution $\sim 1 \text{ mm}$ wire spacing

Precision of 'Spatial' Measurements: v. good $\sim 50 \mu\text{m}$

Count Rates: local $10^4 \text{ mm}^{-2} \text{ sec}^{-1}$
global 10^7 sec^{-1}

Linearity : few percent

'Time Resolution' 0.1 ms $\rightarrow$ seconds
slide results (1,1)

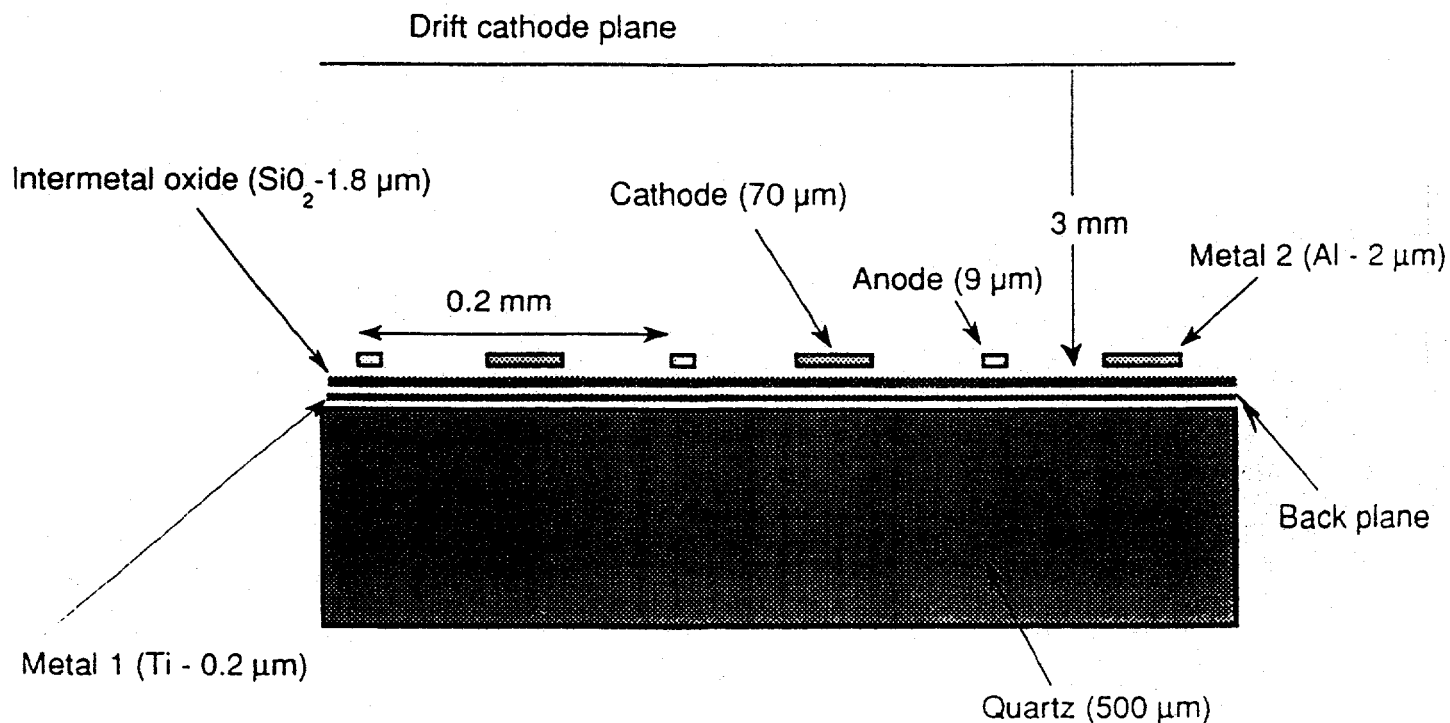


AR Faruqi IEEE Trans Nucl Sci NS-27(1980)644

F. Angelini, R. Bellazzini, A. Brez, M. M. Massai, R. Raffo,
G. Spandre, M. A. Spezziga
INFN-Pisa and University of Pisa
Via Livornese 582-I-56010 S. Piero a Grado, Pisa, ITALY

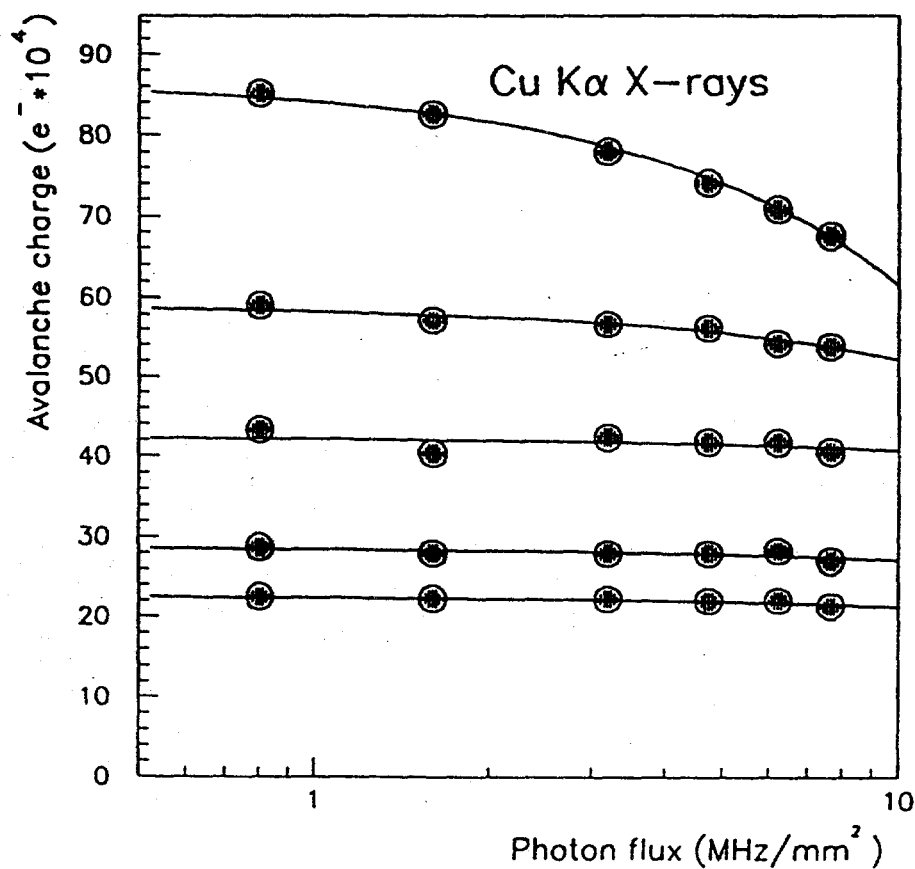
NIM A323 (1992) 229-235

MicroStrip Gas Chambers with true two-dimensional and pixel read-out



F. Angelini, R. Bellazzini, A. Brez, M.M. Massai, R. Raffo,
 G. Spandre, M.A. Spezziga
 INFN-Pisa and University of Pisa
 Via Livornese 582-I-56010 S. Piero a Grado, Pisa, ITALY

NIM A323 (1992) 229-235

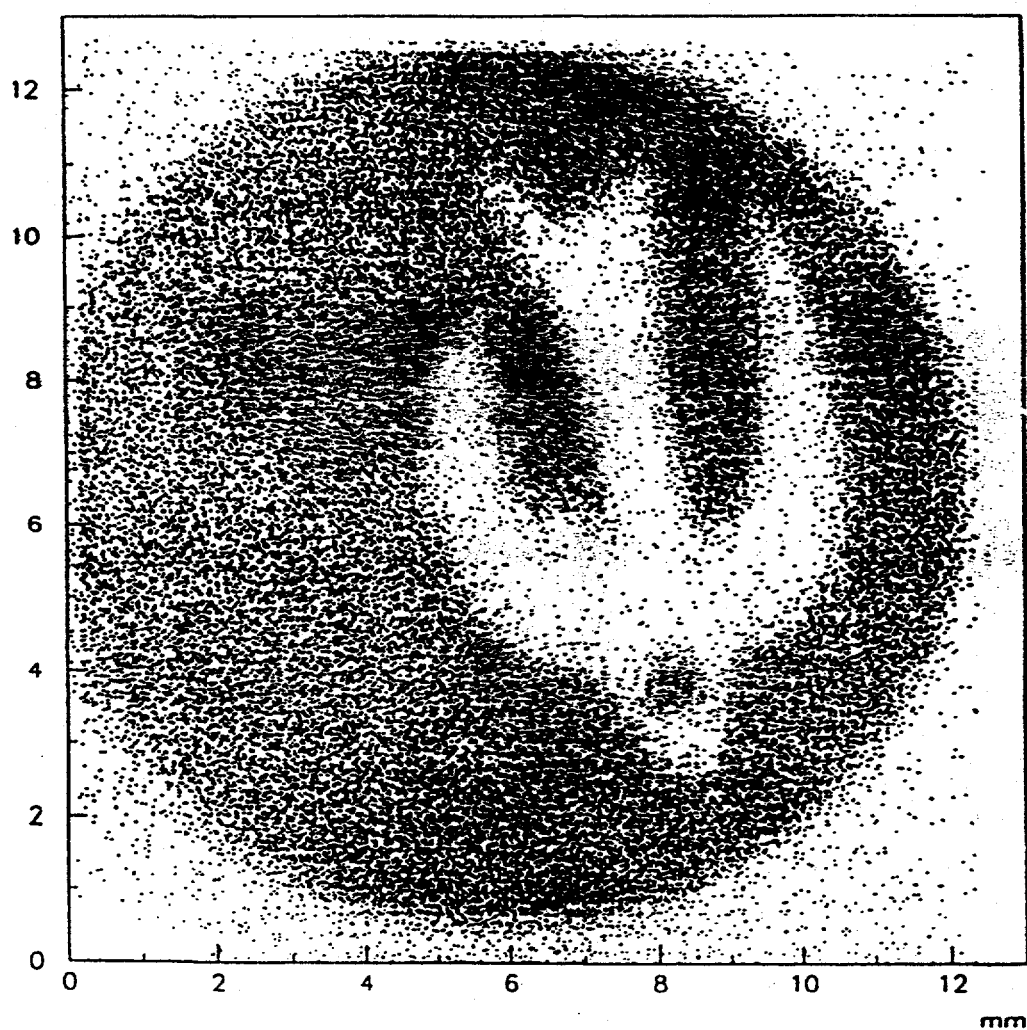


Gas : Argon 90% DME 10%

Radiation Damage $\frac{S G_n}{G} - 15\%$ @ 0.016 C/cm

F. Angelini, R. Bellazzini, A. Brez, M.M. Massai, R. Raffo,
G. Spandre, M.A. Spezziga
INFN-Pisa and University of Pisa
Via Livornese 582-I-56010 S. Piero a Grado, Pisa, ITALY

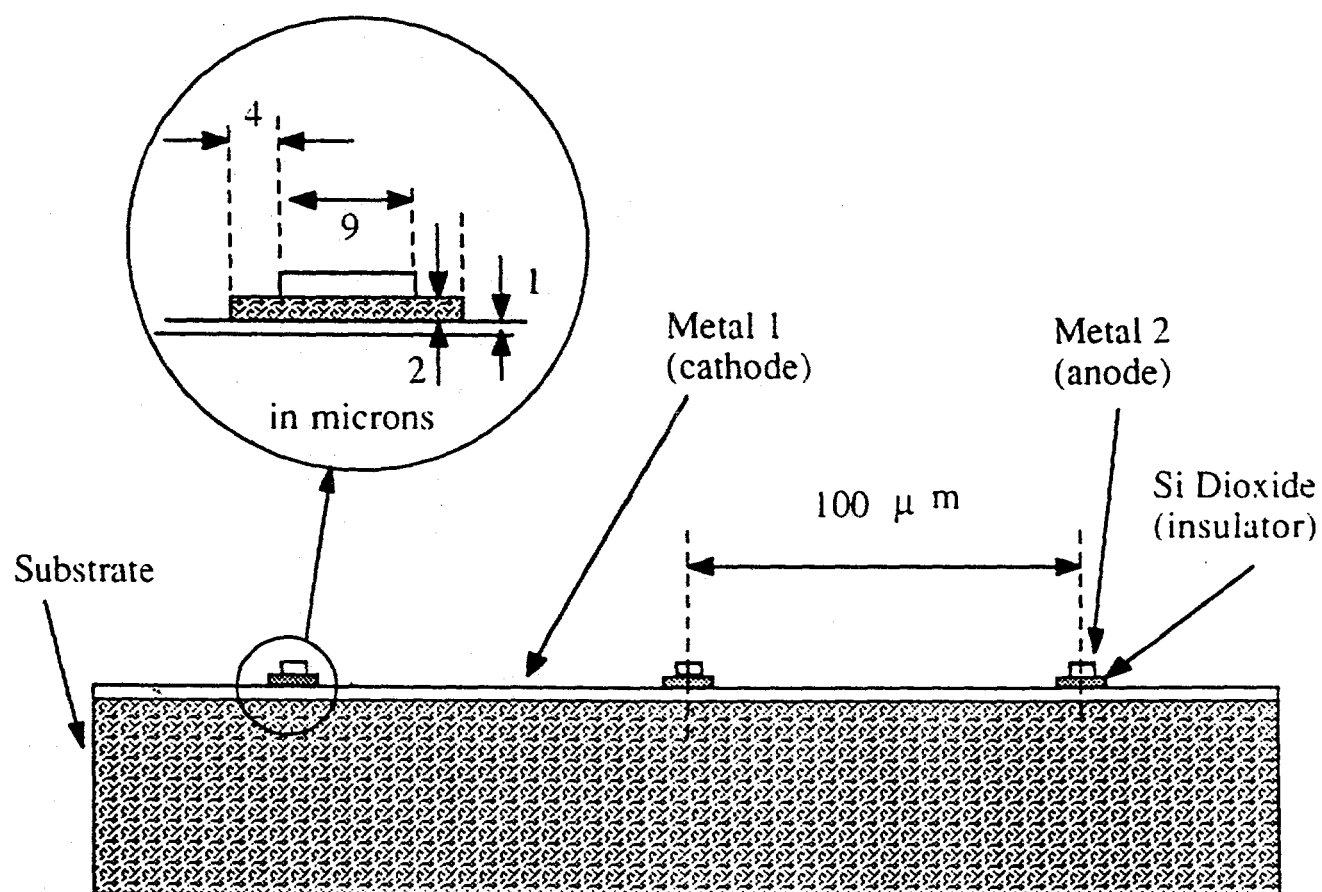
NIM A323 (1992) 229-235



F. Angelini, R. Bellazzini, A. Brez, M.M. Massai, R. Raffo,
G. Spandre, M.A. Spezziga
INFN-Pisa and University of Pisa
Via Livornese 582-I-56010 S. Piero a Grado, Pisa, ITALY

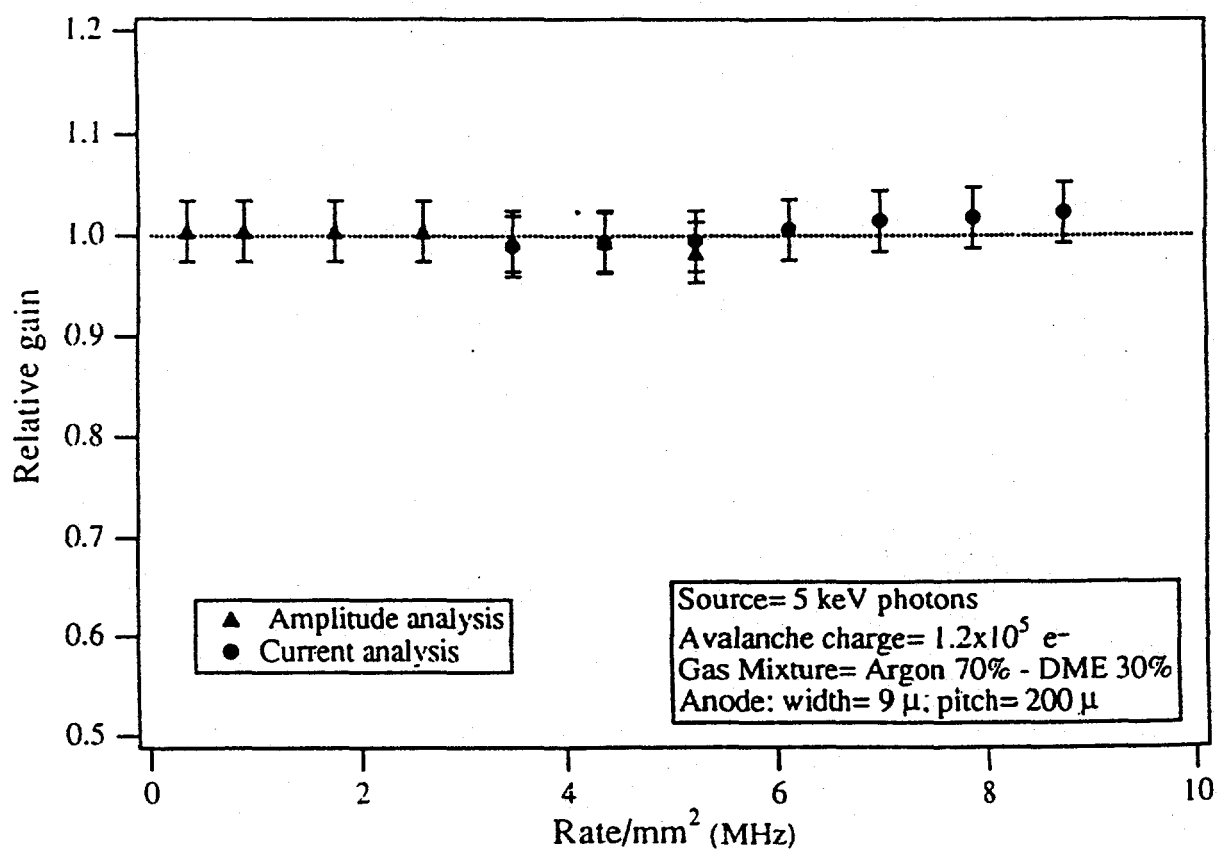
NIM A335 (1993) 69-77

The Micro-Gap Chamber



F. Angelini, R. Bellazzini, A. Brez, M.M. Massai, R. Raffo,
G. Spandre, M.A. Spezziga
INFN-Pisa and University of Pisa
Via Livornese 582-I-56010 S. Piero a Grado, Pisa, ITALY

NIM A335 (1993) 69-77



Microstrip Gas Detectors

Microstrip gas detectors, first proposed by Oed (ILL), circumvent some of the problems associated with conventional multiwire proportional chambers. Both anode and cathode are 'etched' on the surface of a high resistivity material like glass or ceramic and does not use delicate wires which may break easily (LMB chamber has 10 μm anode wires stretched with 12 gm tension and breaking tension is ~ 18 gm). Anode size is similar, i.e. 10 μm separated from the cathode by only ~ 50 μm (compared to 3-6 mm in conventional chambers). X-ray photon is absorbed in the gas which also has a drift field, but multiplication takes place close to the anode. The back plane has strips running at right angles to pick up the orthogonal coordinate.

Main Advantages

1. More uniform gas gain - better energy resolution.
2. Very good spatial resolution in one direction.
3. Lower operating voltages.
4. Higher count rates should be possible as positive ions can be removed more quickly.
5. Substrate may be made of flexible material which can be rolled up, for example, into a cylindrical shape detector.

Main Disadvantages

1. Anodes can still be destroyed by minor sparks - repair not possible.
2. Choice of substrate quite tricky as gas gain appears variable (probably) due to charge build up.

Reference

Budt-Jorgensen, *et al* Nucl Instr & Meth. A310 (1991) pp82-87

How to reduce parallax

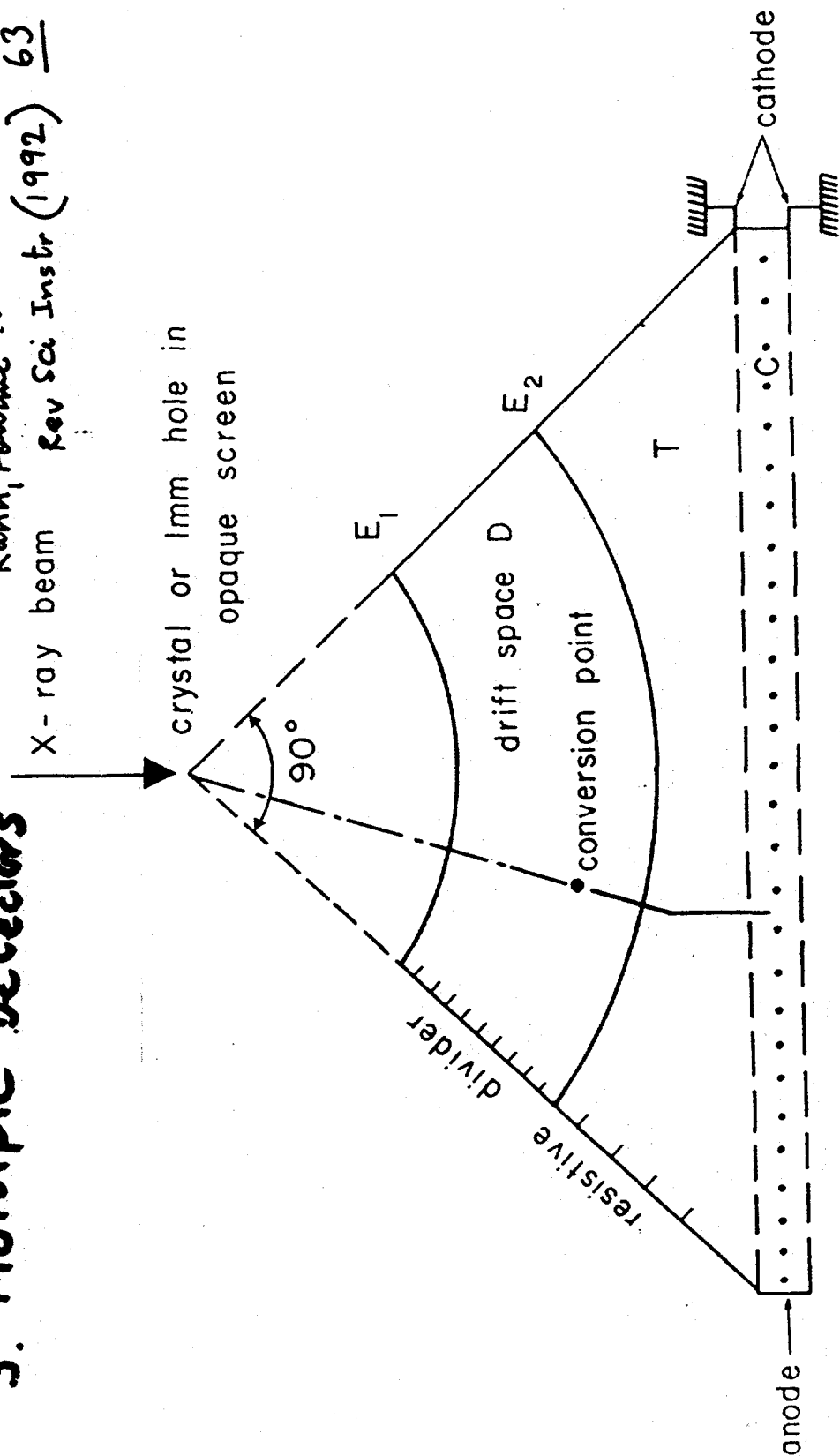
1. Radial Drift Field

2. Pressure

3. Multiple Detectors

G. CHARPAK NIM 156, (1978), 1-11

Kahn, Fournier
Rev Sci Instr (1992) 63 655-656



DETECTOR REQUIREMENTS - A SUMMARY

Resolution **2000 * 2000 pixels**

Size **150 - 200 mms**

Count Rates global **10 - 1000 MHz**
 local **100 kHz**

Detective Quantum Efficiency **'high'** **for 0.5 - 1.5**
Angstrom

Linearity and Uniformity **should be correctable**

Dynamic Range **1000 - 10000**

Radiation Damage **should be able to withstand few**
months

Time Framing **desirable**

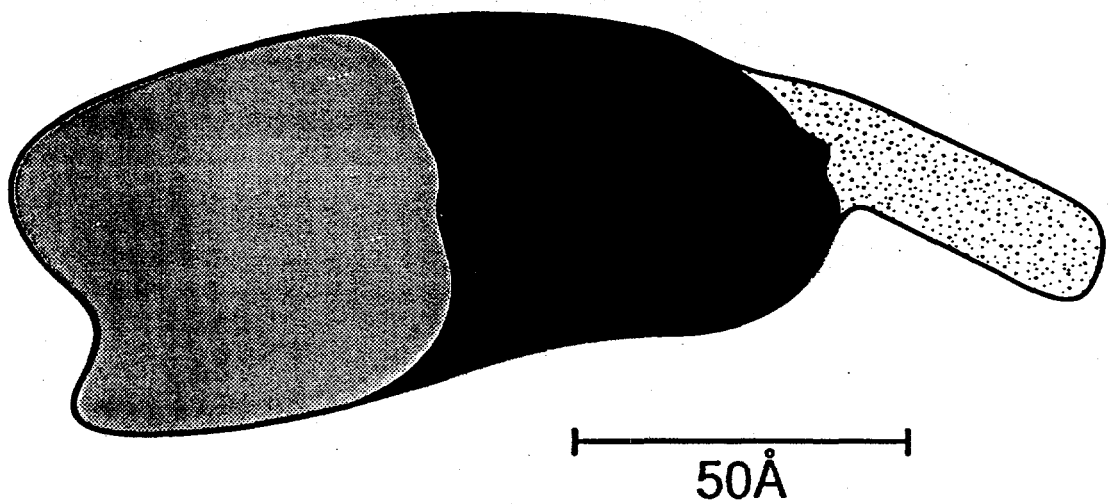
General Reviews:

- 1. Proceedings of the European Workshop on**
 X-ray Detectors for Synchrotron Radiation Sources
 Aussois France 1991
 Ed. A.H. Walenta
- 2. Detector Applications in biology and condensed matter physics**
 A.R. Faruqi
 Nucl. Instr and Methods A310 (1991) 14-23

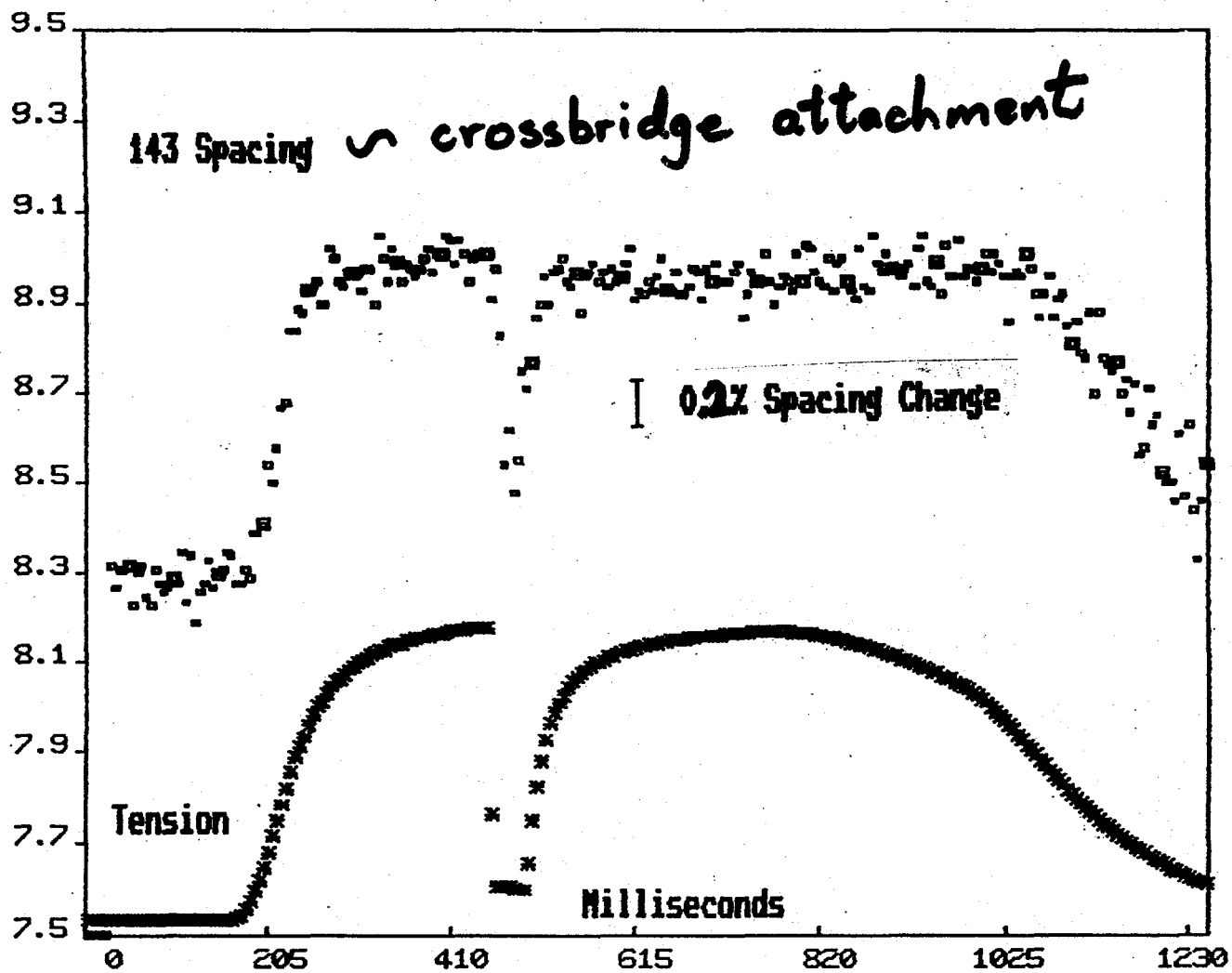
Basic Parameters - Summary (PX)

Resolution	$\sim 2000 \times 2000$ pixels
Size	150 - 200 mm
Count Rates :	global $\sim 10^7 - 10^9$ Hz local $\sim 10^5$ Hz
DQE ($1\text{\AA}$)	'High'
Linearity (& Uniformity)	'correctable'
Dynamic Range	$10^3 - 10^4$
Radiation Damage	'100 days'
Time Framing	desirable (PX) essential (TRXD)

Model of Myosin S1 consisting of three domains



S163A.RES 4 1 AVG 161,162,163 FAST SHORTENING



Sol M. Gruner

Princeton University
Department of Physics

**CCD Area X-ray Detectors:
Experiments and Possibilities**

CCD-based area x-ray detectors are capable of solving many of the quantitative imaging and diffraction problems expected to be encountered at the APS. These detectors are under development by a small number of groups for a variety of problems. The capabilities and limitations of existing detectors are reviewed, with an emphasis on the experiences of our group in applying these devices at the NSLS and at CHESS. Future capabilities are also discussed.

GOAL:

**DEVELOP 2-D DETECTORS FOR
STORAGE RINGS TO**

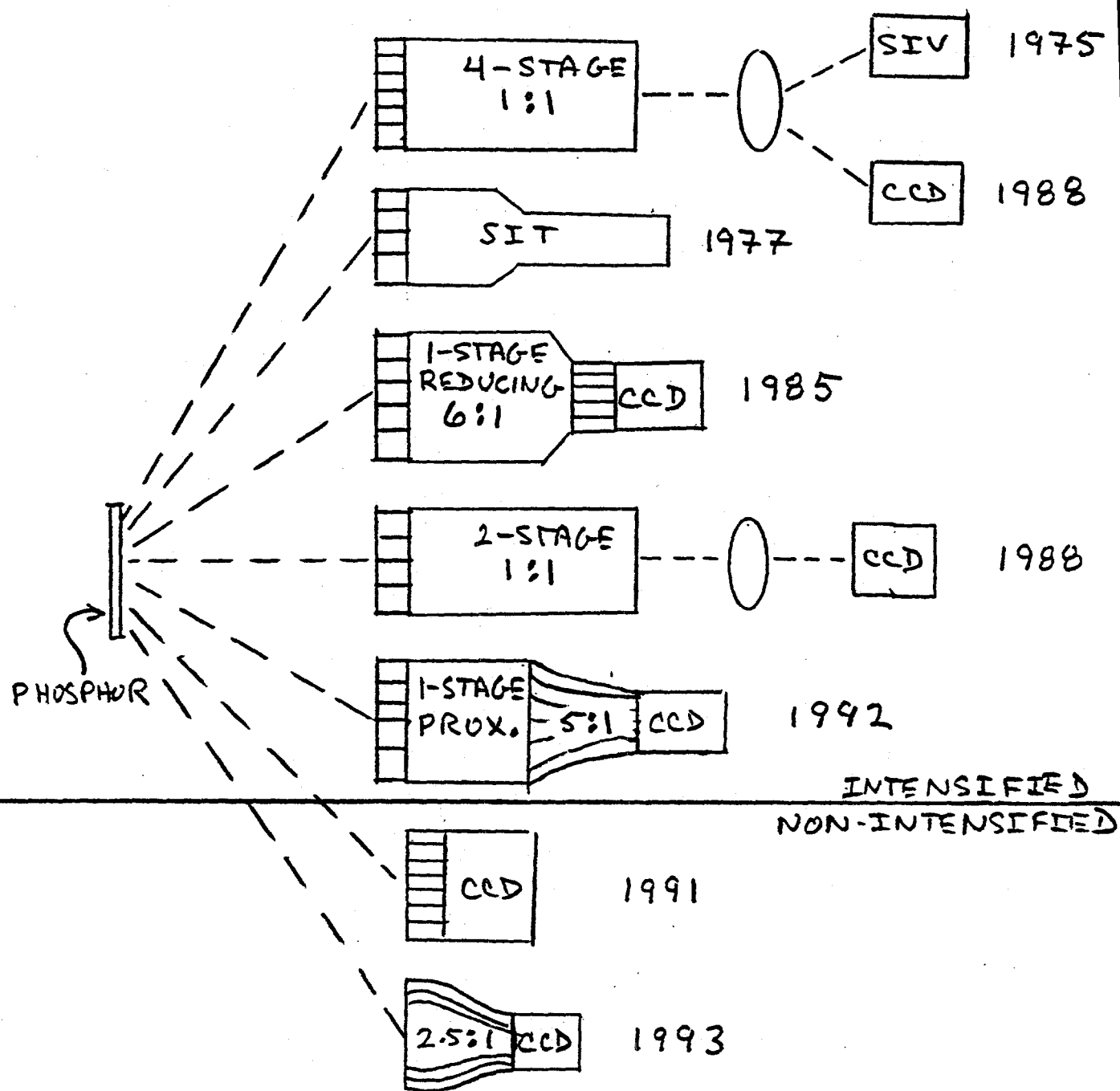
- ENHANCE CAPABILITIES**
- INCREASE EFFICIENCY**

SPECIFICATIONS:

- A) HIGH DQE (QUANTUM LIMITED)**
- B) AREA > 10 CM ACROSS**
- C) FORMAT > 2000 x 2000 PIXELS**
- D) COUNT-RATE INSENSITIVE**
- E) DYNAMIC RANGE > 10,000**
- F) ROBUST IN DEMANDING
ENVIRONMENT**
- G) EXPERIENCE TESTED, USER
FRIENDLY, FLEXIBLE AND
APPLICATION INTEGRATED**

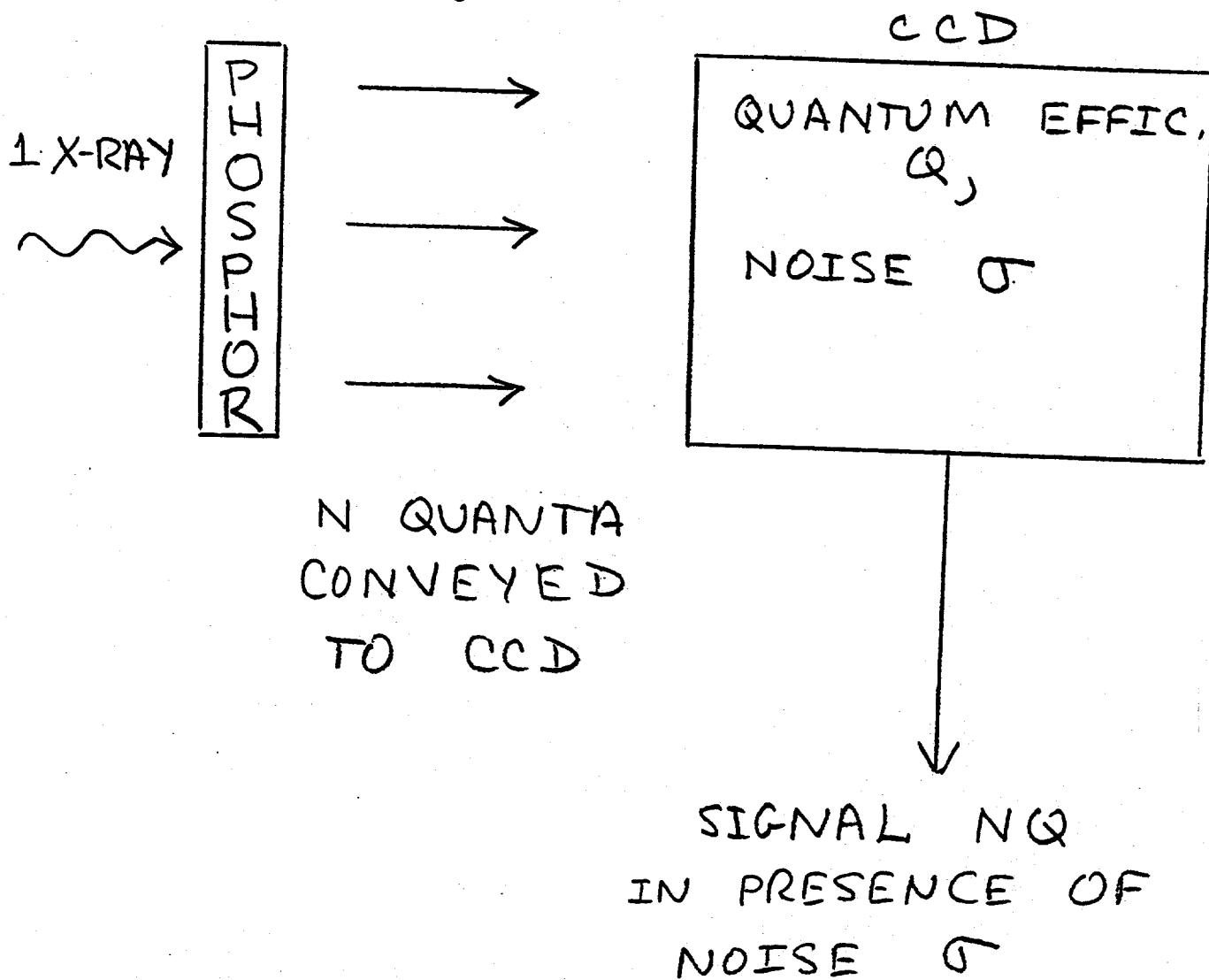
STRATEGY:

- 1) LARGE FORMAT, 1 CCD DETECTORS**
- 2) MOSAIC ARRAY OF SMALLER CCDs**
- 3) PIXEL ARRAY DETECTORS**



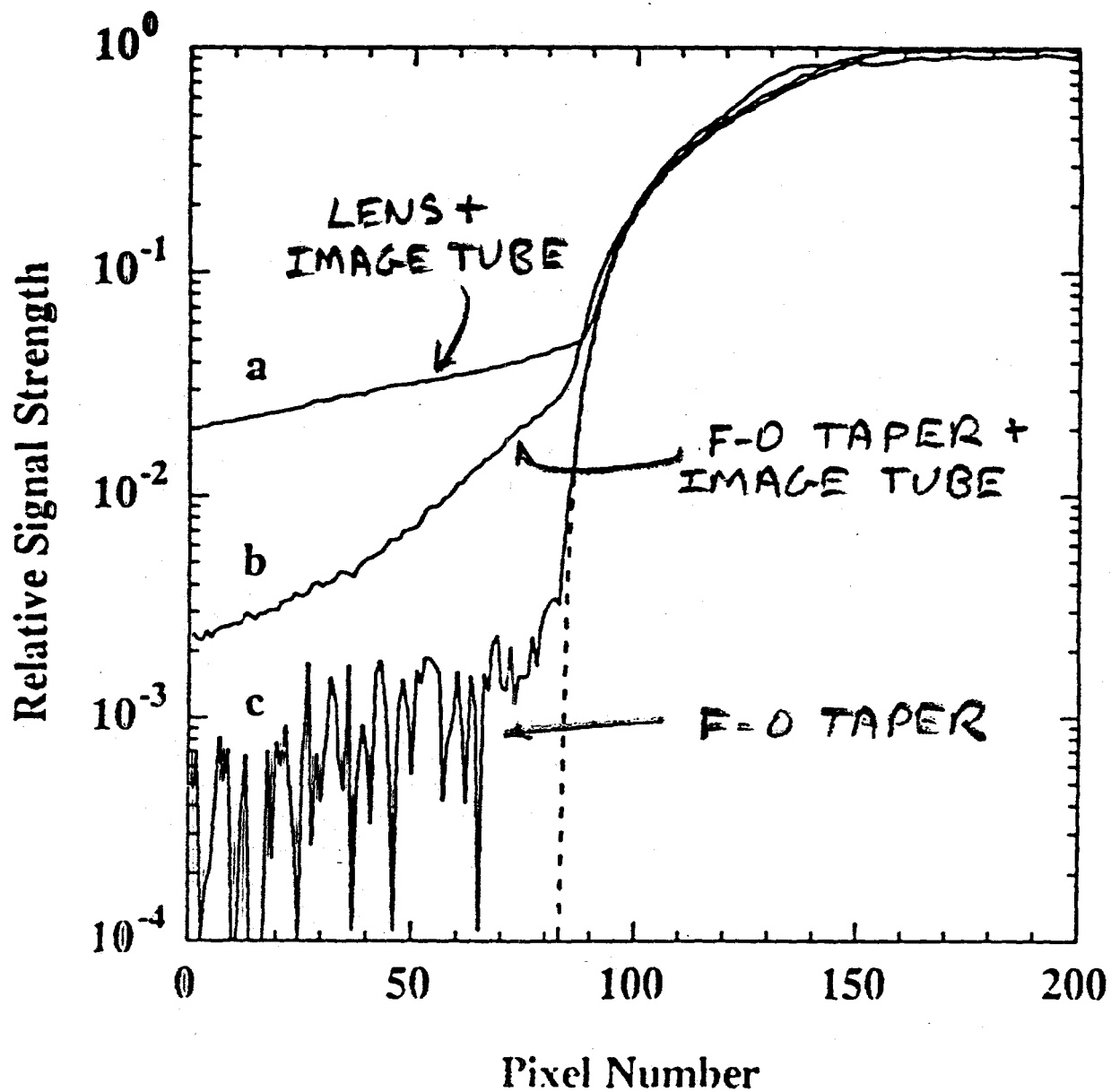
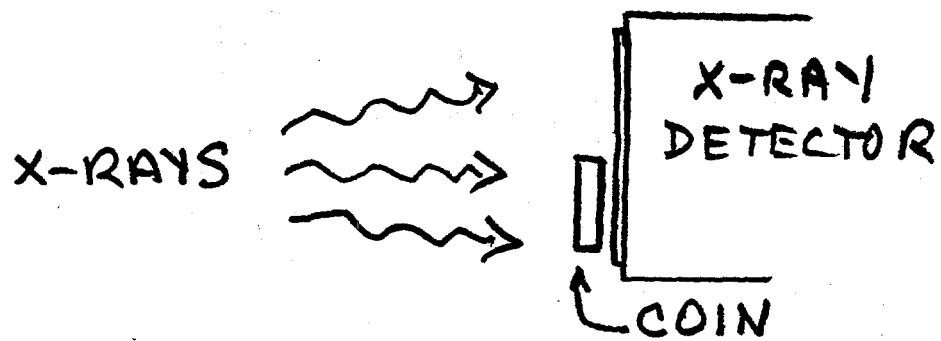
X-RAY DETECTORS CONSTRUCTED
AT PRINCETON

REMOVE
GAIN ELEMENT !



IDEALLY $NQ > \sigma$
BUT TO MAXIMIZE DYNAMIC
RANGE

$$NQ \approx \sigma$$



USEFUL NUMBERS *

1) EFFICIENT INORGANIC PHOSPHOR HAVE

EFFICIENCIES $\equiv$ (X-RAY ENERGY/LIGHT
ENERGY)

= 10-20 %.

FOR 5-10 KeV X-RAYS:

5-15 PHOTOELEC./X-RAY

¹⁴⁰
~~33-100~~ PHOTONS DELIVERED

(P-45, P-43, CsI (Na OR Tl), P-11)

! FOOT NOTE !

2) LENS COUPLING EFFICIENCY $\leq$ FEW %

$$C = \left(\frac{M}{2\mathcal{F}(1+M)} \right)^2$$

M = IMAGE/OBJECT (MAGNIFICATION)

$\mathcal{F}$ = "F" NUMBER

* SEE : GRUNER, "CCD & VIDICON X-RAY DETECTORS:
THEORY AND PRACTICE"
REV. SCI. INSTR. 60(1989) 1545.

3) FIBER-OPTIC TAPER EFFICIENCY (GREEN LIGHT) ↓

<u>M</u>	<u>C_{F.O.}</u>	<u>C_{LENS}</u> (f/1.0)
1	75%	6%
0.5	20%	3%
0.3	13%	1.3%
0.25	9%	1%

(COLEMAN, ADV. E.E.P. 64B (1985) 649)

C = 75% ACROSS A FIBER-OPTIC INTERFACE

4) OPTICAL QUANTUM EFFICIENCY OF Si

$$Q_S = 35 - 80\%$$

↑
BARE Si

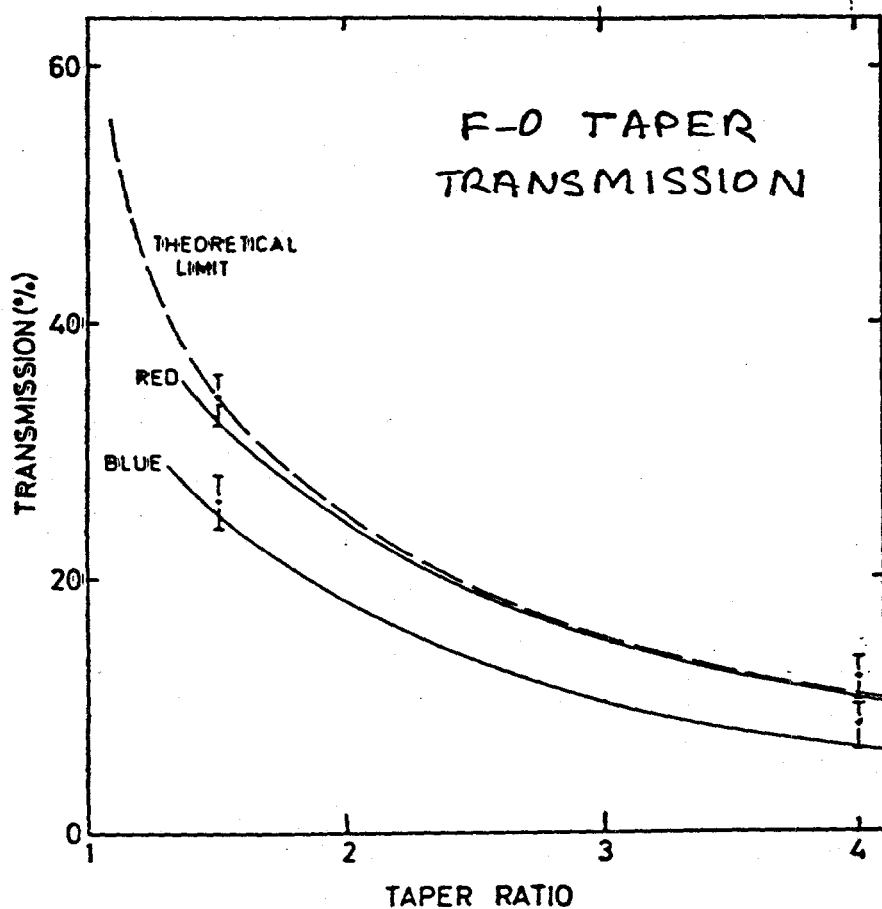
OVERLAID STRUCTURES

5) 3.65 eV OF X-RAY ENERGY IN Si
PRODUCES 1 e-hole PAIR.

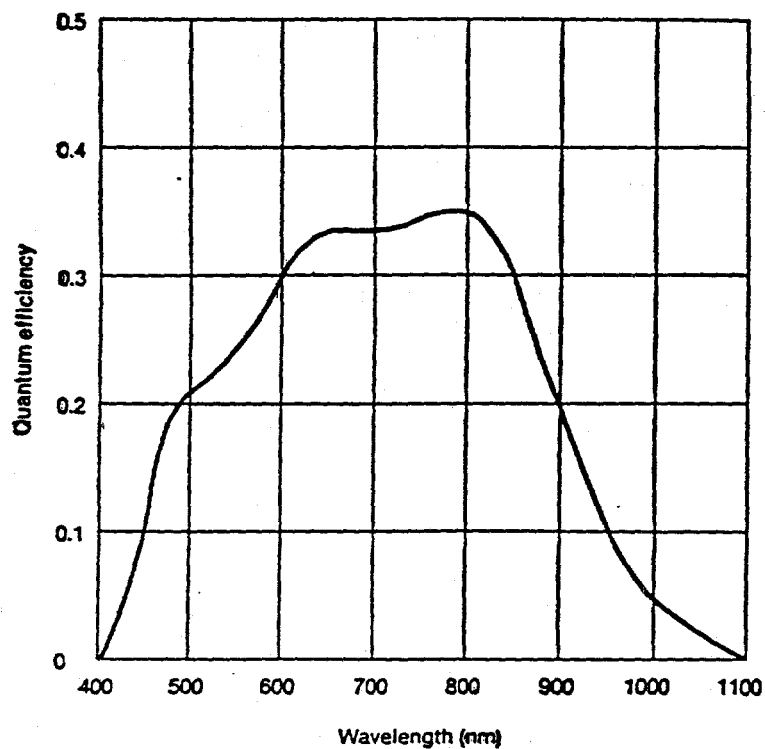
IMPORTANT X-RAY CHARACTERISTICS

- (1) ROBUST & STABLE
- (2) EFFICIENTLY CONVERT X-RAYS TO LIGHT
- (3) SPECTRAL MATCHING TO TAPER & CCD
- (4) PROMPT EMISSION W/LOW PERSISTENCE
- (5) HIGH X-RAY STOPPING POWER/RESOLUTION
- (6) LINEARITY OF OUTPUT W/DOSE & INTENSITY

**NO SINGLE KNOWN PHOSPHOR EMBODIES THE
BEST OF THESE CHARACTERISTICS.**



COLEMAN
ADV. EEP
64B(1984) 649



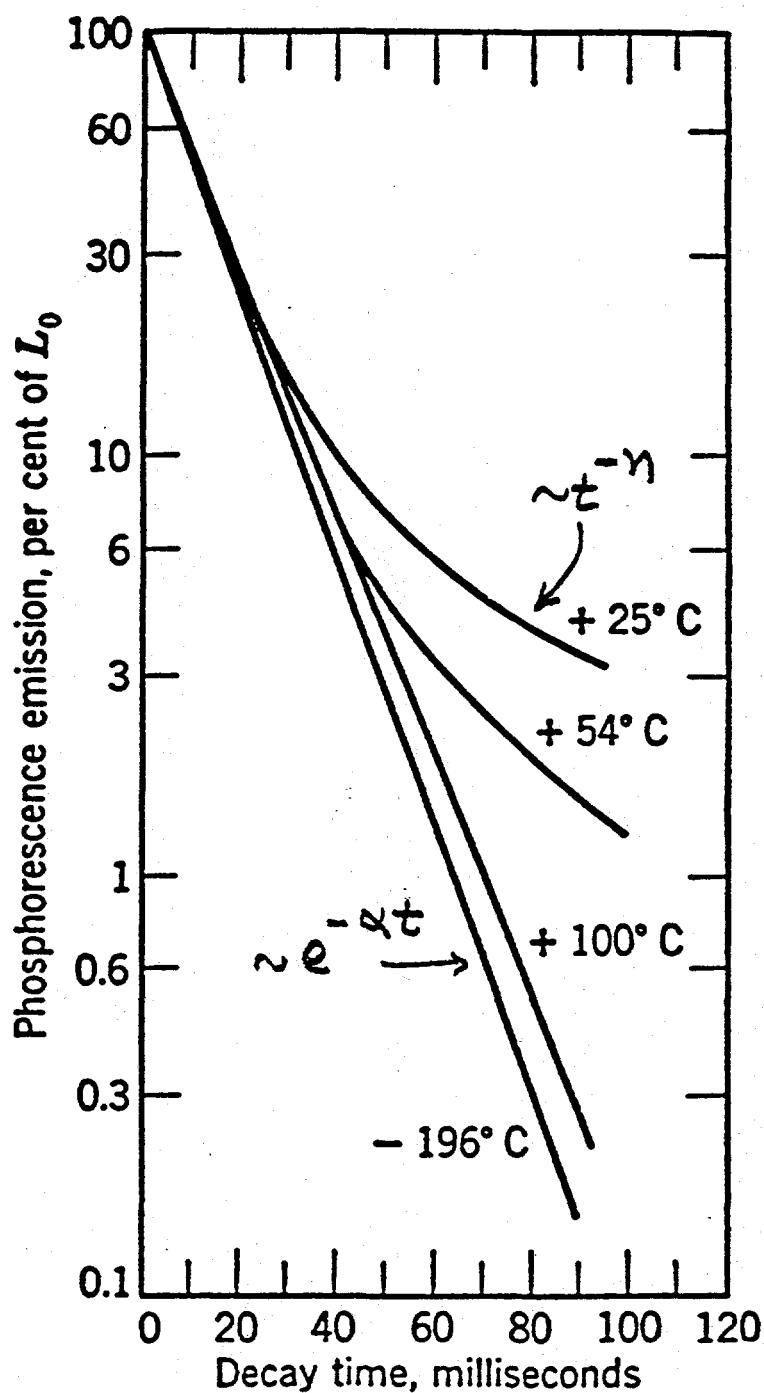
SPECTRAL
RESPONSE

THOMSON
TH7896A
CCD.

(FRONT ILLUM.)

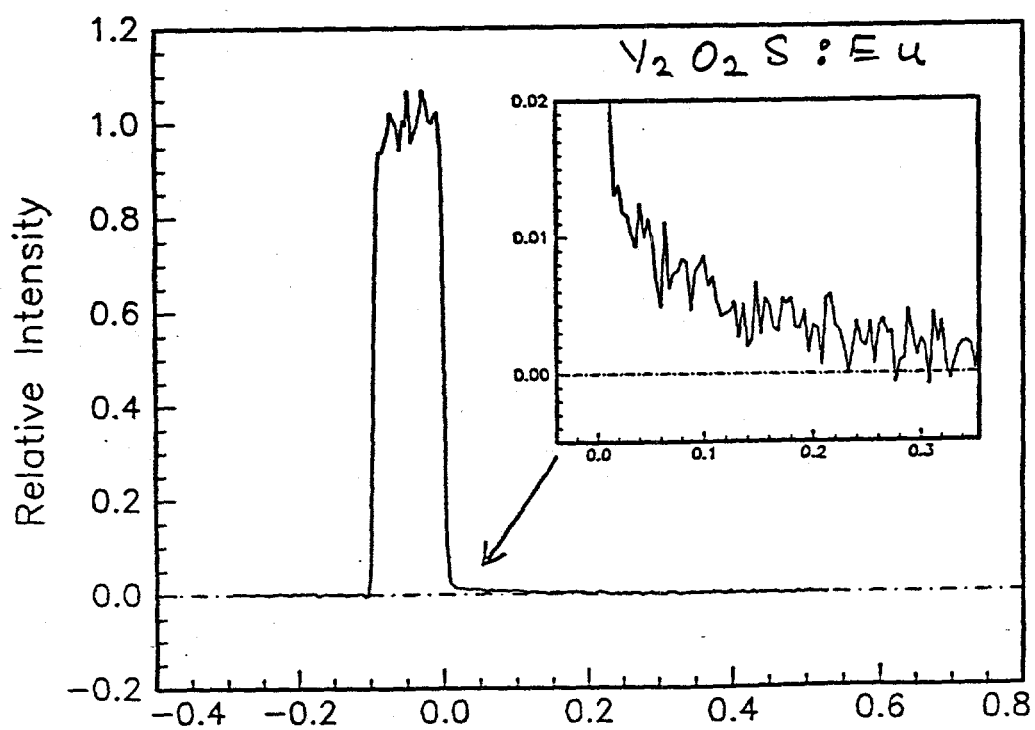
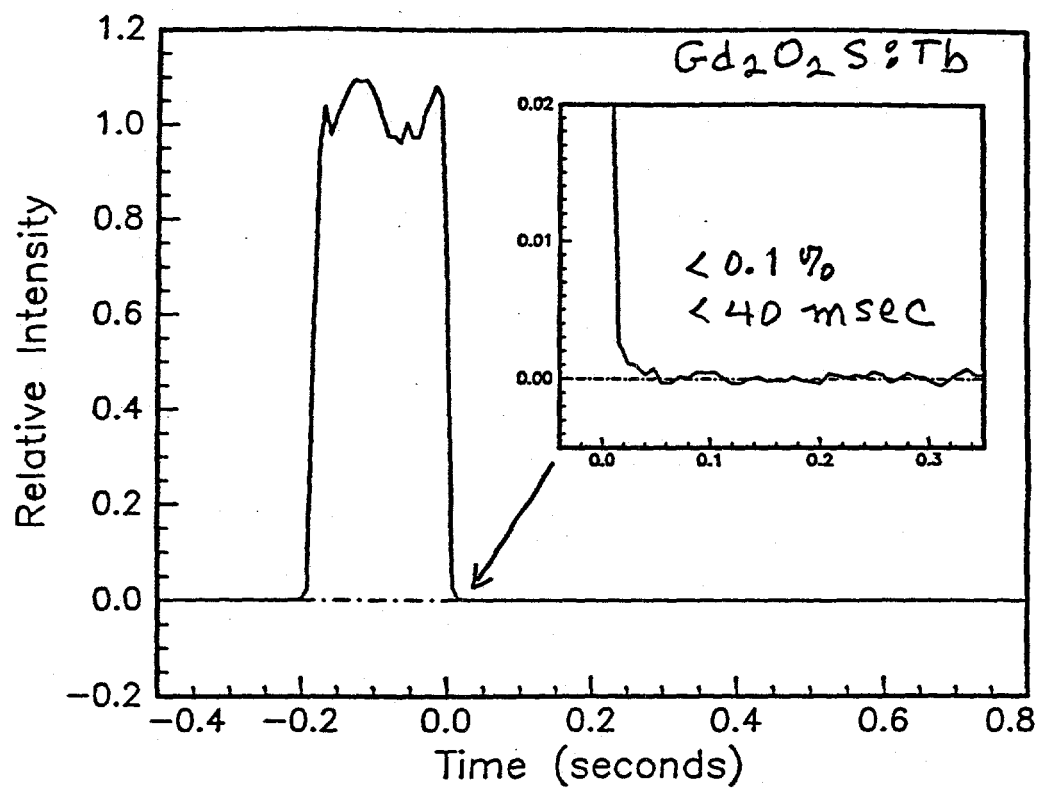
FIGURE 7: TYPICAL SPECTRAL RESPONSE

rbhdl - $\text{Zn}_2\text{SiO}_4:\text{Mn}(0.3)$



LEVERENZ, AN INTRO. TO LUMINESCENCE
OF SOLIDS

(JOHN WILEY, NY, 1950)



	⁽¹⁾ CsI:Na	⁽¹⁾ CsI:Tl	⁽²⁾ Gd ₂ O ₂ S:Tb	⁽²⁾ La ₂ O ₂ S:Eu
ROBUSTNESS	VERY HYGROSCOPIC	HYGROSCOPIC	STABLE	STABLE
X-RAY STOPPING POWER	VERY HIGH	VERY HIGH	HIGH	HIGH
EFFICIENCY	GOOD	GOOD	GOOD	GOOD
<u>SPEED</u> PERSISTENCE (TO 10 ⁻³)	<u>FAST</u> NO LAG	<u>FAST</u> LAG	<u>SLOW</u> A LITTLE LAG	<u>SLOW</u> SOME LAG
SPECTRUM	BLUE	GREEN	GREEN	RED
LINEARITY	?	?	?	?

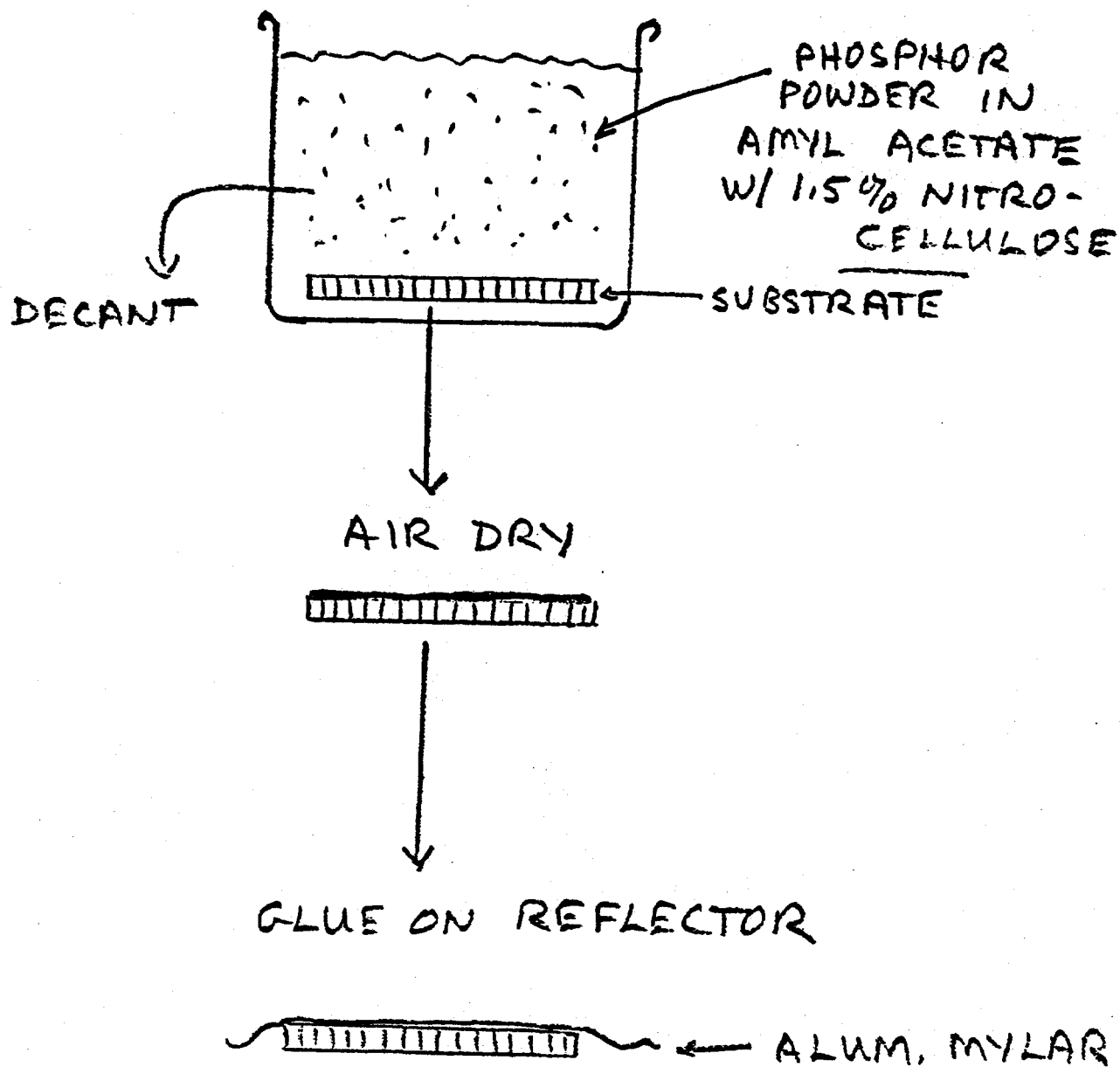
(1) EVAPORATED
ALLOWS TEXTURED GROWTH

(2) SETTLED POWDER

QUESTION:

**GIVEN THAT NO SINGLE PHOSPHOR IS IDEAL,
HOW WELL CAN WE DO USING SIMPLE, SETTLED
SCREENS OF COMMERCIALY AVAILABLE
PHOSPHOR POWDERS?**

SETTLE PHOSPHOR



RESULTS:

6 MM $Gd_2O_2S:Tb$

10 mg/cm²

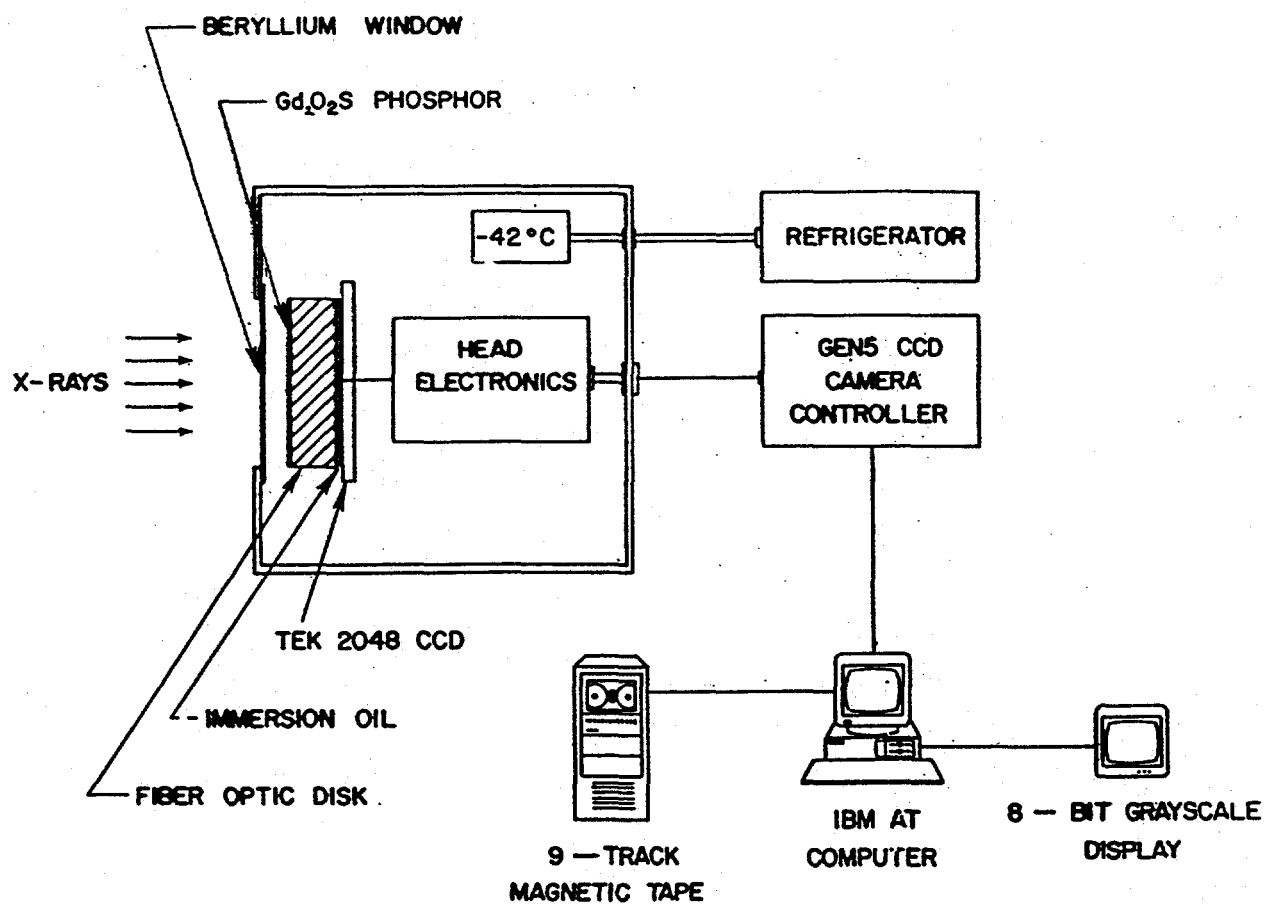
32 MM THICK

41% CRYSTAL DENSITY

Phosphor	Density	Efficiency*	Decay Time**	Stopping Power for 10 mg/cm ²	
				5.9 keV	13.6 keV
Y ₂ O ₂ S:Tb	8-11 mg/cm ²	50-140	-	92%	23%
Y ₂ O ₂ S:Eu	8-12 mg/cm ²	130-150	-	92%	23%
La ₂ O ₂ S:Eu	11 mg/cm ²	170	300 ms	100%	54%
Gd ₂ O ₂ S:Tb	10-15 mg/cm ²	50-70	10 ms	91%	66%

* Photons/⁵⁵Fe x-ray, guided through the fiber optic plate.

** To 0.2%



2048 X 2048 PIXEL CCD X-RAY DETECTOR

EIKENBERRY, TATE, BELMONTE, LOWRANCE, BILDERBACK & GRUNER. IEEE TRANS. NUC. SCI. 38 (1991) 110-118.

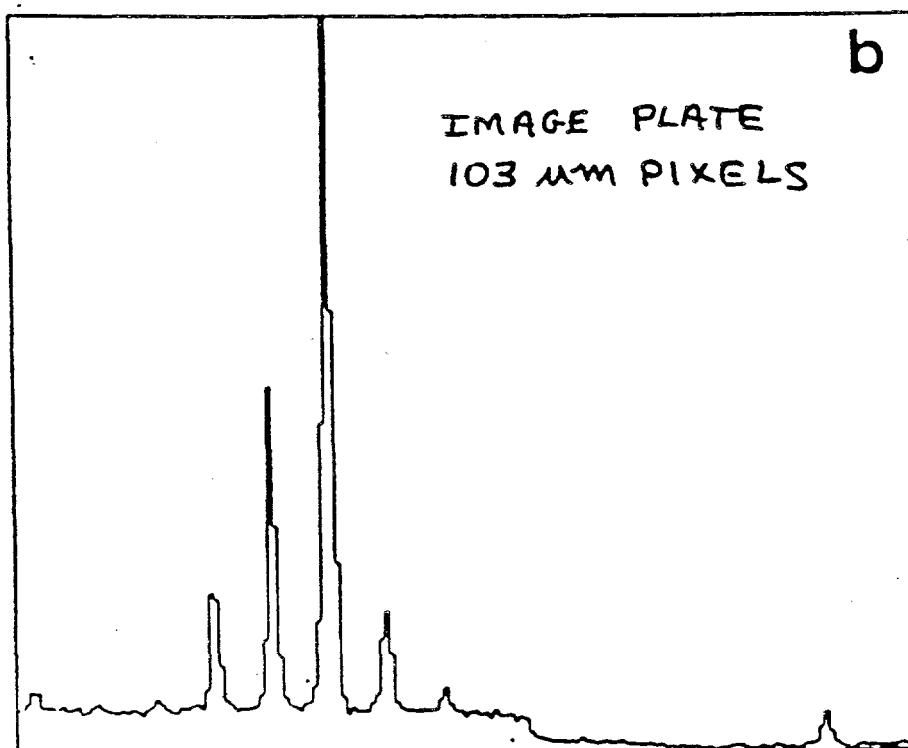
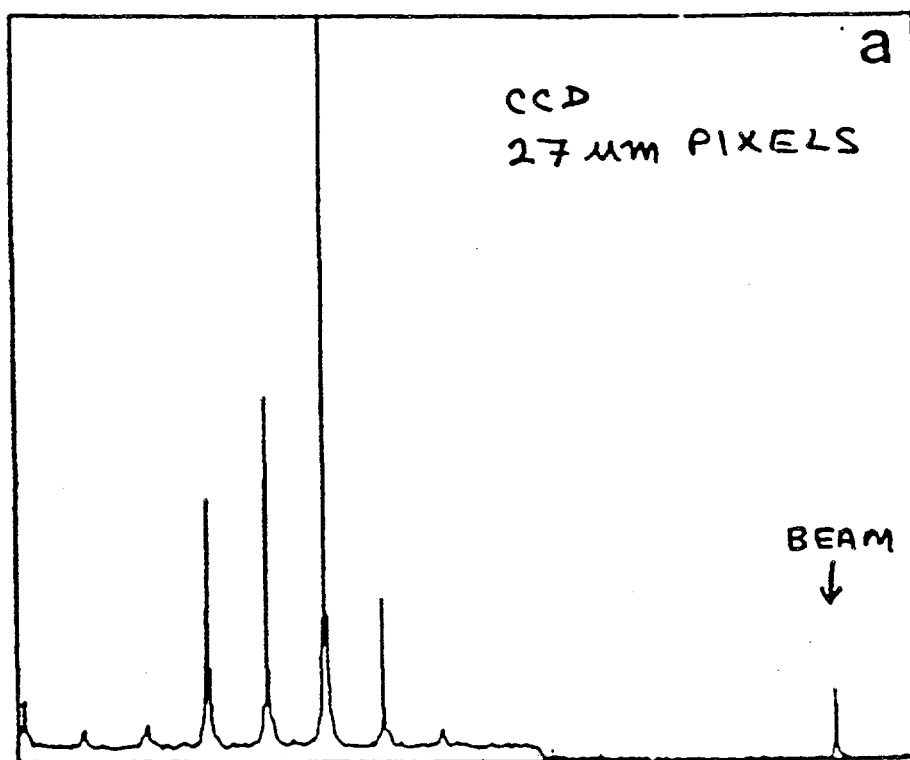
2K CCD X-RAY DETECTOR

CCD	TEK 2K, 2048 x 2048 pixels
Pixel Size	27 μm x 27 μm
Phosphor	GdO ₂ S, 9 mg/cm ² on 50 mm fiber optic
PSF	45 μm , FWHM
Sensitivity	24 e ⁻ /x-ray, ⁵⁵ Fe
Saturation	3 x 10 ⁴ x-rays/pixel
Dark Current	0.56 x time @ -42 °C
Dark Current Noise	0.2 x $\sqrt{\text{time}}$ @ -42 °C
Readout Noise	1 x-ray
Linearity	Excellent
Distortion	< 0.35 pixel
Zinger Rate	4 x 10 ⁻⁷ /pix/s on phosphor 6 x 10 ⁻⁸ /pix/s off phosphor

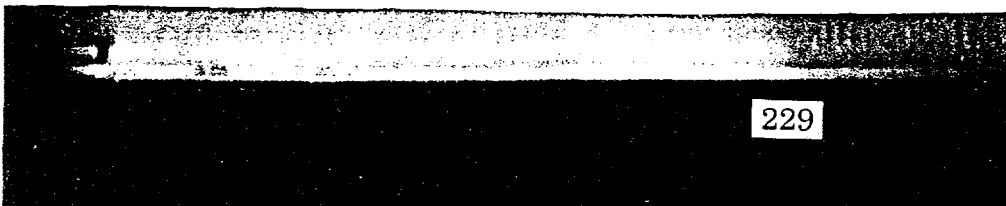
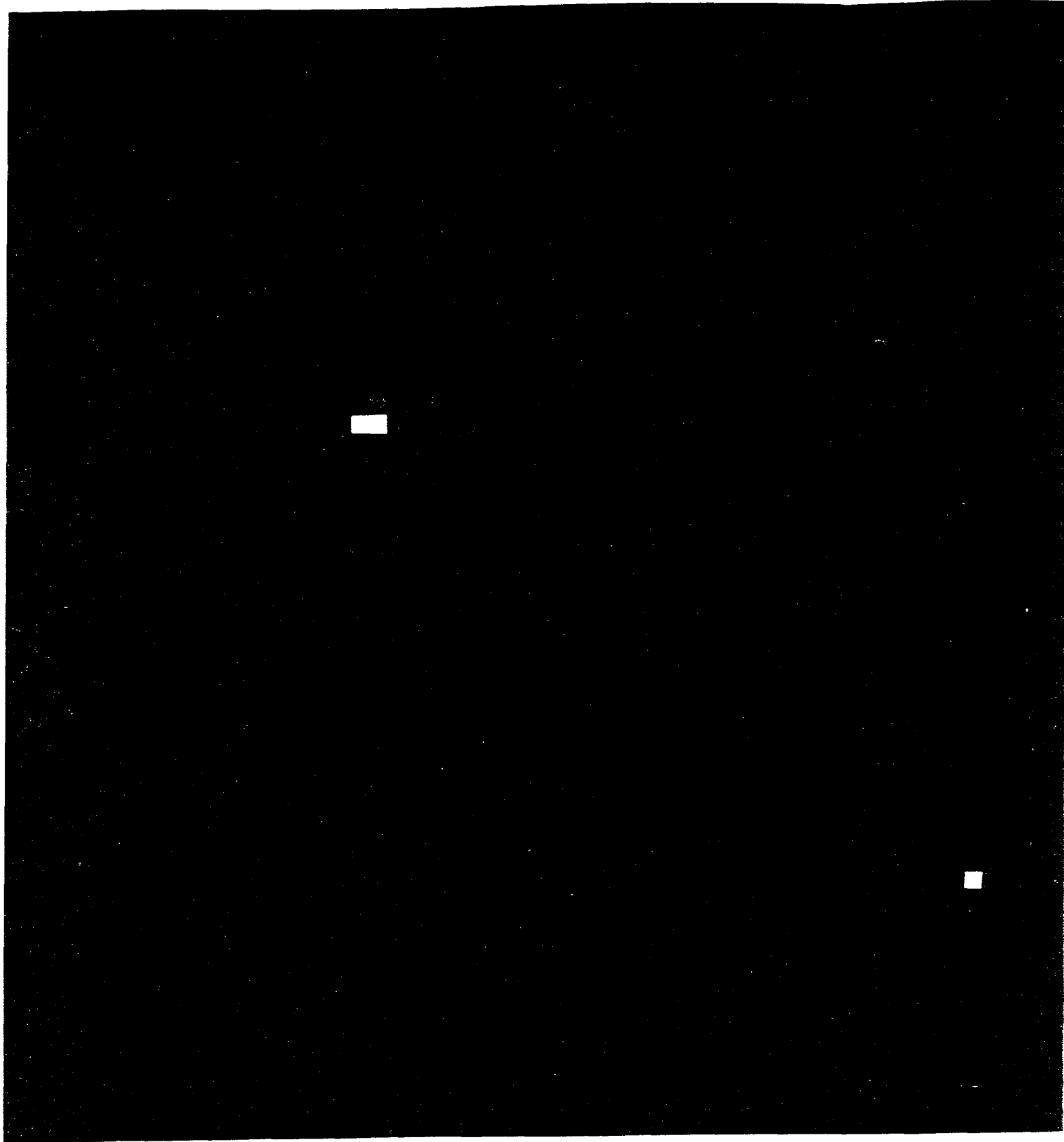
EIKENBERRY, TATE, BELMONT, LOWRANCE,
BILDERBACK & GRUNER, "A DIRECT-COUPLED
DETECTOR FOR SYNCHROTRON X-RADIATION
USING A LARGE FORMAT CCD"

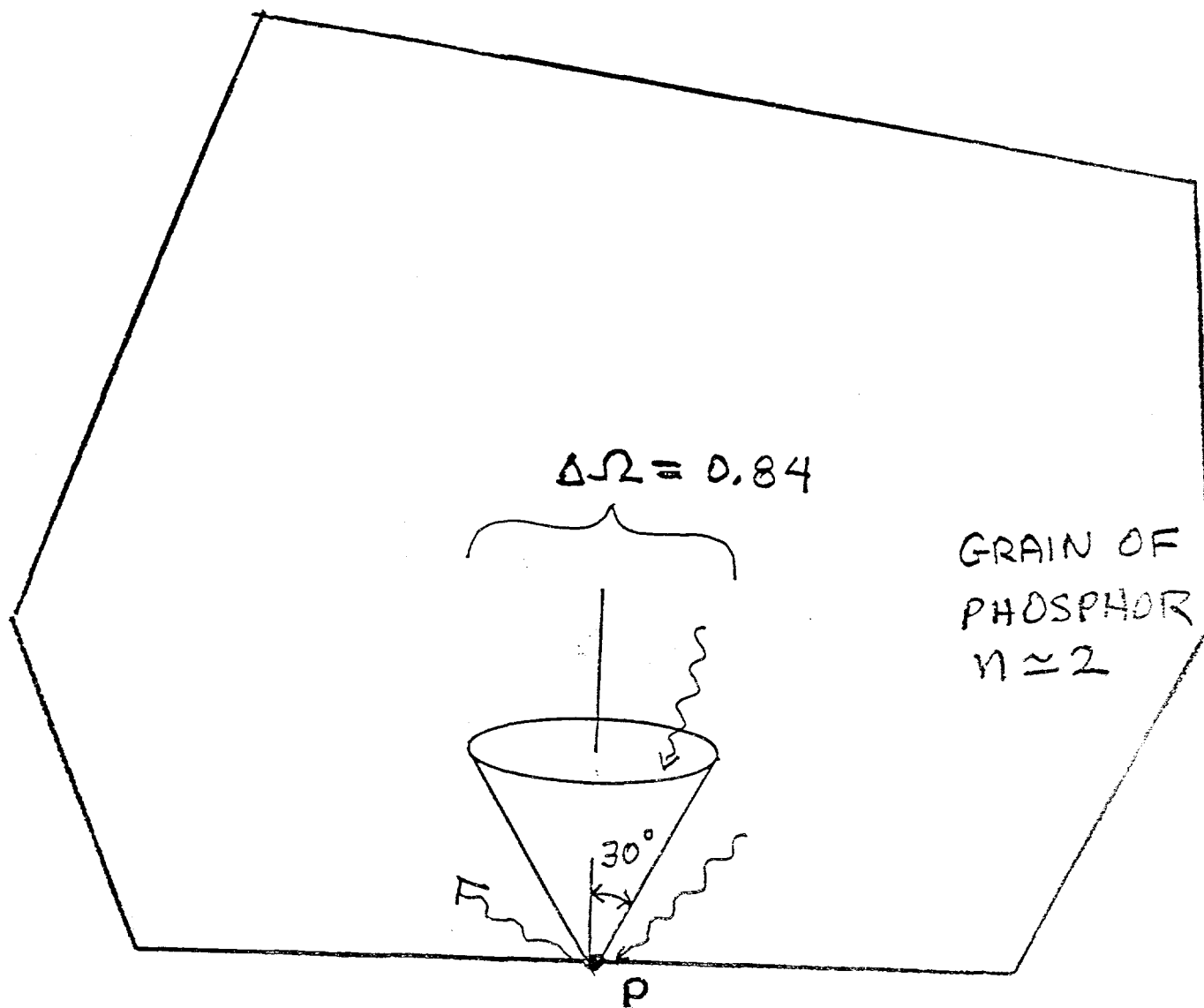
IEEE TRANS. NUC. SCI. 38 (1991) 110-118.

GALLIUM ARSENIDE, LAUE
20 μm INCIDENT BEAM

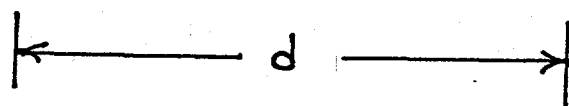
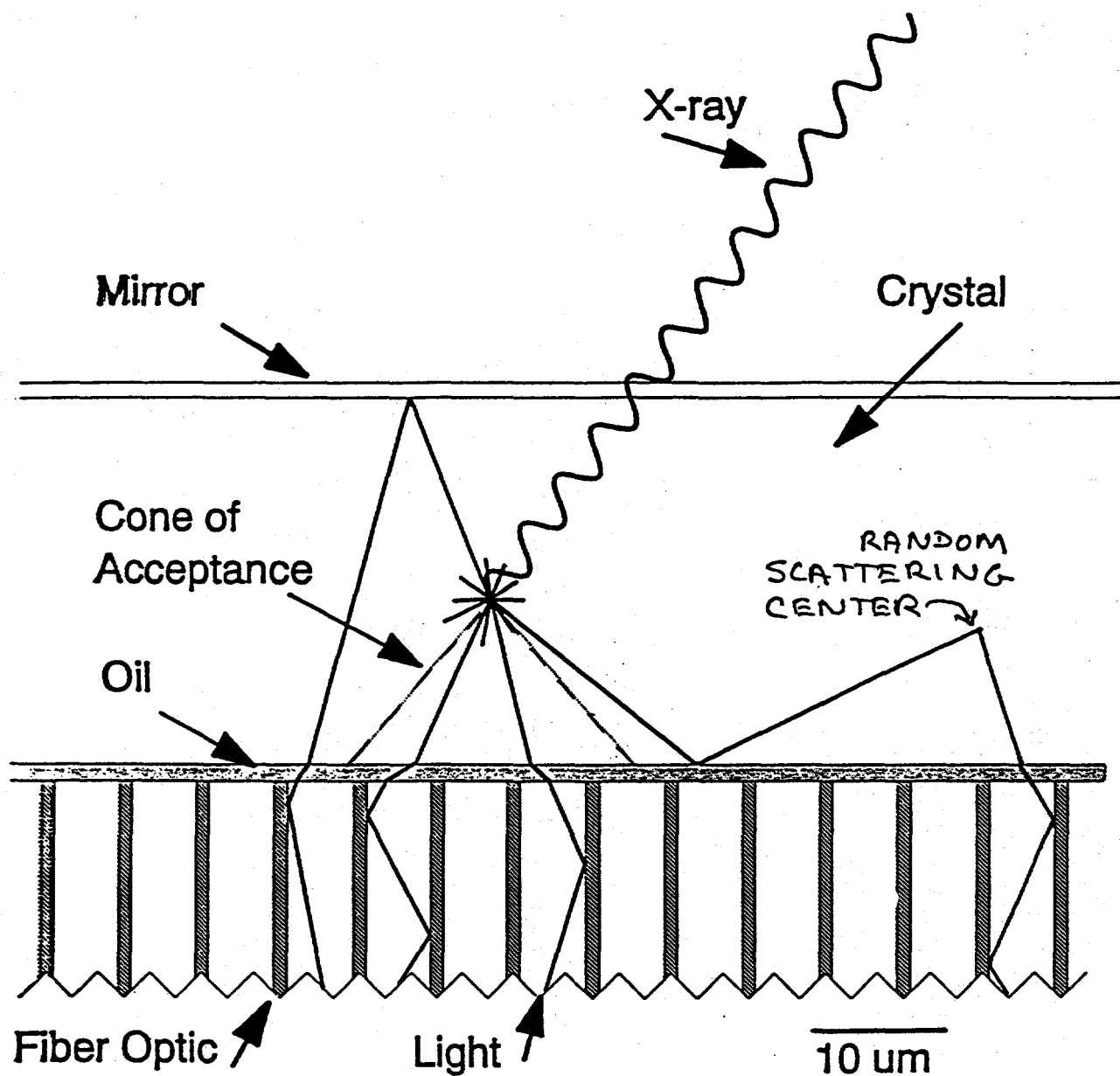








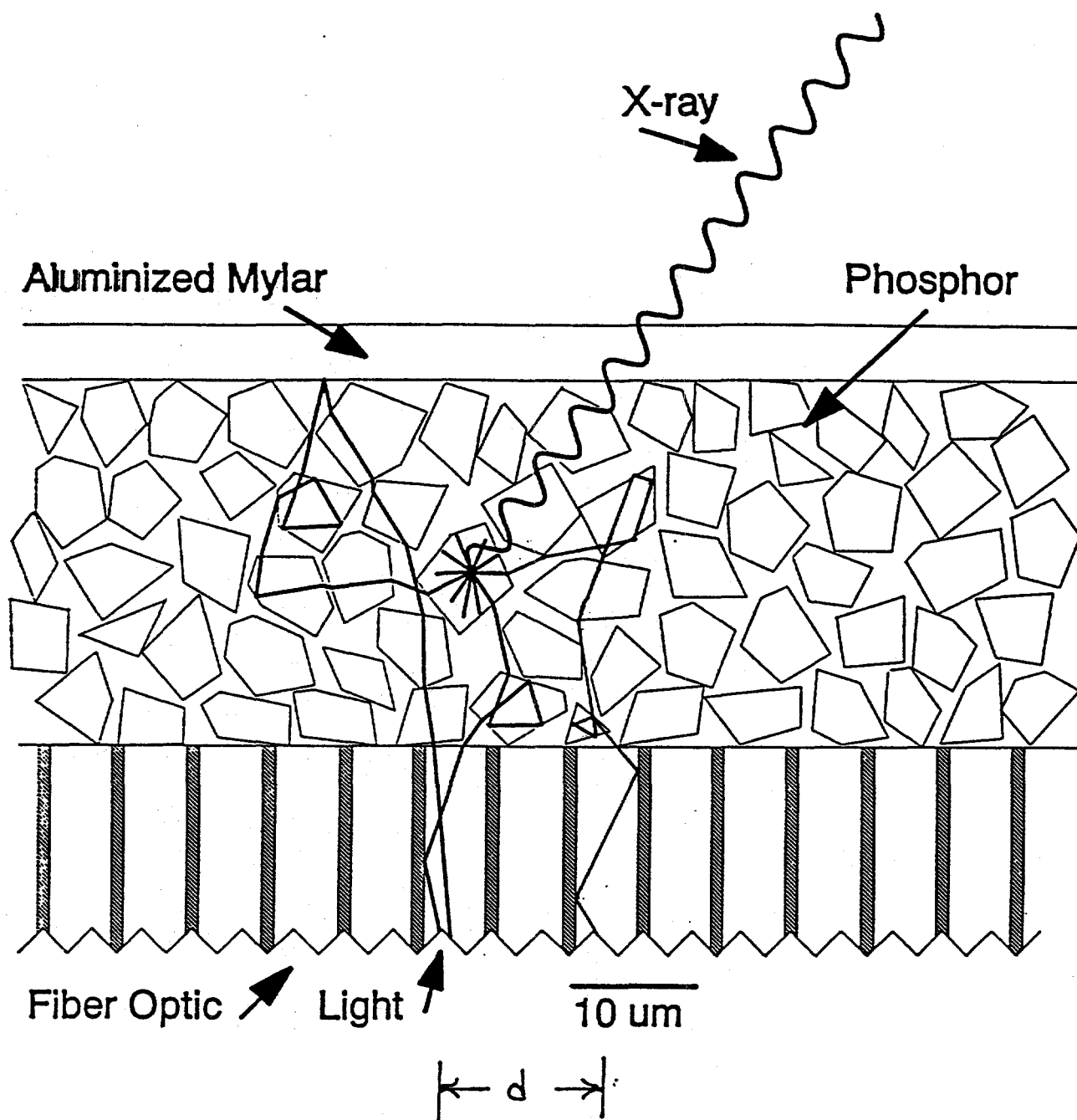
PROBABILITY FOR ESCAPE
AT POINT P =
$$\frac{\Delta\Omega (\text{STERAD})}{2\pi (\text{STERAD})} = 0.13 \approx \frac{1}{7.5}$$



$$\text{ATTENUATION} \sim e^{-Pd/c}$$

$C = \text{XTAL ABSORP. LENGTH}$

$$P \approx 1$$

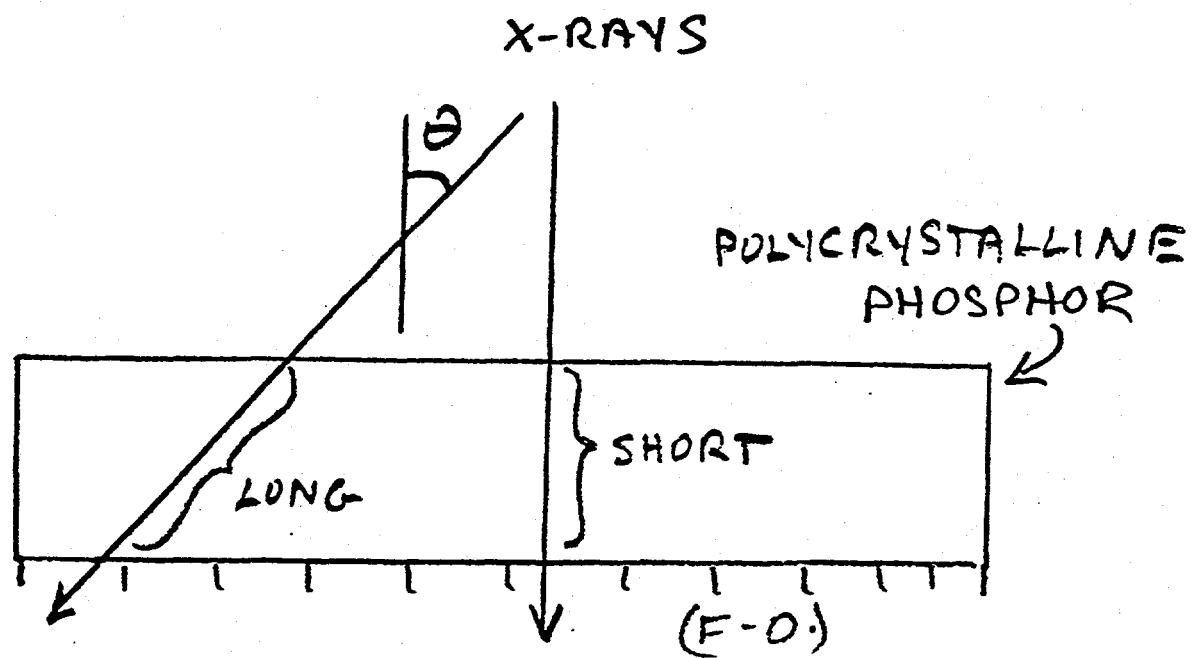


$$d \approx S\sqrt{N}$$

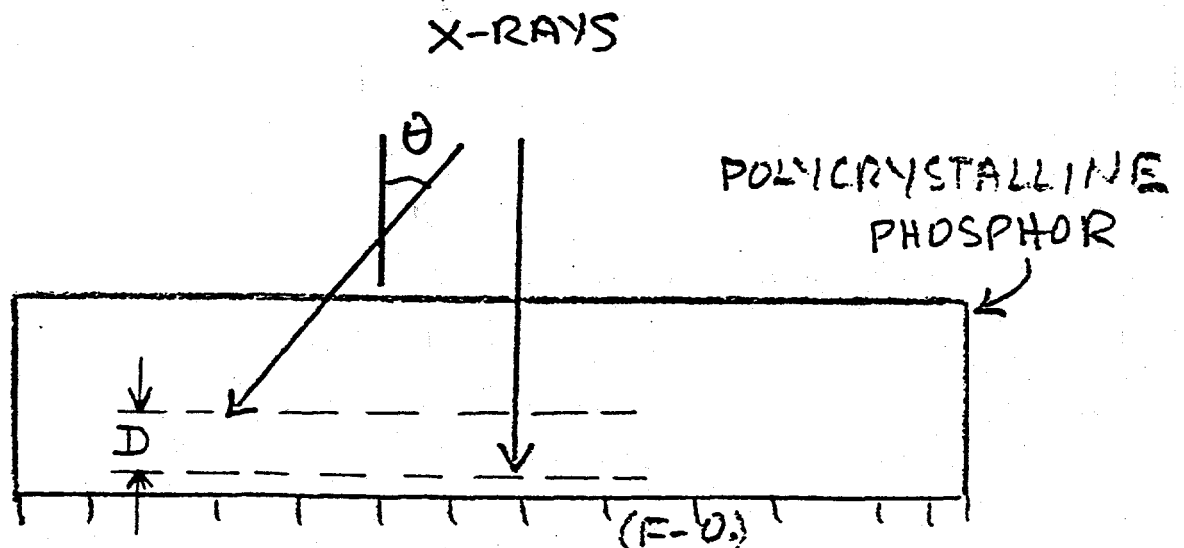
$$d_{TOT} = SN$$

S = STEP SIZE
N = # STEPS

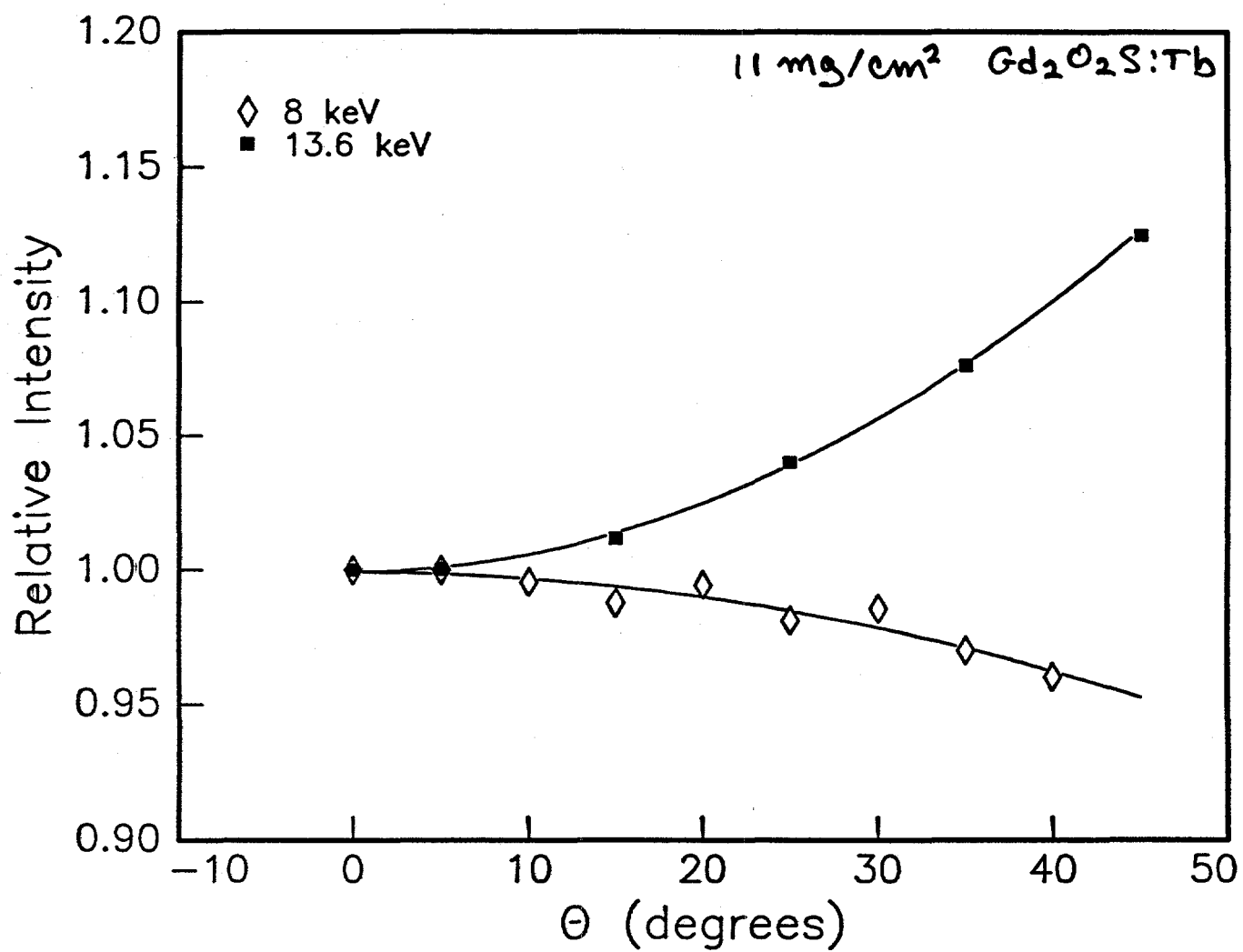
$$\text{ATTENUATION} \sim e^{-\frac{d_{TOT}}{c}} = e^{-\frac{d^2}{cS}}$$

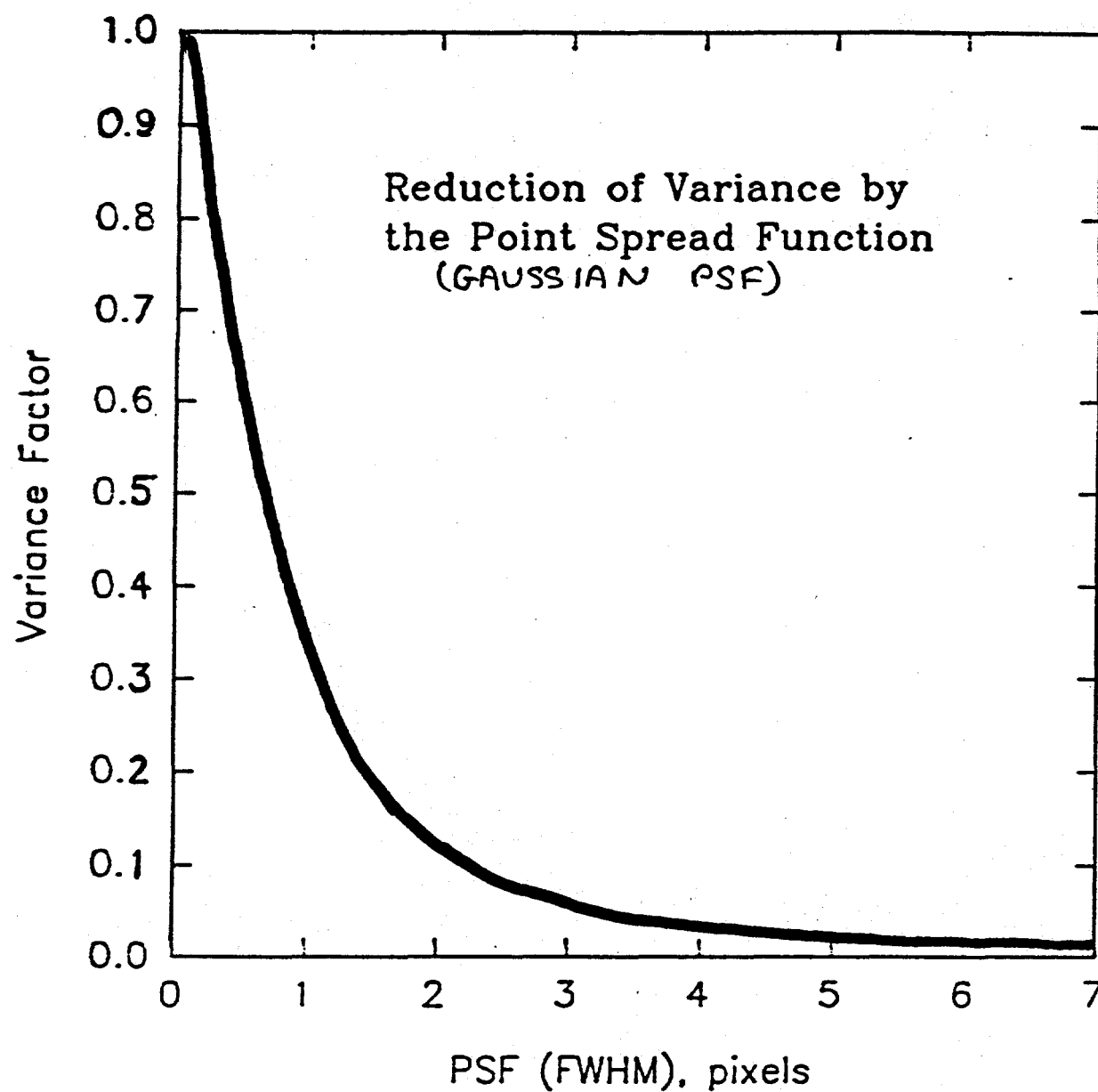


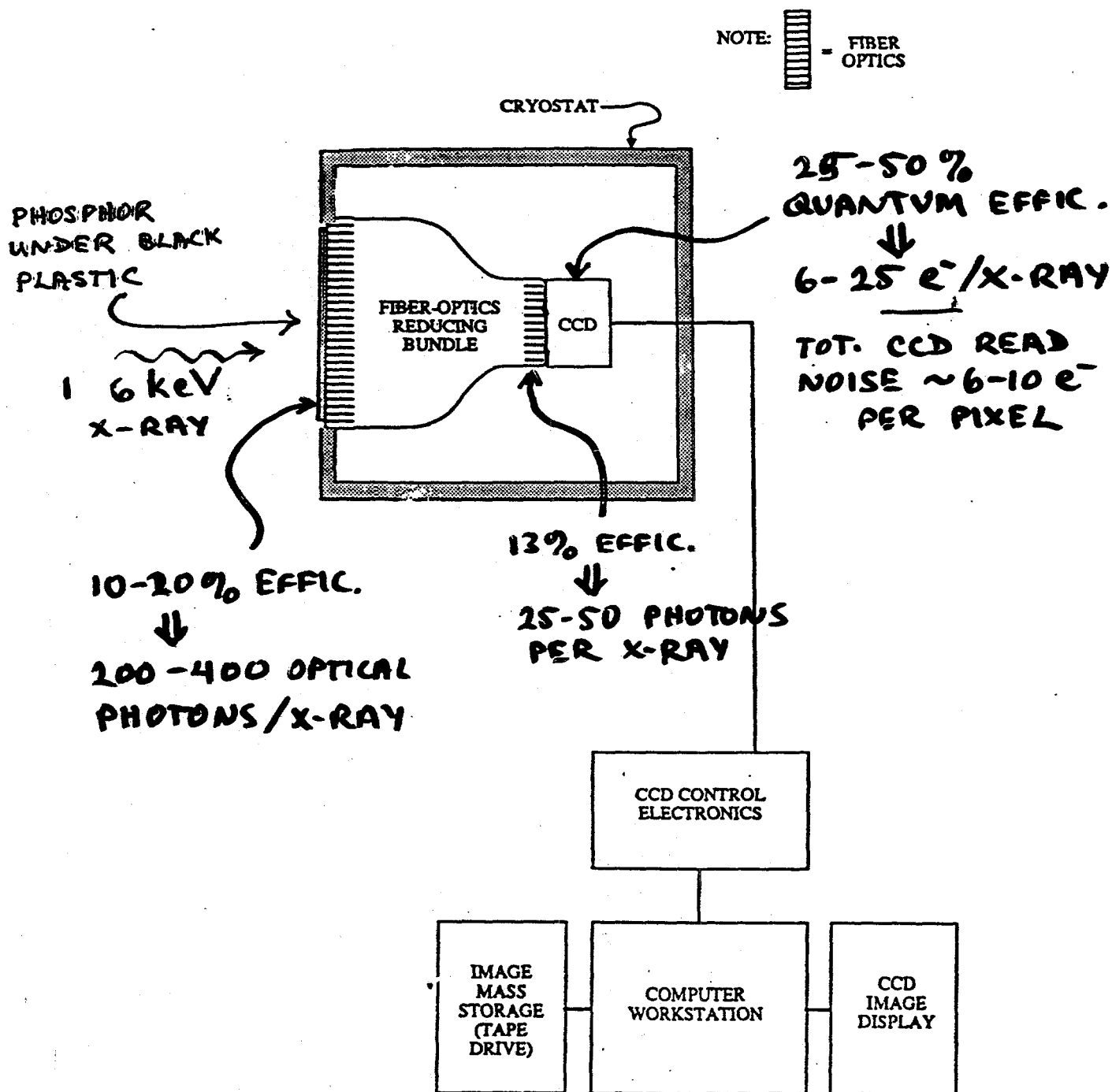
X-RAY TRANSPARENT LIMIT (λ SHORT)
 STOPPING POWER INCREASES
 $\therefore$ EFFICIENCY GOES UP AS θ INCREASES



X-RAY OPAQUE LIMIT (λ LONG)
 LIGHT PASSED TO F-OPTICS DECREASES
 AS D INCREASES, i.e., AS θ INCREASES.
 $\therefore$ EFFICIENCY GOES DOWN AS θ INCREASES







CCD	Thomson TH7896AVRNF
Pixel format	1024 × 1024
Fiber optic reduction ratio	2.6:1
Active input area	51 × 51 mm ²
Pixel size at phosphor (microns)	50.1
Phosphor	Gd ₂ O ₂ S:Tb
Operating temperature	-60 °C
A/D resolution (bits)	16 ²
Gain (e ⁻ /ADU)	4.6
Sensitivity (e ⁻ /5.9 keV x-ray)	4.6
Read noise (e ⁻ /pixel) RMS	8
Dark accumulation (e ⁻ /pixel/s)	0.8 at -60 °C
Full well (e ⁻ /pix)	4 × 10 ⁵
Point spread (microns)	
full width half maximum	80
full width tenth maximum	165
full width hundredth maximum	230

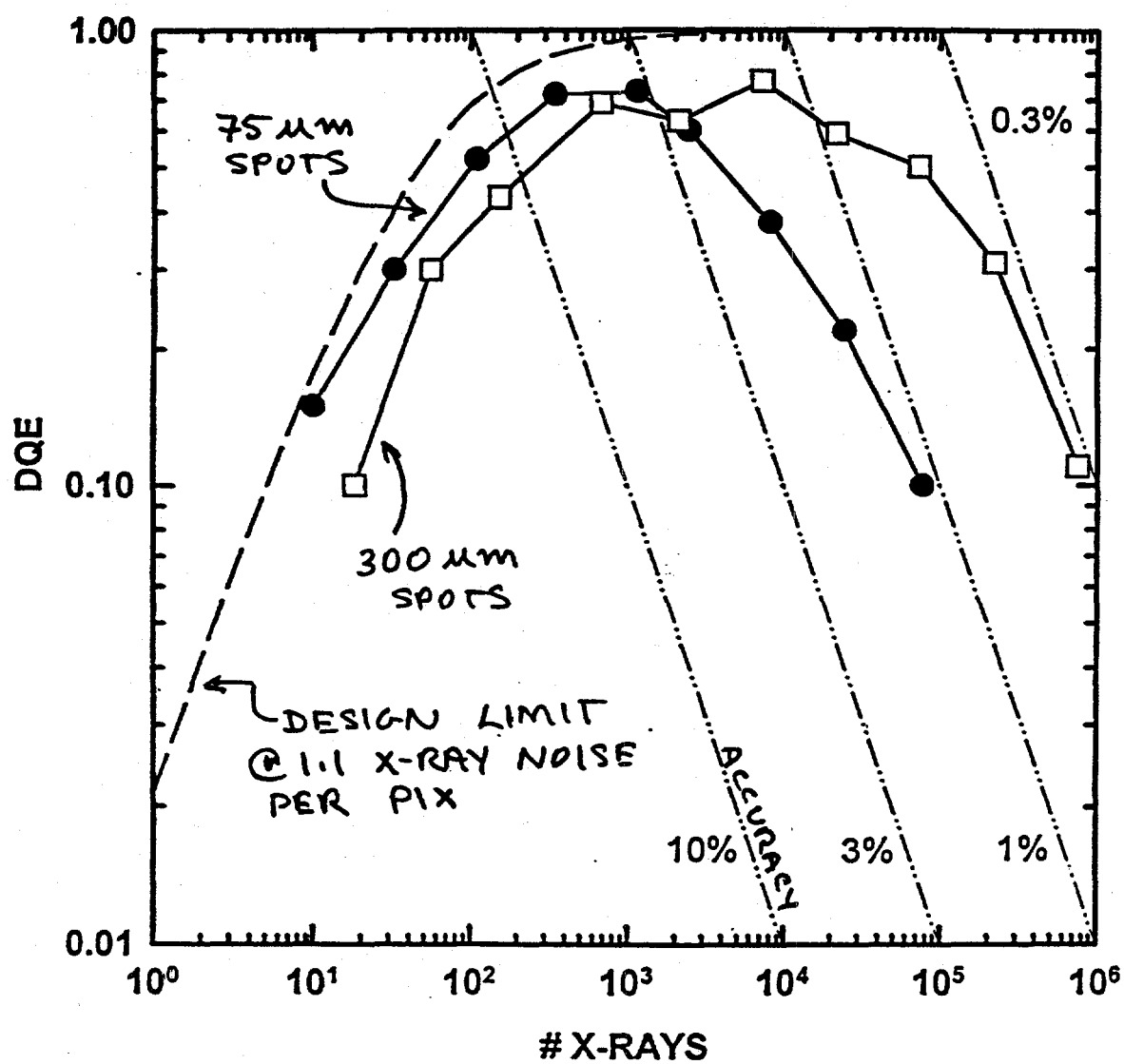
TABLE II
Detector sensitivity vs. x-ray energy

X-ray energy (keV)	5.9	8.0	8.9	11.0	13.5	18.0
Fraction of x-rays stopped ¹	0.932	0.986	0.975	0.878	0.703	0.430
Signal/incident x-ray (e ⁻)	4.6	7.1	7.7	10.3	11.1	10.3
Signal/stopped x-ray (e ⁻)	4.9	7.2	7.9	11.7	15.8	24.0
Signal/stopped x-ray/Energy (e ⁻)	0.83	0.90	0.89	1.06	1.16	1.33
Quadratic response coefficient ²	—	-3.5 × 10 ⁻⁵	-2.2 × 10 ⁻⁵	2.0 × 10 ⁻⁵	6.0 × 10 ⁻⁵	1.2 × 10 ⁻⁴

¹ For 11.5 mg/cm² Gd₂O₂S:Tb phosphor.

² Quadratic coefficient, B, characterizing the change in detector response, R, as a function of angle as
R = 1 + B × θ², where θ is given in degrees.

Thomson 1k DQE - 75 and 300 micron spots



TBSV

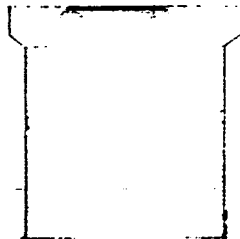
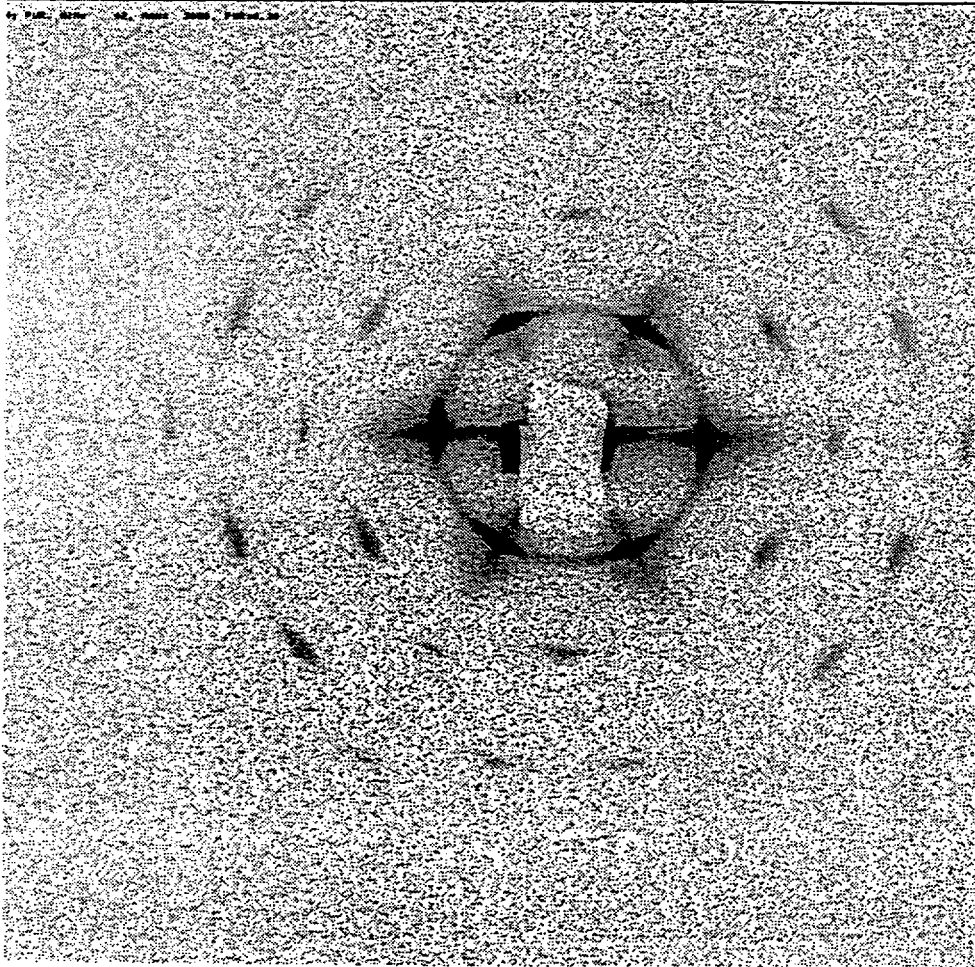
TEIV-B2.TIF: (SHIFT, FUTE, 200, 140, 4

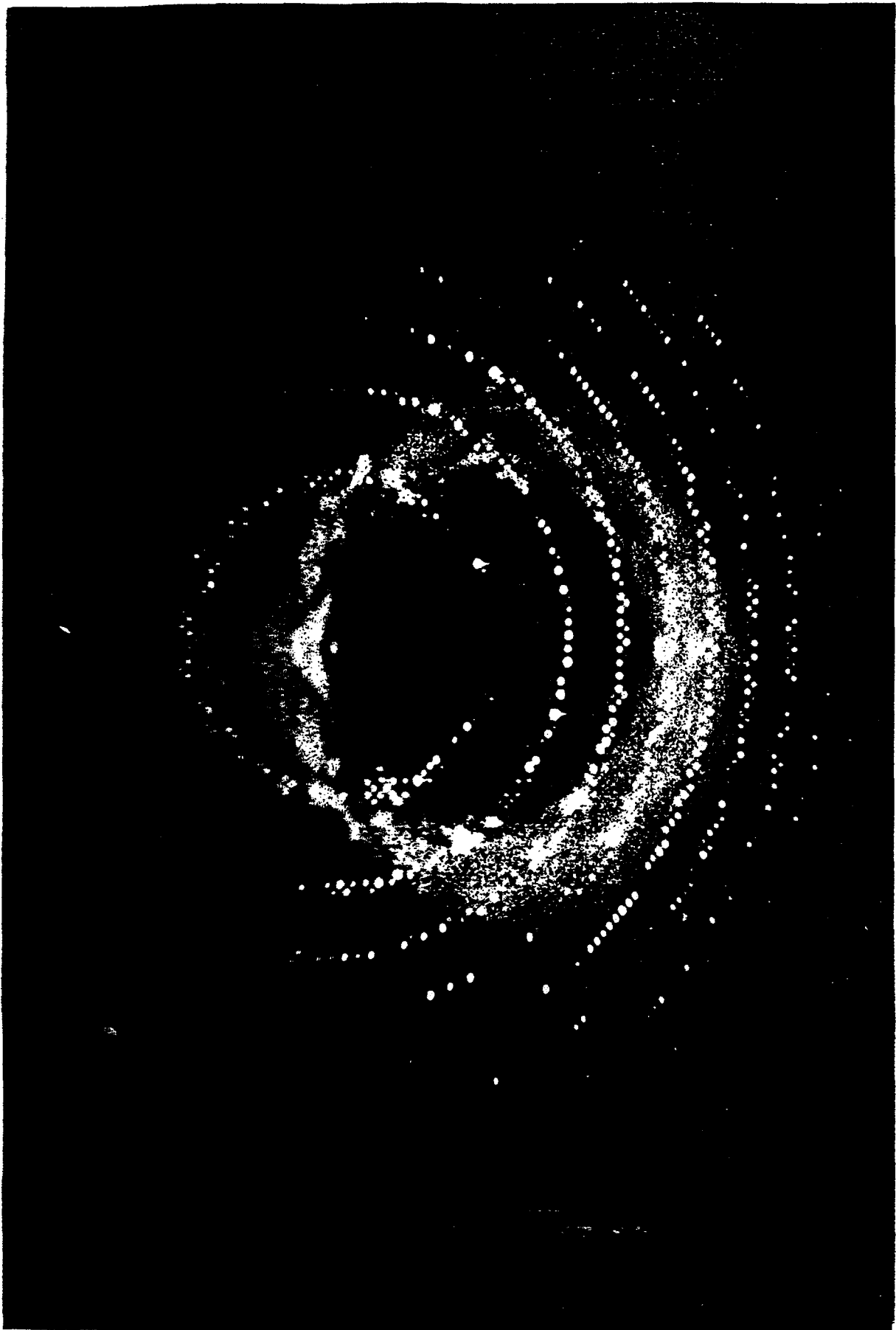
Tomato Bushy Stunt Virus
F1, 100mm collimator
I₂₃ space group
386 Å unit cell
0.2° rotation, 40 sec.
Courtesy Wendy Minor
& Patrick David Rogers
and Steve Harrison

PHI_X

PHI-X MULTIFRAME SHIFT: F0T= 450, SCALE= 2

PHI-X virus
F1, 100 mm collimator
0.3° rotation
30 sec. exposure
courtesy Wladimir
+ Michael Roseman





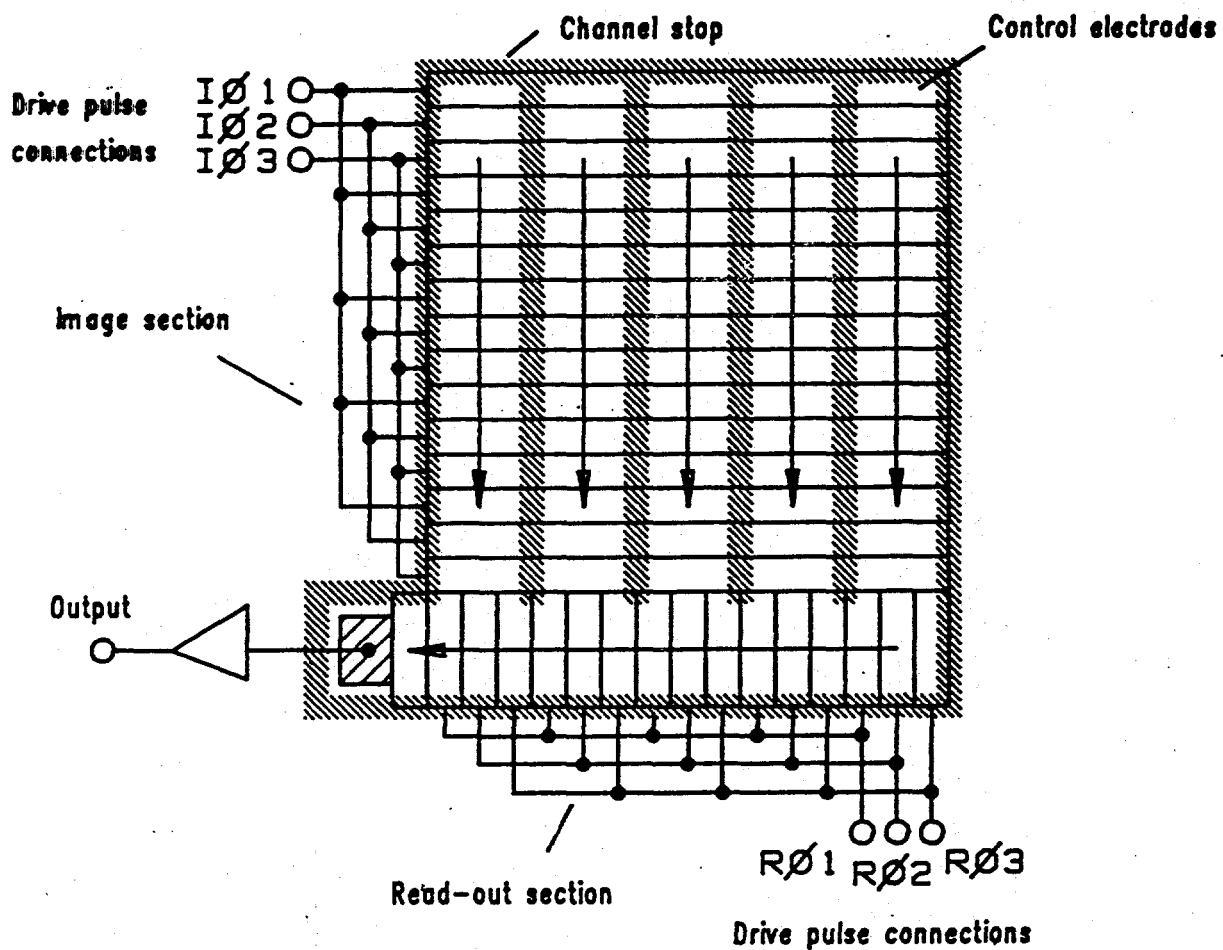


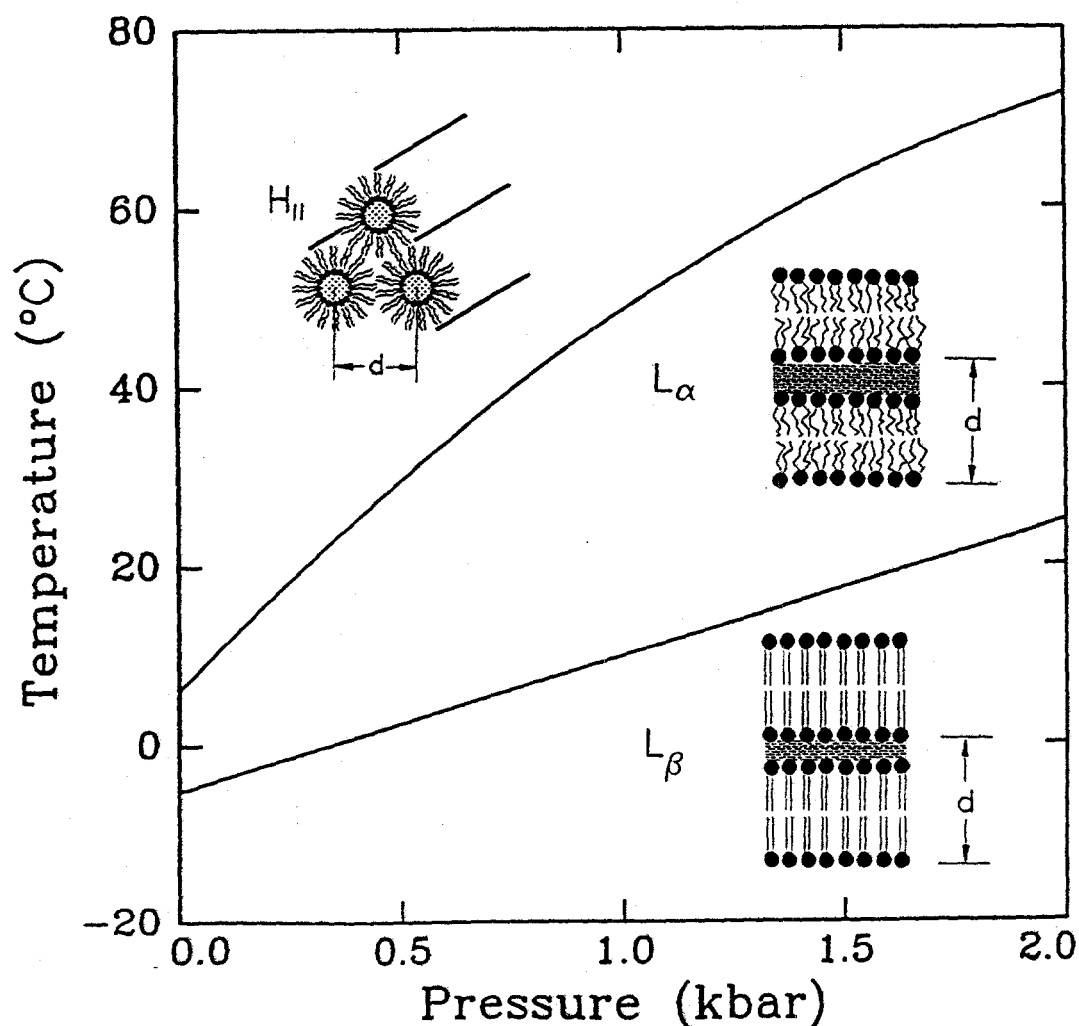
Fig. 1. Diagram of a basic CCD array.

DJ. BURT
NIM A305 (1991) 564

OSTERBERG, KRIECHBAUM, POLCYN, SKITA, TATE, SO,
GRUNER & SHYAMSUNDER ERRAMILLI

Sample used in p-jump studies:

DOPE (Dioleoyl-phosphatidylethanolamine) in excess water. The morphology as a function of temperature T and pressure p includes two lamellar phases (gel phase L_β and the liquid crystalline phase L_α) and the inverted-hexagonal (H_{II}) phase as shown in the p - T phase diagram below. Static measurements have shown the existence of additional phases at high pressure in the L_β phase regime (P.T.C. So, Thesis, Princeton University, 1992)



$\Rightarrow Q$

$(1,0) (1,1) (2,0) (2,1)$

$\leftarrow$ PRESSURE JUMP

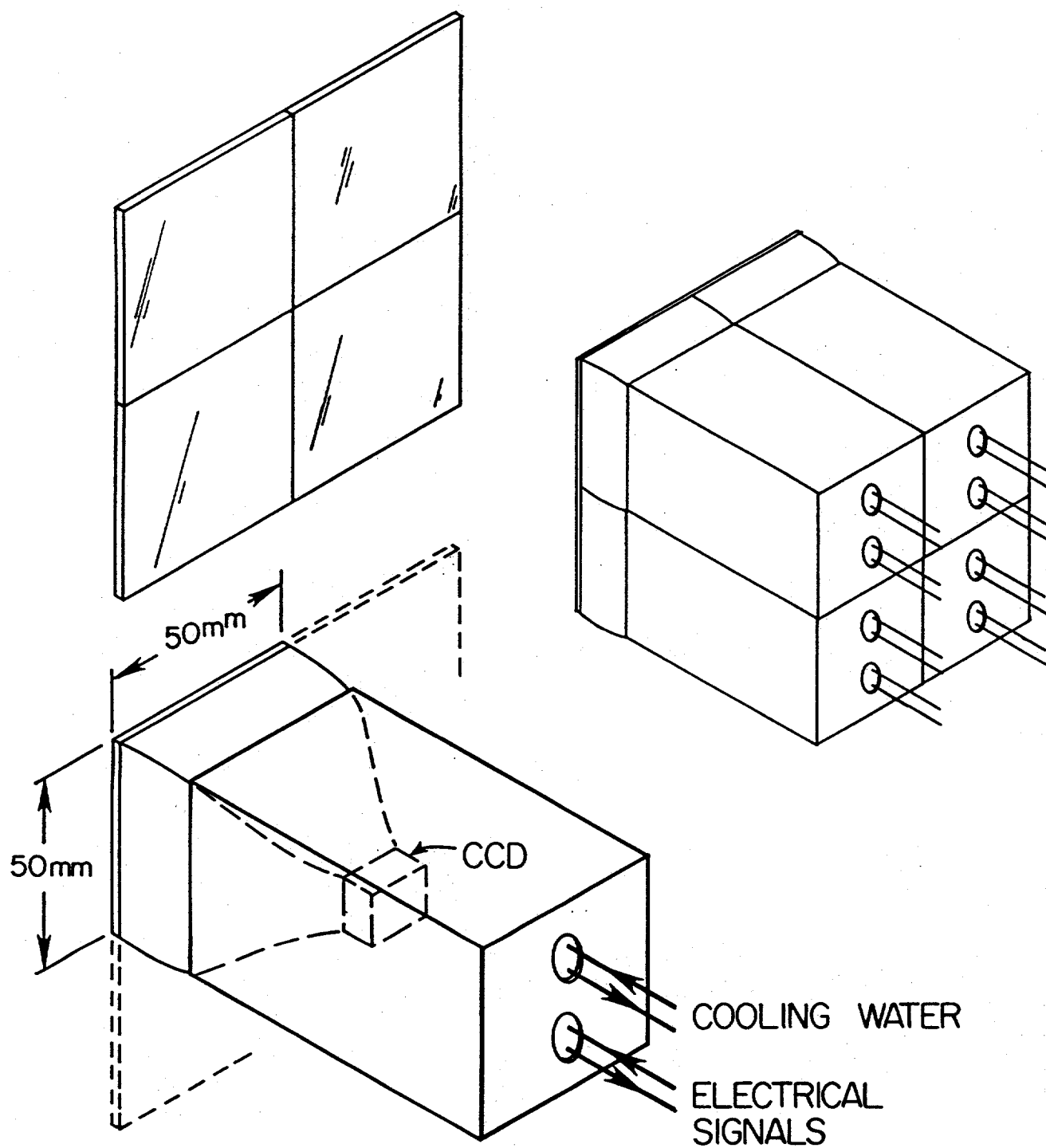
$\downarrow$ TIME

CTM100>: BOT= 894; TOP= 2000; PWR= .10

DOPE, EXCESS WATER, $H_D \rightarrow h_d$
 25°C, 102 BAR $\rightarrow$ 1935 BAR
 9 ms/LINE

(IM100) = 2 B00 894 TOP = 2000; PWR = .10

DOPE, EXCESS WATER, $L_{\alpha} \rightarrow H_{II}$
25 °C, 1895 BAR $\rightarrow$ 222 BAR
9 ms/LINE



MOSAIC CONCEPT

ADVANTAGES

- 1) AVAILABILITY OF PARTS
- 2) MPP-CCDs REQUIRE LESS COOLING
- 3) AREA AND FORMAT ARE UNLIMITED
- 4) FLEXIBLE GEOMETRY OF AREA
- 5) NO NEW BASIC TECHNOLOGY NEEDED
- 6) HOME LAB/NAT. LAB TRANSITIONS EASED

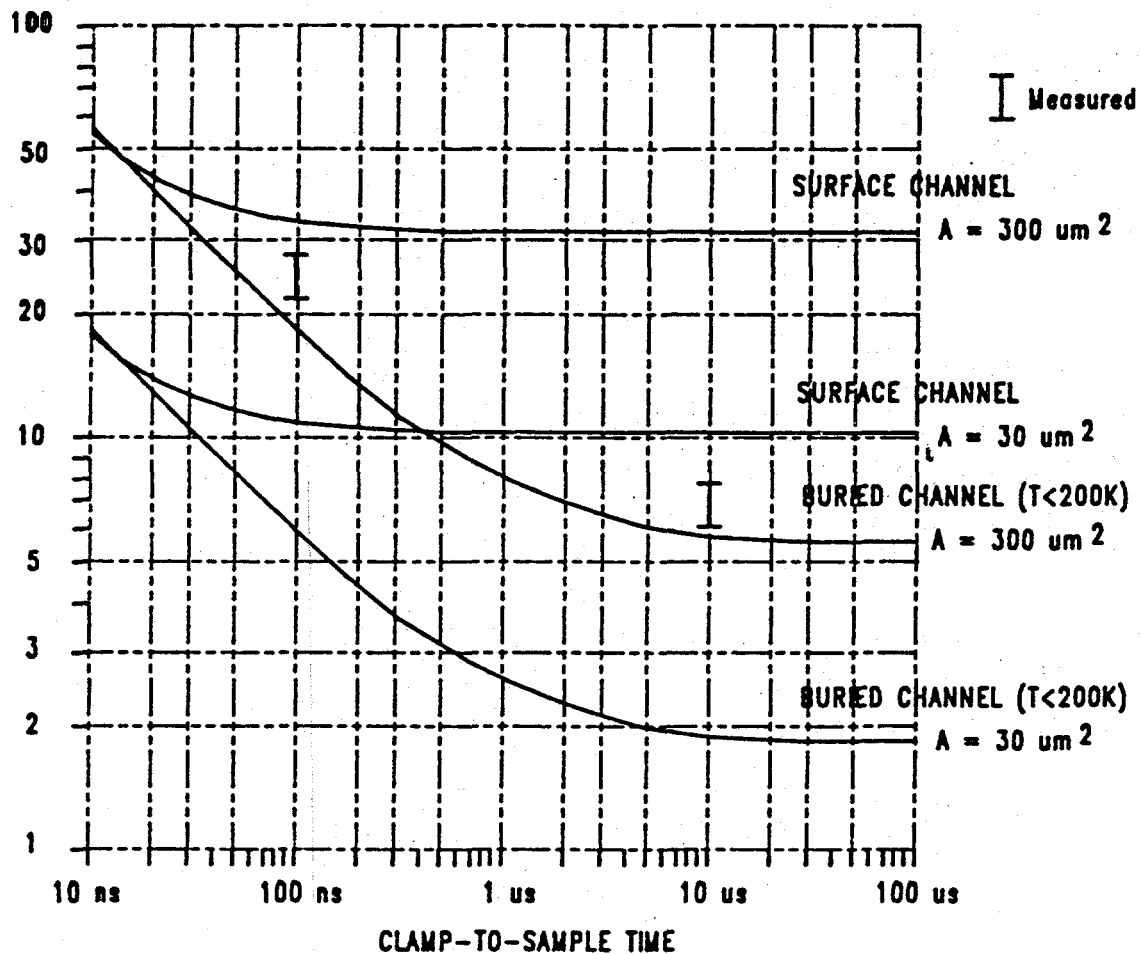
TO DO

- 1) PACKAGING
- 2) CONTROL ELECTRONICS
- 3) SOFTWARE INTERFACE
- 4) DATA HANDLING
- 5) CALIBRATIONS
- 6) COST CONTAINMENT

HOW FAST CAN WE DRIVE THE CCD?
1 MPX/SEC IS DIFFICULT, BUT FEASIBLE.

CCD OUTPUT AMP LIMITS

NOISE ELECTRONS rms



A = OUTPUT TRANSISTOR AREA.

$300 \mu\text{m}^2$ IS TYPICAL. IN PRACTICE 1 MHz
LOW NOISE OPERATION IS HARD TO ACHIEVE.

D.J. BURT

NIM A305 (1991) 564

NEEDED FUTURE WORK

- 1) BETTER PHOSPHORS**
- 2) IMPROVED FIBER OPTICS**
- 3) BETTER CALIBRATIONS**
- 4) BETTER DATA HANDLING METHODS**
(2000 x 2000 PIX/10 SEC) x (2 BYTES/PIX) x
(24 HRS/DAY) = 70 GBYTES/DAY
- 5) BETTER USER EDUCATION**
- 6) NEWER CCDs**
- 7) MOSAIC DEVICES AND STRATEGIES**
- 8) MORE BEAMLINER EXPERIENCE**

PRIMARY PARTICIPANTS:

SOL GRUNER -- PRINCETON U.

MARK TATE -- PRINCETON U.

ERIC EIKENBERRY -- RWJ MEDICAL SCHOOL

PETER EISENBERGER -- PRINCETON U.

JOHN SHEPHERD -- PRINCETON U.

SANDOR BARNA -- PRINCETON U.

MARTIN NOVAK -- PRINCETON U.

JOHN LOWRANCE -- PRINCETON SCI. INSTR.

STEVE EALICK -- CHESS

DON BILDERBACK -- CHESS

BRIAN RODRICKS -- APS

SUPPORT:

DoE -- MOSTLY

NSF -- A LITTLE BIT

FRIENDS.END

Istevan Naday

Argonne National Laboratory

and

Robert Street

Xerox

Amorphous Silicon-Based Imaging Detectors for Protein Crystallography

Two-dimensional amorphous silicon arrays have been developed in recent years primarily for liquid crystal displays and optical imagers. The novel aspect of the technology is the large size and low cost of the image sensor array. Present techniques allow an array size of about 10 in. x 10 in., but it is anticipated that 24 in. x 24 in. or larger will be possible in the future. Page size arrays with pixel sizes of $127\ \mu\text{m}^2$ have been made, although the technology is capable of even higher resolution. The arrays are made possible by the successful integration of field-effect thin film transistors (TFTs) and light sensors in large-area devices. Each pixel contains an amorphous silicon photodiode, connected to a TFT, controlled by the matrix of gate and data lines that cross the whole array. The parameters of the imager and readout electronics have been studied by computer simulation. The two most significant sources of the readout noise are the thermal noise of the "on" resistance of the TFT and the noise of the readout electronics. The simulation confirmed the already demonstrated 1000-2000 electron read noise figure. The intrinsic dynamic range of the imaging array is about 10^5 . The minimum readout time of about 25 msec allows real-time imaging.

X-ray images are obtained by exposing arrays that are in contact with a phosphor/scintillator. Contact imaging allows the imager to collect light very efficiently, making it well suited to x-ray imaging. Medical applications of this technology for imaging during radiation therapy, fluoroscopic, and radiographic procedures appear very promising. In protein crystallography, the large size and high conversion gain of the

imager will offset the effect of the higher read noise. The expected Detective Quantum Efficiency of a large-area amorphous silicon x-ray detector for protein crystallography will be better than 50%.

Amorphous Silicon Detectors for Protein Crystallography

Robert STREET,
Istvan NADAY,
Stephen ROSS,

XEROX Electronics Materials Labs.
ANL Electronics and Computing Technologies
ANL Electronics and Computing Technologies

APS Workshop

Detectors for Third-Generation Synchrotron X-Ray Sources

February 14-15, 1994
Argonne National Laboratory

Amorphous Silicon detectors for Protein Crystallography

- **Advantages compared to CCD detectors:**
 - much lower cost of basic detector
 - can be made physically large
 - no fiber optics, less spatial distortion
 - tolerant of higher dosages of radiation (direct detection)
- **Disadvantages**
 - limited availability -- its a new material
 - higher readout noise
 - larger pixels, lower resolution
 - concern over longterm stability of material
 - small amount of image lag

Goals of initial ANL a:Si-H Detector work

- Establish its reliability at a working protein crystallography synchrotron beamline.
- Perform basic studies of how the imager behaves
 - develop general performance (especially noise) models and measure device parameters
 - determine to effect of direct phosphor deposition
 - measure effects of temperature
- Get experience with the engineering aspects of making an a:Si-H detector
 - reliable connections to glass plate
 - trial designs and packaging of the many parallel readout amplifiers
 - possible integration of readout electronics using custom integrated circuited (e.g. MOSIS foundry)

Amorphous silicon has been previously used or proposed for various nuclear detectors.

- **U. Michigan/Xerox collaboration to develop the array for radiation oncology diagnostics (Antonuk et. al.)**
- **X-ray and beta detection with CsI + a-Si photodiodes (Fujieda et. al., Xerox)**
- **Neutron detection (proposed), (Miresighi et. al., LBL)**

Status of a:Si-H work at ANL

- **Models developed to predict performance of a -Si based detector for crystallography**
 - Analytical and PSPICE detector plus electronics noise models.
 - Spreadsheet to predict DQE, SNR given electronics noise, allow quick trades involving exposure times, detector placement, temperature.
- **Consideration given to layout of the detector**
 - electrical connection to the glass substrate
 - means to cool and support the array
- **Phosphor deposition studied**
 - deposition on array or on fiberoptic faceplate
- **Consideration given to readout electronics**
 - circuitry necessary to optimize readout to improve SNR via changes in filtering and timing
 - physical layout of the large numbers of readout amplifiers

Requirements for Protein crystallography drive the performance of the detector.

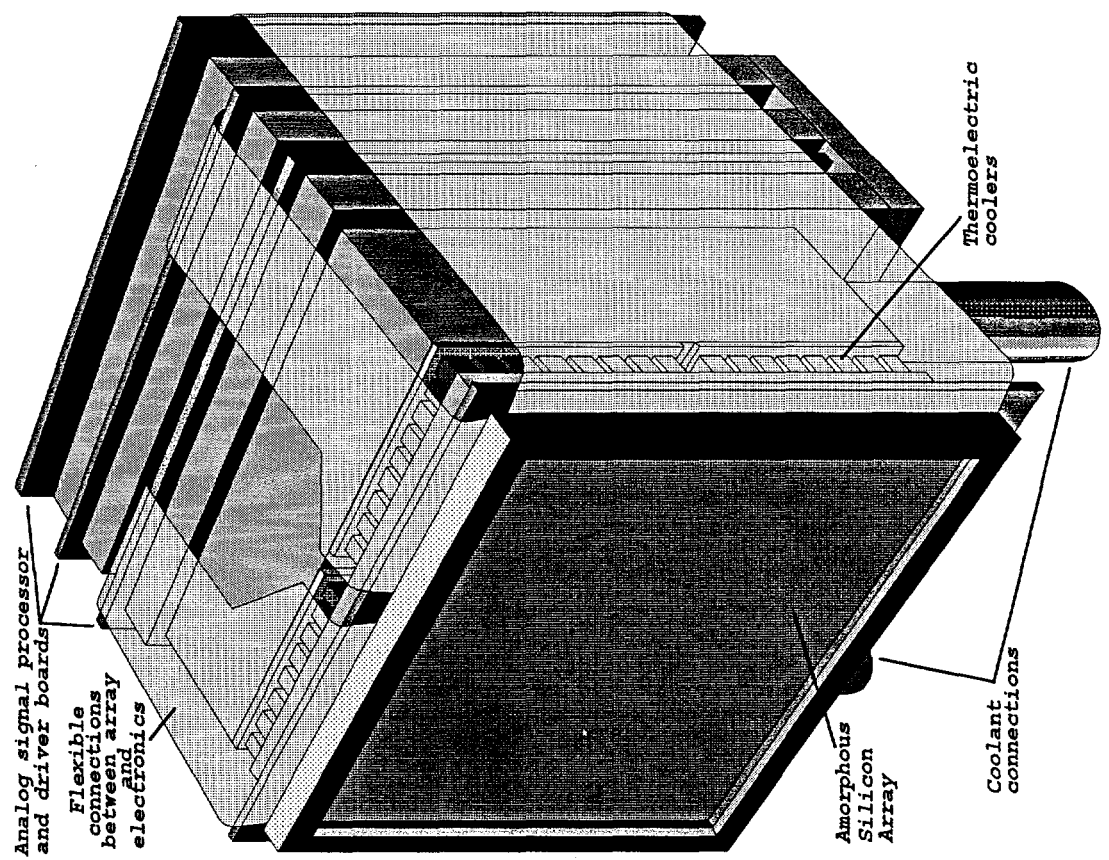
- **Crystal structure R factor requirement sets minimum SNR**
- **Total Radiation Dose to Crystal sets total exposure time to X-ray beam**
- **Crystal unit cell size sets pixel resolution**
- **Maximum Bragg angle of interest sets the total sampled area**

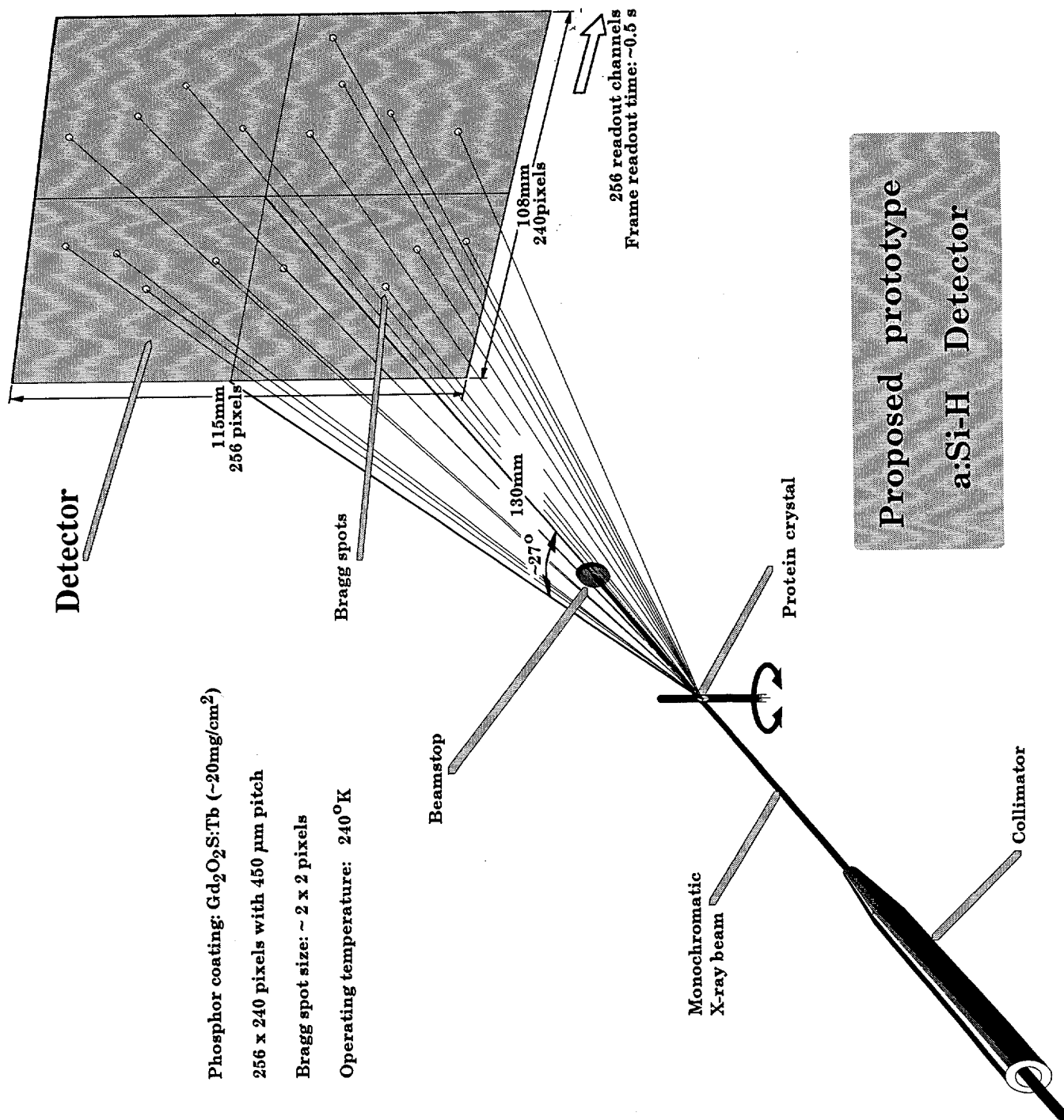
Dominant Noise Sources

- **Thin film a:Si-H FET “on” resistance thermal noise during reset of the sensor capacitance (kTC noise)**
 - may be removed by double sampling of video at the expense of additional operational amplifier read noise.
- **Thin film FET “on” resistance thermal noise during the readout of the sensor charge (modified by readout bandwidth)**
 - may be filtered at the expense of circuit complexity
- **Operational amplifier voltage read noise.**
 - may be filtered at the expense of circuit complexity

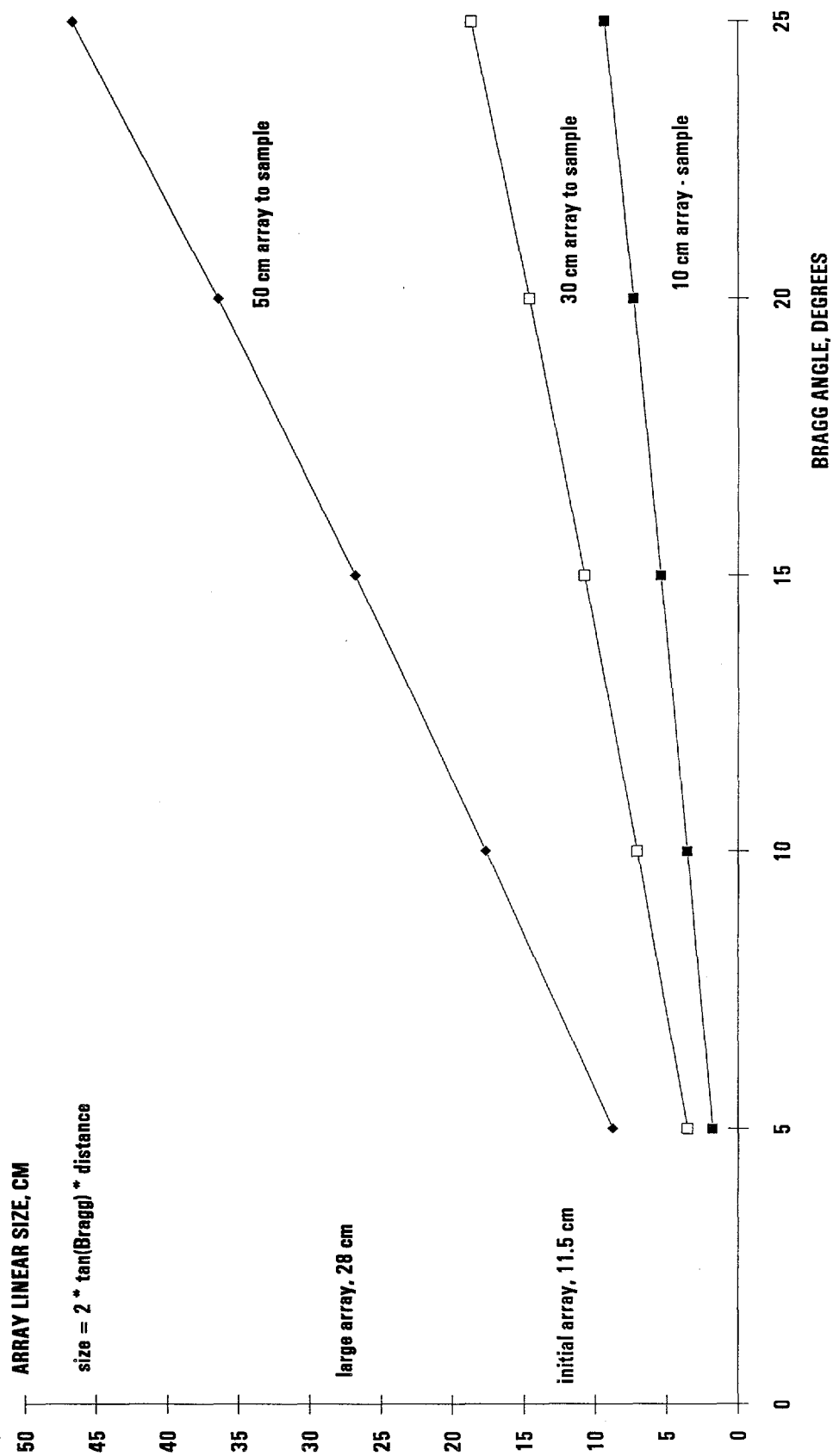
Gold CCD vs. a:Si-H

• array size cm	15	28
• pixel size, um	50	120
• xray/sec/pix	50	120
• exposure time, sec	1	3.5
• exposures/xtal	3.5	1
• signal in, xrays	50	420
• electron out/xray in	13.2	188
• electron out/pixel	660	78000
• electronic noise/pixel	15	3000
• binning of pixels	5x5	2x2
• binned signal out, electrons	16500	314000
• binned electronic noise eRMS	75	6000
• binned dark electrons	150	1100
• noise w/o electronics eRMS	525	11800
• total noise out eRMS	530	13300
• SNR out (Binned pixels)	31	24
• SNR in (Binned pixels)	35	41
• DQE (Binned pixels)	.77	.33

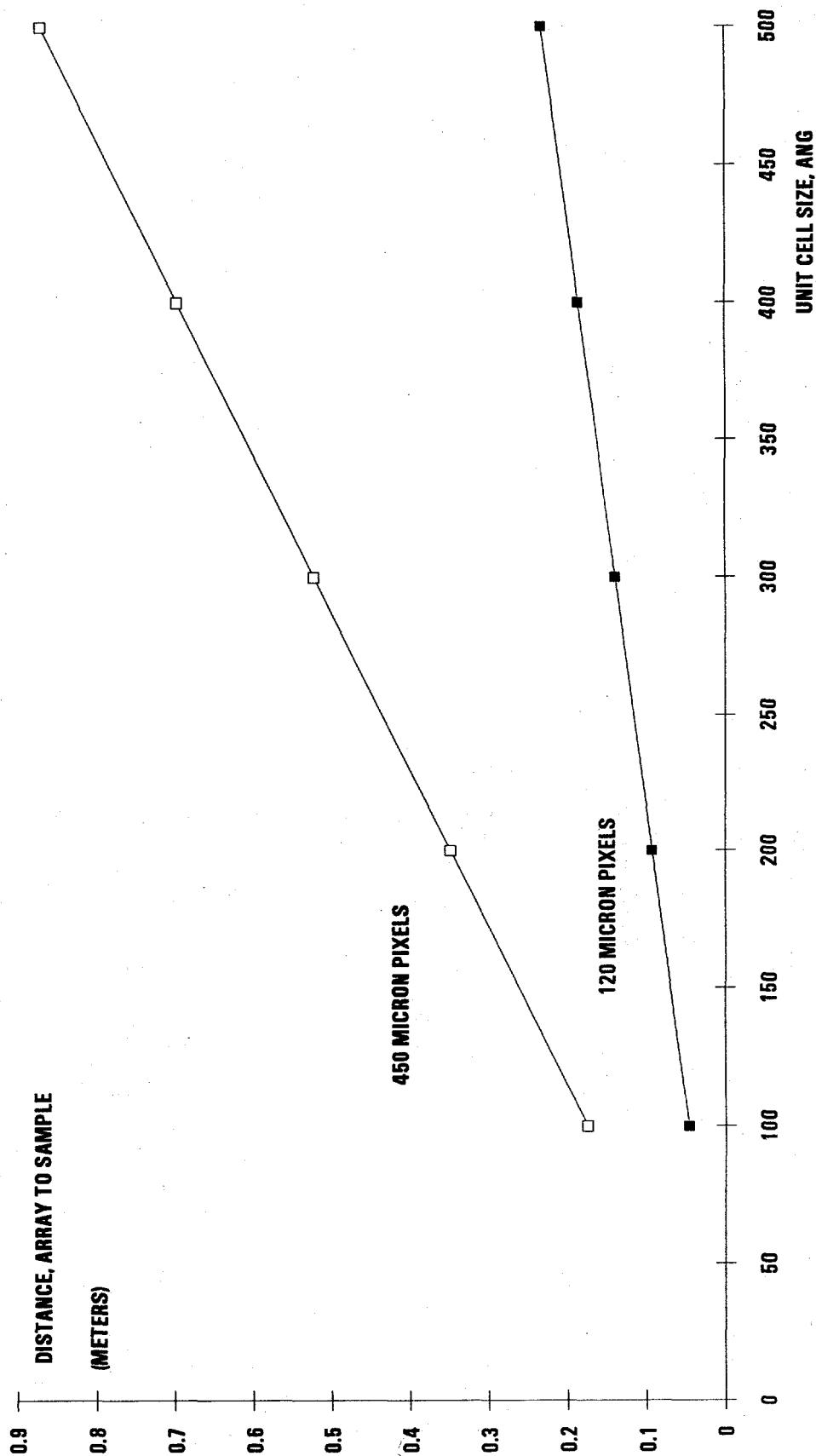




ARRAY SIZE FOR FULL COVERAGE

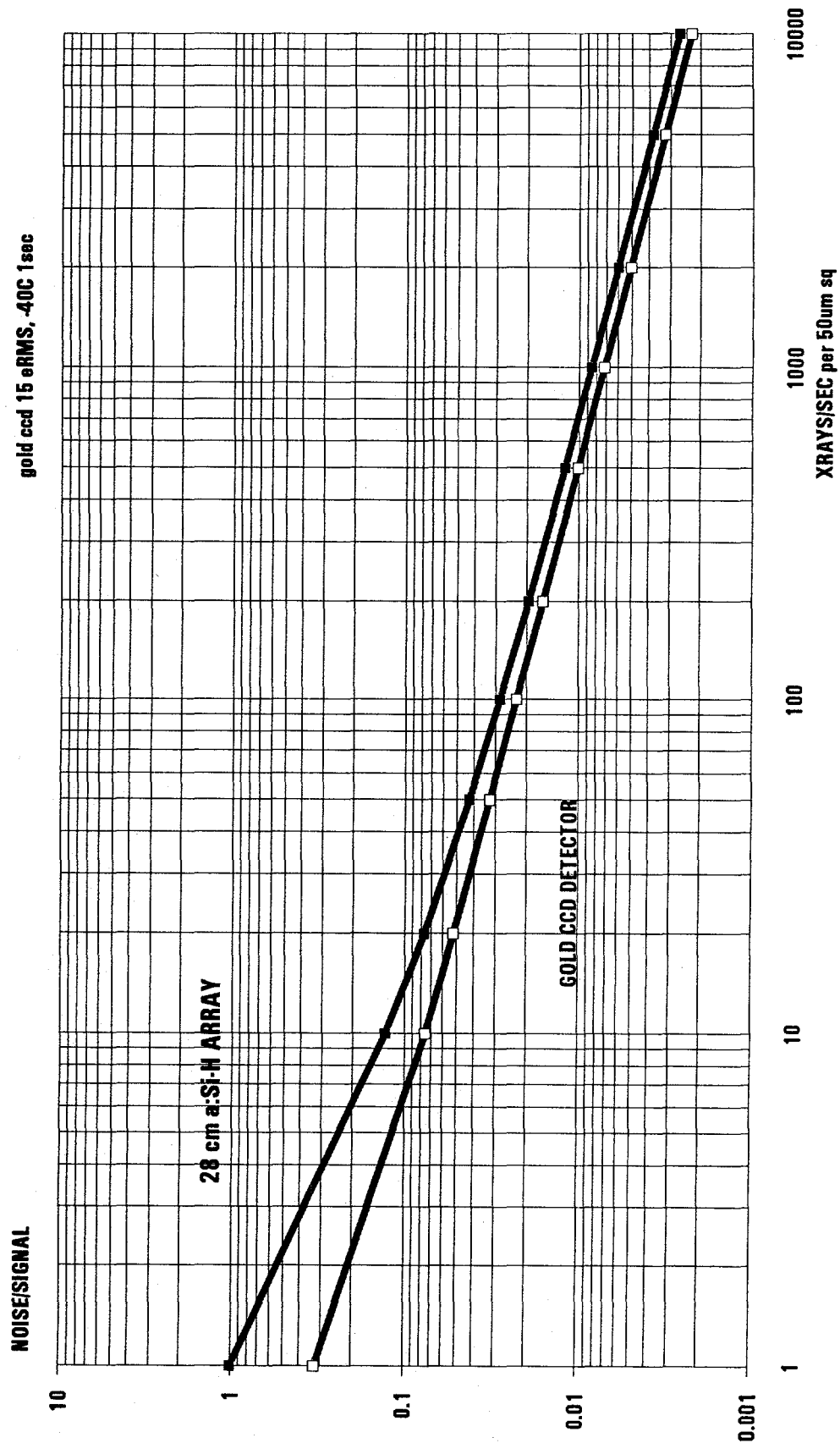


TO RESOLVE LARGER UNIT CELLS, ARRAY MUST BE MOVED BACK
(RESOLUTION MEANS 4 PIXELS BETWEEN BRAGG PEAKS)



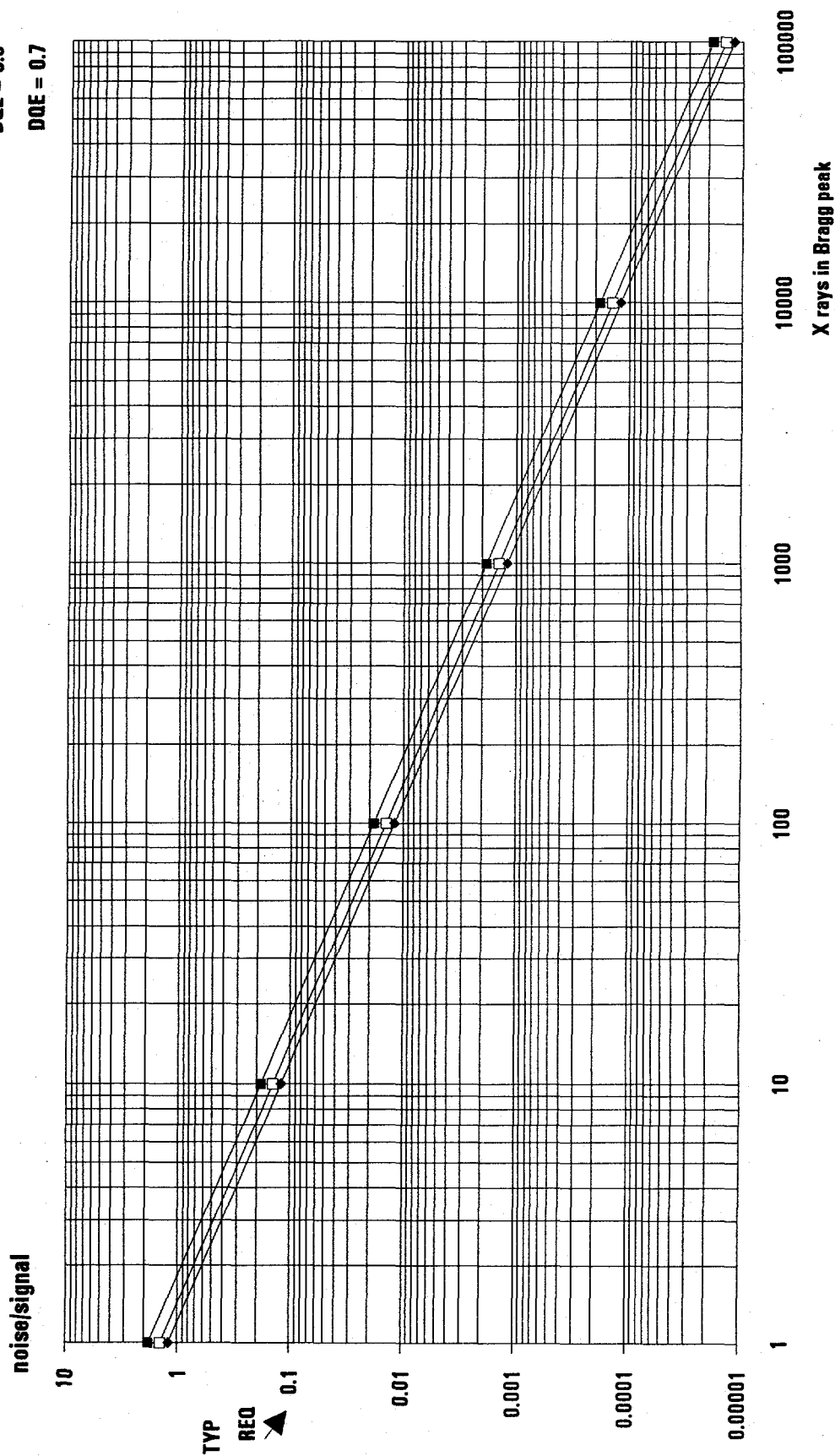
noise out/signal out

aSiH: 3000 eRMS, -40C 3.5 sec 28cm
gold ccd 15 eRMS, -40C 1sec

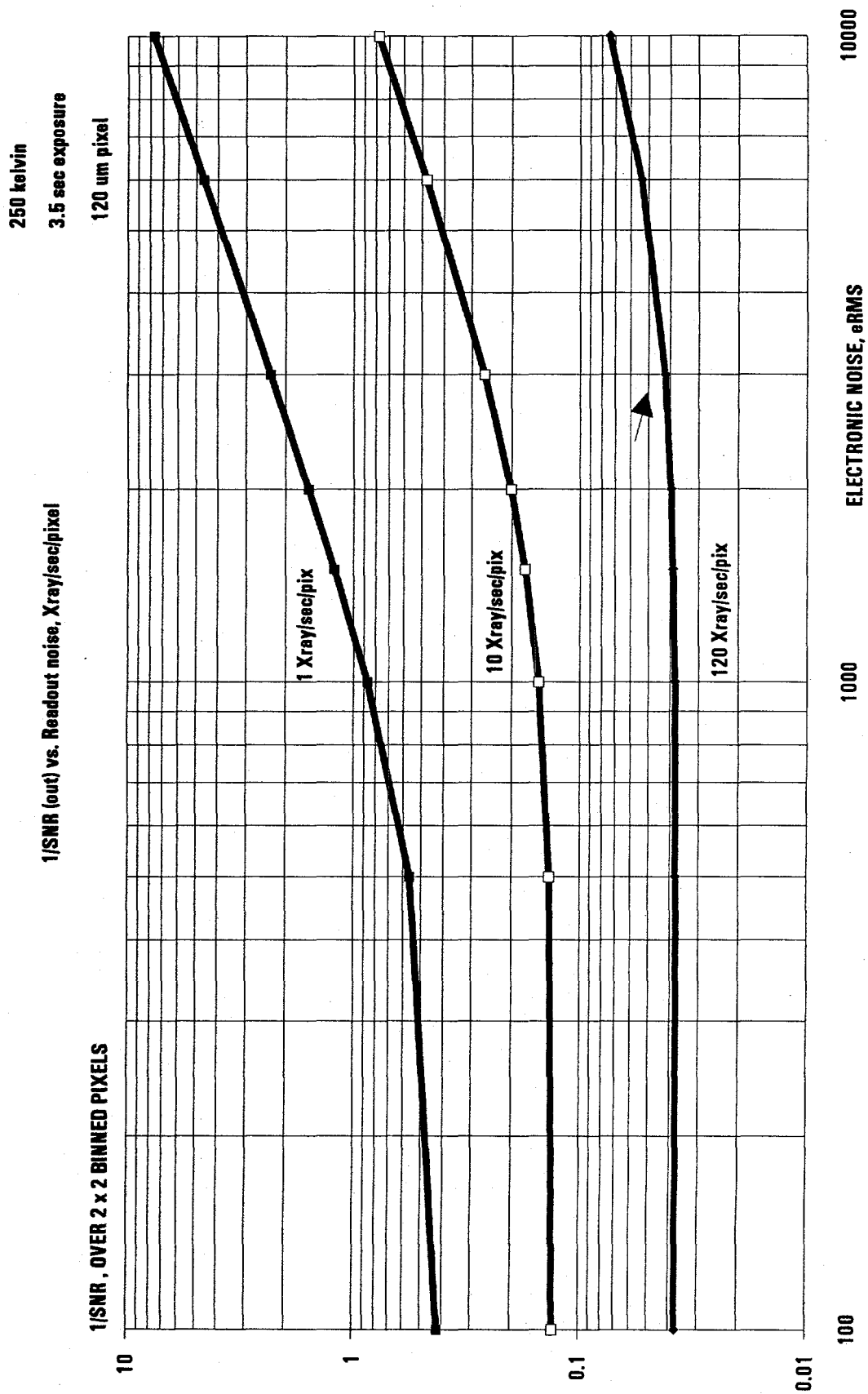


Relative Variance is determined by Xray counts and DQE

DQE = 0.3
DQE = 0.5
DQE = 0.7



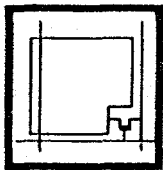
AMOR10.XLS Chart 30



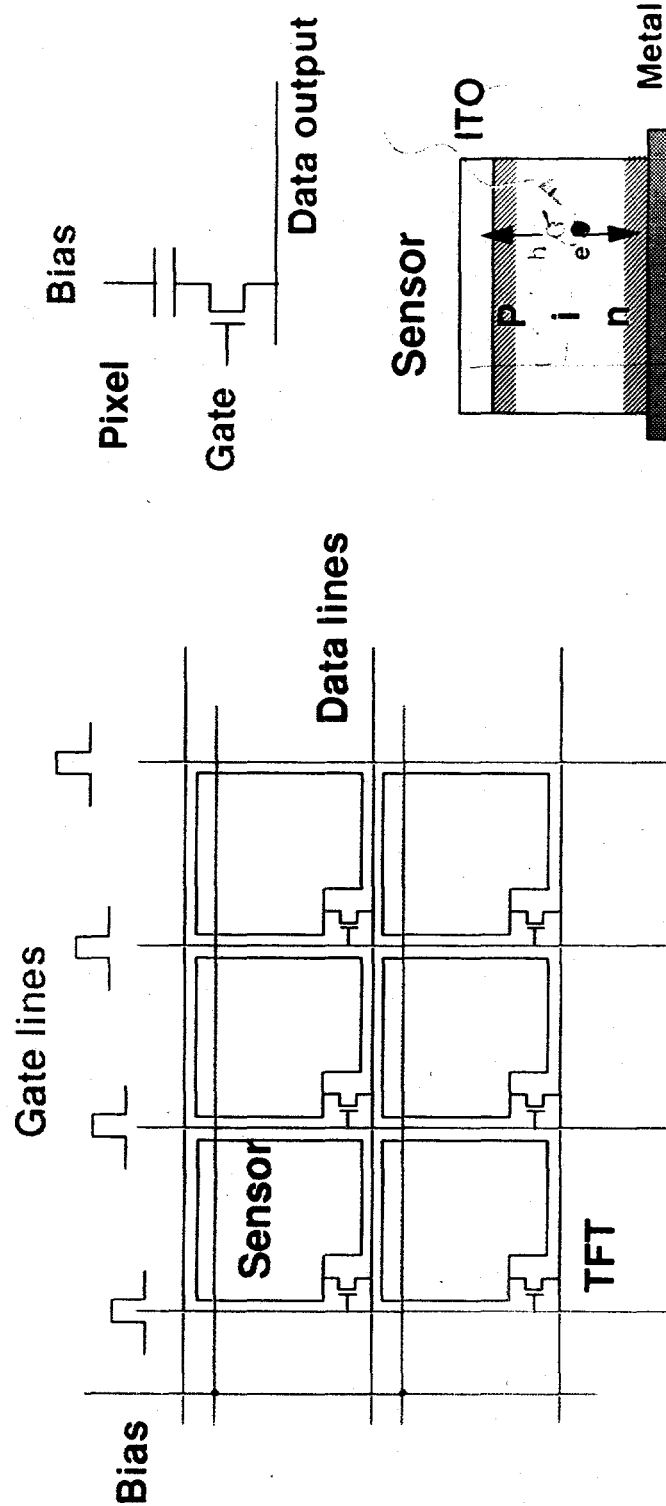
Amorphous silicon detectors

Bob Street, Xerox PARC; Steve Naday, ANL

- Large area amorphous silicon matrix addressed arrays
- Applications to Protein Crystallography



The Sensor Array is Matrix Addressed



The same addressing structure is used for:

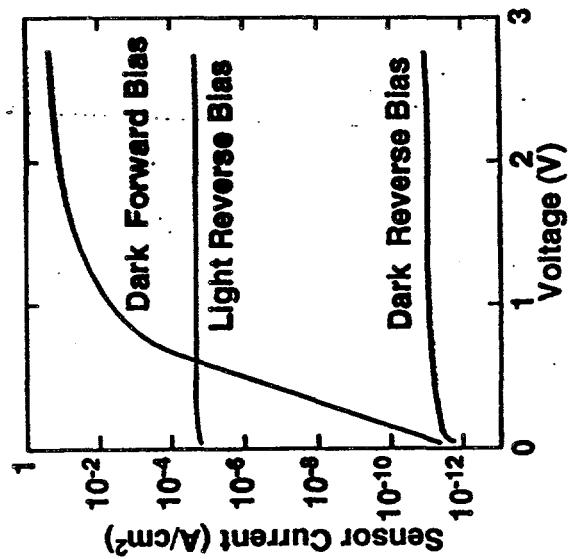
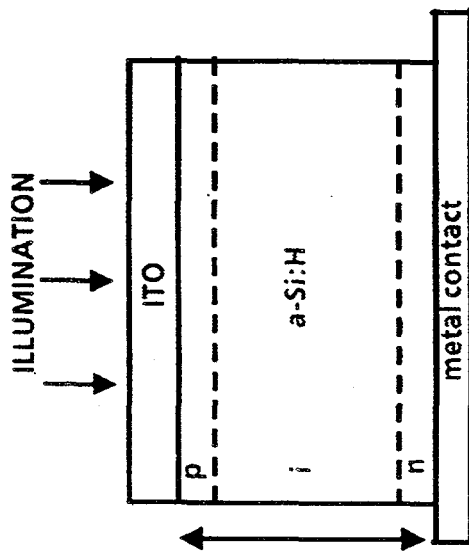
- Liquid crystal display
- Optical imagers
- Linear arrays (FAX)

XEROX
PARC

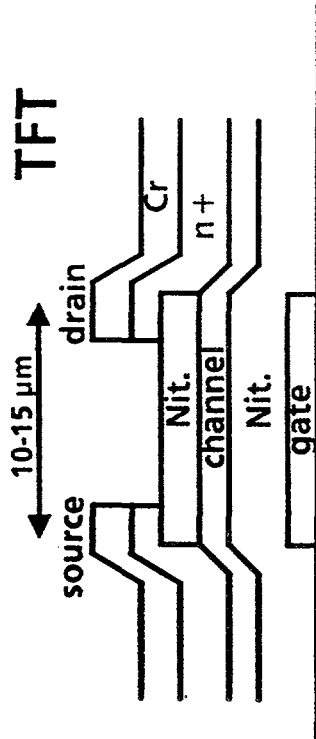
Electronic Materials Laboratory

Amorphous silicon devices

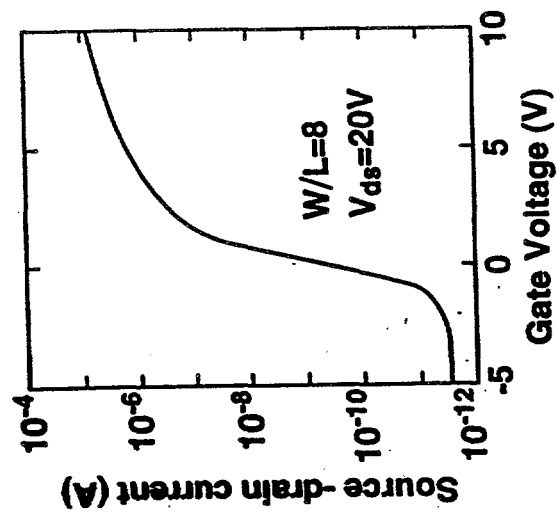
sensor

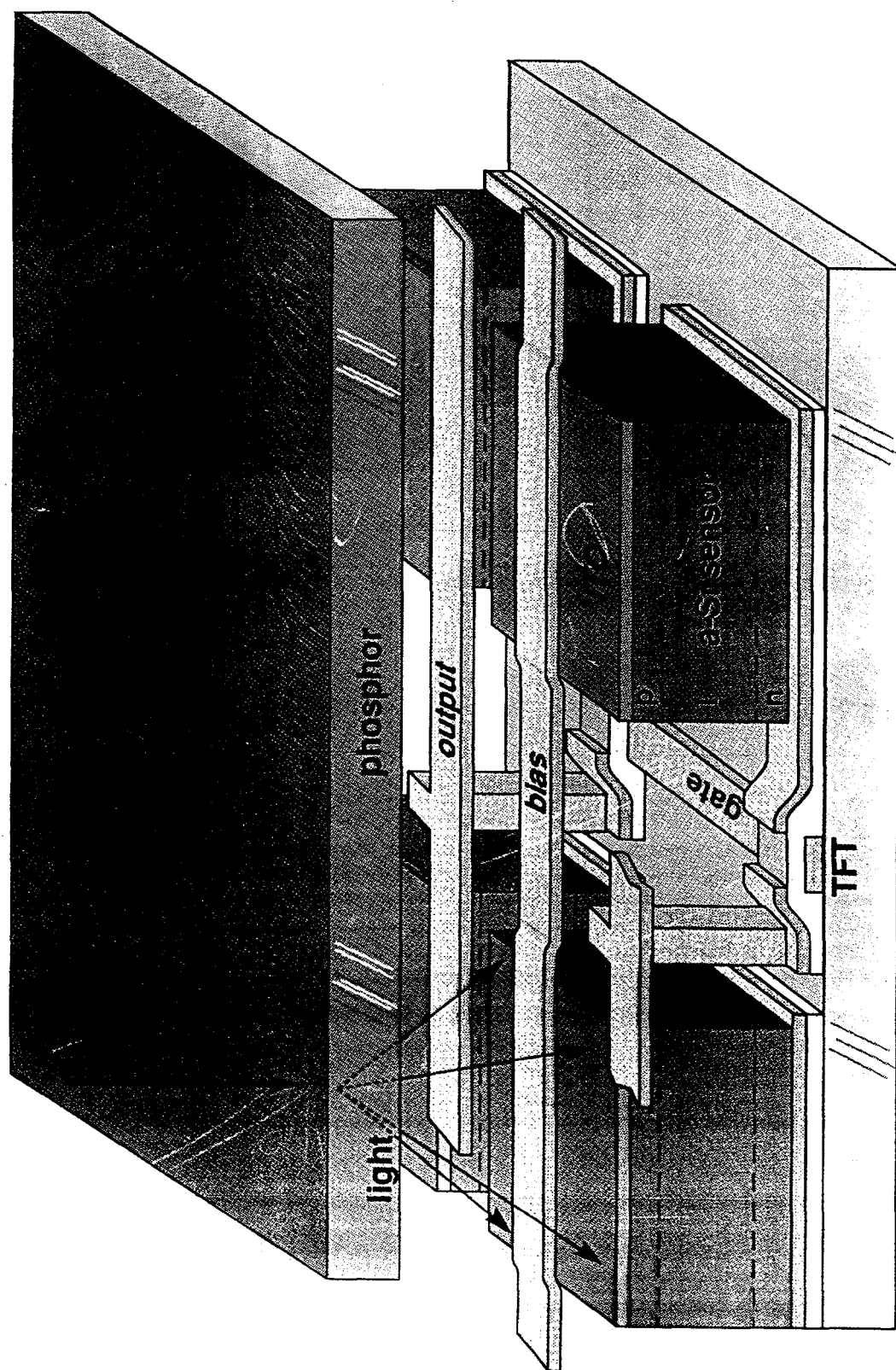


TFT

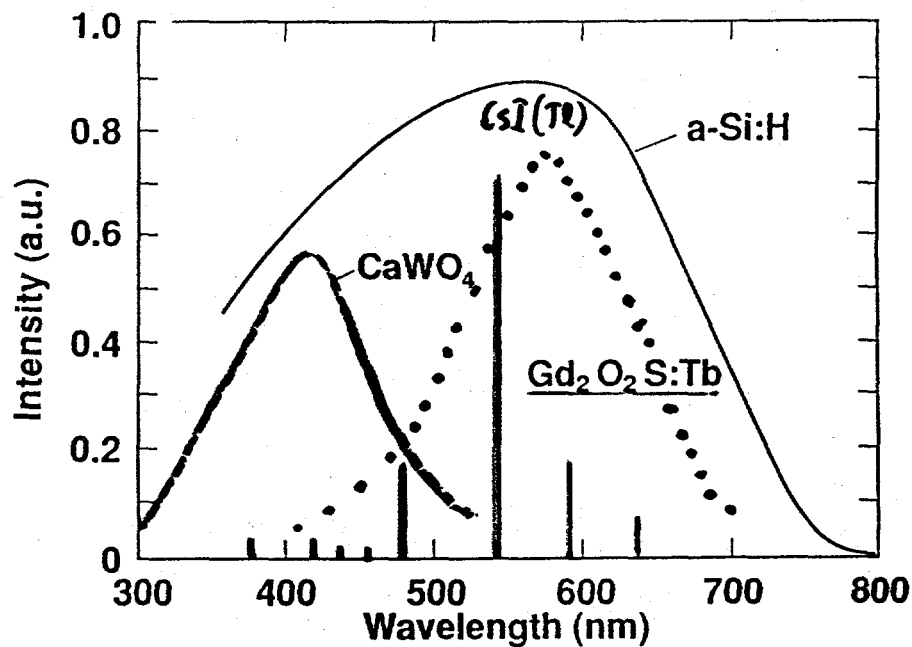


n-channel accumulation mode
mobility $0.5-1.0 \text{ cm}^2/V\text{sec}$





Emission spectra of phosphors



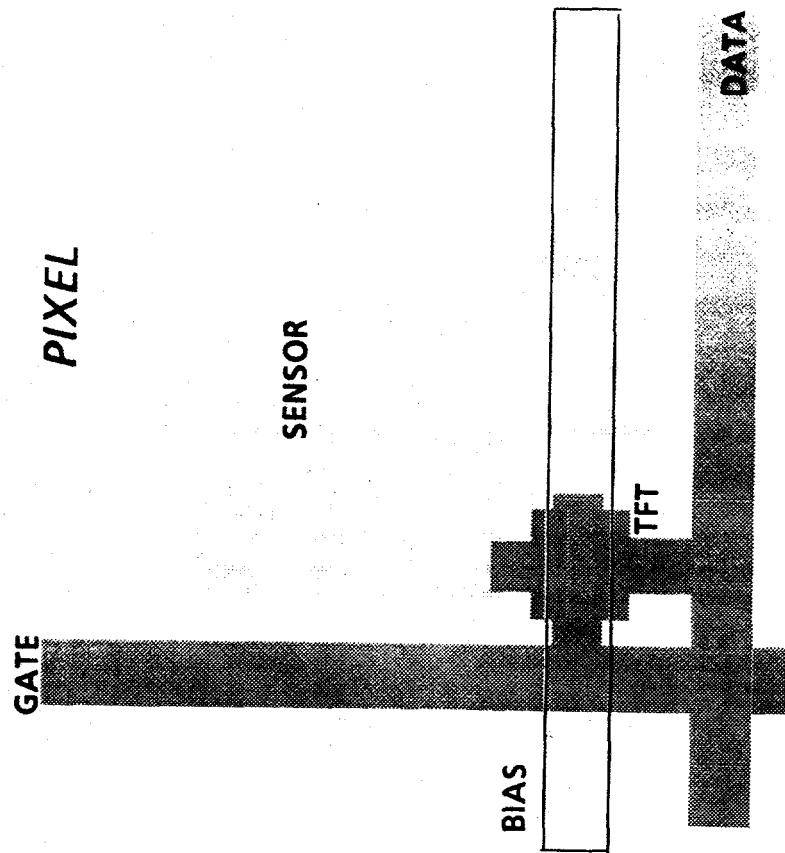
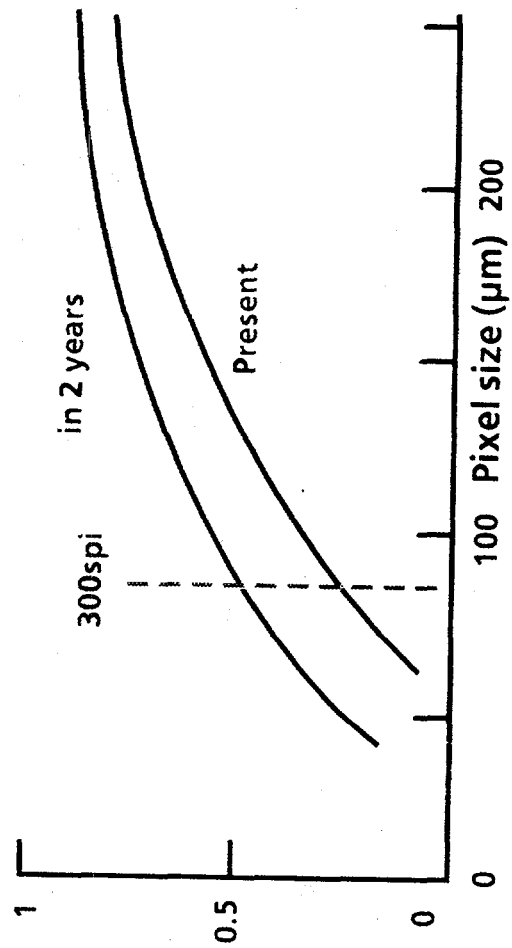
- Gd₂O₂S:Tb is well suited to the a-Si:H collection efficiency spectrum
- Alternative phosphors include, CsI, NaI and many others

Pixel design

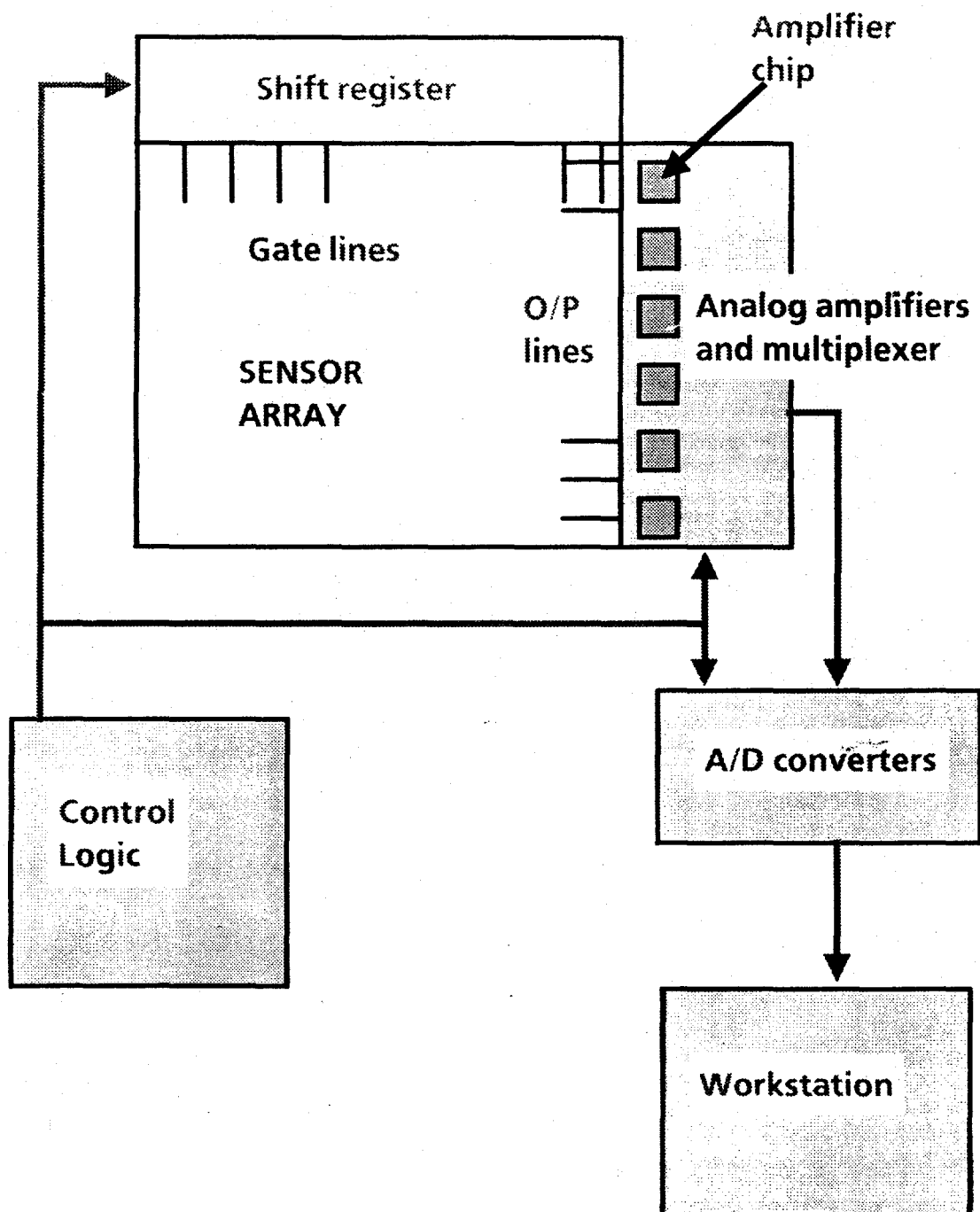
For higher resolution:

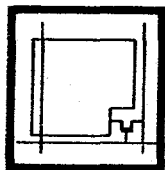
- reduced design rules
- sensor over metal lines

Sensor
Fill
Factor



Imaging system

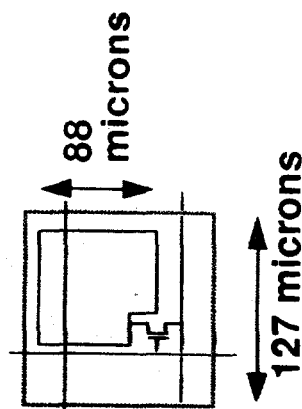




Specifications of a 200 spi Array

Physical:

Array size: 7.7" x 9.6"
Number of pixels: 1536 x 1920
Sensor fill factor: 36%
Transparent region: 20%

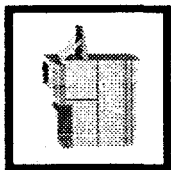


Electrical:

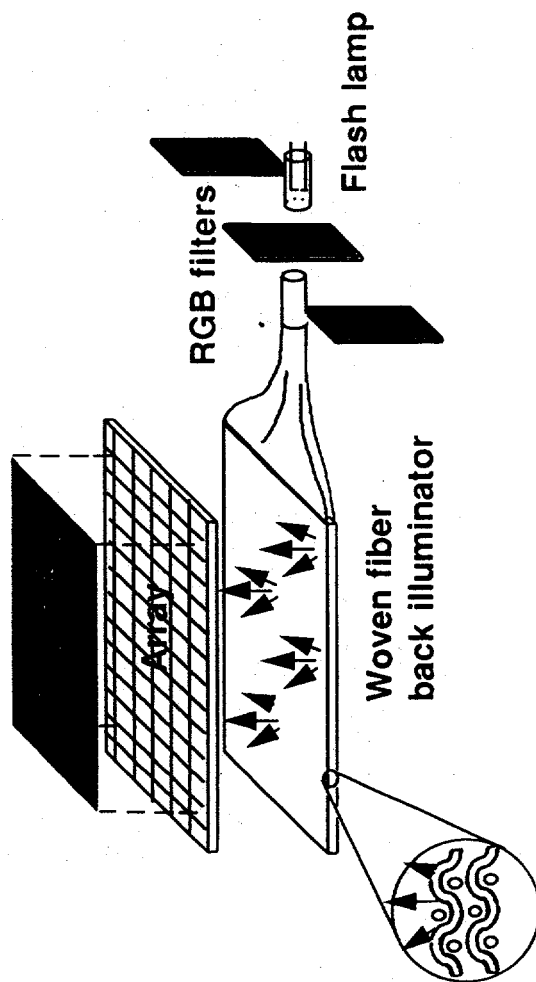
Sensor capacitance: 0.8 pF
Max pixel charge: 4 pC $\sim 1 \text{ cd/m}^2$ in light intensity
TFT on-resistance (10V): 4 MOhm
Array frame time: $1920 \times 5 R_{\text{on}} C_{\text{sens}} = 30 \text{ msec}$
 $\rightarrow 33 \text{ pages/sec}$
Sensor dynamic range: $10^4 \sim 10^5$
System dynamic range: 500 $\sim$ 1000
Responsivity uniformity: 10%

XEROX
PARC

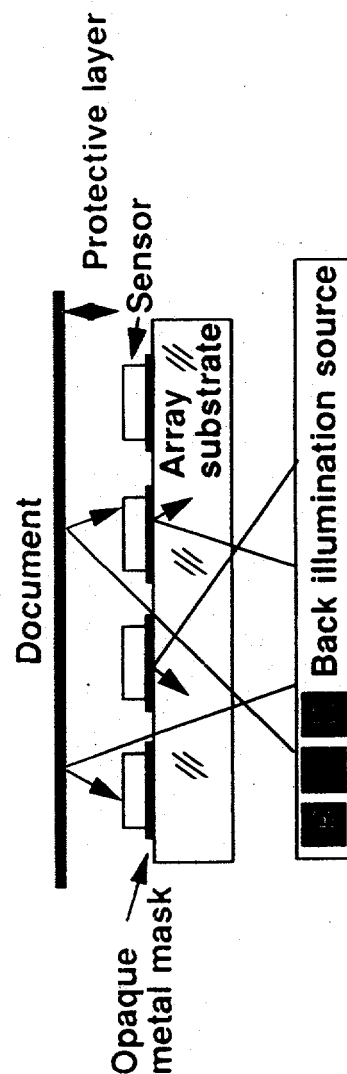
Electronic Materials Laboratory



Back Illumination Allows Contact Imaging



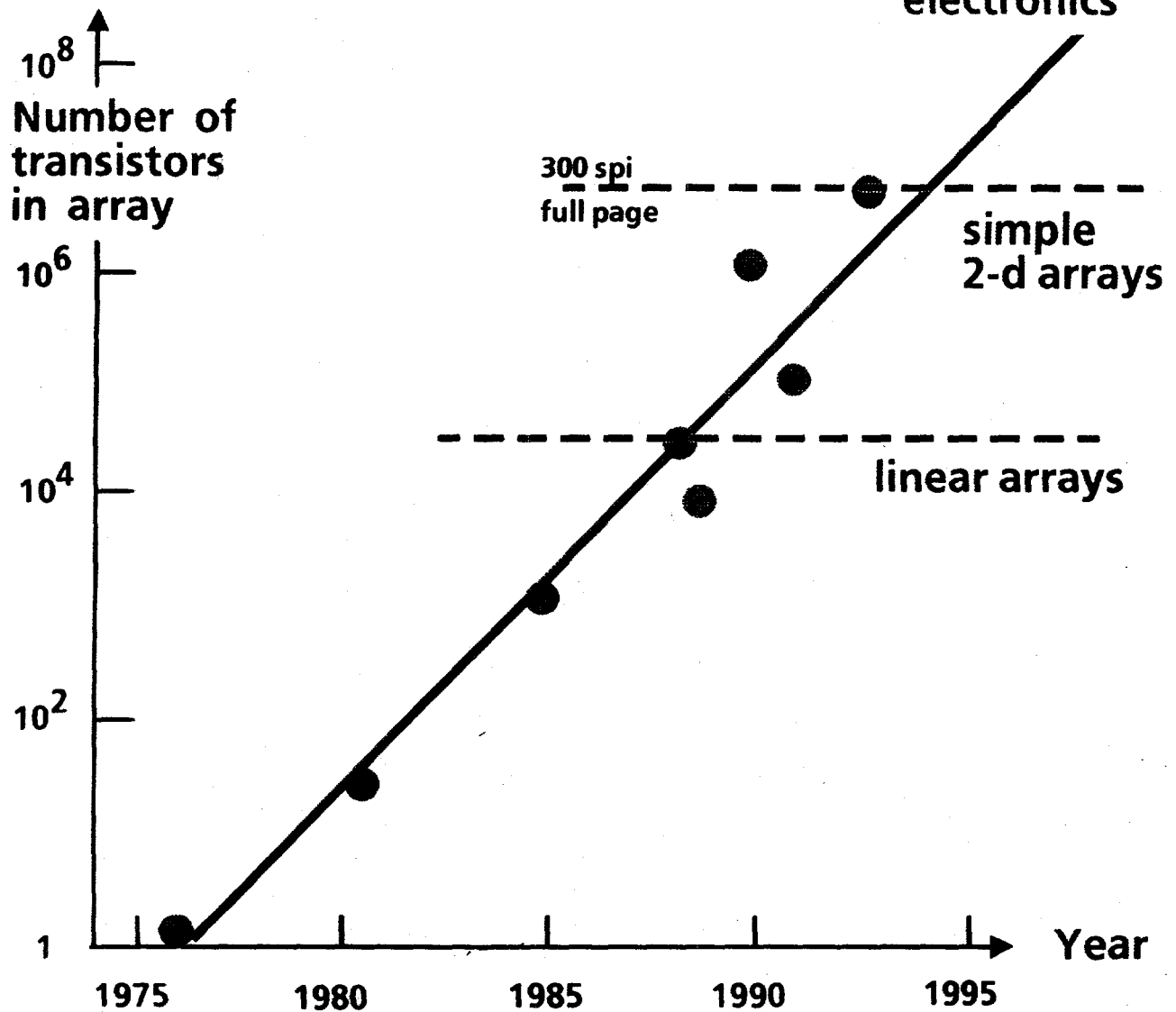
- Illumination through transparent glass substrate and between sensors.
- Contact imaging has an efficient optical transfer.



XEROX
PARC

Electronic Materials Laboratory

Technology progression



Pixel electronics;

Amplifiers, image processing, 3-d structures

EML/EIL
PARC

Wladek Minor

Purdue University
Department of Biological Sciences

**Crystallographic Data Handling and Reduction in Experiments
with Extremely High Data-Acquisition Rates**

As in many experimental sciences, data acquisition and data processing are often the most critical steps in x-ray crystallographic studies and dictate the success or failure of the entire process. The successful synchrotron experiment requires high photon brilliance, a very fast x-ray detector, and a computing environment that can handle very high rates of data collection effectively. Although data acquisition may not be computationally intensive even for very high data-acquisition rates, the experiment evaluation procedures and robust data reduction at rates comparable to the data collection rate will require not only a very fast computer but also software designed for the synchrotron environment.

In anticipation of an increase in data-acquisition rates due to more intense synchrotron sources and new fast detectors, modular software tools should be developed with the goal of speeding up the entire crystallographic experiment and optimizing the use of beam time. The software modules should be unified by a flexible, rapid and easy to use graphical user interface. These modules should provide the ability to evaluate and control a crystallographic experiment in conditions close to real time, at all currently expected rates of data acquisition. Among the most important tools will be those that allow the rapid evaluation of diffraction images, fast crystal alignment and/or indexing, and real-time reduction of two- or three-dimensional diffraction data to indexed intensities. The effective management of the very high rate of data acquisition, experimental data base setup and access, long-term data storage, and effective use of networking must also be addressed.

Wild West approach:

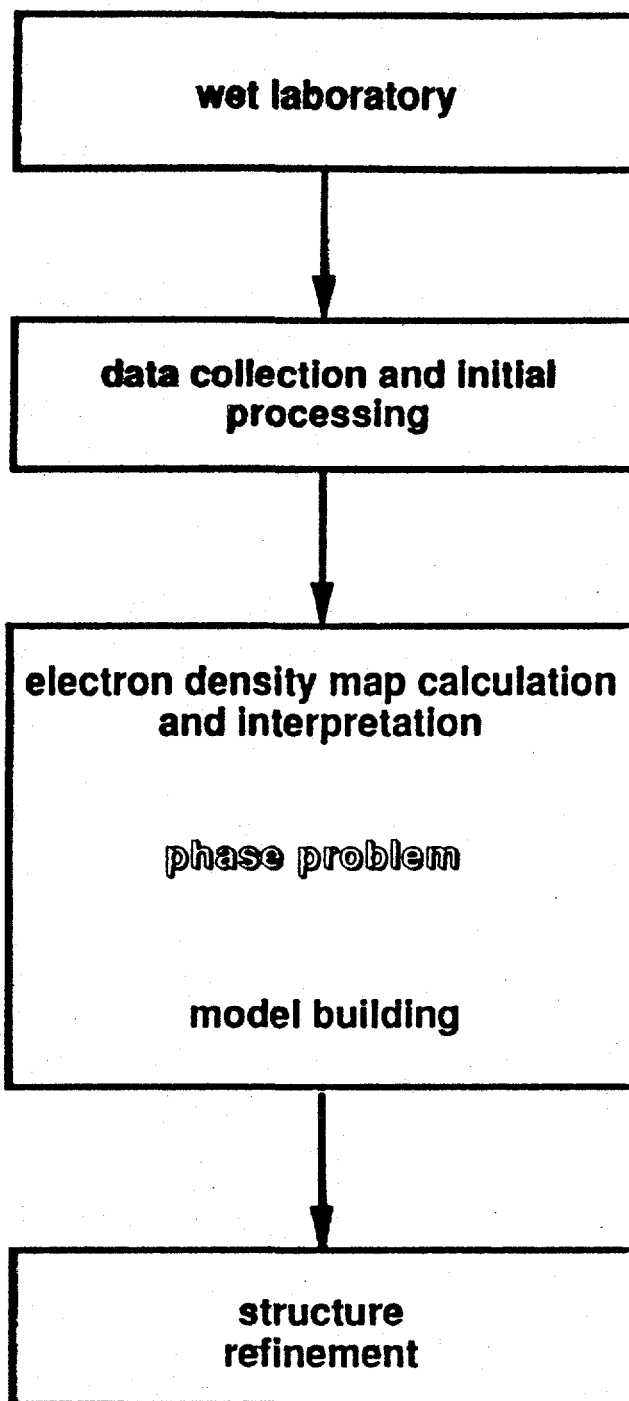
Shoot first and ask questions later.

Let them shoot crystals and send them home with data (any data)
and they will ask themselves questions later (when at home).

East coast approach:

W. Hendrickson (Science 254(1991)54) :

The challenge is to produce at existing and developing synchrotron sources both the necessary instrumentation and also convenient modes of access and use. A long-awaited trip to the synchrotron used to yield packs of films to be processed; now one can return from a few synchrotron centers with processed diffraction amplitudes. In the future, the hope is to return from an on-call trip to one of several MAD beam lines with both the amplitudes and phases needed to solve another exciting biological problem.



Software role from the synchrotron user point of view:

Design of Experiment

Data acquisition

evaluation and on the fly monitoring

reduction - *in real time*

storage and/or transmission

User requirements:

Instrument and experiment independent

Computer independent

Network transparent

User friendly graphical interface

The strength of the chain is determined by it's weakest link

Detector from the software point of view:

Low intrinsic noise

High spatial and time resolution

High dynamic range

Reproducibility

Software has to understand the nature of the detector hardware

Software type of calibration

COMPUTING STANDARDS at APS

The hallmark of computing environment is FLEXIBILITY.

- modular and powerful computing tools for very convenient, rapid control and monitoring of the experiment**
- effective management of the very high rate of data acquisition**
- easily adaptable**
- easy addition of new features by people other than the program author**
- operating system independent, powerful and easy to use user interface**
- portable to a "standard" laboratory environment**
- flexible to the rapidly advancing computer industry**
- real-time computer response
store and reliably process diffraction data at a rate
comparable to the rate at which they will be recorded.**

This is one of the biggest challenges of the computing effort, and it can not be seen as a substitute for storage of raw data images.

USER INTERFACE

Powerful user interfaces that allow the user to concentrate on the experiment with minimal concern about how to run the support software.

- management of the experiment**
- rapid, graphical and flexible**
- flexibility for addition of new experiments.**
- ability to interact with all phases of the experiment**
 - crystal evaluation and alignment,**
 - set-up and running of data collection**
 - on line experiment monitoring**
 - real-time data processing**

MANAGEMENT OF THE EXPERIMENT

- **Extremes of organization**
- **electronic notebook for the experimenter.**
- **some information from the database of the APS**
- **Example of items**
 - **time and date**
 - **ring current and energy**
 - **wavelength or wavelength range**
 - **settings of insertion device**
 - **positions and settings of beamline optical elements**
 - **type and Bragg reflection of the monochromator crystal**
 - **positions of slits, attenuators and filters in the beam**
 - **shutter condition**
 - **instrument alignment angles**
 - **incident beam intensity**
 - **detector count rate**
 - **position of the beam and beamstop**
 - **hutch temperature**
 - **actual and set temperatures for sample cooling**
 - **Helium and cooling gas flows to the experiment**
 - **instrument angles at the aligned position of the sample**
 - **instrument setting**
 - **angular range and scan speed for the current image**
 - **exposure time and dose of current image**
 - **fiducial marking on the image.**

Ideal data reduction package:

Source	-	any
Crystal	-	any space group any cell dimensions (5 - 2000 Å)
Diagnostics	-	everything
Feedback	-	real time
Speed	-	real time
Goniostat	-	any
Detector	-	any
Computer	-	any (with full graphics support)
OS	-	any
Cost	-	public domain

Data processing:

MADNES

MOSFILM

XENGEN - POLYDET

XDS

OSC

DENZO

HKL package:

Denzo

Xdisplayf

Scalepack

Tasks:

Indexing

Calibration

Prediction

Refinement

Integration

Processing time:

Lipoxygenase (2.1 Å)

MAC-Science scanner: 180/25 sec/frame
(95.6, 94.3, 50.3, 90.0 91.3, 90.0)

Rotavirus (8.0 Å)

FUJI scanner (CHESS): 180/40 sec/frame
(692, 993, 1395, 90, 90,90)
Steve Harrison - Brenda Temple

Bovine PNP (1.7 Å)

CCD detector (CHESS): 180/50 sec/frame
(92.7, 92.7, 92.7, 90, 90, 90)
Steve Ealick

primitive cubic	44.52%	82.59	82.59	82.59	90.00	90.00	90.00
		50.29	94.11	95.29	90.02	91.45	89.95
I centred cubic	38.72%	116.46	116.46	116.46	90.00	90.00	90.00
		106.74	106.61	133.91	128.87	127.68	77.78
F centred cubic	25.82%	142.76	142.76	142.76	90.00	90.00	90.00
		142.22	143.86	142.19	96.45	97.13	138.83
primitive rhombohedral	44.52%	82.59	82.59	82.59	89.64	89.64	89.64
		50.29	95.29	94.11	89.98	89.95	88.55
primitive hexagonal	15.27%	101.11	101.11	94.11	90.00	90.00	120.00
		106.61	95.29	94.11	89.98	89.99	151.86
primitive tetragonal	1.25%	94.70	94.70	50.29	90.00	90.00	90.00
		94.11	95.29	50.29	91.45	90.05	89.98
I centred tetragonal	8.17%	138.11	138.11	50.29	90.00	90.00	90.00
		142.19	133.91	50.29	89.00	109.64	89.68
primitive orthorhombic	0.59%	50.29	94.11	95.29	90.00	90.00	90.00
		50.29	94.11	95.29	90.02	91.45	89.95
C centred orthorhombic	0.74%	133.91	133.94	50.29	90.00	90.00	90.00
		133.91	133.94	50.29	91.07	89.00	90.72
I centred orthorhombic	5.92%	50.29	133.91	142.19	90.00	90.00	90.00
		50.29	133.91	142.19	89.68	70.36	91.00
F centred orthorhombic	5.20%	50.29	194.78	195.87	90.00	90.00	90.00
		50.29	194.78	195.87	93.44	103.42	75.08
primitive monoclinic	0.02%	50.29	94.11	95.29	90.00	91.45	90.00
		50.29	94.11	95.29	90.02	91.45	89.95
C centred monoclinic	0.66%	133.94	133.91	50.29	90.00	91.07	90.00
		133.94	133.91	50.29	91.00	91.07	89.28
primitive triclinic	0.00%	50.29	94.11	95.29	89.98	88.55	89.95
autoindex unit cell		50.29	94.11	95.29	90.00	91.45	90.00
Volume of the primitive cell		450846.					
Autoindex Xbeam, Ybeam		99.38	99.82				

primitive cubic	34.86%	1209.381209.381209.38	90.00	90.00	90.00
		1205.861395.00 993.82	89.89	144.93	89.99
I centred cubic	33.06%	1607.821607.821607.82	90.00	90.00	90.00
		1697.311395.001711.25	144.50	109.67	89.91
F centred cubic	28.18%	1845.381845.381845.38	90.00	90.00	90.00
		1848.271844.171843.71	81.68	114.86	135.91
primitive rhombohedral	16.47%	1560.631560.631560.63	37.04	37.04	37.04
		1559.601711.251395.00	35.50	26.38	43.39
primitive hexagonal	13.57%	1104.941104.941395.00	90.00	90.00	120.00
		1205.86 993.821395.00	90.11	90.01	144.93
primitive tetragonal	14.87%	856.69 856.691395.00	90.00	90.00	90.00
		692.94 993.821395.00	90.11	90.18	89.43
I centred tetragonal	17.07%	1782.571782.57 692.94	90.00	90.00	90.00
		1848.271714.35 692.94	90.48	112.20	107.42
primitive orthorhombic	0.23%	692.94 993.821395.00	90.00	90.00	90.00
		692.94 993.821395.00	90.11	90.18	89.43
C centred orthorhombic	6.83%	692.942098.421395.00	90.00	90.00	90.00
		692.942098.421395.00	90.04	89.82	71.29
I centred orthorhombic	12.22%	692.941844.172195.41	90.00	90.00	90.00
		692.941844.172195.41	89.78	128.66	68.11
F centred orthorhombic	6.20%	692.942098.422872.61	90.00	90.00	90.00
		692.942098.422872.61	94.48	103.78	71.29
primitive monoclinic	0.12%	993.821395.00 692.94	90.00	90.57	90.00
		993.821395.00 692.94	90.18	90.57	89.89
C centred monoclinic	6.83%	692.942098.421395.00	90.00	90.18	90.00
		692.942098.421395.00	90.04	90.18	108.71
primitive triclinic	0.00%	692.94 993.821395.00	89.89	89.82	89.43

autoindex unit cell 692.90 993.771394.99 90.00 90.00 90.00

crystal rotx, roty, rotz -40.648 176.335 2.546

Volume of the primitive cell 1960614720.

Autoindex Xbeam, Ybeam 122.67 99.18

Networking:

The World of Multiple Standards

Internet: Collection of voluntary participants

Transparent for users - easy to realize within short distances.

Now: Ethernet, TCP/IP, NFS

Future: FDDI - Fiber Distributed Data Interface

Future: OSI - Open System Interconnect

Long-Distance

Link	Speed [Mb/s]
T1	1.5
T3	45
NREN	100

Data Storage:

Right combination of adequate capacity, functionality, long-term value and economy

On-line storage of data on RAID (Redundant Array of Inexpensive Disks) and migration to cheaper off-line storage with relatively high capacity and relatively slow access time.

Data compression ??????

very fast compression, speed of decompression less important

CS type of compression not applicable - *nature of crystallographic data*

Diffraction Industry	-	nightmare
MRC Cambridge	-	J.P. Abrams
NIST	-	P. Klosowski

Off - line storage:

Media	Capacity [GB]	Cost [GB/s]	Speed [MB/s]	Investment [k\$]
8 mm	2.3 / 5.0	1.40	0.5	2.5
4mm (DAT)	1.3	1.75	0.2	2.5
VHS	14.0	1.40	3.0	250.0 (600GB)
D1 / D2	165.0	2.50	15.0	700.0 (6TB)
WORM	6.6	140.00	0.5	10.0
RWOD	0.6	400.00	0.5	15.0
Opt. tape	50.0	~1.00	?	?

Hardware requirements:

CPU	as fast as possible (ALPHA)
Memory	> 128MB (at least 5 x diffraction image)
Disk space	> 10GB
Network	internet, fast NFS - FDDI
Graphics	> 1024 x 1248, fast
OS	Unix (OSF/1), VMS, Windows NT,
Vendor	DEC, SGI, Sun, HP, IBM
Cost	< 40k\$

Michael Campbell

CERN

Silicon Pixel Detector Development at CERN

Future experiments at the proposed Large Hadron Collider at CERN will study particle collision events generating thousands of particles every 25 ns. Silicon pixel detectors could yield enormous benefits by providing unambiguous two-dimensional images of particle tracks at the center of these experiments. The CERN RD 19 Collaboration has developed a hybrid pixel detector covering a 53 mm x 56 mm plane with two staggered arrays. The design of the readout chip will be presented, along with practical aspects of the construction of such a system. I will attempt to emphasize the lessons we learned from this exercise, which could help in designing pixel detectors for the APS. Finally, I will present the excellent results we obtained in 1993, which make us believe that pixel detectors have a very promising future in such experiments.

Silicon pixel detector development at CERN

Michael Campbell

representing the

CERN RD-19 Collaboration

Chicago, February 1994

- **The particle physics environment**
- **The Omega2 pixel readout chip**
- **Development of a 5cm x 5cm array**
- **Experimental results**
- **Conclusions**

Future high energy physics experiments at CERN

- bunch crossing interval 25 ns
- no. of particles generated per bunch crossing
>> 1000
- Radiation dose 1 MRad/year and
 $1 \text{ e }^{13} \text{ n/cm}^2/\text{year}$
- detector types:

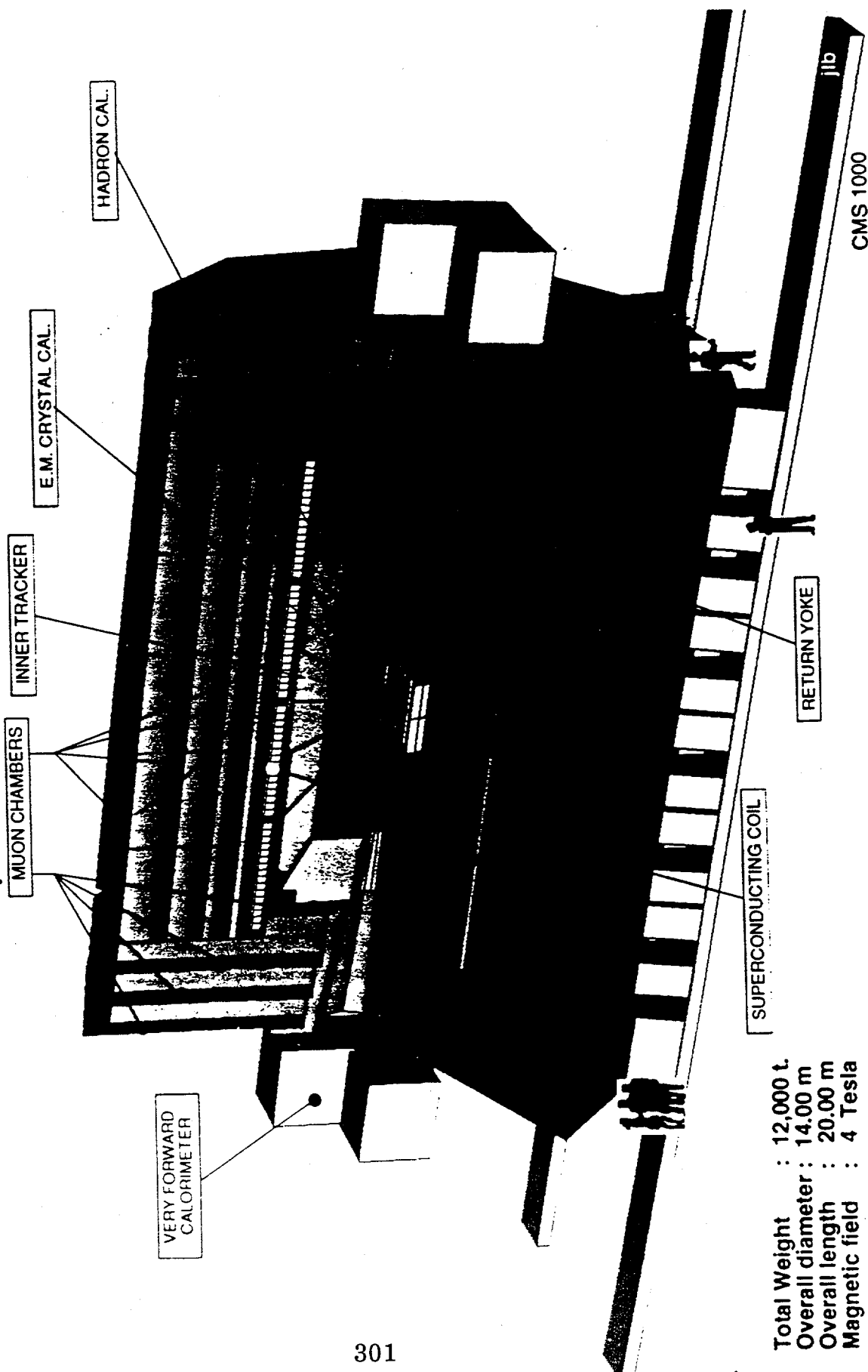
muon

calorimeter

tracking

CMS

A Compact Solenoidal Detector for LHC



Two dimensional detectors:

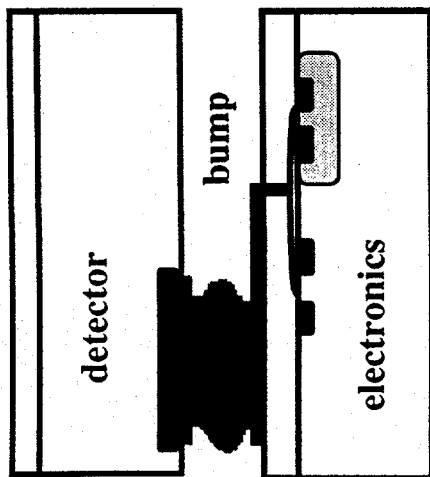
CCD

**low readout speed, but well developed
technology**

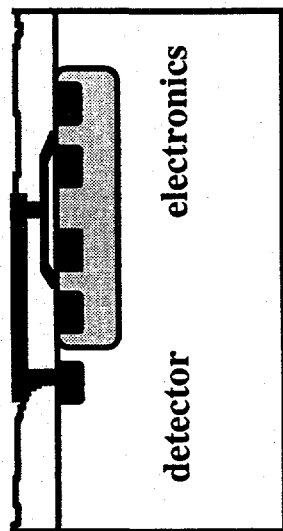
Pixel detectors

**high speed but new approach
readout can be analog or binary**

Silicon Pixel Detector - 3 possible approaches



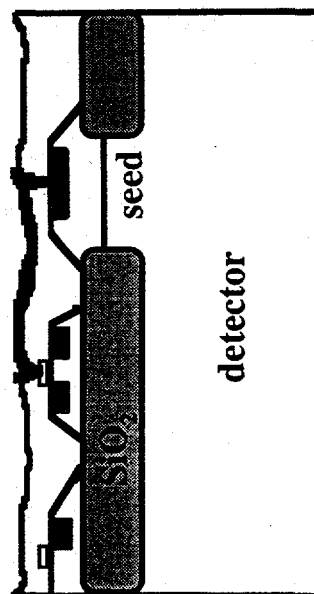
Hybrid



Monolithic

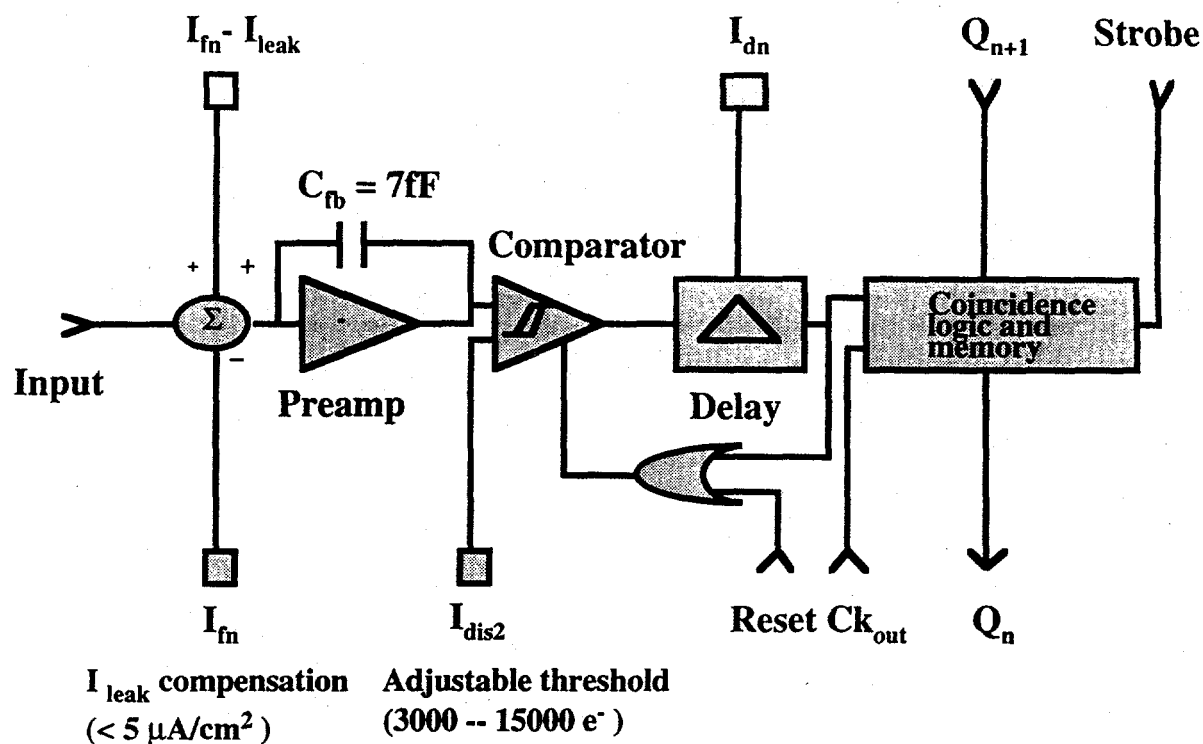
Advantages of the hybrid approach:

- Well mastered CMOS technology
- Simple detector structure
- Reliable bump-bonding procedure
- Electrical isolation

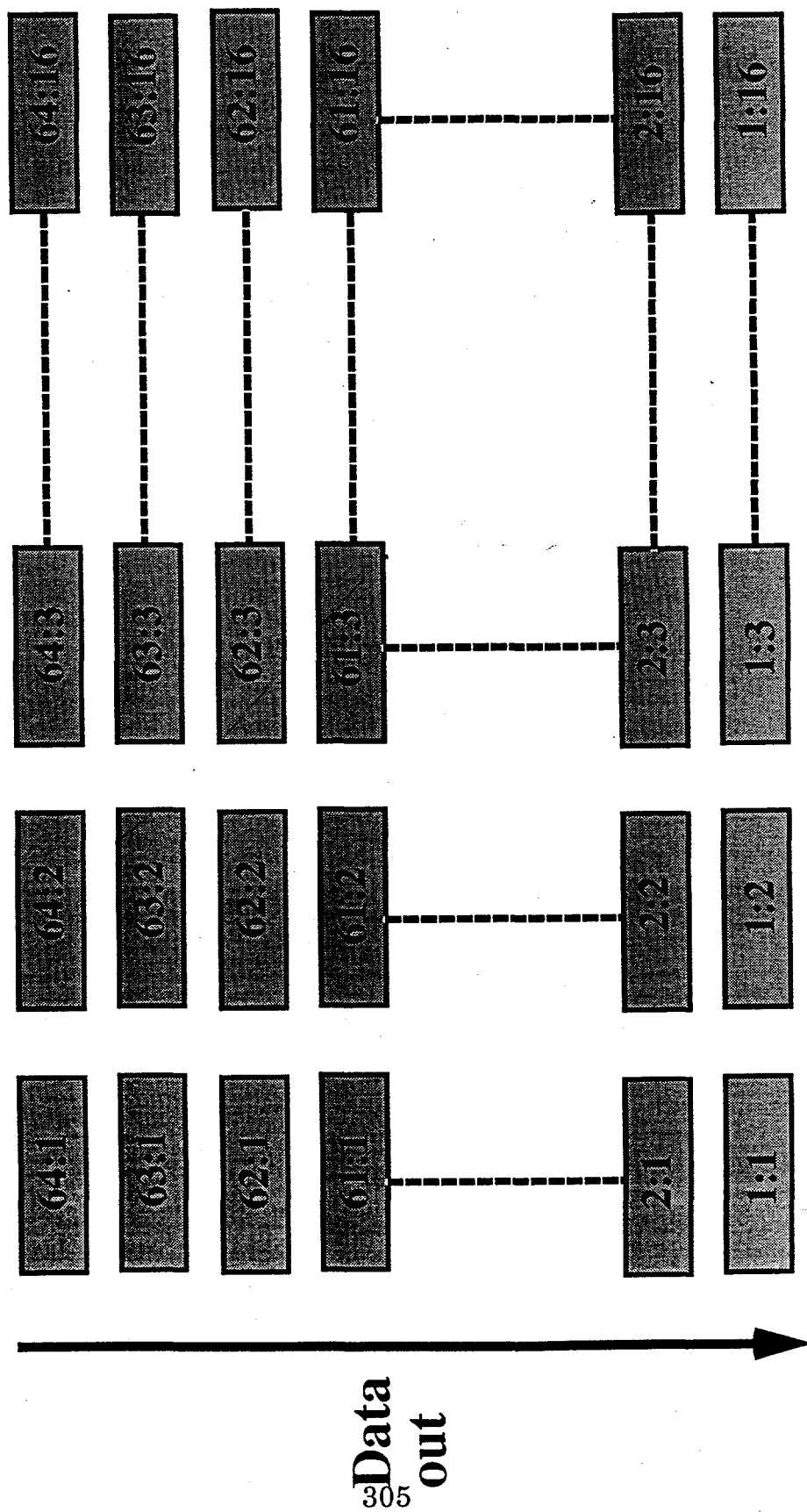


SOI

Omega2 pixel cell and timing

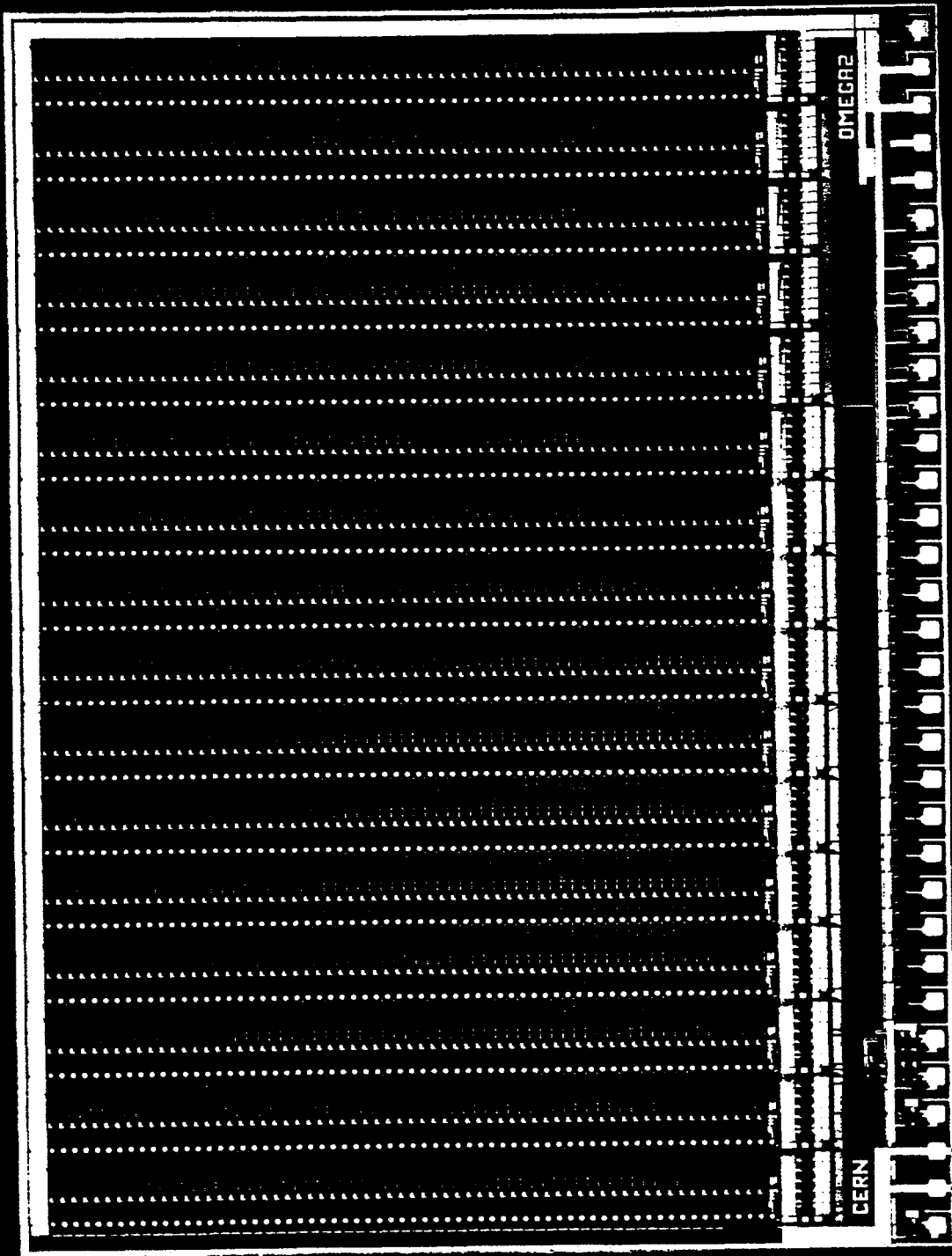


Simple Readout architecture



64 x 16 - bit words

ENCLOSURE 102/



5

PHO

42

20K0

100PM

042

42

WHITE

2011

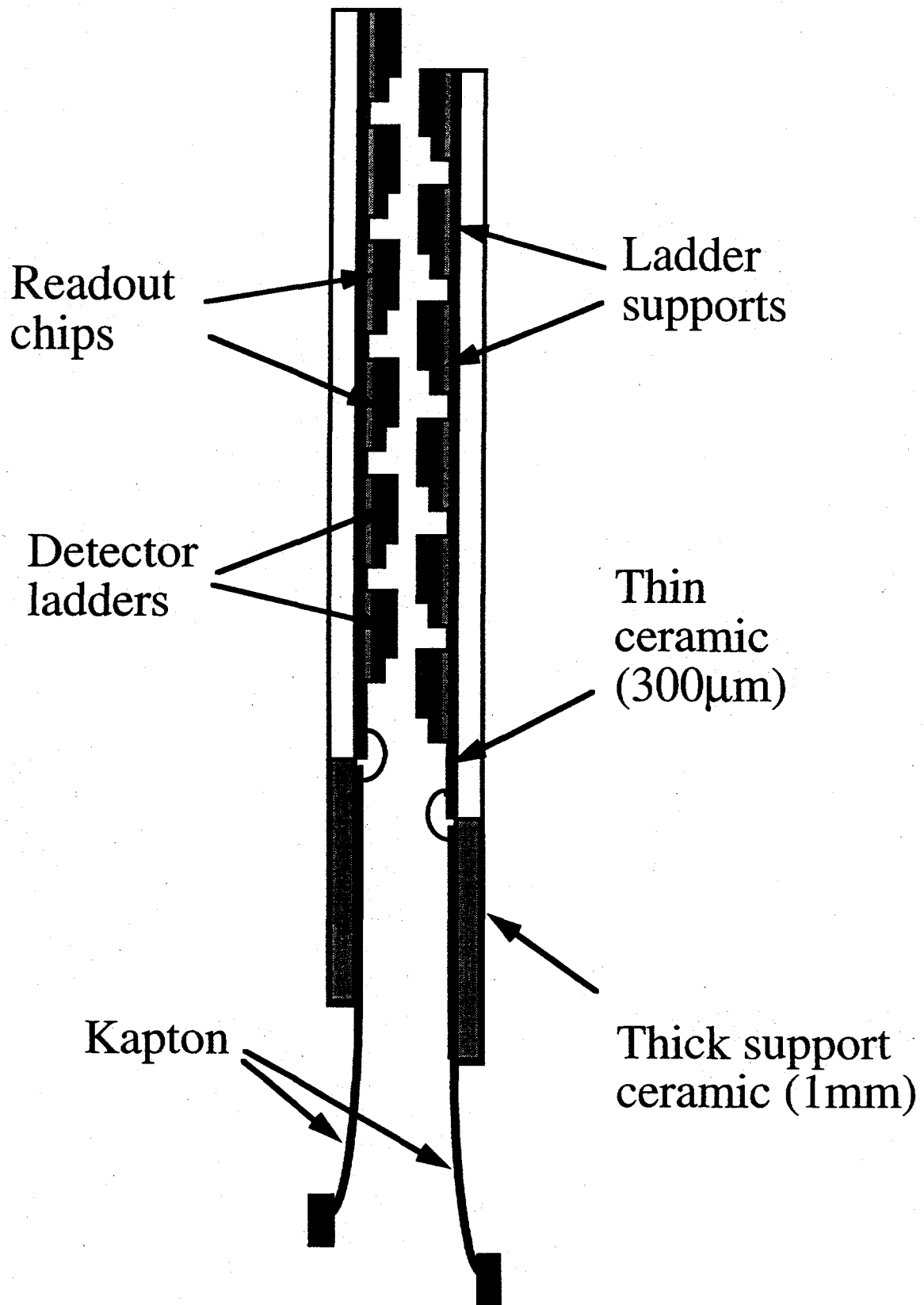


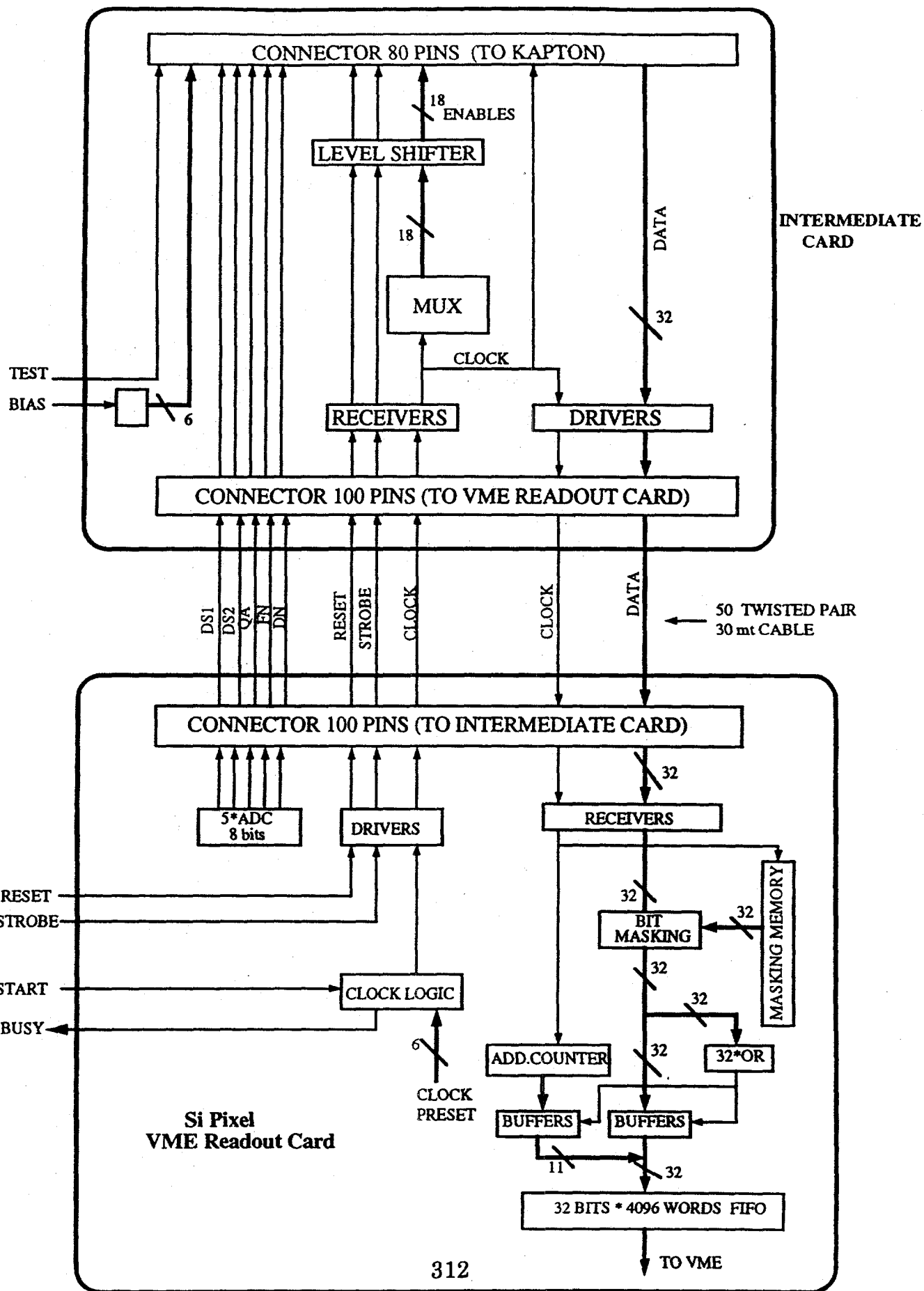
Development of a 5 cm x 5 cm logical plane

- **Detector ladders with 6 readout chips**
 - detector dimensions 53 mm x 4.8 mm
 - no insensitive regions between readout chips
- **Ceramics containing 6 ladders**
 - ladder spacing < 4.8 mm
- **Two ladders staggered**

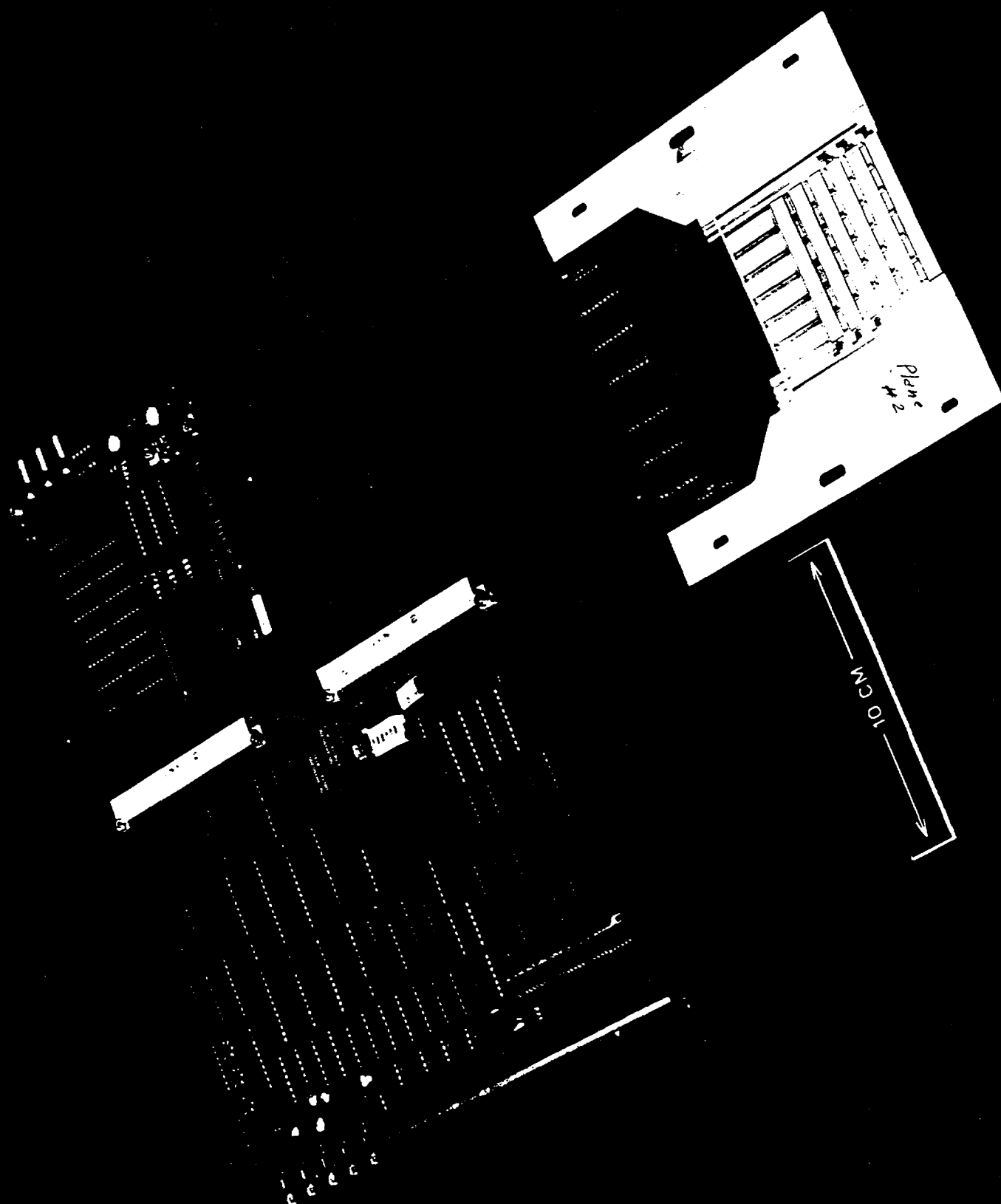
IT 7-7-93 / 6

Logical Plane



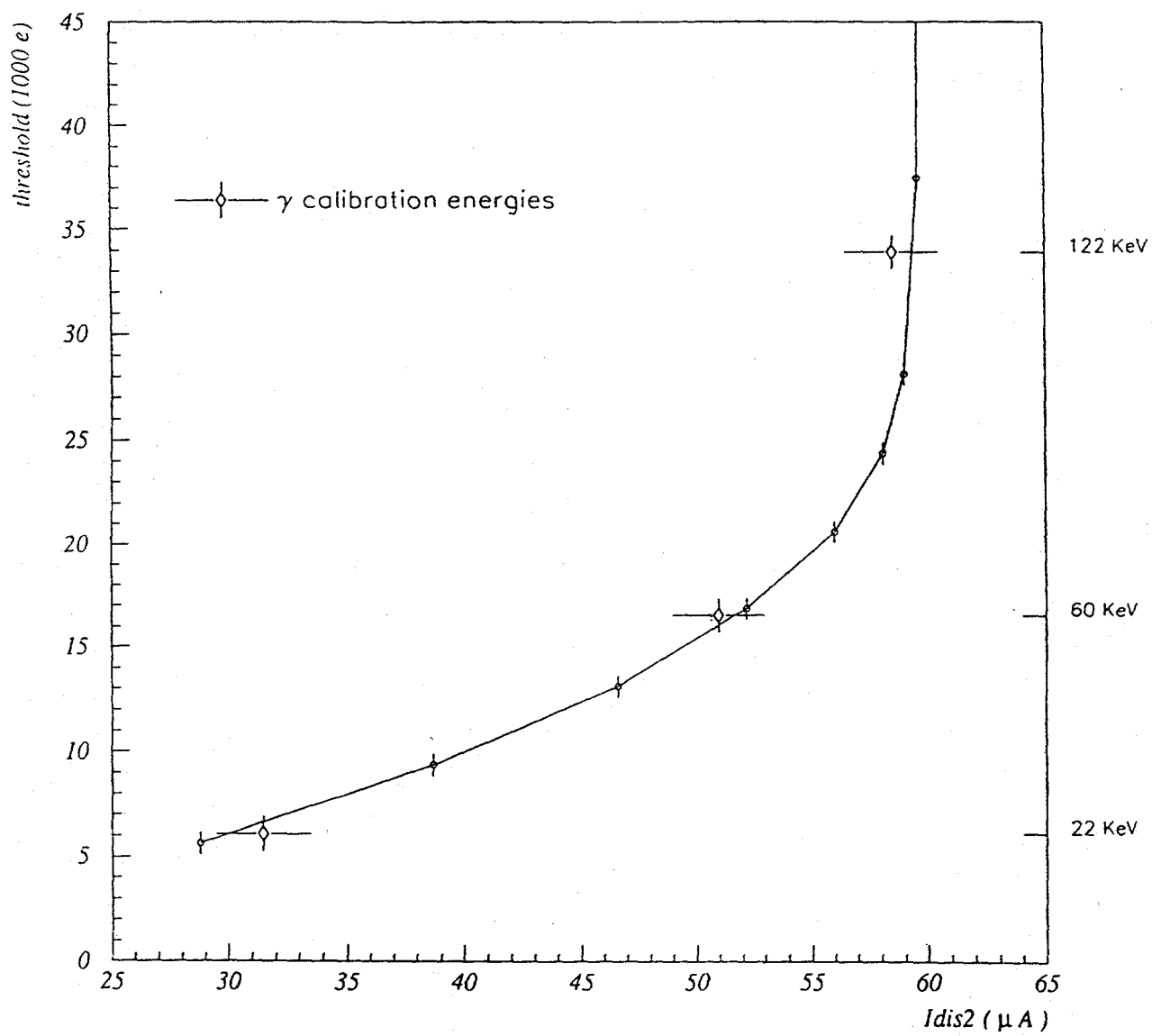


6-7-11-1-9

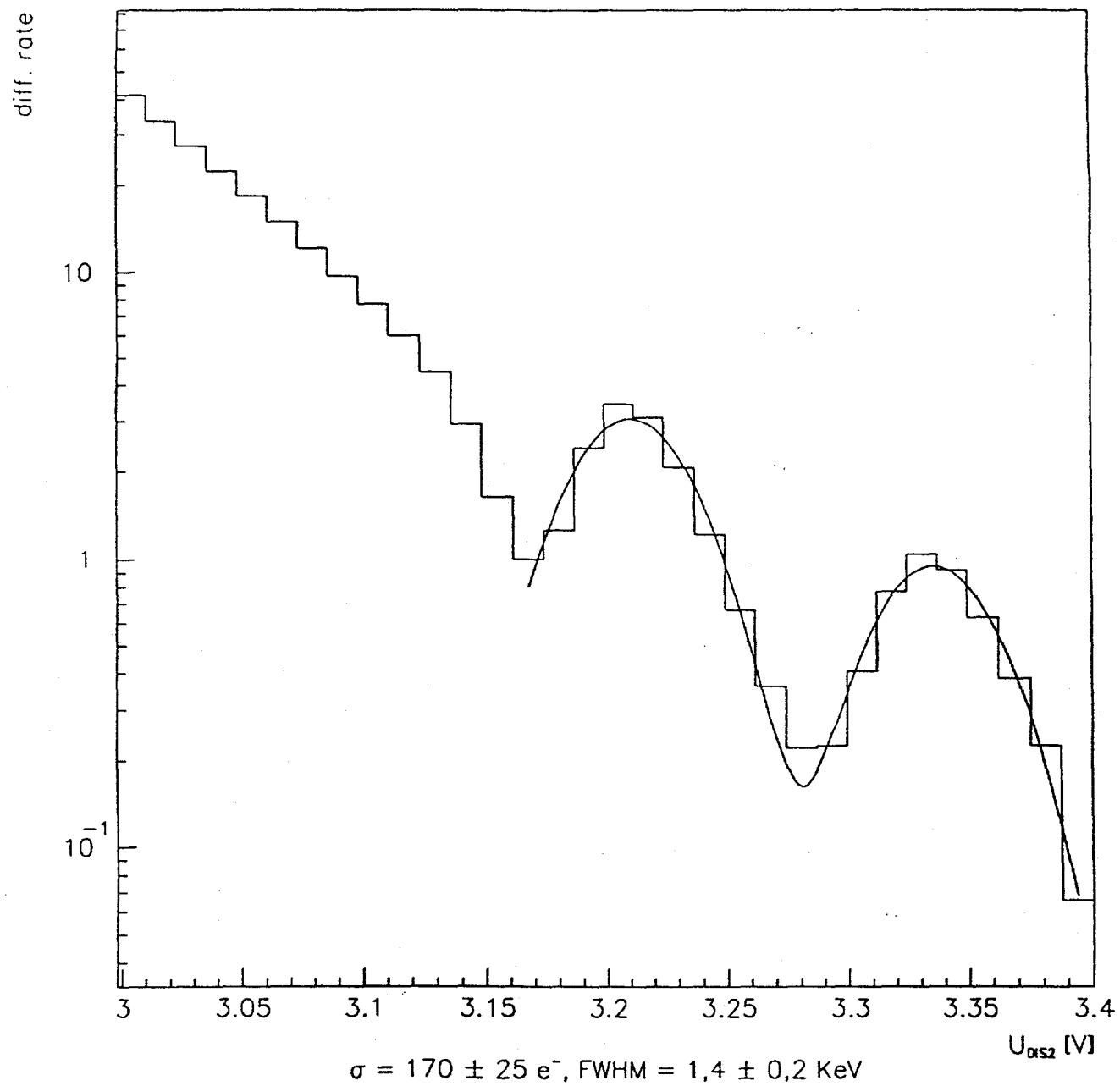


Electrical characterisation

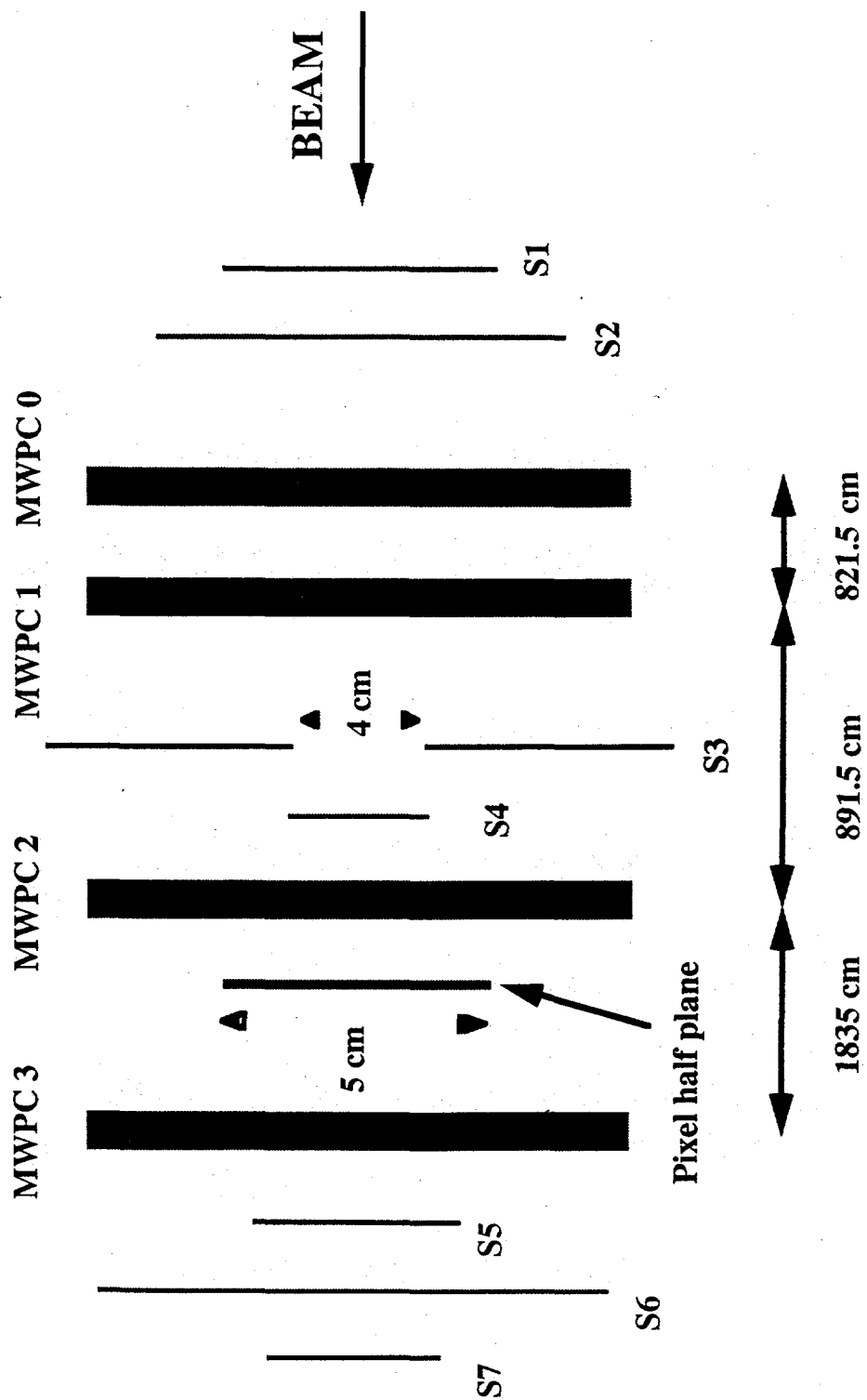
- Each chip contains 16 test pixels which can be used for timing and threshold measurements
- Minimum effective strobe width is 100 ns per chip and $\sim 1 \mu\text{s}$ for the array
- Threshold variable from 3 000 to 15 000 e^-
- Large threshold variation $\sim 750 \text{ e}^- \text{ rms}$
- Very low noise 100 $\text{e}^- \text{ rms}$
- Digital to analog cross-talk limits strobe width
- Test channels essential for commissioning



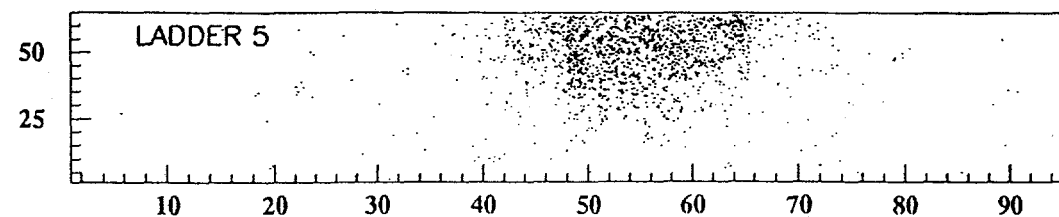
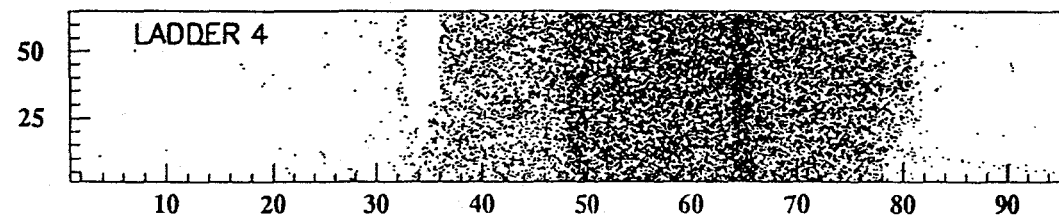
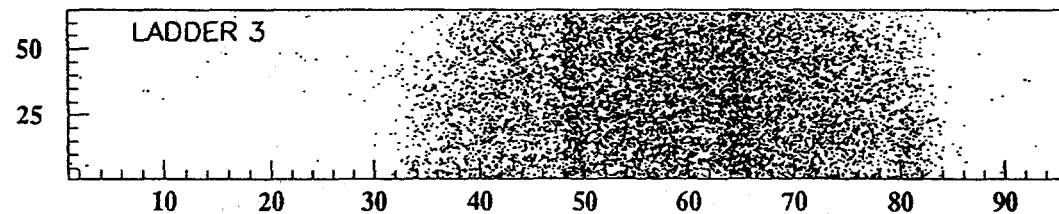
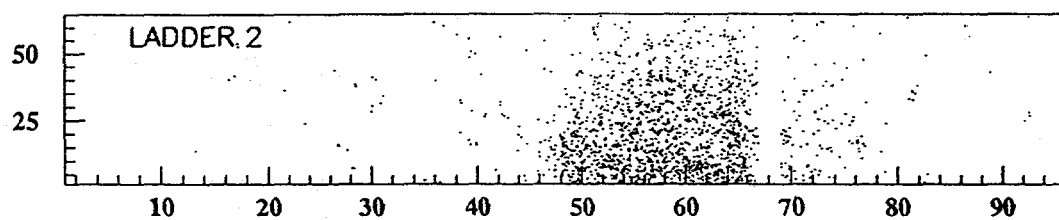
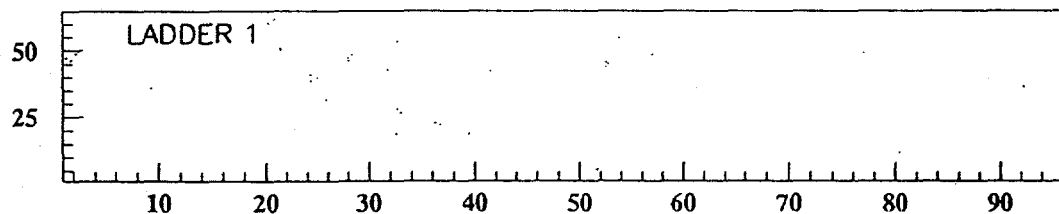
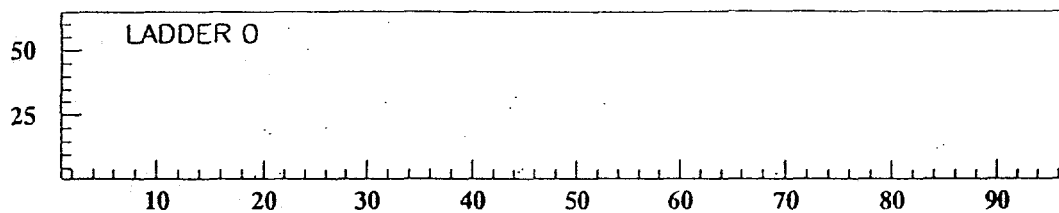
CD Spectrum with 22 KeV and 25 KeV line



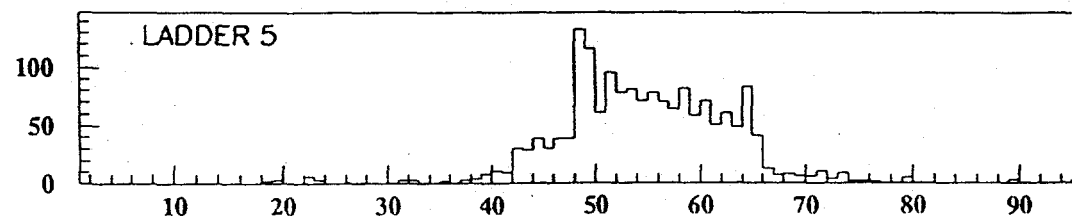
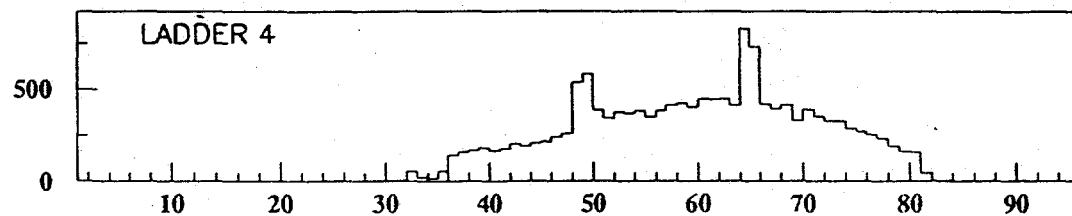
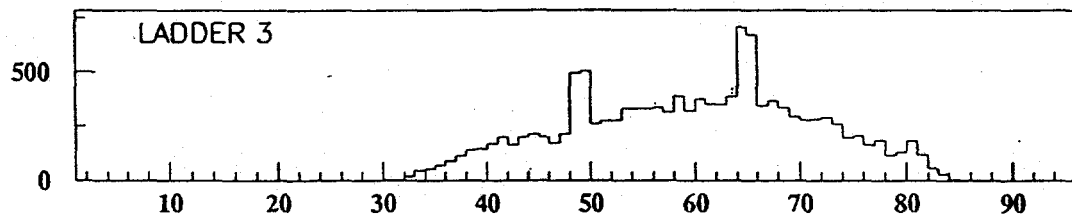
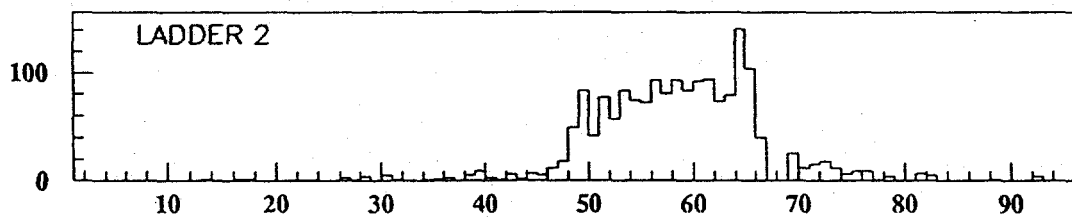
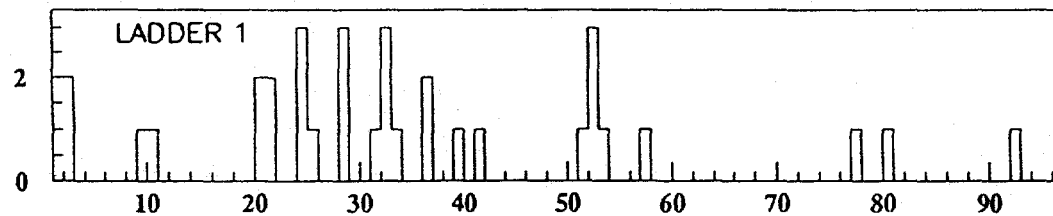
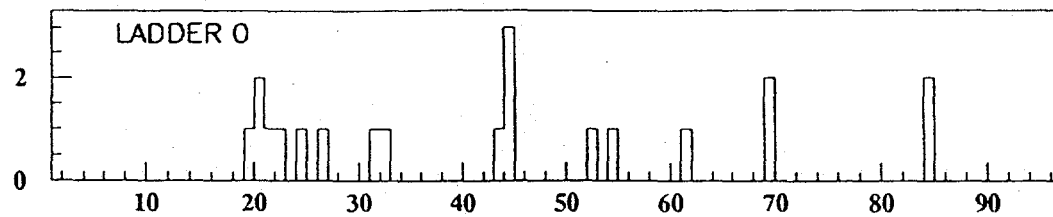
Test Beam Setup

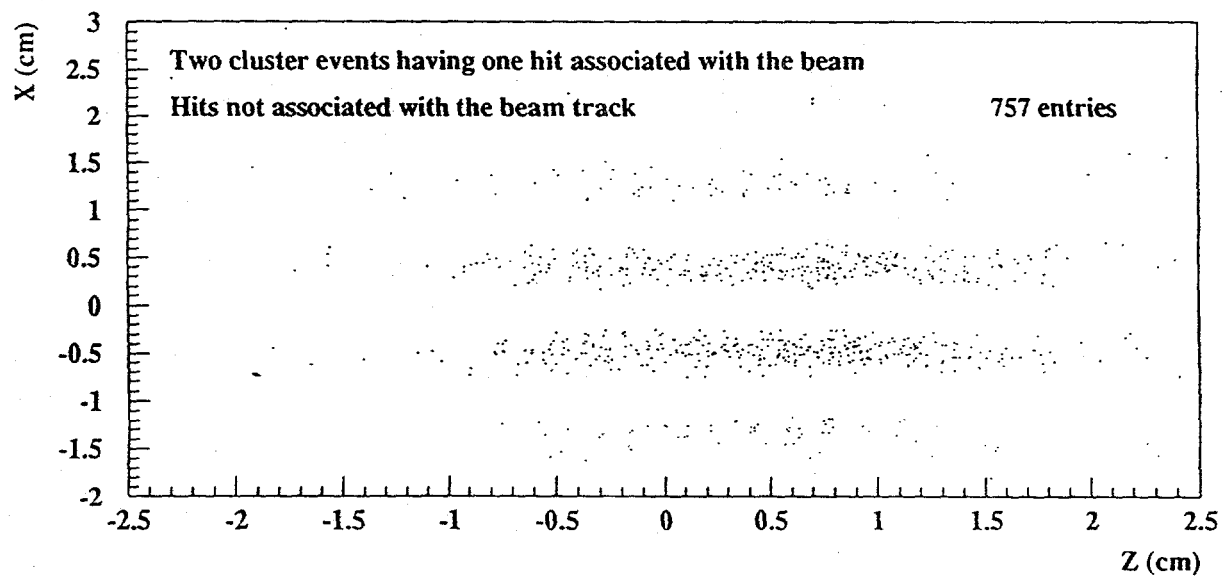
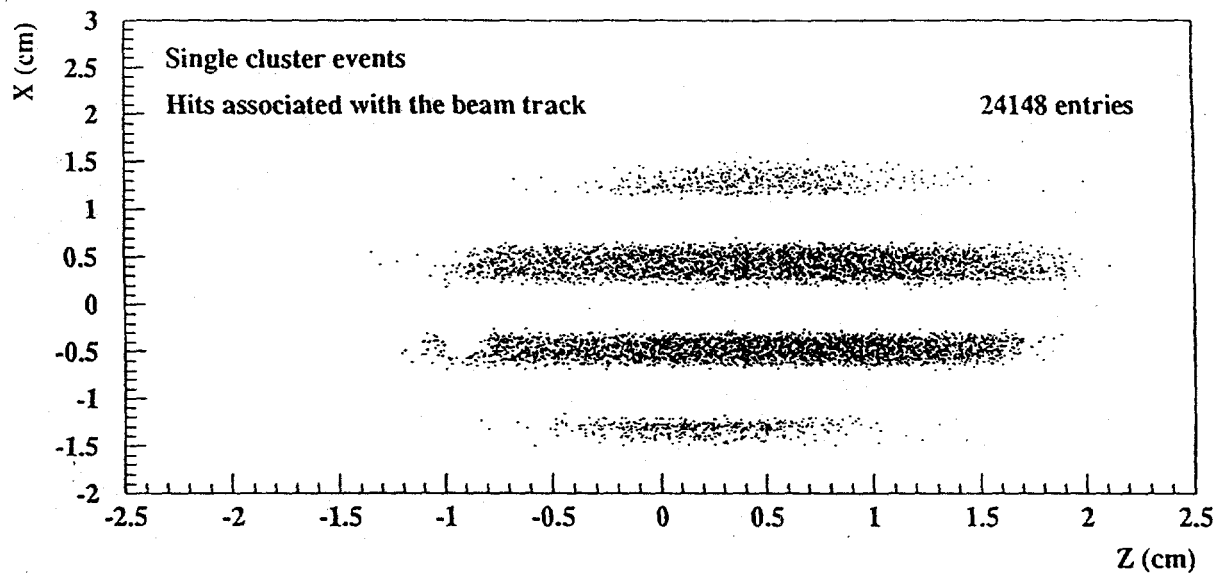


PIXELS SCATTER PLOT

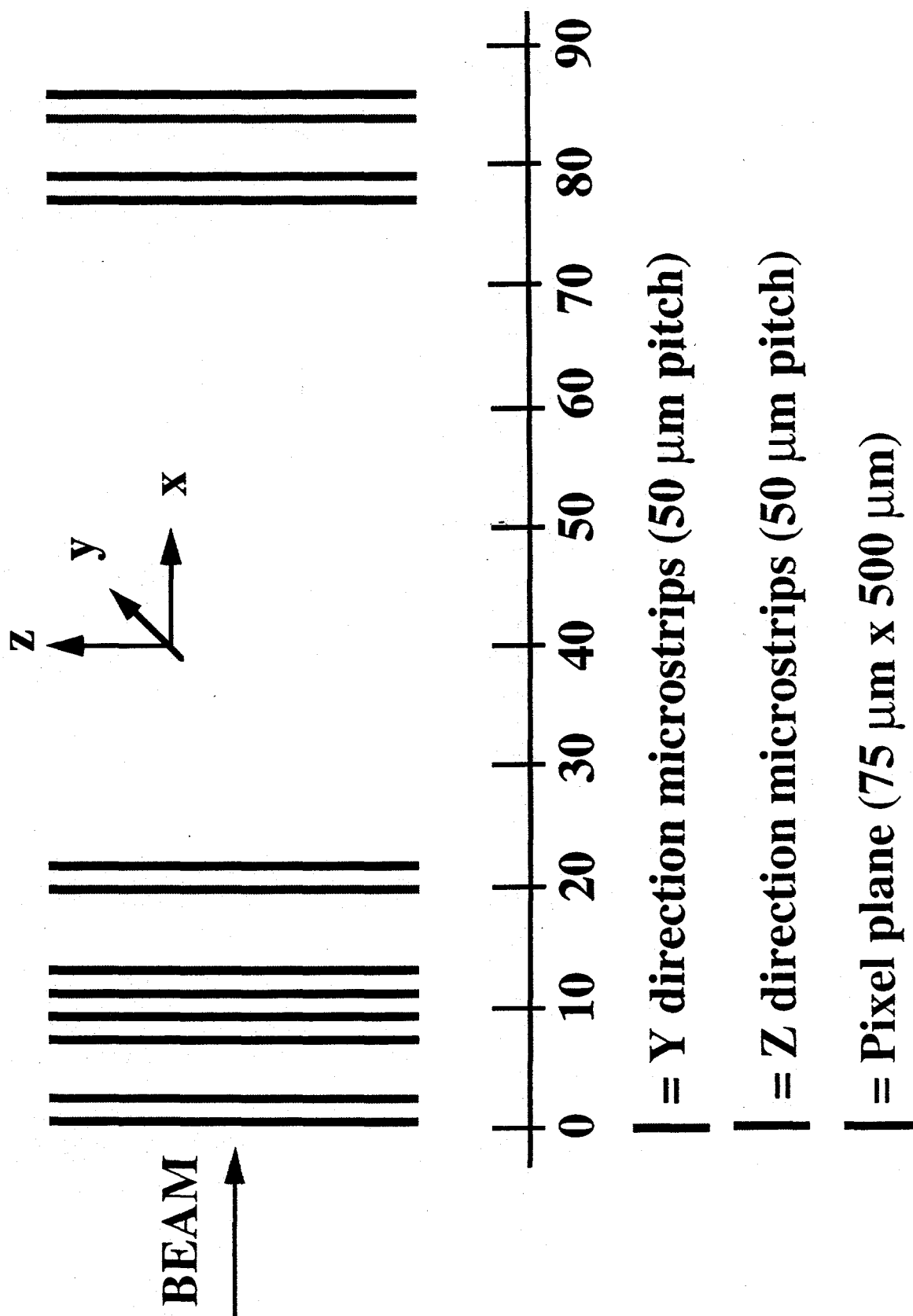


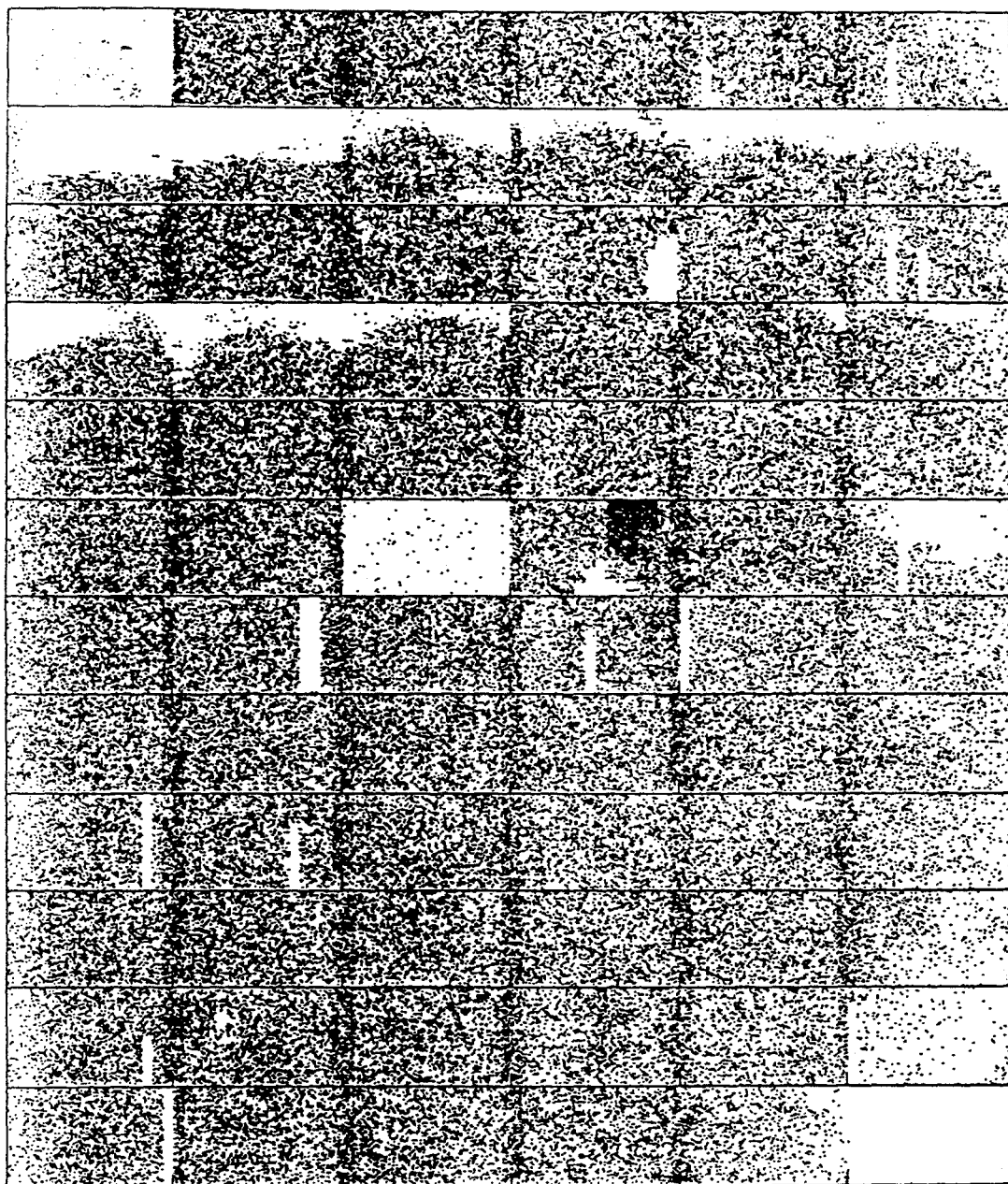
PIXEL COLUMNS PROFILE



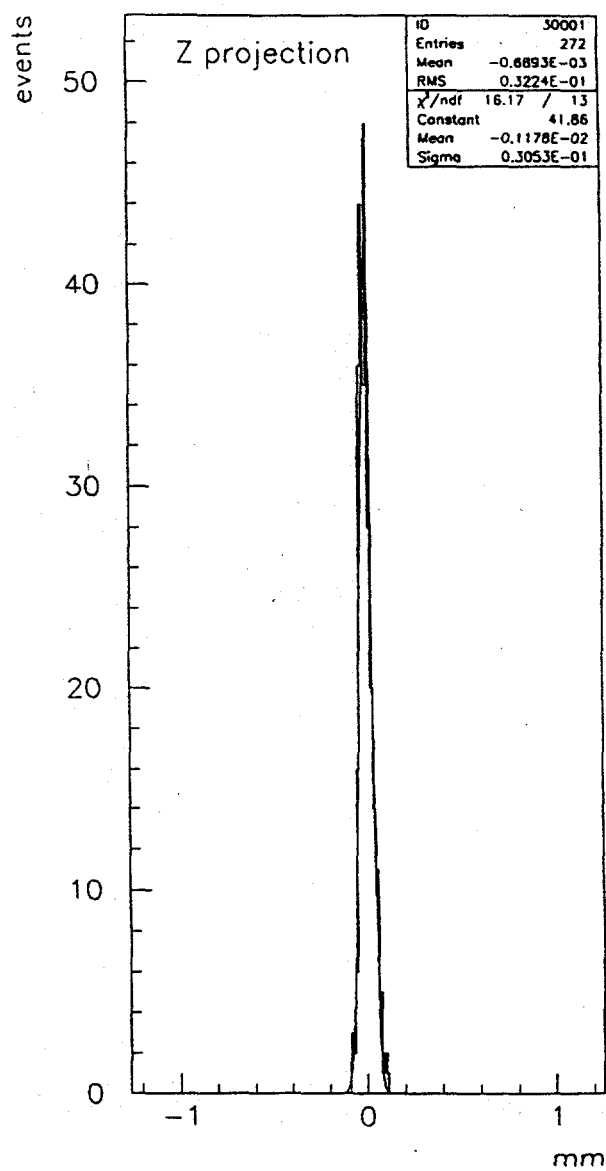
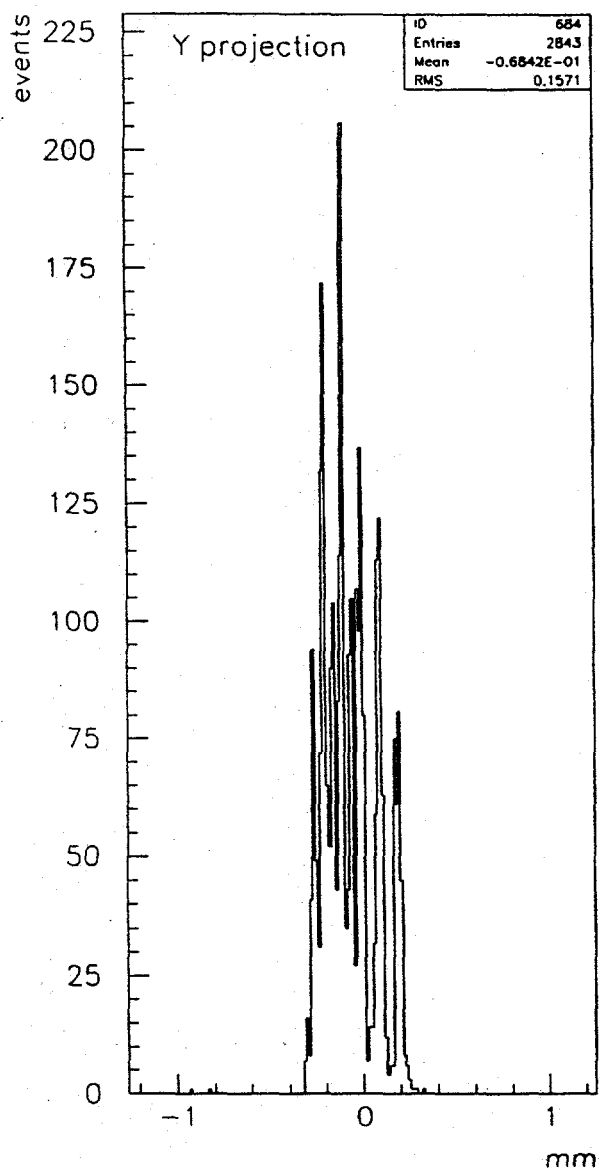


WA97 Test Beam Setup





PIXEL RESOLUTION



Conclusions

- A silicon pixel detector has been developed for high energy physics applications
- A logical plane of 5 cm x 5 cm has been constructed comprising 2 physical planes and containing 72 000 sensitive elements
- The equivalent noise charge has been measured to be 170 e⁻
- Clean data has been obtained in several beam tests
- Pixel detectors hold great potential for future HEP experiments and may be of interest for the APS

Applications to photon imaging

- Different detector material to improve detection efficiency eg GaAs
- Tiling an area with one plane could be difficult
- Present readout scheme well adapted for HEP - may need to be changed
- Already tested for visible detection

Key references:

F. Anghinolfi et al.

A 1006 element hybrid silicon pixel detector with strobed binary output

IEEE trans Nucl. Sci. NS-39 (1992) 654.

E.H.M. Heijne et al.

First operation of a 72 k element hybrid silicon micropattern pixel detector array

to be submitted to,

Nuclear Instruments and Methods A, February 1994.

copies and preprints available from:

M. Campbell

ECP Division

CERN

1211 Geneva 23

Switzerland

Wolfgang Sturhahn

Advanced Photon Source
Argonne National Laboratory

APDs - Large Dynamic Range Detectors for Hard X-rays[†]

The ultrahigh brilliance of the third-generation synchrotron radiation sources will increase count rates by several orders of magnitude if compared to existing synchrotron radiation sources. Detectors that allow one to exploit this advantage should have a linear range of operation that reaches from very high count rates to their intrinsic noise level. We investigated APDs (Avalanche Photo Diodes) with respect to linearity, efficiency, time resolution, and dynamic range by the use of 8.4-keV and 14.4-keV synchrotron radiation. We observed linear behavior up to count rates of 10^8 Hz. The intrinsic noise level was below 10^{-2} Hz. Efficiencies of about 50% at 8.4 keV and about 14% at 14.4 keV were achieved. The time resolution was about 1 ns. We will present the experimental data and discuss the performance of APD detectors.

[†] in collaboration with T. Toellner, E. E. Alp, P. Montana, and M. Ramanathan. This work is supported by US - DOE, BES Materials Science, under contract No.: W-31109-ENG-38.

HPDs - Large Dynamic Range Detectors for Hard X-Rays

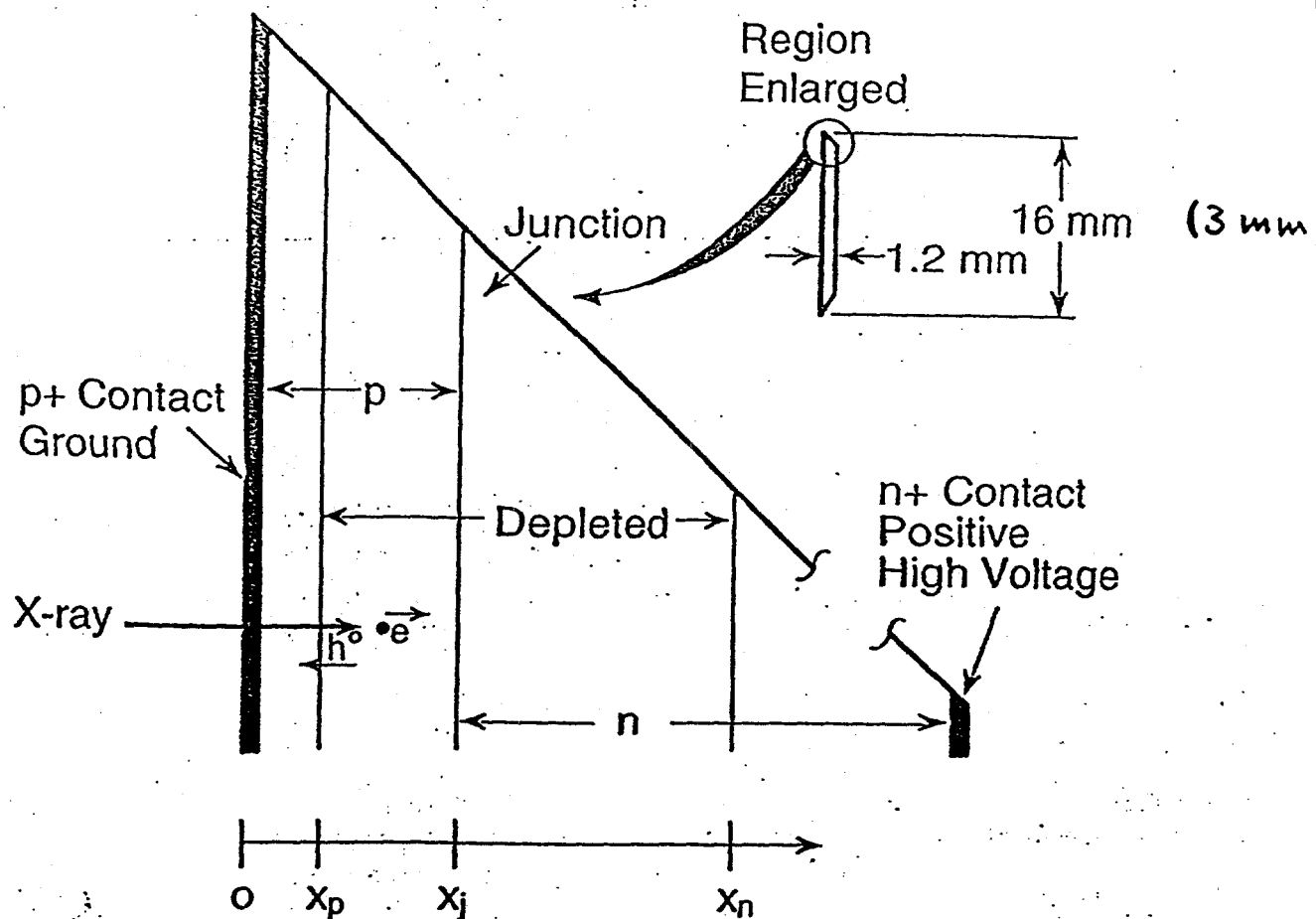
by

Wolfgang Sturhahn

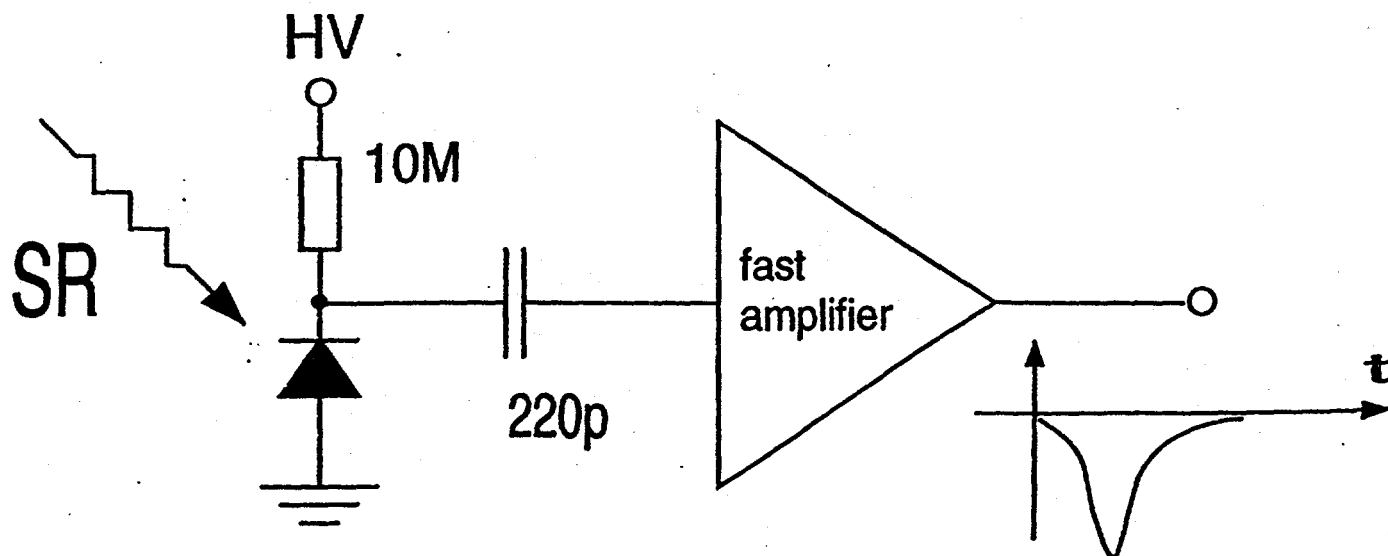
Argonne National Laboratory

Advanced Photon Source

- (1) Introduction
- (2) Multiphoton Counting
- (3) Linearity
- (4) Time Resolution and
Dynamic Range
- (5) Efficiency
- (6) Conclusion



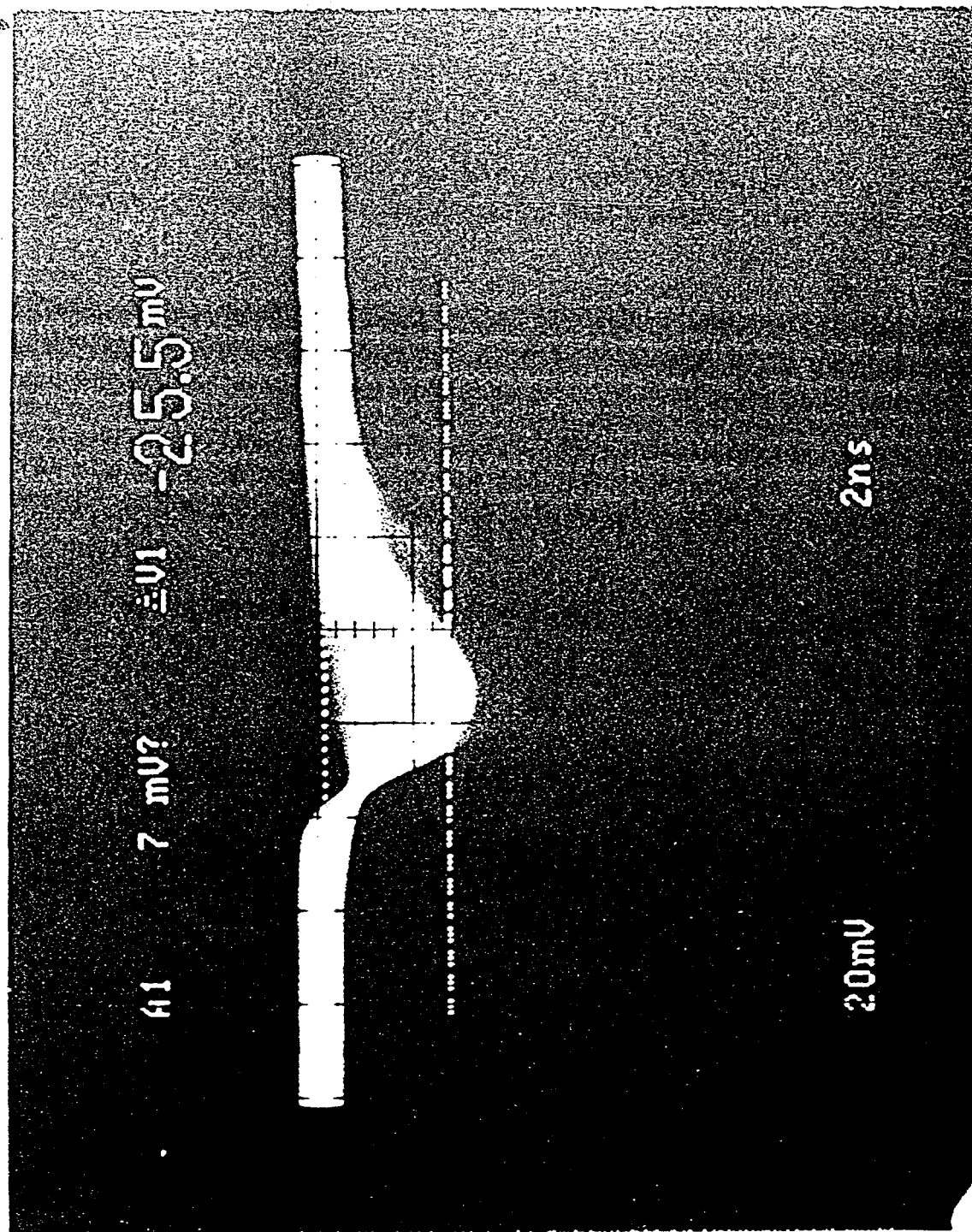
HPD operational setup:



Multiphoton counting

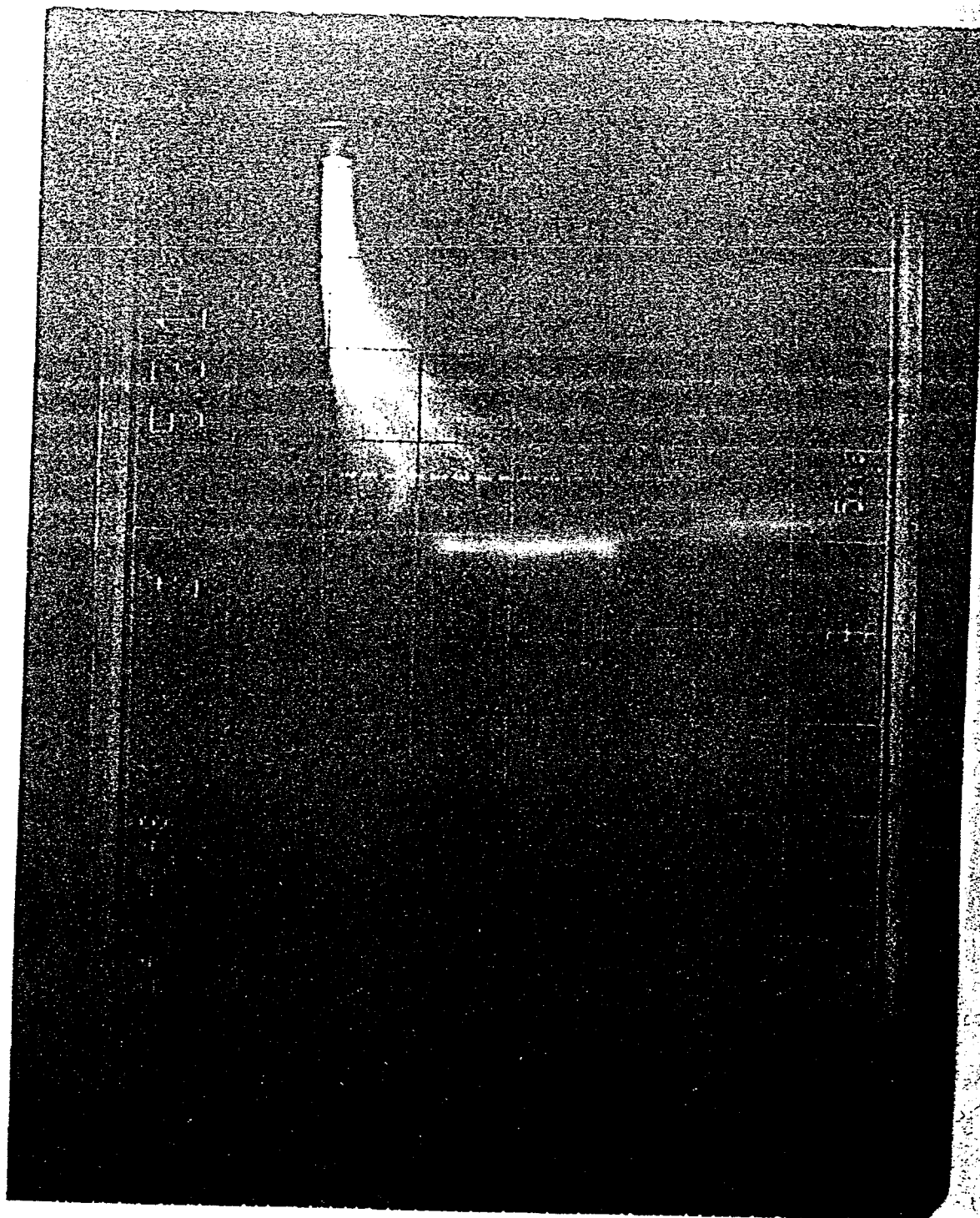
- The average number of photons per SR flash may come close to one or at high intensities exceed one considerably
 - The RPD output pulse height increases in steps with the step size proportional to the amount of charge one photon is releasing
- (energy resolution: 10% @ 6 keV)

100 kHz



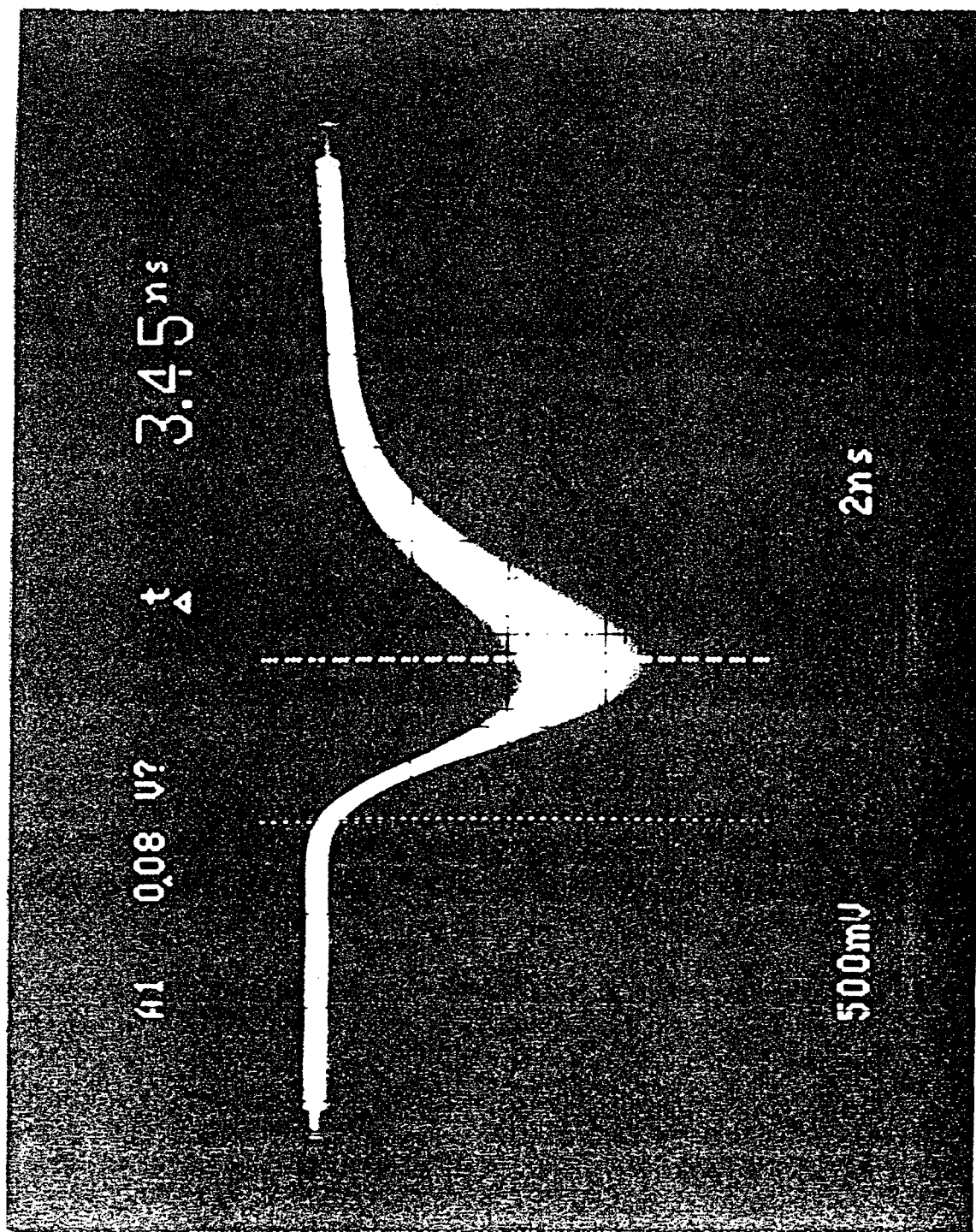
2-2

14.106 Hz



54 photons / flash

$9.6 \cdot 10^7 \text{ Hz}$

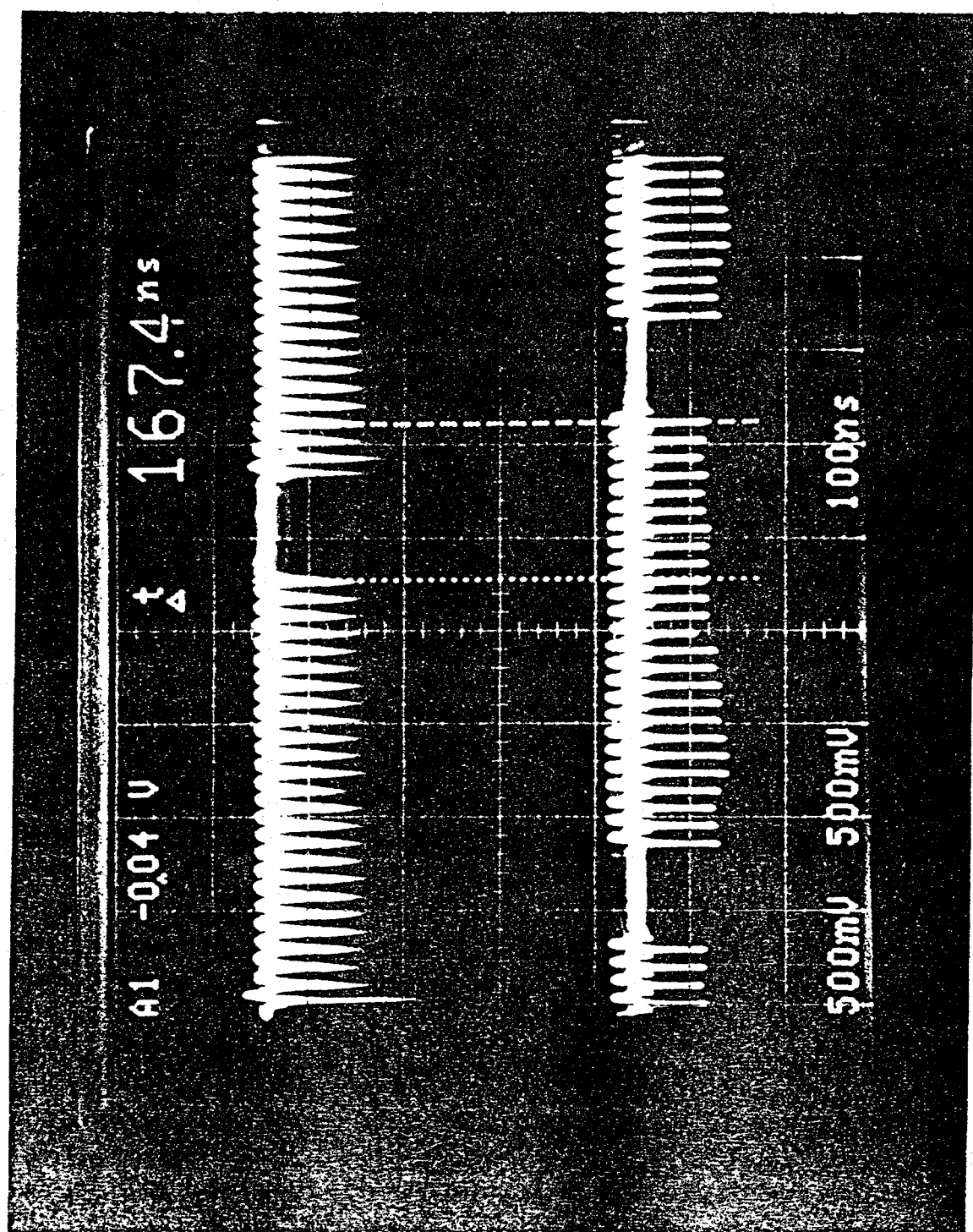


$3 \cdot 10^9$ H₂ $\rightarrow$ photons/flash

$3 \cdot 10^9$ H₂

HPD

NSLS
pickup
electrode

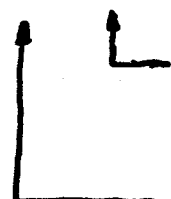


Multiphoton counting

The probability to observe n photons in a SR flash is given by

$$P_n(\lambda) = e^{-\lambda} \frac{\lambda^n}{n!} \quad (\text{Poisson distr.})$$

with $\lambda = I \cdot \tau$

 separation of SR pulses
average intensity

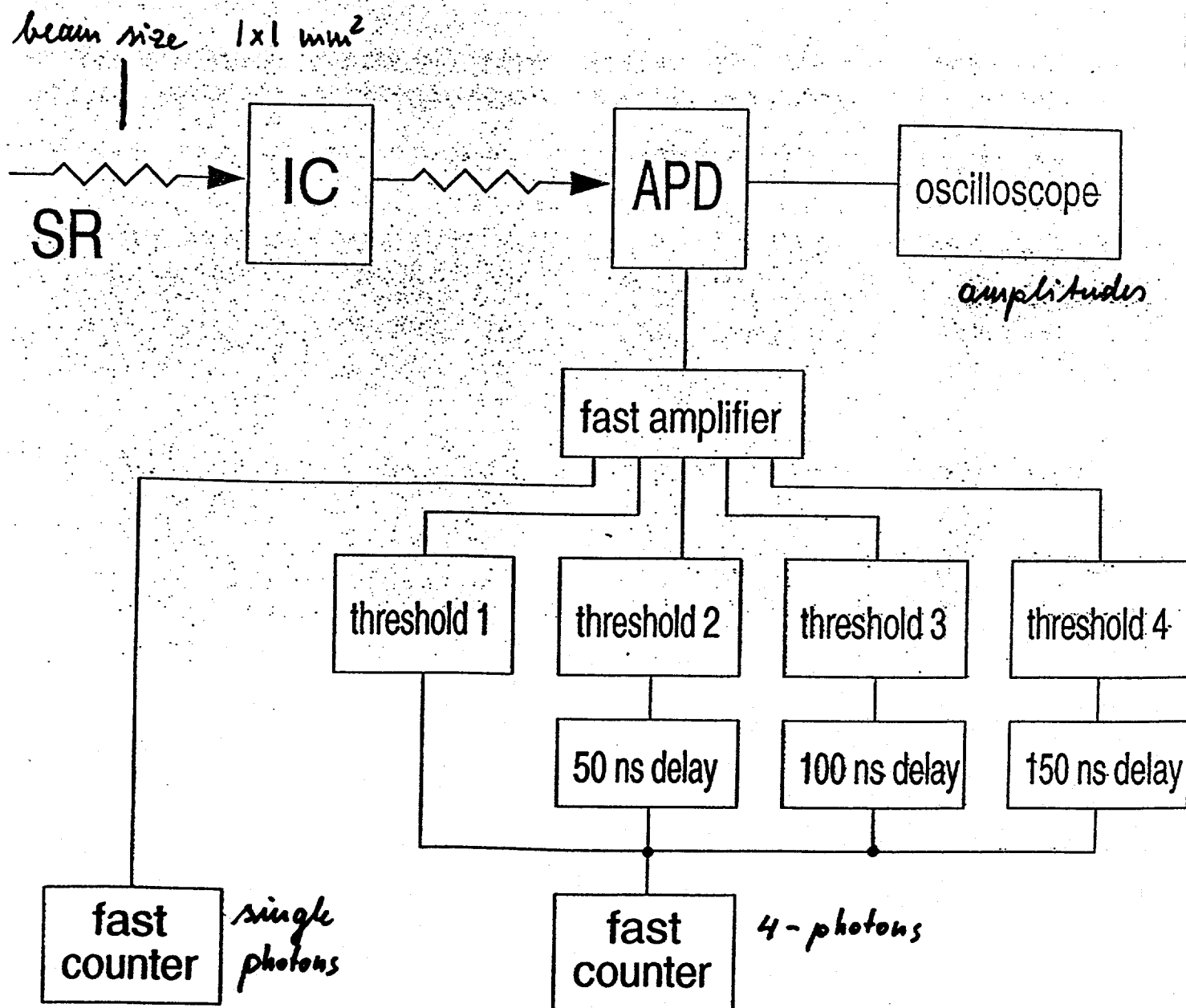
If the detector can detect j photons in the same flash the measured intensity evaluates to

$$N_j = I - \underbrace{\frac{1}{\tau} \sum_{n=j+1}^{\infty} (n-j) P_n(\lambda)}$$

small for $I \ll \frac{1}{\tau} \{(j+1)!\}^{1/j}$

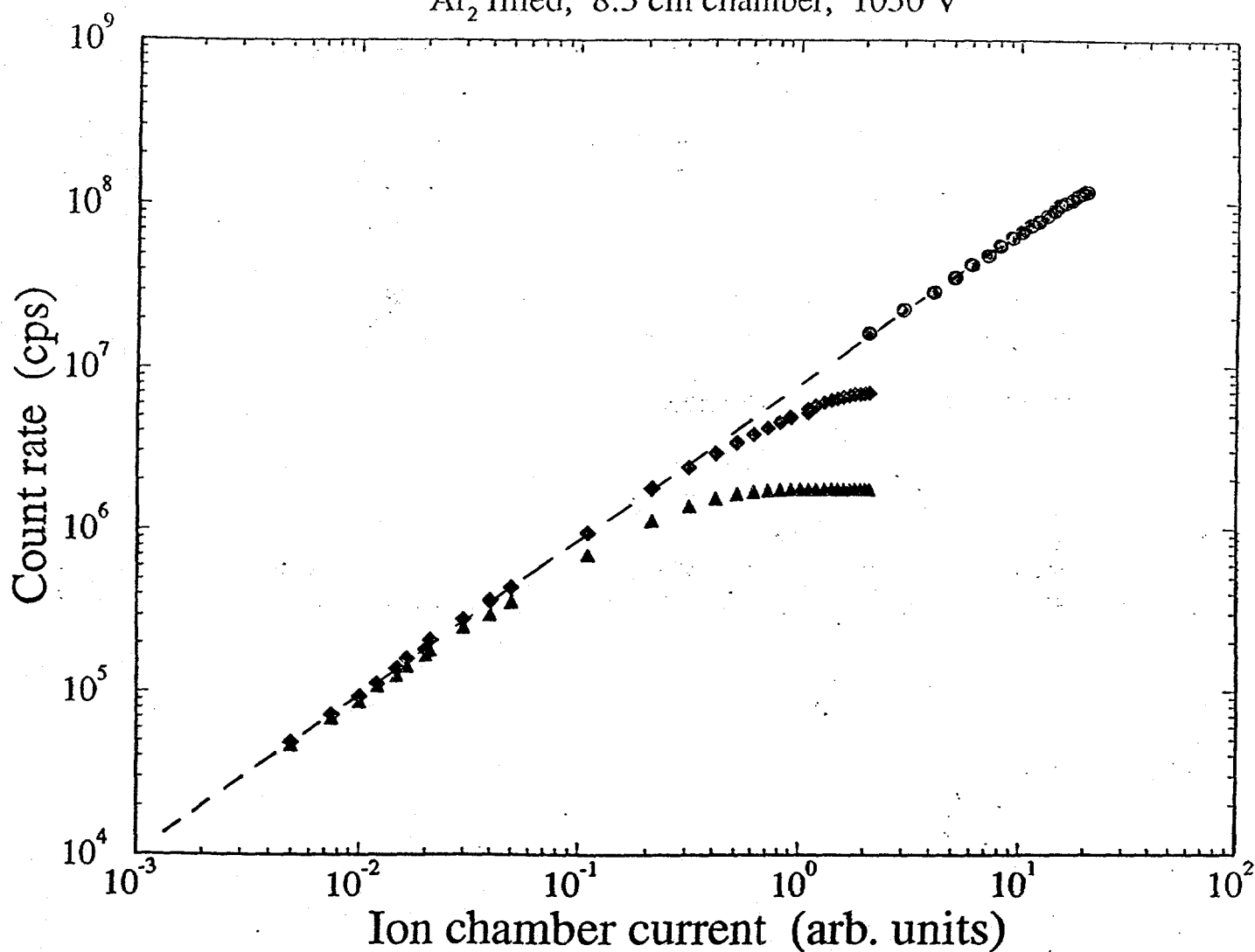
Linearity

experimental setup for linearity measurement



Linearity of APD to 8.4 keV photons

Ar₂ filled, 8.5 cm chamber, 1050 V

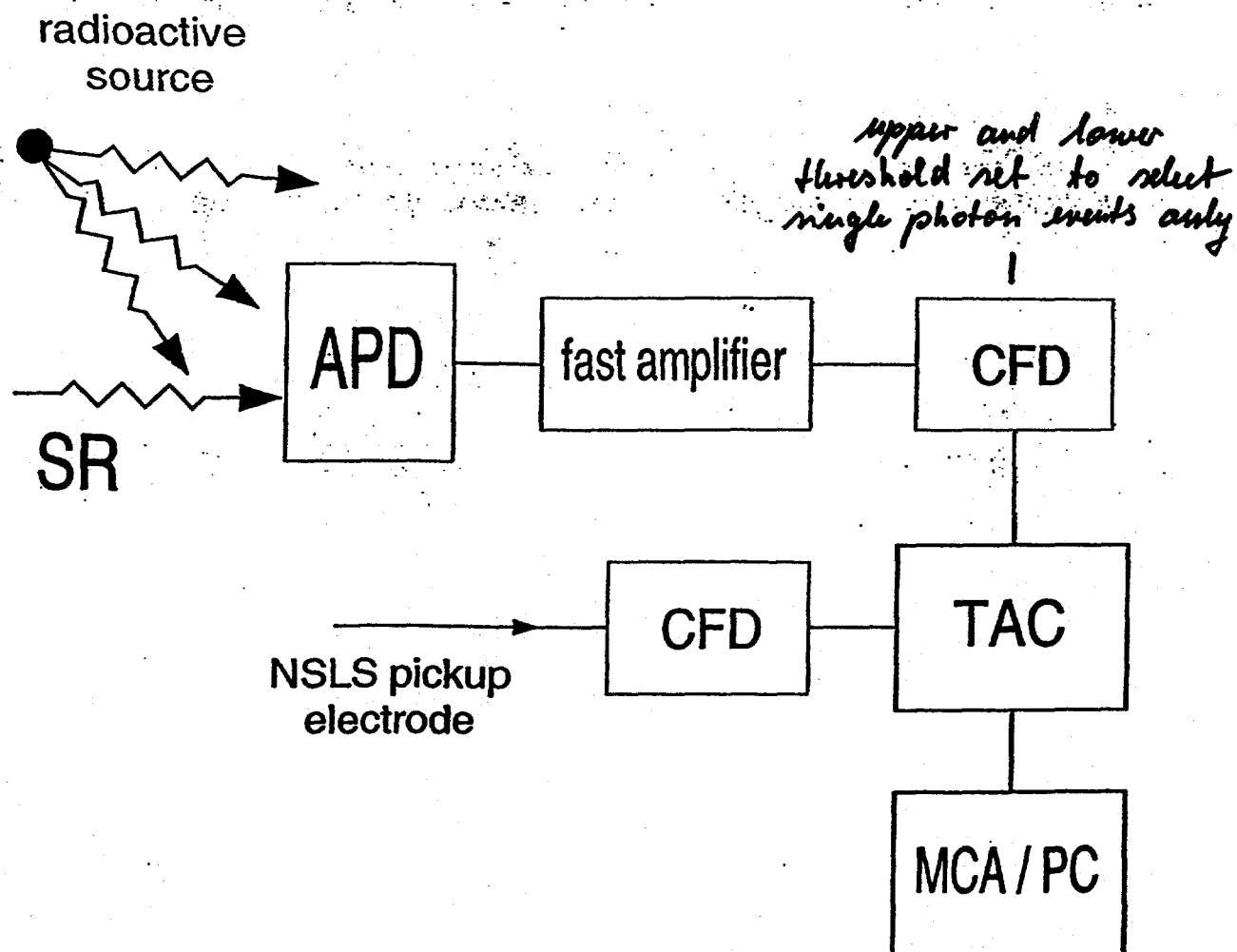


one photon counter
4-photon counter
amplitude measurement

Time resolution and dynamic range

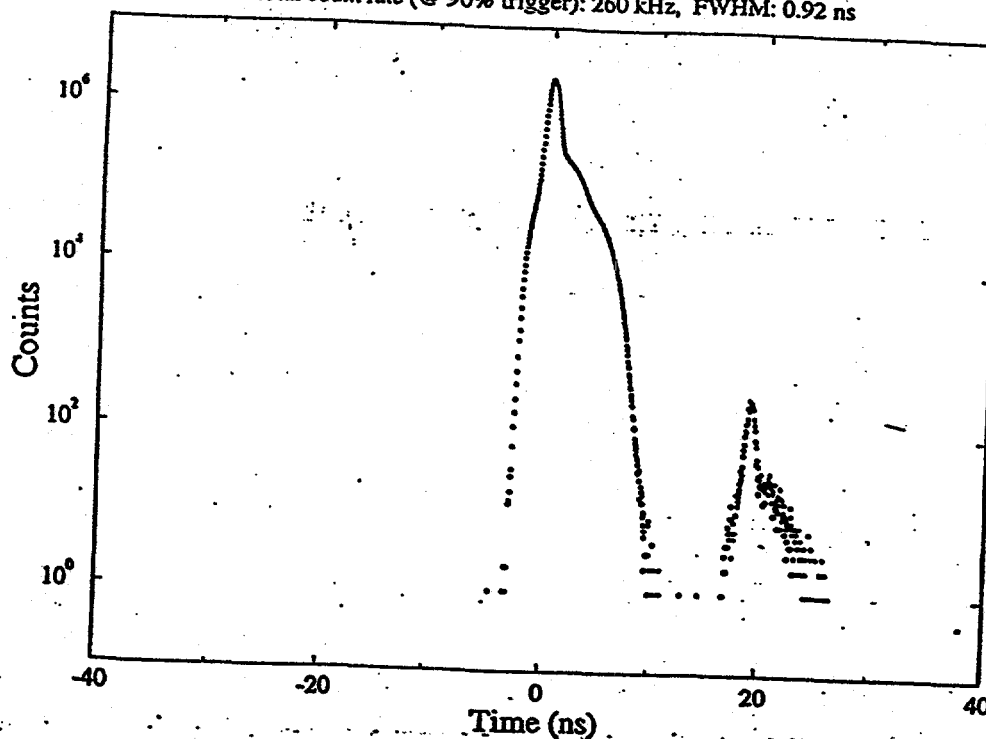
experimental setup for timing experiments:

- analyze the ability of an APD to count single photons after a SR flash



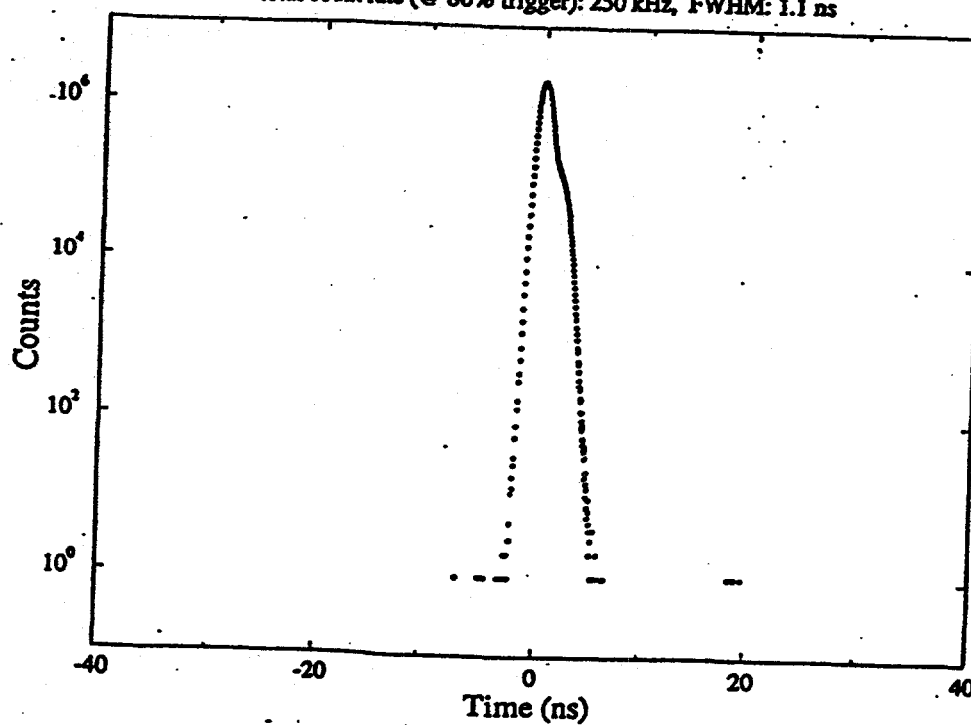
APD time response to single 8.4 keV photons

total count rate (@ 90% trigger): 260 kHz, FWHM: 0.92 ns



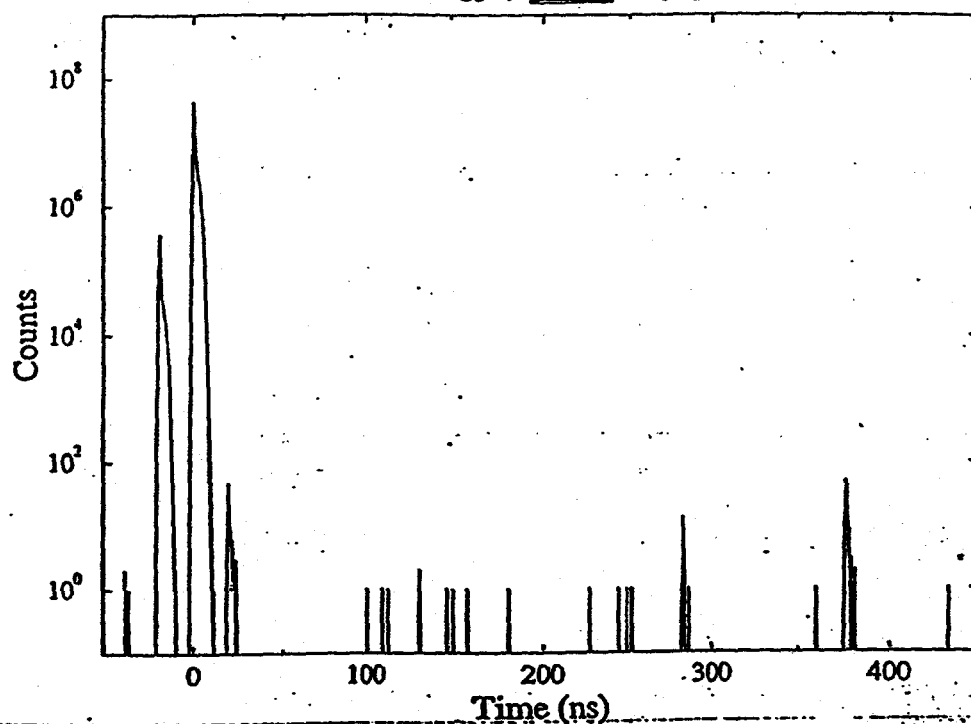
APD time response to single 8.4 keV photons

total count rate (@ 80% trigger): 250 kHz, FWHM: 1.1 ns



8.4 keV pulsed SR time spectrum

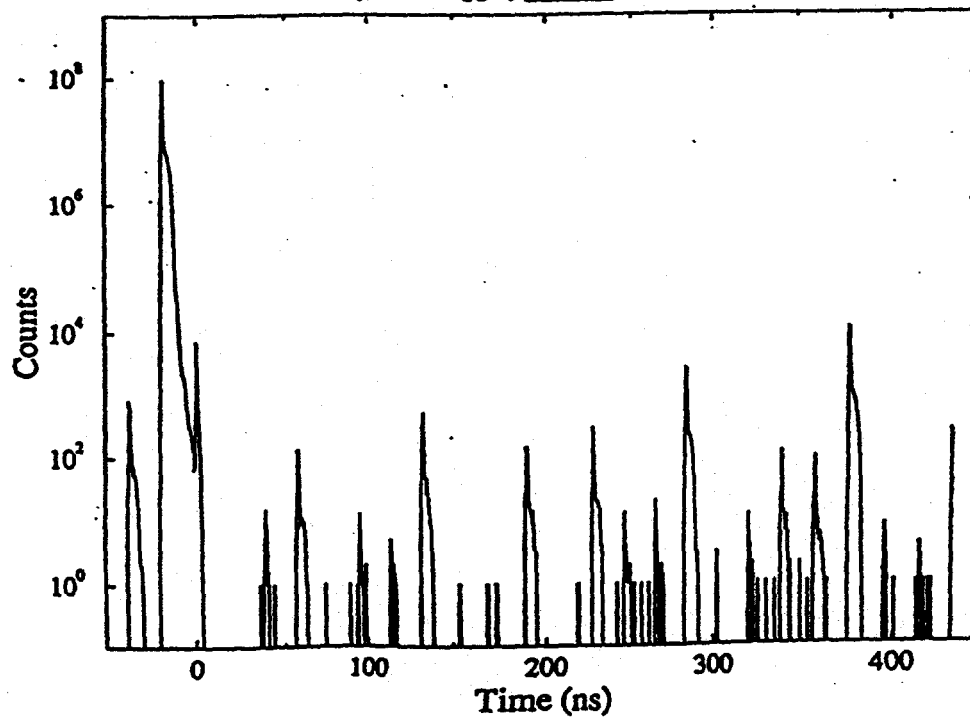
total count rate (@ 90% trigger): 100 kHz, single photon events only



~ 30 min

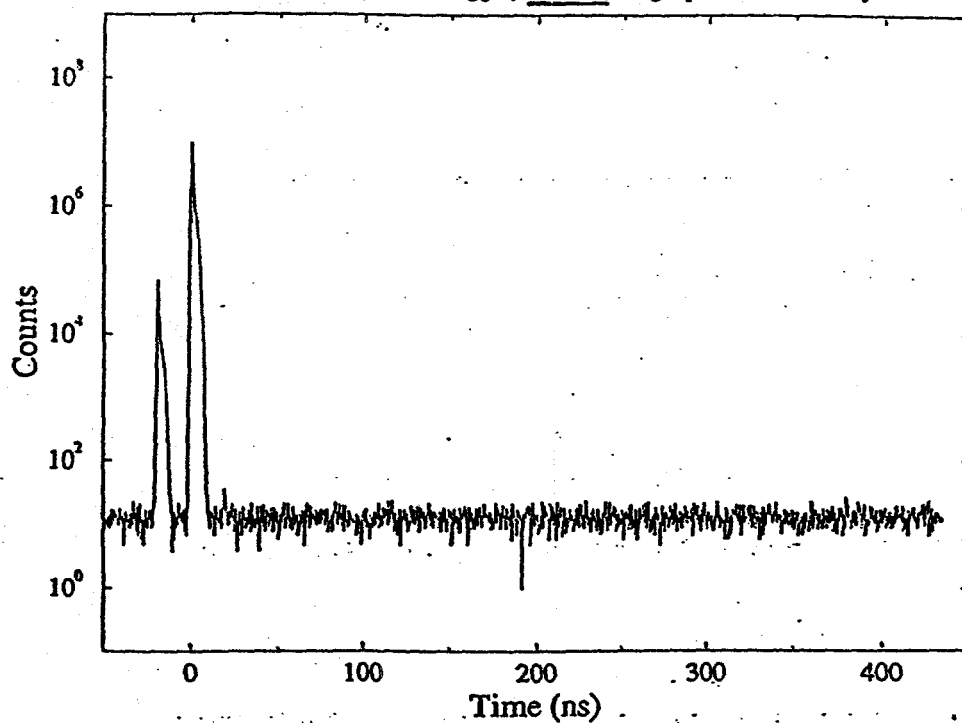
8.4 keV pulsed SR time spectrum

total count rate (@ 90% trigger): 26 MHz, single photon events only



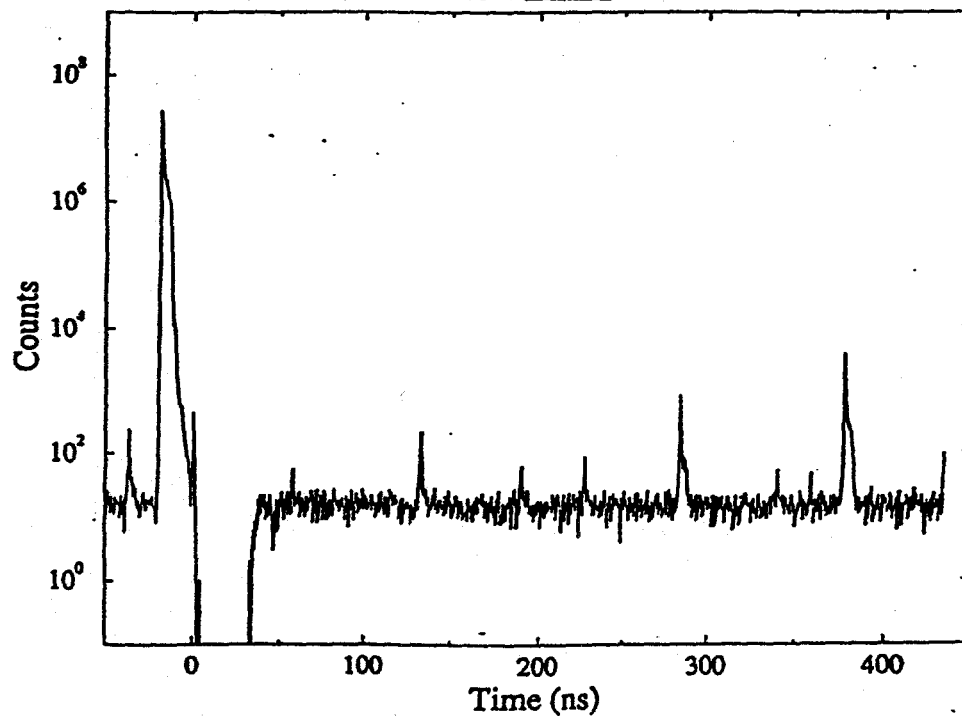
8.4 keV pulsed SR and CuK (8 keV) source

total count rate (@ 90% trigger): 70 kHz, single photon events only



8.4 keV pulsed SR and CuK (8 keV) source

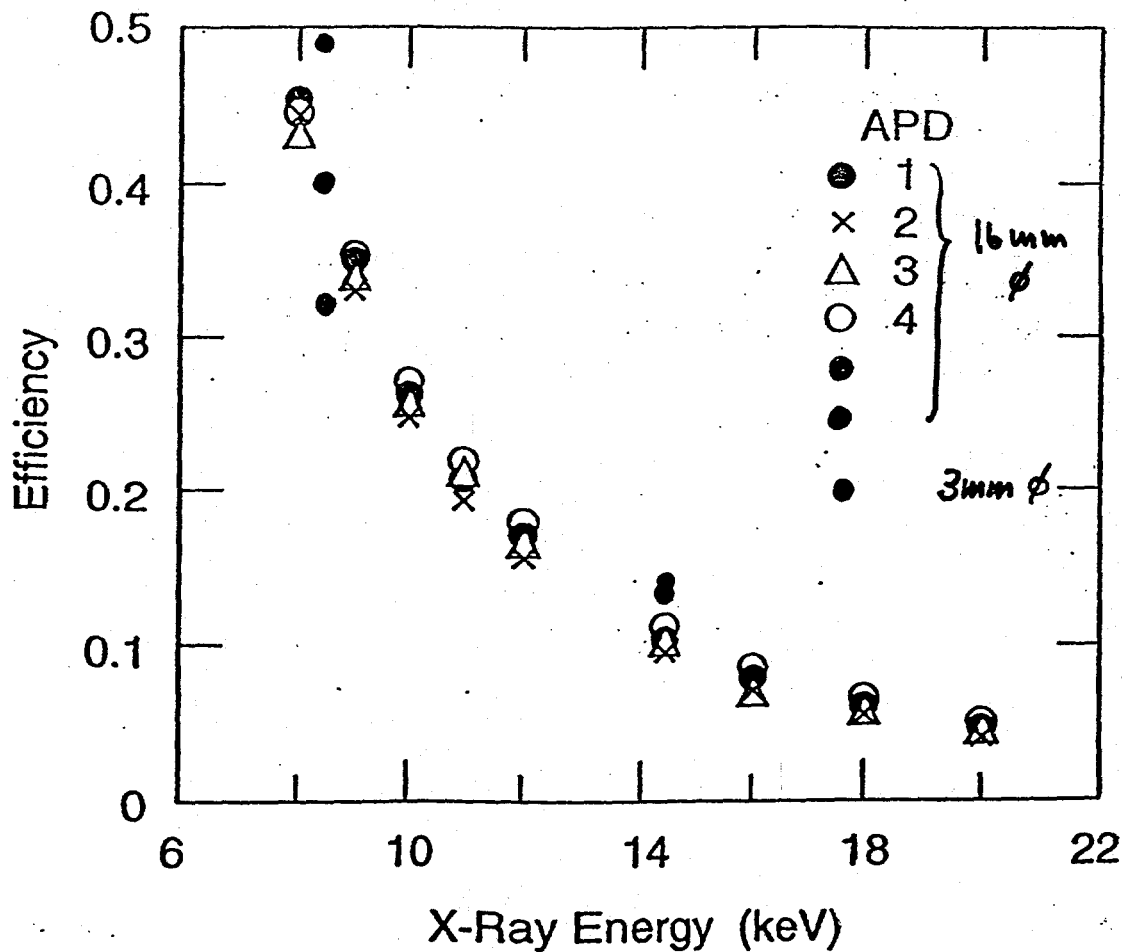
total count rate (@ 90% trigger): 26 MHz, single photon events only



Efficiency

- the efficiency is determined by the thickness of the active zone and by the substrate material

here: active zone ~ 50 μm
 substrate silicon



1..4

A. G. R. Baron et al.

Conclusion

- FPDs have a very good time resolution and a good energy resolution
- FPDs were used for multiphoton counting and thus linear behaviour up to 10^8 Hz was demonstrated
- the noise level was well below 0.01 Hz
- reasonable efficiencies can be achieved up to 20 keV

Richard C. Schirato

Science Applications International Corporation

**Application of Bulk-Grown $\text{Cd}_{1-x}\text{Zn}_x\text{Te}$ Alloys to
Single-Photon X-ray Imaging**

Richard C. Schirato, Raulf M. Polichar
and John H. Reed

We have fabricated monolithic x- and gamma-ray detector arrays using various $\text{Cd}_{1-x}\text{Zn}_x\text{Te}$ alloys in both linear and area geometries with associated read-out systems. Advantages of these materials include relatively high stopping power and room-temperature operation. The arrays have been operated in a pulse-counting mode with photon energy discrimination. So far, we have fabricated arrays with a pixel pitch as small as 0.8 mm. Our results show that even smaller pitches should be possible. The effects of material properties and array geometry on spatial and energy resolution will be discussed, with emphasis upon charge carrier transport. Results from calculational models and experimental measurements of pulse height vs event interaction position within a pixel will be presented, along with images obtained with these arrays. The experimental results include data from arrays recently fabricated from new High-Pressure Bridgeman-grown $\text{Cd}_{0.9}\text{Zn}_{0.1}\text{Te}$ material with improvements in both electron and hole mobility lifetime products. Possible areas of application for systems based on this technology include nuclear medicine, low-dose simultaneous dual-energy radiography, nonproliferation inspection, NDE, and x-ray astronomy.



APPLICATION OF BULK-GROWN $\text{Cd}_{1-x}\text{Zn}_x\text{Te}$ ALLOYS TO SINGLE-PHOTON X-RAY IMAGING

Presented to:

ADVANCED PHOTON SOURCE WORKSHOP ON DETECTORS
FOR THIRD GENERATION SYNCHROTRON SOURCES
Argonne National Laboratory

Presented by :

R.C. Schirato, R.M. Polichar, J.H. Reed
SCIENCE APPLICATIONS INTERNATIONAL CORPORATION
4161 Campus Point Court, San Diego, California 92121
(619) 458-3779

February 14 and 15, 1994



Science Applications
International Corporation

ADVANTAGES OF SOLID STATE IONIZATION DETECTORS

- HIGH EFFICIENCY POSSIBLE
- LARGE SIGNAL CURRENTS (Relative to
Scintillators - Photodiodes)
- FAST COLLECTION TIME
- ADAPTABLE TO BOTH PULSE COUNTING AND
CURRENT MODE
- CAN BE MADE AS MONOLITHIC ARRAYS

USE OF MONOLITHIC ARRAYS FOR X-RAY AND GAMMA-RAY IMAGING DEVICES

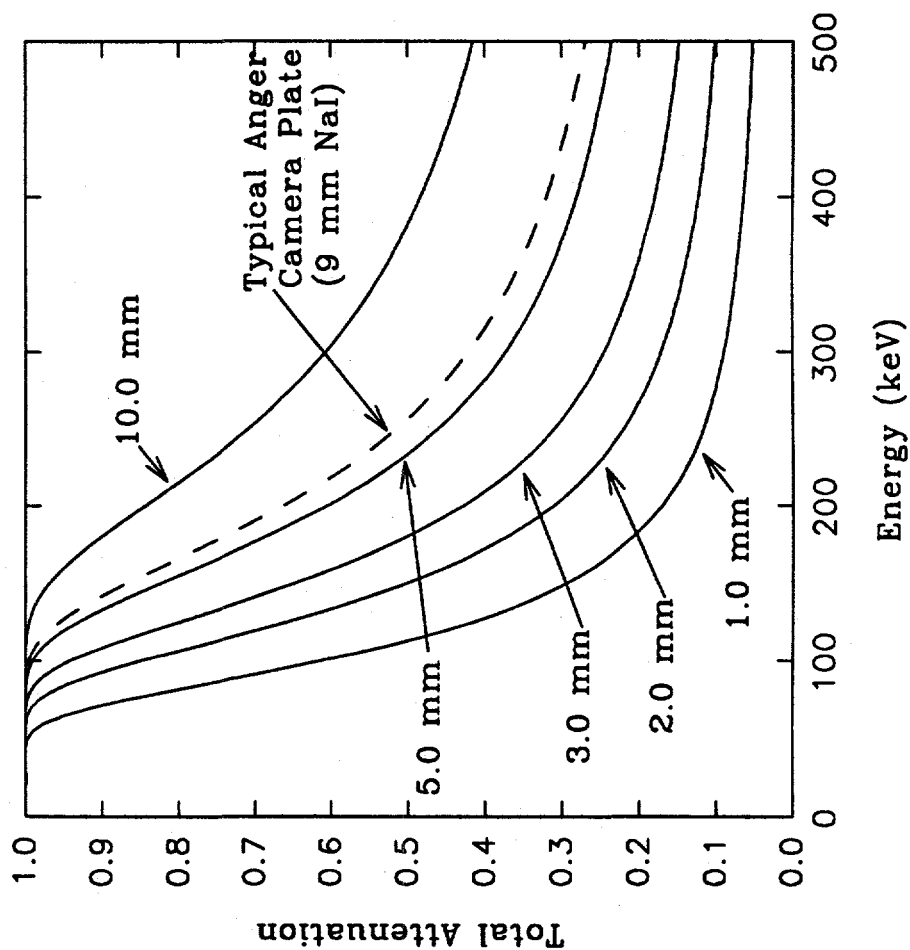
- GOOD DIRECTIONAL CHARGE COLLECTION IN HIGH-FIELD MONOLITHIC DEVICES GIVES CROSSTALK PERFORMANCE COMPETITIVE WITH DISCRETE DEVICES
- VACUUM DEPOSITION OF CONTACTS MAKES LARGER AND MORE COMPLEX DEVICES PRACTICAL
- FABRICATION COSTS OF MONOLITHIC ARRAYS ARE LESS THAN COMPARABLE MULTIPLE DISCRETE DEVICE ARRAYS
- READOUT FOR BOTH LINEAR AND AREAL ARRAYS DEMONSTRATED
- TECHNOLOGY OF MONOLITHIC CONSTRUCTION DEMONSTRATED AND AVAILABLE NOW

ADVANTAGES OF USING HIGH PRESSURE BRIDGMAN GROWN CdTe AND CdZnTe FOR DETECTORS AND ARRAYS

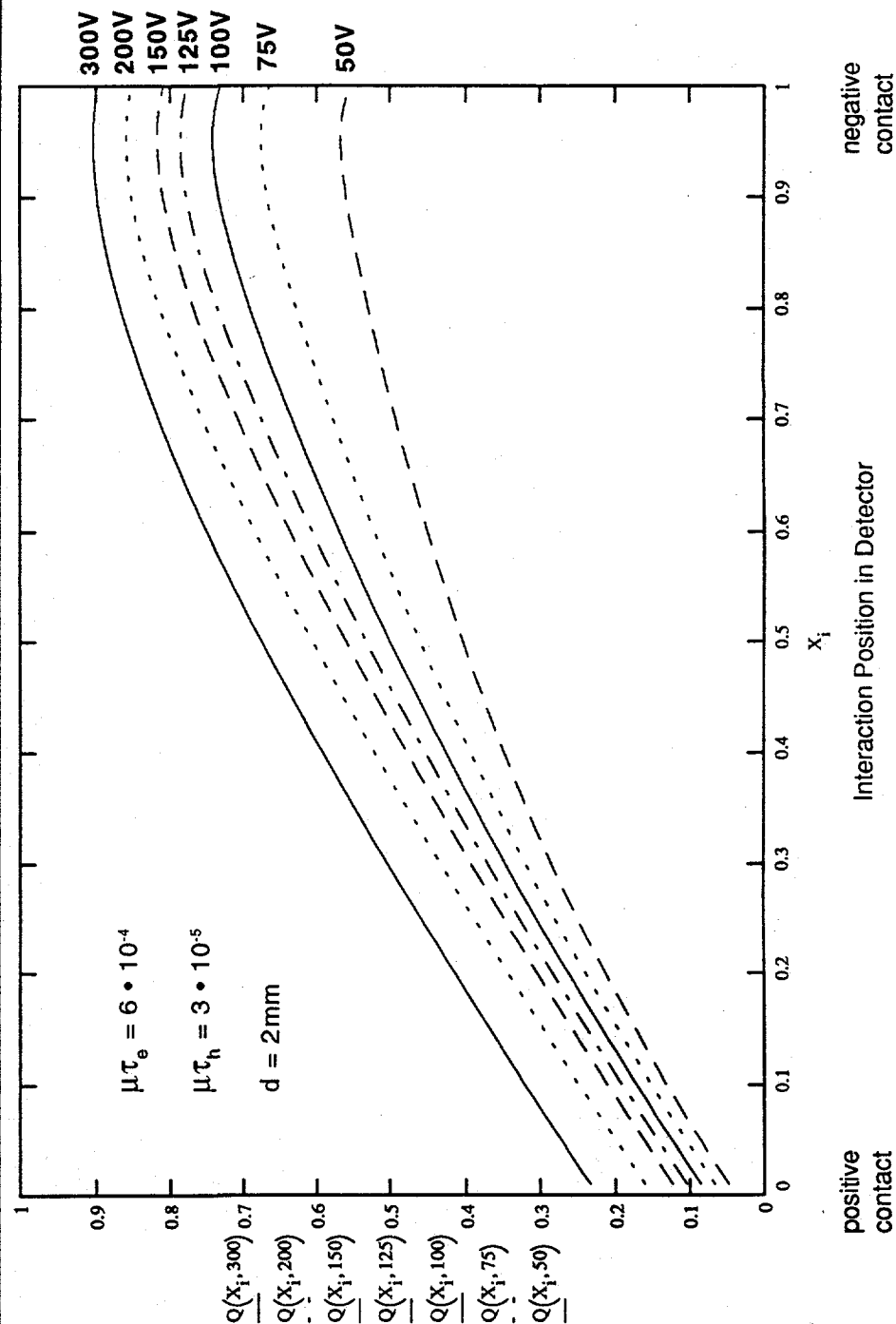
- **LARGE AREA BOULE CROSSECTION ALLOWS FLEXIBLE USE OF MATERIALS**
- **NEW REFINING METHODS RESULT IN HIGHER RESISTIVITIES (>10" OHM-cm) AND LONGER CARRIER LIFETIMES**
- **UNIFORMITY OVER CROSSECTION PERMITS FABRICATION OF LARGE MONOLITHIC ARRAYS**
- **SEVERAL RELIABLE SOURCES OF MATERIALS ALLOW ONE TO FOCUS ON DETECTOR FABRICATION AND SYSTEMS**
- **NEW PROCESSING METHODS ARE ALREADY LEADING TO LOWER COSTS AND HIGHER PERFORMANCE DEVICES**

APPLICATION OF MONOLITHIC CdTe and CdZnTe DETECTOR
ARRAYS TO NUCLEAR AND X-RAY IMAGING

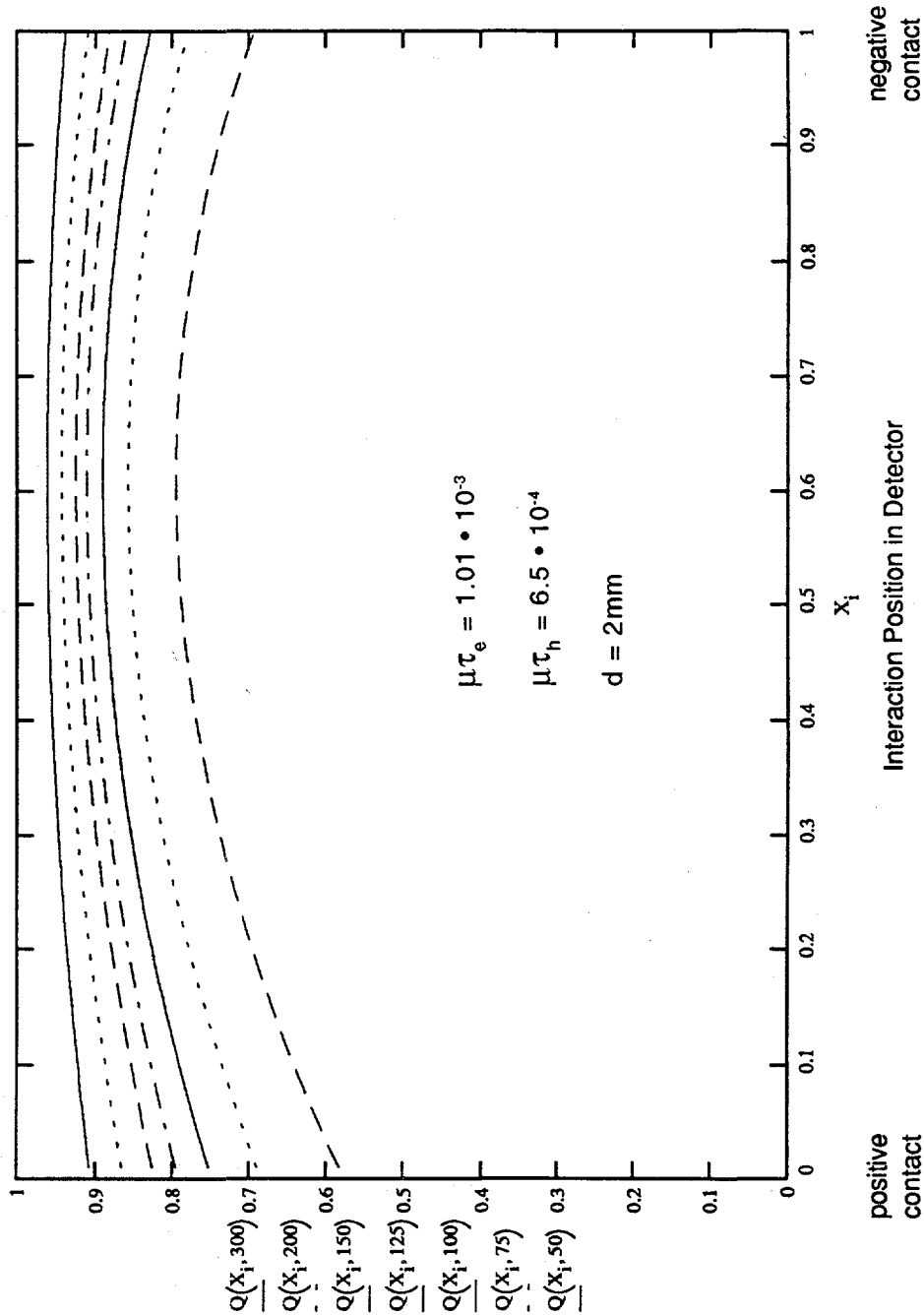
**COMPARISON OF GAMMA RAY EFFICIENCY
FOR DIFFERENT THICKNESS OF CdZnTe
AND A STANDARD NaI ANGER PLATE**



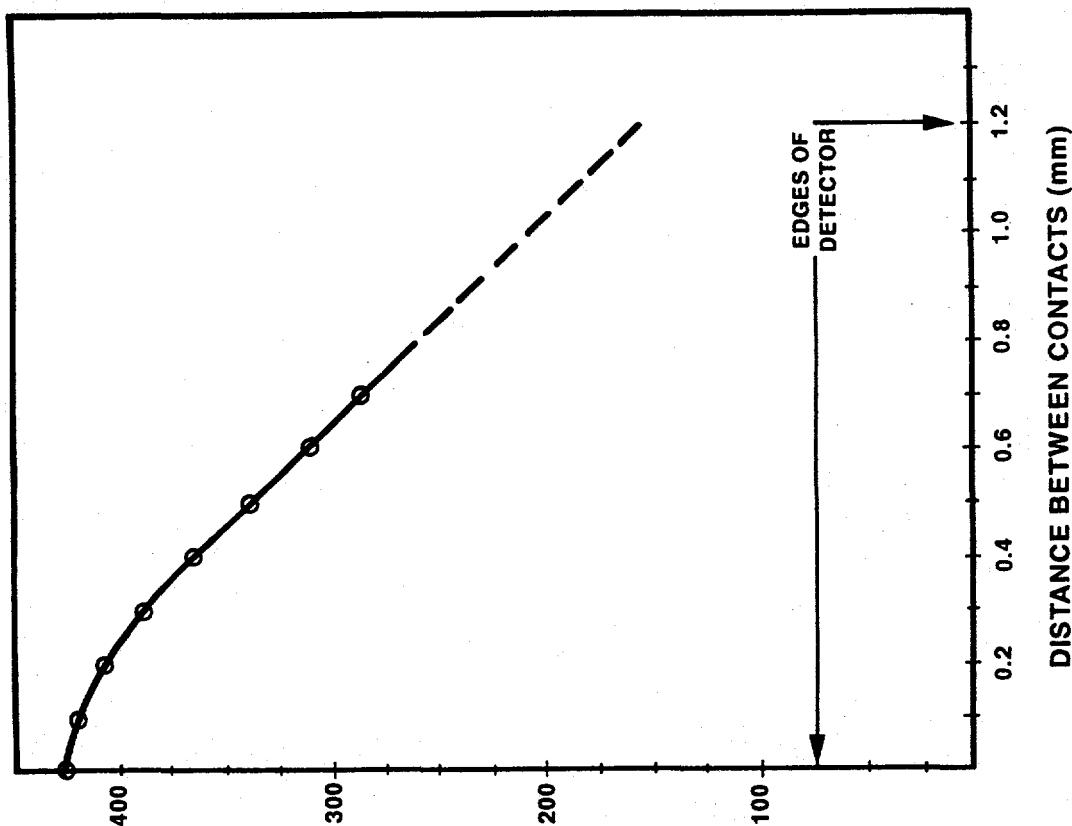
CALCULATION OF RELATIVE CHARGE OUTPUT, Q AS A FUNCTION OF INTERACTION POSITION



CALCULATION OF RELATIVE CHARGE OUTPUT, Q AS A FUNCTION OF INTERACTION POSITION



GAIN OF Am^{241} PHOTOPEAK (CHANNEL #)



MEASURED VARIATION OF DEVICE
GAIN ACROSS DETECTOR WIDTH
IS DUE TO CHARGE TRAPPING OF
HOLE CARRIERS IN EARLY CdZnTe
WHEN VIEWED BY SIDE-ENTRANCE
GEOMETRY



Science Applications
International Corporation

APPLICATION OF MONOLITHIC CdTe and CdZnTe DETECTOR
ARRAYS TO NUCLEAR AND X-RAY IMAGING

SENSOR MATERIALS EVALUATED

$\text{Cd}_{0.8}\text{Zn}_{0.2}\text{Te}$

[AURORA TECH. EARLY HPB DEVELOPMENT
MATERIAL]

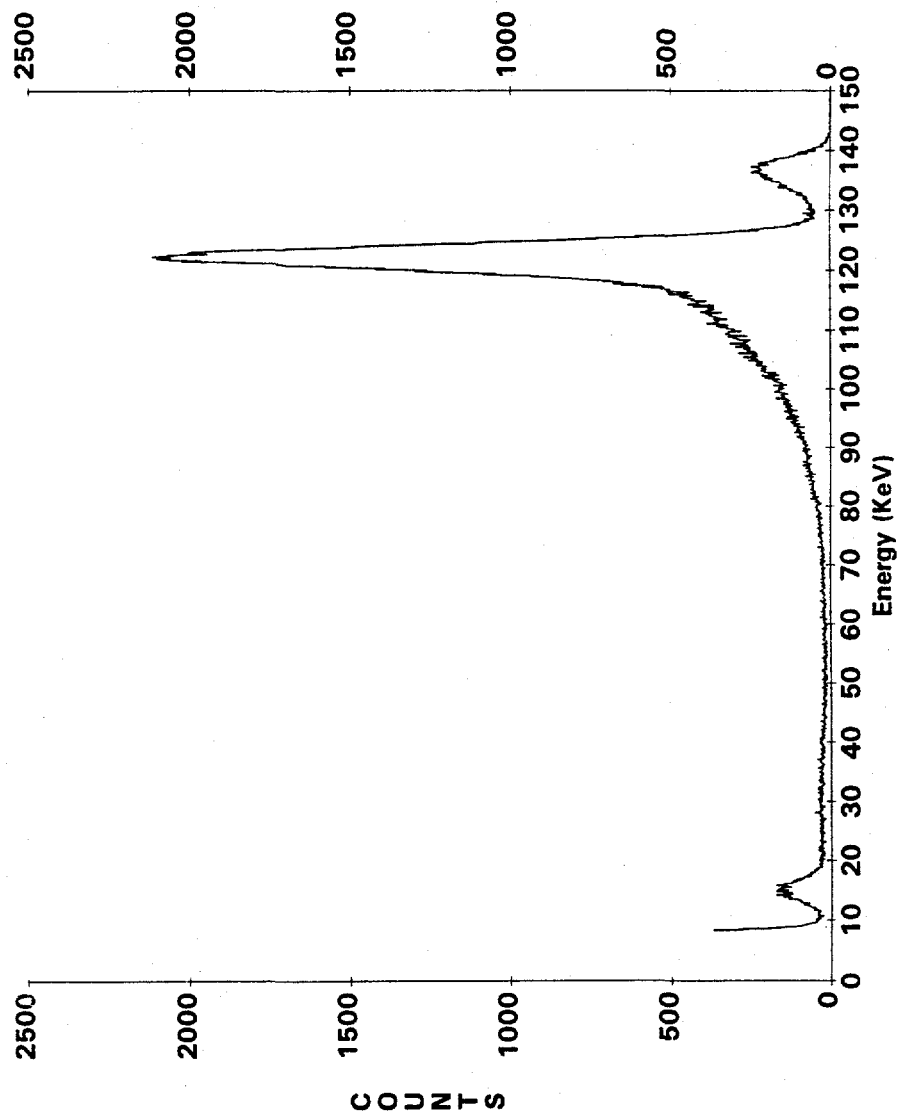
CdTe

[eV PRODUCTS / IIVI: ULTRAPURE HPB,
UNDOPED MATERIAL]

$\text{Cd}_{0.9}\text{Zn}_{0.1}\text{Te}$

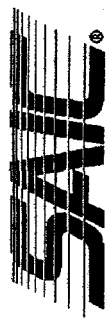
[eV PRODUCTS / IIVI: ALLOYED, HPB MATERIAL
WITH LOWER LEAKAGE AND IMPROVED CHARGE
COLLECTION]

PULSE HEIGHT SPECTRUM OF ^{57}Co (122 keV) USING A 2.5 cm THICK $\text{Cd}_{0.9}\text{Zn}_{0.1}\text{Te}$ DETECTOR



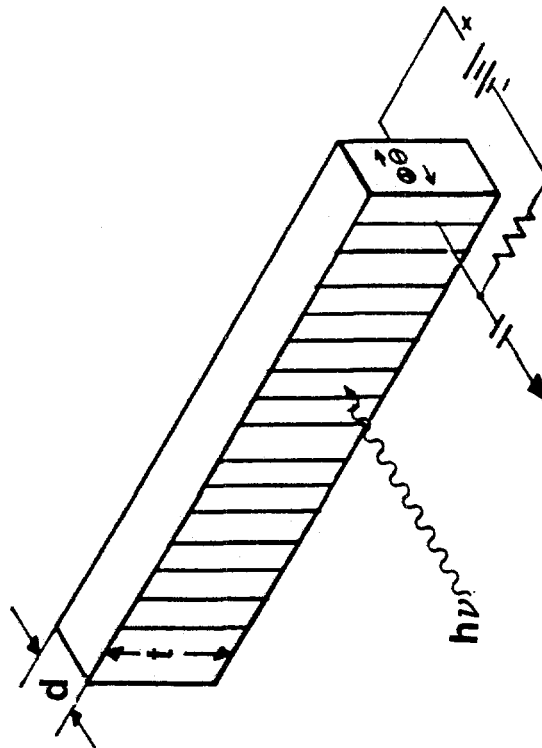
Source ^{57}Co
Crystal Size 10mm x 10mm x 25mm
Bias Voltage +2000 VDC
Shaping time 2 μsec
Oper. temp. +25° C
FWHM 4.7 %

Spectrum Courtesy eV Products

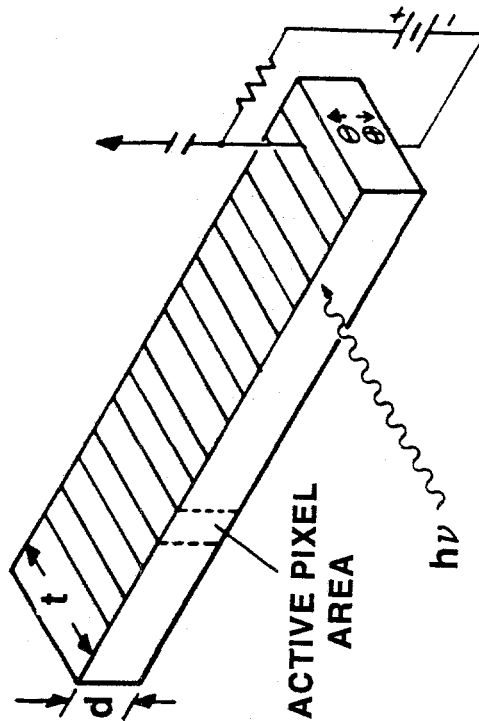


Science Applications
International Corporation

CdZnTe LINEAR SCANNER ILLUMINATION GEOMETRY



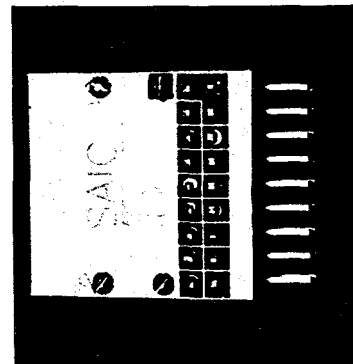
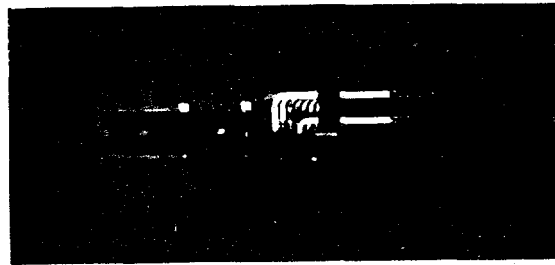
Standard Geometry
Gammas Enter Neg Contact
Best Energy Resolution for Low-Energy Radiation
Limited Stopping Power Because
Charge Collection Limits Depth



Side Illuminated Geometry
Poorer Resolution for Low-Energy Gammas
Enhanced Efficiency for Higher Energies
Shows Promise for High-Energy Spectrometers

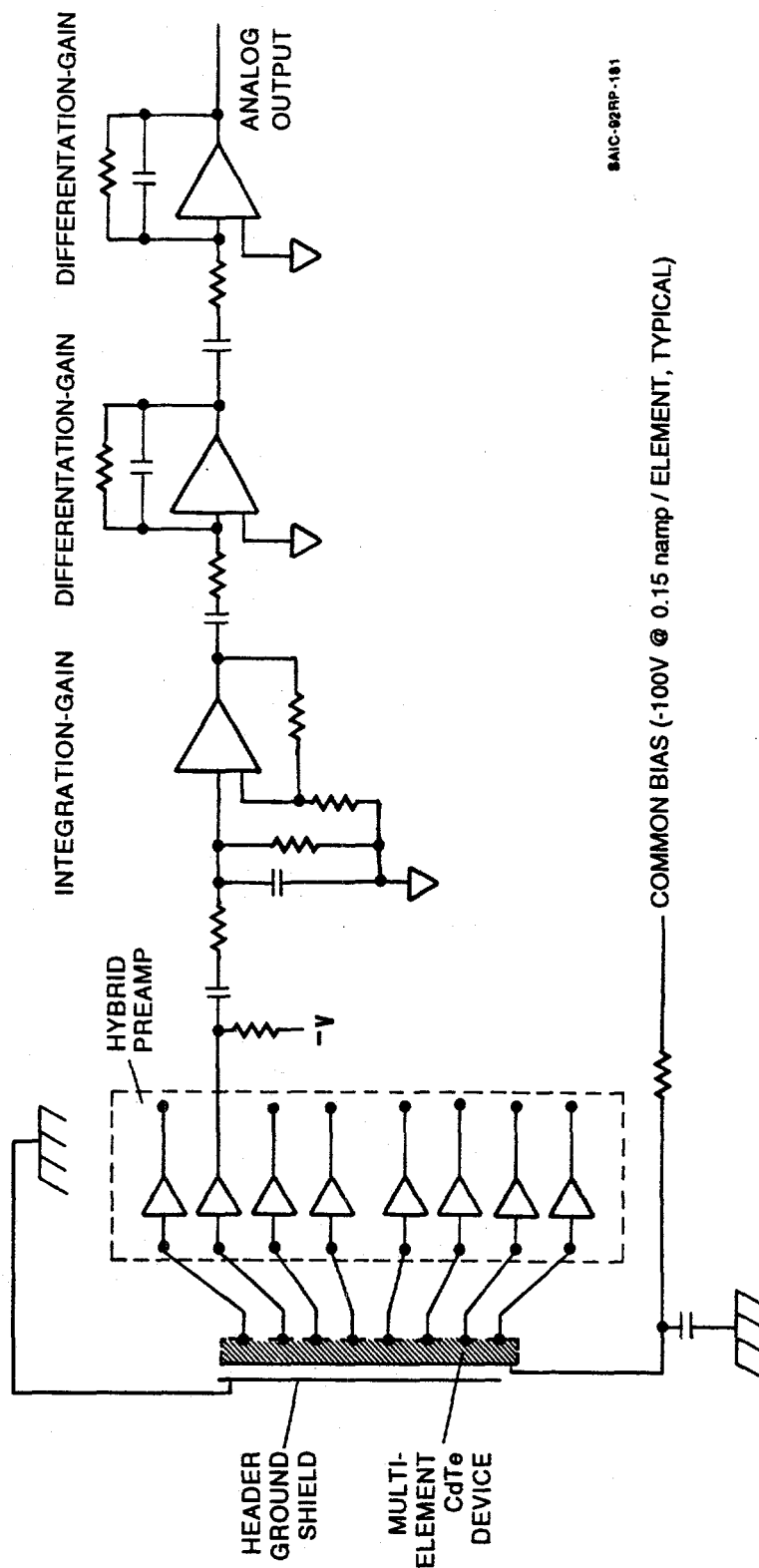
16- ELEMENT CdZnTe LINEAR ARRAY MOUNTED ON PLUG-IN HEADER ASSEMBLY

SAIC
Science Applications
International Corporation



SAIC-92RP-185

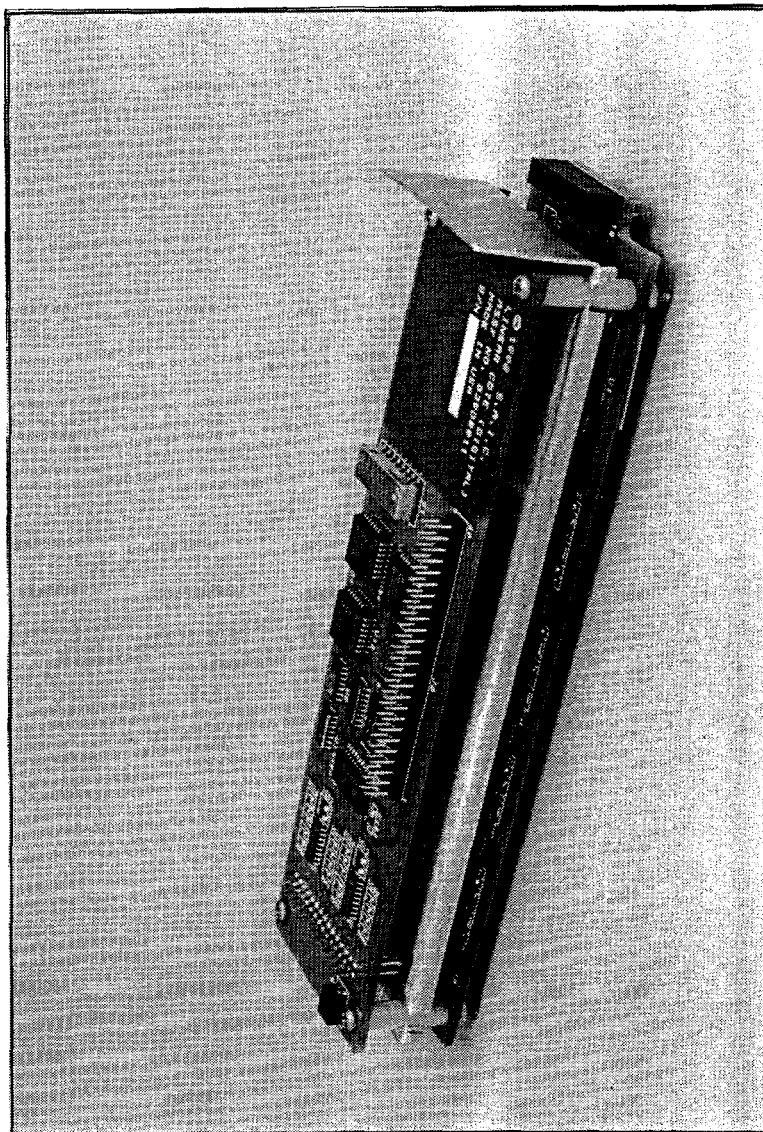
**UNIQUE DC BIASING OF MULTI-ELEMENT DEVICE
REDUCES NOISE FROM BIAS RESISTOR, BUT
DEPENDS ON LOW-LEAKAGE CURRENT DEVICES
SUCH AS CdZnTe**





Science Applications
International Corporation

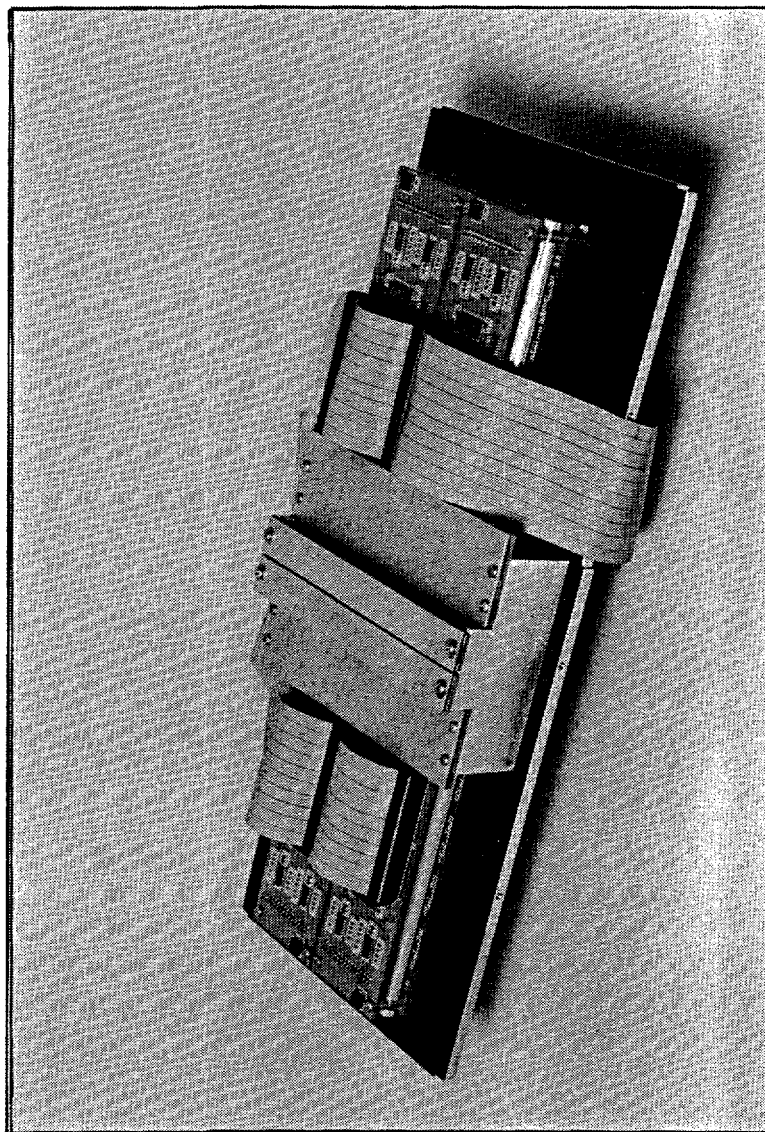
COMPLETED 16-CHANNEL READOUT SYSTEM INCLUDES ALL ANALOG PULSE SHAPING, COMPARATORS AND BUFFERED DIGITAL OUTPUTS



SAIC-92RP-189

64-CHANNEL LINEAR SCANNER PROTOTYPE USING FOUR CASCADED ARRAYS

SAIL[®]
Science Applications
International Corporation

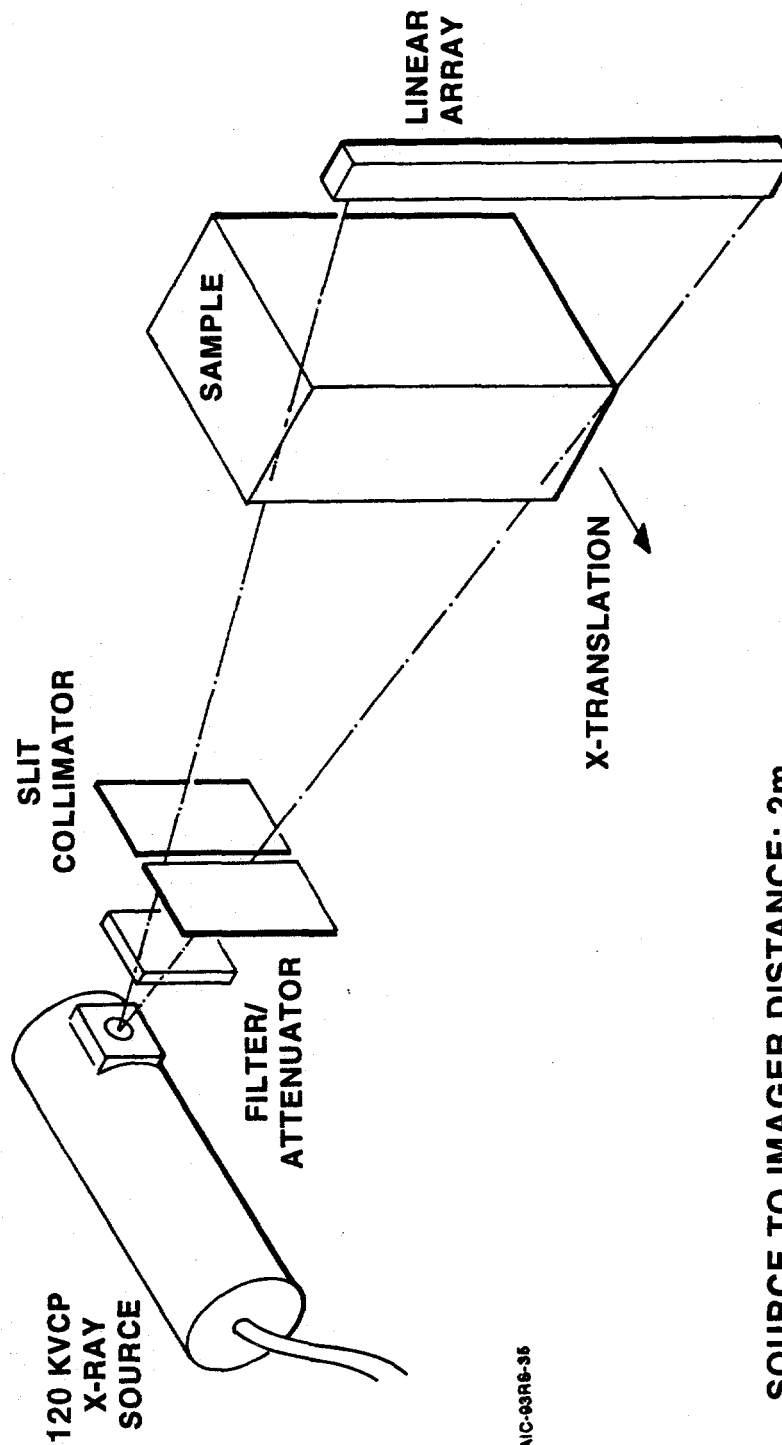


SAIC-92RP-190



Science Applications
International Corporation

LINEAR SCANNER TRANSMISSION RADIOGRAPHY



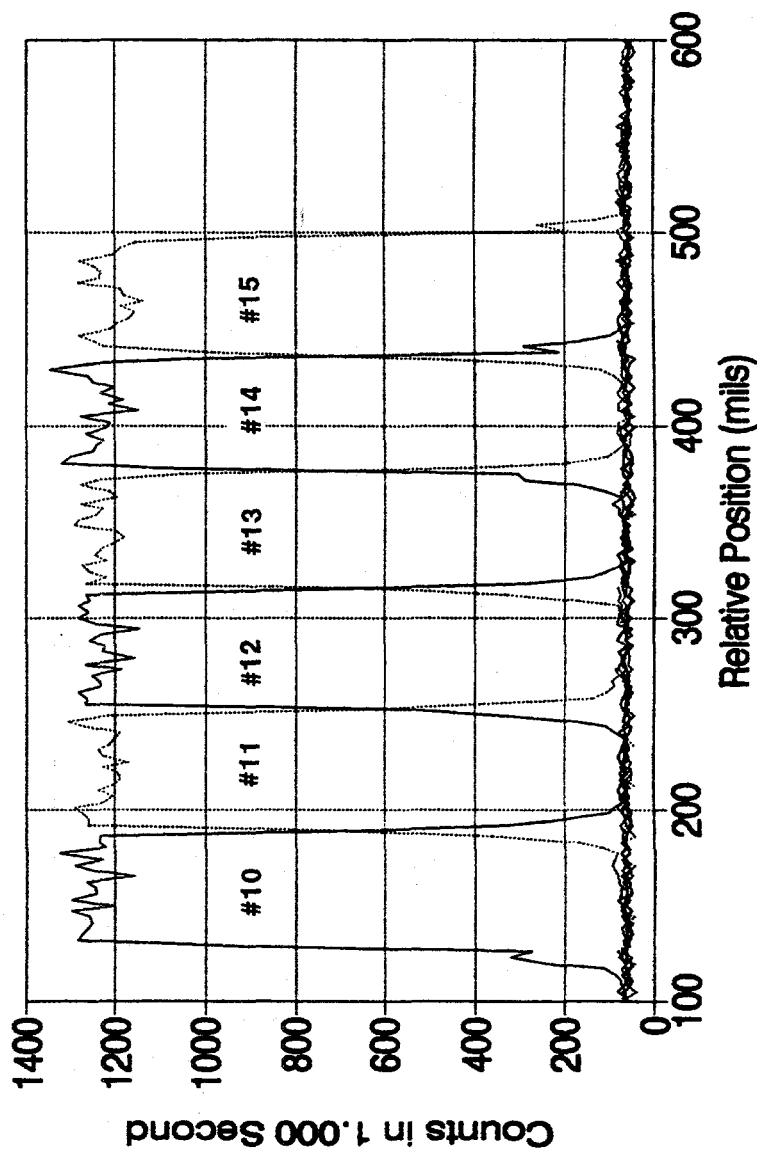
SAIC-93RS-35

SOURCE TO IMAGER DISTANCE: 2m
ATTENUATOR: 0.22cm Cu
SOURCE PARAMETERS: 120 kV POTENTIAL, <0.5mA CURRENT

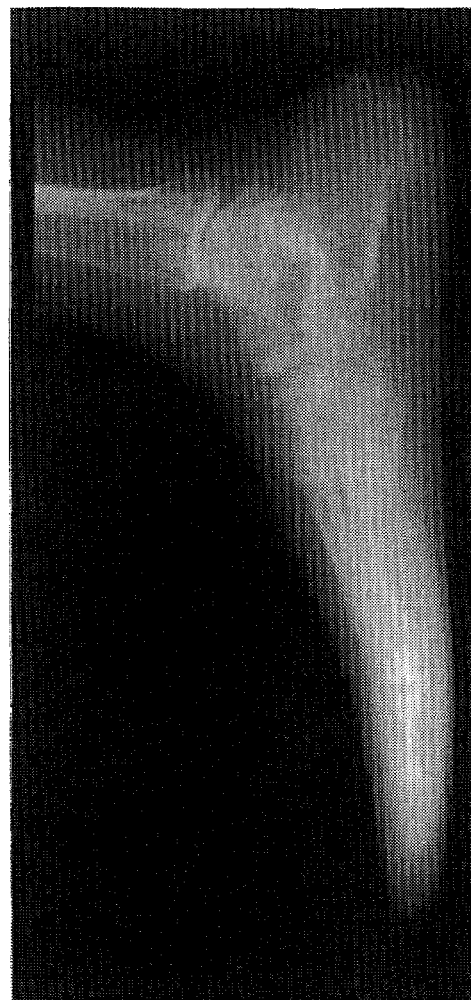
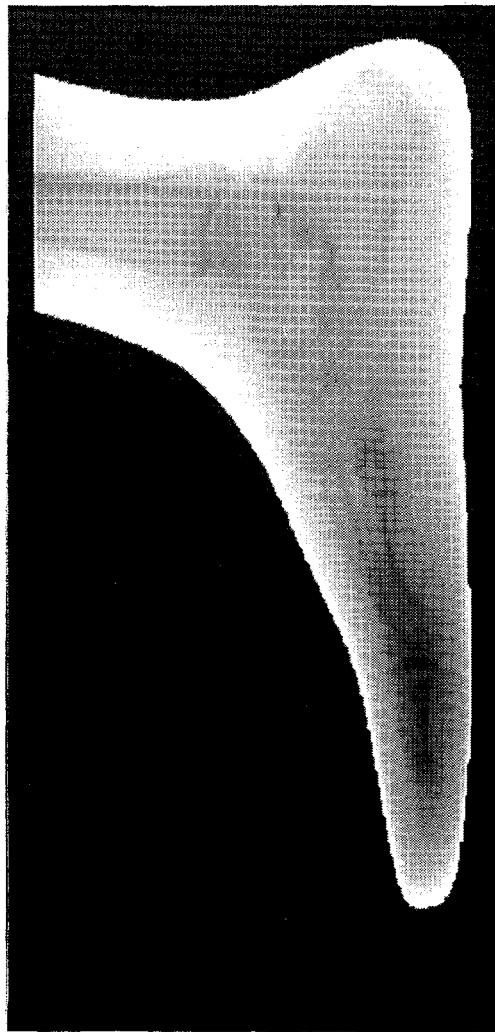
SAIC-93RS-35

COUNTS AS A FUNCTION OF POSITION CdZnTe LINEAR ARRAY #109

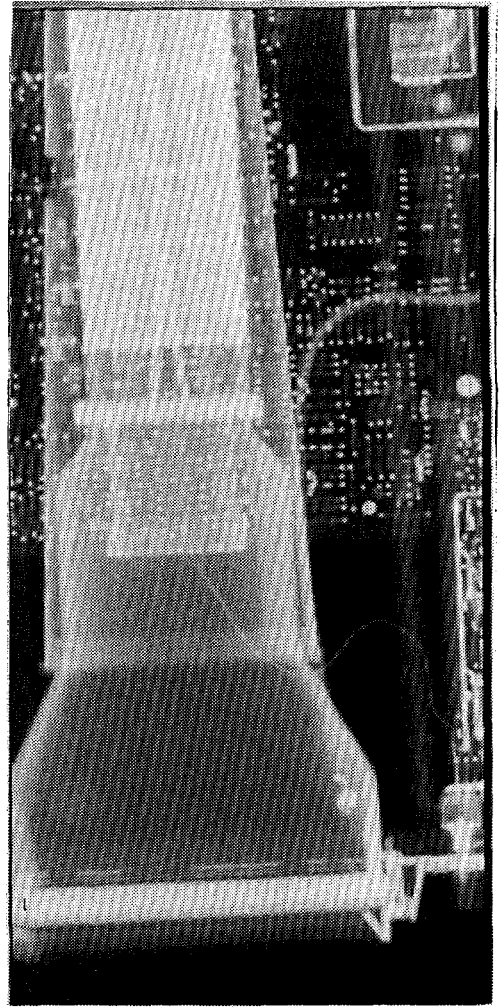
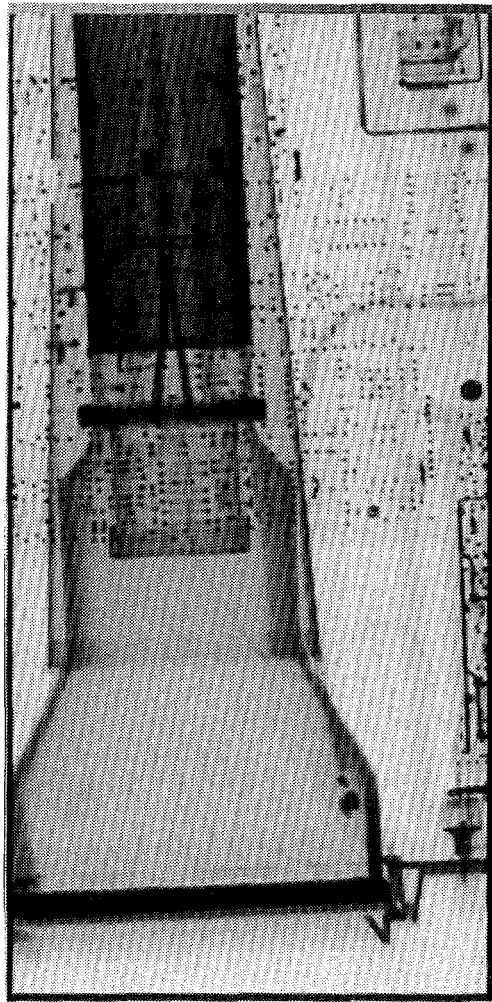
120V Bias, DAC Threshold = 50, 125kV CP X-Ray Source, Slit Size = 5 mils,
88 mil Cu Filter.



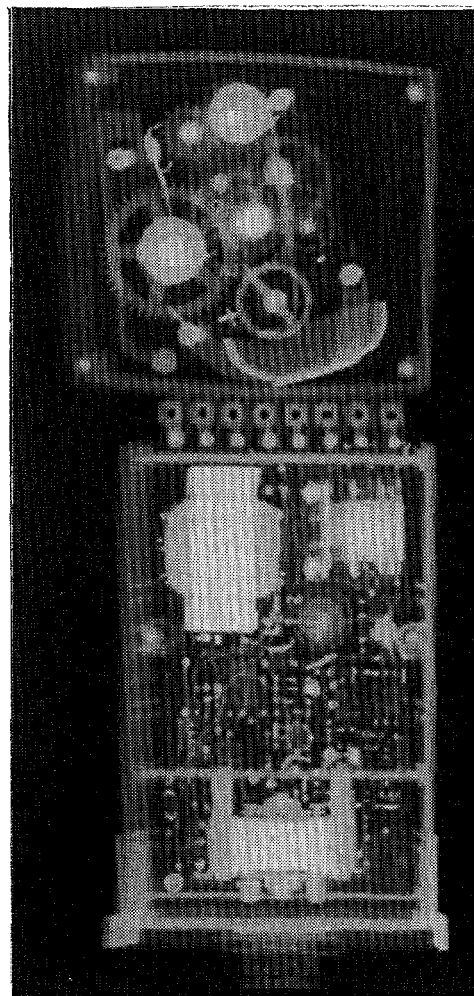
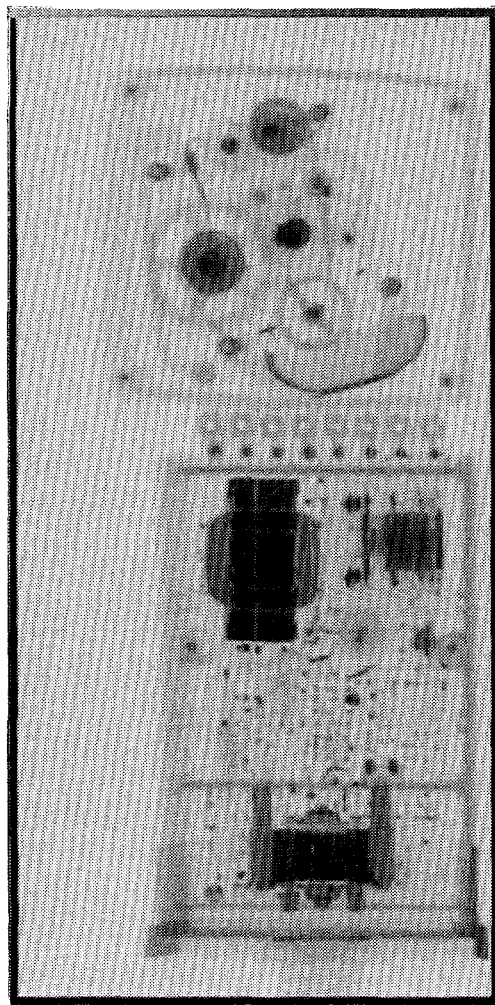
LOW-DOSE, LINE-SCAN X-RAY IMAGE OF FOOT PHANTOM

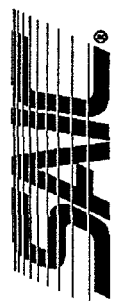


LOW-DOSE, LINE-SCAN X-RAY IMAGE OF LABORATORY OSCILLOSCOPE



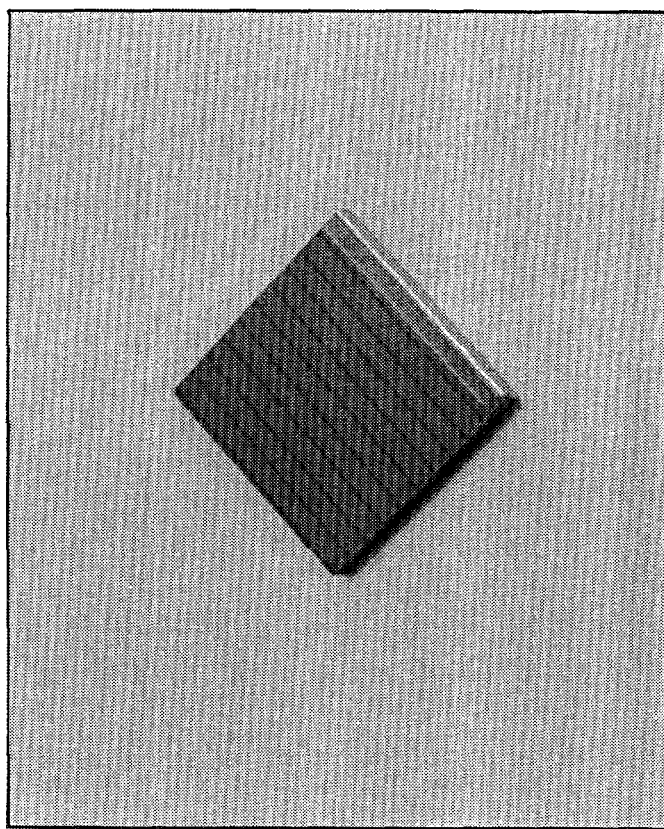
LOW-DOSE, LINE-SCAN X-RAY IMAGE OF CLOCK AND THERMAL CONTROLLER





Science Applications
International Corporation

10 x 10 ELEMENT CdZnTe AREA ARRAY



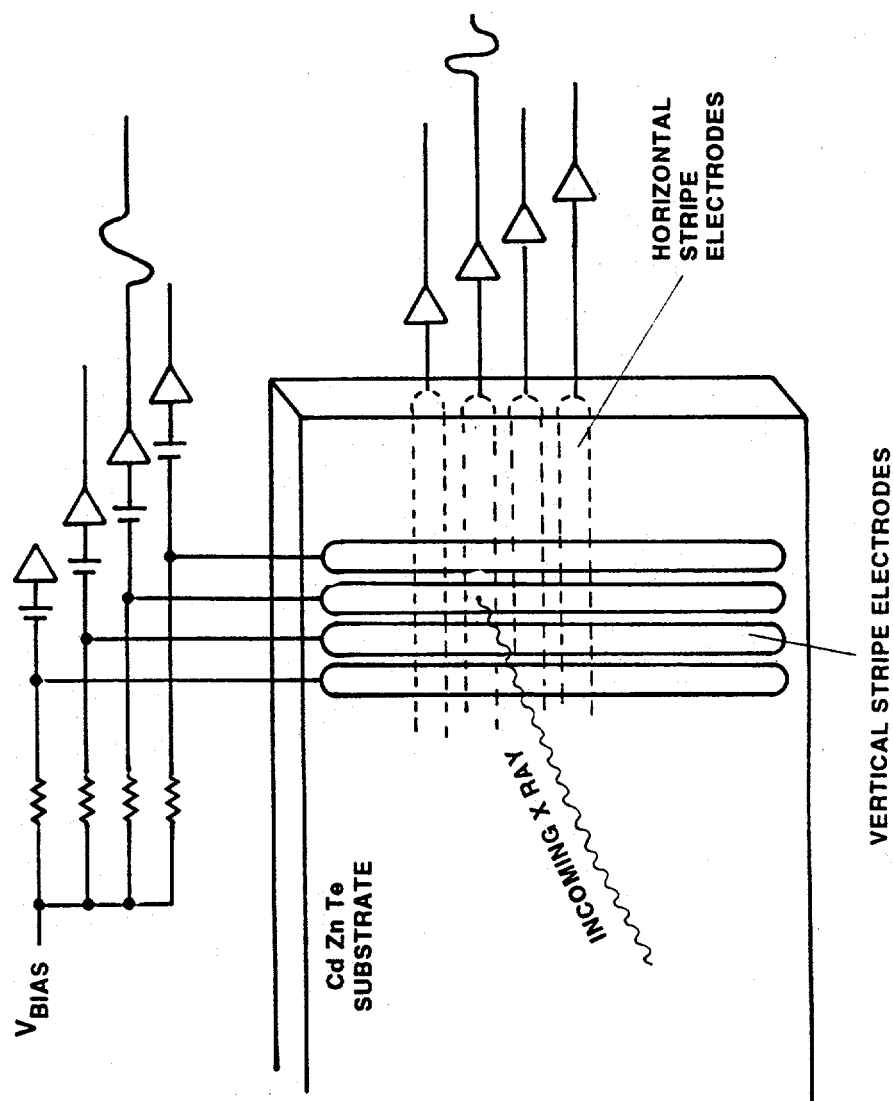
SIZE: 1 X 1 cm

PITCH: 1.0 mm

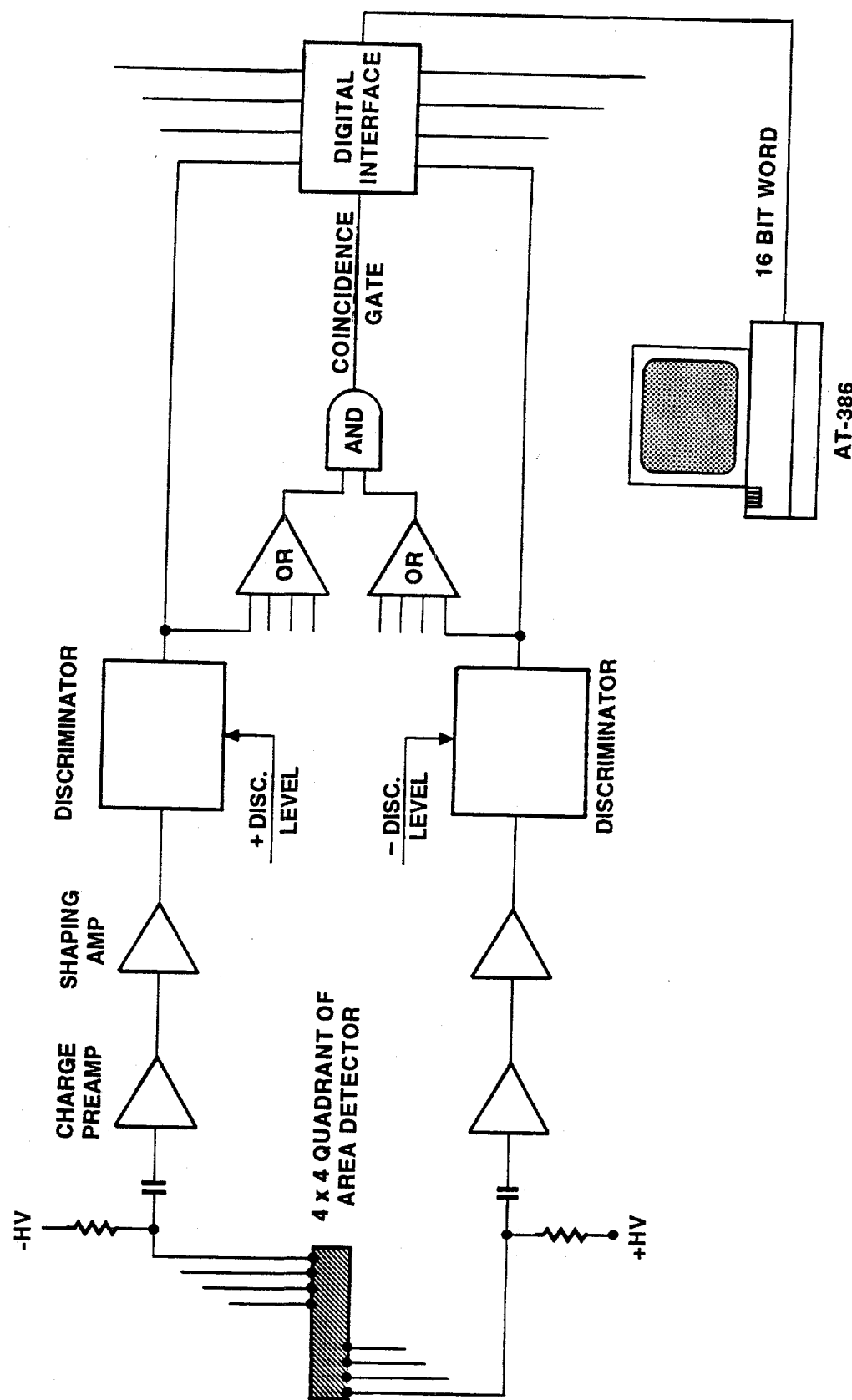
THICKNESS: 1.8 mm

SAIC-92FP-187

COINCIDENT CHARGE READOUT FOR A CdZnTe DETECTOR ARRAY



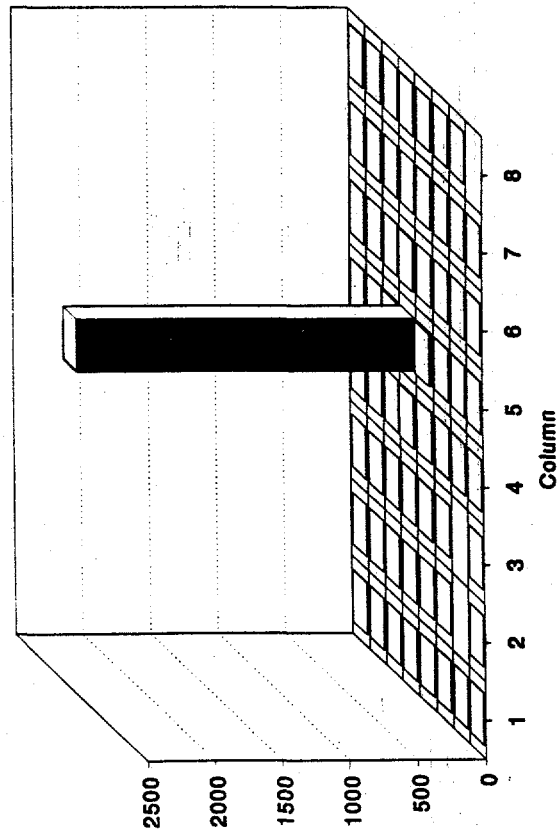
PULSE ACQUISITION AND PROCESSING USED FOR "AREA" ARRAYS



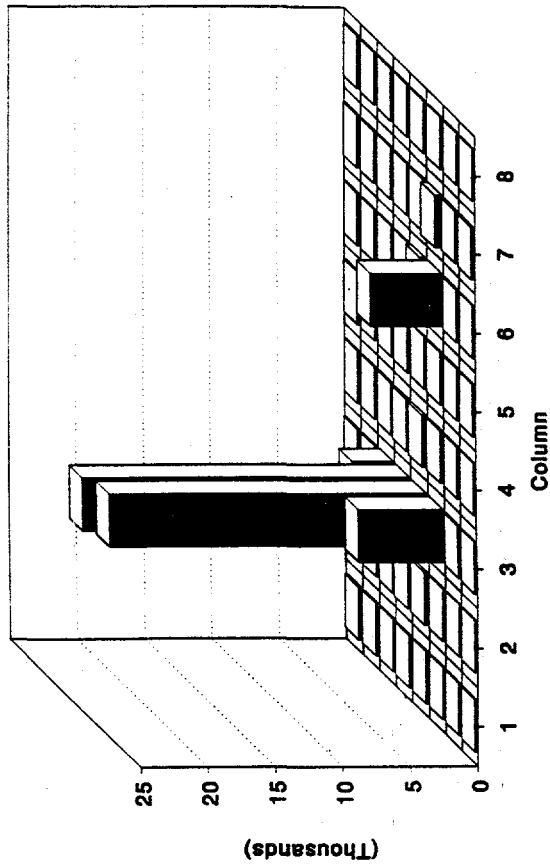
SAIC-92RS-41

GAMMA-RAY IMAGING DATA FROM PROTOTYPE CdTe ARRAY

8 x 8 Array Pinhole Image
1 mCi Am-241 Source, 1 mm Diameter

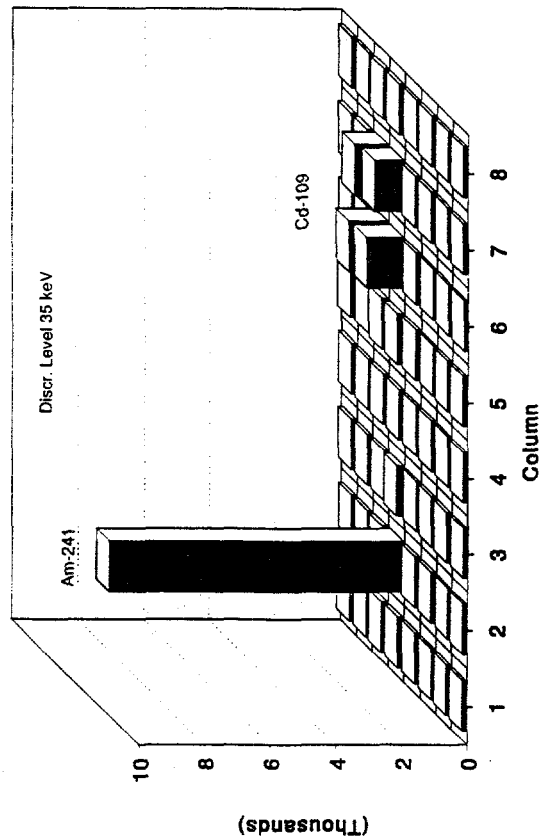


8 x 8 Array Pinhole Image
Two Am-241 Sources



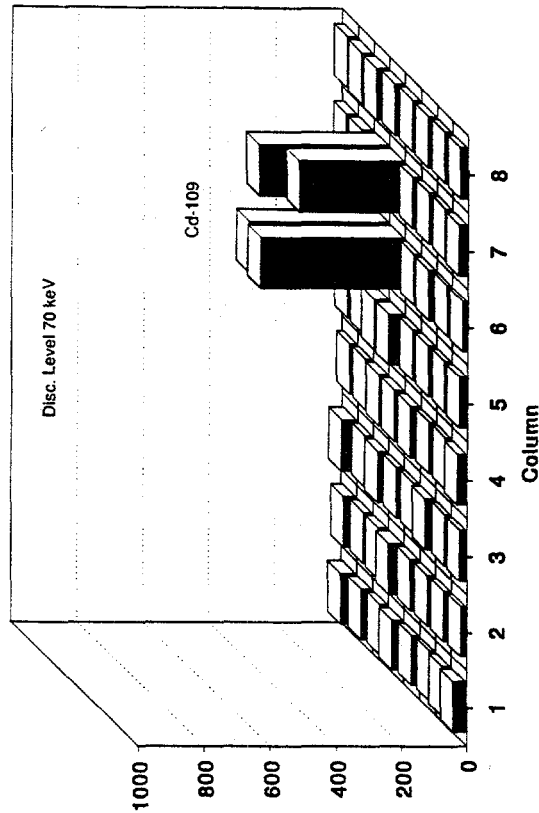
GAMMA-RAY DATA ILLUSTRATES ENERGY DISCRIMINATION CAPABILITIES

8 x 8 Array Pinhole Image
1.0 mCi Am-241, 1.6 mCi Cd-109



DISCRIMINATING LEVEL $\approx$ 35 keV

8 x 8 Array Pinhole Image
1.0 mCi Am-241, 1.6 mCi Cd-109



DISCRIMINATING LEVEL $\approx$ 70 keV

Sung Shik Yoo

Department of Physics
University of Illinois

**MBE CdTe Photoconductive Position
Sensitive X-ray Detectors***

The group II-VI compound semiconductors, such as CdTe, are very attractive for x-ray detectors because of their large atomic numbers. Since the band gap is fairly large (1.46 eV), the dark current is small enough to operate the devices at room temperature. MBE growth of CdTe has been greatly improved to provide high-quality crystals. To date, 125 arcsec of DCRC FWHM has been obtained on Si substrates. We fabricated 10-20 μm thick MBE CdTe layers for application as x-ray detectors. Thirty-two or sixty-four element linear photoconductor arrays were fabricated on MBE CdTe layers. The photoconductor gap size varies from 5 to 50 μm with 50- μm width and 100- μm pitch sizes.

The temporal response was measured by using 100 fsec Ti:Sapphire laser pulses, values of 25 psec rise time and 35 psec pulse width were measured on the devices. The spatial response was measured by using a Nd:YAG laser, x-rays from a rotating anode, and synchrotron x-rays (NSLS). We also measured the energy response of the device over a wide range of energies (7-18 keV). The image of the beam profile was obtained for the direct and the partially attenuated beams by rastering a single photoconductor around the x-ray beam. In the synchrotron direct beam, no saturation response was observed. The noise was small enough so that the dynamic range reaches three decades at room temperature in spite of the small size of the active area. The photoconductor was exposed to the synchrotron beam for 60 hours without any observable deterioration of the device.

* Work supported by the US DOE.

MBE CdTe PHOTOCONDUCTIVE POSITION SENSITIVE X-RAY DETECTORS*

S. S. Yoo¹, B. Rodricks², S. Sivananthan¹, J. Bai^{3,4},
J. P. Faurie¹, and P.A. Montano^{1,4}

¹Department of Physics
Microphysics Laboratory
University of Illinois at Chicago
Chicago, IL 60607

²Advanced Photon Source
Argonne National Laboratory
Argonne, IL 60439

³Department of Physics,
Brooklyn College of CUNY,
Brooklyn, NY

⁴Material Science Division
Argonne National Laboratory
Argonne, IL 60439

* Work supported by the US DOE

MOTIVATION

1. Diagnosis for Ultrashort X-ray Pulses

- * 72 psec pulsewidth
- * 184 nsec period

2. Position Sensitive Detector

- * 5-50 x 50 μm sensitive area
- * 100 μm pitch size
- * High spatial resolution

CdTe FOR X-RAY DETECTION

1. Large Atomic Number

- * Cd:48, Te:52

- * Large absorption coefficient

- ($\mu = 500 - 1000 \text{ cm}^{-1}$ for 5 - 20 KeV)

2. Wide Band Gap

- * $E_g = 1.48 \text{ eV}$

- * $\rho = 10^8 - 10^{11} \Omega\text{-cm}^{-3}$

3. Excellent Carrier Transportation Property

- * $\mu_e = 1000 \text{ cm}^2/\text{V-sec}$

- * $\mu_h = 200 \text{ cm}^2/\text{V-sec}$

4. Room Temperature Operation

MOLECULAR BEAM EPITAXY OF CdTe

1. High Quality Crystal
 - * DCRC FWHM of 125 arcsec on Si substrate

2. Thin Film Growth
 - * 10 - 20 μm Thickness
 - * Increased spatial resolution

3. Flexible Choice of Substrates
 - * Insulating
 - * Conducting
 - * Semiconducting

FABRICATION

1. Molecular Beam Epitaxy of CdTe
 - * High quality of CdTe on Si substrate
 - * 10 - 20 μm thickness

2. Mounting on Insulating Substrate
 - * Removal of Si Substrate
 - * Surface etching of CdTe

3. 1st Photolithography
 - * Device isolation

4. Device Isolation
 - * Etching between elements

FABRICATION

5. 2nd Photolithography

- * 5-50 μm photoconductor gap
- * 50 μm wide and 100 μm pitch
- * 32 or 64 element linear array
- * Fan-out metal strip for bonding

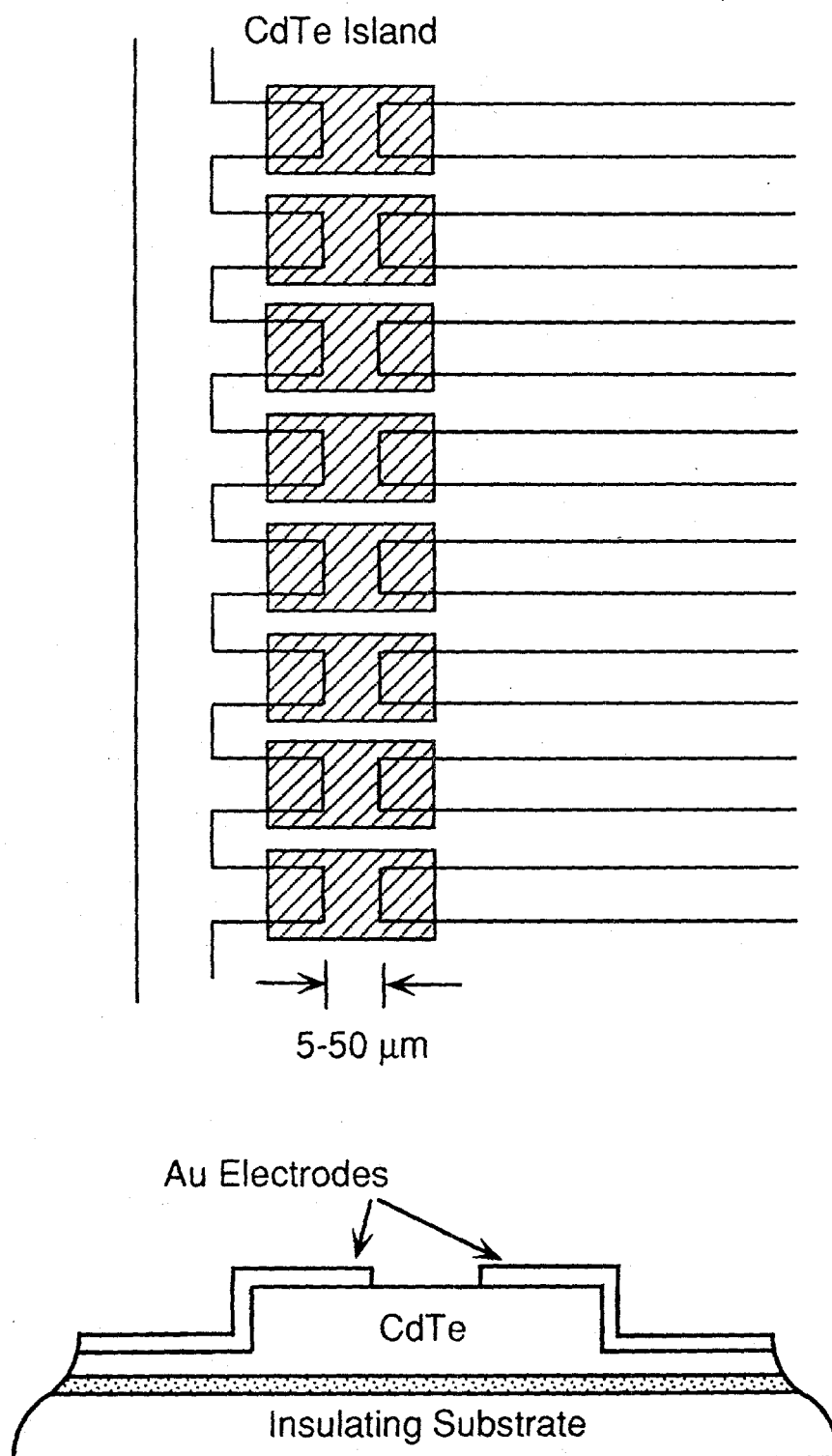
6. Metal Deposition and Liftoff

- * Electroless Au
- * Sputtered Au or Ni

7. Mounting and Bonding

- * Mounted on 64 leadless chip carrier
- * Gold wire bonding on 32 elements

SCHEMATIC DIAGRAM OF LINEAR ARRAY STRUCTURE



MEASUREMENTS

1. Electrical Measurement

- * Current-Voltage

2. Laser Response

- * Nd:YAG laser (0.53 μ m)
- * Ti:Sapphire (0.875 μ m)
- * Tektronix CS803 Sampling Digital Scope (20 GHz Bandwidth)

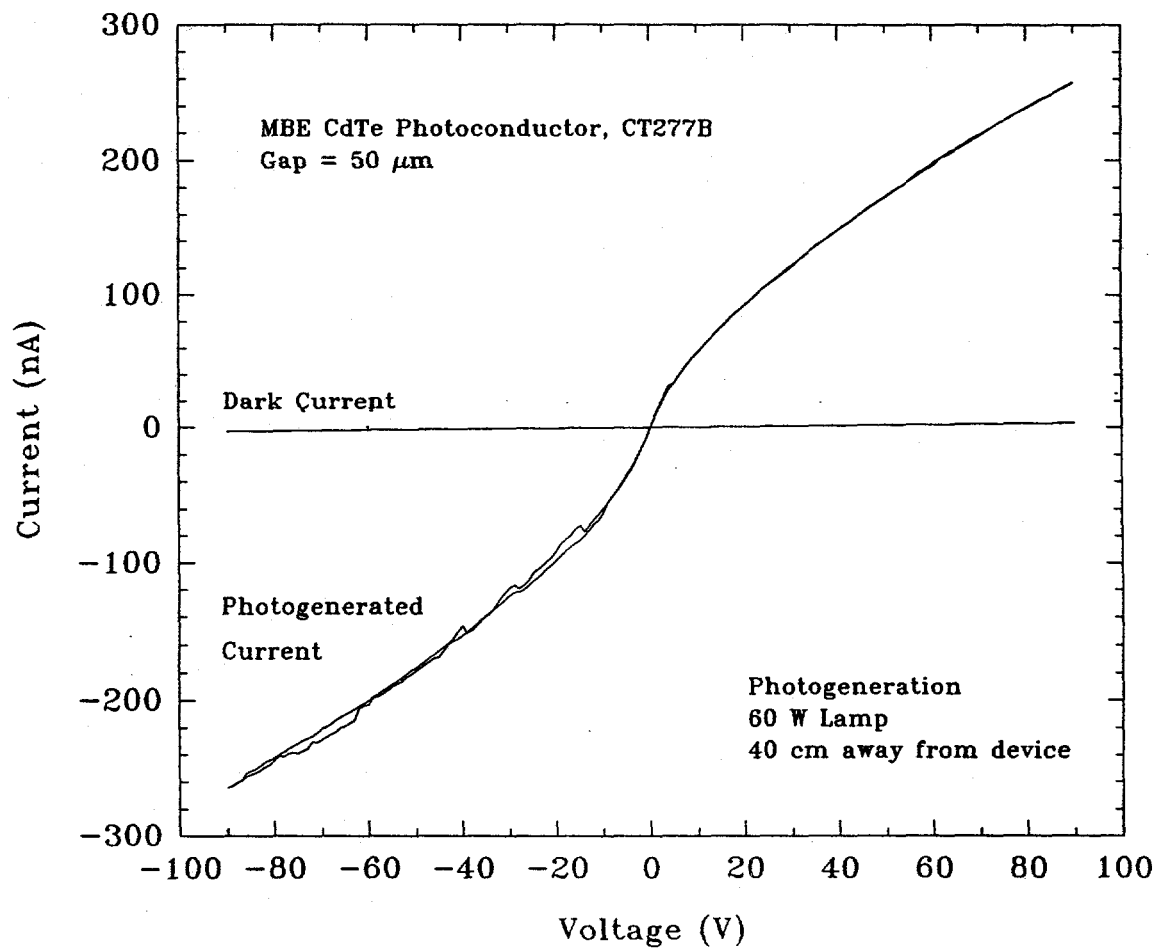
3. Rotating Anode X Ray (Cu)

- * White beam
- * Monochromatic beam

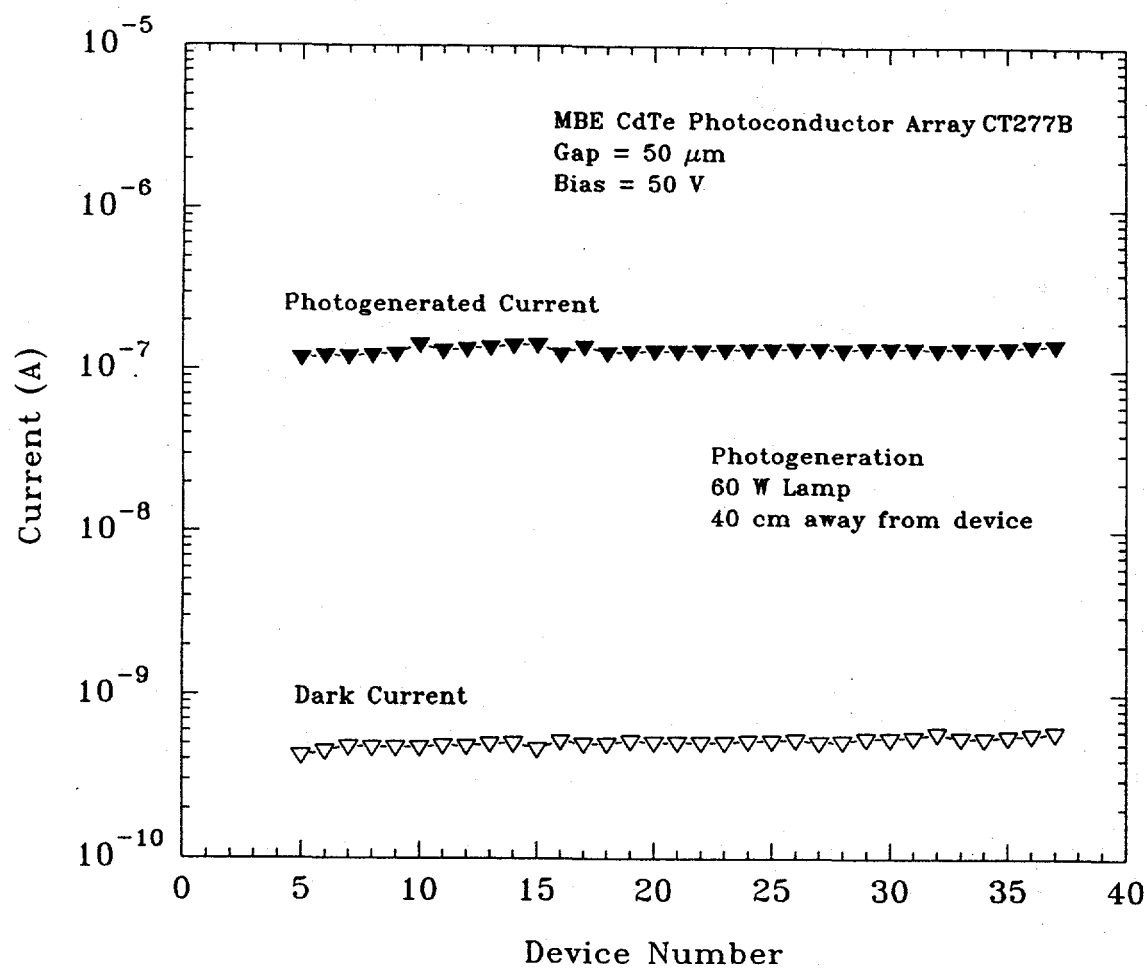
4. Synchrotron Source (NSLS/X18B)

- * Monochromatic beam (7 - 18 KeV)

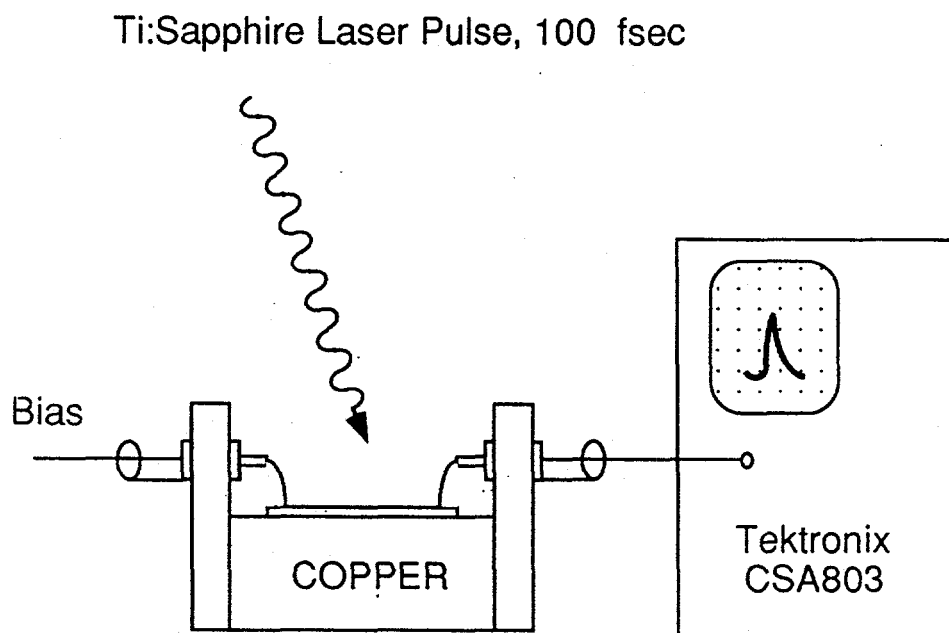
CURRENT-VOLTAGE CHARACTERISTICS



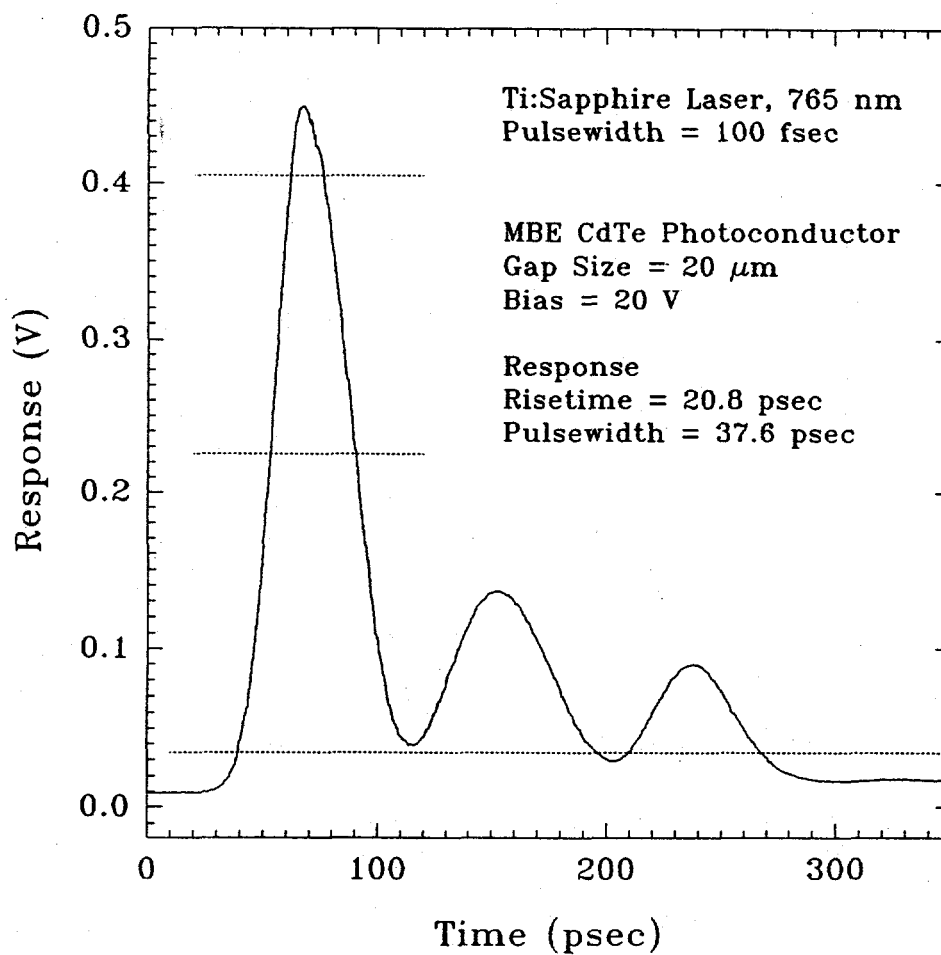
UNIFORMITY OF LINEAR ARRAY



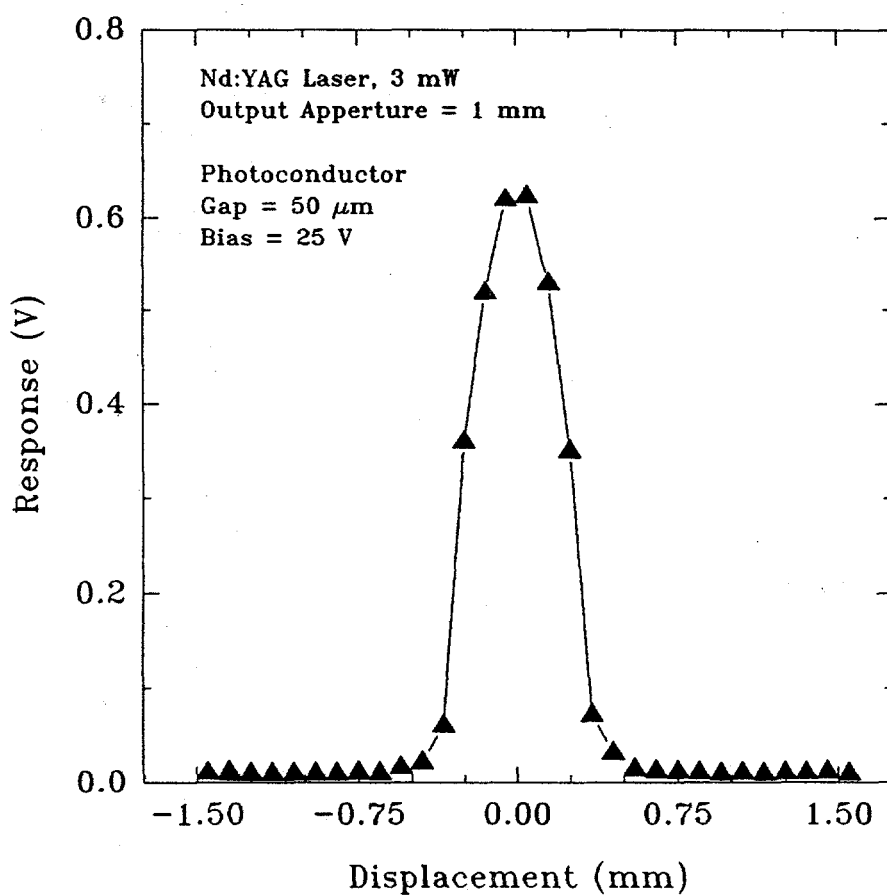
SCHEMATIC DIAGRAM OF TEMPORAL RESPONSE MEASUREMENT



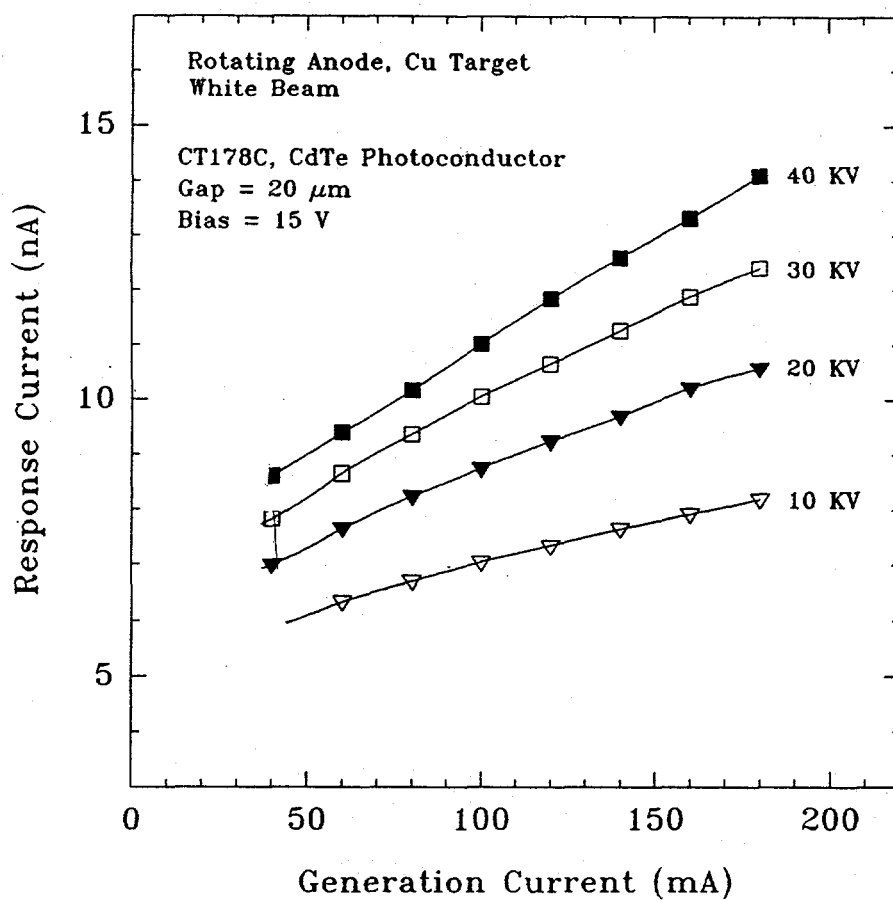
TEMPORAL RESPONSE TO Ti:Sapphire LASER PULSE



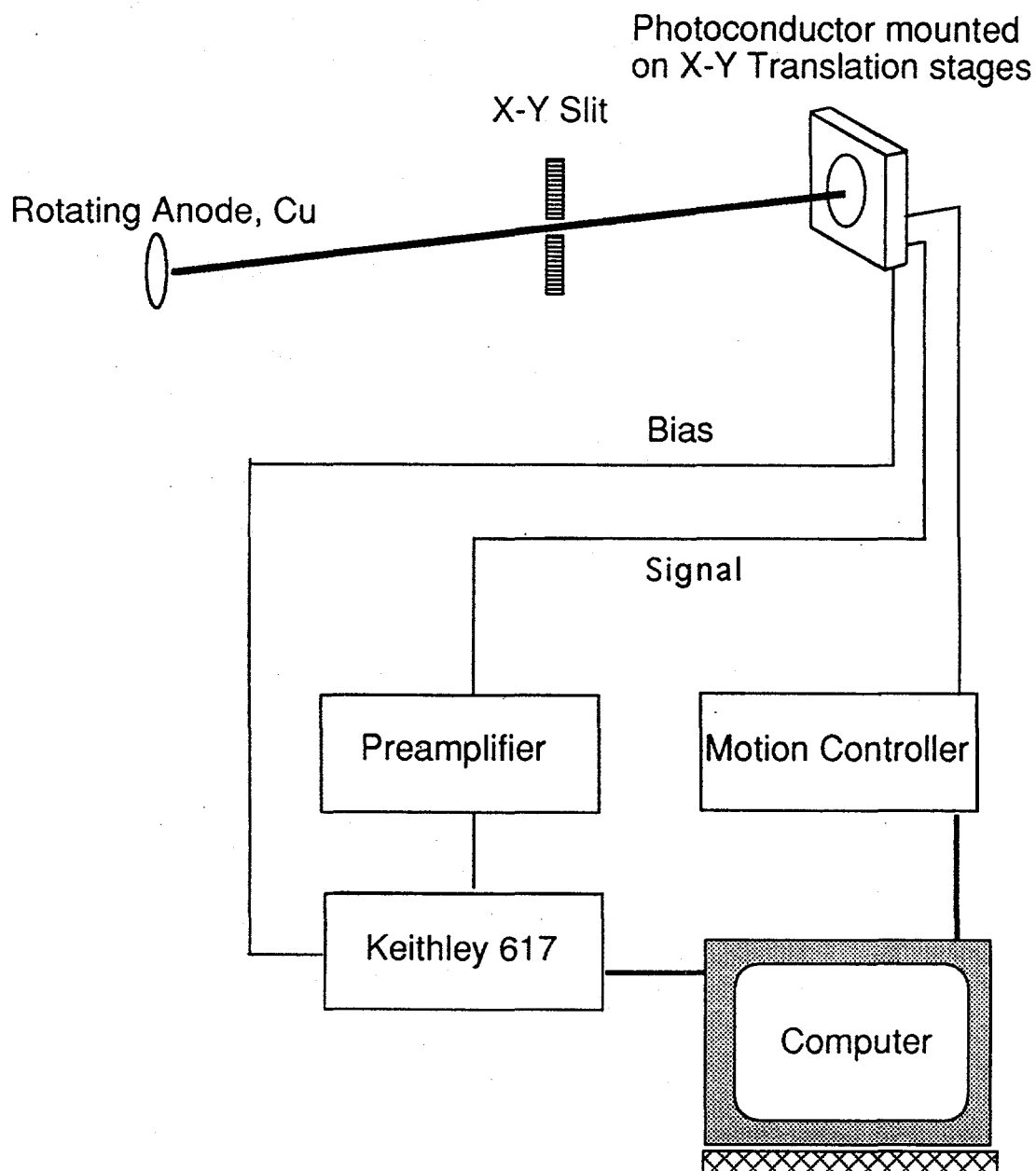
SPATIAL RESPONSE TO Nd:YAG LASER PULSE



LINEAR RESPONSE TO ROTATING ANODE X RAY (WHITE BEAM)

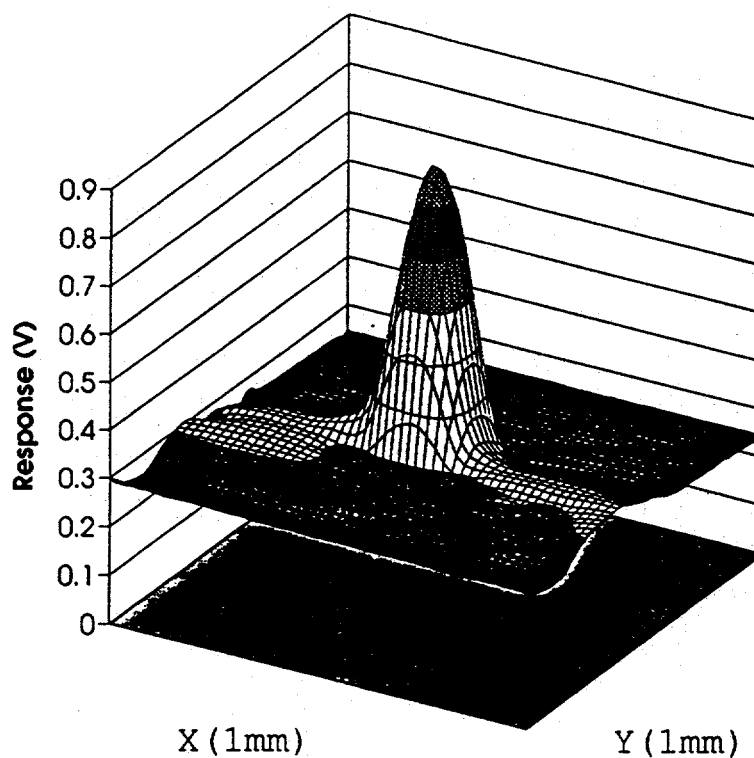


SCHEMATIC DIAGRAM OF SPATIAL RESPONSE MEASUREMENT



Spatial Response To Synchrotron Source

(NSLS/X18B)



Synchrotron Source:

I=206 mA

E=16 KeV

I₀=1436

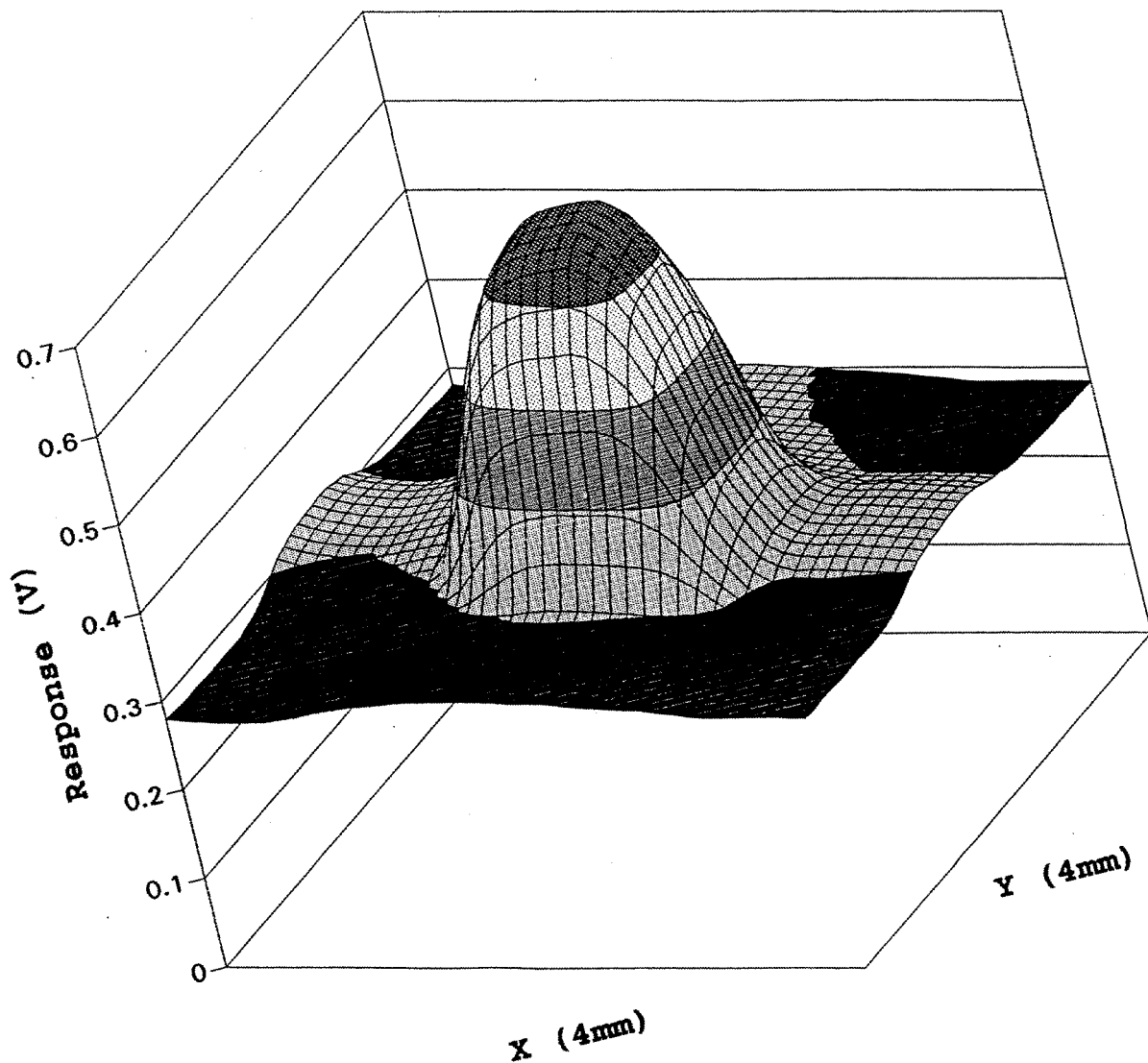
CdTe Photoconductor:

20 μm gap, 5 V

CONCLUSION

1. Utilized MBE CdTe for X-ray Detection
 - * 10-20 μm thickness, 50 μm widePosition Sensitive Detector
2. Fast Temporal Response Achieved.
 - * 20 psec risetime and 35 psec pulsewidth
3. Linear Response to X-Ray Photon Flux
 - * Rotating Anode
4. Demonstrated X-ray Beam Profiling
 - * Rotating Anode X Ray
 - * Synchrotron Source (NSLS)
5. Room Temperature Operation

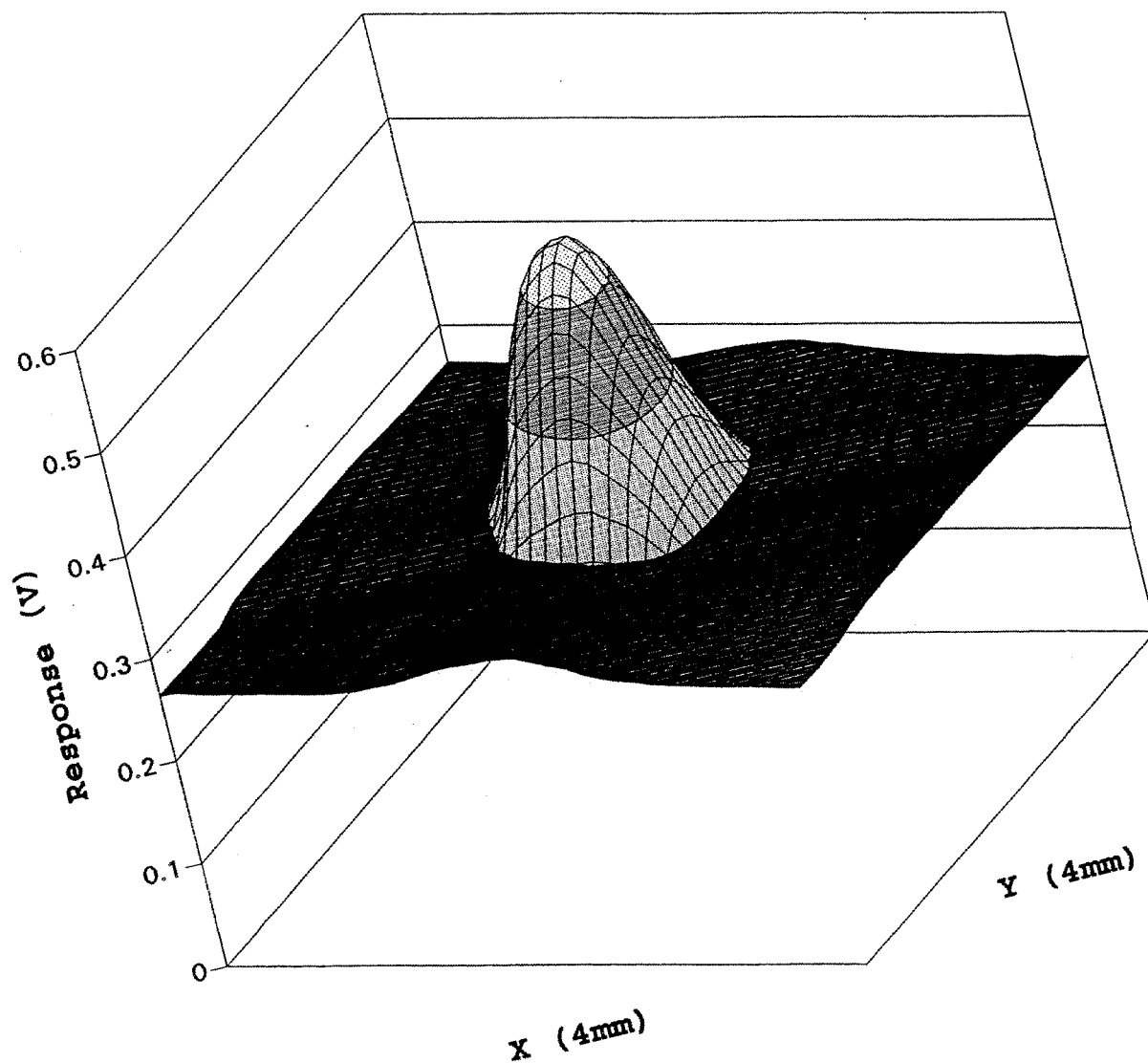
SPATIAL RESPONSE TO ROTATING ANODE (Cu, White Beam)



X-Ray Source:
Slit Size:
CdTe Photoconductor:

20 KV, 100 mA
1500 X 1500 μm
15 μm , 5 V

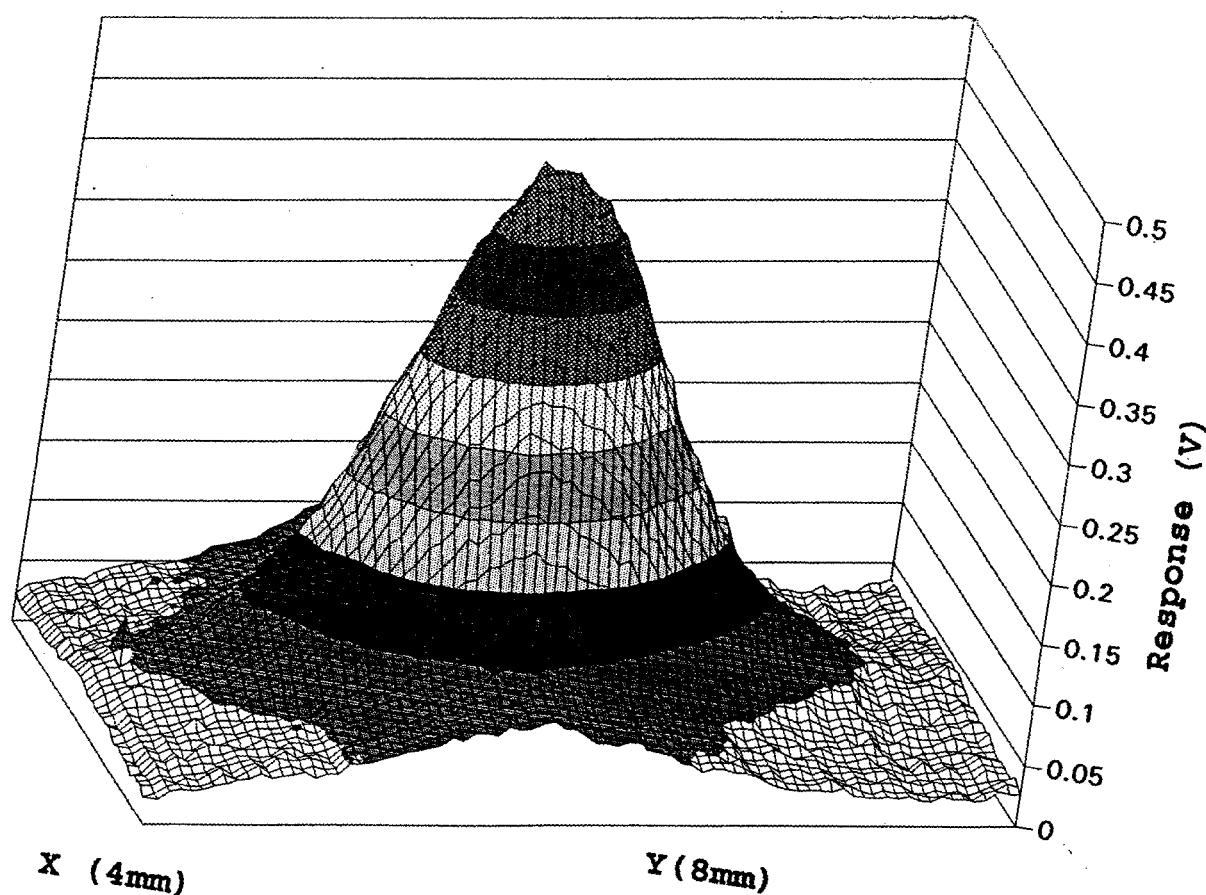
SPATIAL RESPONSE TO ROTATING ANODE (Cu, White Beam)



X-Ray Source:
Slit Size:
CdTe Photoconductor:

20 KV, 100 mA
600 x 600 μ m
15 μ m, 5 V

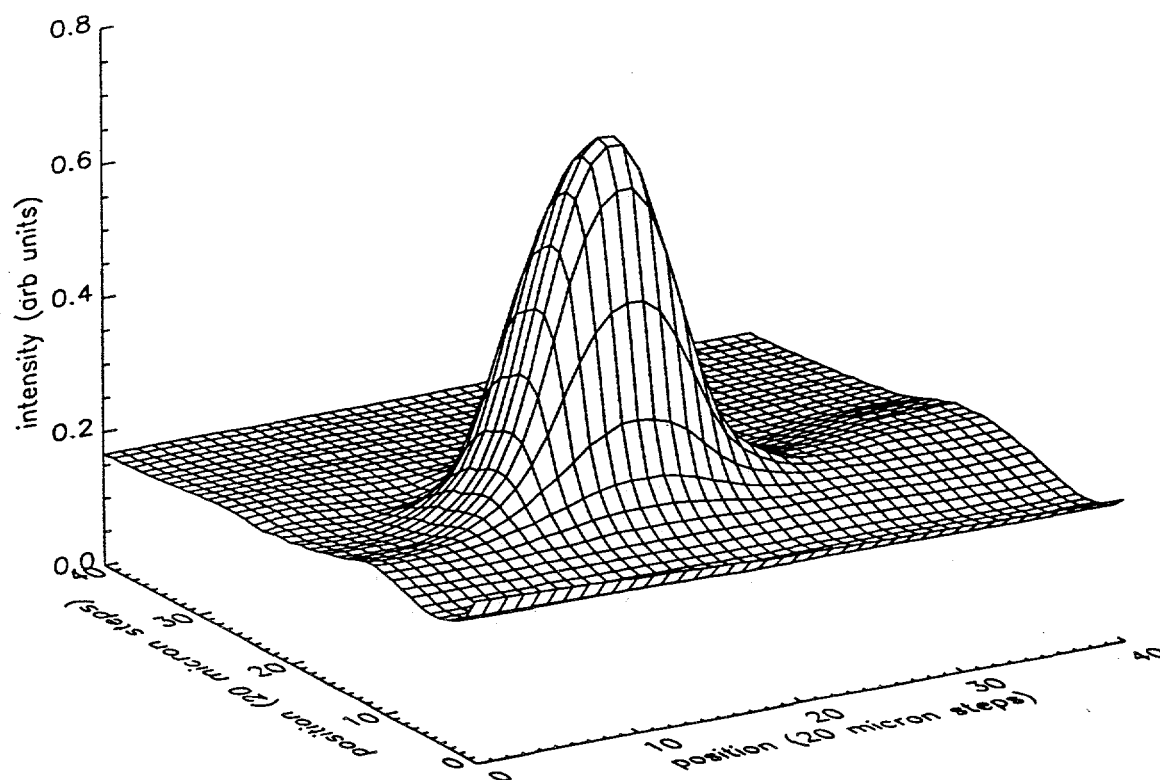
SPATIAL RESPONSE TO ROTATING ANODE (8 KeV Monochromatic and Focused Beam)



X-Ray Source:
X-Y Slit:
CdTe Photoconductor:

20 KV, 20mA
3 X 3 mm
15 μ m, 5 V

SPATIAL RESPONSE TO SYNCHROTRON SOURCE (NSLS/X18B)



Synchrotron Source:

I=206 mA

E=16 KeV

I₀=1436

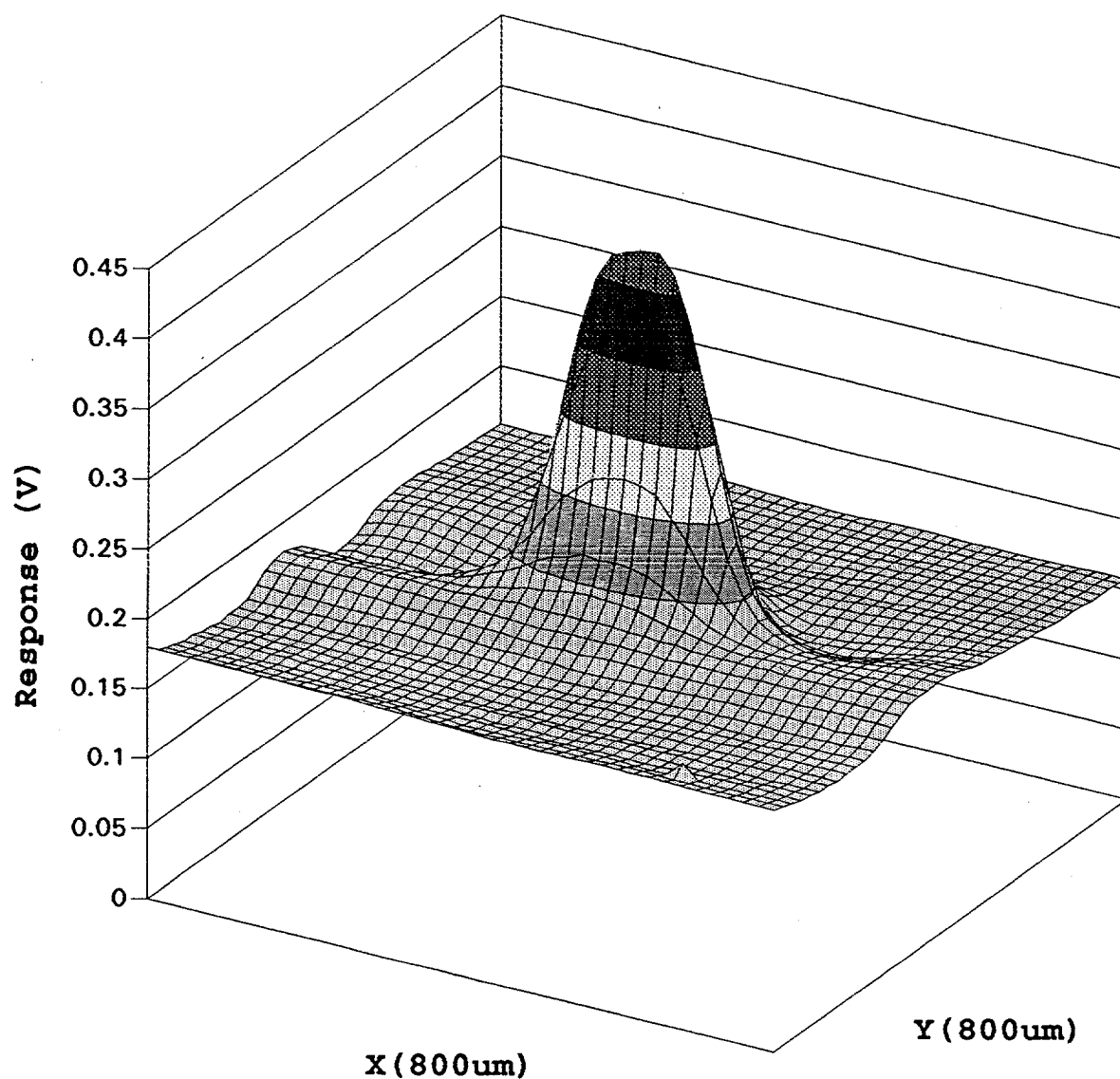
Beam Size:

100x100 μm

CdTe Photoconductor:

20 μm gap, 5 V

SPATIAL RESPONSE TO SYNCHROTRON SOURCE (NSLS/X18B)

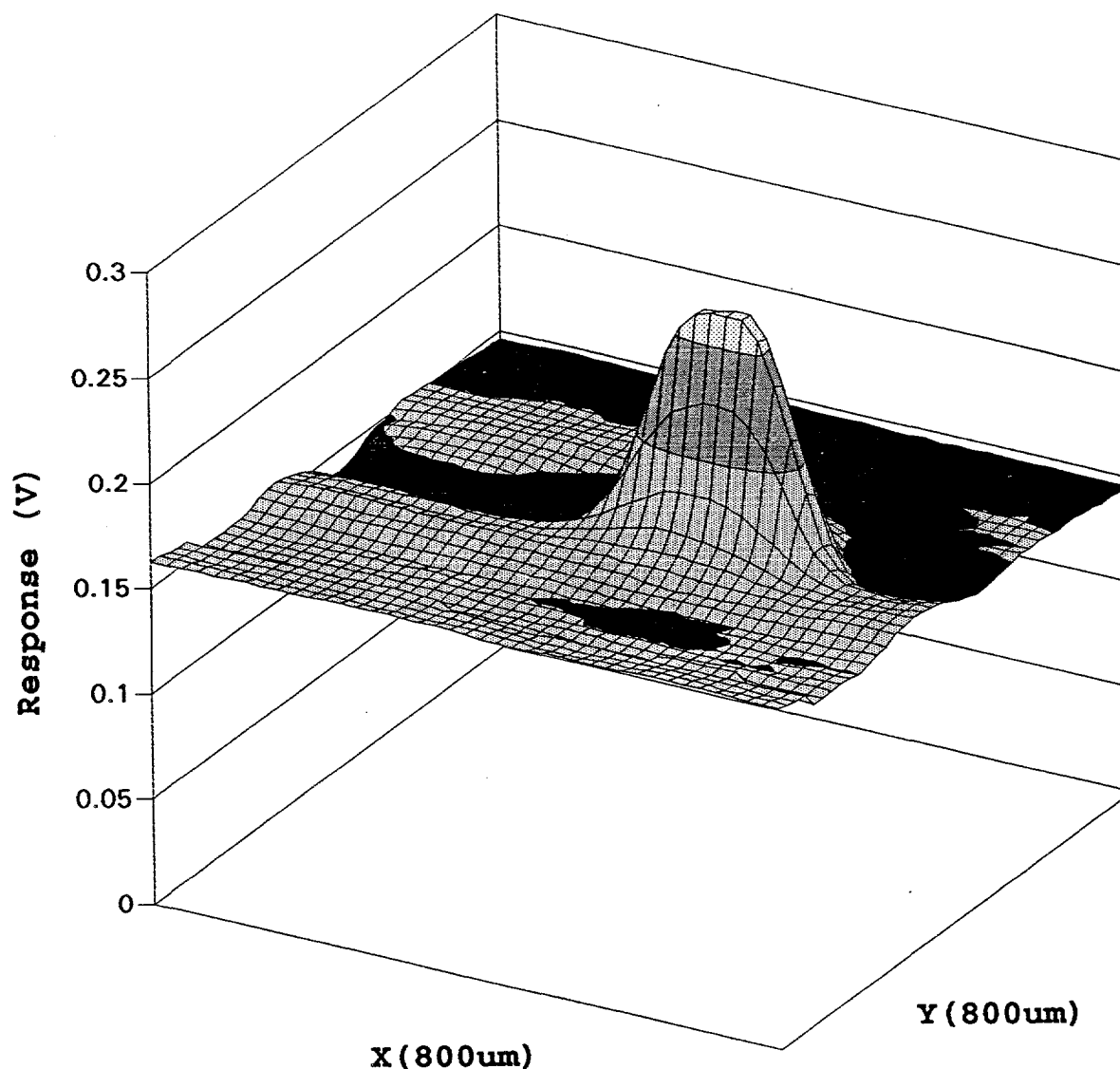


Synchrotron Source:
(Direct Beam)

Slit Size:
CdTe Photoconductor:

I=141mA
E=8 KeV
I₀=982
200(X) x 50(Y) μm
20 μm gap, 5 V

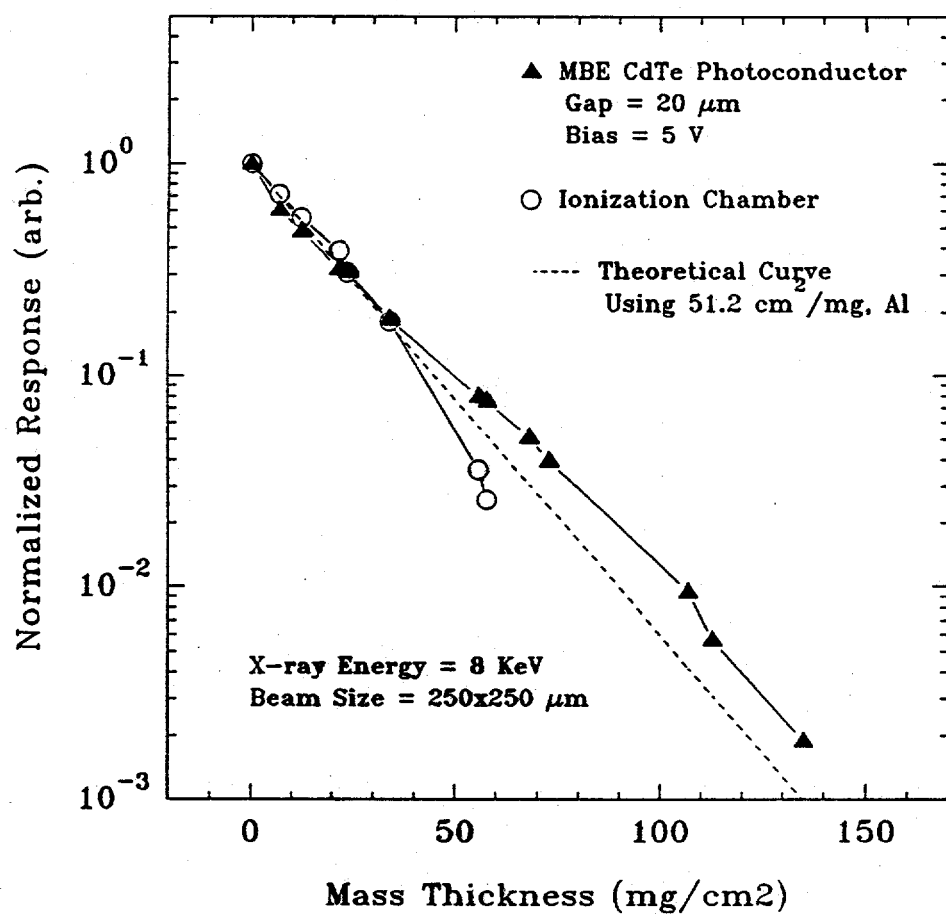
SPATIAL RESPONSE TO SYNCHROTRON SOURCE (NSLS/X18B)

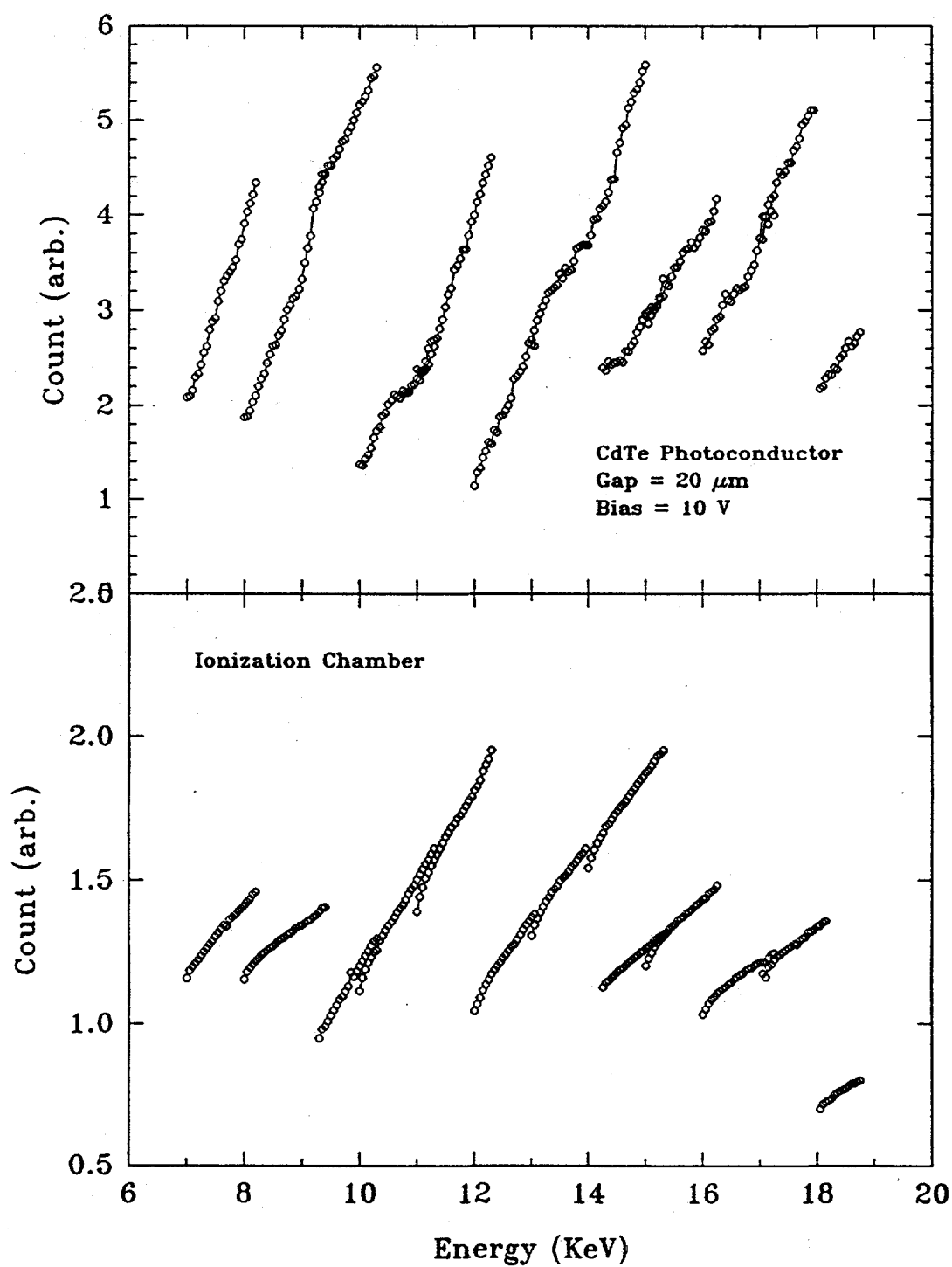


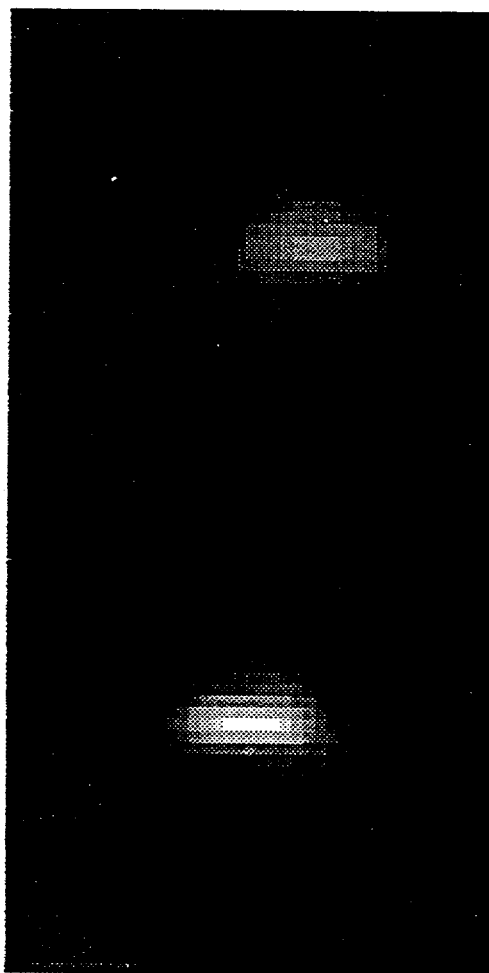
Synchrotron Source:
(Partially Absorbed Beam)

Slit Size:
CdTe Photoconductor:

I=120 m
E =8 KeV
I0=302
200(X) x 50(Y) μ m
20 μ m gap, 5 V







← 800AM →